查询PIC18F67K90供应商

2010 Microchip Technology Inc.

dzsc.com

MICROCHIP

PIC18F87K90 Family Data Sheet

64/80-Pin, High-Performance Microcontrollers with LCD Driver and nanoWatt XLP Technology



查询PIC18F67K90供应商

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION. QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV ISO/TS 16949:2002

Trademarks

The Microchip name and logo, the Microchip logo, dsPIC, KEELOQ, KEELOQ logo, MPLAB, PIC, PICmicro, PICSTART, PIC³² logo, rfPIC and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Hampshire, HI-TECH C, Linear Active Thermistor, MXDEV, MXLAB, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, Application Maestro, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, HI-TIDE, In-Circuit Serial Programming, ICSP, Mindi, MiWi, MPASM, MPLAB Certified logo, MPLIB, MPLINK, mTouch, Octopus, Omniscient Code Generation, PICC, PICC-18, PICDEM, PICDEM.net, PICkit, PICtail, REAL ICE, rfLAB, Select Mode, Total Endurance, TSHARC, UniWinDriver, WiperLock and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

 $\ensuremath{\mathsf{SQTP}}$ is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2010, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.



ISBN: 978-1-60932-224-3

Microchip received ISO/TS-16949:2002 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.



64/80-Pin, High-Performance Microcontrollers with LCD Driver and nanoWatt XLP Technology

Low-Power Features:

- Power-Managed modes:
 - Run: CPU on, peripherals on
 - Idle: CPU off, peripherals on
 - Sleep: CPU off, peripherals off
- Two-Speed Oscillator Start-up
- Fail-Safe Clock Monitor
- Power-Saving Peripheral Module Disable (PMD)
- Ultra Low-Power Wake-up
- Fast Wake-up, 2 μs Typical
- · Low-Power WDT, 300 nA Typical
- Ultra Low 50 nA Input Leakage
- Run mode Currents Down to very low 5.5 μA, Typical
- Idle mode Currents Down to very low 2.2 μA, Typical
- Sleep mode Current Down to very low 20 nA, Typical
- RTCC Current Down to very low 700 nA, Typical
- LCD Current Down to very low 300 nA, Typical

LCD Driver and Keypad Features:

- Direct LCD Panel Drive Capability:
 - Can drive LCD panel while in Sleep mode
- Up to 48 Segments and 192 Pixels, Software-Selectable
- Programmable LCD Timing module:
 - Multiple LCD timing sources available
 - Up to four commons: static, 1/2, 1/3 or 1/4 multiplex
 - Bias configuration: Static, 1/2 or 1/3
- Low-Power Resistor Bias Network for LCD

Peripheral Highlights:

- Ten or eight CCP/ECCP modules:
 - Seven Capture/Compare/PWM (CCP) modules
 - Three Enhanced Capture/Compare/PWM (ECCP) modules
- Eleven 8/16-Bit Timer/Counter modules:
 - Timer0 8/16-bit timer/counter with 8-bit programmable prescaler
 - Timer1,3,5,7 16-bit timer/counter
 - Timer2,4,6,8,10,12 8-bit timer/counter
- Three Analog Comparators
- Configurable Reference Clock Output
- Hardware Real-Time Clock and Calendar (RTCC) module with Clock, Calendar and Alarm Functions
 Time-out from 0.5s to 1 year
- Charge Time Measurement Unit (CTMU):
 - Capacitance measurement for mTouch™ Sensing
 - Time measurement with 1 ns typical resolution
- High-Current Sink/Source 25 mA/25 mA (PORTB and PORTC)
- Up to Four External Interrupts
- Two Master Synchronous Serial Port (MSSP) modules:
 - 3/4-wire SPI (supports all four SPI modes)
 - I²C[™] Master and Slave mode

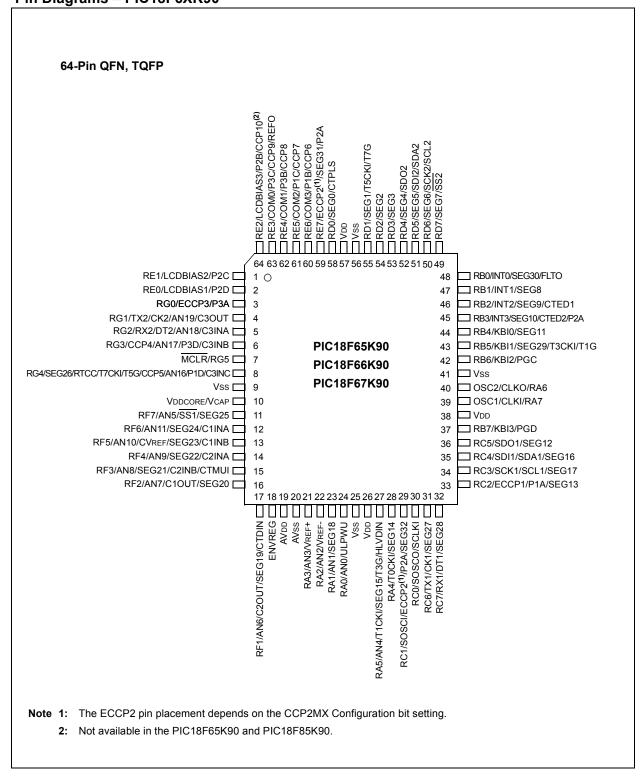
Device	Flash Program Memory (Bytes)	SRAM Data Memory (Bytes)	EEPROM (Bytes)	I/O	LCD Pixels	Timers 8/16-Bit	CCP/ ECCP	SPI	l²C™	EUSART	12-Bit A/D (Channels)	Comparators	стми	RTCC
PIC18F65K90	32K	2K	1K	53	132	4/4	5/3	Yes	Yes	2	16	3	Y	Y
PIC18F66K90	64K	4K	1K	53	132	6/5	7/3	Yes	Yes	2	16	3	Y	Y
PIC18F67K90	128K	4K	1K	53	132	6/5	7/3	Yes	Yes	2	16	3	Υ	Y
PIC18F85K90	32K	2K	1K	69	192	4/4	5/3	Yes	Yes	2	24	3	Υ	Y
PIC18F86K90	64K	4K	1K	69	192	6/5	7/3	Yes	Yes	2	24	3	Y	Y
PIC18F87K90	128K	4K	1K	69	192	6/5	7/3	Yes	Yes	2	24	3	Y	Y

查询PIC18F67K90供应商

- Special Microcontroller Features:
- Operating Voltage Range: 1.8V to 5.5V
- On-Chip 3.3V Regulator
- Operating Speed up to 64 MHz
- Up to 128 Kbytes On-Chip Flash Program Memory
- Data EEPROM of 1,024 Bytes
- 4K x 8 General Purpose Registers (SRAM)
- 10,000 Erase/Write Cycle Flash Program Memory, Typical
- 1,000,000 Erase/write Cycle Data EEPROM Memory, Typical
- Flash Retention 40 Years, Minimum
- Three Internal Oscillators: LF-INTRC (31 kHz), MF-INTOSC (500 kHz) and HF-INTOSC (16 MHz)
- Self-Programmable under Software Control

- Priority Levels for Interrupts
- 8 x 8 Single-Cycle Hardware Multiplier
- Extended Watchdog Timer (WDT):
- Programmable period from 4 ms to 4,194s (about 70 minutes)
- In-Circuit Serial Programming[™] (ICSP[™]) via Two Pins
- In-Circuit Debug via Two Pins
- Programmable:
 - BOR
 - LVD
- Two Enhanced Addressable USART modules:
 - LIN/J2602 support
 - Auto-Baud Detect (ABD)
- 12-Bit A/D Converter with up to 24 Channels:
 - Auto-acquisition and Sleep operation
 - Differential Input mode of operation

查询PIC18F67K90供应商 Pin Diagrams – PIC18F6XK90



© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商 **Pin Diagrams – PIC18F8XK90**

80-Pin TQFP RE3/COM0/P3C/CCP9⁽³⁾/REFO RE2/LCDBIAS3/P2B/CCP10⁽²⁾ DRE7/ECCP2⁽¹⁾/P2A/SEG3[·] DRD0/SEG0/CTPLS DVDD BRE6/COM2/P1C/CCP7⁽³⁾ BRE6/COM3/P1B/CCP6⁽³⁾ RE4/COM1/P3B/CCP8⁽³⁾ DRD6/SEG6/SCK2/SCL2 DRD1/SEG1/T5CKI/T7G DRD2/SEG2 DRD5/SEG5/SDI2/SDA2 RH0/SEG47/AN23 RH1/SEG46/AN22 RD4/SEG4/SDO2 **JRD7/SEG7/SS2** DRJO DRJ1/SEG33 RD2/SEG2 RD3/SEG3 **J**VSS 80 79 78 77 76 75 74 73 72 71 70 69 68 67 66 65 64 63 62 61 60 RJ2/SEG34 RH2/SEG45/AN21 RH3/SEG44/AN20 59 RJ3/SEG35 2 RE1/LCDBIAS2/P2C 3 58 RB0/INT0/SEG30/FLT0 4 57 RB1/INT1/SEG8 RE0/LCDBIAS1/P2D RG0/ECCP3/P3A 5 56 RB2/INT2/SEG9/CTED1 RG1/TX2/CK2/AN19/C3OUT 6 55 RB3/INT3/SEG10/CTED2/P2A 54 RB4/KBI0/SEG11 RG2/RX2/DT2/AN18/C3INA 7 RG3/CCP4/AN17/P3D/C3INB 8 53 RB5/KBI1/SEG29/T3CKI/T1G PIC18F85K90 52 RB6/KBI2/PGC MCLR/RG5 9 RG4/SEG26/RTCC/T7CKI/T5G/CCP5/AN16/P1D/C3INC 0 10 51 Vss PIC18F86K90 50 OSC2/CLKO/RA6 Vss 🛙 11 PIC18F87K90 49 OSC1/CLKI/RA7 VDDCORE/VCAP 12 48 VDD RF7/AN5/SS1/SEG25 [13 47 RB7/KBI3/PGD RF6/AN11/SEG24/C1INA 14 46 RC5/SDO1/SEG12 RF5/AN10/CVREF/SEG23/C1INB 15 45 TRC4/SDI1/SDA1/SEG16 RF4/AN9/SEG22/C2INA RF3/AN8/SEG21/C2INB/CTMUI 44 RC3/SCK1/SCL1/SEG17 17 RF2/AN7/C10UT/SEG20 [18 RH7/SEG43/CCP6⁽³⁾/P1B/AN15 [19 43 RC2/ECCP1/P1A/SEG13 42 RJ7/SEG36 RH6/SEG42/CCP7⁽³⁾/P1C/AN14/C1INC 20 41 RJ6/SEG37 RF1/AN6/C2OUT/SEG19/CTDIN [] 25 RVDD [] 25 RVDD [] 25 RA3/AN3/YREF-1 [] 25 RA3/AN3/YREF-1 [] 25 RA2/AN3/YREF-1 [] 25 RA3/AN3/YREF-1 [] 21 22 23 24 25 26 27 28 29 30 31 32 33 34 35 36 37 38 39 40 RC7/RX1/DT1/SEG2805 RJ4/SEG3905 RJ5/SEG3805 RH5/SEG41/CCP8⁽³⁾/P3B/AN13/C2IND PH4/SFG40/CCP9⁽³⁾/P3C/AN12/C2INC D RC6/TX1/CK1/SEG27 RC1/SOSCI/ECCP2⁽¹⁾I/SEG32/P2A RC0/SOSCO/SCKL Note 1: The ECCP2 pin placement depends on the CCP2MX Configuration bit setting. 2: Not available in the PIC18F65K90 and PIC18F85K90. The CCP6, CCP7, CCP8 and CCP9 pin placement depends on the ECCPMX Configuration bit setting 3:

查询PIC18F67K90供应商 Table of Contents

IUN		
1.0	Device Overview	9
2.0	Guidelines for Getting Started with PIC18FXXKXX Microcontrollers	
3.0	Oscillator Configurations	39
4.0	Power-Managed Modes	51
5.0	Reset	67
6.0	Memory Organization	83
7.0	Flash Program Memory	109
8.0	Data EEPROM Memory	119
9.0	8 x 8 Hardware Multiplier	
10.0	Interrupts	127
11.0		
12.0		
13.0		
14.0		
15.0	Timer3/5/7 Modules	
16.0		
17.0		
18.0		
19.0		
20.0		
21.0		
22.0		
23.0		
25.0	· · · · · · · · · · · · · · · · · · ·	
26.0	5 5 ()	
	Charge Time Measurement Unit (CTMU)	
	Special Features of the CPU	
	······································	
30.0	e e de la contra c	
31.0		
	Packaging Information	
	endix A: Revision History	
	endix B: Migration From PIC18F85J90 and PIC18F87J90 to PIC18F87K90	
	Χ	
	Microchip Web Site	
	tomer Change Notification Service	
	tomer Support	
	der Response	
Prod	luct Identification System	565

查询PIC18F67K90供应商

TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at **docerrors@microchip.com** or fax the **Reader Response Form** in the back of this data sheet to (480) 792-4150. We welcome your feedback.

Most Current Data Sheet

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

http://www.microchip.com

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000A is version A of document DS30000).

Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; http://www.microchip.com
- Your local Microchip sales office (see last page)

When contacting a sales office, please specify which device, revision of silicon and data sheet (include literature number) you are using.

Customer Notification System

Register on our web site at www.microchip.com to receive the most current information on all of our products.

查询PIC18F67K90供应商 **1.0 DEVICE OVERVIEW**

This document contains device-specific information for the following devices:

- PIC18F65K90 PIC18F85K90
- PIC18F66K90 PIC18F86K90
- PIC18F67K90 PIC18F87K90

This family combines the traditional advantages of all PIC18 microcontrollers – namely, high computational performance and a rich feature set – with a versatile on-chip LCD driver, while maintaining an extremely competitive price point. These features make the PIC18F87K90 family a logical choice for many high-performance applications where price is a primary consideration.

1.1 Core Features

1.1.1 nanoWatt TECHNOLOGY

All of the devices in the PIC18F87K90 family incorporate a range of features that can significantly reduce power consumption during operation. Key items include:

- Alternate Run Modes: By clocking the controller from the Timer1 source or the internal RC oscillator, power consumption during code execution can be reduced.
- Multiple Idle Modes: The controller can also run with its CPU core disabled but the peripherals still active. In these states, power consumption can be reduced even further.
- **On-the-Fly Mode Switching:** The power-managed modes are invoked by user code during operation, allowing the user to incorporate power-saving ideas into their application's software design.
- **nanoWatt XLP:** An extra low-power BOR, RTCC and low-power Watchdog Timer. Also, an ultra low-power regulator for Sleep mode is provided in regulator enabled modes.

1.1.2 OSCILLATOR OPTIONS AND FEATURES

All of the devices in the PIC18F87K90 family offer different oscillator options, allowing users a range of choices in developing application hardware. These include:

- External Resistor/Capacitor (RC); RA6 available
- External Resistor/Capacitor with Clock Out (RCIO)
- Three External Clock modes:
 - External Clock (EC); RA6 available
 - External Clock with Clock Out (ECIO)
 - External Crystal (XT, HS, LP)
- A Phase Lock Loop (PLL) frequency multiplier, available to the External Oscillator modes which allows clock speeds of up to 64 MHz. PLL can also be used with the internal oscillator.

- An internal oscillator block that provides a 16 MHz clock (±2% accuracy) and an INTRC source (approximately 31 kHz, stable over temperature and VDD)
 - Operates as HF-INTOSC or MF-INTOSC when block selected for 16 MHz or 500 kHz
 - Frees the two oscillator pins for use as additional general purpose I/O

The internal oscillator block provides a stable reference source that gives the family additional features for robust operation:

- Fail-Safe Clock Monitor: This option constantly monitors the main clock source against a reference signal provided by the internal oscillator. If a clock failure occurs, the controller is switched to the internal oscillator, allowing for continued low-speed operation or a safe application shutdown.
- **Two-Speed Start-up:** This option allows the internal oscillator to serve as the clock source from Power-on Reset, or wake-up from Sleep mode, until the primary clock source is available.

1.1.3 MEMORY OPTIONS

The PIC18F87K90 family provides ample room for application code, from 32 Kbytes to 128 Kbytes of code space. The Flash cells for program memory are rated to last up to 10,000 erase/write cycles. Data retention without refresh is conservatively estimated to be greater than 40 years.

The Flash program memory is readable and writable. During normal operation, the PIC18F87K90 family also provides plenty of room for dynamic application data with up to 3,828 bytes of data RAM.

1.1.4 EXTENDED INSTRUCTION SET

The PIC18F87K90 family implements the optional extension to the PIC18 instruction set, adding 8 new instructions and an Indexed Addressing mode. Enabled as a device configuration option, the extension has been specifically designed to optimize re-entrant application code originally developed in high-level languages, such as 'C'.

1.1.5 EASY MIGRATION

Regardless of the memory size, all devices share the same rich set of peripherals (except the 32-Kbyte parts, which have two less CCPs and three less Timers), allowing for a smooth migration path as applications grow and evolve.

The consistent pinout scheme, used throughout the entire family, also aids in migrating to the next larger device. This is true when moving between the 64-pin members, between the 80-pin members, or even jumping from 64-pin to 80-pin devices.

查询PIC18F67K90供应商 The PIC18F87K90 family is also largely pin-compatible with other PIC18 families, such as the PIC18F8720, PIC18F8722. PIC18F85J11. PIC18F8490. PIC18F85J90, PIC18F87J90 and PIC18F87J93 families of microcontrollers with LCD drivers. This allows a new dimension to the evolution of applications, allowing developers to select different price points within Microchip's PIC18 portfolio, while maintaining a similar feature set.

1.2 LCD Driver

The on-chip LCD driver includes many features that ease the integration of displays in low-power applications. These include an integrated internal resistor ladder, so bias voltages can be generated internally. This enables software-controlled contrast control and eliminates the need for external bias voltage resistors.

1.3 **Other Special Features**

- Communications: The PIC18F87K90 family incorporates a range of serial communication peripherals including two Enhanced USART, that support LIN/J2602, and two Master SSP modules capable of both SPI and I^2C^{TM} (Master and Slave) modes of operation.
- CCP Modules: PIC18F87K90 family devices incorporate up to seven or five Capture/ Compare/PWM (CCP) modules. Up to six different time bases can be used to perform several different operations at once.
- ECCP Modules: The PIC18F87K90 family has three Enhanced CCP (ECCP) modules to maximize flexibility in control applications:
 - Up to eight different time bases for performing several different operations at once
 - Up to four PWM outputs for each module, for a total of 12 PWMs
 - Other beneficial features, such as polarity selection, programmable dead time, auto-shutdown and restart, and Half-Bridge and Full-Bridge Output modes
- 12-Bit A/D Converter: The PIC18F87K90 family has differential ADC. It incorporates programmable acquisition time, allowing for a channel to be selected and a conversion to be initiated without waiting for a sampling period, and thus, reducing code overhead.
- Charge Time Measurement Unit (CTMU): The CTMU is a flexible analog module that provides accurate differential time measurement between pulse sources, as well as asynchronous pulse generation.

Together with other on-chip analog modules, the CTMU can precisely measure time, measure capacitance or relative changes in capacitance, or generate output pulses that are independent of the system clock.

- LP Watchdog Timer (WDT): This enhanced version incorporates a 22-bit prescaler, allowing an extended time-out range that is stable across operating voltage and temperature. See Section 31.0 "Electrical Characteristics" for time-out periods.
- **Real-Time Clock and Calendar Module (RTCC):** The RTCC module is intended for applications requiring that accurate time be maintained for extended periods of time with minimum to no intervention from the CPU.

The module is a 100-year clock and calendar with automatic leap year detection. The range of the clock is from 00:00:00 (midnight) on January 1, 2000 to 23:59:59 on December 31, 2099.

Details on Individual Family 1.4 Members

Devices in the PIC18F87K90 family are available in 64-pin and 80-pin packages. Block diagrams for the two groups are shown in Figure 1-1 and Figure 1-2.

The devices are differentiated from each other in these ways:

- Flash Program Memory -
 - PIC18FX5K90 (PIC18F65K90 and PIC18F85K90) - 32 Kbytes
 - PIC18FX6K90 (PIC18F66K90 and PIC18F86K90) - 64 Kbytes
 - PIC18FX7K90 (PIC18F67K90 and PIC18F87K90) - 128 Kbytes
- Data RAM
 - All devices except PIC18FX5K90 4 Kbytes
 - PIC18FX5K90 2 Kbytes
- · I/O Ports
 - PIC18F6XK90 (64-pin devices) Seven bidirectional ports
 - PIC18F8XK90 (80-pin devices) Nine bidirectional ports
- · LCD Pixels:
 - PIC18F6XK90 132 pixels (33 SEGs x 4 COMs)
 - PIC18F8XK90 192 pixels (48 SEGs x 4 COMs)
- · CCP Module
 - All devices except PIC18FX5K90 have seven CCP modules, PIC18FX5K90 has only five CCP modules
- Timers
 - All devices except 18FX5K90 have six 8-bit timers and five 16-bit timers, PIC18FX5K90 has only four 8-bit timers and four 16-bit timers.
- · A/D Channels
 - All PIC18F8XK90 devices have 24 A/D channels, all PIC18F6XK90 devices have 16 A/D channels

All other features for devices in this family are identical. These are summarized in Table 1-1 and Table 1-2.

The pinouts for all devices are listed in Table 1-3 and Table 1-4.

查询PIC18F67K90供应商 TABLE 1-1: DEVICE FEATURES FOR THE PIC18F6XK90 (64-PIN DEVICES)

Features	PIC18F65K90	PIC18F66K90	PIC18F67K90					
Operating Frequency	DC – 64 MHz							
Program Memory (Bytes)	32K	64K	128K					
Program Memory (Instructions)	16,384	32,768	65,536					
Data Memory (Bytes)	2K	4K	4K					
Interrupt Sources	42	4	8					
I/O Ports		Ports A, B, C, D, E, F, G	i					
LCD Driver (available pixels to drive)		132 (33 SEGs x 4 COMs)						
Timers	8 11							
Comparators		3						
СТМИ		Yes						
RTCC		Yes						
Capture/Compare/PWM (CCP) Modules	5	7	7					
Enhanced CCP (ECCP) Modules		3						
Serial Communications	Two MSSP a	Two MSSP and two Enhanced USART (EUSART)						
12-Bit Analog-to-Digital Module		16 Input Channels						
Resets (and Delays)	POR, BOR, RESET Instruction, Stack Full, Stack Underflow, MCLR, (PWRT, OST)							
Instruction Set	75 Instructions,	83 with Extended Instruc	tion Set Enabled					
Packages	(64-Pin QFN, 64-Pin TQF	P					

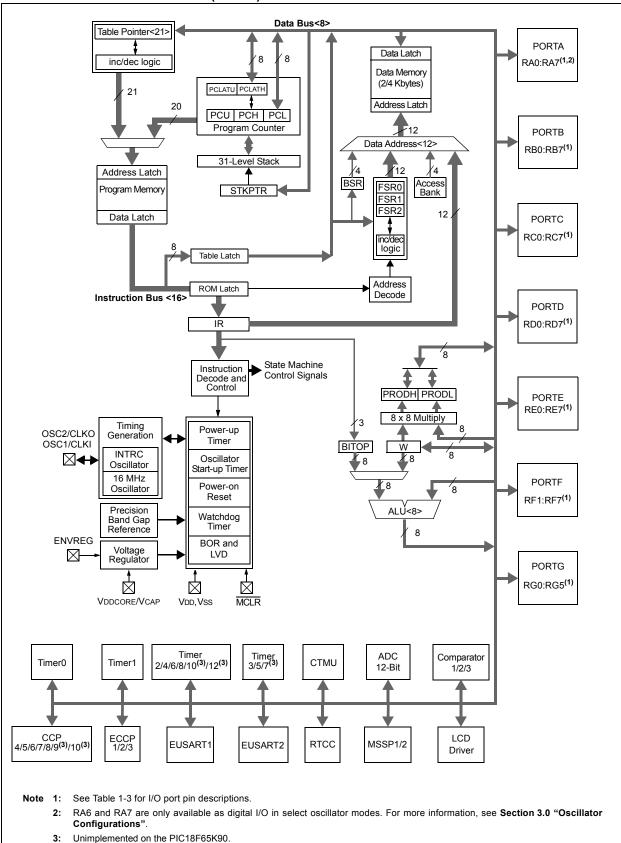
TABLE 1-2: DEVICE FEATURES FOR THE PIC18F8XK90 (80-PIN DEVICES)

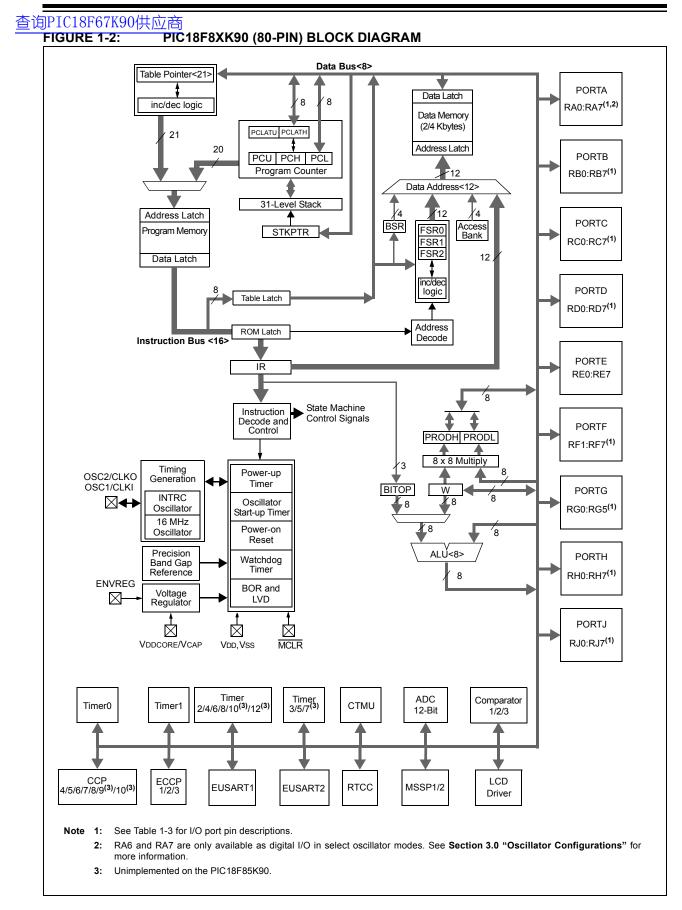
Features	PIC18F85K90	PIC18F86K90	PIC18F87K90			
Operating Frequency	DC – 64 MHz					
Program Memory (Bytes)	32K	64K	128K			
Program Memory (Instructions)	16,384	32,768	65,536			
Data Memory (Bytes)	2K	4K	4K			
Interrupt Sources	42	4	48			
I/O Ports	Р	orts A, B, C, D, E, F, G, H	I, J			
LCD Driver (available pixels to drive)		192 (48 SEGs x 4 COMs)				
Timers	8 11					
Comparators		3				
СТМИ	Y	′es				
RTCC	Y	<i>ï</i> es				
Capture/Compare/PWM (CCP) Modules	5	7	7			
Enhanced CCP (ECCP) Modules	3					
Serial Communications	Two MSSP	and two Enhanced USAF	RT (EUSART)			
12-Bit Analog-to-Digital Module	24 Input Channels					
Resets (and Delays)	POR, BOR, RESET Instruction, Stack Full, Stack Underflow, MCI (PWRT, OST)					
Instruction Set	75 Instructions,	83 with Extended Instruc	tion Set Enabled			
Packages		80-Pin TQFP				

© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商

FIGURE 1-1: PIC18F6XK90 (64-PIN) BLOCK DIAGRAM





查询PIC18F67K90供应商

TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number	Pin	Buffer	Description
Pin Name	QFN/TQFP	Туре	Туре	Description
MCLR/RG5	7			
MCLR		I	ST	Master Clear (input) or programming voltage (input).
				This pin is an active-low Reset to the device.
RG5			ST	General purpose, input only pin.
OSC1/CLKI/RA7	39			Oscillator crystal or external clock input.
OSC1		I	CMOS	Oscillator crystal input.
CLKI		I	CMOS	External clock source input. Always associated
				with pin function, OSC1. (See related OSC1/CLKI,
				OSC2/CLKO pins.)
RA7		I/O	TTL	General purpose I/O pin.
OSC2/CLKO/RA6	40			Oscillator crystal or clock output.
OSC2		0	_	Oscillator crystal output. Connects to crystal or
				resonator in Crystal Oscillator mode.
CLKO		0	_	In certain oscillator modes, OSC2 pin outputs CLKO,
				which has 1/4 the frequency of OSC1 and denotes the
				instruction cycle rate.
RA6		I/O	TTL	General purpose I/O pin.
Legend: TTL = TTL o	compatible inpu	t		CMOS = CMOS compatible input or output
ST = Schm	nitt Trigger input	t with C	CMOS lev	els Analog = Analog input

= Output

= Open-Drain (no P diode to VDD)

0

OD

Ρ = Power

 $I^2C^{TM} = I^2C/SMBus$

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

查询PIC18F67K90供应商 TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description
	QFN/TQFP	Туре	Туре	Description
				PORTA is a bidirectional I/O port.
RA0/AN0/ULPWU RA0 AN0 ULPWU	24	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 0. Ultra low-power wake-up input.
RA1/AN1/SEG18 RA1 AN1 SEG18	23	I/O I O	TTL Analog Analog	Digital I/O. Analog Input 1. SEG18 output for LCD.
RA2/AN2/VREF- RA2 AN2 VREF-	22	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 2. A/D reference voltage (low) input.
RA3/AN3/VREF+ RA3 AN3 VREF+	21	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 3. A/D reference voltage (high) input.
RA4/T0CKI/SEG14 RA4 T0CKI SEG14	28	I/O I O	ST ST Analog	Digital I/O. Timer0 external clock input. SEG14 output for LCD.
RA5/AN4/SEG15/T1CKI/ T3G/HLVDIN RA5 AN4 SEG15 T1CKI T3G HLVDIN	27	I/O I 0 I I	TTL Analog Analog ST ST Analog	Digital I/O. Analog Input 4. SEG15 output for LCD. Timer1 clock input. Timer3 external clock gate input. High/Low-Voltage Detect (HLVD) input.
RA6				See the OSC2/CLKO/RA6 pin.
RA7				See the OSC1/CLKI/RA7 pin.
$ST = Schm$ $I = Input$ $P = Powe$ $I^{2}C^{TM} = I^{2}C/SI$	MBus	with C		CMOS = CMOS compatible input or output Analog = Analog input O = Output OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

查询PIC18F67K90供应商 TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description
Pin Name	QFN/TQFP	Туре	Туре	Description
				PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.
RB0/INT0/SEG30/FLTO RB0 INT0 SEG30 FLTO	48	I/O I O I	TTL ST Analog ST	Digital I/O. External Interrupt 0. SEG30 output for LCD. Enhanced PWM Fault input for ECCP1/2/3.
RB1/INT1/SEG8 RB1 INT1 SEG8	47	I/O I O	TTL ST Analog	Digital I/O. External Interrupt 1. SEG8 output for LCD.
RB2/INT2/SEG9/CTED1 RB2 INT2 CTED1 SEG9	46	I/O I I O	TTL ST ST Analog	Digital I/O. External Interrupt 2. CTMU Edge 1 input. SEG9 output for LCD.
RB3/INT3/SEG10/CTED2/ ECCP2/P2A RB3 INT3 SEG10 CTED2 ECCP2 P2A	45	I/O I 0 I/O 0	TTL ST Analog ST ST —	Digital I/O. External Interrupt 3. SEG10 output for LCD. CTMU Edge 2 input. Capture 2 input/Compare 2 output/PWM2. Enhanced PWM2 Output A.
RB4/KBI0/SEG11 RB4 KBI0 SEG11	44	I/O I O	TTL TTL Analog	Digital I/O. Interrupt-on-change pin. SEG11 output for LCD.
RB5/KBI1/SEG29/T3CKI/ T1G RB5 KBI1 SEG29 T3CKI T1G	43	I/O 0 	TTL TTL Analog ST ST	Digital I/O. Interrupt-on-change pin. SEG29 output for LCD. Timer3 clock input. Timer1 external clock gate input.
RB6/KBI2/PGC RB6 KBI2 PGC	42	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP™ programming clock pin
RB7/KBI3/PGD RB7 KBI3 PGD	37	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP programming data pin.
ST = Schm I = Input P = Powe $I^2C^{TM} = I^2C/SI$	MBus	t with (CMOS = CMOS compatible input or output els Analog = Analog input O = Output OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

查询PIC18F67K90供应商 TABLE 1-3: PIC18F6XK90 PINOLIT I/O DESCRIPTIONS (CONTINUED)

TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)					
Pin Name	QFN/TQFP	Pin Type	Buffer Type	Description	
				PORTC is a bidirectional I/O port.	
RC0/SOSCO/SCLKI RC0 SOSCO SCLKI	30	I/O O I	ST — ST	Digital I/O. SOSC oscillator output. Digital SOSC input.	
RC1/SOSCI/ECCP2/P2A/ SEG32	29				
RC1 SOSCI ECCP2 ⁽¹⁾ P2A SEG32		I/O I I/O O O	ST CMOS ST — Analog	Digital I/O. SOSC oscillator input. Capture 2 input/Compare 2 output/PWM2 output. Enhanced PWM2 Output A. SEG32 output for LCD.	
RC2/ECCP1/P1A/SEG13 RC2 ECCP1 P1A SEG13	33	I/O I/O O O	ST ST — Analog	Digital I/O. Capture 1 input/Compare 1 output/PWM1 output. Enhanced PWM1 Output A. SEG13 output for LCD.	
RC3/SCK1/SCL1/SEG17 RC3 SCK1 SCL1 SEG17	34	I/O I/O I/O O	ST ST I ² C Analog	Digital I/O. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I ² C™ mode. SEG17 output for LCD.	
RC4/SDI1/SDA1/SEG16 RC4 SDI1 SDA1 SEG16	35	I/O I I/O O	ST ST I ² C Analog	Digital I/O. SPI data in. I ² C data I/O. SEG16 output for LCD.	
RC5/SDO1/SEG12 RC5 SDO1 SEG12	36	I/O O O	ST — Analog	Digital I/O. SPI data out. SEG12 output for LCD.	
RC6/TX1/CK1/SEG27 RC6 TX1 CK1 SEG27	31	I/O O I/O O	ST — ST Analog	Digital I/O. EUSART asynchronous transmit. EUSART synchronous clock (see related RX1/DT1). SEG27 output for LCD.	
RC7/RX1/DT1/SEG28 RC7 RX1 DT1 SEG28	32	I/O I I/O O	ST ST ST Analog	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX1/CK1). SEG28 output for LCD.	
	ompatible inpu itt Trigger input		CMOS lev	CMOS = CMOS compatible input or output els Analog = Analog input	
$I = Input$ $P = Powe$ $I^2 C^{TM} = I^2 C/SI$	r			O = Output OD = Open-Drain (no P diode to VDD)	

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

查询PIC18F67K90供应商

TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number QFN/TQFP			Description
Pin Name				Description
				PORTD is a bidirectional I/O port.
RD0/SEG0/CTPLS RD0 SEG0 CTPLS	58	I/O O O	ST Analog —	Digital I/O. SEG0 output for LCD. CTMU pulse generator output.
RD1/SEG1/T5CKI/T7G RD1 SEG1 T5CKI T7G	55	I/O O I I	ST Analog ST ST	Digital I/O. SEG1 output for LCD. Timer5 clock input. Timer7 external clock gate input.
RD2/SEG2 RD2 SEG2	54	I/O O	ST Analog	Digital I/O. SEG2 output for LCD.
RD3/SEG3 RD3 SEG3	53	I/O O	ST Analog	Digital I/O. SEG3 output for LCD.
RD4/SEG4/SDO2 RD4 SEG4 SDO2	52	I/O O O	ST Analog —	Digital I/O. SEG4 output for LCD. SPI data out.
RD5/SEG5/SDI2/SDA2 RD5 SEG5 SDI2 SDA2	51	I/O O I I/O	ST Analog ST I ² C	Digital I/O. SEG5 output for LCD. SPI data in. I ² C™ data I/O.
RD6/SEG6/SCK2/SCL2 RD6 SEG6 SCK2 SCL2	50	I/O O I/O I/O	ST Analog ST I ² C	Digital I/O. SEG6 output for LCD. Synchronous serial clock. Synchronous serial clock for I ² C mode.
RD7/SEG7/SS2 RD7 SEG7 SS2	49	I/O O I	ST Analog TTL	Digital I/O. SEG7 output for LCD. SPI slave select input.
	er		CMOS lev	CMOS = CMOS compatible input or output Analog = Analog input O = Output OD = Open-Drain (no P diode to VDD)

 $I^2C^{TM} = I^2C/SMBus$

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

查询PIC18F67K90供应商 TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Din Nama	Pin Number	Pin	Buffer Type	Description
Pin Name	QFN/TQFP	Туре		Description
				PORTE is a bidirectional I/O port.
RE0/LCDBIAS1/P2D RE0 LCDBIAS1 P2D	2	I/O I O	ST Analog —	Digital I/O. BIAS1 input for LCD. EECP2 PWM Output D.
RE1/LCDBIAS2/P2C RE1 LCDBIAS2 P2C	1	I/O I O	ST Analog —	Digital I/O. BIAS2 input for LCD. ECCP2 PWM Output C.
RE2/LCDBIAS3/P2B/ CCP10 RE2 LCDBIAS3 P2B CCP10 ⁽³⁾	64	I/O I O I/O	ST Analog — S/T	Digital I/O. BIAS3 input for LCD. ECCP2 PWM Output B. Capture 10 input/Compare 10 output/PWM10 output.
RE3/COM0/P3C/CCP9/ REFO RE3 COM0 P3C CCP9 ⁽³⁾ REFO	63	I/O O O I/O O	ST Analog — S/T —	Digital I/O. COM0 output for LCD. ECCP3 PWM Output C. Capture 9 input/Compare 9 output/PWM9 output. Reference clock out.
RE4/COM1/P3B/CCP8 RE4 COM1 P3B CCP8	62	I/O O O I/O	ST Analog — S/T	Digital I/O. COM1 output for LCD. ECCP3 PWM Output B. Capture 8 input/Compare 8 output/PWM8 output.
RE5/COM2/P1C/CCP7 RE5 COM2 P1C CCP7	61	I/O O O I/O	ST Analog — S/T	Digital I/O. COM2 output for LCD. ECCP1 PWM Output C. Capture 7 input/Compare 7 output/PWM7 output.
RE6/COM3/P1B/CCP6 RE6 COM3 P1B CCP6	60	I/O O O I/O	ST Analog — S/T	Digital I/O. COM3 output for LCD. ECCP1 PWM Output B. Capture 6 input/Compare 6 output/PWM6 output.
RE7/ECCP2/SEG31/P2A RE7 ECCP2 ⁽²⁾ SEG31 P2A	59	I/O I/O O	ST ST Analog —	Digital I/O. Capture 2 input/Compare 2 output/PWM2 output. SEG31 Output for LCD. ECCP2 PWM output A.
			CMOS lev	CMOS = CMOS compatible input or output Analog = Analog input O = Output OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

查询PIC18F67K90供应商

TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description
Fill Name	QFN/TQFP	Туре	Туре	Description
				PORTF is a bidirectional I/O port.
RF1/AN6/C2OUT/SEG19/	17			
CTDIN				
RF1		I/O	ST	Digital I/O.
AN6			Analog	Analog Input 6.
C2OUT SEG19		0 0	 Analog	Comparator 2 output. SEG19 output for LCD.
CTDIN		Î	ST	CTMU pulse delay input.
RF2/AN7/C1OUT/SEG20	16		-	
RF2	10	I/O	ST	Digital I/O.
AN7		1	Analog	Analog Input 7.
C1OUT		0	—	Comparator 1 output.
SEG20		0	Analog	SEG20 output for LCD.
RF3/AN8/SEG21/C2INB/	15			
CTMUI				
RF3		I/O	ST	Digital I/O.
AN8			Analog	Analog Input 8.
SEG21 C2INB		0	Analog Analog	SEG21 output for LCD. Comparator 2 Input B.
CTMUI		0		CTMU pulse generator charger for the C2INB
		Ŭ		comparator input.
RF4/AN9/SEG22/C2INA	14			
RF4		I/O	ST	Digital I/O.
AN9		I.	Analog	Analog Input 9.
SEG22		0	Analog	SEG22 output for LCD
C2INA		I	Analog	Comparator 2 Input A.
RF5/AN10/CVREF/	13			
SEG23/C1INB				
RF5		I/O	ST	Digital I/O.
AN10 CVREF		0	Analog Analog	Analog Input 10. Comparator reference voltage output.
SEG23		0	Analog	SEG23 output for LCD.
C1INB		Ĩ	Analog	Comparator 1 Input B.
RF6/AN11/SEG24/C1INA	12		-	
RF6	12	I/O	ST	Digital I/O.
AN11		I.	Analog	Analog Input 11.
SEG24		0	Analog	SEG24 output for LCD
C1INA		I	Analog	Comparator 1 Input A.
RF7/AN5/SS1/SEG25	11			
RF7		I/O	ST	Digital I/O.
<u>AN5</u>		0	AnalogT	Analog Input 5.
SS1 SEG25			TL Analog	SPI1 slave select input. SEG25 output for LCD.
	l compatible inpu	-	лаюу	CMOS = CMOS compatible input or output
	itt Trigger inpu		CMOS lev	
I = Input				O = Output
P = Powe				OD = Open-Drain (no P diode to VDD)
I ² C™ = I ² C/SI	MBus			

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

查询PIC18F67K90供应商 TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

	Pin Number	Pin Buffer	Description		
Pin Name	QFN/TQFP	Туре	Туре	Description	
				PORTG is a bidirectional I/O port.	
RG0/ECCP3/P3A RG0 ECCP3 P3A	3	I/O I/O O	ST ST	Digital I/O. Capture 3 input/Compare 3 output/PWM3 output. ECCP3 PWM Output A.	
RG1/TX2/CK2/AN19/ C3OUT	4				
RG1 TX2 CK2 AN19 C3OUT		I/O O I/O I O	ST — ST Analog —	Digital I/O. USART asynchronous transmit. USART synchronous clock (see related RX2/DT2). Analog Input 19. Comparator 3 output.	
RG2/RX2/DT2/AN18/	5				
C3INA RG2 RX2 DT2 AN18 C3INA		I/O /O 	ST ST ST Analog Analog	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX2/CK2). Analog Input 18. Comparator 3 Input A.	
RG3/CCP4/AN17/P3D/ C3INB	6				
RG3 CCP4 AN17 P3D C3INB		I/O I/O I O I	ST S/T Analog — Analog	Digital I/O. Capture 4 input/Compare 4 output/PWM4 output. Analog Input 18. ECCP3 PWM Output D. Comparator 3 Input B.	
RG4/SEG26/RTCC/ T7CKI/T5G/CCP5/AN16/ P1D/C3INC	8				
RG4 SEG26 RTCC T7CKI ⁽³⁾ T5G CCP5 AN16 P1D C3INC		/0 0 /0 0 	ST Analog — ST ST ST Analog — Analog	Digital I/O. SEG26 output for LCD. RTCC output Timer7 clock input. Timer5 external clock gate input. Capture 5 input/Compare 5 output/PWM5 output. Analog Input 16. ECCP1 PWM Output D. Comparator 3 Input C.	
RG5	7			See the MCLR/RG5 pin.	

I = Input P = Power

 $I^2C^{TM} = I^2C/SMBus$

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

OD

= Open-Drain (no P diode to VDD)

查询PIC18F67K90供应商

TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description	
	QFN/TQFP	Туре	Туре Туре	Description	
Vss	9, 25, 41, 56	Р	_	Ground reference for logic and I/O pins.	
Vdd	26, 38, 57	Р	_	Positive supply for logic and I/O pins.	
AVss	20	Р	_	Ground reference for analog modules.	
AVDD	19	Р	_	Positive supply for analog modules.	
ENVREG	18	Ι	ST	Enable for on-chip voltage regulator.	
Vddcore/Vcap Vddcore Vcap	10	Р	_	Core logic power or external filter capacitor connection. External filter capacitor connection (regulator enabled/disabled).	
Legend:TTL=TTL compatible inputCMOS=CMOS compatible input or outputST=Schmitt Trigger input with CMOS levelsAnalog=Analog inputI=InputO=Output					

= Power

Ρ $I^2C^{TM} = I^2C/SMBus$

OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number	Pin	Buffer	Description
Fill Name	TQFP	Туре Туре		Description
MCLR/RG5	9			
		I	ST	Master Clear (input) or programming voltage (input).
				This pin is an active-low Reset to the device.
RG5		I	ST	General purpose, input only pin.
OSC1/CLKI/RA7	49			Oscillator crystal or external clock input.
OSC1		I	CMOS	Oscillator crystal input.
CLKI		I.	CMOS	External clock source input. Always associated
				with pin function, OSC1. (See related OSC1/CLKI,
				OSC2/CLKO pins.)
RA7		I/O	TTL	General purpose I/O pin.
OSC2/CLKO/RA6	50			Oscillator crystal or clock output.
OSC2		0	—	Oscillator crystal output. Connects to crystal or
				resonator in Crystal Oscillator mode.
CLKO		0	—	In certain oscillator modes, OSC2 pin outputs CLKO,
				which has 1/4 the frequency of OSC1 and denotes the
				instruction cycle rate.
RA6		I/O	TTL	General purpose I/O pin.
Legend: TTL = TTL co	mpatible input			CMOS = CMOS compatible input or output
ST = Schmi	tt Trigger input	with C	MOS leve	els Analog = Analog input
I = Input				O = Output
P = Power				OD = Open-Drain (no P diode to VDD)
I ² C™ = I ² C/SN	1Bus			

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

查询PIC18F67K90供应商 TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Pin Buffer	Description	
	TQFP	Туре	Туре	Description	
				PORTA is a bidirectional I/O port.	
RA0/AN0/ULPWU RA0 AN0 ULPWU	30	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 0. Ultra low-power wake-up input.	
RA1/AN1/SEG18 RA1 AN1 SEG18	29	I/O I O	TTL Analog Analog	Digital I/O. Analog Input 1. SEG18 output for LCD.	
RA2/AN2/VREF- RA2 AN2 VREF-	28	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 2. A/D reference voltage (low) input.	
RA3/AN3/VREF+ RA3 AN3 VREF+	27	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 3. A/D reference voltage (high) input.	
RA4/T0CKI/SEG14 RA4 T0CKI SEG14	34	I/O I O	ST ST Analog	Digital I/O. Timer0 external clock input. SEG14 output for LCD.	
RA5/AN4/SEG15/T1CKI/ T3G/HLVDIN RA5 AN4 SEG15 T1CKI T3G HLVDIN	33	I/O I O I I	TTL Analog Analog ST ST Analog	Digital I/O. Analog Input 4. SEG15 output for LCD. Timer1 clock input. Timer3 external clock gate input. High/Low-Voltage Detect (HLVD) input.	
RA6				See the OSC2/CLKO/RA6 pin.	
RA7				See the OSC1/CLKI/RA7 pin.	
Image: RA7See the OSC1/CLK/RA7 pin.Legend:TTL = TTL compatible inputCMOS = CMOS compatible input or outputST = Schmitt Trigger input with CMOS levelsAnalog = Analog inputI = InputO = OutputP = PowerOD = Open-Drain (no P diode to VDD) $I^2C^{TM} = I^2C/SMBus$ Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set					

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

查询PIC18F67K90供应商

TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description		
Fill Name	TQFP	Туре	Туре	Description		
				PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.		
RB0/INT0/SEG30/FLT0 RB0 INT0 SEG30 FLT0	58	I/O I O I	TTL ST Analog ST	Digital I/O. External Interrupt 0. SEG30 output for LCD. Enhanced PWM Fault input for ECCP1/2/3.		
RB1/INT1/SEG8 RB1 INT1 SEG8	57	I/O I O	TTL ST Analog	Digital I/O. External Interrupt 1. SEG8 output for LCD.		
RB2/INT2/SEG9/CTED1 RB2 INT2 SEG9 CTED1	56	I/O I O I	TTL ST Analog ST	Digital I/O. External Interrupt 2. SEG9 output for LCD. CTMU Edge 1 input.		
RB3/INT3/SEG10/ CTED2/ECCP2/P2A RB3 INT3 SEG10 CTED2 ECCP2 P2A	55	I/O I 0 I I/O 0	TTL ST Analog ST ST ST	Digital I/O. External Interrupt 3. SEG10 output for LCD. CTMU Edge 2 input. Capture 2 input/Compare 2 output/PWM2 output. Enhanced PWM 2 Output A.		
RB4/KBI0/SEG11 RB4 KBI0 SEG11	54	I/O I O	TTL TTL Analog	Digital I/O. Interrupt-on-change pin. SEG11 output for LCD.		
RB5/KBI1/SEG29/T3CKI/ T1G RB5 KBI1 SEG29 T3CKI T1G	53	I/O I O I	TTL TTL Analog ST ST	Digital I/O. Interrupt-on-change pin. SEG29 output for LCD. Timer3 clock input. Timer1 external clock gate input.		
Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output ST = Schmitt Trigger input with CMOS levels Analog = Analog input I = Input O = Output P = Power OD = Open-Drain (no P diode to VDD)						

P = Power $I^2C^{TM} = I^2C/SMBus$

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

Pin Name	Pin Number	Pin	Buffer	Description		
Fill Name	TQFP	Туре	Туре	Description		
RB6/KBI2/PGC	52					
RB6		I/O	TTL	Digital I/O.		
KBI2		I	TTL	Interrupt-on-change pin.		
PGC		I/O	ST	In-Circuit Debugger and ICSP™ programming clock p		
RB7/KBI3/PGD	47					
RB7		I/O	TTL	Digital I/O.		
KBI3		I	TTL	Interrupt-on-change pin.		
PGD		I/O	ST	In-Circuit Debugger and ICSP programming data pin.		
Legend: TTL = TTL c	ompatible input			CMOS = CMOS compatible input or output		
ST = Schmitt Trigger input with CMOS levels Analog = Analog input						
I = Input				O = Output		
P = Powe	r			OD = Open-Drain (no P diode to VDD)		
$I^2 C^{TM} = I^2 C/S$	MBus					

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

查询PIC18F67K90供应商

TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description		
Fill Name	TQFP	Туре	Туре	Description		
				PORTC is a bidirectional I/O port.		
RC0/SOSCO/SCKLI RC0 SOSCO SCKLI	36	I/O O I	ST — ST	Digital I/O. SOSC oscillator output. Digital SOSC input.		
RC1/SOSCI/ECCP2/ SEG32/P2A RC1 SOSCI ECCP2 ⁽¹⁾ SEG32 P2A	35	I/O I I/O O	ST CMOS ST Analog —	Digital I/O. SOSC oscillator input. Capture 2 input/Compare 2 output/PWM2 output. SEG32 output for LCD. Enhanced PWM 2 Output A.		
RC2/ECCP1/P1A/SEG13 RC2 ECCP1 P1A SEG13	43	I/O I/O O	ST ST — Analog	Digital I/O. Capture 1 input/Compare 1 output/PWM1 output. Enhanced PWM 1 Output A. SEG13 output for LCD.		
RC3/SCK1/SCL1/SEG17 RC3 SCK1 SCL1 SEG17	44	I/O I/O I/O O	ST ST ST Analog	Digital I/O. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I ² C™ mode. SEG17 output for LCD.		
RC4/SDI1/SDA1/SEG16 RC4 SDI1 SDA1 SEG16	45	I/O I I/O O	ST ST ST Analog	Digital I/O. SPI data in. I ² C data I/O. SEG16 output for LCD.		
RC5/SDO1/SEG12 RC5 SDO1 SEG12	46	I/O O O	ST Analog	Digital I/O. SPI data out. SEG12 output for LCD.		
RC6/TX1/CK1/SEG27 RC6 TX1 CK1 SEG27	37	I/O O I/O O	ST — ST Analog	Digital I/O. EUSART asynchronous transmit. EUSART synchronous clock (see related RX1/DT1). SEG27 output for LCD.		
RC7/RX1/DT1/SEG28 RC7 RX1 DT1 SEG28	38	I/O I I/O O	ST ST ST Analog	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX1/CK1). SEG28 output for LCD.		
Legend:TTL= TTL compatible inputCMOS= CMOS compatible input or outputST= Schmitt Trigger input with CMOS levelsAnalog= Analog inputI= InputO= OutputP= PowerOD= Open-Drain (no P diode to VDD) $l^2C^{TM} = l^2C/SMBus$ II						

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

查询PIC18F67K90供应商 TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name Pin Number	Pin	Buffer	Description			
Fininaine	TQFP	Туре	Туре	Description		
				PORTD is a bidirectional I/O port.		
RD0/SEG0/CTPLS RD0 SEG0 CTPLS	72	I/O O O	ST Analog ST	Digital I/O. SEG0 output for LCD. CTMU pulse generator output.		
RD1/SEG1/T5CKI/T7G RD1 SEG1 T5CKI T7G	69	I/O O I I	ST Analog ST ST	Digital I/O. SEG1 output for LCD. Timer5 clock input. Timer7 external clock gate input.		
RD2/SEG2 RD2 SEG2	68	I/O O	ST Analog	Digital I/O. SEG2 output for LCD.		
RD3/SEG3 RD3 SEG3	67	I/O O	ST Analog	Digital I/O. SEG3 output for LCD.		
RD4/SEG4/SDO2 RD4 SEG4 SDO2	66	I/O O O	ST Analog —	Digital I/O. SEG4 output for LCD. SPI data out.		
RD5/SEG5/SDI2/SDA2 RD5 SEG5 SDI2 SDA2	65	I/O O I I/O	ST Analog ST I ² C	Digital I/O. SEG5 output for LCD. SPI data in. I ² C™ data in.		
RD6/SEG6/SCK2/SCL2 RD6 SEG6 SCK2 SCL2	64	I/O O I/O I/O	ST Analog ST I ² C	Digital I/O. SEG6 output for LCD. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I ² C™ mode.		
RD7/SEG7/ SS2 RD7 <u>SEG</u> 7 SS2	63	I/O O I	ST Analog TTL	Digital I/O. SEG7 output for LCD. SPI slave select input.		
Legend:TTLTTL compatible inputCMOS= CMOS compatible inputST= Schmitt Trigger input with CMOS levelsAnalog= Analog inputI= InputO= OutputP= PowerOD= Open-Drain (no P diode to VDD) $I^2C^{TM} = I^2C/SMBus$ II						

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

查询PIC18F67K90供应商

TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Buffer		Description		
Pin Name	TQFP	Туре	Туре	Description		
				PORTE is a bidirectional I/O port.		
RE0/LCDBIAS1/P2D RE0 LCDBIAS1 P2D	4	I/O I O	ST Analog —	Digital I/O. BIAS1 input for LCD. ECCP2 PWM Output D.		
RE1/LCDBIAS2/P2C RE1 LCDBIAS2 P2C	3	I/O I O	ST Analog —	Digital I/O. BIAS2 input for LCD. ECCP2 PWM Output C.		
RE2/LCDBIAS3/P2B/ CCP10 RE2 LCDBIAS3 P2B CCP10 ⁽³⁾	78	I/O I O I/O	ST Analog ST ST	Digital I/O. BIAS3 input for LCD. ECCP2 PWM Output B. Capture 10 input/Compare 10 output/PWM10 output.		
RE3/COM0/P3C/CCP9/ REFO RE3 COM0 P3C CCP9 ⁽⁴⁾ REFO	77	I/O O I/O O	ST Analog — S/T —	Digital I/O. COM0 output for LCD. ECCP3 PWM Output C. Capture 9 input/Compare 9 output/PWM9 output. Reference clock out.		
RE4/COM1/P3B/CCP8 RE4 COM1 P3B CCP8 ⁽⁴⁾	76	I/O O O I/O	ST Analog — ST	Digital I/O. COM1 output for LCD. ECCP4 PWM Output B. Capture 8 input/Compare 8 output/PWM8 output.		
RE5/COM2/P1C/CCP7 RE5 COM2 P1C CCP7 ⁽⁴⁾	75	I/O O O I/O	ST Analog — ST	Digital I/O. COM2 output for LCD. ECCP1 PWM Output C. Capture 7 input/Compare 7 output/PWM7 output.		
RE6/COM3/P1B/CCP6 RE6 COM3 P1B CCP6 ⁽⁴⁾	74	I/O O O I/O	ST Analog — ST	Digital I/O. COM3 output for LCD. ECCP1 PWM Output B. Capture 6 input/Compare 6 output/PWM6 output.		
RE7/ECCP2/P2A/SEG31 RE7 ECCP2 ⁽²⁾ P2A SEG31	73	I/O I/O O	ST ST — Analog	Digital I/O. Capture 2 input/Compare 2 output/PWM2 output. ECCP2 PWM Output A. SEG31 output for LCD.		
SEG31OAnalogSEG31 output for LCD.Legend:TTL = TTL compatible inputCMOS= CMOS compatible input or outputST = Schmitt Trigger input with CMOS levelsAnalog= Analog inputIInputO= OutputP= PowerOD= Open-Drain (no P diode to VDD) $l^2 C^{TM} = l^2 C/SMBus$ Note 1:Default assignment for ECCP2 when the CCP2MX Configuration bit is set.						

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

查询PIC18F67K90供应商 PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED) TABLE 1-4

Pin Name	Pin Number	Pin	Buffer	Description		
FIII Naille	TQFP	Туре	Туре	Description		
RF1/AN6/C2OUT/SEG19/	23			PORTF is a bidirectional I/O port.		
CTDIN RF1 AN6 C2OUT SEG19 CTDIN	23	I/O I O I	ST Analog — Analog ST	Digital I/O. Analog Input 6. Comparator 2 output. SEG19 output for LCD. CTMU pulse delay input.		
RF2/AN7/C1OUT/ SEG20/CTMUI RF2 AN7 C1OUT SEG20 CTMUI	18	I/O I O O	ST Analog — Analog —	Digital I/O. Analog Input 7. Comparator 1 output. SEG20 output for LCD. CTMU pulse generator charger for the C2INB comparator input.		
RF3/AN8/SEG21/C2INB RF3 AN8 SEG21 C2INB	17	I/O I O I	ST Analog Analog Analog	Digital I/O. Analog Input 8. SEG21 output for LCD. Comparator 2 Input B.		
RF4/AN9/SEG22/C2INA RF4 AN9 SEG22 C2INA	16	I/O I O I	ST Analog Analog Analog	Digital I/O. Analog Input 9. SEG22 output for LCD. Comparator 2 Input A.		
RF5/AN10/CVREF/ SEG23/C1INB RF5 AN10 CVREF SEG23 C1INB	15	I/O I O I	ST Analog Analog Analog Analog	Digital I/O. Analog Input 10. Comparator reference voltage output. SEG23 output for LCD. Comparator 1 Input B.		
RF6/AN11/SEG24/C1INA RF6 AN11 SEG24 C1INA	14	I/O I O I	ST Analog Analog Analog	Digital I/O. Analog Input 11. SEG24 output for LCD. Comparator 1 Input A.		
RF7/AN5/SS1/SEG25 RF7 <u>AN5</u> SS1 SEG25	13	I/O O I O	ST Analog TTL Analog	Digital I/O. Analog Input 5. SPI slave select input. SEG25 output for LCD.		
Legend:TTL= TTL compatible inputCMOS= CMOS compatible input or outputST= Schmitt Trigger input with CMOS levelsAnalog= Analog inputI= InputO= OutputP= PowerOD= Open-Drain (no P diode to VDD)						

 $I^2C^{TM} = I^2C/SMBus$

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

查询PIC18F67K90供应商

TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description		
Fill Name	TQFP	Туре	Туре	Description		
				PORTG is a bidirectional I/O port.		
RG0/ECCP3/P3A RG0 ECCP3 P3A	5	I/O I/O O	ST ST	Digital I/O. Capture 3 input/Compare 3 output/PWM3 output. ECCP3 PWM Output A.		
RG1/TX2/CK2/AN19/ C3OUT RG1 TX2 CK2 AN19 C3OUT	6	I/O O I/O I O	ST — ST Analog —	Digital I/O. EUSART asynchronous transmit. EUSART synchronous clock (see related RX2/DT2). Analog Input 19. Comparator 3 output.		
RG2/RX2/DT2/AN18/ C3INA RG2 RX2 DT2 AN18 C3INA	7	I/O /O 	ST ST ST Analog Analog	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX2/CK2). Analog Input 18. Comparator 3 Input A.		
RG3/CCP4/AN17/P3D/ C3INB RG3 CCP4 AN17 P3D C3INB	8	I/O I/O I O I	ST ST Analog — Analog	Digital I/O. Capture 4 input/Compare 4 output/PWM4 output. Analog Input 17. ECCP3 PWM Output D. Comparator 3 Input B.		
RG4/SEG26/RTCC/ T7CKI/T5G/CCP5/AN16/ P1D/C3INC RG4 SEG26 RTCC T7CKI ⁽³⁾ T5G CCP5 AN16 P1D C3INC	10	1/0 0 I I 1/0 I	ST Analog — ST ST ST Analog — Analog	Digital I/O. SEG26 output for LCD. RTCC output. Timer7 clock input. Timer5 external clock gate input. Capture 5 input/Compare 5 output/PWM5 output. Analog Input 16. ECCP1 PWM Output D. Comparator 3 Input C.		
RG5	9			See the MCLR/RG5 pin.		
RG59See the MCLR/RG5 pin.Legend:TTL = TTL compatible inputCMOS = CMOS compatible input or outputST = Schmitt Trigger input with CMOS levelsAnalog = Analog inputI = InputO = OutputP = PowerOD = Open-Drain (no P diode to VDD) $I^2C^{TM} = I^2C/SMBus$ OD = Open-Drain (no P diode to VDD)						

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

查询PIC18F67K90供应商 TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

TABLE 1-4: PIC18F		1		RIPTIONS (CONTINUED)		
Pin Name	Pin Number	FIII		Description		
	TQFP	Туре	Туре			
				PORTH is a bidirectional I/O port.		
RH0/SEG47/AN23 RH0 SEG47 AN23	79	I/O O I	ST Analog Analog	Digital I/O. SEG47 output for LCD. Analog Input 23.		
RH1/SEG46/AN22 RH1 SEG46 AN22	80	I/O O I	ST Analog Analog	Digital I/O. SEG46 output for LCD. Analog Input 22.		
RH2/SEG45/AN21 RH2 SEG45 AN21	1	I/O O I	ST Analog Analog	Digital I/O. SEG45 output for LCD. Analog Input 21.		
RH3/SEG44/AN20 RH3 SEG44 AN20	2	I/O O I	ST Analog Analog	Digital I/O. SEG44 output for LCD. Analog Input 20.		
RH4/SEG40/CCP9/P3C/ AN12/C2INC RH4 SEG40 CCP9 ⁽⁴⁾ P3C AN12 C2INC	22	I/O O I/O O I	ST Analog ST — Analog Analog	Digital I/O. SEG40 output for LCD. Capture 9 input/Compare 9 output/PWM9 output. ECCP3 PWM Output C. Analog Input 12. Comparator 2 Input C.		
RH5/SEG41/CCP8/P3B/ AN13/C2IND RH5 SEG41 CCP8 ⁽⁴⁾ P3B AN13 C2IND	21	I/O O I/O I I	ST Analog ST — Analog Analog	Digital I/O. SEG41 output for LCD. Capture 8 input/Compare 8 output/PWM8 output. ECCP3 PWM Output B. Analog Input 13. Comparator 1 Input D.		
RH6/SEG42/CCP7/P1C/ AN14/C1INC RH6 SEG42 CCP7 ⁽⁴⁾ P1C AN14 C1INC Legend: TTL = TTL co	20	I/O O I/O O I I	ST Analog ST — Analog Analog	Digital I/O. SEG42 output for LCD. Capture 7 input/Compare 7 output/PWM7 output. ECCP1 PWM Output C. Analog Input 14. Comparator 1 Input C. CMOS = CMOS compatible input or output		
Legend:TTL= TTL compatible inputCMOS= CMOS compatible input or outputST= Schmitt Trigger input with CMOS levelsAnalog= Analog inputI= InputO= OutputP= PowerOD= Open-Drain (no P diode to VDD) l^2C^{TM} = $l^2C/SMBus$ OD= Open-Drain (no P diode to VDD)						

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

查询PIC18F67K90供应商

TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description
	TQFP	Туре	Туре	Description
RH7/SEG43/CCP6/P1B/ AN15	19			
RH7		I/O	ST	Digital I/O.
SEG43		0	Analog	SEG43 output for LCD.
CCP6 ⁽⁴⁾		I/O	ST	Capture 6 input/Compare 6 output/PWM6 output.
P1B		0	—	ECCP1 PWM Output B.
AN15		I	Analog	Analog Input 15.
Legend: TTL = TTL co	mpatible input			CMOS = CMOS compatible input or output
ST = Schmit	t Trigger input	with C	MOS level	s Analog = Analog input
I = Input				O = Output
$P = Power$ $I^2 C^{TM} = I^2 C/SN$				OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

查询PIC18F67K90供应商 TABLE 1-4: PIC18F8XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTJ is a bidirectional I/O port.
RJ0	62	I/O	ST	Digital I/O.
RJ1/SEG33 RJ1 SEG33	61	I/O O	ST Analog	Digital I/O. SEG33 output for LCD.
RJ2/SEG34 RJ2 SEG34	60	I/O O	ST Analog	Digital I/O. SEG34 output for LCD.
RJ3/SEG35 RJ3 SEG35	59	I/O O	ST Analog	Digital I/O. SEG35 output for LCD.
RJ4/SEG39 RJ4 SEG39	39	I/O O	ST Analog	Digital I/O. SEG39 output for LCD.
RJ5/SEG38 RJ5 SEG38	40	I/O O	ST Analog	Digital I/O SEG38 output for LCD.
RJ6/SEG37 RJ6 SEG37	41	I/O O	ST Analog	Digital I/O. SEG37 output for LCD.
RJ7/SEG36 RJ7 SEG36	42	I/O O	ST Analog	Digital I/O. SEG36 output for LCD.
Vss	11, 31, 51, 70	Ρ	—	Ground reference for logic and I/O pins.
Vdd	32, 48, 71	Р	—	Positive supply for logic and I/O pins.
AVss	26	Р	—	Ground reference for analog modules.
AVDD	25	P	_	Positive supply for analog modules.
ENVREG	24	I	ST	Enable for on-chip voltage regulator.
VDDCORE/VCAP VDDCORE	12			Core logic power or external filter capacitor connection.
VCAP		Ρ	_	External filter capacitor connection (regulator enabled/disabled).
	er	with C	MOS leve	CMOS = CMOS compatible input or output

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商

2.0 GUIDELINES FOR GETTING STARTED WITH PIC18FXXKXX MICROCONTROLLERS

2.1 Basic Connection Requirements

Getting started with the PIC18F87K90 family family of 8-bit microcontrollers requires attention to a minimal set of device pin connections before proceeding with development.

The following pins must always be connected:

- All VDD and Vss pins (see Section 2.2 "Power Supply Pins")
- All AVDD and AVss pins, regardless of whether or not the analog device features are used (see Section 2.2 "Power Supply Pins")
- MCLR pin
 (see Section 2.3 "Master Clear (MCLR) Pin")
- ENVREG (if implemented) and VCAP/VDDCORE pins (see Section 2.4 "Voltage Regulator Pins (ENVREG and VCAP/VDDCORE)")

These pins must also be connected if they are being used in the end application:

- PGC/PGD pins used for In-Circuit Serial Programming[™] (ICSP[™]) and debugging purposes (see **Section 2.5 "ICSP Pins**")
- OSCI and OSCO pins when an external oscillator source is used

(see Section 2.6 "External Oscillator Pins")

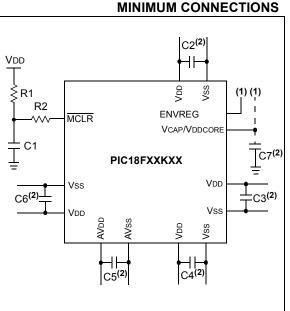
Additionally, the following pins may be required:

• VREF+/VREF- pins are used when external voltage reference for analog modules is implemented

Note: The AVDD and AVss pins must always be connected, regardless of whether any of the analog modules are being used.

The minimum mandatory connections are shown in Figure 2-1.

FIGURE 2-1: RECOMMENDED



Key (all values are recommendations):

C1 through C6: 0.1 $\mu\text{F},$ 20V ceramic R1: 10 k Ω

R2: 100Ω to 470Ω

- Note 1: See Section 2.4 "Voltage Regulator Pins (ENVREG and VCAP/VDDCORE)" for explanation of ENVREG pin connections.
 - 2: The example shown is for a PIC18F device with five VDD/VSS and AVDD/AVSS pairs. Other devices may have more or less pairs; adjust the number of decoupling capacitors appropriately.

查询PIC18F67K90供应商 2.2 Power Supply Pins

2.2.1 DECOUPLING CAPACITORS

The use of decoupling capacitors on every pair of power supply pins, such as VDD, VSS, AVDD and AVSS, is required.

Consider the following criteria when using decoupling capacitors:

- Value and type of capacitor: A 0.1 μ F (100 nF), 10-20V capacitor is recommended. The capacitor should be a low-ESR device, with a resonance frequency in the range of 200 MHz and higher. Ceramic capacitors are recommended.
- Placement on the printed circuit board: The decoupling capacitors should be placed as close to the pins as possible. It is recommended to place the capacitors on the same side of the board as the device. If space is constricted, the capacitor can be placed on another layer on the PCB using a via; however, ensure that the trace length from the pin to the capacitor is no greater than 0.25 inch (6 mm).
- Handling high-frequency noise: If the board is experiencing high-frequency noise (upward of tens of MHz), add a second ceramic type capacitor in parallel to the above described decoupling capacitor. The value of the second capacitor can be in the range of 0.01 μ F to 0.001 μ F. Place this second capacitor next to each primary decoupling capacitor. In high-speed circuit designs, consider implementing a decade pair of capacitances as close to the power and ground pins as possible (e.g., 0.1 μ F in parallel with 0.001 μ F).
- Maximizing performance: On the board layout from the power supply circuit, run the power and return traces to the decoupling capacitors first, and then to the device pins. This ensures that the decoupling capacitors are first in the power chain. Equally important is to keep the trace length between the capacitor and the power pins to a minimum, thereby reducing PCB trace inductance.

2.2.2 TANK CAPACITORS

On boards with power traces running longer than six inches in length, it is suggested to use a tank capacitor for integrated circuits, including microcontrollers, to supply a local power source. The value of the tank capacitor should be determined based on the trace resistance that connects the power supply source to the device, and the maximum current drawn by the device in the application. In other words, select the tank capacitor so that it meets the acceptable voltage sag at the device. Typical values range from 4.7 μ F to 47 μ F.

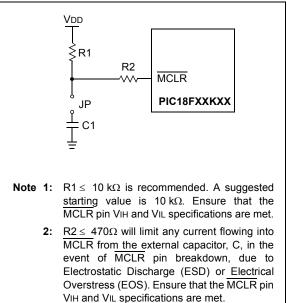
2.3 Master Clear (MCLR) Pin

The MCLR pin provides two specific device functions: Device Reset, and Device Programming and Debugging. If programming and debugging are not required in the end application, a direct connection to VDD may be all that is required. The addition of other components, to help increase the application's resistance to spurious Resets from voltage sags, may be beneficial. A typical configuration is shown in Figure 2-1. Other circuit designs may be implemented, depending on the application's requirements.

During programming and debugging, the resistance and capacitance that can be added to the pin must be considered. Device programmers and debuggers drive the MCLR pin. Consequently, specific voltage levels (VIH and VIL) and fast signal transitions must not be adversely affected. Therefore, specific values of R1 and C1 will need to be adjusted based on the application and PCB requirements. For example, it is recommended that the capacitor, C1, be isolated from the MCLR pin during programming and debugging operations by using a jumper (Figure 2-2). The jumper is replaced for normal run-time operations.

Any components associated with the $\overline{\text{MCLR}}$ pin should be placed within 0.25 inch (6 mm) of the pin.

FIGURE 2-2: EXAMPLE OF MCLR PIN CONNECTIONS



查询PIC18F67K90供应商

2.4 Voltage Regulator Pins (ENVREG and VCAP/VDDCORE)

The on-chip voltage regulator enable pin, ENVREG, must always be connected directly to either a supply voltage or to ground. Tying ENVREG to VDD enables the regulator, while tying it to ground disables the regulator. Refer to **Section 28.3 "On-Chip Voltage Regulator"** for details on connecting and using the on-chip regulator.

When the regulator is enabled, a low-ESR (< 5 Ω) capacitor is required on the VCAP/VDDCORE pin to stabilize the voltage regulator output voltage. The VCAP/VDDCORE pin must not be connected to VDD and must use a capacitor of 10 μ F connected to ground. The type can be ceramic or tantalum. A suitable example is the Murata GRM21BF50J106ZE01 (10 μ F, 6.3V) or equivalent. Designers may use Figure 2-3 to evaluate ESR equivalence of candidate devices.

It is recommended that the trace length not exceed 0.25 inch (6 mm). Refer to **Section 31.0 "Electrical Characteristics"** for additional information.

When the regulator is disabled, a 0.1 μ F capacitor should be connected from the VCAP/VDDCORE pin to ground. This capacitor's characteristics must be similar to those of the "decoupling" capacitors explained in **Section 2.2.1 "Decoupling Capacitors**". For details on the VDD requirement, when the regulator is disabled, see parameter D001 in **Section 31.0** "**Electrical Characteristics**".

Some PIC18FXXKXX families or some devices within a family do not provide the option of enabling or disabling the on-chip voltage regulator:

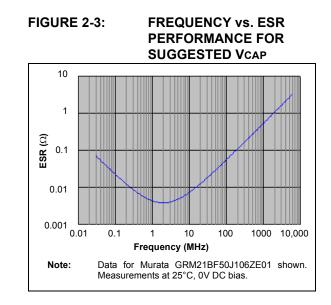
• Some devices (with the name, PIC18LFXXKXX) permanently disable the voltage regulator.

These devices' do not have the ENVREG pin and require a 0.1 μ F capacitor on the VCAP/VDDCORE pin. The VDD level of these devices must comply with the "voltage regulator disabled" specification for parameter D001, in **Section 31.0 "Electrical Characteristics"**.

• Some devices permanently enable the voltage regulator.

These devices also do not have the ENVREG pin. The 10μ F capacitor is still required on the VCAP/VDDCORE pin.

For details on all members of the PIC18F87K90 family, see **Section 28.3 "On-Chip Voltage Regulator"**.



2.5 ICSP Pins

The PGC and PGD pins are used for In-Circuit Serial ProgrammingTM (ICSPTM) and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of ohms, not to exceed 100 Ω .

Pull-up resistors, series diodes and capacitors on the PGC and PGD pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternatively, refer to the AC/DC characteristics and timing requirements information in the respective device Flash programming specification for information on capacitive loading limits, and pin input voltage high (VIH) and input low (VIL) requirements.

For device emulation, ensure that the "Communication Channel Select" (i.e., PGCx/PGDx pins) programmed into the device matches the physical connections for the ICSP to the Microchip debugger/emulator tool.

For more information on available Microchip development tools connection requirements, refer to **Section 30.0 "Development Support"**.

查询PIC18F67K90供应商 2.6 External Oscillator Pins

Many microcontrollers have options for at least two oscillators: a high-frequency primary oscillator and a low-frequency secondary oscillator (refer to **Section 3.0 "Oscillator Configurations"** for details).

The oscillator circuit should be placed on the same side of the board as the device. Place the oscillator circuit close to the respective oscillator pins with no more than 0.5 inch (12 mm) between the circuit components and the pins. The load capacitors should be placed next to the oscillator itself, on the same side of the board.

Use a grounded copper pour around the oscillator circuit to isolate it from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed.

Layout suggestions are shown in Figure 2-4. In-line packages may be handled with a single-sided layout that completely encompasses the oscillator pins. With fine-pitch packages, it is not always possible to completely surround the pins and components. A suitable solution is to tie the broken guard sections to a mirrored ground layer. In all cases, the guard trace(s) must be returned to ground.

In planning the application's routing and I/O assignments, ensure that adjacent port pins and other signals in close proximity to the oscillator are benign (i.e., free of high frequencies, short rise and fall times, and other similar noise).

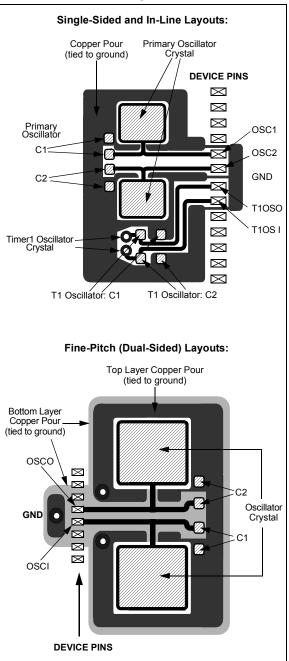
For additional information and design guidance on oscillator circuits, please refer to these Microchip Application Notes, available at the corporate web site (www.microchip.com):

- AN826, "Crystal Oscillator Basics and Crystal Selection for rfPIC[™] and PICmicro[®] Devices"
- AN849, "Basic PICmicro[®] Oscillator Design"
- AN943, "Practical PICmicro[®] Oscillator Analysis and Design"
- AN949, "Making Your Oscillator Work"

2.7 Unused I/Os

Unused I/O pins should be configured as outputs and driven to a logic low state. Alternatively, connect a 1 k Ω to 10 k Ω resistor to Vss on unused pins and drive the output to logic low.

FIGURE 2-4: SUGGESTED PLACEMENT OF THE OSCILLATOR CIRCUIT



查询PIC18F67K90供应商 3.0 OSCILLATOR CONFIGURATIONS

3.1 Oscillator Types

The PIC18F87K90 family of devices can be operated in the following oscillator modes:

- EC External Clock, RA6 available
- ECIO External Clock, Clock Out RA6 (Fosc/4 on RA6)
- HS High-Speed Crystal/Resonator
- XT Crystal/Resonator
- LP Low-Power Crystal
- RC External Resistor/Capacitor, RA6 available
- RCIO External Resistor/Capacitor, Clock Out RA6 (Fosc/4 on RA6)
- INTIO2 Internal Oscillator with I/O on RA6 and RA7
- INTIO1 Internal Oscillator with Fosc/4 Output on RA6 and I/O on RA7

There is also an option for running the 4xPLL on any of the clock sources in the input frequency range of 4 to 16 MHz.

The PLL is enabled by setting the PLLCFG bit (CONFIG1H<4>) or the PLLEN bit (OSCTUNE<6>).

For the EC and HS mode, the PLLEN (software) or PLLCFG (CONFIG) bit can be used to enable the PLL.

For the INTIOx modes (HF-INTOSC):

- Only the PLLEN can enable the PLL (PLLCFG is ignored).
- When the oscillator is configured for the internal oscillator (OSC<3:0> = 100x), the PLL can be enabled only when the HF-INTOSC frequency is 8 or 16 MHz.

When the RA6 and RA7 pins are not used for an oscillator function or CLKOUT function, they are available as general purpose I/Os. To optimize power consumption when using EC/HS/ XT/LP/RC as the primary oscillator, the frequency input range can be configured to yield an optimized power bias:

- Low-Power Bias External frequency less than 160 kHz
- Medium Power Bias External frequency between 160 kHz and 16 MHz
- High-Power Bias External frequency greater than 16 MHz

All of these modes are selected by the user by programming the OSC<3:0> Configuration bits (CONFIG1H<3:0>). In addition, PIC18F87K90 family devices can switch between different clock sources, either under software control or under certain conditions, automatically. This allows for additional power savings by managing device clock speed in real time without resetting the application. The clock sources for the PIC18F87K90 family of devices are shown in Figure 3-1.

For the HS and EC mode, there are additional power modes of operation – depending on the frequency of operation.

HS1 is the Medium Power mode with a frequency range of 4 MHz to 16 MHz. HS2 is the High-Power mode where the oscillator frequency can go from 16 MHz to 25 MHz. HS1 and HS2 are achieved by setting the CONFIG1H<3:0> correctly. (For details, see Register 28-2 on page 426.)

EC mode has these modes of operation:

- EC1 For low power with a frequency range up to 160 kHz
- EC2 Medium power with a frequency range of 160 kHz to 16 MHz
- EC3 High power with a frequency range of 16 MHz to 64 MHz

EC1, EC2 and EC3 are achieved by setting the CONFIG1H<3:0> correctly. (For details, see Register 28-2 on page 426.)

Table 3-1 shows the HS and EC modes' frequency range and OSC<3:0> settings.

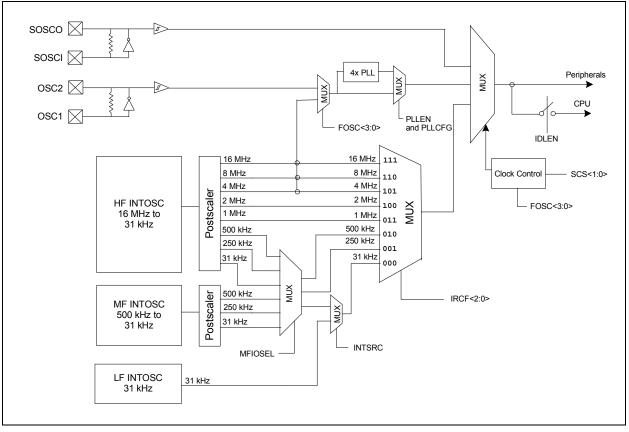
查询PIC18F67K90供应商

TABLE 3-1: HS, EC, XT, LP AND RC MODES: RANGES AND SETTINGS

Mode	Frequency Range	OSC<3:0> Setting
EC1 (low power)		1101
(EC1 & EC1IO)	DC-160 kHz	1100
EC2 (medium power)	160 kHz-16 MHz	1011
(EC2 & EC2IO)		1010
EC3 (high power)		0101
(EC3 & EC3IO)	16 MHz-64 MHz	0100
HS1 (medium power)	4 MHz-16 MHz	0011
HS2 (high power)	16 MHz-25 MHz	0010
XT	100 kHz-4 MHz	0001
LP	31.25 kHz	0000
RC (External)	0-4 MHz	011x
INTIO	32 kHz-16 MHz	100x (and OSCCON, OSCCON2)



PIC18F87K90 FAMILY CLOCK DIAGRAM



<u>查询PIC18F67K90供应商</u> 3.2 Control Registers

The OSCCON register (Register 3-1) controls the main aspects of the device clock's operation. It selects the oscillator type to be used, which of the power-managed modes to invoke and the output frequency of the INTOSC source. It also provides status on the oscillators.

The OSCTUNE register (Register 3-3) controls the tuning and operation of the internal oscillator block. It also implements the PLLEN bit which controls the operation of the Phase Locked Loop (PLL) (see Section 3.5.2 "PLL Frequency Multiplier").

REGISTER 3-1: OSCCON: OSCILLATOR CONTROL REGISTER⁽¹⁾

R/W-0	R/W-1	R/W-1	R/W-0	R ⁽¹⁾	R-0	R/W-0	R/W-0
IDLEN	IRCF2 ⁽²⁾	IRCF1 ⁽²⁾	IRCF0 ⁽²⁾	OSTS	HFIOFS	SCS1 ⁽⁴⁾	SCS0 ⁽⁴⁾
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

 1 = Device enters an Idle mode when a SLEEP instruction is executed 0 = Device enters Sleep mode when a SLEEP instruction is executed 0 = Device enters Sleep mode when a SLEEP instruction is executed 11 = HF-INTOSC: Output frequency used (16 MHz) 11 = HF-INTOSC/2 output frequency used (20 MHz) 10 = HF-INTOSC/3 output frequency used (20 MHz) 11 = HF-INTOSC/3 output frequency used (31.25 KHz) 11 = HF-INTOSC/32 output frequency used (31.25 KHz) 11 = HF-INTOSC output frequency used (31.25 KHz) 11 = MF-INTOSC output frequency used (300 KHz) 11 = MF-INTOSC output frequency used (500 KHz) 11 = MF-INTOSC output frequency used (500 KHz) 11 = MF-INTOSC output frequency used (500 KHz) 11 = MF-INTOSC/32 output frequency used (250 KHz) 11 = MF-INTOSC/32 output frequency used (250 KHz) 11 = MF-INTOSC/2 output frequency used (250 KHz) 11 = MF-INTOSC/2 output frequency used (250 KHz) 11 = MF-INTOSC/32 output frequency used (250 KHz) 11 = MF-INTOSC/32 output frequency used (250 KHz) 11 = MF-INTOSC/16 output frequency used (250 KHz)	bit 7	IDLEN: Idle Enable bit
 0 = Device enters Sleep mode when a SLEEP instruction is executed bit 6-4 IRCF-2:0>: Internal Oscillator Frequency Select bits⁽²⁾ 111 = HF-INTOSC output frequency used (16 MHz) 110 = HF-INTOSC/2 output frequency used (2 MHz) 101 = HF-INTOSC/6 output frequency used (2 MHz) 111 = HF-INTOSC/6 output frequency used (2 MHz) 112 = HF-INTOSC/6 output frequency used (2 MHz) 113 = HF-INTOSC/6 output frequency used (2 MHz) 114 = HF-INTOSC/6 output frequency used (250 kHz) 115 = HF-INTOSC/6 output frequency used (250 kHz) 116 = HF-INTOSC/64 output frequency used (250 kHz) 117 = HF-INTOSC/64 output frequency used (250 kHz) 118 = HF-INTOSC/64 output frequency used (250 kHz) 119 = HF-INTOSC/64 output frequency used (250 kHz) 110 = HF-INTOSC/64 output frequency used (250 kHz) 111 = HF-INTOSC/64 output frequency used (31.25 kHz) 111 INTSRC = 1 and MFIOSEL = 1.^(3,5) 111 INTSRC = 1 and MFIOSEL = 1.^(3,5) 112 = MF-INTOSC output frequency used (250 kHz) 114 = HF-INTOSC output frequency used (250 kHz) 115 = MF-INTOSC output frequency used (250 kHz) 118 = MF-INTOSC output frequency used (250 kHz) 119 = MF-INTOSC output frequency used (250 kHz) 110 = MF-INTOSC output frequency used (250 kHz) 111 = MF-INTOSC output freq		1 = Device enters an Idle mode when a SLEEP instruction is executed
 111 = HF-INTOSC output frequency used (16 MHz) 110 = HF-INTOSC/2 output frequency used (2 MHz) 101 = HF-INTOSC/4 output frequency used (2 MHz) 101 = HF-INTOSC/16 output frequency used (2 MHz) 101 = HF-INTOSC/16 output frequency used (1 MHz) 111 = HF-INTOSC/12 output frequency used (500 KHz) 111 = HF-INTOSC/20 output frequency used (500 KHz) 112 = HF-INTOSC/20 output frequency used (500 KHz) 113 = HF-INTOSC/64 output frequency used (500 KHz) 114 = HF-INTOSC/64 output frequency used (500 KHz) 115 = HF-INTOSC/64 output frequency used (500 KHz) 115 = HF-INTOSC/64 output frequency used (500 KHz) 114 = H-INTOSC/64 output frequency used (500 KHz) 115 = HF-INTOSC/64 output frequency used (500 KHz) 114 = H-INTOSC/64 output frequency used (500 KHz) 115 = HF-INTOSC/64 output frequency used (500 KHz) 114 = H-INTOSC/20 output frequency used (500 KHz) 115 = HF-INTOSC output frequency used (500 KHz) 114 = HF-INTOSC/20 output frequency used (500 KHz) 115 = MF-INTOSC output frequency used (500 KHz) 116 = MF-INTOSC output frequency used (500 KHz) 116 = MF-INTOSC/20 output frequency used (500 KHz) 116 = MF-INTOSC/16 output frequency used (500 KHz) 116 = MF-INTOSC/16 output frequency used (500 KHz) 117 = MF-INTOSC/16 output frequency used (500 KHz) 118 = HF-INTOSC/16 output frequency used (500 KHz) 119 = MF-INTOSC/16 output frequency used (500 KHz) 119 = MF-INTOSC/16 output frequency used (500 KHz) 119 = MF-INTOSC/20 output frequency used (500 KHz) 111 = MF-INTOSC/16 output frequency used (500 KHz) 111 = MSCIIlator Start-up Timer (OST) time-out sa expired: primary oscillator is running, as defined by OSCC-30.20 111 = Oscil		0 = Device enters Sleep mode when a SLEEP instruction is executed
 110 = HF-INTOSC/2 output frequency used (8 MHz), default) 111 = HF-INTOSC/4 output frequency used (2 MHz) 112 = HF-INTOSC/16 output frequency used (2 MHz) 113 = HF-INTOSC/16 output frequency used (1 MHz) 114 = HF-INTOSC/16 output frequency used (1 MHz) 115 = HF-INTOSC/2 output frequency used (250 KHz) 110 = HF-INTOSC/30 output frequency used (250 KHz) 111 = HF-INTOSC/32 output frequency used (250 KHz) 111 = HF-INTOSC/32 output frequency used (250 KHz) 112 = 111 = HF-INTOSC/32 output frequency used (250 KHz) 114 = HF-INTOSC/32 output frequency used (250 KHz) 115 = HF-INTOSC/32 output frequency used (250 KHz) 116 = HF-INTOSC/512 output frequency used (250 KHz) 117 = MF-INTOSC / 40 tiput frequency used (250 KHz) 118 = HF-INTOSC / 40 tiput frequency used (250 KHz) 119 = HF-INTOSC / 40 tiput frequency used (250 KHz) 110 = MF-INTOSC / 40 tiput frequency used (250 KHz) 110 = MF-INTOSC / 40 tiput frequency used (250 KHz) 111 = HF-INTOSC / 40 tiput frequency used (250 KHz) 111 = HF-INTOSC / 40 tiput frequency used (250 KHz) 111 = HF-INTOSC / 40 tiput frequency used (250 KHz) 111 = HF-INTOSC / 40 tiput frequency used (500 KHz) 111 = HF-INTOSC / 40 tiput frequency used (250 KHz) 112 = HF-INTOSC / 40 tiput frequency used (250 KHz) 113 OSTS: Oscillator Start-up Timer Time-out Status bit⁽¹⁾ 11 = Oscillator Start-up Timer Time-out Status bit⁽¹⁾ 12 = Oscillator Start-up Timer (OST) time-out thas expired: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) 114 Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 32 Source selected by the INTSRC bit (OSCTUNE<7>). 43 Modifying these bits will cause an immediate clock source sw	bit 6-4	IRCF<2:0>: Internal Oscillator Frequency Select bits ⁽²⁾
 101 = HF-INTOSC/4 output frequency used (4 MHz) 100 = HF-INTOSC/8 output frequency used (2 MHz) 011 = HF-INTOSC/16 output frequency used (1 MHz) If INTSRC = 0 and MFIOSEL = 0;^(3,5) 010 = HF-INTOSC/32 output frequency used (500 kHz) 001 = HF-INTOSC/46 output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 0;^(3,5) 010 = HF-INTOSC/32 output frequency used (500 kHz) 001 = HF-INTOSC/32 output frequency used (250 kHz) 000 = HF-INTOSC/32 output frequency used (250 kHz) 001 = HF-INTOSC/64 output frequency used (250 kHz) 000 = HF-INTOSC/64 output frequency used (31.25 kHz) If INTSRC = 0 and MFIOSEL = 1;^(3,5) 010 = MF-INTOSC output frequency used (250 kHz) 000 = HF-INTOSC output frequency used (250 kHz) 000 = HF-INTOSC /2 output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 1;^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC /2 output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 1;^(3,5) 010 = MF-INTOSC /2 output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 1;^(3,5) 010 = MF-INTOSC /16 output frequency used (31.25 kHz) 001 = MF-INTOSC/16 output frequency used (31.25 kHz) 001 = MF-INTOSC/16 output frequency used (31.25 kHz) 001 = MF-INTOSC/2 output frequency used (31.25 kHz) 001 = MF-INTOSC/16 output frequency used (31.25 kHz) 001 = MF-INTOSC/16 output frequency used (31.25 kHz) 001 = MF-INTOSC/16 output frequency used (31.25 kHz) 002 = Start-up Timer (OST) time-out tas usinting: primary oscillator is running, as defined by OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out tas unning: primary oscil		111 = HF-INTOSC output frequency used (16 MHz)
 100 = HF-INTOSC/8 output frequency used (2 MHz) 011 = HF-INTOSC/16 output frequency used (1 MHz) If INTSRC = 0 and MFIOSEL = 0.^(3,5) 010 = HF-INTOSC/32 output frequency used (500 kHz) 001 = HF-INTOSC output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 0.^(3,5) 010 = HF-INTOSC/32 output frequency used (500 kHz) 001 = HF-INTOSC/32 output frequency used (250 kHz) 001 = HF-INTOSC/32 output frequency used (250 kHz) 001 = HF-INTOSC/512 output frequency used (250 kHz) 001 = HF-INTOSC output frequency used (250 kHz) 001 = MF-INTOSC output frequency used (250 kHz) 010 = MF-INTOSC output frequency used (250 kHz) 010 = MF-INTOSC output frequency used (250 kHz) 001 = MF-INTOSC output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (250 kHz) 001 = MF-INTOSC output frequency used (250 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 001 = MF-INTOSC/16 output frequency used (21.25 kHz) bit 3 OSTS: Oscillator Start-up Timer (OST) time-out Status bit⁽¹⁾ 1 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state o		
 011 = HF-INTOSC/16 output frequency used (1 MHz) If INTSRC = 0 and MEIOSEL = 0.^(3,6) 010 = HF-INTOSC/32 output frequency used (500 kHz) 001 = HF-INTOSC (64 output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (31.25 kHz) If INTSRC = 1 and MEIOSEL = 0.^(3,5) 010 = HF-INTOSC/64 output frequency used (500 kHz) 001 = HF-INTOSC/64 output frequency used (250 kHz) 001 = HF-INTOSC/64 output frequency used (31.25 kHz) If INTSRC = 0 and MEIOSEL = 1.^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC output frequency used (51.25 kHz) If INTSRC = 1 and MEIOSEL = 1.^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC/16 output frequency used (500 kHz) 002 = Oscillator Start-up Timer (OST) time-out Status bit⁽¹⁾ 1 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is running, as defined by OSC-3:0> 0 = Oscillator Start-up Timer (OST) time-out is curning: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7		
If INTSRC = 0 and MFIOSEL = 0: ^(3,5) 010 = HF-INTOSC/32 output frequency used (500 kHz) 000 = LF-INTOSC output frequency used (250 kHz) 100 = HF-INTOSC output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 0: ^(3,5) 010 = HF-INTOSC/32 output frequency used (500 kHz) 001 = HF-INTOSC/32 output frequency used (250 kHz) 001 = HF-INTOSC/512 output frequency used (250 kHz) 010 = MF-INTOSC output frequency used (500 kHz) 011 = MF-INTOSC output frequency used (500 kHz) 010 = MF-INTOSC output frequency used (500 kHz) 010 = MF-INTOSC output frequency used (500 kHz) 010 = MF-INTOSC/16 output frequency used (250 kHz) 000 = MF-INTOSC/16 output fr		
 010 = HF-INTOSC/32 output frequency used (500 kHz) 001 = HF-INTOSC (A output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 0:^(3,5) 010 = HF-INTOSC/64 output frequency used (500 kHz) 001 = HF-INTOSC/64 output frequency used (31.25 kHz) If INTSRC = 0 and MFIOSEL = 1:^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 1:^(3,5) 010 = MF-INTOSC output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (250 kHz) 000 = MF-INTOSC/16 output frequency used (250 kHz) 001 = MF-INTOSC/16 output frequency used (250 kHz) 000 = MF-INTOSC/16 output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 1:^(3,5) 010 = MF-INTOSC/16 output frequency used (250 kHz) 000 = MF-INTOSC/16 output frequency used (31.25 kHz) bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit⁽¹⁾ 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock		
 001 = HF-INTOSC/64 output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 0:^(3,5) 010 = HF-INTOSC/32 output frequency used (500 kHz) 001 = HF-INTOSC/512 output frequency used (250 kHz) 000 = HF-INTOSC output frequency used (31.25 kHz) If INTSRC = 0 and MFIOSEL = 1:^(3,5) 010 = MF-INTOSC /2 output frequency used (250 kHz) 001 = MF-INTOSC /2 output frequency used (250 kHz) 001 = MF-INTOSC /2 output frequency used (250 kHz) 001 = MF-INTOSC /2 output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 1:^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC /2 output frequency used (500 kHz) 001 = MF-INTOSC /2 output frequency used (500 kHz) 001 = MF-INTOSC /2 output frequency used (500 kHz) 001 = MF-INTOSC /2 output frequency used (500 kHz) 001 = MF-INTOSC /2 output frequency used (250 kHz) 000 = MF-INTOSC /2 output frequency used (250 kHz) 000 = MF-INTOSC /2 output frequency used (250 kHz) 000 = MF-INTOSC /2 output frequency used (21.25 kHz) bit 3 OSTS: Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 		
 000 = LF-INTOSC output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 0:^(3,5) 010 = HF-INTOSC/32 output frequency used (500 kHz) 001 = HF-INTOSC/512 output frequency used (31.25 kHz) If INTSRC = 0 and MFIOSEL = 1:^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC /2 output frequency used (250 kHz) 000 = LF-INTOSC /2 output frequency used (250 kHz) 000 = LF-INTOSC /2 output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (250 kHz) 000 = LF-INTOSC /2 output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (250 kHz) 000 = MF-INTOSC output frequency used (250 kHz) 001 = MF-INTOSC /2 output frequency used (500 kHz) 001 = MF-INTOSC /2 output frequency used (250 kHz) 001 = MF-INTOSC /46 output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 1:^(3,5) 010 = MF-INTOSC /3 output frequency used (31.25 kHz) 001 = MF-INTOSC /16 output frequency used (31.25 kHz) 000 = MF-INTOSC /16 output frequency used (31.25 kHz) 000 = MF-INTOSC /3 output frequency used (31.25 kHz) 000 = MF-INTOSC /3 output frequency used (31.25 kHz) 000 = MF-INTOSC /3 output frequency used (500 kHz) 000 = MF-INTOSC /3 output frequency used (500 kHz) 000 = MF-INTOSC /3 output frequency used (500 kHz) 000 = MF-INTOSC /3 output frequency used (500 kHz) 000 = MF-INTOSC /3 output frequency used (500 kHz) 000 = MF-INTOSC /3 output frequency used (500 kHz) 000 = MF-INTOSC /3 output frequency used (500 kHz) 000 = MF-INTOSC /3 output frequency used (500 kHz) 000 = MF-INTOSC /3 output frequency used (500 kHz) 000 = Oscillator Start		
 If INTSRC = 1 and MFIOSEL = 0:^(3,5) 010 = HF-INTOSC/32 output frequency used (500 kHz) 001 = HF-INTOSC/64 output frequency used (250 kHz) 000 = HF-INTOSC/512 output frequency used (31.25 kHz) If INTSRC = 0 and MFIOSEL = 1:^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 000 = MF-INTOSC/2 output frequency used (250 kHz) 000 = MF-INTOSC/2 output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 1:^(3,5) 010 = MF-INTOSC/16 output frequency used (31.25 kHz) bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit⁽¹⁾ 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 		
 Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch. if the internal oscillator is providing these bits will cause an immediate clock source switch. 		
 000 = HF-INTOSC/512 output frequency used (31.25 kHz) [f INTSRC = 0 and MFIOSEL = 1:^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (31.25 kHz) [f INTSRC = 1 and MFIOSEL = 1:^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC/2 output frequency used (500 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 000 = MF-INTOSC/16 output frequency used (31.25 kHz) bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit⁽¹⁾ 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 		
If INTSRC = 0 and MFIOSEL = 1: ^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 1: ^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC /2 output frequency used (250 kHz) 001 = MF-INTOSC /2 output frequency used (250 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 001 = MF-INTOSC /2 output frequency used (250 kHz) 001 = MF-INTOSC /2 output frequency used (250 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 001 = MF-INTOSC /2 output frequency used (250 kHz) 001 = MF-INTOSC /2 output frequency used (31.25 kHz) DOTS: Oscillator Start-up Timer Time-out Status bit ⁽¹⁾ 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). <		
 10 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 1:^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 000 = MF-INTOSC/16 output frequency used (31.25 kHz) bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit⁽¹⁾ 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 		
 001 = MF-INTOSC/2 output frequency used (250 kHz) 000 = LF-INTOSC output frequency used (31.25 kHz) If INTSRC = 1 and MFIOSEL = 1:^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 000 = MF-INTOSC/16 output frequency used (31.25 kHz) bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit⁽¹⁾ 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 		
 000 = LF-INTOSC output frequency used (31.25 kHz) <u>If INTSRC = 1 and MFIOSEL = 1:</u>^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 000 = MF-INTOSC/16 output frequency used (31.25 kHz) bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit⁽¹⁾ 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 		
 If INTSRC = 1 and MFIOSEL = 1:^(3,5) 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 000 = MF-INTOSC/16 output frequency used (31.25 kHz) bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit⁽¹⁾ 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 		
 010 = MF-INTOSC output frequency used (500 kHz) 001 = MF-INTOSC/2 output frequency used (250 kHz) 000 = MF-INTOSC/16 output frequency used (31.25 kHz) bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit⁽¹⁾ 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 		
 001 = MF-INTOSC/2 output frequency used (250 kHz) 000 = MF-INTOSC/16 output frequency used (31.25 kHz) bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit⁽¹⁾ 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 		
 000 = MF-INTOSC/16 output frequency used (31.25 kHz) bit 3 OSTS: Oscillator Start-up Timer Time-out Status bit⁽¹⁾ 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 		
 1 = Oscillator Start-up Timer (OST) time-out has expired: primary oscillator is running, as defined by OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 		
 OSC<3:0> 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 	bit 3	OSTS: Oscillator Start-up Timer Time-out Status bit ⁽¹⁾
 0 = Oscillator Start-up Timer (OST) time-out is running: primary oscillator is not ready, device is running from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 		
 from an internal oscillator (HF-INTOSC, MF-INTOSC or LF-INTOSC) Note 1: Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>). 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 		
 Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks. Source selected by the INTSRC bit (OSCTUNE<7>). Modifying these bits will cause an immediate clock source switch. 		
 the device clocks. 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 	Note 1:	Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>).
 3: Source selected by the INTSRC bit (OSCTUNE<7>). 4: Modifying these bits will cause an immediate clock source switch. 	2:	
4: Modifying these bits will cause an immediate clock source switch.	3.	
	5.	

查询PIC18F67K90供应商

REGISTER 3-1: OSCCON: OSCILLATOR CONTROL REGISTER⁽¹⁾ (CONTINUED)

- bit 2 **HFIOFS:** INTOSC Frequency Stable bit
 - 1 = HF-INTOSC oscillator frequency is stable
 - 0 = HF-INTOSC oscillator frequency is not stable
- bit 1-0 SCS<1:0>: System Clock Select bits⁽⁴⁾
 - 1x = Internal oscillator block (LF-INTOSC, MF-INTOSC or HF-INTOSC)
 - 01 = SOSC oscillator
 - 00 = Default primary oscillator (OSC1/OSC2 or HF-INTOSC with or without PLL. Defined by the OSC<3:0> Configuration bits, CONFIG1H<3:0>.)
- **Note 1:** Reset state depends on the state of the IESO Configuration bit (CONFIG1H<7>).
 - 2: Modifying these bits will cause an immediate clock frequency switch if the internal oscillator is providing the device clocks.
 - 3: Source selected by the INTSRC bit (OSCTUNE<7>).
 - 4: Modifying these bits will cause an immediate clock source switch.
 - **5**: INTSRC = OSCTUNE<7> and MFIOSEL = OSCCON2<0>.

REGISTER 3-2: OSCCON2: OSCILLATOR CONTROL REGISTER 2

U-0	R-0	U-0	U-0	R/W-0	U-0	R-x	R/W-0
—	SOSCRUN			SOSCGO		MFIOFS	MFIOSEL
bit 7							bit 0

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7	Unimplemented: Read as '0'
bit 6	SOSCRUN: SOSC Run Status bit
	 1 = System clock comes from a secondary SOSC 0 = System clock comes from an oscillator other than SOSC
bit 5-4	Unimplemented: Read as '0'
bit 3	SOSCGO: Oscillator Start Control bit
	 1 = Oscillator is running, even if no other sources are requesting it 0 = Oscillator is shut off if no other sources are requesting it (When the SOSC is selected to run from a digital clock input, rather than an external crystal, this bit has no effect.)
bit 2	Unimplemented: Read as '0'
bit 1	MFIOFS: MF-INTOSC Frequency Stable bit
	 1 = MF-INTOSC is stable 0 = MF-INTOSC is not stable
bit 0	MFIOSEL: MF-INTOSC Select bit 1 = MF-INTOSC is used in place of HF-INTOSC frequencies of 500 kHz, 250 kHz and 31.25 kHz 0 = MF-INTOSC is not used

查询PIC18F67K90供应商 REGISTER 3-3: OSCTUNE: OSCILLATOR TUNING REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
INTSRC	PLLEN	TUN5	TUN4	TUN3	TUN2	TUN1	TUN0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	INTSRC: Internal Oscillator Low-Frequency Source Select bit 1 = 31.25 kHz device clock is derived from 16 MHz INTOSC source (divide-by-512 enabled, HF-INTOSC) 0 = 31 kHz device clock is derived from INTRC 31 kHz oscillator (LF-INTOSC)
bit 6	PLLEN: Frequency Multiplier PLL Enable bit 1 = PLL is enabled 0 = PLL is disabled
bit 5-0	TUN<5:0>: Fast RC Oscillator (INTOSC) Frequency Tuning bits 011111 = Maximum frequency • • • 000001 000000 = Center frequency. Fast RC oscillator is running at the calibrated frequency. 111111 • • 100000 = Minimum frequency

3.3 Clock Sources and Oscillator Switching

Essentially, PIC18F87K90 family devices have these independent clock sources:

- Primary oscillators
- Secondary oscillators
- Internal oscillator

The **primary oscillators** can be thought of as the main device oscillators. These are any external oscillators connected to the OSC1 and OSC2 pins, and include the External Crystal and Resonator modes and the External Clock modes. If selected by the OSC<3:0> Configuration bits (CONFIG1H<3:0>), the internal oscillator block may be considered a primary oscillator. The internal oscillator block can be one of the following:

- 31 kHz LF-INTRC source
- 31 kHz to 500 kHz MF-INTOSC source
- 31 kHz to 16 MHz HF-INTOSC source

The particular mode is defined by the OSC Configuration bits. The details of these modes are covered in **Section 3.4 "External Oscillator Modes**".

The **secondary oscillators** are external clock sources that are not connected to the OSC1 or OSC2 pin. These sources may continue to operate, even after the controller is placed in a power-managed mode. PIC18F87K90 family devices offer the SOSC (Timer1/3/5/7) oscillator as a secondary oscillator source. This oscillator, in all power-managed modes, is often the time base for functions, such as a Real-Time Clock (RTC).

The SOSCEN bit in the corresponding timer should be set correctly for the enabled SOSC. The SOSCEL<1:0> bits (CONFIG1L<4:3>) decide the SOSC mode of operation:

- 11 = High-power SOSC circuit
- 10 = Digital (SCLKI) mode
- 01 = Low-power SOSC circuit

In addition to being a primary clock source in some circumstances, the **internal oscillator** is available as a power-managed mode clock source. The LF-INTOSC source is also used as the clock source for several special features, such as the WDT and Fail-Safe Clock Monitor. The internal oscillator block is discussed in more detail in **Section 3.6** "Internal Oscillator **Block**".

The PIC18F87K90 family includes features that allow the device clock source to be switched from the main oscillator, chosen by device configuration, to one of the alternate clock sources. When an alternate clock source is enabled, various power-managed operating modes are available.

查询PIC18F67K90供应商 3.3.1 OSC1/OSC2 OSCILLATOR

The OSC1/OSC2 oscillator block is used to provide the oscillator modes and frequency ranges:

Mode	Design Operating Frequency
LP	31.25-100 kHz
XT	100 kHz to 4 MHz
HS	4 MHz to 25 MHz
EC	0 to 64 MHz (external clock)
EXTRC	0 to 4 MHz (external RC)

The crystal-based oscillators (XT, HS and LP) have a built-in start-up time. The operation of the EC and EXTRC clocks is immediate.

3.3.2 CLOCK SOURCE SELECTION

The System Clock Select bits, SCS<1:>0 (OSCCON2<1:0>), select the clock source. The available clock sources are the primary clock defined by the OSC<3:0> Configuration bits, the secondary clock (SOSC oscillator) and the internal oscillator. The clock source changes after one or more of the bits is written to, following a brief clock transition interval.

The OSTS (OSCCON<3>) and SOSCRUN (OSCCON2<6>) bits indicate which clock source is currently providing the device clock. The OSTS bit indicates that the Oscillator Start-up Timer (OST) has timed out and the primary clock is providing the device clock in primary clock modes. The SOSCRUN bit indicates when the SOSC oscillator (from Timer1/3/5/7) is providing the device clock in secondary clock modes. In power-managed modes, only one of these bits will be set at any time. If neither of these bits is set, the INTRC is providing the clock, or the internal oscillator has just started and is not yet stable.

The IDLEN bit (OSCCON<7>) determines if the device goes into Sleep mode or one of the Idle modes when the SLEEP instruction is executed.

The use of the flag and control bits in the OSCCON register is discussed in more detail in **Section 4.0 "Power-Managed Modes"**.

- Note 1: The secondary oscillator must be enabled to select the secondary clock source. The SOSC oscillator is enabled by setting the SOSCGO bit in the OSCCON2 register (OSCCON<3>). If the SOSC oscillator is not enabled, then any attempt to select a secondary clock source when executing a SLEEP instruction will be ignored.
 - 2: It is recommended that the secondary oscillator be operating and stable before executing the SLEEP instruction or a very long delay may occur while the SOSC oscillator starts.

3.3.2.1 System Clock Selection and Device Resets

Since the SCS bits are cleared on all forms of Reset, this means the primary oscillator defined by the OSC<3:0> Configuration bits is used as the primary clock source on device Resets. This could either be the internal oscillator block by itself, or one of the other primary clock source (HS, EC, XT, LP, External RC and PLL-enabled modes).

In those cases when the internal oscillator block, without PLL, is the default clock on Reset, the Fast RC oscillator (INTOSC) will be used as the device clock source. It will initially start at 8 MHz; the postscaler selection that corresponds to the Reset value of the IRCF<2:0> bits ('110').

Regardless of which primary oscillator is selected, INTRC will always be enabled on device power-up. It serves as the clock source until the device has loaded its configuration values from memory. It is at this point that the OSC Configuration bits are read and the oscillator selection of the operational mode is made.

Note that either the primary clock source or the internal oscillator will have two bit setting options for the possible values of the SCS<1:0> bits, at any given time.

3.3.3 OSCILLATOR TRANSITIONS

PIC18F87K90 family devices contain circuitry to prevent clock "glitches" when switching between clock sources. A short pause in the device clock occurs during the clock switch. The length of this pause is the sum of two cycles of the old clock source and three to four cycles of the new clock source. This formula assumes that the new clock source is stable.

Clock transitions are discussed in greater detail in **Section 4.1.2 "Entering Power-Managed Modes"**.

3.4 External Oscillator Modes

3.4.1 CRYSTAL OSCILLATOR/CERAMIC RESONATORS (HS MODES)

In HS or HSPLL Oscillator modes, a crystal or ceramic resonator is connected to the OSC1 and OSC2 pins to establish oscillation. Figure 3-2 shows the pin connections.

The oscillator design requires the use of a crystal rated for parallel resonant operation.

Note: Use of a crystal rated for series resonant operation may give a frequency out of the crystal manufacturer's specifications.

查询PIC18F67K90供应商 TABLE 3-2: CAPACITOR SELECTION FOR CERAMIC RESONATORS

Typical Capacitor Values Used:							
Mode	Freq.	OSC1	OSC2				
HS	8.0 MHz 16.0 MHz	27 pF 22 pF	27 pF 22 pF				

Capacitor values are for design guidance only.

Different capacitor values may be required to produce acceptable oscillator operation. The user should test the performance of the oscillator over the expected VDD and temperature range for the application. Refer to the following application notes for oscillator-specific information:

- AN588, "PIC[®] Microcontroller Oscillator Design Guide"
- AN826, "Crystal Oscillator Basics and Crystal Selection for rfPIC[®] and PIC[®] Devices"
- AN849, "Basic PIC[®] Oscillator Design"
- AN943, "Practical PIC[®] Oscillator Analysis and Design"
- AN949, "Making Your Oscillator Work"

See the notes following Table 3-3 for additional information.

TABLE 3-3: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR

Osc Type	Crystal Freq.	Typical Capa Tes	
	Fieq.	C1	C2
HS	4 MHz	27 pF	27 pF
	8 MHz	22 pF	22 pF
	20 MHz	15 pF	15 pF

Capacitor values are for design guidance only.

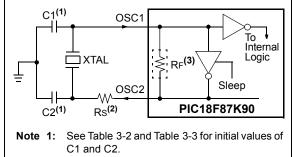
Different capacitor values may be required to produce acceptable oscillator operation. The user should test the performance of the oscillator over the expected VDD and temperature range for the application.

Refer to the Microchip application notes cited in Table 3-2 for oscillator-specific information. Also see the notes following this table for additional information.

- Note 1: Higher capacitance increases the stability of oscillator but also increases the start-up time.
 - 2: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
 - **3:** Rs may be required to avoid overdriving crystals with low drive level specification.
 - 4: Always verify oscillator performance over the VDD and temperature range that is expected for the application.

FIGURE 3-2:

CRYSTAL/CERAMIC RESONATOR OPERATION (HS OR HSPLL CONFIGURATION)



- **2:** A series resistor (Rs) may be required for AT strip cut crystals.
- **3:** RF varies with the oscillator mode chosen.

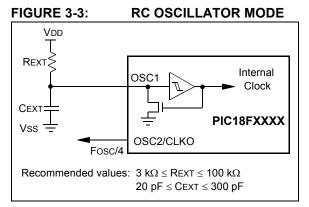
3.5 RC Oscillator

For timing-insensitive applications, the RC and RCIO Oscillator modes offer additional cost savings. The actual oscillator frequency is a function of several factors:

- · Supply voltage
- Values of the external resistor (REXT) and capacitor (CEXT)
- Operating temperature Given the same device, operating voltage and temperature and component values, there will also be unit-to-unit frequency variations. These are due to factors such as:
 - normal manufacturing variation
 - difference in lead frame capacitance between package types (especially for low CEXT values)
 - variations within the tolerance of limits of $\ensuremath{\mathsf{Rext}}$ and $\ensuremath{\mathsf{Cext}}$

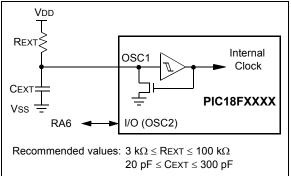
查询PIC18F67K90供应商

In the RC Oscillator mode, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic. Figure 3-3 shows how the R/C combination is connected.



The RCIO Oscillator mode (Figure 3-4) functions like the RC mode, except that the OSC2 pin becomes an additional general purpose I/O pin. The I/O pin becomes bit 6 of PORTA (RA6).



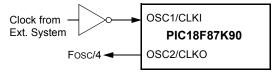


3.5.1 EXTERNAL CLOCK INPUT (EC MODES)

The EC and ECPLL Oscillator modes require an external clock source to be connected to the OSC1 pin. There is no oscillator start-up time required after a Power-on Reset or after an exit from Sleep mode.

In the EC Oscillator mode, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic. Figure 3-5 shows the pin connections for the EC Oscillator mode.

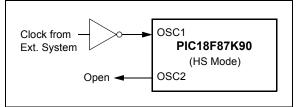
FIGURE 3-5: EXTERNAL CLOCK INPUT OPERATION (EC CONFIGURATION)



An external clock source may also be connected to the OSC1 pin in the HS mode, as shown in Figure 3-6. In this configuration, the divide-by-4 output on OSC2 is not available. Current consumption in this configuration will be somewhat higher than EC mode, as the internal oscillator's feedback circuitry will be enabled (in EC mode, the feedback circuit is disabled).



EXTERNAL CLOCK INPUT OPERATION (HS OSC CONFIGURATION)



3.5.2 PLL FREQUENCY MULTIPLIER

A Phase Lock Loop (PLL) circuit is provided as an option for users who want to use a lower frequency oscillator circuit, or to clock the device up to its highest rated frequency from a crystal oscillator. This may be useful for customers who are concerned with EMI due to high-frequency crystals, or users who require higher clock speeds from an internal oscillator.

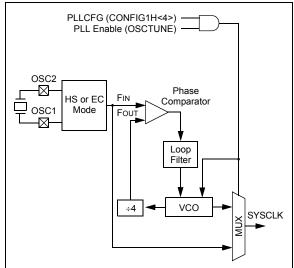
3.5.2.1 HSPLL and ECPLL Modes

The HSPLL and ECPLL modes provide the ability to selectively run the device at four times the external oscillating source to produce frequencies up to 64 MHz.

The PLL is enabled by setting the PLLEN bit (OSCTUNE<6>) or the PLLCFG bit (CONFIG1H<4>). For the HF-INTOSC as primary, the PLL must be enabled with the PLLEN. This provides software control for the PLL, enabling even if PLLCFG is set to '1', so that the PLL is enabled only when the HF-INTOSC frequency is within the 4 MHz to 16 MHz input range.

This also enables additional flexibility for controlling the application's clock speed in software. The PLLEN should be enabled in HF-INTOSC mode only if the input frequency is in the range of 4 MHz-16 MHz.

查询PIC18F67K90供应商 FIGURE 3-7: PLL BLOCK DIAGRAM



3.5.2.2 PLL and HF-INTOSC

The PLL is available to the internal oscillator block when the internal oscillator block is configured as the primary clock source. In this configuration, the PLL is enabled in software and generates a clock output of up to 64 MHz.

The operation of INTOSC with the PLL is described in **Section 3.6.2 "INTPLL Modes"**. Care should be taken that the PLL is enabled only if the HF-INTOSC postscaler is configured for 4 MHz, 8 MHz or 16 MHz.

3.6 Internal Oscillator Block

The PIC18F87K90 family of devices includes an internal oscillator block which generates two different clock signals. Either clock can be used as the micro-controller's clock source, which may eliminate the need for an external oscillator circuit on the OSC1 and/or OSC2 pins.

The internal oscillator consists of three blocks, depending on the frequency of operation. They are HF-INTOSC, MF-INTOSC and LF-INTRC.

In HF-INTOSC mode, the internal oscillator can provide a frequency, ranging from 31 KHz to 16 MHz, with the postscaler deciding the selected frequency (IRCF<2:0>).

The INTSRC bit (OSCTUNE<7>) and MFIOSEL bit (OSCCON2<0>) also decide which INTOSC provides the lower frequency (500 kHz to 31 KHz). For the HF-INTOSC to provide these frequencies, INTSRC = 1 and MFIOSEL = 0.

In HF-INTOSC, the postscaler (IRCF<2:0>) provides the frequency range of 31 kHz to 16 MHz. If HF-INTOSC is used with the PLL, the input frequency to the PLL should be 4 MHz to 16 MHz (IRCF<2:0> = 111, 110 or 101).

For MF-INTOSC mode to provide a frequency range of 500 kHz to 31 kHz, INTSRC = 1 and MFIOSEL = 1. The postscaler (IRCF<2:0>), in this mode, provides the frequency range of 31 kHz to 500 kHz.

The LF-INTRC can provide only 31 kHz if INTSRC = 0.

The LF-INTRC provides 31 kHz and is enabled if it is selected as the device clock source. The mode is enabled automatically when any of the following is enabled:

- Power-up Timer
- · Fail-Safe Clock Monitor
- Watchdog Timer
- Two-Speed Start-up

These features are discussed in greater detail in **Section 28.0 "Special Features of the CPU"**.

The clock source frequency (HF-INTOSC, MF-INTOSC or LF-INTRC direct) is selected by configuring the IRCF bits of the OSCCON register, as well the INTSRC and MFIOSEL bits. The default frequency on device Resets is 8 MHz.

3.6.1 INTIO MODES

Using the internal oscillator as the clock source eliminates the need for up to two external oscillator pins, which can then be used for digital I/O. Two distinct oscillator configurations, which are determined by the OSC Configuration bits, are available:

- In INTIO1 mode, the OSC2 pin (RA6) outputs Fosc/4, while OSC1 functions as RA7 (see Figure 3-8) for digital input and output.
- In INTIO2 mode, OSC1 functions as RA7 and OSC2 functions as RA6 (see Figure 3-9). Both are available as digital input and output ports.

FIGURE 3-8: INTIO1 OSCILLATOR MODE

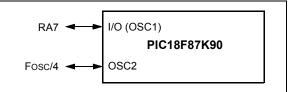
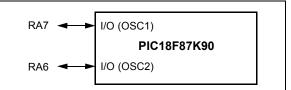


FIGURE 3-9: INTIO2 OSCILLATOR MODE



查询PIC18F67K90供应商 3.6.2 INTPLL MODES

The 4x Phase Locked Loop (PLL) can be used with the HF-INTOSC to produce faster device clock speeds than are normally possible with the internal oscillator sources. When enabled, the PLL produces a clock speed of 16 MHz or 64 MHz.

PLL operation is controlled through software. The control bits, PLLEN (OSCTUNE<6>) and PLLCFG (CONFIG1H<4>), are used to enable or disable its operation. The PLL is available only to HF-INTOSC and the other oscillator is set with HS and EC modes. Additionally, the PLL will only function when the selected output frequency is either 4 MHz or 16 MHz (OSCCON<6:4> = 111, 110 or 101).

Like the INTIO modes, there are two distinct INTPLL modes available:

- In INTPLL1 mode, the OSC2 pin outputs Fosc/4, while OSC1 functions as RA7 for digital input and output. Externally, this is identical in appearance to INTIO1 (Figure 3-8).
- In INTPLL2 mode, OSC1 functions as RA7 and OSC2 functions as RA6, both for digital input and output. Externally, this is identical to INTIO2 (Figure 3-9).

3.6.3 INTERNAL OSCILLATOR OUTPUT FREQUENCY AND TUNING

The internal oscillator block is calibrated at the factory to produce an INTOSC output frequency of 16 MHz. It can be adjusted in the user's application by writing to TUN<5:0> (OSCTUNE<5:0>) in the OSCTUNE register (Register 3-3).

When the OSCTUNE register is modified, the INTOSC (HF-INTOSC and MF-INTOSC) frequency will begin shifting to the new frequency. The oscillator will require some time to stabilize. Code execution continues during this shift and there is no indication that the shift has occurred.

The LF-INTOSC oscillator operates independently of the HF-INTOSC or the MF-INTOSC source. Any changes in the HF-INTOSC or the MF-INTOSC source, across voltage and temperature, are not necessarily reflected by changes in LF-INTOSC or vice versa. The frequency of LF-INTOSC is not affected by OSCTUNE.

3.6.4 INTOSC FREQUENCY DRIFT

The INTOSC frequency may drift as VDD or temperature changes, and can affect the controller operation in a variety of ways. It is possible to adjust the INTOSC frequency by modifying the value in the OSCTUNE register. Depending on the device, this may have no effect on the LF-INTOSC clock source frequency. Tuning INTOSC requires knowing when to make the adjustment, in which direction it should be made, and in some cases, how large a change is needed. Three compensation techniques are shown here.

3.6.4.1 Compensating with the EUSART

An adjustment may be required when the EUSART begins to generate framing errors or receives data with errors while in Asynchronous mode. Framing errors indicate that the device clock frequency is too high. To adjust for this, decrement the value in OSCTUNE to reduce the clock frequency. On the other hand, errors in data may suggest that the clock speed is too low. To compensate, increment OSCTUNE to increase the clock frequency.

3.6.4.2 Compensating with the Timers

This technique compares device clock speed to some reference clock. Two timers may be used; one timer is clocked by the peripheral clock, while the other is clocked by a fixed reference source, such as the SOSC oscillator.

Both timers are cleared, but the timer clocked by the reference generates interrupts. When an interrupt occurs, the internally clocked timer is read and both timers are cleared. If the internally clocked timer value is much greater than expected, then the internal oscillator block is running too fast. To adjust for this, decrement the OSCTUNE register.

3.6.4.3 Compensating with the CCP Module in Capture Mode

A CCP module can use free-running Timer1 (or Timer3), clocked by the internal oscillator block and an external event with a known period (i.e., AC power frequency). The time of the first event is captured in the CCPRxH:CCPRxL registers and is recorded for use later. When the second event causes a capture, the time of the first event is subtracted from the time of the second event. Since the period of the external event is known, the time difference between events can be calculated.

If the measured time is much greater than the calculated time, the internal oscillator block is running too fast. To compensate, decrement the OSCTUNE register. If the measured time is much less than the calculated time, the internal oscillator block is running too slow. To compensate, increment the OSCTUNE register.

查询PIC18F67K90供应商 3.7 Reference Clock Output

In addition to the FOSC/4 clock output in certain oscillator modes, the device clock in the PIC18F87K90 family can also be configured to provide a reference clock output signal to a port pin. This feature is available in all oscillator configurations and allows the user to select a greater range of clock submultiples to drive external devices in the application.

This reference clock output is controlled by the REFOCON register (Register 3-4). Setting the ROON bit (REFOCON<7>) makes the clock signal available on the REFO (RE3) pin. The RODIV<3:0> bits enable the selection of 16 different clock divider options.

The ROSSLP and ROSEL bits (REFOCON<5:4>) control the availability of the reference output during Sleep mode. The ROSEL bit determines if the oscillator on OSC1 and OSC2, or the current system clock source, is used for the reference clock output. The ROSSLP bit determines if the reference source is available on RE3 when the device is in Sleep mode.

To use the reference clock output in Sleep mode, both the ROSSLP and ROSEL bits must be set. The device clock must also be configured for an EC or HS mode; otherwise, the oscillator on OSC1 and OSC2 will be powered down when the device enters Sleep mode.

Clearing the ROSEL bit allows the reference output frequency to change as the system clock changes during any clock switches.

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ROON	—	ROSSLP	ROSEL ⁽¹⁾	RODIV3	RODIV2	RODIV1	RODIV0
bit 7							bit 0

REGISTER 3-4: REFOCON: REFERENCE OSCILLATOR CONTROL REGISTER

Legend:				
R = Readal	ble bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR '1' = Bit is set		'0' = Bit is cleared	x = Bit is unknown	
bit 7	1 = Refe	Reference Oscillator Output E rence oscillator output is avai rence oscillator output is disa	lable on REFO pin	
bit 6	Unimple	mented: Read as '0'		
bit 5	1 = Refe	P: Reference Oscillator Outpurence oscillator continues to rence oscillator continues to rence oscillator is disabled in	run in Sleep	
bit 4	1 = Prima	Reference Oscillator Source ary oscillator (EC or HS) is us em clock is used as the base		clock switching of the devic
bit 3-0	1111 = E 1110 = E 1101 = E 1001 = E 1011 = E 1010 = E 1000 = E 0111 = E 0110 = E 0101 = E 0100 = E 0011 = E 0010 = E 0010 = E	3:0>: Reference Oscillator Di Base clock value divided by 3 Base clock value divided by 4 Base clock value divided by 4 Base clock value divided by 2 Base clock value divided by 2 Base clock value divided by 5 Base clock value divided by 5 Base clock value divided by 2 Base clock value divided by 4 Base clock value divided by 4	2,768 6,384 ,192 ,096 ,048 ,024 12 56 28 4 28 4 2 6	

Note 1: For ROSEL (REFOCON<4>), the primary oscillator is only available when configured as default via the FOSC settings (regardless of whether the device is in Sleep mode).

查询PIC18F67K90供应商

3.8 Effects of Power-Managed Modes on the Various Clock Sources

When PRI_IDLE mode is selected, the designated primary oscillator continues to run without interruption. For all other power-managed modes, the oscillator using the OSC1 pin is disabled. The OSC1 pin (and OSC2 pin if used by the oscillator) will stop oscillating.

In secondary clock modes (SEC_RUN and SEC_IDLE), the SOSC oscillator is operating and providing the device clock. The SOSC oscillator may also run in all power-managed modes if required to clock SOSC.

In RC_RUN and RC_IDLE modes, the internal oscillator provides the device clock source. The 31 kHz LF-INTOSC output can be used directly to provide the clock and may be enabled to support various special features, regardless of the power-managed mode (see Section 28.2 "Watchdog Timer (WDT)" through Section 28.5 "Fail-Safe Clock Monitor" for more information on WDT, Fail-Safe Clock Monitor and Two-Speed Start-up).

If the Sleep mode is selected, all clock sources are stopped. Since all the transistor switching currents have been stopped, Sleep mode achieves the lowest current consumption of the device (only leakage currents).

Enabling any on-chip feature that will operate during Sleep will increase the current consumed during Sleep. The INTOSC is required to support WDT operation. The SOSC oscillator may be operating to support a Real-Time Clock (RTC). Other features may be operating that do not require a device clock source (i.e., MSSP slave, INTx pins and others). Peripherals that may add significant current consumption are listed in Section 31.2 "DC Characteristics: Power-Down and Supply Current PIC18F87K90 Family (Industrial)".

3.9 Power-up Delays

Power-up delays are controlled by two timers, so that no external Reset circuitry is required for most applications. The delays ensure that the device is kept in Reset until the device power supply is stable under normal circumstances and the primary clock is operating and stable. For additional information on power-up delays, see **Section 5.6 "Power-up Timer (PWRT)**".

The first timer is the Power-up Timer (PWRT), which provides a fixed delay on power-up time of about 64 ms (parameter 33, Table 31-10); it is always enabled.

The second timer is the Oscillator Start-up Timer (OST), intended to keep the chip in Reset until the crystal oscillator is stable (HS, XT or LP modes). The OST does this by counting 1,024 oscillator cycles before allowing the oscillator to clock the device.

There is a delay of interval, TCSD (parameter 38, Table 31-10), following POR, while the controller becomes ready to execute instructions.

Oscillator Mode	OSC1 Pin	OSC2 Pin
EC, ECPLL	Floating, pulled by external clock	At logic low (clock/4 output)
HS, HSPLL	Feedback inverter disabled at quiescent voltage level	Feedback inverter disabled at quiescent voltage level
INTOSC, INTPLL1/2	I/O pin, RA6, direction controlled by TRISA<6>	I/O pin, RA6, direction controlled by TRISA<7>

 TABLE 3-4:
 OSC1 AND OSC2 PIN STATES IN SLEEP MODE

Note: See **Section 5.0** "**Reset**" for time-outs due to Sleep and MCLR Reset.

查询PIC18F67K90供应商 4.0 POWER-MANAGED MODES

The PIC18F87K90 family of devices offers a total of seven operating modes for more efficient power management. These modes provide a variety of options for selective power conservation in applications where resources may be limited (such as battery-powered devices).

There are three categories of power-managed modes:

- Run modes
- Idle modes
- · Sleep mode

There is an Ultra Low-Power Wake-up (ULPWU) for waking from the Sleep mode.

These categories define which portions of the device are clocked, and sometimes, at what speed. The Run and Idle modes may use any of the three available clock sources (primary, secondary or internal oscillator block). The Sleep mode does not use a clock source.

The ULPWU mode, on the RA0 pin, enables a slow falling voltage to generate a wake-up, even from Sleep, without excess current consumption. (See Section 4.7 "Ultra Low-Power Wake-up".)

The power-managed modes include several powersaving features offered on previous PIC[®] devices. One is the clock switching feature, offered in other PIC18 devices. This feature allows the controller to use the SOSC oscillator instead of the primary one. Another power-saving feature is Sleep mode, offered by all PIC devices, where all device clocks are stopped.

4.1 Selecting Power-Managed Modes

Selecting a power-managed mode requires two decisions:

- · Will the CPU be clocked or not
- · What will be the clock source

The IDLEN bit (OSCCON<7>) controls CPU clocking, while the SCS<1:0> bits (OSCCON<1:0>) select the clock source. The individual modes, bit settings, clock sources and affected modules are summarized in Table 4-1.

4.1.1 CLOCK SOURCES

The SCS<1:0> bits select one of three clock sources for power-managed modes. Those sources are:

- The primary clock, as defined by the OSC<3:0> Configuration bits
- The secondary clock (the SOSC oscillator)
- The internal oscillator block (for LF-INTOSC modes)

4.1.2 ENTERING POWER-MANAGED MODES

Switching from one power-managed mode to another begins by loading the OSCCON register. The SCS<1:0> bits select the clock source and determine which Run or Idle mode is used. Changing these bits causes an immediate switch to the new clock source, assuming that it is running. The switch may also be subject to clock transition delays. These considerations are discussed in **Section 4.1.3 "Clock Transitions and Status Indicators"** and subsequent sections.

Entering the power-managed Idle or Sleep modes is triggered by the execution of a SLEEP instruction. The actual mode that results depends on the status of the IDLEN bit.

Depending on the current and impending mode, a change to a power-managed mode does not always require setting all of the previously discussed bits. Many transitions can be done by changing the oscillator select bits, or changing the IDLEN bit, prior to issuing a SLEEP instruction. If the IDLEN bit is already configured as desired, it may only be necessary to perform a SLEEP instruction to switch to the desired mode.

Mada	OSCCON Bits		Module Clocking		Available Cleak and Casillater Source		
Mode	IDLEN<7>(1)	SCS<1:0>	CPU	Peripherals	Available Clock and Oscillator Source		
Sleep	0	N/A	Off	Off	None – All clocks are disabled		
PRI_RUN	N/A	00	Clocked	Clocked	Primary – XT, LP, HS, EC, RC and PLL modes. This is the normal, full-power execution mode.		
SEC_RUN	N/A	01	Clocked	Clocked	Secondary – SOSC Oscillator		
RC_RUN	N/A	1x	Clocked	Clocked	Internal oscillator block ⁽²⁾		
PRI_IDLE	1	00	Off	Clocked	Primary – LP, XT, HS, RC, EC		
SEC_IDLE	1	01	Off	Clocked	Secondary – SOSC oscillator		
RC_IDLE	1	1x	Off	Clocked	Internal oscillator block ⁽²⁾		

TABLE 4-1:POWER-MANAGED MODES

Note 1: IDLEN reflects its value when the **SLEEP** instruction is executed.

2: Includes INTOSC (HF-INTOSC and MG-INTOSC) and INTOSC postscaler, as well as the LF-INTISC source.

查询PIC18F67K90供应商

4.1.3 CLOCK TRANSITIONS AND STATUS INDICATORS

The length of the transition between clock sources is the sum of two cycles of the old clock source and three to four cycles of the new clock source. This formula assumes that the new clock source is stable. The HF-INTOSC and MF-INTOSC are termed as INTOSC in this chapter.

Three bits indicate the current clock source and its status, as shown in Table 4-2. The three bits are:

- OSTS (OSCCON<3>)
- HFIOFS (OSCCON<2>)
- SOSCRUN (OSCCON2<6>)

TABLE 4-2: SYSTEM CLOCK INDICATOR

Main Clock Source	OSTS	HFIOFS or MFIOFS	SOSCRUN
Primary Oscillator	1	0	0
INTOSC (HF-INTOSC or MF-INTOSC)	0	1	0
Secondary Oscillator	0	0	1
MF-INTOSC or HF-INTOSC as Primary Clock Source	1	1	0
LF-INTOSC is Running or INTOSC is Not Yet Stable	0	0	0

When the OSTS bit is set, the primary clock is providing the device clock. When the HFIOFS or MFIOFS bit is set, the INTOSC output is providing a stable clock source to a divider that actually drives the device clock. When the SOSCRUN bit is set, the SOSC oscillator is providing the clock. If none of these bits are set, either the LF-INTOSC clock source is clocking the device or the INTOSC source is not yet stable.

If the internal oscillator block is configured as the primary clock source by the OSC<3:0> Configuration bits (CONFIG1H<3:0>). Then, the OSTS and HFIOFS or MFIOFS bits can be set when in PRI_RUN or PRI_IDLE modes. This indicates that the primary clock (INTOSC output) is generating a stable output. Entering another INTOSC power-managed mode at the same frequency would clear the OSTS bit.

- Note 1: Caution should be used when modifying a single IRCF bit. At a lower VDD, it is possible to select a higher clock speed than is supportable by that VDD. Improper device operation may result if the VDD/ Fosc specifications are violated.
 - 2: Executing a SLEEP instruction does not necessarily place the device into Sleep mode. It acts as the trigger to place the controller into either the Sleep mode or one of the Idle modes, depending on the setting of the IDLEN bit.

4.1.4 MULTIPLE SLEEP COMMANDS

The power-managed mode that is invoked with the SLEEP instruction is determined by the setting of the IDLEN bit at the time the instruction is executed. If another SLEEP instruction is executed, the device will enter the power-managed mode specified by IDLEN at that time. If IDLEN has changed, the device will enter the new power-managed mode specified by the new setting.

4.2 Run Modes

In the Run modes, clocks to both the core and peripherals are active. The difference between these modes is the clock source.

4.2.1 PRI_RUN MODE

The PRI_RUN mode is the normal, full-power execution mode of the microcontroller. This is also the default mode upon a device Reset, unless Two-Speed Start-up is enabled. (For details, see **Section 28.4 "Two-Speed Start-up**".) In this mode, the OSTS bit is set. The HFIOFS or MFIOFS bit may be set if the internal oscillator block is the primary clock source. (See **Section 3.2 "Control Registers"**.)

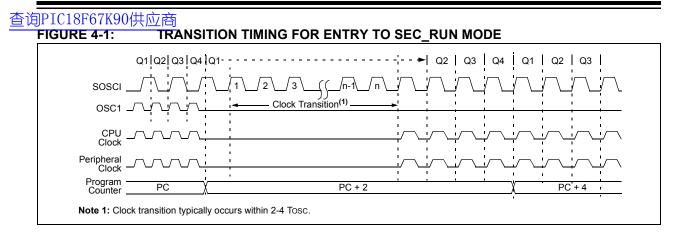
4.2.2 SEC_RUN MODE

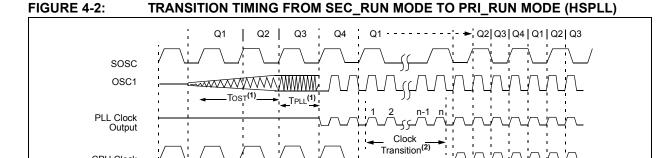
The SEC_RUN mode is the compatible mode to the "clock-switching" feature offered in other PIC18 devices. In this mode, the CPU and peripherals are clocked from the SOSC oscillator. This enables lower power consumption while retaining a high-accuracy clock source.

SEC_RUN mode is entered by setting the SCS<1:0> bits to '01'. The device clock source is switched to the SOSC oscillator (see Figure 4-1), the primary oscillator is shut down, the SOSCRUN bit (OSCCON2<6>) is set and the OSTS bit is cleared.

SEC_RUN mode can switch immediately once SCS<1:0> are set to '01'.	If this bit is set, the clock switch to the	Note: The SOSC oscillator can be enabled by setting the SOSCGO bit (OSCCON2<3>).	se If	
--	---	--	----------	--

On transitions from SEC_RUN mode to PRI_RUN mode, the peripherals and CPU continue to be clocked from the SOSC oscillator while the primary clock is started. When the primary clock becomes ready, a clock switch back to the primary clock occurs (see Figure 4-2). When the clock switch is complete, the SOSCRUN bit is cleared, the OSTS bit is set and the primary clock is providing the clock. The IDLEN and SCS bits are not affected by the wake-up and the SOSC oscillator continues to run.





OSTS bit Set

Note 1: TOST = 1024 TOSC; TPLL = 2 ms (approx). These intervals are not shown to scale.

4.2.3 RC_RUN MODE

CPU Clock Peripheral Clock Program Counter

In RC_RUN mode, the CPU and peripherals are clocked from the internal oscillator block using the INTOSC multiplexer. In this mode, the primary clock is shut down. When using the LF-INTOSC source, this mode provides the best power conservation of all the Run modes, while still executing code. It works well for user applications which are not highly timing-sensitive or do not require high-speed clocks at all times.

SCS<1:0> bits Changed

2: Clock transition typically occurs within 2-4 Tosc.

If the primary clock source is the internal oscillator block – either LF-INTOSC or INTOSC (MF-INTOSC or HF-INTOSC) – there are no distinguishable differences between the PRI_RUN and RC_RUN modes during execution. Entering or exiting RC_RUN mode, however, causes a clock switch delay. Therefore, if the primary clock source is the internal oscillator block, using RC_RUN mode is not recommended. This mode is entered by setting the SCS1 bit to '1'. To maintain software compatibility with future devices, it is recommended that the SCS0 bit also be cleared, even though the bit is ignored. When the clock source is switched to the INTOSC multiplexer (see Figure 4-3), the primary oscillator is shut down and the OSTS bit is cleared. The IRCF bits may be modified at any time to immediately change the clock speed.

Note: Caution should be used when modifying a single IRCF bit. At a lower VDD, it is possible to select a higher clock speed than is supportable by that VDD. Improper device operation may result if the VDD/ Fosc specifications are violated.

查询PIC18F67K90供应商

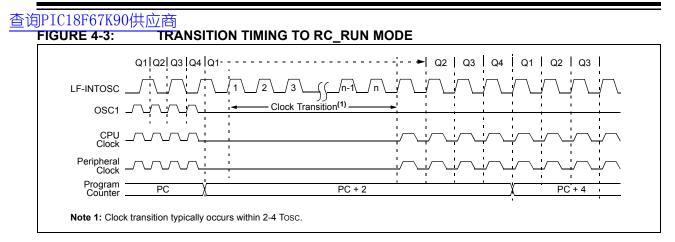
If the IRCF bits and the INTSRC bit are all clear, the INTOSC output (HF-INTOSC/MF-INTOSC) is not enabled and the HFIOFS and MFIOFS bits will remain clear. There will be no indication of the current clock source. The LF-INTOSC source is providing the device clocks. If the IRCF bits are changed from all clear (thus, enabling the INTOSC output) or if INTSRC or MFIOSEL is set, the HFIOFS or MFIOFS bit is set after the INTOSC output becomes stable. For details, see Table 4-3.

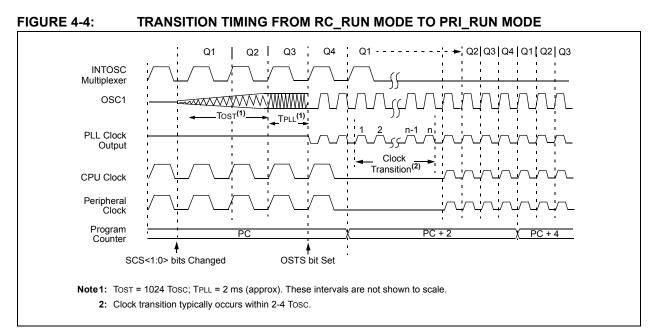
IRCF<2:0>	INTSRC	MFIOSEL	Status of MFIOFS or HFIOFS when INTOSC is Stable
000	0	x	MFIOFS = 0, HFIOFS = 0 and clock source is LF-INTOSC
000	1	0	MFIOFS = 0, HFIOFS = 1 and clock source is HF-INTOSC
000	1	1	MFIOFS = 1, HFIOFS = 0 and clock source is MF-INTOSC
Non-Zero	x	0	MFIOFS = 0, HFIOFS = 1 and clock source is HF-INTOSC
Non-Zero	x	1	MFIOFS = 1, HFIOFS = 0 and clock source is MF-INTOSC

TABLE 4-3: INTERNAL OSCILLATOR FREQUENCY STABILITY BITS

Clocks to the device continue while the INTOSC source stabilizes after an interval of TIOBST (parameter 39, Table 31-10).

If the IRCF bits were previously at a non-zero value, or if INTSRC was set before setting SCS1 and the INTOSC source was already stable, the HFIOFS or MFIOFS bit will remain set. On transitions from RC_RUN mode to PRI_RUN mode, the device continues to be clocked from the INTOSC multiplexer while the primary clock is started. When the primary clock becomes ready, a clock switch to the primary clock occurs (see Figure 4-4). When the clock switch is complete, the HFIOFS or MFIOFS bit is cleared, the OSTS bit is set and the primary clock is providing the device clock. The IDLEN and SCS bits are not affected by the switch. The LF-INTOSC source will continue to run if either the WDT or the Fail-Safe Clock Monitor is enabled.





查询PIC18F67K90供应商 4.3 Sleep Mode

The power-managed Sleep mode in the PIC18F87K90 family of devices is identical to the legacy Sleep mode offered in all other PIC devices. It is entered by clearing the IDLEN bit (the default state on device Reset) and executing the SLEEP instruction. This shuts down the selected oscillator (Figure 4-5). All clock source status bits are cleared.

Entering Sleep mode from any other mode does not require a clock switch. This is because no clocks are needed once the controller has entered Sleep. If the WDT is selected, the LF-INTOSC source will continue to operate. If the SOSC oscillator is enabled, it will also continue to run.

When a wake event occurs in Sleep mode (by interrupt, Reset or WDT time-out), the device will not be clocked until the clock source selected by the SCS<1:0> bits becomes ready (see Figure 4-6). Alternately, the device will be clocked from the internal oscillator block if either the Two-Speed Start-up or the Fail-Safe Clock Monitor is enabled (see **Section 28.0 "Special Features of the CPU"**). In either case, the OSTS bit is set when the primary clock is providing the device clocks. The IDLEN and SCS bits are not affected by the wake-up.

4.4 Idle Modes

The Idle modes allow the controller's CPU to be selectively shut down while the peripherals continue to operate. Selecting a particular Idle mode allows users to further manage power consumption.

If the IDLEN bit is set to a '1' when a SLEEP instruction is executed, the peripherals will be clocked from the clock source selected using the SCS<1:0> bits. The CPU, however, will not be clocked. The clock source status bits are not affected. This approach is a quick method to switch from a given Run mode to its corresponding Idle mode.

If the WDT is selected, the LF-INTOSC source will continue to operate. If the SOSC oscillator is enabled, it will also continue to run.

Since the CPU is not executing instructions, the only exits from any of the Idle modes are by interrupt, WDT time-out or a Reset. When a wake event occurs, CPU execution is delayed by an interval of TCSD (parameter 38, Table 31-10) while it becomes ready to execute code. When the CPU begins executing code, it resumes with the same clock source for the current Idle mode. For example, when waking from RC_IDLE mode, the internal oscillator block will clock the CPU and peripherals (in other words, RC_RUN mode). The IDLEN and SCS bits are not affected by the wake-up.

While in any Idle mode or Sleep mode, a WDT timeout will result in a WDT wake-up to the Run mode currently specified by the SCS<1:0> bits.

FIGURE 4-5: TRANSITION TIMING FOR ENTRY TO SLEEP MODE

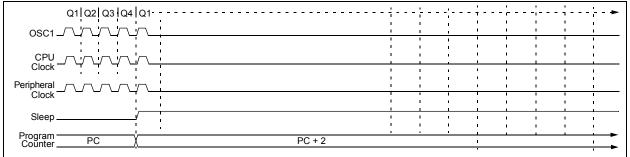
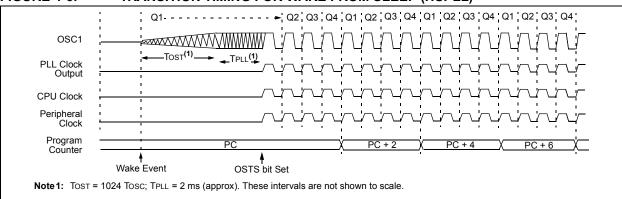


FIGURE 4-6: TRANSITION TIMING FOR WAKE FROM SLEEP (HSPLL)



查询PIC18F67K90供应商 4.4.1 PRI IDLE MODE

This mode is unique among the three low-power ldle modes, in that it does not disable the primary device clock. For timing-sensitive applications, this allows for the fastest resumption of device operation with its more accurate, primary clock source, since the clock source does not have to "warm-up" or transition from another oscillator.

PRI_IDLE mode is entered from PRI_RUN mode by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, set IDLEN first, then clear the SCS bits and execute SLEEP. Although the CPU is disabled, the peripherals continue to be clocked from the primary clock source specified by the OSC<3:0> Configuration bits. The OSTS bit remains set (see Figure 4-7).

When a wake event occurs, the CPU is clocked from the primary clock source. A delay of interval, TCSD (parameter 39, Table 31-10), is required between the wake event and the start of code execution. This is required to allow the CPU to become ready to execute instructions. After the wake-up, the OSTS bit remains set. The IDLEN and SCS bits are not affected by the wake-up (see Figure 4-8).

4.4.2 SEC_IDLE MODE

In SEC_IDLE mode, the CPU is disabled but the peripherals continue to be clocked from the SOSC oscillator. This mode is entered from SEC_RUN by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, set the IDLEN bit first, then set the SCS<1:0> bits to '01' and execute SLEEP. When the clock source is switched to the SOSC oscillator, the primary oscillator is shut down, the OSTS bit is cleared and the SOSCRUN bit is set.

When a wake event occurs, the peripherals continue to be clocked from the SOSC oscillator. After an interval of TCSD following the wake event, the CPU begins executing code being clocked by the SOSC oscillator. The IDLEN and SCS bits are not affected by the wake-up and the SOSC oscillator continues to run (see Figure 4-8).

FIGURE 4-7: TRANSITION TIMING FOR ENTRY TO IDLE MODE

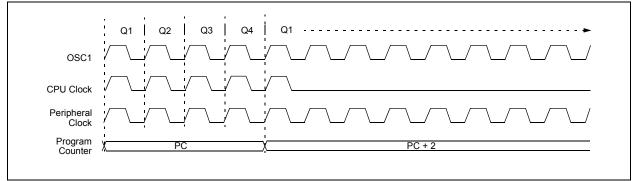
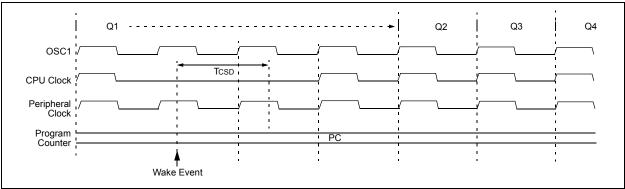


FIGURE 4-8: TRANSITION TIMING FOR WAKE FROM IDLE TO RUN MODE



查询PIC18F67K90供应商 4.4.3 RC IDLE MODE

In RC_IDLE mode, the CPU is disabled but the peripherals continue to be clocked from the internal oscillator block using the INTOSC multiplexer. This mode provides controllable power conservation during Idle periods.

From RC_RUN, this mode is entered by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, first set IDLEN, then set the SCS1 bit and execute SLEEP. To maintain software compatibility with future devices, it is recommended that SCS0 also be cleared, though its value is ignored. The INTOSC multiplexer may be used to select a higher clock frequency by modifying the IRCF bits before executing the SLEEP instruction. When the clock source is switched to the INTOSC multiplexer, the primary oscillator is shut down and the OSTS bit is cleared.

If the IRCF bits are set to any non-zero value, or the INTSRC/MFIOSEL bit is set, the INTOSC output is enabled. The HFIOFS/MFIOFS bits become set, after the INTOSC output becomes stable after an interval of TIOBST (parameter 38, Table 31-10). (For information on the HFIOFS/MFIOFS bits, see Table 4-3.)

Clocks to the peripherals continue while the INTOSC source stabilizes. The HFIOFS/MFIOFS bits will remain set if the IRCF bits were previously at a non-zero value or if INTSRC was set before the SLEEP instruction was executed and the INTOSC source was already stable. If the IRCF bits and INTSRC are all clear, the INTOSC output will not be enabled, the HFIOFS/MFIOFS bits will remain clear and there will be no indication of the current clock source.

When a wake event occurs, the peripherals continue to be clocked from the INTOSC multiplexer. After a delay of TCSD (parameter 38, Table 31-10), following the wake event, the CPU begins executing code clocked by the INTOSC multiplexer. The IDLEN and SCS bits are not affected by the wake-up. The INTRC source will continue to run if either the WDT or the Fail-Safe Clock Monitor is enabled.

4.5 Selective Peripheral Module Control

Idle mode allows users to substantially reduce power consumption by stopping the CPU clock. Even so, peripheral modules still remain clocked, and thus, consume power. There may be cases where the application needs what this mode does not provide: the allocation of power resources to the CPU processing with minimal power consumption from the peripherals.

PIC18F87K90 family devices address this requirement by allowing peripheral modules to be selectively disabled, reducing or eliminating their power consumption. This can be done with two control bits:

- Peripheral Enable bit, generically named XXXEN Located in the respective module's main Control register
- Peripheral Module Disable (PMD) bit, generically named XXXMD – Located in one of the PMDx Control registers (PMD0, PMD1, PMD2 or PMD3)

Disabling a module by clearing its XXXEN bit disables the module's functionality, but leaves its registers available to be read and written to. This reduces power consumption, but not by as much as the second approach.

Most peripheral modules have an enable bit.

In contrast, setting the PMD bit for a module disables all clock sources to that module, reducing its power consumption to an absolute minimum. In this state, the control and status registers associated with the peripheral are also disabled, so writes to those registers have no effect and read values are invalid. Many peripheral modules have a corresponding PMD bit.

There are four PMD registers in PIC18F87K90 family devices: PMD0, PMD1, PMD2 and PMD3. These registers have bits associated with each module for disabling or enabling a particular peripheral.

查询PIC18F67K90供应商 REGISTER 4-1: PMD3: PERIPHERAL MODULE DISABLE REGISTER 3 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 CCP10MD⁽¹⁾ CCP9MD⁽¹⁾ CCP8MD CCP7MD CCP6MD CCP5MD CCP4MD TMR12MD⁽¹⁾ bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown CCP10MD: PMD CCP10 Enable/Disable bit⁽¹⁾ bit 7 1 = Peripheral Module Disable (PMD) is enabled for CCP10, disabling all of its clock sources 0 = PMD is disabled for CCP10 **CCP9MD:** PMD CCP9 Enable/Disable bit⁽¹⁾ bit 6 1 = Peripheral Module Disable (PMD) is enabled for CCP9, disabling all of its clock sources 0 = PMD is disabled for CCP9 CCP8MD: PMD CCP8 Enable/Disable bit bit 5 1 = Peripheral Module Disable (PMD) is enabled for CCP8, disabling all of its clock sources 0 = PMD is disabled for CCP8 bit 4 CCP7MD: PMD CCP7 Enable/Disable bit 1 = Peripheral Module Disable (PMD) is enabled for CCP7, disabling all of its clock sources 0 = PMD is disabled for CCP7 bit 3 CCP6MD: PMD CCP6 Enable/Disable bit 1 = Peripheral Module Disable (PMD) is enabled for CCP6, disabling all of its clock sources 0 = PMD is disabled for CCP6 bit 2 CCP5MD: PMD CCP5 Enable/Disable bit 1 = Peripheral Module Disable (PMD) is enabled for CCP5, disabling all of its clock sources 0 = PMD is disabled for CCP5 bit 1 CCP4MD: PMD CCP4 Enable/Disable bit 1 = Peripheral Module Disable (PMD) is enabled for CCP4, disabling all of its clock sources

- bit 0 TMR12MD: TMR12MD Disable bit⁽¹⁾ 1 = PMD is enabled and all TMR12MD clock sources are disabled 0 = PMD is disabled and TMR12MD is enabled
 - Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商

REGISTER 4-2: PMD2: PERIPHERAL MODULE DISABLE REGISTER 2

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
TMR10MD ⁽¹⁾	TMR8MD	TMR7MD ⁽¹⁾	TMR6MD	TMR5MD	CMP3MD	CMP2MD	CMP1MD
bit 7	-						bit
Legend:							
R = Readable	bit	W = Writable b	oit	U = Unimpler	mented bit, read	l as '0'	
-n = Value at I	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
			(4)				
bit 7		MR10MD Disal					
		al Module Disat disabled and TM			TMR10MD clo	ck sources are	disabled
bit 6				abied			
	TMR8MD: TMR8MD Disable bit 1 = PMD is enabled and all TMR8MD clock sources are disabled						
	0 = PMD is disabled and TMR8MD clock sources are disabled 0 = PMD is disabled and TMR8MD is enabled						
bit 5	TMR7MD : TMR7MD Disable bit ⁽¹⁾						
	1 = PMD is enabled and all TMR7MD clock sources are disabled						
	0 = PMD is disabled and TMR7MD is enabled						
bit 4	TMR6MD: TMR6MD Disable bit						
	 1 = PMD is enabled and all TMR6MD clock sources are disabled 0 = PMD is disabled and TMR6MD is enabled 						
bit 3				bied			
	TMR5MD: TMR5MD Disable bit 1 = PMD is enabled and all TMR5MD clock sources are disabled						
	 1 = PMD is enabled and all TMR5MD clock sources are disabled 0 = PMD is disabled and TMR5MD is enabled 						
bit 2	CMP3MD: PI	MD Comparator	3 Enable/Dis	able bit			
	CMP3MD: PMD Comparator 3 Enable/Disable bit 1 = PMD is enabled for Comparator 3, disabling all of its clock sources						
		lisabled for Con					
bit 1		MD Comparator					
		enabled for Com lisabled for Con		sabling all of its	clock sources		
bit 0		MD Comparator	-	able hit			
		enabled for Corr			clock sources		
		lisabled for Con					

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商 REGISTER 4-3: PMD1: PERIPHERAL MODULE DISABLE REGISTER 1

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	CTMUMD	RTCCMD ⁽¹⁾	TMR4MD	TMR3MD	TMR2MD	TMR1MD	_
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6	CTMUMD: PMD CTMU Enable/Disable bit
	 1 = Peripheral Module Disable (PMD) is enabled for CMTU, disabling all of its clock sources 0 = PMD is disabled for CMTU
bit 5	RTCCMD: PMD RTCC Enable/Disable bit ⁽¹⁾
	1 = PMD is enabled for RTCC, disabling all of its clock sources0 = PMD is disabled for RTCC
bit 4	TMR4MD: TMR4MD Disable bit
	1 = PMD is enabled and all TMR4MD clock sources are disabled0 = PMD is disabled and TMR4MD is enabled
bit 3	TMR3MD: TMR3MD Disable bit
	1 = PMD is enabled and all TMR3MD clock sources are disabled0 = PMD is disabled and TMR3MD is enabled
bit 2	TMR2MD: TMR2MD Disable bit
	1 = PMD is enabled and all TMR2MD clock sources are disabled0 = PMD is disabled and TMR2MD is enabled
bit 1	TMR1MD: TMR1MD Disable bit
	1 = PMD is enabled and all TMR1MD clock sources are disabled0 = PMD is disabled and TMR1MD is enabled
bit 0	Unimplemented: Read as '0'

Note 1: RTCCMD can only be set to '1' after an EECON2 unlock sequence; refer to Section 17.0 "Real-Time Clock and Calendar (RTCC)" for the unlock sequence (see Example 17-1).

查询PIC18F67K90供应商 REGISTER 4-4: PMD0: PERIPHERAL MODULE DISABLE REGISTER 0

R/W-0	R/W-0 R/W-0		R/W-0	R/W-0 R/W-0		R/W-0	R/W-0
CCP3MD	MD CCP2MD CCP1MD UART2MD		UART1MD	SSP2MD	SSP1MD	ADCMD	
bit 7			•				bit 0

Legend:				
R = Readable bit		W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
bit 7	1 = Peri	D: PMD ECCP3 Enable/Disab pheral Module Disable (PMD) D is disabled for ECCP3		ling all of its clock sources
bit 6	1 = PM[D: PMD ECCP2 Enable/Disab D is enabled for ECCP2, disab D is disabled for ECCP2		
bit 5	1 = PMD	D: PMD ECCP1 Enable/Disab D is enabled for ECCP1, disab D is disabled for ECCP1		
bit 4	1 = PM	ID: PMD UART2 Enable/Disa D is enabled for UART2, disab D is disabled for UART2		
bit 3	1 = PM[ID: PMD UART1 Enable/Disa) is enabled for UART1, disab) is disabled for UART1		
bit 2	1 = PM[9: PMD MSSP2 Enable/Disab D is enabled for MSSP2, disab D is disabled for MSSP2		
bit 1	1 = PM[b: PMD MSSP1 Enable/Disab D is enabled for MSSP1, disab D is disabled for MSSP1		
bit 0	1 = PM[: PMD Analog/Digital Converte D is enabled for Analog/Digital D is disabled for Analog/Digita	Converter, disabling all of its	s clock sources

查询PIC18F67K90供应商 4.6 Exiting Idle and Sleep Modes

An exit from Sleep mode or any of the Idle modes is triggered by an interrupt, a Reset or a WDT time-out. This section discusses the triggers that cause exits from power-managed modes. The clocking subsystem actions are discussed in each of the power-managed modes (see Section 4.2 "Run Modes", Section 4.3 "Sleep Mode" and Section 4.4 "Idle Modes").

4.6.1 EXIT BY INTERRUPT

Any of the available interrupt sources can cause the device to exit from an Idle or Sleep mode to a Run mode. To enable this functionality, an interrupt source must be enabled by setting its enable bit in one of the INTCONx or PIEx registers. The exit sequence is initiated when the corresponding interrupt flag bit is set.

On all exits from Idle or Sleep modes by interrupt, code execution branches to the interrupt vector if the GIE/ GIEH bit (INTCON<7>) is set. Otherwise, code execution continues or resumes without branching (see **Section 10.0 "Interrupts"**).

4.6.2 EXIT BY WDT TIME-OUT

A WDT time-out will cause different actions depending on which power-managed mode the device is in when the time-out occurs.

If the device is not executing code (all Idle modes and Sleep mode), the time-out will result in an exit from the power-managed mode (see Section 4.2 "Run Modes" and Section 4.3 "Sleep Mode"). If the device is executing code (all Run modes), the time-out will result in a WDT Reset (see Section 28.2 "Watchdog Timer (WDT)").

Executing a SLEEP or CLRWDT instruction clears the WDT timer and postscaler, loses the currently selected clock source (if the Fail-Safe Clock Monitor is enabled) and modifies the IRCF bits in the OSCCON register (if the internal oscillator block is the device clock source).

4.6.3 EXIT BY RESET

Normally, the device is held in Reset by the Oscillator Start-up Timer (OST) until the primary clock becomes ready. At that time, the OSTS bit is set and the device begins executing code. If the internal oscillator block is the new clock source, the HFIOFS/MFIOFS bits are set instead.

The exit delay time from Reset to the start of code execution depends on both the clock sources before and after the wake-up, and the type of oscillator if the new clock source is the primary clock. Exit delays are summarized in Table 4-4.

Code execution can begin before the primary clock becomes ready. If either the Two-Speed Start-up (see Section 28.4 "Two-Speed Start-up") or Fail-Safe Clock Monitor (see Section 28.5 "Fail-Safe Clock Monitor") is enabled, the device may begin execution as soon as the Reset source has cleared. Execution is clocked by the INTOSC multiplexer driven by the internal oscillator block. Execution is clocked by the internal oscillator block. Execution is clocked by the internal oscillator block until either the primary clock becomes ready or a power-managed mode is entered before the primary clock becomes ready; the primary clock is then shut down.

4.6.4 EXIT WITHOUT AN OSCILLATOR START-UP DELAY

Certain exits from power-managed modes do not invoke the OST at all. The two cases are:

- When in PRI_IDLE mode, where the primary clock source is not stopped
- When the primary clock source is not any of the LP, XT, HS or HSPLL modes

In these instances, the primary clock source either does not require an oscillator start-up delay, since it is already running (PRI_IDLE), or normally does not require an oscillator start-up delay (RC, EC and INTIO Oscillator modes). However, a fixed delay of interval, TCSD, following the wake event is still required when leaving Sleep and Idle modes to allow the CPU to prepare for execution. Instruction execution resumes on the first clock cycle following this delay.

查询PIC18F67K90供应商

4.7 Ultra Low-Power Wake-up

The Ultra Low-Power Wake-up (ULPWU) on pin, RA0, allows a slow falling voltage to generate an interrupt without excess current consumption.

To use this feature:

- 1. Charge the capacitor on RA0 by configuring the RA0 pin to an output and setting it to '1'.
- 2. Stop charging the capacitor by configuring RA0 as an input.
- 3. Discharge the capacitor by setting the ULPEN and ULPSINK bits in the WDTCON register.
- 4. Configure Sleep mode.
- 5. Enter Sleep mode.

When the voltage on RA0 drops below VIL, the device wakes up and executes the next instruction.

This feature provides a low-power technique for periodically waking up the device from Sleep mode.

The time-out is dependent on the discharge time of the RC circuit on RA0.

When the ULPWU module wakes the device from Sleep mode, the ULPLVL bit (WDTCON<5>) is set. Software can check this bit upon wake-up to determine the wake-up source.

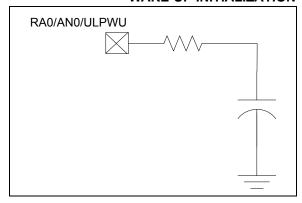
See Example 4-1 for initializing the ULPWU module.

EXAMPLE 4-1: ULTRA LOW-POWER WAKE-UP INITIALIZATION

```
//Charge the capacitor on RAO
       TRISAbits.TRISA0 = 0;
PORTAbits.RA0 = 1;
for(i = 0; i < 10000; i++) Nop();</pre>
       //Stop Charging the capacitor
       //on RAO
       TRISAbits.TRISA0 = 1;
       //Enable the Ultra Low Power
       //Wakeup module and allow
       //capacitor discharge
       WDTCONbits ULPEN = 1;
WDTCONbits.ULPSINK = 1;
       //For Sleep
OSCCONbits.IDLEN = 0;
       //Enter Sleep Mode
       11
Sleep();
       //for sleep, execution will
       //resume here
```

A series resistor, between RA0 and the external capacitor, provides overcurrent protection for the RA0/AN0/ ULPWU pin and enables software calibration of the time-out (see Figure 4-9).

FIGURE 4-9: ULTRA LOW-POWER WAKE-UP INITIALIZATION



A timer can be used to measure the charge time and discharge time of the capacitor. The charge time can then be adjusted to provide the desired delay in Sleep. This technique compensates for the affects of temperature, voltage and component accuracy. The peripheral can also be configured as a simple programmable Low-Voltage Detect (LVD) or temperature sensor.

Note: For more information, see AN 879, "Using the Microchip Ultra Low-Power Wake-up Module" (DS00879).

查询PIC18F67K90供应商

TABLE 4-4: EXIT DELAY ON WAKE-UP BY RESET FROM SLEEP MODE OR ANY IDLE MODE (BY CLOCK SOURCES)

Power-Managed Mode	Clock Source ⁽⁵⁾	Exit Delay	Clock Ready Status Bits		
	LP, XT, HS				
	HSPLL		OSTS		
	EC, RC	TCSD ⁽¹⁾			
PRI_IDLE mode	HF-INTOSC ⁽²⁾	ICSD(*)	HFIOFS		
	MF-INTOSC ⁽²⁾		MFIOFS		
	LF-INTOSC		None		
SEC_IDLE mode	SOSC T _{CSD} ⁽¹⁾		SOSCRUN		
	HF-INTOSC ⁽²⁾		HFIOFS		
RC_IDLE mode	MF-INTOSC ⁽²⁾	Tcsd ⁽¹⁾	MFIOFS		
	LF-INTOSC		None		
	LP, XT, HS	Tost ⁽³⁾			
	HSPLL	Tost + t _{rc} ⁽³⁾	OSTS		
Class made	EC, RC	TCSD ⁽¹⁾			
Sleep mode	HF-INTOSC ⁽²⁾		HFIOFS		
	MF-INTOSC ⁽²⁾	TIOBST ⁽⁴⁾	MFIOFS		
	LF-INTOSC		None		

Note 1: TCSD (parameter 38, Table 31-10) is a required delay when waking from Sleep and all Idle modes, and runs concurrently with any other required delays (see **Section 4.4 "Idle Modes**").

2: Includes postscaler derived frequencies. On Reset, INTOSC defaults to HF-INTOSC at 8 MHz.

3: TOST is the Oscillator Start-up Timer (parameter 32, Table 31-10). TRC is the PLL Lock-out Timer (parameter F12, Table 31-7); it is also designated as TPLL.

- 4: Execution continues during TIOBST (parameter 39, Table 31-10), the INTOSC stabilization period.
- **5:** The clock source is dependent upon the settings of the SCS (OSCCON<1:0>), IRCF (OSCCON<6:4>) and FOSC (CONFIG1H<3:0>) bits.

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商

5.0 RESET

The PIC18F87K90 family of devices differentiates between various kinds of Reset:

- a) Power-on Reset (POR)
- b) MCLR Reset during normal operation
- c) MCLR Reset during power-managed modes
- d) Watchdog Timer (WDT) Reset (during execution)
- e) Configuration Mismatch (CM) Reset
- f) Brown-out Reset (BOR)
- g) RESET Instruction
- h) Stack Full Reset
- i) Stack Underflow Reset

This section discusses Resets generated by MCLR, POR and BOR, and covers the operation of the various start-up timers. Stack Reset events are covered in Section 6.1.3.4 "Stack Full and Underflow Resets". WDT Resets are covered in Section 28.2 "Watchdog Timer (WDT)". A simplified block diagram of the on-chip Reset circuit is shown in Figure 5-1.

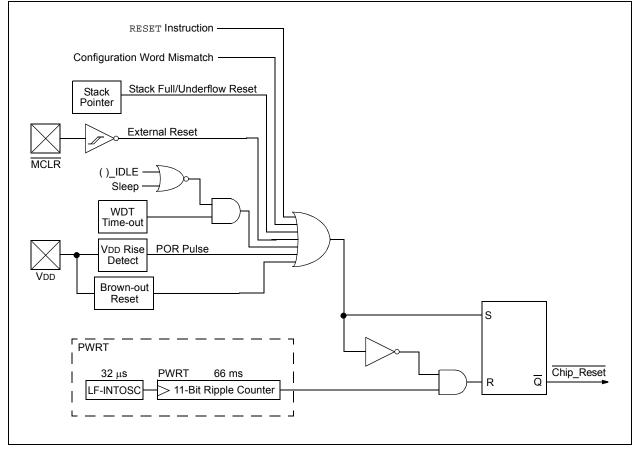
5.1 RCON Register

Device Reset events are tracked through the RCON register (Register 5-1). The lower five bits of the register indicate that a specific Reset event has occurred. In most cases, these bits can only be set by the event and must be cleared by the application after the event.

The state of these flag bits, taken together, can be read to indicate the type of Reset that just occurred. This is described in more detail in **Section 5.7** "**Reset State of Registers**".

The RCON register also has a control bit for setting interrupt priority (IPEN). Interrupt priority is discussed in **Section 10.0 "Interrupts"**.

FIGURE 5-1: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



查询PIC18F67K90供应商 REGISTER 5-1: RCON: RESET CONTROL REGISTER

R/W-0	R/W-1	R/W-1	R/W-1	R-1	R-1	R/W-0	R/W-0	
IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	
bit 7							bit	
Legend:								
R = Readable	e bit	W = Writable	bit	U = Unimpler	mented bit, rea	d as '0'		
-n = Value at POR		'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unknown		
bit 7		riority levels or	n interrupts	PIC16CXXX Co	empatibility mo	de)		
bit 6	SBOREN: BC <u>If BOREN<1:(</u> 1 = BOR is c 0 = BOR is c <u>If BOREN<1:(</u>	OR Software E <u>)> = 01:</u> enabled	nable bit			,		
bit 5	 CM: Configuration Mismatch Flag bit 1 = A Configuration Mismatch Reset has not occurred 0 = A Configuration Mismatch Reset has occurred (must be set in software after a Configuration Mismatch Reset occurs) 							
bit 4	 RI: RESET Instruction Flag bit 1 = The RESET instruction was not executed (set by firmware only) 0 = The RESET instruction was executed, causing a device Reset (must be set in software after a Brown-out Reset occurs) 							
bit 3	TO: Watchdog Time-out Flag bit 1 = Set by power-up, CLRWDT instruction or SLEEP instruction 0 = A WDT time-out has occurred							
bit 2	 PD: Power-Down Detection Flag bit 1 = Set by power-up or by the CLRWDT instruction 0 = Set by execution of the SLEEP instruction 							
bit 1	 POR: Power-on Reset Status bit 1 = A Power-on Reset has not occurred (set by firmware only) 0 = A Power-on Reset has occurred (must be set in software after a Power-on Reset occurs) 							
bit 0	 BOR: Brown-out Reset Status bit 1 = A Brown-out Reset has not occurred (set by firmware only) 0 = A Brown-out Reset has occurred (must be set in software after a Brown-out Reset occurs) 							

Note 1: It is recommended that the POR bit be set after a Power-on Reset has been detected, so that subsequent Power-on Resets may be detected.

2: Brown-out Reset is said to have occurred when BOR is '0' and POR is '1' (assuming that POR was set to '1' by software immediately after a Power-on Reset).

查询PIC18F67K90供应商 5.2

Master Clear (MCLR)

The MCLR pin provides a method for triggering a hard external Reset of the device. A Reset is generated by holding the pin low. PIC18 extended microcontroller devices have a noise filter in the MCLR Reset path which detects and ignores small pulses.

The MCLR pin is not driven low by any internal Resets, including the WDT.

5.3 Power-on Reset (POR)

A Power-on Reset condition is generated on-chip whenever VDD rises above a certain threshold. This allows the device to start in the initialized state when VDD is adequate for operation.

To take advantage of the POR circuitry, tie the MCLR pin through a resistor (1 k Ω to 10 k Ω) to VDD. This will eliminate external RC components usually needed to create a Power-on Reset delay. A minimum rise rate for VDD is specified (parameter D004). For a slow rise time, see Figure 5-2.

When the device starts normal operation (exiting the Reset condition), device operating parameters (such as voltage, frequency and temperature) must be met to ensure operation. If these conditions are not met, the device must be held in Reset until the operating conditions are met.

Power-on Reset events are captured by the POR bit (RCON<1>). The state of the bit is set to '0' whenever a Power-on Reset occurs and does not change for any other Reset event. POR is not reset to '1' by any hardware event. To capture multiple events, the user manually resets the bit to '1' in software following any Power-on Reset.

5.4 **Brown-out Reset (BOR)**

The PIC18F87K90 family has four BOR modes:

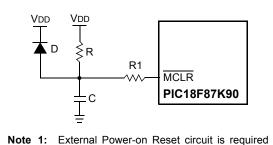
- High-Power BOR
- Medium Power BOR
- · Low-Power BOR
- Zero-Power BOR

Each power mode is selected by the BORPWR<1:0> setting (CONFIG2L<6:5>). For low, medium and highpower BOR, the module monitors the VDD depending on the BORV<1:0> setting (CONFIG1L<3:2>). A BOR event re-arms the Power-on Reset. It also causes a Reset depending on which of the trip levels has been set: 1.8V, 2V, 2.7V or 3V. The typical (AIBOR) for the Low and Medium Power BOR will be 0.75 μ A and 3 μ A. In Zero-Power BOR (ZPBORMV), the module monitors the VDD voltage and re-arms the POR at about 2V. ZPBORMV does not cause a Reset, but re-arms the POR.

The BOR accuracy varies with its power level. The lower the power setting, the less accurate the BOR trip levels are. So, the high-power BOR has the highest accuracy and the low-power has the lowest accuracy. The trip levels (BVDD, parameter D005), current consumption (Section 31.2 "DC Characteristics: Power-Down and Supply Current PIC18F87K90 Family (Industrial)") and time required below BVDD (TBOR, parameter 35) can all be found in Section 31.0 "Electrical Characteristics"

FIGURE 5-2:

EXTERNAL POWER-ON **RESET CIRCUIT (FOR** SLOW VDD POWER-UP)



- only if the VDD power-up slope is too slow. The diode, D, helps discharge the capacitor quickly when VDD powers down.
 - **2:** $R < 40 \text{ k}\Omega$ is recommended to make sure that the voltage drop across R does not violate the device's electrical specification.
 - **3:** $R1 \ge 1 \ k\Omega$ will limit any current flowing into MCLR from external capacitor, C, in the event of MCLR/VPP pin breakdown, due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS).

5.4.1 DETECTING BOR

The BOR bit always resets to '0' on any Brown-out Reset or Power-on Reset event. This makes it difficult to determine if a Brown-out Reset event has occurred just by reading the state of BOR alone. A more reliable method is to simultaneously check the state of both POR and BOR. This assumes that the POR bit is reset to '1' in software immediately after any Power-on Reset event. If $\overline{\text{BOR}}$ is '0' while $\overline{\text{POR}}$ is '1', it can be reliably assumed that a Brown-out Reset event has occurred.

LP-BOR cannot be detected with the $\overline{\text{BOR}}$ bit in the RCON register. LP-BOR can rearm the POR and can cause a Power-on Reset.

查询PIC18F67K90供应商

5.5 Configuration Mismatch (CM)

The Configuration Mismatch (CM) Reset is designed to detect, and attempt to recover from, random, memory corrupting events. These include Electrostatic Discharge (ESD) events that can cause widespread, single bit changes throughout the device and result in catastrophic failure.

In PIC18F87K90 family Flash devices, the device Configuration registers (located in the configuration memory space) are continuously monitored during operation by comparing their values to complimentary shadow registers. If a mismatch is detected between the two sets of registers, a CM Reset automatically occurs. These events are captured by the CM bit (RCON<5>). The state of the bit is set to '0' whenever a CM event occurs and does not change for any other Reset event.

A CM Reset behaves similarly to a Master Clear Reset, RESET instruction, WDT time-out or Stack Event Reset. As with all hard and power Reset events, the device Configuration Words are reloaded from the Flash Configuration Words in program memory as the device restarts.

5.6 Power-up Timer (PWRT)

PIC18F87K90 family devices incorporate an on-chip Power-up Timer (PWRT) to help regulate the Power-on Reset process. The PWRT is enabled by setting the PWRTEN bit (CONFIG2L<0>). The main function is to ensure that the device voltage is stable before code is executed.

The Power-up Timer (PWRT) of the PIC18F87K90 family devices is a 13-bit counter that uses the LF-INTOSC source as the clock input. This yields an approximate time interval of 2,048 x 32 μ s = 66 ms. While the PWRT is counting, the device is held in Reset.

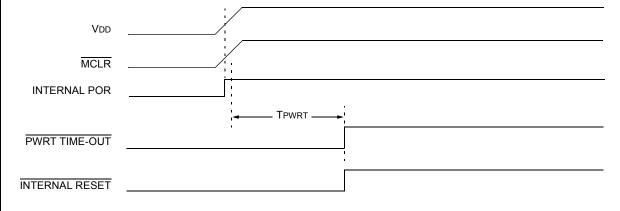
The power-up time delay depends on the LF-INTOSC clock and will vary from chip-to-chip due to temperature and process variation. See DC parameter 33 for details.

5.6.1 TIME-OUT SEQUENCE

If enabled, the PWRT time-out is invoked after the POR pulse has cleared. The total time-out will vary based on the status of the PWRT. Figure 5-3, Figure 5-4, Figure 5-5 and Figure 5-6 all depict time-out sequences on power-up with the Power-up Timer enabled.

Since the time-outs occur from the POR pulse, if MCLR is kept low long enough, the PWRT will expire. Bringing MCLR high will begin execution immediately (Figure 5-5). This is useful for testing purposes, or for synchronizing more than one PIC18 device operating in parallel.

FIGURE 5-3: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD, VDD RISE < TPWRT)



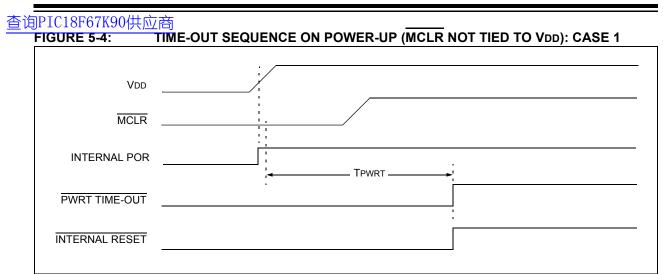


FIGURE 5-5: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 2

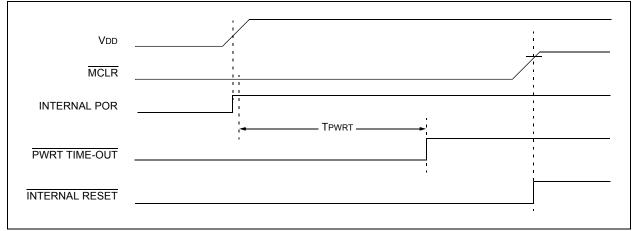
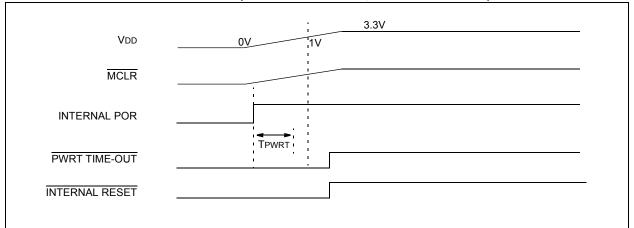


FIGURE 5-6: SLOW RISE TIME (MCLR TIED TO VDD, VDD RISE > TPWRT)



查询PIC18F67K90供应商

5.7 Reset State of Registers

Most registers are unaffected by a Reset. Their status is unknown on POR and unchanged by all other Resets. The other registers are forced to a "Reset state" depending on the type of Reset that occurred.

Most registers are not affected by a WDT wake-up, since this is viewed as the resumption of normal operation. Status bits from the RCON register (\overline{CM} , \overline{RI} , \overline{TO} , \overline{PD} , \overline{POR} and \overline{BOR}) are set or cleared differently in

different Reset situations, as indicated in Table 5-1. These bits are used in software to determine the nature of the Reset.

Table 5-2 describes the Reset states for all of the Special Function Registers. These are categorized by Power-on and Brown-out Resets, Master Clear and WDT Resets, and WDT wake-ups.

TABLE 5-1:STATUS BITS, THEIR SIGNIFICANCE AND THE INITIALIZATION CONDITION FOR
RCON REGISTER

Condition	Program			STKPTR Register					
Condition	Counter ⁽¹⁾	CM	RI	то	PD	POR	BOR	STKFUL	STKUNF
Power-on Reset	0000h	1	1	1	1	0	0	0	0
RESET instruction	0000h	u	0	u	u	u	u	u	u
Brown-out Reset	0000h	1	1	1	1	u	0	u	u
Configuration Mismatch Reset	0000h	0	u	u	u	u	u	u	u
MCLR Reset during power-managed Run modes	0000h	u	u	1	u	u	u	u	u
MCLR Reset during power- managed Idle modes and Sleep mode	0000h	u	u	1	0	u	u	u	u
MCLR Reset during full-power execution	0000h	u	u	u	u	u	u	u	u
Stack Full Reset (STVREN = 1)	0000h	u	u	u	u	u	u	1	u
Stack Underflow Reset (STVREN = 1)	0000h	u	u	u	u	u	u	u	1
Stack Underflow Error (not an actual Reset, STVREN = 0)	0000h	u	u	u	u	u	u	u	1
WDT time-out during full-power or power-managed Run modes	0000h	u	u	0	u	u	u	u	u
WDT time-out during power-managed Idle or Sleep modes	PC + 2	u	u	0	0	u	u	u	u
Interrupt exit from power-managed modes	PC + 2	u	u	u	0	u	u	u	u

Legend: u = unchanged

Note 1: When the wake-up is due to an interrupt and the GIEH or GIEL bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

查询PIC18F67K90供应商

TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS

Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt
TOSU	PIC18F6XK90	PIC18F8XK90	0 0000	0 0000	0 uuuu (1)
TOSH	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu ⁽¹⁾
TOSL	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu (1)
STKPTR	PIC18F6XK90	PIC18F8XK90	00-0 0000	uu-0 0000	uu-u uuuu ⁽¹⁾
PCLATU	PIC18F6XK90	PIC18F8XK90	0 0000	0 0000	u uuuu
PCLATH	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PCL	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	PC + 2 ⁽²⁾
TBLPTRU	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu
TBLPTRH	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
TBLPTRL	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
TABLAT	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PRODH	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
PRODL	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
INTCON	PIC18F6XK90	PIC18F8XK90	0000 000x	0000 000u	uuuu uuuu ⁽³⁾
INTCON2	PIC18F6XK90	PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu (3)
INTCON3	PIC18F6XK90	PIC18F8XK90	1100 0000	1100 0000	uuuu uuuu ⁽³⁾
INDF0	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
POSTINC0	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
POSTDEC0	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
PREINC0	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
PLUSW0	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
FSR0H	PIC18F6XK90	PIC18F8XK90	xxx	uuuu	uuuu
FSR0L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
WREG	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
INDF1	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
POSTINC1	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
POSTDEC1	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
PREINC1	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
PLUSW1	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
FSR1H	PIC18F6XK90	PIC18F8XK90	xxxx	uuuu	uuuu
FSR1L	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
BSR	PIC18F6XK90	PIC18F8XK90	0000	0000	uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).

4: See Table 5-1 for Reset value for specific condition.

查询PIC18F67K90供应商

TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicabl	e Devices	Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt
INDF2	PIC18F6XK90 PIC18F8XK90		N/A	N/A	N/A
POSTINC2	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
POSTDEC2	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
PREINC2	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
PLUSW2	PIC18F6XK90	PIC18F8XK90	N/A	N/A	N/A
FSR2H	PIC18F6XK90	PIC18F8XK90	xxxx	uuuu	uuuu
FSR2L	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
STATUS	PIC18F6XK90	PIC18F8XK90	x xxxx	u uuuu	u uuuu
TMR0H	PIC18F6XK90	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu
TMR0L	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
TOCON	PIC18F6XK90	PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
SPBRGH1	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
OSCCON	PIC18F6XK90	PIC18F8XK90	0110 q000	0110 q000	uuuu quuu
IPR5	PIC18F6XK90	PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
WDTCON	PIC18F6XK90	PIC18F8XK90	0-x0 -000	0-x0 -000	u-uu -uuu
RCON	PIC18F6XK90	PIC18F8XK90	0111 11qq	0uqq qquu	uuuu qquu
TMR1H	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR1L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
T1CON	PIC18F6XK90	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu
TMR2	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PR2	PIC18F6XK90	PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
T2CON	PIC18F6XK90	PIC18F8XK90	-000 0000	-000 0000	-uuu uuuu
SSP1BUF	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
SSP1ADD	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
SSP1STAT	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
SSP1CON1	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
SSP1CON2	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
ADRESH	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
ADRESL	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
ADCON0	PIC18F6XK90	PIC18F8XK90	-000 0000	-000 0000	-uuu uuuu
ADCON1	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
ADCON2	PIC18F6XK90	PIC18F8XK90	0-00 0000	0-00 0000	u-uu uuuu
ECCP1AS	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

- **2:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
- 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
- 4: See Table 5-1 for Reset value for specific condition.

查询PIC18F67K90供应商 TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

TABLE 5-2:	INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)					
Register	Applicable Devices	Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt		
ECCP1DEL	PIC18F6XK90 PIC18F8XK9	O 0000 0000	0000 0000	uuuu uuuu		
CCPR1H	PIC18F6XK90 PIC18F8XK9) xxxx xxxx	uuuu uuuu	uuuu uuuu		
CCPR1L	PIC18F6XK90 PIC18F8XK9) xxxx xxxx	uuuu uuuu	uuuu uuuu		
CCP1CON	PIC18F6XK90 PIC18F8XK9	O 0000 0000	0000 0000	uuuu uuuu		
PIR5	PIC18F6XK90 PIC18F8XK9	O 0000 0000	0000 0000	uuuu uuuu		
PIE5	PIC18F6XK90 PIC18F8XK9	O 0000 0000	0000 0000	uuuu uuuu (1)		
IPR4	PIC18F6XK90 PIC18F8XK9	D 1111 1111	1111 1111	uuuu uuuu		
PIR4	PIC18F6XK90 PIC18F8XK9	O 0000 0000	0000 0000	uuuu uuuu ⁽¹⁾		
PIE4	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	uuuu uuuu		
CVRCON	PIC18F6XK90 PIC18F8XK9	O 0000 0000	0000 0000	uuuu uuuu		
CMSTAT	PIC18F6XK90 PIC18F8XK9) 111	111	uuu		
TMR3H	PIC18F6XK90 PIC18F8XK9) xxxx xxxx	uuuu uuuu	uuuu uuuu		
TMR3L	PIC18F6XK90 PIC18F8XK9) xxxx xxxx	uuuu uuuu	uuuu uuuu		
T3CON	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0x00	00x0 0x00		
T3GCON	PIC18F6XK90 PIC18F8XK9	0 0000 0x00	00x0 0x00	uuuu uuuu		
SPBRG1	PIC18F6XK90 PIC18F8XK9	0 0000 0000 C	0000 0000	uuuu uuuu		
RCREG1	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	uuuu uuuu		
TXREG1	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	սսսս սսսս		
TXSTA1	PIC18F6XK90 PIC18F8XK9	0 0000 0010	0000 0010	uuuu uuuu		
RCSTA1	PIC18F6XK90 PIC18F8XK9	0000 000x	0000 000x	uuuu uuuu		
T1GCON	PIC18F6XK90 PIC18F8XK9	0 0000 0x00 0	0000 0x00	սսսս սսսս		
IPR6	PIC18F6XK90 PIC18F8XK9	D1 -111	1 -111	u -uuu		
HLVDCON	PIC18F6XK90 PIC18F8XK9	D 0000 0101	0000 0101	սսսս սսսս		
PIR6	PIC18F6XK90 PIC18F8XK9	00 -000	0 -000	u -uuu		
IPR3	PIC18F6XK90 PIC18F8XK9) 1111 1111	1111 1111	սսսս սսսս		
PIR3	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	սսսս սսսս		
PIE3	PIC18F6XK90 PIC18F8XK9	0000 0000	0000 0000	սսսս սսսս		
IPR2	PIC18F6XK90 PIC18F8XK9) 1-11 1111	1-11 1111	u-uu uuuu		
PIR2	PIC18F6XK90 PIC18F8XK9	0 000 00-0	0-00 0000	u-uu uuuu		
PIE2	PIC18F6XK90 PIC18F8XK9	0 000 00-0 0000	0-00 0000	u-uu uuuu		
IPR1	PIC18F6XK90 PIC18F8XK9	D –111 1111	-111 1111	-uuu uuuu		
PIR1	PIC18F6XK90 PIC18F8XK9	0 000 0000	-000 0000	-uuu uuuu		
PIE1	PIC18F6XK90 PIC18F8XK9	0 -000 0000	-000 0000	-uuu uuuu		

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

- 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
- 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
- **4:** See Table 5-1 for Reset value for specific condition.

查询PIC18F67K90供应商

TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

	TIONS FOR ALL REGISTERS (CONTINUED)			
Applicable Devices	Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt	
PIC18F6XK90 PIC18F8XK90	00-0 0001	00-0 0001	uu-u uuuu	
PIC18F6XK90 PIC18F8XK90	0000 0000	0000 0000	սսսս սսսս	
PIC18F6XK90 PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	1111 1111	1111 1111	սսսս սսսս	
PIC18F6XK90 PIC18F8XK90	1 1111	1 1111	u uuuu	
PIC18F6XK90 PIC18F8XK90	1111 111-	1111 111-	uuuu uuu-	
PIC18F6XK90 PIC18F8XK90	1111 1111	1111 1111	սսսս սսսս	
PIC18F6XK90 PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	1111 1111	1111 1111	սսսս սսսս	
PIC18F6XK90 PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	x xxxx	u uuuu	u uuuu	
PIC18F6XK90 PIC18F8XK90	xxxx xxx-	uuuu uuu-	uuuu uuu-	
PIC18F6XK90 PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	XXXX XXXX	xxxx xxxx	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	x0 000x	x0 000x	uu uuuu	
PIC18F6XK90 PIC18F8XK90	0000 000-	0000 000-	uuuu uuu-	
PIC18F6XK90 PIC18F8XK90	xxxx xxxx	xxxx xxxx	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	XXXX XXXX	xxxx xxxx	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	XXXX XXXX	xxxx xxxx	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	xxxx xxxx	xxxx xxxx	uuuu uuuu	
PIC18F6XK90 PIC18F8XK90	xx0x 0000	uu0u 0000	uuuu uuuu	
	Applicable Devices PIC18F6XK90 PIC18F8XK90 PIC18F6XK90 PIC18F8XK90 <td>Applicable Devices Power-on Reset, Brown-out Reset PIC18F6XK90 PIC18F8XK90 0000 0001 PIC18F6XK90 PIC18F8XK90 0000 0000 PIC18F6XK90 PIC18F8XK90 1111 1111 PIC18F6XK90 PIC18F8XK90 XXXX XXXX PIC18F6XK90 PIC18F8XK90 XXXX XXXXX</td> <td>Applicable Devices Power-on Reset, Brown-out Reset WDT Reset, RESET Instruction, Stack Resets, CM Resets PIC18F6XK90 PIC18F8XK90 000-0 0001 00-0 0001 PIC18F6XK90 PIC18F8XK90 00000 00000 0000 PIC18F6XK90 PIC18F8XK90 1111 1111 PIC18F6XK90 PIC18F8XK90 XXXX XXXX uuuu uuu PIC18F6XK90 PIC18F8XK90 XXXX XXXX PIC18F6XK90</td>	Applicable Devices Power-on Reset, Brown-out Reset PIC18F6XK90 PIC18F8XK90 0000 0001 PIC18F6XK90 PIC18F8XK90 0000 0000 PIC18F6XK90 PIC18F8XK90 1111 1111 PIC18F6XK90 PIC18F8XK90 XXXX XXXX PIC18F6XK90 PIC18F8XK90 XXXX XXXXX	Applicable Devices Power-on Reset, Brown-out Reset WDT Reset, RESET Instruction, Stack Resets, CM Resets PIC18F6XK90 PIC18F8XK90 000-0 0001 00-0 0001 PIC18F6XK90 PIC18F8XK90 00000 00000 0000 PIC18F6XK90 PIC18F8XK90 1111 1111 PIC18F6XK90 PIC18F8XK90 XXXX XXXX uuuu uuu PIC18F6XK90 PIC18F8XK90 XXXX XXXX PIC18F6XK90	

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).

4: See Table 5-1 for Reset value for specific condition.

查询PIC18F67K90供应商 TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

TABLE 5-2:			ITIONS FOR ALL REGISTERS (CONTINUED)				
Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt		
EECON1	PIC18F6XK90	PIC18F8XK90	xx-0 x000	uu-0 u000	uu-u uuuu		
EECON2	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	0000 0000		
LCDDATA23	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA22	PIC18F6XK90	PIC18F8XK90	x	u	u		
LCDDATA22	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA21	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA20	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA19	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA18	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA17	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA16	PIC18F6XK90	PIC18F8XJ90	x	u	u		
LCDDATA16	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA15	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA14	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA13	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA12	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA11	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA10	PIC18F6XK90	PIC18F8XK90	x	u	u		
LCDDATA10	PIC18F6XK90	PIC18F8XJ90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA9	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA8	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA7	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA6	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA5	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA4	PIC18F6XK90	PIC18F8XJ90	x	u	u		
LCDDATA4	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu		
LCDDATA3	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu		
LCDDATA2	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu		
LCDDATA1	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu		
LCDDATA0	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu		
BAUDCON1	PIC18F6XK90	PIC18F8XK90	0100 0-00	0100 0-00	uuuu u-uu		
OSCCON2	PIC18F6XK90	PIC18F8XK90	-0 0-x0	-0 0-u0	-u u-uu		
EEADRH	PIC18F6XK90	PIC18F8XK90	00	00	uu		

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

- 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
- 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
- **4:** See Table 5-1 for Reset value for specific condition.

查询PIC18F67K90供应商

TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt
EEADR	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
EEDATA	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	սսսս սսսս
PIE6	PIC18F6XK90	PIC18F8XK90	0 -000	0 -000	u -uuu
RTCCFG	PIC18F6XK90	PIC18F8XK90	0-00 0000	u-uu uuuu	u-uu uuuu
RTCCAL	PIC18F6XK90	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu
RTCVALH	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu
RTCVALL	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
ALRMCFG	PIC18F6XK90	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu
ALRMRPT	PIC18F6XK90	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu
ALRMVALH	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	սսսս սսսս	սսսս սսսս
ALRMVALL	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CTMUCONH	PIC18F6XK90	PIC18F8XK90	0-00 0000	0-00 0000	u-uu uuuu
CTMUCONL	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 00xx	uuuu uuuu
CTMUICON	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
CM1CON	PIC18F6XK90	PIC18F8XK90	0001 1111	0001 1111	uuuu uuuu
PADCFG1	PIC18F6XK90	PIC18F8XK90	00000-	uuuuu-	uuuuu-
ECCP2AS	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
ECCP2DEL	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
CCPR2H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCPR2L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCP2CON	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
ECCP3AS	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
ECCP3DEL	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
CCPR3H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCPR3L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	սսսս սսսս	uuuu uuuu
CCP3CON	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
CCPR8H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCPR8L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	սսսս սսսս	սսսս սսսս
CCP8CON	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu
CCPR9H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCPR9L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCP9CON	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu
CCPR10H	PIC18F6XK90	PIC18F8XK90	xxxx xxxx	uuuu uuuu	uuuu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).

4: See Table 5-1 for Reset value for specific condition.

查询PIC18F67K90供应商 TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt
CCPR10L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	սսսս սսսս	uuuu uuuu
CCP10CON	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu
TMR7H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
TMR7L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
T7CON	PIC18F6XK90	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu -uuu
T7GCON	PIC18F6XK90	PIC18F8XK90	0000 0x00	00x0 0x00	uuuu uuuu
TMR6	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PR6	PIC18F6XK90	PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
T6CON	PIC18F6XK90	PIC18F8XK90	-000 0000	-000 0000	-uuu uuuu
TMR8	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PR8	PIC18F6XK90	PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
T8CON	PIC18F6XK90	PIC18F8XK90	-000 0000	-000 0000	-uuu uuuu
TMR10	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PR10	PIC18F6XK90	PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
T10CON	PIC18F6XK90	PIC18F8XK90	-000 0000	-000 0000	-uuu uuuu
TMR12	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PR12	PIC18F6XK90	PIC18F8XK90	1111 1111	1111 1111	uuuu uuuu
T12CON	PIC18F6XK90	PIC18F8XK90	-000 0000	-000 0000	-uuu uuuu
CM2CON	PIC18F6XK90	PIC18F8XK90	0001 1111	0001 1111	uuuu uuuu
CM3CON	PIC18F6XK90	PIC18F8XK90	0001 1111	0001 1111	uuuu uuuu
CCPTMRS0	PIC18F6XK90	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu
CCPTMRS1	PIC18F6XK90	PIC18F8XK90	00-0 -000	uu-u -uuu	uu-u -uuu
CCPTMRS2	PIC18F6XK90	PIC18F8XK90	0 -000	u -uuu	u -uuu
REFOCON	PIC18F6XK90	PIC18F8XK90	0-00 0000	u-uu uuuu	u-uu uuuu
ODCON1	PIC18F6XK90	PIC18F8XK90	0000	uuuu	uuuu
ODCON2	PIC18F6XK90	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu
ODCON3	PIC18F6XK90	PIC18F8XK90	000	uuu	uuu
ANCON0	PIC18F6XK90	PIC18F8XK90	1111 1111	uuuu uuuu	uuuu uuuu
ANCON1	PIC18F6XK90	PIC18F8XK90	1111 1111	uuuu uuuu	uuuu uuuu
ANCON2	PIC18F6XK90	PIC18F8XK90	1111 1111	uuuu uuuu	uuuu uuuu
RCSTA2	PIC18F6XK90	PIC18F8XK90	0000 000x	0000 000x	uuuu uuuu
TXSTA2	PIC18F6XK90	PIC18F8XK90	0000 0010	0000 0010	uuuu uuuu
BAUDCON2	PIC18F6XK90	PIC18F8XK90	0100 0-00	0100 0-00	uuuu u-uu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

- 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
- 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
- **4:** See Table 5-1 for Reset value for specific condition.

查询PIC18F67K90供应商

TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt
SPBRGH2	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
SPBRG2	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
RCREG2	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	սսսս սսսս
TXREG2	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	սսսս սսսս
PSTR2CON	PIC18F6XK90	PIC18F8XK90	00-0 0001	00-0 0001	uu-u uuuu
PSTR3CON	PIC18F6XK90	PIC18F8XK90	00-0 0001	00-0 0001	uu-u uuuu
PMD0	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PMD1	PIC18F6XK90	PIC18F8XK90	-000 000-	-000 000-	-uuu uuu-
PMD2	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	սսսս սսսս
PMD3	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
TMR5H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
TMR5L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
T5CON	PIC18F6XK90	PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu
T5GCON	PIC18F6XK90	PIC18F8XK90	00x0 0x00	00x0 0x00	uuuu uuuu
CCPR4H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCPR4L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCP4CON	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu
CCPR5H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCPR5L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCP5CON	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu
CCPR6H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCPR6L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCP6CON	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu
CCPR7H	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCPR7L	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
CCP7CON	PIC18F6XK90	PIC18F8XK90	00 0000	00 0000	uu uuuu
TMR4	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
PR4	PIC18F6XK90	PIC18F8XK90	1111 1111	uuuu uuuu	uuuu uuuu
T4CON	PIC18F6XK90	PIC18F8XK90	-000 0000	-000 0000	-uuu uuuu
SSP2BUF	PIC18F6XK90	PIC18F8XK90	XXXX XXXX	uuuu uuuu	uuuu uuuu
SSP2ADD	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
SSP2STAT	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu
SSP2CON1	PIC18F6XK90	PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

- **2:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
- 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
- 4: See Table 5-1 for Reset value for specific condition.

TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices	Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset, RESET Instruction, Stack Resets, CM Resets	Wake-up via WDT or Interrupt	
SSP2CON2	PIC18F6XK90 PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu	
LCDREF	PIC18F6XK90 PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu	
LCDRL	PIC18F6XK90 PIC18F8XK90	0000 -000	0000 -000	uuuu -uuu	
LCDSE5	PIC18F6XK90 PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu	
LCDSE4	PIC18F6XK90 PIC18F8XK90	0	u	u	
LCDSE4	PIC18F6XK90 PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu	
LCDSE3	PIC18F6XK90 PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu	
LCDSE2	PIC18F6XK90 PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu	
LCDSE1	PIC18F6XK90 PIC18F8XK90	0000 0000	սսսս սսսս	uuuu uuuu	
LCDSE0	PIC18F6XK90 PIC18F8XK90	0000 0000	uuuu uuuu	uuuu uuuu	
LCDPS	PIC18F6XK90 PIC18F8XK90	0000 0000	0000 0000	uuuu uuuu	
LCDCON	PIC18F6XK90 PIC18F8XK90	000- 0000	000- 0000	uuu- uuuu	

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).

4: See Table 5-1 for Reset value for specific condition.

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商 6.0 MEMORY ORGANIZATION

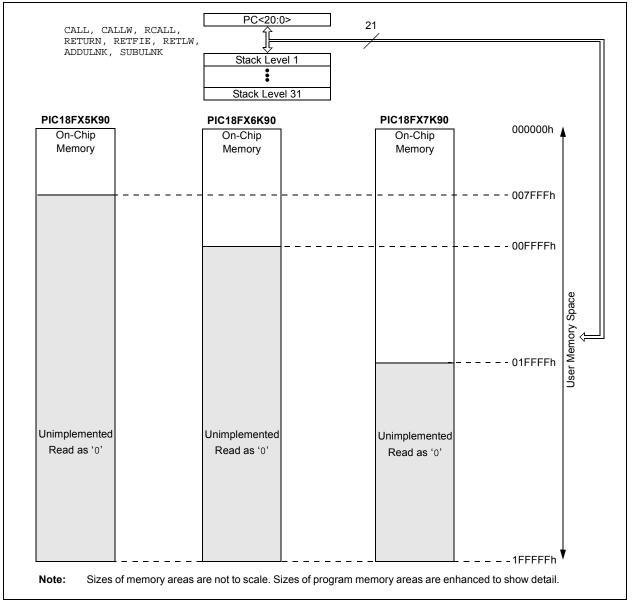
PIC18F87K90 family devices have these types of memory:

- Program Memory
- Data RAM
- Data EEPROM

As Harvard architecture devices, the data and program memories use separate busses. This enables concurrent access of the two memory spaces. The data EEPROM, for practical purposes, can be regarded as a peripheral device because it is addressed and accessed through a set of control registers.

Additional detailed information on the operation of the Flash program memory is provided in **Section 7.0 "Flash Program Memory"**. The data EEPROM is discussed separately in **Section 8.0 "Data EEPROM Memory"**.

FIGURE 6-1: MEMORY MAPS FOR PIC18F87K90 FAMILY DEVICES



查询PIC18F67K90供应商

6.1 Program Memory Organization

PIC18 microcontrollers implement a 21-bit program counter that is capable of addressing a 2-Mbyte program memory space. Accessing a location between the upper boundary of the physically implemented memory and the 2-Mbyte address will return all '0's (a NOP instruction).

The entire PIC18F87K90 family offers a range of on-chip Flash program memory sizes, from 32 Kbytes (up to 16,384 single-word instructions) to 128 Kbytes (65,536 single-word instructions).

- PIC18F65K90 and PIC18F85K90 32 Kbytes of Flash memory, storing up to 16,384 single-word instructions
- PIC18F66K90 and PIC18F86K90 64 Kbytes of Flash memory, storing up to 32,768 single-word instructions
- PIC18F67K90 and PIC18F87K90 128 Kbytes of Flash memory, storing up to 65,536 single-word instructions

The program memory maps for individual family members are shown in Figure 6-1.

6.1.1 HARD MEMORY VECTORS

All PIC18 devices have a total of three hard-coded return vectors in their program memory space. The Reset vector address is the default value to which the program counter returns on all device Resets. It is located at 0000h.

PIC18 devices also have two interrupt vector addresses for handling high-priority and low-priority interrupts. The high-priority interrupt vector is located at 0008h and the low-priority interrupt vector is at 0018h. The locations of these vectors are shown, in relation to the program memory map, in Figure 6-2.

FIGURE 6-2: HARD VECTOR FOR PIC18F87K90 FAMILY DEVICES

	Reset Vector	0000h
	High-Priority Interrupt Vector	0008h
	Low-Priority Interrupt Vector	0018h
	On-Chip Program Memory	
	Read '0'	
Le	of on-chip program n Figure 6-1 for device Shaded area represe	-specific values). ents unimplemented
	memory. Areas are n	

查询PIC18F67K90供应商 6.1.2 PROGRAM COUNTER

The Program Counter (PC) specifies the address of the instruction to fetch for execution. The PC is 21 bits wide and contained in three separate 8-bit registers.

The low byte, known as the PCL register, is both readable and writable. The high byte, or PCH register, contains the PC<15:8> bits and is not directly readable or writable. Updates to the PCH register are performed through the PCLATH register. The upper byte is called PCU. This register contains the PC<20:16> bits; it is also not directly readable or writable. Updates to the PCU register are performed through the PCLATU register.

The contents of PCLATH and PCLATU are transferred to the program counter by any operation that writes PCL. Similarly, the upper two bytes of the program counter are transferred to PCLATH and PCLATU by an operation that reads PCL. This is useful for computed offsets to the PC (see **Section 6.1.5.1 "Computed** GOTO").

The PC addresses bytes in the program memory. To prevent the PC from becoming misaligned with word instructions, the Least Significant bit of PCL is fixed to a value of '0'. The PC increments by two to address sequential instructions in the program memory.

The CALL, RCALL, GOTO and program branch instructions write to the program counter directly. For these instructions, the contents of PCLATH and PCLATU are not transferred to the program counter.

6.1.3 RETURN ADDRESS STACK

The return address stack enables execution of any combination of up to 31 program calls and interrupts. The PC is pushed onto the stack when a CALL or RCALL instruction is executed, or an interrupt is Acknowledged. The PC value is pulled off the stack on a RETURN, RETLW or a RETFIE instruction. The value also is pulled off the stack on ADDULNK and SUBULNK instructions, if the extended instruction set is enabled. PCLATU and PCLATH are not affected by any of the RETURN or CALL instructions.

The stack operates as a 31-word by 21-bit RAM and a 5-bit Stack Pointer, STKPTR. The stack space is not part of either program or data space. The Stack Pointer is readable and writable and the address on the top of the stack is readable and writable through the Top-of-Stack Special Function Registers. Data can also be pushed to, or popped from the stack, using these registers.

A CALL type instruction causes a push onto the stack. The Stack Pointer is first incremented and the location pointed to by the Stack Pointer is written with the contents of the PC (already pointing to the instruction following the CALL). A RETURN type instruction causes a pop from the stack. The contents of the location pointed to by the STKPTR are transferred to the PC and then the Stack Pointer is decremented.

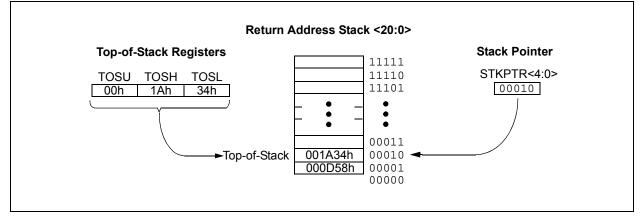
The Stack Pointer is initialized to '00000' after all Resets. There is no RAM associated with the location corresponding to a Stack Pointer value of '00000'; this is only a Reset value. Status bits indicate if the stack is full, has overflowed or has underflowed.

6.1.3.1 Top-of-Stack Access

Only the top of the return address stack (TOS) is readable and writable. A set of three registers, TOSU:TOSH:TOSL, holds the contents of the stack location pointed to by the STKPTR register (Figure 6-3). This allows users to implement a software stack, if necessary. After a CALL, RCALL or interrupt (or ADDULNK and SUBULNK instructions, if the extended instruction set is enabled), the software can read the pushed value by reading the TOSU:TOSH:TOSL registers. These values can be placed on a user-defined software stack. At return time, the software can return these values to TOSU:TOSH:TOSL and do a return.

While accessing the stack, users must disable the global interrupt enable bits to prevent inadvertent stack corruption.

FIGURE 6-3: RETURN ADDRESS STACK AND ASSOCIATED REGISTERS



查询PIC18F67K90供应商

6.1.3.2 Return Stack Pointer (STKPTR)

The STKPTR register (Register 6-1) contains the Stack Pointer value, the STKFUL (Stack Full) status bit and the STKUNF (Stack Underflow) status bits. The value of the Stack Pointer can be 0 through 31. The Stack Pointer increments before values are pushed onto the stack and decrements after values are popped off the stack. On Reset, the Stack Pointer value will be zero.

The user may read and write the Stack Pointer value. This feature can be used by a Real-Time Operating System (RTOS) for return-stack maintenance.

After the PC is pushed onto the stack 31 times (without popping any values off the stack), the STKFUL bit is set. The STKFUL bit is cleared by software or by a POR.

What happens when the stack becomes full depends on the state of the STVREN (Stack Overflow Reset Enable) Configuration bit. (For a description of the device Configuration bits, see **Section 28.1 "Configuration Bits"**.) If STVREN is set (default), the 31st push will push the (PC + 2) value onto the stack, set the STKFUL bit and reset the device. The STKFUL bit will remain set and the Stack Pointer will be set to zero.

If STVREN is cleared, the STKFUL bit will be set on the 31st push and the Stack Pointer will increment to 31. Any additional pushes will not overwrite the 31st push and the STKPTR will remain at 31.

When the stack has been popped enough times to unload the stack, the next pop will return a value of zero to the PC and set the STKUNF bit, while the Stack Pointer remains at zero. The STKUNF bit will remain set until cleared by software or until a POR occurs.

Note:

6.1.3.3 PUSH and POP Instructions

Since the Top-of-Stack is readable and writable, the ability to push values onto the stack and pull values off the stack, without disturbing normal program execution, is a desirable feature. The PIC18 instruction set includes two instructions, PUSH and POP, that permit the TOS to be manipulated under software control. TOSU, TOSH and TOSL can be modified to place data or a return address on the stack.

The PUSH instruction places the current PC value onto the stack. This increments the Stack Pointer and loads the current PC value onto the stack.

The POP instruction discards the current TOS by decrementing the Stack Pointer. The previous value pushed onto the stack then becomes the TOS value.

REGISTER 6-1: STKPTR: STACK POINTER REGISTER

R/C-0	R/C-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
STKFUL ⁽¹⁾	STKUNF ⁽¹⁾	_	SP4	SP3	SP2	SP1	SP0
bit 7							bit
Legend:		C = Clearable	e bit				
R = Readable	e bit	W = Writable	bit	U = Unimplem	nented bit, rea	d as '0'	
-n = Value at POR '1' = Bit is set '0' = E					ared	x = Bit is unkn	iown
bit 7	1 = Stack bec	ck Full Flag bit ame full or ove not become fu	erflowed	ed			
bit 6		ick Underflow I					
		lerflow occurre	•				
	0 = Stack und	lerflow did not	occur				
bit 5		lerflow did not ted: Read as '					

6.1.3.4 Stack Full and Underflow Resets

Device Resets on stack overflow and stack underflow conditions are enabled by setting the STVREN bit (CONFIG4L<0>). When STVREN is set, a full or underflow condition will set the appropriate STKFUL or STKUNF bit and then cause a device Reset. When STVREN is cleared, a full or underflow condition will set the appropriate STKFUL or STKUNF bit, but not cause a device Reset. The STKFUL or STKUNF bits are cleared by the user software or a Power-on Reset.

6.1.4 FAST REGISTER STACK

A Fast Register Stack is provided for the STATUS, WREG and BSR registers to provide a "fast return" option for interrupts. This stack is only one level deep and is neither readable nor writable. It is loaded with the current value of the corresponding register when the processor vectors for an interrupt. All interrupt sources will push values into the Stack registers. The values in the registers are then loaded back into the working registers if the RETFIE, FAST instruction is used to return from the interrupt.

If both low and high-priority interrupts are enabled, the Stack registers cannot be used reliably to return from low-priority interrupts. If a high-priority interrupt occurs while servicing a low-priority interrupt, the Stack register values stored by the low-priority interrupt will be overwritten. In these cases, users must save the key registers in software during a low-priority interrupt.

If interrupt priority is not used, all interrupts may use the Fast Register Stack for returns from interrupt. If no interrupts are used, the Fast Register Stack can be used to restore the STATUS, WREG and BSR registers at the end of a subroutine call. To use the Fast Register Stack for a subroutine call, a CALL label, FAST instruction must be executed to save the STATUS, WREG and BSR registers to the Fast Register Stack. A RETURN, FAST instruction is then executed to restore these registers from the Fast Register Stack.

Example 6-1 shows a source code example that uses the Fast Register Stack during a subroutine call and return.

EXAMPLE 6-1: FAST REGISTER STACK CODE EXAMPLE

CALL SUB1, FAST	;STATUS, WREG, BSR
•	;SAVED IN FAST REGISTER
SUB1	;STACK
RETURN FAST	;RESTORE VALUES SAVED ;IN FAST REGISTER STACK

6.1.5 LOOK-UP TABLES IN PROGRAM MEMORY

There may be programming situations that require the creation of data structures, or look-up tables, in program memory. For PIC18 devices, look-up tables can be implemented in two ways:

- Computed GOTO
- Table Reads

6.1.5.1 Computed GOTO

A computed GOTO is accomplished by adding an offset to the program counter. An example is shown in Example 6-2.

A look-up table can be formed with an ADDWF PCL instruction and a group of RETLW nn instructions. The W register is loaded with an offset into the table before executing a call to that table. The first instruction of the called routine is the ADDWF PCL instruction. The next instruction executed will be one of the RETLW nn instructions that returns the value 'nn' to the calling function.

The offset value (in WREG) specifies the number of bytes that the program counter should advance and should be multiples of two (LSb = 0).

In this method, only one data byte may be stored in each instruction location and room on the return address stack is required.

EXAMPLE 6-2: COMPUTED GOTO USING AN OFFSET VALUE

	MOVF	OFFSET, W
	CALL	TABLE
ORG	nn00h	
TABLE	ADDWF	PCL
	RETLW	nnh
	RETLW	nnh
	RETLW	nnh
	•	

6.1.5.2 Table Reads

A better method of storing data in program memory allows two bytes of data to be stored in each instruction location.

Look-up table data may be stored two bytes per program word while programming. The Table Pointer (TBLPTR) specifies the byte address and the Table Latch (TABLAT) contains the data that is read from the program memory. Data is transferred from program memory one byte at a time.

The table read operation is discussed further in **Section 7.1 "Table Reads and Table Writes**".

查询PIC18F67K90供应商 6.2 PIC18 Instruction Cycle

6.2.1 CLOCKING SCHEME

The microcontroller clock input, whether from an internal or external source, is internally divided by four to generate four non-overlapping quadrature clocks (Q1, Q2, Q3 and Q4). Internally, the program counter is incremented on every Q1, with the instruction fetched from the program memory and latched into the Instruction Register (IR) during Q4.

The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow are shown in Figure 6-4.

6.2.2 INSTRUCTION FLOW/PIPELINING

An "Instruction Cycle" consists of four Q cycles, Q1 through Q4. The instruction fetch and execute are pipelined in such a manner that a fetch takes one instruction cycle, while the decode and execute take another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction (such as GOTO) causes the program counter to change, two cycles are required to complete the instruction. (See Example 6-3.)

A fetch cycle begins with the Program Counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the Instruction Register (IR) in cycle Q1. This instruction is then decoded and executed during the Q2, Q3 and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).

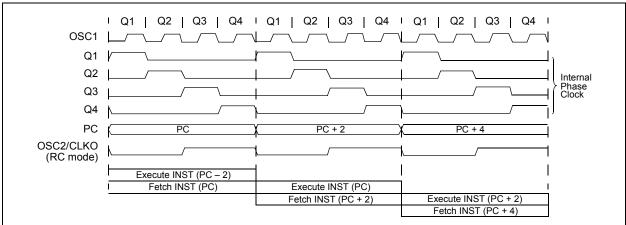


FIGURE 6-4: CLOCK/INSTRUCTION CYCLE

EXAMPLE 6-3: INSTRUCTION PIPELINE FLOW

Tcy0	Tcy1	Tcy2	TCY3	Tcy4	TcY5
1. MOVLW 55h Fetch 1	Execute 1		_		
2. MOVWF PORTB	Fetch 2	Execute 2		_	
3. BRA SUB_1		Fetch 3	Execute 3		
4. BSF PORTA, BIT3 (Forced NOP)			Fetch 4	Flush (NOP)	
5. Instruction @ address SUB_1				Fetch SUB_1	Execute SUB_1

All instructions are single cycle, except for any program branches. These take two cycles since the fetch instruction is "flushed" from the pipeline while the new instruction is being fetched and then executed.

6.2.3 INSTRUCTIONS IN PROGRAM MEMORY

The program memory is addressed in bytes. Instructions are stored as two or four bytes in program memory. The Least Significant Byte of an instruction word is always stored in a program memory location with an even address (LSB = 0). To maintain alignment with instruction boundaries, the PC increments in steps of two and the LSB will always read '0' (see Section 6.1.2 "Program Counter").

Figure 6-5 shows an example of how instruction words are stored in the program memory.

The CALL and GOTO instructions have the absolute program memory address embedded into the instruction. Since instructions are always stored on word boundaries, the data contained in the instruction is a word address. The word address is written to PC<20:1> which accesses the desired byte address in program memory. Instruction #2 in Figure 6-5 shows how the instruction, GOTO 0006h, is encoded in the program memory. Program branch instructions, which encode a relative address offset, operate in the same manner. The offset value stored in a branch instruction represents the number of single-word instructions that the PC will be offset by. For more details on the instruction set, see **Section 29.0 "Instruction Set Summary"**.

FIGURE 6-5:	INSTRUCTIONS IN PROGRAM MEMORY
-------------	--------------------------------

			LSB = 1	LSB = 0	Word Address \downarrow
	Program N	lemory			000000h
	Byte Locat	ions \rightarrow			000002h
					000004h
					000006h
Instruction 1:	MOVLW	055h	0Fh	55h	000008h
Instruction 2:	GOTO	0006h	EFh	03h	00000Ah
			F0h	00h	00000Ch
Instruction 3:	MOVFF	123h, 456h	C1h	23h	00000Eh
			F4h	56h	000010h
					000012h
					000014h

6.2.4 TWO-WORD INSTRUCTIONS

The standard PIC18 instruction set has four two-word instructions: CALL, MOVFF, GOTO and LSFR. In all cases, the second word of the instructions always has '1111' as its four Most Significant bits. The other 12 bits are literal data, usually a data memory address.

The use of '1111' in the 4 MSbs of an instruction specifies a special form of NOP. If the instruction is executed in proper sequence, immediately after the first word, the data in the second word is accessed and

used by the instruction sequence. If the first word is skipped for some reason, and the second word is executed by itself, a NOP is executed instead. This is necessary for cases when the two-word instruction is preceded by a conditional instruction that changes the PC. Example 6-4 shows how this works.

Note: For information on two-word instructions in the extended instruction set, see Section 6.5 "Program Memory and the Extended Instruction Set".

EXAMPLE 6-4:	TWO-WORD INSTRUCTIONS

CASE 1:		
Object Code	Source Code	
0110 0110 0000 0000	TSTFSZ REG1	; is RAM location 0?
1100 0001 0010 0011	MOVFF REG1, REG2	; No, skip this word
1111 0100 0101 0110		; Execute this word as a NOP
0010 0100 0000 0000	ADDWF REG3	; continue code
CASE 2:		
Object Code	Source Code	
0110 0110 0000 0000	TSTFSZ REG1	; is RAM location 0?
1100 0001 0010 0011	MOVFF REG1, REG2	; Yes, execute this word
1111 0100 0101 0110		; 2nd word of instruction
0010 0100 0000 0000	ADDWF REG3	; continue code

© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商

6.3 Data Memory Organization

Note:	The operation of some aspects of data
	memory are changed when the PIC18
	extended instruction set is enabled. See
	Section 6.6 "Data Memory and the
	Extended Instruction Set" for more
	information.

The data memory in PIC18 devices is implemented as static RAM. Each register in the data memory has a 12-bit address, allowing up to 4,096 bytes of data memory. The memory space is divided into as many as 16 banks that contain 256 bytes each. PIC18FX6K90 and PIC18FX7K90 devices implement all 16 complete banks, for a total of 4 Kbytes. PIC18FX5K90 devices implement only the first eight complete banks, for a total of 2 Kbytes.

Figure 6-6 and Figure 6-7 show the data memory organization for the devices.

The data memory contains Special Function Registers (SFRs) and General Purpose Registers (GPRs). The SFRs are used for control and status of the controller and peripheral functions, while GPRs are used for data storage and scratchpad operations in the user's application. Any read of an unimplemented location will read as '0's.

The instruction set and architecture allow operations across all banks. The entire data memory may be accessed by Direct, Indirect or Indexed Addressing modes. Addressing modes are discussed later in this section.

To ensure that commonly used registers (select SFRs and select GPRs) can be accessed in a single cycle, PIC18 devices implement an Access Bank. This is a 256-byte memory space that provides fast access to select SFRs and the lower portion of GPR Bank 0 without using the Bank Select Register. For details on the Access RAM, see **Section 6.3.2 "Access Bank"**.

6.3.1 BANK SELECT REGISTER

Large areas of data memory require an efficient addressing scheme to make possible rapid access to any address. Ideally, this means that an entire address does not need to be provided for each read or write operation. For PIC18 devices, this is accomplished with a RAM banking scheme. This divides the memory space into 16 contiguous banks of 256 bytes. Depending on the instruction, each location can be addressed directly by its full 12-bit address, or an 8-bit, low-order address and a four-bit Bank Pointer.

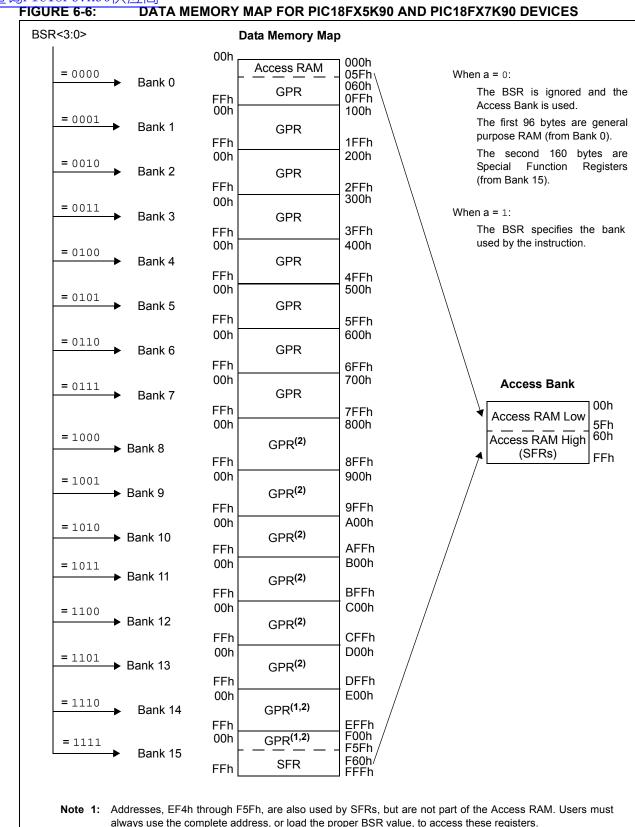
Most instructions in the PIC18 instruction set make use of the Bank Pointer, known as the Bank Select Register (BSR). This SFR holds the four Most Significant bits of a location's address. The instruction itself includes the eight Least Significant bits. Only the four lower bits of the BSR are implemented (BSR<3:0>). The upper four bits are unused, always read as '0' and cannot be written to. The BSR can be loaded directly by using the MOVLB instruction.

The value of the BSR indicates the bank in data memory. The eight bits in the instruction show the location in the bank and can be thought of as an offset from the bank's lower boundary. The relationship between the BSR's value and the bank division in data memory is shown in Figure 6-7.

Since up to 16 registers may share the same low-order address, the user must always be careful to ensure that the proper bank is selected before performing a data read or write. For example, writing what should be program data to an 8-bit address of F9h while the BSR is 0Fh, will end up resetting the program counter.

While any bank can be selected, only those banks that are actually implemented can be read or written to. Writes to unimplemented banks are ignored, while reads from unimplemented banks will return '0's. Even so, the STATUS register will still be affected as if the operation was successful. The data memory map in Figure 6-6 indicates which banks are implemented.

In the core PIC18 instruction set, only the MOVFF instruction fully specifies the 12-bit address of the source and target registers. When this instruction executes, it ignores the BSR completely. All other instructions include only the low-order address as an operand and must use either the BSR or the Access Bank to locate their target registers.



2: These addresses are unused for devices with 32 Kbytes of program memory (PIC18FX5K90). For those devices, read these addresses at 00h.

查询PIC18F67K90供应商 FIGURE 6-7: USE OF THE BANK SELECT REGISTER (DIRECT ADDRESSING) Data Memory From Opcode⁽²⁾ BSR⁽¹⁾ 000h 7 0 7 0 00h Bank 0 0 0 0 1 0 1 0 0 0 1 1 1 1 1 1 1 FFh 100h 00h Bank 1 Bank Select⁽²⁾ FFh 200h 00h Bank 2 FFh 300h 00h Bank 3 through Bank 13 FFh E00h 00h Bank 14 FFh F00h 00h Bank 15 FFFh FFh The Access RAM bit of the instruction can be used to force an override of the selected bank (BSR<3:0>) Note 1: to the registers of the Access Bank. 2: The MOVFF instruction embeds the entire 12-bit address in the instruction.

6.3.2 ACCESS BANK

While the use of the BSR, with an embedded 8-bit address, allows users to address the entire range of data memory, it also means that the user must ensure that the correct bank is selected. If not, data may be read from, or written to, the wrong location. This can be disastrous if a GPR is the intended target of an operation, but an SFR is written to instead. But verifying and/or changing the BSR for each read or write to data memory can become very inefficient.

To streamline access for the most commonly used data memory locations, the data memory is configured with an Access Bank, which allows users to access a mapped block of memory without specifying a BSR. The Access Bank consists of the first 96 bytes of memory (00h-5Fh) in Bank 0 and the last 160 bytes of memory (60h-FFh) in Bank 15. The lower half is known as the "Access RAM" and is composed of GPRs. The upper half is where the device's SFRs are mapped. These two areas are mapped contiguously in the Access Bank and can be addressed in a linear fashion by an 8-bit address (Figure 6-6).

The Access Bank is used by core PIC18 instructions that include the Access RAM bit (the 'a' parameter in the instruction). When 'a' is equal to '1', the instruction uses the BSR and the 8-bit address included in the opcode for the data memory address. When 'a' is '0', however, the instruction is forced to use the Access Bank address map. In that case, the current value of the BSR is ignored entirely.

Using this "forced" addressing allows the instruction to operate on a data address in a single cycle without updating the BSR first. For 8-bit addresses of 60h and above, this means that users can evaluate and operate on SFRs more efficiently. The Access RAM below 60h is a good place for data values that the user might need to access rapidly, such as immediate computational results or common program variables.

Access RAM also allows for faster and more code efficient context saving and switching of variables.

The mapping of the Access Bank is slightly different when the extended instruction set is enabled (XINST Configuration bit = 1). This is discussed in more detail in Section 6.6.3 "Mapping the Access Bank in Indexed Literal Offset Mode".

6.3.3 GENERAL PURPOSE REGISTER FILE

PIC18 devices may have banked memory in the GPR area. This is data RAM which is available for use by all instructions. GPRs start at the bottom of Bank 0 (address 000h) and grow upwards towards the bottom of the SFR area. GPRs are not initialized by a Power-on Reset and are unchanged on all other Resets.

6.3.4 SPECIAL FUNCTION REGISTERS

The Special Function Registers (SFRs) are registers used by the CPU and peripheral modules for controlling the desired operation of the device. These registers are implemented as static RAM. SFRs start at the top of data memory (FFFh) and extend downward to occupy all of Bank 15 (F00h to FFFh) and the top part of Bank 14 (EF4h to EFFh).

A list of these registers is given in Table 6-1 and Table 6-2.

The SFRs can be classified into two sets: those associated with the "core" device functionality (ALU, Resets and interrupts) and those related to the peripheral functions. The Reset and Interrupt registers are described in their respective chapters, while the ALU's STATUS register is described later in this section. Registers related to the operation of the peripheral features are described in the chapter for that peripheral.

The SFRs are typically distributed among the peripherals whose functions they control. Unused SFR locations are unimplemented and read as '0's.

TABLE 6-1:	PIC18F87K90 FAMILY SPECIAL FUNCTION REGISTER MAP ⁽⁵⁾

Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name
FFFh	TOSU	FDFh	INDF2 ⁽¹⁾	FBFh	ECCP1AS	F9Fh	IPR1	F7Fh	EECON1	F5Fh	RTCCFG
FFEh	TOSH	FDEh	POSTINC2 ⁽¹⁾	FBEh	ECCP1DEL	F9Eh	PIR1	F7Eh	EECON2	F5Eh	RTCCAL
FFDh	TOSL	FDDh	POSTDEC2 ⁽¹⁾	FBDh	CCPR1H	F9Dh	PIE1	F7Dh	LCDDATA23 ⁽³⁾	F5Dh	RTCVALH
FFCh	STKPTR	FDCh	PREINC2 ⁽¹⁾	FBCh	CCPR1L	F9Ch	PSTR1CON	F7Ch	LCDDATA22 ⁽³⁾	F5Ch	RTCVALL
FFBh	PCLATU	FDBh	PLUSW2 ⁽¹⁾	FBBh	CCP1CON	F9Bh	OSCTUNE	F7Bh	LCDDATA21	F5Bh	ALRMCFG
FFAh	PCLATH	FDAh	FSR2H	FBAh	PIR5	F9Ah	TRISJ ⁽³⁾	F7Ah	LCDDATA20	F5Ah	ALRMRPT
FF9h	PCL	FD9h	FSR2L	FB9h	PIE5	F99h	TRISH ⁽³⁾	F79h	LCDDATA19	F59h	ALRMVALH
FF8h	TBLPTRU	FD8h	STATUS	FB8h	IPR4	F98h	TRISG	F78h	LCDDATA18	F58h	ALRMVALL
FF7h	TBLPTRH	FD7h	TMR0H	FB7h	PIR4	F97h	TRISF	F77h	LCDDATA17 ⁽³⁾	F57h	CTMUCONH
FF6h	TBLPTRL	FD6h	TMR0L	FB6h	PIE4	F96h	TRISE	F76h	LCDDATA16 ⁽³⁾	F56h	CTMUCONL
FF5h	TABLAT	FD5h	T0CON	FB5h	CVRCON	F95h	TRISD	F75h	LCDDATA15	F55h	CTMUICON
FF4h	PRODH	FD4h	SPBRGH1	FB4h	CMSTAT	F94h	TRISC	F74h	LCDDATA14	F54h	CMCON1
FF3h	PRODL	FD3h	OSCCON	FB3h	TMR3H	F93h	TRISB	F73h	LCDDATA13	F53h	PADCFG1
FF2h	INTCON	FD2h	IPR5	FB2h	TMR3L	F92h	TRISA	F72h	LCDDATA12	F52h	ECCP2AS
FF1h	INTCON2	FD1h	WDTCON	FB1h	T3CON	F91h	LATJ ⁽³⁾	F71h	LCDDATA11 ⁽³⁾	F51h	ECCP2DEL
FF0h	INTCON3	FD0h	RCON	FB0h	T3GCON	F90h	LATH ⁽³⁾	F70h	LCDDATA10 ⁽³⁾	F50h	CCPR2H
FEFh	INDF0 ⁽¹⁾	FCFh	TMR1H	FAFh	SPBRG1	F8Fh	LATG	F6Fh	LCDDATA9	F4Fh	CCPR2L
FEEh	POSTINC0 ⁽¹⁾	FCEh	TMR1L	FAEh	RCREG1	F8Eh	LATF	F6Eh	LCDDATA8	F4Eh	CCP2CON
FEDh	POSTDEC0 ⁽¹⁾	FCDh	T1CON	FADh	TXREG1	F8Dh	LATE	F6Dh	LCDDATA7	F4Dh	ECCP3AS
FECh	PREINC0 ⁽¹⁾	FCCh	TMR2	FACh	TXSTA1	F8Ch	LATD	F6Ch	LCDDATA6	F4Ch	ECCP3DEL
FEBh	PLUSW0 ⁽¹⁾	FCBh	PR2	FABh	RCSTA1	F8Bh	LATC	F6Bh	LCDDATA5 ⁽³⁾	F4Bh	CCPR3H
FEAh	FSR0H	FCAh	T2CON	FAAh	T1GCON	F8Ah	LATB	F6Ah	LCDDATA4 ⁽³⁾	F4Ah	CCPR3L
FE9h	FSR0L	FC9h	SSP1BUF	FA9h	IPR6	F89h	LATA	F69h	LCDDATA3	F49h	CCP3CON
FE8h	WREG	FC8h	SSP1ADD	FA8h	HLVDCON	F88h	PORTJ ⁽³⁾	F68h	LCDDATA2	F48h	CCPR8H
FE7h	INDF1 ⁽¹⁾	FC7h	SSP1STAT	FA7h	(2)	F87h	PORTH ⁽³⁾	F67h	LCDDATA1	F47h	CCPR8L
FE6h	POSTINC1 ⁽¹⁾	FC6h	SSP1CON1	FA6h	PIR6	F86h	PORTG	F66h	LCDDATA0	F46h	CCP8CON
FE5h	POSTDEC1 ⁽¹⁾	FC5h	SSP1CON2	FA5h	IPR3	F85h	PORTF	F65h	BAUDCON1	F45h	CCPR9H ⁽⁴⁾
FE4h	PREINC1 ⁽¹⁾	FC4h	ADRESH	FA4h	PIR3	F84h	PORTE	F64h	OSCCON2	F44h	CCPR9L ⁽⁴⁾
FE3h	PLUSW1 ⁽¹⁾	FC3h	ADRESL	FA3h	PIE3	F83h	PORTD	F63h	EEADRH	F43h	CCP9CON ⁽⁴⁾
FE2h	FSR1H	FC2h	ADCON0	FA2h	IPR2	F82h	PORTC	F62h	EEADR	F42h	CCPR10H ⁽⁴⁾
FE1h	FSR1L	FC1h	ADCON1	FA1h	PIR2	F81h	PORTB	F61h	EEDATA	F41h	CCPR10L ⁽⁴⁾
FE0h	BSR	FC0h	ADCON2	FA0h	PIE2	F80h	PORTA	F60h	PIE6	F40h	CCP10CON ⁽⁴⁾

Note 1: This is not a physical register.

2: Unimplemented registers are read as '0'.

3: This register is not available on 64-pin devices (PIC18F6XK90).

4: This register is not available on devices with a program memory of 32 Kbytes (PIC18FX5K90).

5: Addresses, EF4h through F5Fh, are also used by SFRs, but are not part of the Access RAM. Users must always load the proper BSR value to access these registers.

查询PIC18F67K90供应意 TABLE 6-1: PIC18F87K90 FAMILY SPECIAL FUNCTION REGISTER MAP⁽⁵⁾ (CONTINUED)

Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name	Addr.	Name
F3Fh	TMR7H ⁽⁴⁾	F32h	TMR12 ⁽⁴⁾	F25h	ANCON0	F18h	PMD1	F0Bh	CCPR6H	EFEh	SSP2CON2
F3Eh	TMR7L ⁽⁴⁾	F31h	PR12 ⁽⁴⁾	F24h	ANCON1	F17h	PMD2	F0Ah	CCPR6L	EFDh	LCDREF
F3Dh	T7CON ⁽⁴⁾	F30h	T12CON ⁽⁴⁾	F23h	ANCON2	F16h	PMD3	F09h	CCP6CON	EFCh	LCDRL
F3Ch	T7GCON ⁽⁴⁾	F2Fh	CM2CON	F22h	RCSTA2	F15h	TMR5H	F08h	CCPR7H	EFBh	LCDSE5 ⁽³⁾
F3Bh	TMR6	F2Eh	CM3CON	F21h	TXSTA2	F14h	TMR5L	F07h	CCPR7L	EFAh	LCDSE4
F3Ah	PR6	F2Dh	CCPTMRS0	F20h	BAUDCON2	F13h	T5CON	F06h	CCP7CON	EF9h	LCDSE3
F39H	T6CON	F2Ch	CCPTMRS1	F1Fh	SPBRGH2	F12h	T5GCON	F05h	TMR4	EF8h	LCDSE2
F38h	TMR8	F2Bh	CCPTMRS2	F1Eh	SPBRG2	F11h	CCPR4H	F04h	PR4	EF7h	LCDSE1
F37h	PR8	F2Ah	REFOCON	F1Dh	RCREG2	F10h	CCPR4L	F03h	T4CON	EF6h	LCDSE0
F36h	T8CON	F29H	ODCON1	F1Ch	TXREG2	F0Fh	CCP4CON	F02h	SSP2BUF	EF5h	LCDPS
F35h	TMR10 ⁽⁴⁾	F28h	ODCON2	F1Bh	PSTR2CON	F0Eh	CCPR5H	F01h	SSP2ADD	EF4h	LCDCON
F34h	PR10 ⁽⁴⁾	F27h	ODCON3	F1Ah	PSTR3CON	F0Dh	CCPR5L	F00h	SSP2STAT		
F33h	T10CON ⁽⁴⁾	F26h	—	F19h	PMD0	F0Ch	CCP5CON	EFFh	SSP2CON1]	

Note 1: This is not a physical register.

2: Unimplemented registers are read as '0'.

3: This register is not available on 64-pin devices (PIC18F6XK90).

4: This register is not available on devices with a program memory of 32 Kbytes (PIC18FX5K90).

5: Addresses, EF4h through F5Fh, are also used by SFRs, but are not part of the Access RAM. Users must always load the proper BSR value to access these registers.

查询PIC18F67K90供应商 TABLE 6-2: PIC18F87K90 FAMILY REGISTER FILE SUMMARY

Address	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	
EF4h	LCDCON	LCDEN	SLPEN	WERR	—	CS1	CS0	LMUX1	LMUX0	000- 0000	
EF5h	LCDPS	WFT	BIASMD	LCDA	WA	LP3	LP2	LP1	LP0	0000 0000	
EF6h	LCDSE0	SE07	SE06	SE05	SE04	SE03	SE02	SE01	SE00	0000 0000	
EF7h	LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE09	SE08	0000 0000	
EF8h	LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	0000 0000	
EF9h	LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	0000 0000	
EFAh	LCDSE4	SE39	SE38	S37	SE36	SE35	SE34	SE33	SE32	0000 0000	
EFBh	LCDSE5 ⁽²⁾	SE47	SE46	SE45	SE44	SE43	SE42	SE41	SE40	0000 0000	
EFCh	LCDRL	LRLAP1	LRLAP0	LRLBP1	LRLBP0	_	LRLAT2	LRLAT1	LRLAT0	0000 -000	
EFDh	LCDREF	LCDIRE	LCDIRS	LCDCST2	LCDCST1	LCDCST0	VLCD3PE	VLCD2PE	VLCD1PE	0000 0000	
EFEh	SSP2CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	
EFFh	SSP2CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	
F00h	SSP2STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	0000 0000	
F01h	SSP2ADD	MSSP Addres			Vode, SSP1 E	-				0000 0000	
F02h	SSP2BUF		SP Receive Buffer/Transmit Register								
F03h	T4CON	_	— T40UTPS3 T40UTPS2 T40UTPS1 T40UTPS0 TMR40N T4CKPS1 T4CKPS0								
F04h	PR4	Timer4 Period							11014 00	-000 0000	
F05h	TMR4	Timer4 Regis	•							1111 1111	
F06h	CCP7CON		— — DC7B1 DC7B0 CCP7M3 CCP7M2 CCP7M1 CCP7M0						00 0000		
F07h	CCPR7L	Capture/Com	nare/PWM Re	egister 7 Low			00171112	00171111	00171110	xxxx xxxx	
F08h	CCPR7H			egister7 High						XXXX XXXX	
F09h	CCP6CON			DC6B1	DC6B0	CCP6M3	CCP6M2	CCP6M1	CCP6M0	00 0000	
F0Ah	CCPR6L	Capture/Com	nare/P\//M R	egister 6 Low						xxxx xxxx	
F0Bh	CCPR6H			egister6 High						XXXX XXXX	
F0Ch	CCP5CON			DC5B1	DC5B0	CCP5M3	CCP5M2	CCP5M1	CCP5M0	00 0000	
F0Dh	CCPR5L	Capture/Com	nare/P\//M R	egister 5 Low		001 51015				xxxx xxxx	
F0Eh	CCPR5H			egister 5 Low							
F0Fh	CCP4CON	Capture/Com		DC4B1	DC4B0	CCP4M3	CCP4M2	CCP4M1	CCP4M0	00 0000	
	CCP4CON CCPR4L			egister 4 Low		CCF4IVI3	CCF4IVIZ	CCF4IMI	CCF4IVIU		
F10h				egister 4 High						XXXX XXXX	
F11h F12h	CCPR4H T5GCON	TMR5GE	T5GPOL	T5GTM	T5GSPM	T5GGO/ T5DONE	T5GVAL	T5GSS1	T5GSS0	xxxx xxxx 0000 0000	
F13h	T5CON	TMR5CS1	TMR5CS0	T5CKPS1	T5CKPS0	SOSCEN	T5SYNC	RD16	TMR5ON	0000 0000	
F14h	TMR5L	Timer5 Regis		100101	100101 00	COODEN	1001110	RDTO	THIRDON	0000 0000	
	TMR5H	Timer5 Regis									
	PMD3	CCP10MD ⁽³⁾	(*)	CCP8MD	CCP7MD	CCP6MD	CCP5MD	CCP4MD	TMR12MD ⁽³⁾	xxxx xxxx 0000 0000	
	PMD2	TMR10MD ⁽³⁾	TMR8MD	TMR7MD ⁽³⁾	TMR6MD	TMR5MD	CMP3MD	CMP2MD	CMP1MD	0000 0000	
	PMD1		CTMUMD	RTCCMD	TMR4MD	TMR3MD	TMR2MD	TMR1MD		-000 000-	
	PMD0	CCP3MD	CCP2MD	CCP1MD	UART2MD	UART1MD	SSP2MD	SSP1MD	ADCMD	0000 0000	
				COPINID	STRSYNC						
	PSTR3CON	CMPL1	CMPL0			STRD	STRC STRC	STRB	STRA	00-0 0001	
F1Bh F1Ch	PSTR2CON TXREG2	CMPL1 Transmit Data		_	STRSYNC	STRD	JIRU	STRB	STRA	00-0 0001	
										XXXX XXXX	
	RCREG2	Receive Data		ator Low Dot-						0000 0000	
F1Eh	SPBRG2			ator Low Byte						0000 0000	
F1Fh	SPBRGH2			ator High Byte	1			14/1-1-		0000 0000	
	BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	-	WUE	ABDEN	0100 0-00	
F21h	TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	0000 0010	
	RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	
F23h	ANCON2	ANSEL23	ANSEL22	ANSEL21	ANSEL20	ANSEL19	ANSEL18	ANSEL17	ANSEL16	1111 1111	

Pit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, bit is unimplemented.
 Unimplemented on 64-pin devices (PIC18F6XK90).

3: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商 TABLE 6-2: PIC18F87K90 FAMILY REGISTER FILE SUMMARY (CONTINUED)

Address	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR
F24h	ANCON1	ANSEL15	ANSEL14	ANSEL13	ANSEL12	ANSEL11	ANSEL10	ANSEL9	ANSEL8	1111 1111
F25h	ANCON0	ANSEL7	ANSEL6	ANSEL5	ANSEL4	ANSEL3	ANSEL2	ANSEL1	ANSEL0	1111 1111
	_	_	—		_	_	—	—	—	_
F27h	ODCON3	U2OD	U10D		_	_	_	_	CTMUDS	000
F28h	ODCON2	CCP100D	CCP9OD	CCP8OD	CCP7OD	CCP6OD	CCP5OD	CCP4OD	CCP3OD	0000 0000
F29H	ODCON1	SSP10D	CCP2OD	CCP10D	_	_	—	—	SSP2OD	0000
F2Ah	REFOCON	ROON	_	ROSSLP	ROSEL	RODIV3	RODIV2	RODIV1	RODIV0	0-00 0000
F2Bh	CCPTMRS2	_	_	_	C10TSEL0	_	C9TSEL0	C8TSEL1	C8TSEL0	0 -000
F2Ch	CCPTMRS1	C7TSEL1	C7TSEL0	_	C6TSEL0	_	C5TSEL0	C4TSEL1	C4TSEL0	00-0 -000
F2Dh	CCPTMRS0	C3TSEL1	C3TSEL0	C2TSEL2	C2TSEL1	C2TSEL0	C1TSEL2	C1TSEL1	C1TSEL0	0000 0000
F2Eh	CM3CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	0001 1111
F2Fh	CM2CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	0001 1111
F30h	T12CON	_	T12OUTPS3	T12OUTPS2	T12OUTPS1	T12OUTPS0	TMR12ON	T12CKPS1	T12CKPS0	-000 0000
F31h	PR12	Timer12 Peri	od Register					•	•	1111 1111
F32h	TMR12	TMR12 Regi	ster							0000 0000
F33h	T10CON	_	T10OUTPS3	T10OUTPS2	T10OUTPS1	T10OUTPS0	TMR100N	T10CKPS1	T10CKPS0	-000 0000
F34h	PR10	Timer10 Peri	od Register							1111 1111
F35h	TMR10	TMR10 Regi	ster							0000 0000
F36h	T8CON	_	T8OUTPS3	T8OUTPS2	T8OUTPS1	T8OUTPS0	TMR8ON	T8CKPS1	T8CKPS0	-000 0000
F37h	PR8	Timer8 Perio	d Register							1111 1111
F38h	TMR8	Timer8 Register								0000 0000
F39H	T6CON	_	T6OUTPS3	T6OUTPS2	T6OUTPS1	T6OUTPS0	TMR6ON	T6CKPS1	T6CKPS0	-000 0000
F3Ah	PR6	Timer6 Period Register							1111 1111	
F3Bh	TMR6	Timer6 Register							0000 0000	
F3Ch	T7GCON ⁽³⁾	TMR7GE	T7GPOL	T7GTM	T7GSPM	T7GGO/ T7DONE	T7GVAL	T7GSS1	T7GSS0	0000 0x00
F3Dh	T7CON ⁽³⁾	TMR7CS1	TMR7CS0	T7CKPS1	T7CKPS0	_	T7SYNC	RD16	TMR7ON	0000 0x00
F3Eh	TMR7L ⁽³⁾	Timer7 Regis	ter Low Byte							xxxx xxxx
F3Fh	TMR7H ⁽³⁾	Timer7 Regis	ter High Byte							xxxx xxxx
F40h	CCP10CON ⁽³⁾	_	_	DC10B1	DC10B0	CCP10M3	CCP10M2	CCP10M1	CCP10M0	00 0000
F41h	CCPR10L ⁽³⁾	Capture/Com	pare/PWM Re	egister 10 Low	v Byte					xxxx xxxx
F42h	CCPR10H ⁽³⁾	Capture/Com	pare/PWM Re	egister 10 Hig	h Byte					XXXX XXXX
F43h	CCP9CON ⁽³⁾	_	_	DC9B1	DC9B0	CCP9M3	CCP9M2	CCP9M1	CCP9M0	00 0000
F44h	CCPR9L ⁽³⁾	Capture/Com	pare/PWM Re	egister 9 Low	Byte					XXXX XXXX
F45h	CCPR9H ⁽³⁾	Capture/Com	pare/PWM Re	egister 9 High	Byte					XXXX XXXX
F46h	CCP8CON	_	_	DC8B1	DC8B0	CCP8M3	CCP8M2	CCP8M1	CCP8M0	00 0000
F47h	CCPR8L	Capture/Com	pare/PWM Re	egister 8 Low	Byte					XXXX XXXX
F48h	CCPR8H	Capture/Com	pare/PWM Re	egister 8 High	Byte					XXXX XXXX
F49h	CCP3CON	P3M1	P3M0	DC3B1	DC3B0	CCP3M3	CCP3M2	CCP3M1	CCP3M0	0000 0000
F4Ah	CCPR3L	Capture/Com	pare/PWM Re	egister 3 Low	Byte					xxxx xxxx
F4Bh	CCPR3H		pare/PWM Re	•						xxxx xxxx
F4Ch	ECCP3DEL	P3RSEN	P3DC6	P3DC5	P3DC4	P3DC3	P3DC2	P3DC1	P3DC0	0000 0000
F4Dh	ECCP3AS		ECCP3AS2			PSS3AC1	PSS3AC0	PSS3BD1	PSS3BD0	0000 0000
F4Eh	CCP2CON	P2M1	P2M0	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	0000 0000
F4Fh	CCPR2L		pare/PWM Re							xxxx xxxx

Note 1: Bit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, bit is unimplemented.

2: Unimplemented on 64-pin devices (PIC18F6XK90).

3: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商 TABLE 6-2: PIC18F87K90 FAMILY REGISTER FILE SUMMARY (CONTINUED)

Address	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR
F50h	CCPR2H	Capture/Com	pare/PWM Re	egister 2 High	Byte					XXXX XXXX
F51h	ECCP2DEL	P2RSEN	P2DC6	P2DC5	P2DC4	P2DC3	P2DC2	P2DC1	P2DC0	0000 0000
F52h	ECCP2AS	ECCP2ASE	ECCP2AS2	ECCP2AS1	ECCP2AS0	PSS2AC1	PSS2AC0	PSS2BD1	PSS2BD0	0000 0000
F53h	PADCFG1	RDPU	REPU	RJPU ⁽²⁾	_	_	RTSECSEL1	RTSECSEL0	_	00000-
F54h	CM1CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	0001 1111
F55h	CTMUICON	ITRIM5	ITRIM4	ITRIM3	ITRIM2	ITRIM1	ITRIM0	IRNG1	IRNG1	0000 0000
F56h	CTMUCONL	EDG2POL	EDG2SEL1	EDG2SEL0	EDG1POL	EDG1SEL1	EDG1SEL0	EDG2STAT	EDG1STAT	0000 0000
F57h	CTMUCONH	CTMUEN	_	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	CTTRIG	0-00 0000
F58h	ALRMVALL		High Register		d on APTR<1					0000 000
-59h	ALRMVALH		High Register							xxxx xxx
F5Ah	ALRMRPT	ARPT7	ARPT6	ARPT5	ARPT4	ARPT3	ARPT2	ARPT1	ARPT0	0000 000
F5Bh	ALRMCFG	ALRMEN	CHIME	AMASK3	AMASK2	AMASK1	AMASK0	ALRMPTR1	ALRMPTR0	0000 000
=5Ch	RTCVALL		Low Register				7 (10) (0) (0)			0000 000
	RTCVALL		High Register							
F5Dh		CAL7	<u> </u>				041.0	CAL1	CAL0	XXXX XXX
F5Eh	RTCCAL		CAL6	CAL5	CAL4	CAL3	CAL2	CAL1		XXXX XXX
-5Fh	RTCCFG	RTCEN	_	RTCWREN	RTCSYNC	HALFSEC	RTCOE	RTCPTR1	RTCPTR0	0-00 000
-60h	PIE6	—		—	EEIE	—	CMP3IE	CMP2IE	CMP1IE	0 -00
-61h	EEDATA	EEPROM Da	0							0000 000
-62h	EEADR		dress Registe	,						0000 000
-63h	EEADRH	EEPROM Ad	dress Registe	r High Byte						0
-64h	OSCCON2	—	SOSCRUN	—	—	SOSCGO	—	MFIOFS	MFIOSEL	-0 0-x
-65h	BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	0000 0-x
-66h	LCDDATA0	S07C0	S06C0	S05C0	S04C0	S03C0	S02C0	S01C0	S00C0	XXXX XXX
-67h	LCDDATA1	S15C0	S14C0	S13C0	S12C0	S11C0	S10C0	S09C0	S08C0	XXXX XXX
F68h	LCDDATA2	S23C0	S22C0	S21C0	S20C0	S19C0	S18C0	S17C0	S16C0	XXXX XXX
F69h	LCDDATA3	S31C0	S30C0	S29C0	S28C0	S27C0	S26C0	S25C0	S24C0	XXXX XXX
F6Ah	LCDDATA4	S39C0	S38C0	S37C0	S36C0	S35C0	S34C0	S33C0	S32C0	xxxx xxx
F6Bh	LCDDATA5	S47C0	S46C0	S45C0	S44C0	S43C0	S42C0	S41C0	S40C0	XXXX XXX
F6Ch	LCDDATA6	S07C1	S06C1	S05C1	S04C1	S03C1	S02C1	S01C1	S00C1	XXXX XXX
F6Dh	LCDDATA7	S15C1	S14C1	S13C1	S12C1	S11C1	S10C1	S09C1	S08C1	xxxx xxx
F6Eh	LCDDATA8	S23C1	S22C1	S21C1	S20C1	S19C1	S18C1	S17C1	S16C1	XXXXXXXX
F6Fh	LCDDATA9	S31C1	S30C1	S29C1	S28C1	S27C1	S26C1	S25C1	S24C1	xxxx xxx
F70h	LCDDATA10 ⁽²⁾	S39C1 ⁽²⁾	S38C1 ⁽²⁾	S37C1 ⁽²⁾	S36C1 ⁽²⁾	S35C1 ⁽²⁾	S34C1 ⁽²⁾	S33C1 ⁽²⁾	S32C1	XXXX XXX
F71h	LCDDATA11 ⁽²⁾	S47C1	S46C1	S45C1	S44C1	S43C1	S42C1	S41C1	S40C1	xxxx xxx
F72h	LCDDATA12	S07C2	S06C2	S05C2	S04C2	S03C2	S02C2	S01C2	S00C2	xxxx xxx
-73h	LCDDATA13	S15C2	S14C2	S13C2	S12C2	S11C2	S10C2	S09C2	S08C2	xxxx xxx
-74h	LCDDATA14	S23C2	S22C2	S21C2	S20C2	S19C2	S18C2	S17C2	S16C2	xxxx xxx
F75h	LCDDATA15	S31C2	S30C2	S29C2	S28C2	S27C2	S26C2	S25C2	S24C2	XXXX XXX
-76h	LCDDATA16 ⁽²⁾	S39C2 ⁽²⁾	S38C2 ⁽²⁾	S37C2 ⁽²⁾	S36C2 ⁽²⁾	S35C2 ⁽²⁾	S34C2 ⁽²⁾	S33C2 ⁽²⁾	S32C2	XXXX XXX
=77h	LCDDATA17 ⁽²⁾	S47C2	S46C2	S45C2	S44C2	S43C2	S42C2	S41C2	S40C2	XXXX XXX
F78h	LCDDATA17	S07C3	S06C3	S05C3	S04C3	S03C3	S02C3	S01C3	S00C3	
	LCDDATA18									xxxx xxx
=79h =74b		S15C3	S14C3	S13C3	S12C3	S11C3	S10C3	S09C3	S08C3	xxxx xxx
F7Ah	LCDDATA20	S23C3	S22C3	S21C3	S20C3	S19C3	S18C3	S17C3	S16C3	XXXX XXX
F7Bh	LCDDATA21	S31C3	S30C3	S29C3	S28C3	S27C3	S26C3	S25C3	S24C3	XXXX XXX
F7Ch	LCDDATA22	S39C3 ⁽²⁾	S38C3 ⁽²⁾	S37C3 ⁽²⁾	S36C3 ⁽²⁾	S35C3 ⁽²⁾	S34C3 ⁽²⁾	S33C3 ⁽²⁾	S32C3	XXXX XXX
F7Dh	LCDDATA23 ⁽²⁾	S47C3	S46C3	S45C3	S44C3	S43C3	S42C3	S41C3	S40C3	XXXX XXXX
F7Eh	EECON2		ntrol Register	2 (not a phys	,				1	
F7Fh	EECON1	EEPGD	CFGS	—	FREE	WRERR	WREN	WR	RD	xx-0 x00
F80h	PORTA	RA7	RA6	RA5	RA4	RA3	RA2	RA1	RA0	XXXX XXX

2: Unimplemented on 64-pin devices (PIC18F6XK90).

Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商

TABLE 6-2: PIC18F87K90 FAMILY REGISTER FILE SUMMARY (CONTINUED)

Address	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR
F81h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	XXXX XXXX
F82h	PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	XXXX XXXX
F83h	PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	XXXX XXXX
F84h	PORTE	RE7	RE6	RE5	RE4	RE3	RE2	RE1	RE0	xxxx xxxx
F85h	PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	xxxx xxx-
F86h	PORTG	—	_	RG5 ⁽¹⁾	RG4	RG3	RG2	RG1	RG0	xx xxxx
F87h	PORTH ⁽²⁾	RH7	RH6	RH5	RH4	RH3	RH2	RH1	RH0	XXXX XXXX
F88h	PORTJ ⁽²⁾	RJ7	RJ6	RJ5	RJ4	RJ3	RJ2	RJ1	RJ0	XXXX XXXX
F89h	LATA	LATA7	LATA6	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0	XXXX XXXX
F8Ah	LATB	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	XXXX XXXX
F8Bh	LATC	LATC7	LATC6	LATC5	LATC4	LATC3	LATC2	LATC1	LATC0	XXXX XXXX
F8Ch	LATD	LATD7	LATD6	LATD5	LATD4	LATD3	LATD2	LATD1	LATD0	xxxx xxxx
F8Dh	LATE	LATE7	LATE6	LATE5	LATE4	LATE3	LATE2	LATE1	LATE0	xxxx xxxx
F8Eh	LATF	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1	_	xxxx xxx-
F8Fh	LATG	_	_	_	LATG4	LATG3	LATG2	LATG1	LATG0	x xxxx
F90h	LATH ⁽²⁾	LATH7	LATH6	LATH5	LATH4	LATH3	LATH2	LATH1	LATH0	XXXX XXXX
F91h	LATJ ⁽²⁾	LATJ7	LATJ6	LATJ5	LATJ4	LATJ3	LATJ2	LATJ1	LATJ0	xxxx xxxx
F92h	TRISA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1111 1111
F93h	TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	1111 1111
F94h	TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	1111 1111
F95h	TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	1111 1111
F96h	TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	1111 1111
F97h	TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1		1111 111-
F98h	TRISG		_		TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	1 1111
F99h	TRISH ⁽²⁾	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	1111 1111
F9Ah	TRISJ ⁽²⁾	TRISJ7	TRISJ6	TRISJ5	TRISJ4	TRISJ3	TRISJ2	TRISJ1	TRISJ0	1111 1111
F9Bh	OSCTUNE	INTSRC	PLLEN	TUN5	TUN4	TUN3	TUN2	TUN1	TUN0	0000 0000
F9Ch	PSTR1CON	CMPL1	CMPL0	-	STRSYNC	STRD	STRC	STRB	STRA	00-0 0001
F9Dh	PIE1		ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	-000 0000
F9Eh	PIR1		ADIF	RC1IF	TX1IE	SSP1IF	TMR1GIE	TMR2IE	TMR1IF	-000 0000
F9Fh	IPR1		ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	-111 1111
FA0h	PIE2	OSCFIE	ADII	SSP2IE	BCL2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	0-10 0000
FA1h	PIR2	OSCFIF		SSP2IE SSP2IF	BCL2IE BCL2IF	BCL1IF	HLVDIE	TMR3IF	TMR3GIE TMR3GIF	0-10 0000
FA2h	IPR2	OSCFIP		SSP2IP	BCL2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP	1-00 1110
	PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	0000 0000
FA4h	PIR3	TMR5GIE TMR5GIF	LCDIE	RC2IE RC2IF	TX2IE TX2IF	CTMUL	CCP2IE CCP2IF	CCP1IE CCP1IF	RTCCIE	0000 0000
	IPR3	TMR5GIP	LCDIP		TX2IP		CCP2IP	CCP1IP	RTCCIP	
FA5h FA6h	PIR6	TWINGGIP		RC2IP	EEIF	CTMUIP	CCP2IP CMP3IF	CCPTIP CMP2IF	CMP1IF	1111 1111
	FIRO	_					CIVIF3IF			
FA7h			-							
FA8h	HLVDCON	VDIRMAG	BGVST	IRVST	HLVDEN	HLVDL3	HLVDL2	HLVDL1	HLVDL0	0000 0000
FA9h	IPR6				EEIP	— T1000/	CMP3IP	CMP2IP	CMP1IP	1 -111
FAAh	T1GCON	TMR1GE	T1GPOL	T1GTM	T1GSPM	T1GGO/ T1DONE	T1GVAL	T1GSS1	T1GSS0	0000 0x00
FABh	RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x
FACh	TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	0000 0010
FADh	TXREG1	USART1 Trar	nsmit Register	-						XXXX XXXX
FAEh	RCREG1	USART1 Rec	eive Register							0000 0000
FAFh	SPBRG1	USART1 Bau	d Rate Gener	ator						0000 0000

Note 1: Bit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, bit is unimplemented.

2: Unimplemented on 64-pin devices (PIC18F6XK90).

3: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

	6-2: Pl	C18F87K		TREGIS		JUIVIIVIA		TINUED)		T
Address	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Valu POR
FB0h	T3GCON	TMR3GE	T3GPOL	T3GTM	T3GSPM	T3GGO/ T3DONE	T3GVAL	T3GSS1	T3GSS0	0000
FB1h	T3CON	TMR3CS1	TMR3CS0	T3CKPS1	T3CKPS0	SOSCEN	T3SYNC	RD16	TMR3ON	0000
FB2h	TMR3L	Timer3 Regis	ter Low Byte							xxxx
FB3h	TMR3H	Timer3 Regis	ter High Byte							xxxx
FB4h	CMSTAT	CMP3OUT	CMP2OUT	CMP10UT	_	_	_	_	_	111-
FB5h	CVRCON	CVREN	CVROE	CVRSS	CVR4	CVR3	CVR2	CVR1	CVR0	0000
FB6h	PIE4	CCP10IE ⁽³⁾	CCP9IE ⁽³⁾	CCP8IE	CCP7IE ⁽³⁾	CCP6IE	CCP5IE	CCP4IE	CCP3IE	0000
FB7h	PIR4	CCP10IF ⁽³⁾	CCP9IF ⁽³⁾	CCP8IF	CCP7IF ⁽³⁾	CCP6IF	CCP5IF	CCP4IF	CCP3IF	0000
FB8h	IPR4	CCP10IP ⁽³⁾	CCP9IP ⁽³⁾	CCP8IP	CCP7IP ⁽³⁾	CCP6IP	CCP5IP	CCP4IP	CCP3IP	1111
FB9h	PIE5	TMR7GIE ⁽³⁾	TMR12IE ⁽³⁾	TMR10IE ⁽³⁾	TMR8IE	TMR7IE ⁽³⁾	TMR6IE	TMR5IE	TMR4IE	0000
FBAh	PIR5	TMR7GIF ⁽³⁾	TMR12IF ⁽³⁾		TMR8IF	TMR7IF ⁽³⁾	TMR6IF	TMR5IF	TMR4IF	0000
FBBh	CCP1CON	P1M1	P1M0	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	0000
FBCh	CCPR1L			egister 1 Low				1	1	xxxx
FBDh	CCPR1H	Capture/Com	pare/PWM Re	egister 1 High	Bvte					xxxx
FBEh	ECCP1DEL	P1RSEN	P1DC6	P1DC5	P1DC4	P1DC3	P1DC2	P1DC1	P1DC0	0000
FBFh	ECCP1AS	ECCP1ASE		ECCP1AS1	ECCP1AS0	PSS1AC1	PSS1AC0	PSS1BD1	PSS1BD0	0000
FC0h	ADCON2	ADFM	_	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0	0-00
FC1h	ADCON1	TRIGSEL1	TRIGSEL0	VCFG1	VCFG0	VNCFG	CHSN2	CHSN1	CHSN0	0000
FC2h	ADCON0	TRICOLLI	CHS4	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON	-000
FC3h					0132	CHOI	0130	GO/DOINE	ADON	-000 xxxx
	ADRESL									
FC4h	ADRESH					DOEN	DEN	DOEN		xxxx
FC5h	SSP1CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000
FC6h	SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000
FC7h	SSP1STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	0000
FC8h	SSP1ADD				Mode. SSP1 E	aud Rate Rel	oad Register	in I ² C Master	Mode	0000
FC9h	SSP1BUF	MSSP Receiv		smit Register	1					XXXX
FCAh	T2CON			T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000
FCBh	PR2	Timer2 Perio								1111
FCCh	TMR2	Timer2 Regis	ter		1	r	·	r	r	0000
FCDh	T1CON	TMR1CS1	TMR1CS0	T1CKPS1	T1CKPS0	SOSCEN	T1SYNC	RD16	TMR10N	0000
FCEh	TMR1L	Timer1 Regis	ter Low Byte							xxxx
FCFh	TMR1H	Timer1 Regis	ter High Byte							xxxx
FD0h	RCON	IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	0111
FD1h	WDTCON	REGSLP	_	ULPLVL	SRETEN	_	ULPEN	ULPSINK	SWDTEN	0-x0
FD2h	IPR5	TMR7GIP ⁽³⁾	TMR12IP ⁽³⁾	TMR10I ⁽³⁾ P	TMR8IP	TMR7IP ⁽³⁾	TMR6IP	TMR5IP	TMR4IP	1111
FD3h	OSCCON	IDLEN	IRCF2	IRCF1	IRCF0	OSTS	HFIOFS	SCS1	SCS0	0110
FD4h	SPBRGH1	USART1 Bau	d Rate Gener	rator High Byt	е					0000
FD5h	T0CON	TMR0ON	T08BIT	TOCS	TOSE	PSA	TOPS2	TOPS1	TOPS0	1111
FD6h	TMR0L	Timer0 Regis	ter Low Byte	•	•			-		xxxx
FD7h	TMR0H		ter High Byte							0000
FD8h	STATUS	_	_	_	N	OV	Z	DC	С	2
FD9h	FSR2L	Indirect Data	Memory Addr	ess Pointer 2		I	I			xxxx
FDAh	FSR2H			_		Indirect Data	Memory Add	ress Pointer 2	High Byte	
FDBh	PLUSW2		s of FSR2 to a 2 offset by W	address data	memory – valu		-			
FDCh	PREINC2			address data	memory - valu	ue of FSR2 pr	eincremente	ed (not a physi	ical register)	
FDDh	POSTDEC2	Uses contents of FSR2 to address data memory – value of FSR2 preincremented (not a physical register) – Uses contents of FSR2 to address data memory – value of FSR2 post-decremented (not a physical register) –							1	

Note 1: Bit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, bit is unimplemented.

2: Unimplemented on 64-pin devices (PIC18F6XK90).

3: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商 TABLE 6-2: PIC18F87K90 FAMILY REGISTER FILE SUMMARY (CONTINUED)

Address	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR
FDFh	INDF2	Uses content	s of FSR2 to a	address data	memory – val	ue of FSR2 no	t changed (no	ot a physical r	egister)	
FE0h	BSR	—	—	_	—	Bank Select F	Register			0000
FE1h	FSR1L	Indirect Data	Memory Addr	ess Pointer 1	Low Byte					XXXX XXXX
FE2h	FSR1H	_	_	_	_	Indirect Data	Memory Addr	ess Pointer 1	High Byte	xxxx
FE3h	PLUSW1		s of FSR1 to a 1 offset by W	address data	memory – val	ue of FSR1 pro	e-incremented	d (not a physic	cal register) –	
FE4h	PREINC1	Uses content	s of FSR1 to a	address data	memory – val	ue of FSR1 pr	e-incremented	d (not a physic	cal register)	
FE5h	POSTDEC1	Uses content	s of FSR1 to a	address data	memory – val	ue of FSR1 po	st-decrement	ed (not a phys	sical register)	
FE6h	POSTINC1	Uses content	s of FSR1 to a	address data	memory – val	ue of FSR1 po	st-incremente	ed (not a phys	ical register)	
FE7h	INDF1	Uses content	s of FSR1 to a	address data	memory - val	ue of FSR1 no	t changed (no	ot a physical r	egister)	
FE8h	WREG	Working Reg	ister							XXXX XXXX
FE9h	FSR0L	Indirect Data	Memory Addr	ess Pointer 0	Low Byte					XXXX XXXX
FEAh	FSR0H	_	—		_	Indirect Data	Memory Addr	ess Pointer 0	High Byte	xxxx
FEBh	PLUSW0		Uses contents of FSR0 to address data memory – value of FSR0 pre-incremented (not a physical register) – value of FSR0 offset by W							
FECh	PREINC0	Uses content	Uses contents of FSR0 to address data memory – value of FSR0 pre-incremented (not a physical register)							
FEDh	POSTDEC0	Uses content	Uses contents of FSR0 to address data memory – value of FSR0 post-decremented (not a physical register)							
FEEh	POSTINC0	Uses content	Uses contents of FSR0 to address data memory – value of FSR0 post-incremented (not a physical register)							
FEFh	INDF0	Uses content	s of FSR0 to a	address data	memory - val	ue of FSR0 no	t changed (no	ot a physical r	egister)	
FF0h	INTCON3	INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF	1100 0000
FF1h	INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP	1111 1111
FF2h	INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INTOIF	RBIF	0000 000x
FF3h	PRODL	Product Regi	ster Low Byte							XXXX XXXX
FF4h	PRODH	Product Regi	ster High Byte	;						xxxxxxxx
FF5h	TABLAT	Program Mer	nory Table La	tch						0000 0000
FF6h	TBLPTRL	Program Mer	nory Table Po	inter Low Byt	e (TBLPTR<7	:0>)				0000 0000
FF7h	TBLPTRH	Program Mer	nory Table Po	inter High By	te (TBLPTR<1	5:8>)				0000 0000
FF8h	TBLPTRU	_	_	bit 21	Program Mer	nory Table Po	inter Upper B	yte (TBLPTR∢	<20:16>)	00 0000
FF9h	PCL	PC Low Byte	(PC<7:0>)	•						0000 0000
FFAh	PCLATH	Holding Regi	ster for PC<1	5:8>						0000 0000
FFBh	PCLATU	—	—	—	Holding Regi	ster for PC<20):16>			0 0000
FFCh	STKPTR	STKFUL	STKUNF	_	Return Stack	Pointer				uu-0 0000
FFDh	TOSL	Top-of-Stack	Low Byte (TO	S<7:0>)						0000 0000
FFEh	TOSH	Top-of-Stack	High Byte (TC)S<15:8>)						0000 0000
FFFh	TOSU		_		Top-of-Stack	Upper Byte (T	OS<20:16>)			0 0000

Bit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, bit is unimplemented. Note 1:

Unimplemented on 64-pin devices (PIC18F6XK90). 2:

3: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商 6.3.5

STATUS REGISTER

The STATUS register, shown in Register 6-2, contains the arithmetic status of the ALU. The STATUS register can be the operand for any instruction, as with any other register. If the STATUS register is the destination for an instruction that affects the Z, DC, C, OV or N bits, the write to these five bits is disabled.

These bits are set or cleared according to the device logic. Therefore, the result of an instruction with the STATUS register as destination may be different than intended. For example, CLRF STATUS will set the Z bit but leave the other bits unchanged. The STATUS register then reads back as '000u uluu'.

It is recommended, therefore, that only BCF, BSF, SWAPF, MOVFF and MOVWF instructions be used to alter the STATUS register because these instructions do not affect the Z, C, DC, OV or N bits in the STATUS register.

For other instructions not affecting any Status bits, see the instruction set summaries in Table 29-2 and Table 29-3.

Note: The C and DC bits operate, in subtraction, as borrow and digit borrow bits, respectively.

REGISTER 6-2: STATUS REGISTER

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
	_	_	N	OV	Z	DC ⁽¹⁾	C ⁽²⁾	
bit 7							bit 0	
Logondu								
Legend: R = Read		W = Writable	bit	II – I Inimplen	nented bit, rea	d as '0'		
	e at POR	'1' = Bit is set		'0' = Bit is cle		x = Bit is unkr	nwn	
					uicu		IOWIT	
bit 7-5	Unimplem	ented: Read as '	כ'					
bit 4 N: Negative bit This bit is used for signed arithmetic (2's complement). It indicates whether the result was negative (ALU MSB = 1). 1 = Result was negative 0 = Result was positive								
bit 3	which caus 1 = Overflo	ow bit used for signed ar ses the sign bit (bi ow occurred for sig erflow occurred	t 7) to change	state.			bit magnitude	
bit 2		sult of an arithmet sult of an arithmet			. 0			
bit 1	DC: Digit (For ADDWF 1 = A carry	Carry/Borrow bit ⁽¹⁾ , ADDLW, SUBL /-out from the 4th ry-out from the 4th	w and SUBWF low-order bit c	instructions: f the result occ				
bit 0								
Note 1: 2:	operand. For re For borrow, the	e polarity is reverse otate (RRF, RLF) e polarity is reverse otate (RRF, RLF) r.	instructions, th ed. A subtracti	is bit is loaded v on is executed l	with either bit 4 by adding the 2	or bit 3 of the s 2's complement	ource register of the second	

6.4 Data Addressing Modes

Note:	The execution of some instructions in the							
	core PIC18 instruction set are changed							
	when the PIC18 extended instruction set is							
	enabled. For more information, see							
	Section 6.6 "Data Memory and the							
	Extended Instruction Set".							

While the program memory can be addressed in only one way, through the program counter, information in the data memory space can be addressed in several ways. For most instructions, the addressing mode is fixed. Other instructions may use up to three modes, depending on which operands are used and whether or not the extended instruction set is enabled.

The addressing modes are:

- Inherent
- Literal
- Direct
- Indirect

An additional addressing mode, Indexed Literal Offset, is available when the extended instruction set is enabled (XINST Configuration bit = 1). For details on this mode's operation, see **Section 6.6.1 "Indexed Addressing with Literal Offset**".

6.4.1 INHERENT AND LITERAL ADDRESSING

Many PIC18 control instructions do not need any argument at all. They either perform an operation that globally affects the device or they operate implicitly on one register. This addressing mode is known as Inherent Addressing. Examples of this mode include SLEEP, RESET and DAW.

Other instructions work in a similar way, but require an additional explicit argument in the opcode. This method is known as the Literal Addressing mode because the instructions require some literal value as an argument. Examples of this include ADDLW and MOVLW which, respectively, add or move a literal value to the W register. Other examples include CALL and GOTO, which include a 20-bit program memory address.

6.4.2 DIRECT ADDRESSING

Direct Addressing specifies all or part of the source and/or destination address of the operation within the opcode itself. The options are specified by the arguments accompanying the instruction.

In the core PIC18 instruction set, bit-oriented and byte-oriented instructions use some version of Direct Addressing by default. All of these instructions include some 8-bit literal address as their Least Significant Byte. This address specifies the instruction's data source as either a register address in one of the banks of data RAM (see Section 6.3.3 "General Purpose Register File") or a location in the Access Bank (see Section 6.3.2 "Access Bank").

The Access RAM bit 'a' determines how the address is interpreted. When 'a' is '1', the contents of the BSR (Section 6.3.1 "Bank Select Register") are used with the address to determine the complete 12-bit address of the register. When 'a' is '0', the address is interpreted as being a register in the Access Bank. Addressing that uses the Access RAM is sometimes also known as Direct Forced Addressing mode.

A few instructions, such as MOVFF, include the entire 12-bit address (either source or destination) in their opcodes. In these cases, the BSR is ignored entirely.

The destination of the operation's results is determined by the destination bit, 'd'. When 'd' is '1', the results are stored back in the source register, overwriting its original contents. When 'd' is '0', the results are stored in the W register. Instructions without the 'd' argument have a destination that is implicit in the instruction, either the target register is being operated on or the W register.

6.4.3 INDIRECT ADDRESSING

Indirect Addressing allows the user to access a location in data memory without giving a fixed address in the instruction. This is done by using File Select Registers (FSRs) as pointers to the locations to be read or written to. Since the FSRs are themselves located in RAM as Special Function Registers, they can also be directly manipulated under program control. This makes FSRs very useful in implementing data structures such as tables and arrays in data memory.

The registers for Indirect Addressing are also implemented with Indirect File Operands (INDFs) that permit automatic manipulation of the pointer value with auto-incrementing, auto-decrementing or offsetting with another value. This allows for efficient code using loops, such as the example of clearing an entire RAM bank in Example 6-5. It also enables users to perform Indexed Addressing and other Stack Pointer operations for program memory in data memory.

EXAMPLE 6-5: HOW TO CLEAR RAM (BANK 1) USING INDIRECT ADDRESSING

	LFSR	FSR0, 100h	;	
NEXT	CLRF	POSTINC0	;	Clear INDF
			;	register then
			;	inc pointer
	BTFSS	FSROH, 1	;	All done with
			;	Bank1?
	BRA	NEXT	;	NO, clear next
CONTIN	UE		;	YES, continue

6.4.3.1 FSR Registers and the INDF Operand

At the core of Indirect Addressing are three sets of registers: FSR0, FSR1 and FSR2. Each represents a pair of 8-bit registers: FSRnH and FSRnL. The four upper bits of the FSRnH register are not used, so each FSR pair holds a 12-bit value. This represents a value that can address the entire range of the data memory in a linear fashion. The FSR register pairs, then, serve as pointers to data memory locations.

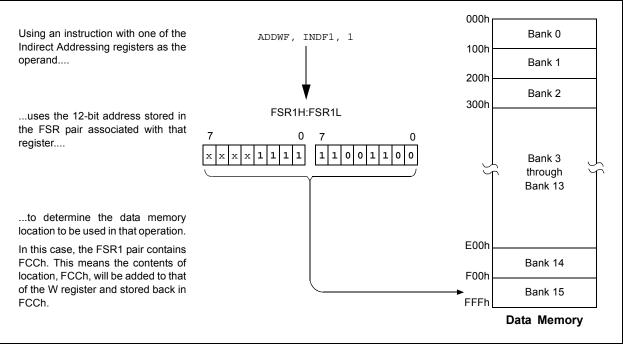
Indirect Addressing is accomplished with a set of Indirect File Operands, INDF0 through INDF2. These can be thought of as "virtual" registers. The operands

FIGURE 6-8: INDIRECT ADDRESSING

are mapped in the SFR space, but are not physically implemented. Reading or writing to a particular INDF register actually accesses its corresponding FSR register pair. A read from INDF1, for example, reads the data at the address indicated by FSR1H:FSR1L.

Instructions that use the INDF registers as operands actually use the contents of their corresponding FSR as a pointer to the instruction's target. The INDF operand is just a convenient way of using the pointer.

Because Indirect Addressing uses a full 12-bit address, data RAM banking is not necessary. Thus, the current contents of the BSR and the Access RAM bit have no effect on determining the target address.



查询PIC18F67K90供应商

6.4.3.2 FSR Registers and POSTINC, POSTDEC, PREINC and PLUSW

In addition to the INDF operand, each FSR register pair also has four additional indirect operands. Like INDF, these are "virtual" registers that cannot be indirectly read or written to. Accessing these registers actually accesses the associated FSR register pair, but also performs a specific action on its stored value.

These operands are:

- POSTDEC Accesses the FSR value, then automatically decrements it by '1' afterwards
- POSTINC Accesses the FSR value, then automatically increments it by '1' afterwards
- PREINC Increments the FSR value by '1', then uses it in the operation
- PLUSW Adds the signed value of the W register (range of -127 to 128) to that of the FSR and uses the new value in the operation

In this context, accessing an INDF register uses the value in the FSR registers without changing them. Similarly, accessing a PLUSW register gives the FSR value, offset by the value in the W register – with neither value actually changed in the operation. Accessing the other virtual registers changes the value of the FSR registers.

Operations on the FSRs with POSTDEC, POSTINC and PREINC affect the entire register pair. Rollovers of the FSRnL register, from FFh to 00h, carry over to the FSRnH register. On the other hand, results of these operations do not change the value of any flags in the STATUS register (for example, Z, N and OV bits).

The PLUSW register can be used to implement a form of Indexed Addressing in the data memory space. By manipulating the value in the W register, users can reach addresses that are fixed offsets from pointer addresses. In some applications, this can be used to implement some powerful program control structure, such as software stacks, inside of data memory.

6.4.3.3 Operations by FSRs on FSRs

Indirect Addressing operations that target other FSRs or virtual registers represent special cases. For example, using an FSR to point to one of the virtual registers will not result in successful operations.

As a specific case, assume that the FSR0H:FSR0L registers contain FE7h, the address of INDF1. Attempts to read the value of the INDF1, using INDF0 as an operand, will return 00h. Attempts to write to INDF1, using INDF0 as the operand, will result in a NOP.

On the other hand, using the virtual registers to write to an FSR pair may not occur as planned. In these cases, the value will be written to the FSR pair, but without any incrementing or decrementing. Thus, writing to INDF2 or POSTDEC2 will write the same value to the FSR2H:FSR2L.

Since the FSRs are physical registers mapped in the SFR space, they can be manipulated through all direct operations. Users should proceed cautiously when working on these registers, however, particularly if their code uses Indirect Addressing.

Similarly, operations by Indirect Addressing are generally permitted on all other SFRs. Users should exercise the appropriate caution, so that they do not inadvertently change settings that might affect the operation of the device.

6.5 Program Memory and the Extended Instruction Set

The operation of program memory is unaffected by the use of the extended instruction set.

Enabling the extended instruction set adds five additional two-word commands to the existing PIC18 instruction set: ADDFSR, CALLW, MOVSF, MOVSS and SUBFSR. These instructions are executed as described in Section 6.2.4 "Two-Word Instructions".

6.6 Data Memory and the Extended Instruction Set

Enabling the PIC18 extended instruction set (XINST Configuration bit = 1) significantly changes certain aspects of data memory and its addressing. Using the Access Bank for many of the core PIC18 instructions introduces a new addressing mode for the data memory space. This mode also alters the behavior of Indirect Addressing using FSR2 and its associated operands.

What does not change is just as important. The size of the data memory space is unchanged, as well as its linear addressing. The SFR map remains the same. Core PIC18 instructions can still operate in both Direct and Indirect Addressing mode. Inherent and literal instructions do not change at all. Indirect Addressing with FSR0 and FSR1 also remains unchanged.

6.6.1 INDEXED ADDRESSING WITH LITERAL OFFSET

Enabling the PIC18 extended instruction set changes the behavior of Indirect Addressing using the FSR2 register pair and its associated file operands. Under the proper conditions, instructions that use the Access Bank – that is, most bit-oriented and byte-oriented instructions – can invoke a form of Indexed Addressing using an offset specified in the instruction. This special addressing mode is known as Indexed Addressing with Literal Offset or the Indexed Literal Offset mode.

When using the extended instruction set, this addressing mode requires the following:

- Use of the Access Bank ('a' = 0)
- A file address argument that is less than or equal to 5Fh

Under these conditions, the file address of the instruction is not interpreted as the lower byte of an address (used with the BSR in Direct Addressing) or as an 8-bit address in the Access Bank. Instead, the value is interpreted as an offset value to an Address Pointer specified by FSR2. The offset and the contents of FSR2 are added to obtain the target address of the operation.

6.6.2 INSTRUCTIONS AFFECTED BY INDEXED LITERAL OFFSET MODE

Any of the core PIC18 instructions that can use Direct Addressing are potentially affected by the Indexed Literal Offset Addressing mode. This includes all byte-oriented and bit-oriented instructions, or almost one-half of the standard PIC18 instruction set. Instructions that only use Inherent or Literal Addressing modes are unaffected.

Additionally, byte-oriented and bit-oriented instructions are not affected, if they do not use the Access Bank (Access RAM bit = 1) or include a file address of 60h or above. Instructions meeting these criteria will continue to execute as before. A comparison of the different possible addressing modes when the extended instruction set is enabled is shown in Figure 6-9.

Those who desire to use byte-oriented or bit-oriented instructions in the Indexed Literal Offset mode should note the changes to assembler syntax for this mode. This is described in more detail in **Section 29.2.1** "Extended Instruction Syntax".

查询PIC18F67K90供应商

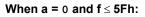
FIGURE 6-9: COMPARING ADDRESSING OPTIONS FOR BIT-ORIENTED AND BYTE-ORIENTED INSTRUCTIONS (EXTENDED INSTRUCTION SET ENABLED)

EXAMPLE INSTRUCTION: ADDWF, f, d, a (Opcode: 0010 01da ffff ffff)

When a = 0 and $f \ge 60h$:

The instruction executes in Direct Forced mode. 'f' is interpreted as a location in the Access RAM between 060h and FFFh. This is the same as locations, F60h to FFFh (Bank 15), of data memory.

Locations below 060h are not available in this addressing mode.

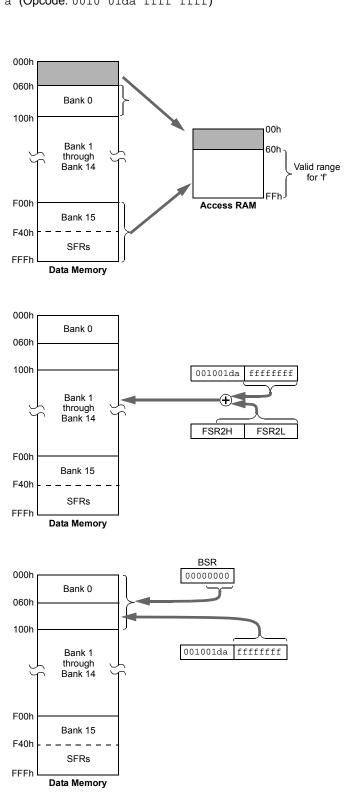


The instruction executes in Indexed Literal Offset mode. 'f' is interpreted as an offset to the address value in FSR2. The two are added together to obtain the address of the target register for the instruction. The address can be anywhere in the data memory space.

Note that in this mode, the correct syntax is now: ADDWF [k], d where 'k' is the same as 'f'.

When a = 1 (all values of f):

The instruction executes in Direct mode (also known as Direct Long mode). 'f' is interpreted as a location in one of the 16 banks of the data memory space. The bank is designated by the Bank Select Register (BSR). The address can be in any implemented bank in the data memory space.



查询PIC18F67K90供应商

6.6.3 MAPPING THE ACCESS BANK IN INDEXED LITERAL OFFSET MODE

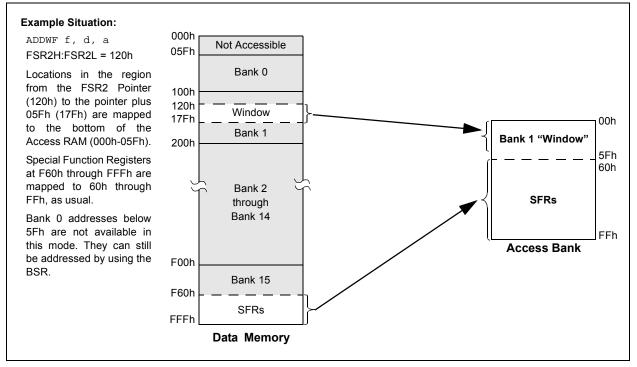
The use of Indexed Literal Offset Addressing mode effectively changes how the lower part of Access RAM (00h to 5Fh) is mapped. Rather than containing just the contents of the bottom part of Bank 0, this mode maps the contents from Bank 0 and a user-defined "window" that can be located anywhere in the data memory space.

The value of FSR2 establishes the lower boundary of the addresses mapped into the window, while the upper boundary is defined by FSR2 plus 95 (5Fh). Addresses in the Access RAM above 5Fh are mapped as previously described. (See **Section 6.3.2 "Access Bank"**.) An example of Access Bank remapping in this addressing mode is shown in Figure 6-10. Remapping the Access Bank applies *only* to operations using the Indexed Literal Offset mode. Operations that use the BSR (Access RAM bit = 1) will continue to use Direct Addressing as before. Any Indirect or Indexed Addressing operation that explicitly uses any of the indirect file operands (including FSR2) will continue to operate as standard Indirect Addressing. Any instruction that uses the Access Bank, but includes a register address of greater than 05Fh, will use Direct Addressing and the normal Access Bank map.

6.6.4 BSR IN INDEXED LITERAL OFFSET MODE

Although the Access Bank is remapped when the extended instruction set is enabled, the operation of the BSR remains unchanged. Direct Addressing, using the BSR to select the data memory bank, operates in the same manner as previously described.

FIGURE 6-10: REMAPPING THE ACCESS BANK WITH INDEXED LITERAL OFFSET ADDRESSING



查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商 7.0 FLASH PROGRAM MEMORY

The Flash program memory is readable, writable and erasable during normal operation over the entire VDD range.

A read from program memory is executed on one byte at a time. For execution of a write to or erasure of program memory:

- Memory of 32 Kbytes and 64 Kbytes (PIC18FX5K90 and PIC18FX6K90 devices) – Blocks of 64 bytes
- Memory of 128 Kbytes (PIC18FX7K90 devices) Blocks of 128 bytes

Writing or erasing program memory will cease instruction fetches until the operation is complete. The program memory cannot be accessed during the write or erase, therefore, code cannot execute. An internal programming timer terminates program memory writes and erases.

A value written to program memory does not need to be a valid instruction. Executing a program memory location that forms an invalid instruction results in a NOP.

7.1 Table Reads and Table Writes

In order to read and write program memory, there are two operations that allow the processor to move bytes between the program memory space and the data RAM:

- Table Read (TBLRD)
- Table Write (TBLWT)

The program memory space is 16 bits wide, while the data RAM space is 8 bits wide. Table reads and table writes move data between these two memory spaces through an 8-bit register (TABLAT).

Table read operations retrieve data from program memory and place it into the data RAM space. Figure 7-1 shows the operation of a table read with program memory and data RAM.

Table write operations store data from the data memory space into holding registers in program memory. The procedure to write the contents of the holding registers into program memory is detailed in **Section 7.5** "**Writing to Flash Program Memory**". Figure 7-2 shows the operation of a table write with program memory and data RAM.

Table operations work with byte entities. A table block containing data, rather than program instructions, is not required to be word-aligned. Therefore, a table block can start and end at any byte address. If a table write is being used to write executable code into program memory, program instructions will need to be word-aligned.

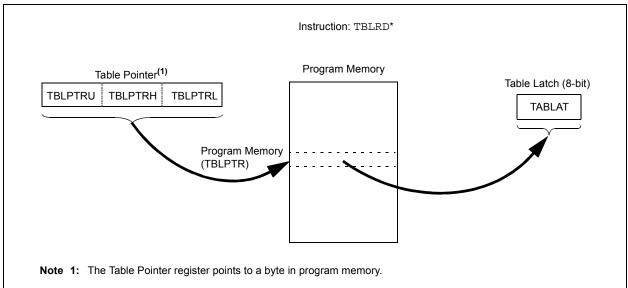
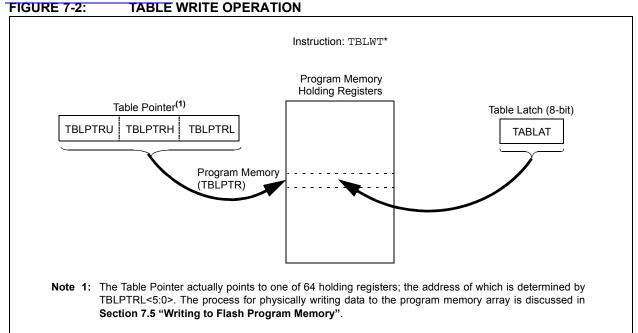


FIGURE 7-1: TABLE READ OPERATION

查询PIC18F67K90供应商



7.2 Control Registers

Several control registers are used in conjunction with the ${\tt TBLRD}$ and ${\tt TBLWT}$ instructions. These include the:

- EECON1 register
- EECON2 register
- TABLAT register
- TBLPTR registers

7.2.1 EECON1 AND EECON2 REGISTERS

The EECON1 register (Register 7-1) is the control register for memory accesses. The EECON2 register, not a physical register, is used exclusively in the memory write and erase sequences. Reading EECON2 will read all '0's.

The EEPGD control bit determines if the access is a program or data EEPROM memory access. When clear, any subsequent operations operate on the data EEPROM memory. When set, any subsequent operations operate on the program memory.

The CFGS control bit determines if the access is to the Configuration/Calibration registers or to program memory/data EEPROM memory. When set, subsequent operations operate on Configuration registers regardless of EEPGD (see **Section 28.0 "Special Features of the CPU"**). When clear, memory selection access is determined by EEPGD. The FREE bit, when set, allows a program memory erase operation. When FREE is set, the erase operation is initiated on the next WR command. When FREE is clear, only writes are enabled.

The WREN bit, when set, allows a write operation. On power-up, the WREN bit is clear. The WRERR bit is set in hardware when the WR bit is set and cleared when the internal programming timer expires and the write operation is complete.

Note:	During normal operation, the WRERR is
	read as '1'. This can indicate that a write
	operation was prematurely terminated by
	a Reset, or a write operation was
	attempted improperly.

The WR control bit initiates write operations. The bit cannot be cleared, only set, in software. It is cleared in hardware at the completion of the write operation.

Note: The EEIF interrupt flag bit (PIR6<4>) is set when the write is complete. It must be cleared in software.

查询PIC18F67K90供应商 REGISTER 7-1: EECON1: EEPROM CONTROL REGISTER 1

R/W-x	R/W-x	U-0	R/W-0	R/W-x	R/W-0	R/S-0	R/S-0
EEPGD	CFGS	—	FREE	WRERR ⁽¹⁾	WREN	WR	RD
bit 7							bit 0

Legend:	S = Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	1 as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	EEPGD: Flash Program or Data EEPROM Memory Select bit
	1 = Access Flash program memory
	0 = Access data EEPROM memory
bit 6	CFGS: Flash Program/Data EEPROM or Configuration Select bit
	1 = Access Configuration registers
	0 = Access Flash program or data EEPROM memory
bit 5	Unimplemented: Read as '0'
bit 4	FREE: Flash Block Erase Enable bit
	1 = Erase the program memory row addressed by TBLPTR on the next WR command
	(cleared by completion of erase operation)
	0 = Perform write-only
bit 3	WRERR: Flash Program/Data EEPROM Error Flag bit ⁽¹⁾
	1 = A write operation is prematurely terminated (any Reset during self-timed programming in normal
	operation or an improper write attempt) 0 = The write operation completed
	· ·
bit 2	WREN: Flash Program/Data EEPROM Write Enable bit
	1 = Allows write cycles to Flash program/data EEPROM
	0 = Inhibits write cycles to Flash program/data EEPROM
bit 1	WR: Write-Control bit
	 1 = Initiates a data EEPROM erase/write cycle, or a program memory erase cycle or write cycle. (The operation is self-timed and the bit is cleared by hardware once write is complete.
	The WR bit can only be set (not cleared) in software.)
	0 = Write cycle to the EEPROM is complete
bit 0	RD: Read Control bit
	1 = Initiates an EEPROM read (Read takes one cycle. RD is cleared in hardware. The RD bit can only
	be set (not cleared) in software. RD bit cannot be set when EEPGD = 1 or CFGS = 1.)
	0 = Does not initiate an EEPROM read

Note 1: When a WRERR occurs, the EEPGD and CFGS bits are not cleared. This allows tracing of the error condition.

查询PIC18F67K90供应商

7.2.2 IABLAT – IABLE LATCH REGISTER

The Table Latch (TABLAT) is an 8-bit register mapped into the SFR space. The Table Latch register is used to hold 8-bit data during data transfers between program memory and data RAM.

7.2.3 TBLPTR – TABLE POINTER REGISTER

The Table Pointer (TBLPTR) register addresses a byte within the program memory. The TBLPTR is comprised of three SFR registers: Table Pointer Upper Byte, Table Pointer High Byte and Table Pointer Low Byte (TBLPTRU:TBLPTRH:TBLPTRL). These three registers join to form a 22-bit wide pointer. The low-order 21 bits allow the device to address up to 2 Mbytes of program memory space. The 22nd bit allows access to the Device ID, the User ID and the Configuration bits.

The Table Pointer register, TBLPTR, is used by the TBLRD and TBLWT instructions. These instructions can update the TBLPTR in one of four ways, based on the table operation. These operations are shown in Table 7-1 and only affect the low-order 21 bits.

7.2.4 TABLE POINTER BOUNDARIES

TBLPTR is used in reads, writes and erases of the Flash program memory.

When a TBLRD is executed, all 22 bits of the TBLPTR determine which byte is read from program memory into TABLAT.

When a TBLWT is executed, the six LSbs of the Table Pointer register (TBLPTR<5:0>) determine which of the 64 program memory holding registers is written to. When the timed write to program memory begins (via the WR bit), the 16 MSbs of the TBLPTR (TBLPTR<21:6>) determine which program memory block of 64 bytes is written to. For more detail, see **Section 7.5 "Writing to Flash Program Memory"**.

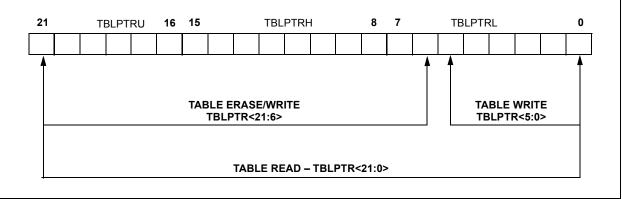
When an erase of program memory is executed, the 16 MSbs of the Table Pointer register (TBLPTR<21:6>) point to the 64-byte block that will be erased. The Least Significant bits (TBLPTR<5:0>) are ignored.

Figure 7-3 describes the relevant boundaries of TBLPTR based on Flash program memory operations.

TABLE 7-1: TABLE POINTER OPERATIONS WITH TBLRD AND TBLWT INSTRUCTIONS

Example	Operation on Table Pointer
TBLRD* TBLWT*	TBLPTR is not modified
TBLRD*+ TBLWT*+	TBLPTR is incremented after the read/write
TBLRD*- TBLWT*-	TBLPTR is decremented after the read/write
TBLRD+* TBLWT+*	TBLPTR is incremented before the read/write

FIGURE 7-3: TABLE POINTER BOUNDARIES BASED ON OPERATION



查询PIC18F67K90供应商

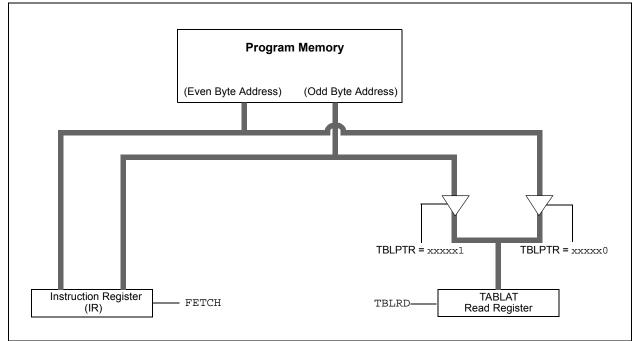
7.3 Reading the Flash Program Memory

The TBLRD instruction is used to retrieve data from program memory and places it into data RAM. Table reads from program memory are performed one byte at a time.

TBLPTR points to a byte address in program space. Executing TBLRD places the byte pointed to into TABLAT. In addition, TBLPTR can be modified automatically for the next table read operation.

The internal program memory is typically organized by words. The Least Significant bit of the address selects between the high and low bytes of the word. Figure 7-4 shows the interface between the internal program memory and the TABLAT.

FIGURE 7-4: READS FROM FLASH PROGRAM MEMORY



EXAMPLE 7-1: READING A FLASH PROGRAM MEMORY WORD

	MOVLW MOVWF MOVLW	CODE_ADDR_UPPER TBLPTRU CODE_ADDR_HIGH	; Load TBLPTR with the base ; address of the word
	MOVWF	TBLPTRH	
	MOVLW	CODE_ADDR_LOW	
	MOVWF	TBLPTRL	
READ_WORD			
	TBLRD*-	÷	; read into TABLAT and increment
	MOVF	TABLAT, W	; get data
	MOVWF	WORD_EVEN	
	TBLRD*-	÷	; read into TABLAT and increment
	MOVF	TABLAT, W	; get data
	MOVF	WORD_ODD	

查询PIC18F67K90供应商

7.4 Erasing Flash Program Memory

The erase block is 32 words or 64 bytes for the PIC18FX5K90 and PIC18FX6K90 devices, and 64 words or 128 bytes for the PIC18FX7K90 devices. Word erase in the Flash array is not supported.

When initiating an erase sequence from the microcontroller itself, a block of 64 or 128 bytes of program memory is erased. The Most Significant 16 bits of the TBLPTR<21:6> point to the block being erased. The TBLPTR<5:0> bits are ignored.

The EECON1 register commands the erase operation. The EEPGD bit must be set to point to the Flash program memory. The WREN bit must be set to enable write operations. The FREE bit is set to select an erase operation.

For protection, the write initiate sequence for EECON2 must be used.

A long write is necessary for erasing the internal Flash. Instruction execution is halted while in a long write cycle. The long write will be terminated by the internal programming timer.

7.4.1 FLASH PROGRAM MEMORY ERASE SEQUENCE

The sequence of events for erasing a block of internal program memory location is:

- 1. Load the Table Pointer register with the address of row to be erased.
- 2. Set the EECON1 register for the erase operation:
 - · Set the EEPGD bit to point to program memory
 - Clear the CFGS bit to access program memory
 - · Set the WREN bit to enable writes
 - Set the FREE bit to enable the erase
- 3. Disable the interrupts.
- 4. Write 0x55 to EECON2.
- 5. Write 0xAA to EECON2.
- Set the WR bit. This begins the row erase cycle. The CPU will stall for the duration of the erase for TIW. (See parameter D133A.)
- 7. Re-enable interrupts.

VLW CODE_ADI	DR_UPPER ;	load TBLPTR with the base	
VWF TBLPTRU	- ;	address of the memory block	
VLW CODE_ADI	DR_HIGH		
VWF TBLPTRH			
VLW CODE_ADI	DR_LOW		
VWF TBLPTRL			
F EECON1,	EEPGD ;	point to Flash program memory	
F EECON1,	CFGS	access Flash program memory	
F EECON1,	WREN	enable write to memory	
F EECON1,	FREE ;	enable Row Erase operation	
F INTCON,	GIE ;	disable interrupts	
VLW 0x55			
VWF EECON2	;	write 55h	
VLW 0xAA			
VWF EECON2	;	write OAAh	
F EECON1,	WR a	start erase (CPU stall)	
F INTCON,	GIE	re-enable interrupts	
	TBLPTRU TBLPTRU TUW CODE_ADI TWF TBLPTRH TWF TBLPTRL TWF TBLPTRL T EECON1, F EECON1, F EECON1, F EECON1, T INTCON, JLW 0x55 JLW 0xAA JWF EECON2 JLW 0xAA JWF EECON2, F EECON1,	WF TBLPTRU ; VLW CODE_ADDR_HIGH ; TWF TBLPTRH ; VLW CODE_ADDR_LOW ; TBLPTRL ; F EECON1, EEPGD ; F EECON1, CFGS ; F EECON1, WREN ; F EECON1, FREE ; F EECON1, FREE ; F EECON2 ; /LW 0x55 ; /LW 0xAA ; /WF EECON2 ; /F EECON1, WR ;	WFF TBLPTRU ; address of the memory block /LW CODE_ADDR_HIGH ; /WF TBLPTRH ; /LW CODE_ADDR_LOW ; /WF TBLPTRL ; ? EECON1, EEPGD ; ? EECON1, CFGS ; access Flash program memory ? EECON1, CFGS ; access Flash program memory ? EECON1, WREN ; enable write to memory ? EECON1, FREE ; enable Row Erase operation ? INTCON, GIE ; disable interrupts /LW 0x55 ; /LW 0xAA ; /WF EECON2 ; write 55h /LW 0xAA ; /WF EECON2 ; write 0AAh F EECON1, WR ; start erase (CPU stall)

EXAMPLE 7-2: ERASING A FLASH PROGRAM MEMORY ROW

查询PIC18F67K90供应商

7.5 Writing to Flash Program Memory

The programming block is 32 words or 64 bytes for PIC18FX5K90 and PIC18FX6K90 devices, and 64 words or 128 bytes for PIC18FX7K90 devices. Word or byte programming is not supported.

Table writes are used internally to load the holding registers needed to program the Flash memory. There are 64 holding registers for PIC18FX5K90 and PIC18FX6K90 devices and 128 holding registers for PIC18FX7K90 used by the table writes for programming.

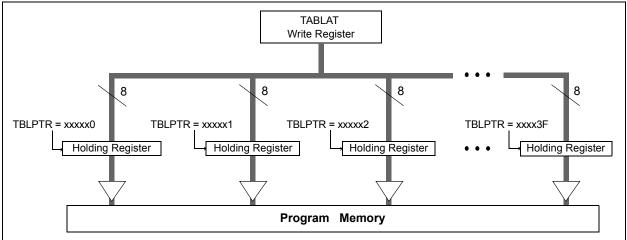
Since the Table Latch (TABLAT) is only a single byte, the TBLWT instruction may need to be executed 64 times for each programming operation. All of the table write operations will essentially be short writes because only the holding registers are written. At the end of updating the 64 or 128 holding registers, the EECON1 register must be written to in order to start the programming operation with a long write.

The long write is necessary for programming the internal Flash. Instruction execution is halted while in a long write cycle. The long write is terminated by the internal programming timer.

The EEPROM on-chip timer controls the write time. The write/erase voltages are generated by an on-chip charge pump, rated to operate over the voltage range of the device.

Note: The default value of the holding registers on device Resets and after write operations is FFh. A write of FFh to a holding register does not modify that byte. This means that individual bytes of program memory may be modified, provided that the change does not attempt to change any bit from a '0' to a '1'. When modifying individual bytes, it is not necessary to load all 64 or 128 holding registers before executing a write operation.





7.5.1 FLASH PROGRAM MEMORY WRITE SEQUENCE

The sequence of events for programming an internal program memory location should be:

- 1. Read the 64 or 128 bytes into RAM.
- 2. Update the data values in RAM as necessary.
- 3. Load the Table Pointer register with the address being erased.
- 4. Execute the row erase procedure.
- 5. Load the Table Pointer register with the address of the first byte being written.
- 6. Write the 64 or 128 bytes into the holding registers with auto-increment.
- 7. Set the EECON1 register for the write operation:
 - Set the EEPGD bit to point to program memory
 - Clear the CFGS bit to access program memory
 - Set WREN to enable byte writes
- 8. Disable the interrupts.
- 9. Write 0x55 to EECON2.

- 10. Write 0xAA to EECON2.
- 11. Set the WR bit. This will begin the write cycle. The CPU will stall for duration of the write for Tiw (see parameter D133A).
- 12. Re-enable the interrupts.
- 13. Verify the memory (table read).

An example of the required code is shown in Example 7-3 on the following page.

- **Note:** Before setting the WR bit, the Table Pointer address needs to be within the intended address range of the 64 or 128 bytes in the holding register.
- **Note:** Self-write execution to Flash and EEPROM memory cannot be done while running in LP Oscillator mode (Low-Power mode). Therefore, executing a self-write will put the device into High-Power mode.

查询PIC18F67K90供应商 EXAMPLE 7-3: WRITING TO FLASH PROGRAM MEMORY

EXAIVIPLE /-3:	VV NI	TING TO FLASH PROU	ЭЛ		
	MOVLW	SIZE_OF_BLOCK	;	number of bytes in erase block	
	MOVWF	COUNTER			
	MOVLW	BUFFER_ADDR_HIGH	;	point to buffer	
	MOVWF	FSR0H			
	MOVLW	BUFFER_ADDR_LOW			
	MOVWF	FSROL			
	MOVLW	CODE_ADDR_UPPER	;	Load TBLPTR with the base	
	MOVWF	TBLPTRU	;	address of the memory block	
	MOVLW	CODE_ADDR_HIGH			
	MOVWF	TBLPTRH			
	MOVLW	CODE_ADDR_LOW			
	MOVWF	TBLPTRL			
READ_BLOCK					
	TBLRD*+	-	;	read into TABLAT, and inc	
	MOVF	TABLAT, W	;	get data	
	MOVWF	POSTINC0	;	store data	
	DECFSZ	COUNTER	;	done?	
	BRA	READ_BLOCK	;	repeat	
MODIFY_WORD					
	MOVLW	DATA_ADDR_HIGH	;	point to buffer	
	MOVWF	FSROH			
	MOVLW	DATA_ADDR_LOW			
	MOVWF	FSROL			
	MOVLW	NEW_DATA_LOW	;	update buffer word	
	MOVWF	POSTINC0			
	MOVLW	NEW_DATA_HIGH			
	MOVWF	INDF0			
ERASE_BLOCK					
	MOVLW	CODE_ADDR_UPPER	;	load TBLPTR with the base	
	MOVWF	TBLPTRU	;	address of the memory block	
	MOVLW	CODE_ADDR_HIGH			
	MOVWF	TBLPTRH			
	MOVLW	CODE_ADDR_LOW			
	MOVWF	TBLPTRL			
	BSF	EECON1, EEPGD	;	point to Flash program memory	
	BCF	EECON1, CFGS	;	access Flash program memory	
	BSF	EECON1, WREN	;	enable write to memory	
	BSF	EECON1, FREE		enable Row Erase operation	
	BCF	INTCON, GIE	;	disable interrupts	
	MOVLW	0x55			
Required	MOVWF	EECON2	;	write 55h	
Sequence	MOVLW	OxAA			
	MOVWF	EECON2		write OAAh	
	BSF	EECON1, WR		start erase (CPU stall)	
	BSF	INTCON, GIE		re-enable interrupts	
	TBLRD*-			dummy read decrement	
	MOVLW	BUFFER_ADDR_HIGH	;	point to buffer	
	MOVWF	FSROH			
	MOVLW	BUFFER_ADDR_LOW			
	MOVWF	FSROL			
WRITE_BUFFER_E					
	MOVLW	SIZE_OF_BLOCK	;	number of bytes in holding register	
	MOVWF	COUNTER			
WRITE_BYTE_TO_	HREGS				
	MOVFF	POSTINC0, WREG		get low byte of buffer data	
	MOVWF	TABLAT		present data to table latch	
	TBLWT+*	•		write data, perform a short write	
				to internal TBLWT holding register.	
		COUNTER	;	loop until buffers are full	
	GOTO	WRITE_BYTE_TO_HREGS			

查询PIC18F67K90供应商 EXAMPLE 7-3: WRITING TO FLASH PROGRAM MEMORY (CONTINUED)

PROGRAM_MEMORY	Y			
	BSF	EECON1, E	EPGD	; point to Flash program memory
	BCF	EECON1, C	CFGS	; access Flash program memory
	BSF	EECON1, W	IREN	; enable write to memory
	BCF	INTCON, G	SIE	; disable interrupts
	MOVLW	0x55		
Required	MOVWF	EECON2		; write 55h
Sequence	MOVLW	0xAA		
	MOVWF	EECON2		; write OAAh
	BSF	EECON1, W	<i>I</i> R	; start program (CPU stall)
	BSF	INTCON, G	SIE	; re-enable interrupts
	BCF	EECON1, W	IREN	; disable write to memory

7.5.2 WRITE VERIFY

Depending on the application, good programming practice may dictate that the value written to the memory should be verified against the original value. This should be used in applications where excessive writes can stress bits near the specification limit.

7.5.3 UNEXPECTED TERMINATION OF WRITE OPERATION

If a write is terminated by an unplanned event, such as loss of power or an unexpected Reset, the memory location just programmed should be verified and reprogrammed if needed. If the write operation is interrupted by a MCLR Reset or a WDT Time-out Reset during normal operation, the user can check the WRERR bit and rewrite the location(s) as needed.

7.5.4 PROTECTION AGAINST SPURIOUS WRITES

To protect against spurious writes to Flash program memory, the write initiate sequence must also be followed. See Section 28.0 "Special Features of the CPU" for more detail.

7.6 Flash Program Operation During Code Protection

See Section 28.6 "Program Verification and Code Protection" for details on code protection of Flash program memory.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
TBLPTRU	—	—	bit 21 ⁽¹⁾	Program Me	emory Table I	Pointer Uppe	r Byte (TBLP	TR<20:16>)	73
TBPLTRH	Program Me	emory Table	Pointer H	ligh Byte (TE	BLPTR<15:8	>)			73
TBLPTRL	Program Me	emory Table	Pointer L	ow Byte (TB	LPTR<7:0>)			73
TABLAT	Program Me	Program Memory Table Latch						73	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
EECON2	EEPROM C	EEPROM Control Register 2 (not a physical register)					77		
EECON1	EEPGD	CFGS	_	FREE	WRERR	WREN	WR	RD	77
IPR6	—	—	_	EEIP	_	CMP3IP	CMP2IP	CMP1IP	75
PIR6	—	—	—	EEIF	_	CMP3IF	CMP2IF	CMP1IF	75
PIE6		_	_	EEIE	_	CMP3IE	CMP2IE	CMP1IE	78

TABLE 7-2: REGISTERS ASSOCIATED WITH PROGRAM FLASH MEMORY

Legend: — = unimplemented, read as '0'. Shaded cells are not used during Flash/EEPROM access.

Note 1: Bit 21 of TBLPTRU allows access to the device Configuration bits.

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商 8.0 DATA EEPROM MEMORY

The data EEPROM is a nonvolatile memory array, separate from the data RAM and program memory, that is used for long-term storage of program data. The PIC18F87K90 family of devices has a 1024-byte data EEPROM. It is not directly mapped in either the register file or program memory space, but is indirectly addressed through the Special Function Registers (SFRs). The EEPROM is readable and writable during normal operation over the entire VDD range.

Five SFRs are used to read and write to the data EEPROM, as well as the program memory. They are:

- EECON1
- EECON2
- EEDATA
- EEADR
- EEADRH

The data EEPROM allows byte read and write. When interfacing to the data memory block, EEDATA holds the 8-bit data for read/write and the EEADRH:EEADR register pair holds the address of the EEPROM location being accessed.

The EEPROM data memory is rated for high erase/write cycle endurance. A byte write automatically erases the location and writes the new data (erase-before-write). The write time is controlled by an on-chip timer; it will vary with voltage and temperature, as well as from chip-to-chip. Please refer to parameter D122 (Table 31-1 in **Section 31.0 "Electrical Characteristics"**) for exact limits.

8.1 EEADR and EEADRH Registers

The EEADRH:EEADR register pair is used to address the data EEPROM for read and write operations. EEADRH holds the two MSbs of the address; the upper 6 bits are ignored. The 10-bit range of the pair can address a memory range of 1024 bytes (00h to 3FFh).

8.2 EECON1 and EECON2 Registers

Access to the data EEPROM is controlled by two registers: EECON1 and EECON2. These are the same registers which control access to the program memory and are used in a similar manner for the data EEPROM.

The EECON1 register (Register 8-1) is the control register for data and program memory access. Control bit, EEPGD, determines if the access will be to program memory or data EEPROM memory. When clear, operations will access the data EEPROM memory. When set, program memory is accessed.

Control bit, CFGS, determines if the access will be to the Configuration registers or to program memory/data EEPROM memory. When set, subsequent operations access Configuration registers. When CFGS is clear, the EEPGD bit selects either program Flash or data EEPROM memory.

The WREN bit, when set, will allow a write operation. On power-up, the WREN bit is clear. The WRERR bit is set in hardware when the WREN bit is set, and cleared, when the internal programming timer expires and the write operation is complete.

Note:	During normal operation, the WRERR is
	read as '1'. This can indicate that a write
	operation was prematurely terminated by
	a Reset or a write operation was
	attempted improperly.

The WR control bit initiates write operations. The bit cannot be cleared, only set, in software; it is cleared in hardware at the completion of the write operation.

Note:	The EEIF interrupt flag bit (PIR6<4>) is set
	when the write is complete. It must be
	cleared in software.

Control bits, RD and WR, start read and erase/write operations, respectively. These bits are set by firmware and cleared by hardware at the completion of the operation.

The RD bit cannot be set when accessing program memory (EEPGD = 1). Program memory is read using table read instructions. See **Section 7.1 "Table Reads and Table Writes"** regarding table reads.

The EECON2 register is not a physical register. It is used exclusively in the memory write and erase sequences. Reading EECON2 will read all '0's.

查询PIC18F67K90供应商

REGISTER 8-1: EECON1: DATA EEPROM CONTROL REGISTER 1

R/W-x	R/W-x	U-0	R/W-0	R/W-x	R/W-0	R/S-0	R/S-0			
EEPGD	CFGS		FREE	WRERR ⁽¹⁾	WREN	WR	RD			
bit 7				· · · · ·			bit (
Legend:		S = Settable	bit							
R = Readable	e bit	W = Writable	bit	U = Unimplen	nented bit, rea	d as '0'				
-n = Value at	POR	'1' = Bit is set	t	'0' = Bit is clea	ared	x = Bit is unki	nown			
bit 7	EEPGD: Fla	ash Program or I	Data EEPROI	M Memory Sele	ct bit					
		Flash program r data EEPROM r								
bit 6	CFGS: Flas	h Program/Data	EEPROM or	Configuration S	Select bit					
		Configuration re		-						
	0 = Access	Flash program o	or data EEPR	OM memory						
bit 5	Unimpleme	ented: Read as '	0'							
bit 4	FREE: Flas	h Row Erase En	able bit							
	by com	he program mer pletion of an era	•	•	BLPTR on the	e next WR com	mand (cleare			
	0 = Perforn	,		(1)						
bit 3		R: Flash Program/Data EEPROM Error Flag bit ⁽¹⁾								
	operatio	peration is prematurely terminated (any Reset during self-timed programming in normal n or an improper write attempt)								
	0 = The write operation completed									
bit 2	WREN: Flas	sh Program/Data	a EEPROM W	/rite Enable bit						
		write cycles to F write cycles to F								
bit 1	WR: Write-0	Control bit								
1 = Initiates a data EEPROM erase/write cycle or a program memory erase operation is self-timed and the bit is cleared by hardware once the write can only be set (not cleared) in software.)										
		ycle to the EEPF	,	,						
bit 0	RD: Read C	Control bit								
		 1 = Initiates an EEPROM read (Read takes one cycle. RD is cleared in hardware. The RD bit can only be set (not cleared) in software. The RD bit cannot be set when EEPGD = 1 or CFGS = 1.) 								
	0 = Does not initiate an EEPROM read									

Note 1: When a WRERR occurs, the EEPGD and CFGS bits are not cleared. This allows tracing of the error condition.

查询PIC18F67K90供应商

8.3 Reading the Data EEPROM Memory

To read a data memory location, the user must write the address to the EEADRH:EEADR register pair, clear the EEPGD control bit (EECON1<7>) and then set control bit, RD (EECON1<0>). After one cycle, the data is available in the EEDATA register; therefore, it can be read after one NOP instruction. EEDATA will hold this value until another read operation, or until it is written to by the user (during a write operation). The basic process is shown in Example 8-1.

8.4 Writing to the Data EEPROM Memory

To write an EEPROM data location, the address must first be written to the EEADRH:EEADR register pair and the data written to the EEDATA register. The sequence in Example 8-2 must be followed to initiate the write cycle.

The write will not begin if this sequence is not exactly followed (write 0x55 to EECON2, write 0xAA to EECON2, then set WR bit) for each byte. It is strongly recommended that interrupts be disabled during this code segment.

Additionally, the WREN bit in EECON1 must be set to enable writes. This mechanism prevents accidental writes to data EEPROM due to unexpected code

EXAMPLE 8-1: DATA EEPROM READ

execution (i.e., runaway programs). The WREN bit should be kept clear at all times, except when updating the EEPROM. The WREN bit is not cleared by hardware.

After a write sequence has been initiated, EECON1, EEADRH:EEADR and EEDATA cannot be modified. The WR bit will be inhibited from being set unless the WREN bit is set. The WREN bit must be set on a previous instruction. Both WR and WREN cannot be set with the same instruction.

At the completion of the write cycle, the WR bit is cleared in hardware and the EEPROM Interrupt Flag bit (EEIF) is set. The user may either enable this interrupt, or poll this bit. EEIF must be cleared by software.

8.5 Write Verify

Depending on the application, good programming practice may dictate that the value written to the memory should be verified against the original value. This should be used in applications where excessive writes can stress bits near the specification limit.

Note:	Self-write	execution	to	Flash	and
	EEPROM	memory can	not t	be done	while
	running in	LP Oscillator	mod	e (Low-F	ower
	mode). Th	erefore, exe	cutin	g a self	-write
	will put the	device into H	-ligh	Power m	node.

MOVLW	DATA_EE_ADDRH	;
MOVWF	EEADRH	; Upper bits of Data Memory Address to read
MOVLW	DATA_EE_ADDR	;
MOVWF	EEADR	; Lower bits of Data Memory Address to read
BCF	EECON1, EEPGD	; Point to DATA memory
BCF	EECON1, CFGS	; Access EEPROM
BSF	EECON1, RD	; EEPROM Read
NOP MOVF	EEDATA, W	; W = EEDATA

EXAMPLE 8-2: DATA EEPROM WRITE

	MOVLW	DATA_EE_ADDRH		;
	MOVWF	EEADRH		; Upper bits of Data Memory Address to write
	MOVLW	DATA_EE_ADDR		i
	MOVWF	EEADR		; Lower bits of Data Memory Address to write
	MOVLW	DATA_EE_DATA		i
	MOVWF	EEDATA		; Data Memory Value to write
	BCF	EECON1, EEPGD		; Point to DATA memory
	BCF	EECON1, CFGS		; Access EEPROM
	BSF	EECON1, WREN		; Enable writes
	BCF	INTCON, GIE		; Disable Interrupts
	MOVLW	0x55	;	
Required	MOVWF	EECON2		; Write 55h
Sequence	MOVLW	0xAA		i
	MOVWF	EECON2		; Write OAAh
	BTFSC	EECON1, WR		; Wait for write to complete
	GOTO	\$-2		
	BSF	INTCON, GIE		; Enable Interrupts
				; User code execution
	BCF	EECON1, WREN		; Disable writes on write complete (EEIF set)

查询PIC18F67K90供应商

8.6 Operation During Code-Protect

Data EEPROM memory has its own code-protect bits in Configuration Words. External read and write operations are disabled if code protection is enabled.

The microcontroller itself can both read and write to the internal data EEPROM regardless of the state of the code-protect Configuration bit. Refer to **Section 28.0 "Special Features of the CPU"** for additional information.

8.7 Protection Against Spurious Write

There are conditions when the device may not want to write to the data EEPROM memory. To protect against spurious EEPROM writes, various mechanisms have been implemented. On power-up, the WREN bit is cleared. In addition, writes to the EEPROM are blocked during the Power-up Timer period (TPWRT, parameter 33).

The write initiate sequence, and the WREN bit together, help prevent an accidental write during brown-out, power glitch or software malfunction. The WREN bit is not cleared by hardware.

8.8 Using the Data EEPROM

The data EEPROM is a high-endurance, byte addressable array that has been optimized for the storage of frequently changing information (e.g., program variables or other data that are updated often). Frequently changing values will typically be updated more often than specification, D124. If this is not the case, an array refresh must be performed. For this reason, variables that change infrequently (such as constants, IDs, calibration, etc.) should be stored in Flash program memory.

A simple data EEPROM refresh routine is shown in Example 8-3.

Note: If data EEPROM is only used to store constants and/or data that changes often, an array refresh is likely not required. See specification, D124.

EXAMPLE 8-3:	DATA EEPROM REFRESH ROUTINE

	CLRF	EEADR	; Start at address 0
	CLRF	EEADRH	i
	BCF	EECON1, CFGS	; Set for memory
	BCF	EECON1, EEPGD	; Set for Data EEPROM
	BCF	INTCON, GIE	; Disable interrupts
	BSF	EECON1, WREN	; Enable writes
LOOP			; Loop to refresh array
	BSF	EECON1, RD	; Read current address
	MOVLW	0x55	;
	MOVWF	EECON2	; Write 55h
	MOVLW	0xAA	;
	MOVWF	EECON2	; Write OAAh
	BSF	EECON1, WR	; Set WR bit to begin write
	BTFSC	EECON1, WR	; Wait for write to complete
	BRA	\$-2	
	INCFSZ	EEADR, F	; Increment address
	BRA	LOOP	; Not zero, do it again
	INCFSZ	EEADRH, F	; Increment the high address
	BRA	LOOP	; Not zero, do it again
	BCF	EECON1, WREN	; Disable writes
	BSF	INTCON, GIE	; Enable interrupts

查询PIC18F67K90供应商

TABLE 8-1: REGISTERS ASSOCIATED WITH DATA EEPROM MEMORY

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
EEADRH	—		—	-	—	—	EEPROM Ac Register Hig	77	
EEADR	EEPROM /	EEPROM Address Register Low Byte							78
EEDATA	EEPROM Data Register						78		
EECON2	N2 EEPROM Control Register 2 (not a physical register)							77	
EECON1	EEPGD	CFGS	_	FREE	WRERR	WREN	WR	RD	77

Legend: — = unimplemented, read as '0'. Shaded cells are not used during Flash/EEPROM access.

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商 9.0 8 x 8 HARDWARE MULTIPLIER

9.1 Introduction

All PIC18 devices include an 8 x 8 hardware multiplier as part of the ALU. The multiplier performs an unsigned operation and yields a 16-bit result that is stored in the product register pair, PRODH:PRODL. The multiplier's operation does not affect any flags in the STATUS register.

Making multiplication a hardware operation allows it to be completed in a single instruction cycle. This has the advantages of higher computational throughput and reduced code size for multiplication algorithms and allows PIC18 devices to be used in many applications previously reserved for digital-signal processors. A comparison of various hardware and software multiply operations, along with the savings in memory and execution time, is shown in Table 9-1.

9.2 Operation

Example 9-1 shows the instruction sequence for an 8 x 8 unsigned multiplication. Only one instruction is required when one of the arguments is already loaded in the WREG register.

Example 9-2 shows the sequence to do an 8 x 8 signed multiplication. To account for the sign bits of the arguments, each argument's Most Significant bit (MSb) is tested and the appropriate subtractions are done.

EXAMPLE 9-1: 8 x 8 UNSIGNED MULTIPLY ROUTINE

MOVF	ARG1,	W	;	
MULWF	ARG2		;	ARG1 * ARG2 ->
			;	PRODH:PRODL

EXAMPLE 9-2: 8 x 8 SIGNED MULTIPLY ROUTINE

MOVF	ARG1, W		
MULWF	ARG2	; ARG1 * ARG2 ->	
		; PRODH:PRODL	
BTFSC	ARG2, SB	; Test Sign Bit	
SUBWF	PRODH, F	; PRODH = PRODH	
		; – ARG1	
MOVF	ARG2, W		
BTFSC	ARG1, SB	; Test Sign Bit	
SUBWF	PRODH, F	; PRODH = PRODH	
		; – ARG2	

D (1)		Program Moreover Cycles		Time				
Routine	Multiply Method	Memory (Words)	(Max)	@ 64 MHz	@ 48 MHz	@ 10 MHz	@ 4 MHz	
	Without hardware multiply	13	69	4.3 μs	5.7 μs	27.6 μs	69 μs	
8 x 8 unsigned	Hardware multiply	1	1	62.5 ns	83.3 ns	400 ns	1 μs	
9 v 9 signad	Without hardware multiply	33	91	5.6 μs	7.5 μs	36.4 μs	91 μs	
8 x 8 signed	Hardware multiply	6	6	375 ns	500 ns	2.4 μs	6 μs	
16 x 16	Without hardware multiply	21	242	15.1 μs	20.1 μs	96.8 μs	242 μs	
unsigned	Hardware multiply	28	28	1.7 μs	2.3 μs	11.2 μs	28 μs	
16 x 16 signed	Without hardware multiply	52	254	15.8 μs	21.2 μs	101.6 μs	254 μs	
16 x 16 signed	Hardware multiply	35	40	2.5 μs	3.3 μs	16.0 μs	40 μs	

TABLE 9-1: PERFORMANCE COMPARISON FOR VARIOUS MULTIPLY OPERATIONS

查询PIC18F67K90供应商

Example 9-3 shows the sequence to do a 16 x 16 unsigned multiplication. Equation 9-1 shows the algorithm that is used. The 32-bit result is stored in four registers (RES3:RES0).

EQUATION 9-1: 16 x 16 UNSIGNED MULTIPLICATION ALGORITHM

RES3:RES0	=	into into into into into into into into
	=	$(ARG1H \bullet ARG2H \bullet 2^{16}) +$
		$(ARG1H \bullet ARG2L \bullet 2^8) +$
		$(ARG1L \bullet ARG2H \bullet 2^8) +$
		$(ARG1L \bullet ARG2L)$

EXAMPLE 9-3: 1

16 x 16 UNSIGNED MULTIPLY ROUTINE

	MOVF	ARG1L, W	
	MULWF	ARG2L	; ARG1L * ARG2L->
			; PRODH:PRODL
	MOVFF	PRODH, RES1	;
	MOVFF	PRODL, RESO	;
;			
	MOVF	ARG1H, W	
	MULWF	ARG2H	; ARG1H * ARG2H->
			; PRODH:PRODL
	MOVFF	PRODH, RES3	;
	MOVFF	PRODL, RES2	;
;			
	MOVF	ARG1L, W	
	MULWF	ARG2H	; ARG1L * ARG2H->
			; PRODH:PRODL
		PRODL, W	;
			; Add cross
		PRODH, W	; products
		RES2, F	;
	CLRF		;
	ADDWFC	RES3, F	;
;			
		ARG1H, W	;
	MULWF		; ARG1H * ARG2L->
			; PRODH:PRODL
		PRODL, W	;
		RES1, F	
			; products
		RES2, F	;
	CLRF		;
	ADDWFC	RES3, F	;

Example 9-4 shows the sequence to do a 16 x 16 signed multiply. Equation 9-2 shows the algorithm used. The 32-bit result is stored in four registers (RES3:RES0). To account for the sign bits of the arguments, the MSb for each argument pair is tested and the appropriate subtractions are done.

EQUATION 9-2: 16 x 16 SIGNED MULTIPLICATION ALGORITHM

RES3:RES0=	ARG1H:ARG1L • ARG2H:ARG2L
=	$(ARG1H \bullet ARG2H \bullet 2^{16}) +$
	$(ARG1H \bullet ARG2L \bullet 2^8) +$
	$(ARG1L \bullet ARG2H \bullet 2^8) +$
	$(ARG1L \bullet ARG2L) +$
	$(-1 \bullet ARG2H < 7 > \bullet ARG1H:ARG1L \bullet 2^{16}) +$
	$(-1 \bullet ARG1H \le 7 \ge \bullet ARG2H: ARG2L \bullet 2^{16})$

EXAMPLE 9-4: 16 x 16 SIGNED MULTIPLY ROUTINE

	MOVF	ARG1L,	W		
	MULWF	ARG2L		;	ARG1L * ARG2L ->
				;	PRODH:PRODL
	MOVFF	PRODH,	RES1	;	
		PRODL,			
;					
	MOVF	ARG1H,	W		
	MULWF			;	ARG1H * ARG2H ->
					PRODH:PRODL
	MOVFF	PRODH	RESS		
		PRODL,			
;	110 11 1	I RODE,	1000	'	
	MOVF	ARG1L,	W		
	MULWF		**		ARG1L * ARG2H ->
	NOTWI	ANGZII			PRODH:PRODL
	MOVF		TAT	;	
		RES1, F			Add cross
		PRODH,			products
		PRODE,	vv ,	;	products
	ADDWFC CLRF	KESZ, F			
				;	
	ADDWFC	RES3, F		;	
;	NOTE	10011			
		ARG1H,	W	;	
	MULWF	ARG2L			ARG1H * ARG2L ->
					PRODH:PRODL
		PRODL,		;	
		RES1, F			Add cross
		PRODH,			products
	ADDWFC		, ,	;	
		WREG		;	
	ADDWFC	RES3, F	, ,	;	
;					
					ARG2H:ARG2L neg?
	BRA SIC			;	no, check ARG1
		ARG1L,	W	;	
	SUBWF	RES2		;	
	MOVF	ARG1H,	W	;	
	SUBWFB	RES3		;	
SIC	GN_ARG1				
	BTFSS	ARG1H,	7	;	ARG1H:ARG1L neg?
	BRA	CONT_CC	DE	;	no, done
		ARG2L,	W	;	
	SUBWF	RES2		;	
		ARG2H,	W	;	
	SUBWFB	RES3			
;					
COI	NT_CODE				
	:				

查询PIC18F67K90供应商 10.0 INTERRUPTS

Members of the PIC18F87K90 family of devices have multiple interrupt sources and an interrupt priority feature that allows most interrupt sources to be assigned a high-priority level or a low-priority level. The high-priority interrupt vector is at 0008h and the low-priority interrupt vector is at 0018h. High-priority interrupt events will interrupt any low-priority interrupts that may be in progress.

The registers for controlling interrupt operation are:

- RCON
- INTCON
- INTCON2
- INTCON3
- PIR1, PIR2, PIR3
- PIE1, PIE2, PIE3
- IPR1, IPR2, IPR3

It is recommended that the Microchip header files supplied with MPLAB[®] IDE be used for the symbolic bit names in these registers. This allows the assembler/compiler to automatically take care of the placement of these bits within the specified register.

In general, interrupt sources have three bits to control their operation. They are:

- Flag bit Indicating that an interrupt event occurred
- Enable bit Enabling program execution to branch to the interrupt vector address when the flag bit is set
- **Priority bit** Specifying high priority or low priority

The interrupt priority feature is enabled by setting the IPEN bit (RCON<7>). When interrupt priority is enabled, there are two bits that enable interrupts globally. Setting the GIEH bit (INTCON<7>) enables all interrupts that have the priority bit set (high priority). Setting the GIEL bit (INTCON<6>) enables all interrupts that have the priority bit cleared (low priority). When the interrupt flag, enable bit and appropriate global interrupt enable bit are set, the interrupt will vector immediately to address 0008h or 0018h, depending on the priority bit setting. Individual interrupts can be disabled through their corresponding enable bits.

When the IPEN bit is cleared (default state), the interrupt priority feature is disabled and interrupts are compatible with PIC[®] mid-range devices. In Compatibility mode, the interrupt priority bits for each source have no effect. INTCON<6> is the PEIE bit that enables/disables all peripheral interrupt sources. INTCON<7> is the GIE bit that enables/disables all interrupt sources. All interrupts branch to address 0008h in Compatibility mode.

When an interrupt is responded to, the global interrupt enable bit is cleared to disable further interrupts. If the IPEN bit is cleared, this is the GIE bit. If interrupt priority levels are used, this will be either the GIEH or GIEL bit. High-priority interrupt sources can interrupt a low-priority interrupt. Low-priority interrupts are not processed while high-priority interrupts are in progress.

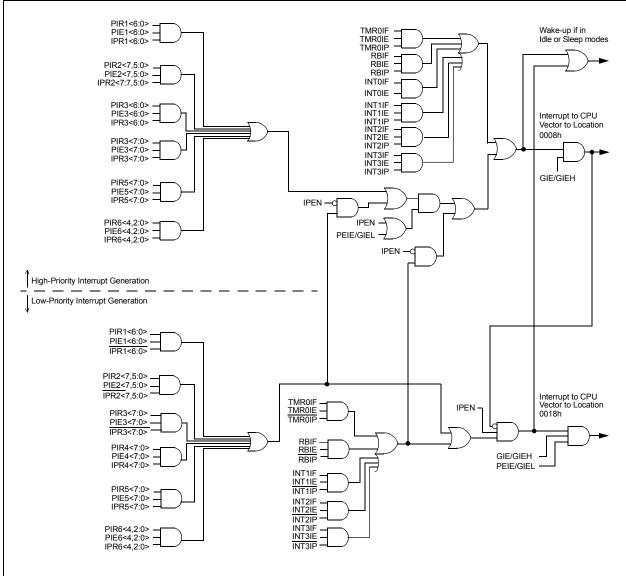
The return address is pushed onto the stack and the PC is loaded with the interrupt vector address (0008h or 0018h). Once in the Interrupt Service Routine, the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bits must be cleared in software before re-enabling interrupts to avoid recursive interrupts.

The "return from interrupt" instruction, RETFIE, exits the interrupt routine and sets the GIE bit (GIEH or GIEL if priority levels are used) that re-enables interrupts.

For external interrupt events, such as the INTx pins or the PORTB input change interrupt, the interrupt latency will be three to four instruction cycles. The exact latency is the same for one or two-cycle instructions. Individual interrupt flag bits are set regardless of the status of their corresponding enable bit or the GIE bit.

Note: Do not use the MOVFF instruction to modify any of the Interrupt Control registers while **any** interrupt is enabled. Doing so may cause erratic microcontroller behavior.

查询PIC18F67K90供应商 FIGURE 10-1: PIC18F87K90 FAMILY INTERRUPT LOGIC



查询PIC18F67K90供应商 10.1 INTCON Registers

The INTCON registers are readable and writable registers that contain various enable, priority and flag bits.

Note: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

REGISTER 10-1: INTCON: INTERRUPT CONTROL REGISTER

GIE/GIEH PEIE/GIEL TMR0IE INT0IE RBIE TMR0IF INT0IF RBIF ⁽¹⁾ bit 7 bit 0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x
bit 7 bit 0	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF ⁽¹⁾
	bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	GIE/GIEH: Global Interrupt Enable bit <u>When IPEN = 0:</u> 1 = Enables all unmasked interrupts 0 = Disables all interrupts <u>When IPEN = 1:</u> 1 = Enables all high-priority interrupts 0 = Disables all interrupts
bit 6	PEIE/GIEL: Peripheral Interrupt Enable bit
Sit U	When IPEN = 0:
	 1 = Enables all unmasked peripheral interrupts 0 = Disables all peripheral interrupts
	When IPEN = 1:
	 1 = Enables all low-priority peripheral interrupts 0 = Disables all low-priority peripheral interrupts
bit 5	TMR0IE: TMR0 Overflow Interrupt Enable bit
	1 = Enables the TMR0 overflow interrupt0 = Disables the TMR0 overflow interrupt
bit 4	INTOIE: INTO External Interrupt Enable bit
	 1 = Enables the INT0 external interrupt 0 = Disables the INT0 external interrupt
bit 3	RBIE: RB Port Change Interrupt Enable bit
	 1 = Enables the RB port change interrupt 0 = Disables the RB port change interrupt
bit 2	TMR0IF: TMR0 Overflow Interrupt Flag bit
	 1 = TMR0 register has overflowed (must be cleared in software) 0 = TMR0 register did not overflow
bit 1	INT0IF: INT0 External Interrupt Flag bit
	 1 = The INT0 external interrupt occurred (must be cleared in software) 0 = The INT0 external interrupt did not occur
bit 0	RBIF: RB Port Change Interrupt Flag bit ⁽¹⁾
	 1 = At least one of the RB<7:4> pins changed state (must be cleared in software) 0 = None of the RB<7:4> pins have changed state
Note 1:	A mismatch condition will continue to set this bit. Reading PORTB, and then waiting one additional instruction

Note 1: A mismatch condition will continue to set this bit. Reading PORTB, and then waiting one additional instruction cycle, will end the mismatch condition and allow the bit to be cleared.

查询PIC18F67K90供应商

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1		
RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP		
bit 7							bit C		
Legend:									
R = Readab	le bit	W = Writable	bit	U = Unimplem	nented bit, read	as '0'			
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown		
bit 7	1 = All PORT	B Pull-up Enal B pull-ups are	disabled	dual port latch v	alues				
bit 6	INTEDG0: Ex 1 = Interrupt	 0 = PORTB pull-ups are enabled by individual port latch values INTEDG0: External Interrupt 0 Edge Select bit 1 = Interrupt on rising edge 0 = Interrupt on falling edge 							
bit 5	1 = Interrupt	ternal Interrupt on rising edge on falling edge	0	t bit					
bit 4	1 = Interrupt	 0 = Interrupt on falling edge INTEDG2: External Interrupt 2 Edge Select bit 1 = Interrupt on rising edge 0 = Interrupt on falling edge 							
bit 3	1 = Interrupt	INTEDG3: External Interrupt 3 Edge Select bit 1 = Interrupt on rising edge 0 = Interrupt on falling edge							
bit 2	TMR0IP: TMF 1 = High prior	TMR0IP: TMR0 Overflow Interrupt Priority bit 1 = High priority 0 = Low priority							
bit 1	INT3IP: INT3 1 = High prior 0 = Low prior	•	upt Priority bit						

- bit 0 RBIP: RB Port Change Interrupt Priority bit 1 = High priority
 - 0 = Low priority

Note: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

查询PIC18F67K90供应商 REGISTER 10-3: INTCON3: INTERRUPT CONTROL REGISTER 3

R/W-1	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF
bit 7							bit 0

Legend: R = Reada	ahle hit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR '1' = Bit is set		'0' = Bit is cleared	x = Bit is unknown	
bit 7	INT2IP:	NT2 External Interrupt Priority	/ bit	
	1 = High	priority		
	0 = Low	priority		
bit 6	INT1IP:	NT1 External Interrupt Priority	/ bit	
	1 = High	priority		
	0 = Low	priority		
bit 5	INT3IE:	NT3 External Interrupt Enable	e bit	
		bles the INT3 external interrup		
	0 = Disa	bles the INT3 external interru	pt	
bit 4	INT2IE:	NT2 External Interrupt Enable	e bit	
	1 = Enal	bles the INT2 external interrup	ot	
	0 = Disa	bles the INT2 external interru	pt	
bit 3	INT1IE:	NT1 External Interrupt Enable	e bit	
		bles the INT1 external interrup		
	0 = Disa	bles the INT1 external interru	pt	
bit 2		NT3 External Interrupt Flag bi		
		INT3 external interrupt occurr		ire)
		INT3 external interrupt did no		
bit 1		NT2 External Interrupt Flag bi		
		INT2 external interrupt occurr	•	ire)
		INT2 external interrupt did no		
bit 0		NT1 External Interrupt Flag bi		
		INT1 external interrupt occurr		ire)
	0 = 1he	INT1 external interrupt did no	toccur	
Note:	Interrupt flag	bits are set when an interru	ot condition occurs regardless	s of the state of its correspondi
	enable bit or	the global interrupt enable bit	. User software should ensure	e the appropriate interrupt flag b

are clear prior to enabling an interrupt. This feature allows for software polling.

查询PIC18F67K90供应商 10.2 PIR Registers

The PIR registers contain the individual flag bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are six Peripheral Interrupt Request (Flag) registers (PIR1 through PIR6).

- Note 1: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the Global Interrupt Enable bit, GIE (INTCON<7>).
 - 2: User software should ensure the appropriate interrupt flag bits are cleared prior to enabling an interrupt and after servicing that interrupt.

REGISTER 10-4: PIR1: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 1

U-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
—	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF
bit 7							bit 0

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7	Unimplemented: Read as '0'
bit 6	ADIF: A/D Converter Interrupt Flag bit
	 1 = An A/D conversion completed (must be cleared in software) 0 = The A/D conversion is not complete
bit 5	RC1IF: EUSART Receive Interrupt Flag bit
	 1 = The EUSART receive buffer, RCREG1, is full (cleared when RCREG1 is read) 0 = The EUSART receive buffer is empty
bit 4	TX1IF: EUSART Transmit Interrupt Flag bit
	 1 = The EUSART transmit buffer, TXREG1, is empty (cleared when TXREG1 is written) 0 = The EUSART transmit buffer is full
bit 3	SSP1IF: Master Synchronous Serial Port Interrupt Flag bit
	1 = The transmission/reception is complete (must be cleared in software)0 = Waiting to transmit/receive
bit 2	TMR1GIF: Timer1 Gate Interrupt Flag bit
	 1 = Timer gate interrupt has occurred (must be cleared in software) 0 = No timer gate interrupt has occurred
bit 1	TMR2IF: TMR2 to PR2 Match Interrupt Flag bit
	1 = TMR2 to PR2 match has occurred (must be cleared in software)0 = No TMR2 to PR2 match has occurred
bit 0	TMR1IF: TMR1 Overflow Interrupt Flag bit
	1 = TMR1 register overflowed (must be cleared in software)0 = TMR1 register did not overflow

查询PIC18F67K90供应商 REGISTER 10-5: PIR2: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 2

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
OSCFIF	—	SSP2IF	BCL2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	OSCFIF: Oscillator Fail Interrupt Flag bit
	 1 = Device oscillator failed, clock input has changed to INTOSC (must be cleared in software) 0 = Device clock operating
bit 6	Unimplemented: Read as '0'
bit 5	SSP2IF: Master Synchronous Serial Port Interrupt Flag bit
	 1 = The transmission/reception has been completed. (must be cleared in software) 0 = Waiting to transmit/receive
bit 4	BCL2IF: Bus Collision Interrupt Flag bit
	 1 = A bus collision occurred (must be cleared in software) 0 = No bus collision occurred
bit 3	BCL1IF: Bus Collision Interrupt Flag bit
	1 = A bus collision occurred (must be cleared in software)0 = No bus collision occurred
bit 2	HLVDIF: High/Low-Voltage Detect Interrupt Flag bit
	 1 = A high/low-voltage condition occurred (must be cleared in software) 0 = The device voltage is above the regulator's low-voltage trip point
bit 1	TMR3IF: TMR3 Overflow Interrupt Flag bit
	 1 = TMR3 register overflowed (must be cleared in software) 0 = TMR3 register did not overflow
bit 0	TMR3GIF: TMR3 Gate Interrupt Flag bit
	1 = Timer gate interrupt occurred (must be cleared in software)
	0 = No timer gate interrupt occurred

查询PIC18F67K90供应商 REGISTER 10-6: PIR3: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 3

R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF
bit 7		•					bit
Legend:							
R = Readabl	e bit	W = Writable	bit	U = Unimplen	nented bit, rea	ad as '0'	
-n = Value at POR		'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
bit 7		imer5 Gate Inte					
	0	ate interrupt occ r gate interrupt o	· ·	cleared in softw	vare)		
bit 6		•		Type-B wavefor	rm with Non-S	Static mode is se	lected)
	1 = LCD dat	ta of all COMs is ta of all COMs is	s output (must	t be cleared in s			,
bit 5	RC2IF: EUS	ART Receive In	iterrupt Flag bi	it			
		SART receive b SART receive b		2, is full (cleared	d when RCRE	G2 is read)	
bit 4	TX2IF: EUS	ART Transmit Ir	nterrupt Flag bi	it			
		SART transmit t SART transmit t		2, is empty (clea	ared when TX	REG2 is written)
bit 3	CTMUIF: CT	MU Interrupt FI	ag bit				
		nterrupt occured 1U interrupt occu	•	ared in software)		
bit 2	CCP2IF: EC	CP2 Interrupt F	lag bit				
		<u>de:</u> register capture R register captur		st be cleared in	software)		
	<u>Compare mo</u> 1 = A TMR		e match occur		eared in softwa	are)	
	<u>PWM mode:</u> Unused in th						
bit 1	CCP1IF: EC	CP1 Interrupt F	lag bit				
		<u>de:</u> register capture R register captur	•	st be cleared in	software)		
		<u>ode:</u> register compare R register compa			eared in softwa	are)	
	<u>PWM mode:</u> Unused in th						
bit 0	RTCCIF: RT	CC Interrupt Fla	ag bit				
		nterrupt occured		ared in software)		

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-
CCP10IF ⁽¹⁾) CCP9IF ⁽¹⁾	CCP8IF	CCP7IF	CCP6IF	CCP5IF	CCP4IF	CCP3
bit 7							
Legend:							
R = Readabl	le bit	W = Writable	bit	U = Unimpler	mented bit, read	as '0'	
-n = Value at	t POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
	0 = No TMR <u>Compare Moo</u> 1 = A TMR re	egister capture register capture <u>de</u> egister compare	e occurred	red (must be c	n software) leared in softwa	ıre)	
bit 0	1 = A TMR re 0 = No TMR Compare Moo 1 = A TMR re 0 = No TMR PWM Mode Not used in P	egister capture register capture de egister compare register compa	e occurred e match occur ire match occi	red (must be c		ıre)	

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商

REGISTER 10-8: PIR5: PERIPHERAL INTERRUPT FLAG REGISTER 5

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
TMR7GIF ⁽¹⁾	TMR12IF ⁽¹⁾	TMR10IF ⁽¹⁾	TMR8IF	TMR7IF ⁽¹⁾	TMR6IF	TMR5IF	TMR4IF
bit 7							bit 0

Legend:					
R = Reada	ble bit	W = Writable bit	U = Unimplemented bit,	, read as '0'	
-n = Value at POR		OR'1' = Bit is set'0' = Bit is clearedx = Bit is unknown			
bit 7		F: TMR7 Gate Interrupt Flag			
		R gate interrupt occurred (mus TMR gate interrupt occurred	st be cleared in software)		
bit 6	TMR12I	F: TMR12 to PR12 Match Inte	errupt Flag bit ⁽¹⁾		
		R12 to PR12 match occurred (TMR12 to PR12 match occurr			
bit 5	TMR10	F: TMR10 to PR10 Match Inte	errupt Flag bit ⁽¹⁾		
		R10 to PR10 match occurred (TMR10 to PR10 match occurr			
bit 4	TMR8IF	: TMR8 to PR8 Match Interrup	ot Flag bit		
		R8 to PR8 match occurred (m TMR8 to PR8 match occurred			
bit 3	TMR7IF	: TMR7 Overflow Interrupt Fla	ıg bit ⁽¹⁾		
		R7 register overflowed (must t R7 register did not overflow	be cleared in software)		
bit 2	TMR6IF	: TMR6 to PR6 Match Interrup	ot Flag bit		
		R6 to PR6 match occurred (m TMR6 to PR6 match occurred			
bit 1	TMR5IF	: TMR5 Overflow Interrupt Fla	ıg bit		
		R5 register overflowed (must t R5 register did not overflow	be cleared in software)		
bit 0	1 = TM	: TMR4 to PR4 Match Interrup R4 to PR4 match occurred (m TMR4 to PR4 match occurred	ust be cleared in software)		

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商 REGISTER 10-9: PIR6: PERIPHERAL INTERRUPT FLAG REGISTER 6

U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	EEIF	—	CMP3IF	CMP2IF	CMP1IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5 bit 4	Unimplemented: Read as '0' EEIF: Data EEDATA/Flash Write Operation Interrupt Flag bit
Dit 4	 1 = The write operation is complete (must be cleared in software) 0 = The write operation is not complete, or has not been started
bit 3	Unimplemented: Read as '0'
bit 2	CMP3IF: CMP3 Interrupt Flag bit
	 1 = CMP3 interrupt occurred (must be cleared in software) 0 = No CMP3 interrupt occurred
bit 1	CMP2IF: CMP2 Interrupt Flag bit
	1 = CMP2 interrupt occurred (must be cleared in software)0 = No CMP2 interrupt occurred
bit 0	CMP1IF: CM1 Interrupt Flag bit
	1 = CMP1 interrupt occurred (must be cleared in software)0 = No CMP1 interrupt occurred

查询PIC18F67K90供应商 10.3 PIE Registers

The PIE registers contain the individual enable bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are six Peripheral Interrupt Enable registers (PIE1 through PIE6). When IPEN (RCON<7>) = 0, the PEIE bit must be set to enable any of these peripheral interrupts.

REGISTER 10-10: PIE1: PERIPHERAL INTERRUPT ENABLE REGISTER 1

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE
bit 7	·						bit C
Legend:							
R = Reada	ble hit	W = Writable I	hit	l I = I Inimpler	mented bit, read	l as 'O'	
-n = Value		'1' = Bit is set	JI	'0' = Bit is cle	,	x = Bit is unkr	
					area		IOWIT
bit 7	Unimplemer	ted: Read as '0)'				
oit 6	ADIE: A/D C	onverter Interru	ot Enable bit				
	1 = Enables	the A/D interrup	t				
	0 = Disables	the A/D interrup	ot				
bit 5	RC1IE: EUS	ART Receive In	terrupt Enable	e bit			
		the EUSART re					
	0 = Disables	the EUSART re	ceive interrup	t			
bit 4	TX1IE: EUSA	ART Transmit In	terrupt Enable	e bit			
		the EUSART tra					
		the EUSART tra					
bit 3		ster Synchronou		Interrupt Enable	e bit		
		the MSSP interr					
		the MSSP inter	•				
bit 2		MR1 Gate Inter	rupt Enable bi	t			
	1 = Enables 1	0					
	0 = Disables	•					
bit 1		R2 to PR2 Matc					
		the TMR2 to PR the TMR2 to PF					
1.11.0				-			
hit O	TMR1IF TM	R1 Overflow Int	errunt Enable	bit			

bit 0 TMR1IE: TMR1 Overflow Interrupt Enable bit

- 1 = Enables the TMR1 overflow interrupt
- 0 = Disables the TMR1 overflow interrupt

查询PIC18F67K90供应商 REGISTER 10-11: PIE2: PERIPHERAL INTERRUPT ENABLE REGISTER 2 R/W-0 U-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 OSCFIE SSP2IE BCL2IE BCL1IE **HLVDIE** TMR3IE TMR3GIE bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '0' = Bit is cleared '1' = Bit is set x = Bit is unknown bit 7 **OSCFIE:** Oscillator Fail Interrupt Enable bit 1 = Enabled 0 = Disabled bit 6 Unimplemented: Read as '0' bit 5 SSP2IE: Master Synchronous Serial Port 2 Interrupt Enable bit 1 = Enables the MSSP interrupt 0 = Disables the MSSP interrupt bit 4 BCL2IE: Bus Collision Interrupt Enable bit 1 = Enables the bus collision interrupt 0 = Disables the bus collision interrupt bit 3 BCL1IE: Bus Collision Interrupt Enable bit 1 = Enabled 0 = Disabled bit 2 HLVDIE: High/Low-Voltage Detect Interrupt Enable bit 1 = Enabled 0 = Disabled TMR3IE: TMR3 Overflow Interrupt Enable bit bit 1 1 = Enabled 0 = Disabled bit 0 TMR3GIE: Timer3 Gate Interrupt Enable bit 1 = Enabled 0 = Disabled

查询PIC18F67K90供应商

REGISTER 10-12: PIE3: PERIPHERAL INTERRUPT ENABLE REGISTER 3

R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE
bit 7							bit (
Legend:							
R = Readab	le bit	W = Writable		•	nented bit, read	d as '0'	
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown
bit 7		mer5 Gate Inter	rupt Enable bi	t			
	1 = Enabled 0 = Disabled						
bit 6		Interrupt Enable	e bit ⁽¹⁾				
	1 = Enabled						
	0 = Disabled						
bit 5	RC2IE: AUSA	ART Receive Ir	iterrupt Enable	e bit			
	1 = Enabled						
	0 = Disabled						
bit 4		RT Transmit Ir	terrupt Enable	e bit			
	1 = Enabled 0 = Disabled						
bit 3		MU Interrupt E	nahla hit				
bit 5	1 = Enabled						
	0 = Disabled						
bit 2	CCP2IE: ECO	CP2 Interrupt E	nable bit				
	1 = Enabled						
	0 = Disabled						
bit 1		CP1 Interrupt E	nable bit				
	1 = Enabled						
h it 0	0 = Disabled		ahla hit				
bit 0	1 = Enabled	CC Interrupt Er	Iadie dit				

Note 1: This bit is valid when the Type-B waveform with Non-Static mode is selected.

REGISTER 10-13: PIE4: PERIPHERAL INTERRUPT ENABLE REGISTER 4

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CCP10IE ⁽¹⁾	CCP9IE ⁽¹⁾	CCP8IE	CCP7IE	CCP6IE	CCP5IE	CCP4IE	CCP3IE
bit 7							bit 0

Legend:			
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0

CCP10IE:CCP3IE: CCP<10:3> Interrupt Enable bits⁽¹⁾

1 = Enabled

0 = Disabled

Note 1: CCP10IE and CCP9IE are unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-	
TMR7GIE ⁽¹⁾	TMR12IE ⁽¹⁾	TMR10IE ⁽¹⁾	TMR8IE	TMR7IE ⁽¹⁾	TMR6IE	TMR5IE	TMR4	
bit 7								
Legend:								
R = Readable	bit	W = Writable b	bit	U = Unimpler	nented bit, read	1 as '0'		
-n = Value at F	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown	
bit 7	TMR7GIE: TN	/IR7 Gate Interr	upt Enable b	it(1)				
	1 = Enabled 0 = Disabled							
bit 6	TMR12IE: TMR12 to PR12 Match Interrupt Enable bit ⁽¹⁾							
		the TMR12 to I		•				
	0 = Disables the TMR12 to PR12 match interrupt							
bit 5	TMR10IE: TMR10 to PR10 Match Interrupt Enable bit ⁽¹⁾							
	 1 = Enables the TMR10 to PR10 match interrupt 0 = Disables the TMR10 to PR10 match interrupt 							
bit 4		R8 to PR8 Matc		-				
		the TMR8 to P	•					
		the TMR8 to F						
bit 3	TMR7IE: TMF	R7 Overflow Inte	errupt Enable	e bit ⁽¹⁾				
	1 = Enables	the TMR7 over	flow interrup	t				
	0 = Disables	the TMR7 ove	rflow interrup	ot				
bit 2	TMR6IE: TMF	R6 to PR6 Matc	h Interrupt E	nable bit				
	1 = Enables	= Enables the TMR6 to PR6 match interrupt						
	0 = Disables	s the TMR6 to F	R6 match in	terrupt				
bit 1	TMR5IE: TMF	TMR5IE: TMR5 Overflow Interrupt Enable bit						
	1 = Enables the TMR5 overflow interrupt							
	0 = Disables	s the TMR5 ove	rflow interrup	ot				
bit 0	TMR4IE: TMF	R4 to PR4 Matc	h Interrupt E	nable bit				
		the TMR4 to P						
	0 = Disables	s the TMR4 to F	D4 motoh int	torrupt				

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商 REGISTER 10-15: PIE6: PERIPHERAL INTERRUPT ENABLE REGISTER 6

U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
—	—	_	EEIE	—	CMP3IE	CMP2IE	CMP1IE
bit 7							bit 0
Logond							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5	Unimplemented: Read as '0'
bit 4	EEIE: Data EEDATA/Flash Write Operation Enable bit
	1 = Interrupt is enabled0 = interrupt is disabled
bit 3	Unimplemented: Read as '0'
bit 2	CMP3IE: CMP3 Enable bit
	1 = Interrupt is enabled
	0 = interrupt is disabled
bit 1	CMP2E: CMP2 Enable bit
	1 = Interrupt is enabled
	0 = interrupt is disabled
bit 0	CMP1IE: CMP1 Enable bit
	1 = Interrupt is enabled
	0 = interrupt is disabled

查询PIC18F67K90供应商 10.4 IPR Registers

The IPR registers contain the individual priority bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are six Peripheral Interrupt Priority registers (IPR1 through IPR6). Using the priority bits requires that the Interrupt Priority Enable (IPEN) bit (RCON<7>) be set.

REGISTER 10-16: IPR1: PERIPHERAL INTERRUPT PRIORITY REGISTER 1

U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP
bit 7							bit 0

Legend:			
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
	-
bit 6	ADIP: A/D Converter Interrupt Priority bit
	1 = High priority
	0 = Low priority
bit 5	RC1IP: EUSART Receive Interrupt Priority bit
	1 = High priority
	0 = Low priority
bit 4	TX1IP: EUSART Transmit Interrupt Priority bit
	1 = High priority
	0 = Low priority
bit 3	SSP1IP: Master Synchronous Serial Port Interrupt Priority bit
	1 = High priority
	0 = Low priority
bit 2	TMR1GIP: Timer1 Gate Interrupt Priority bit
	1 = High priority
	0 = Low priority
bit 1	TMR2IP: TMR2 to PR2 Match Interrupt Priority bit
	1 = High priority
	0 = Low priority
bit 0	TMR1IP: TMR1 Overflow Interrupt Priority bit
	1 = High priority
	0 = Low priority

查询PIC18F67K90供应商 REGISTER 10-17: IPR2: PERIPHERAL INTERRUPT PRIORITY REGISTER 2

R/W-1	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1				
OSCFIP	—	SSP2IP	BCL2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP				
bit 7				·			bit 0				
Legend:	1. 1.4		1.11								
R = Readab		W = Writable		•	nented bit, read						
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown				
bit 7	OSCFIP: Os	cillator Fail Inter	rupt Priority bi	it							
	1 = High pri	ority									
	0 = Low price	ority									
oit 6	Unimpleme	nted: Read as '	כ'								
oit 5	SSP2IP: Ma	SSP2IP: Master Synchronous Serial Port 2 Interrupt Priority bit									
	U 1	1 = High priority									
	0 = Low pric	0 = Low priority									
oit 4		s Collision Interr	upt priority bit	(MSSP)							
	1 = High price										
	0 = Low price	•									
bit 3		BCL1IP: Bus Collision Interrupt Priority bit									
	• •	1 = High priority 0 = Low priority									
bit 2		-	Data at Interrup	t Driarity bit							
		HLVDIP: High/Low-Voltage Detect Interrupt Priority bit									
	1 = High priority 0 = Low priority										
bit 1		TMR3IP: TMR3 Overflow Interrupt Priority bit									
		1 = High priority									
	• •	1 =									
bit 0	TMR3GIP: T	MR3 Gate Inter	rupt Priority bit	t							
	1 = High pri		. ,								
	0 = Low pric	•									

R/W-1	R/W-1	R-1	R-1	R/W-1	R/W-1	R/W-1	R/W-1
TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP
bit 7							bi
Legend:							
R = Readab	ole bit	W = Writable	bit	U = Unimplen	nented bit, read	d as '0'	
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
bit 7	1 = High prid0 = Low pric	ority					
bit 6	LCDIP: LCD 1 = High prio 0 = Low prio	•	/ bit (valid whe	n the Type-B wa	aveform with No	on-Static mode	is selected)
bit 5	RC2IP: AUS 1 = High pric 0 = Low pric		riority Flag bit				
bit 4	TX2IP: AUS, 1 = High pric 0 = Low pric		nterrupt Priorit	y bit			
bit 3	CTMUIP: CT 1 = High pric 0 = Low pric	•	iority bit				
bit	CCP2IP: EC 1 = High pric 0 = Low pric		riority bit				
bit	CCP1IP: EC 1 = High pric 0 = Low pric		riority bit				
			iority bit				

REGISTER 10-19: IPR4: PERIPHERAL INTERRUPT PRIORITY REGISTER 4

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
CCP10IP ⁽¹⁾	CCP9IP ⁽¹⁾	CCP8IP	CCP7IP	CCP6IP	CCP5IP	CCP4IP	CCP3IP
bit 7						•	bit 0
Legend:							
R = Readable bit W = Writable bit			U = Unimplemented bit, read as '0'				
				•			

CCP10IP:CCP3IP: CCP<10:3> Interrupt Priority bit⁽¹⁾

- 1 = High priority
- 0 = Low priority

Note 1: CCP10IP and CCP9IP are unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

bit 7-0

查询PIC18F67K90供应商

REGISTER 10-20: IPR5: PERIPHERAL INTERRUPT PRIORITY REGISTER 5

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1			
TMR7GIP ⁽¹⁾	TMR12IP ⁽¹⁾	TMR10IP ⁽¹⁾	TMR8IP	TMR7IP ⁽¹⁾	TMR6IP	TMR5IP	TMR4IP			
bit 7							bit (
Legend:	L :4		:4			-l (0)				
R = Readable		W = Writable b	lt	U = Unimplem						
-n = Value at F	'UR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown			
bit 7	TMR7GIP: TA	/IR7 Gate Interr	upt Prioritv b	_{it} (1)						
	1 = High price									
	0 = Low prior									
bit 6	TMR12IP: TMR12 to PR12 Match Interrupt Priority bit ⁽¹⁾									
	1 = High price									
	0 = Low prio									
bit 5	TMR10IP: TM	1R10 to PR10 N	latch Interrup	ot Priority bit ⁽¹⁾						
	1 = High price	•								
	0 = Low prio	-								
bit 4	TMR8IP: TMR8 to PR8 Match Interrupt Priority bit									
	1 = High priority									
bit 3	0 = Low priority									
DIL 3	TMR7IP: TMR7 Overflow Interrupt Priority bit ⁽¹⁾									
	1 = High priority 0 = Low priority									
bit 2	-	-	h Interrupt P	riority bit						
	TMR6IP: TMR6 to PR6 Match Interrupt Priority bit 1 = High priority									
	0 = Low priority									
bit 1	TMR5IP: TMR5 Overflow Interrupt Priority bit									
	1 = High priority									
	0 = Low prio	ority								
bit 0		R4 to PR4 Matcl	h Interrupt P	riority bit						
	1 = High pric									
	0 = Low prior	ity								

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商 REGISTER 10-21: IPR6: PERIPHERAL INTERRUPT PRIORITY REGISTER 6

U-0	U-0	U-0	R/W-1	U-0	R/W-1	R/W-1	R/W-1
_	—	_	EEIE	_	CMP3IE	CMP2IE	CMP1IE
bit 7					·		bit (
Legend:							
R = Readable	e bit	W = Writable	bit	U = Unimpler	mented bit, read	as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
bit 7-5	Unimplemen	ted: Read as '	0'				
bit 4	EEIP: EE Inte	errupt Priority b	it				
	1 = High prie	ority					
	0 = Low pric	ority					
bit 3	SBOREN: Re	ead as '0'					
bit 2	CMP3IP: CM	P3 Interrupt Pr	iority bit				
	1 = High prie	•					
	0 = Low pric	•					
bit 1	bit 1 CMP2IP: CMP2 Interrupt Priority bit		iority bit				
	1 = High priority						
	0 = Low pric	-					
bit 0		P1 Interrupt Pr	iority bit				
	1 = High prie	•					
	0 = Low pric	brity					

查询PIC18F67K90供应商 10.5 RCON Register

The RCON register contains bits used to determine the cause of the last Reset or wake-up from Idle or Sleep modes. RCON also contains the bit that enables interrupt priorities (IPEN).

REGISTER 10-22: RCON: RESET CONTROL REGISTER

R/W-0	R/W-1	R/W-1	R/W-1	R-1	R-1	R/W-0	R/W-0
IPEN	SBOREN	CM	RI	TO	PD	POR	BOR
bit 7							bit 0

Legend:					
R = Read	able bit	W = Writable bit	U = Unimplemented bit	, read as '0'	
-n = Value at POR		'1' = Bit is set	'1' = Bit is set '0' = Bit is cleared		
bit 7	IPEN: Int	errupt Priority Enable bit			
bit 7	IPEN: Int	errupt Priority Enable bit			

	 1 = Enable priority levels on interrupts 0 = Disable priority levels on interrupts (PIC16CXXX Compatibility mode)
bit 6	SBOREN: BOR Software Enable bit
	If BOREN<1:0> = 01:1 = BOR is enabled0 = BOR is disabled
	$\frac{\text{If BOREN<1:0> = 00, 10 or 11:}}{\text{Bit is disabled and read as '0'.}}$
bit 5	CM: Configuration Mismatch Flag bit
	 1 = A Configuration Mismatch Reset has not occurred 0 = A Configuration Mismatch Reset has occurred (must be subsequently set in software)
bit 4	RI: RESET Instruction Flag bit
	For details of bit operation, see Register 5-1.
bit 3	TO: Watchdog Timer Time-out Flag bit
	For details of bit operation, see Register 5-1.
bit 2	PD: Power-Down Detection Flag bit
	For details of bit operation, see Register 5-1.
bit 1	POR: Power-on Reset Status bit
	For details of bit operation, see Register 5-1.
bit 0	BOR: Brown-out Reset Status bit
	For details of bit operation, see Register 5-1.

查询PIC18F67K90供应商 10.6 INTx Pin Interrupts

External interrupts on the RB0/INT0, RB1/INT1, RB2/INT2 and RB3/INT3 pins are edge-triggered. If the corresponding INTEDGx bit in the INTCON2 register is set (= 1), the interrupt is triggered by a rising edge. If that bit is clear, the trigger is on the falling edge.

When a valid edge appears on the RBx/INTx pin, the corresponding flag bit, INTxIF, is set. This interrupt can be disabled by clearing the corresponding enable bit, INTxIE. Before re-enabling the interrupt, the flag bit (INTxIF) must be cleared in software in the Interrupt Service Routine.

All external interrupts (INT0, INT1, INT2 and INT3) can wake up the processor from the power-managed modes, if bit, INTxIE, was set prior to going into the power-managed modes. If the Global Interrupt Enable bit (GIE) is set, the processor will branch to the interrupt vector following wake-up.

The interrupt priority for INT1, INT2 and INT3 is determined by the value contained in the Interrupt Priority bits, INT1IP (INTCON3<6>), INT2IP (INTCON3<7>) and INT3IP (INTCON2<1>).

There is no priority bit associated with INT0. It is always a high-priority interrupt source.

10.7 TMR0 Interrupt

In 8-bit mode (the default), an overflow in the TMR0 register (FFh \rightarrow 00h) will set flag bit, TMR0IF. In 16-bit mode, an overflow in the TMR0H:TMR0L register pair (FFFFh \rightarrow 0000h) will set TMR0IF.

The interrupt can be enabled/disabled by setting/clearing enable bit, TMR0IE (INTCON<5>). Interrupt priority for Timer0 is determined by the value contained in the interrupt priority bit, TMR0IP (INTCON2<2>). For further details on the Timer0 module, see **Section 12.0 "Timer0 Module"**.

10.8 PORTB Interrupt-on-Change

An input change on PORTB<7:4> sets flag bit, RBIF (INTCON<0>). The interrupt can be enabled/disabled by setting/clearing enable bit, RBIE (INTCON<3>).

Interrupt priority for PORTB interrupt-on-change is determined by the value contained in the interrupt priority bit, RBIP (INTCON2<0>).

10.9 Context Saving During Interrupts

During interrupts, the return PC address is saved on the stack. Additionally, the WREG, STATUS and BSR registers are saved on the Fast Return Stack.

If a fast return from interrupt is not used (see **Section 6.3 "Data Memory Organization"**), the user may need to save the WREG, STATUS and BSR registers on entry to the Interrupt Service Routine (ISR). Depending on the user's application, other registers also may need to be saved.

Example 10-1 saves and restores the WREG, STATUS and BSR registers during an Interrupt Service Routine.

MOVWF MOVFF ; ; USER ;	W_TEMP STATUS, STATUS_TEMP BSR, BSR_TEMP ISR CODE	; W_TEMP is in virtual bank ; STATUS_TEMP located anywhere ; BSR_TMEP located anywhere
MOVFF	BSR_TEMP, BSR	; Restore BSR
MOVF	W_TEMP, W	; Restore WREG
MOVFF	STATUS_TEMP, STATUS	; Restore STATUS

查询PIC18F67K90供应商

TABLE 10-1: SUMMARY OF REGISTERS ASSOCIATED WITH INTERRUPTS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP	73
INTCON3	INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF	73
PIR1		ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIR2	OSCFIF	_	SSP2IF	BCL2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIR4	CCP10IF ⁽¹⁾	CCP9IF ⁽¹⁾	CCP8IF	CCP7IF	CCP6IF	CCP5IF	CCP4IF	CCP3IF	75
PIR5	TMR7GIF ⁽¹⁾	TMR12IF ⁽¹⁾	TMR10IF ⁽¹⁾	TMR8IF	TMR7IF ⁽¹⁾	TMR6IF	TMR5IF	TMR4IF	75
PIR6	—	—	_	EEIF	—	CMP3IF	CMP2IF	CMP1IF	75
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
PIE2	OSCFIE	—	SSP2IE	BCL2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
PIE4	CCP10IE ⁽¹⁾	CCP9IE ⁽¹⁾	CCP8IE	CCP7IE	CCP6IE	CCP5IE	CCP4IE	CCP3IE	75
PIE5	TMR7GIE ⁽¹⁾	TMR12IE ⁽¹⁾	TMR10IE ⁽¹⁾	TMR8IE	TMR7IE ⁽¹⁾	TMR6IE	TMR5IE	TMR4IE	75
PIE6	—	—	_	EEIE	—	CMP3IE	CMP2IE	CMP1IE	78
IPR1	—	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
IPR2	OSCFIP	—	SSP2IP	BCL2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
IPR4	CCP10IP ⁽¹⁾	CCP9IP ⁽¹⁾	CCP8IP	CCP7IP	CCP6IP	CCP5IP	CCP4IP	CCP3IP	75
IPR5	TMR7GIP ⁽¹⁾	TMR12IP ⁽¹⁾	TMR10IP ⁽¹⁾	TMR8IP	TMR7IP ⁽¹⁾	TMR6IP	TMR5IP	TMR4IP	74
IPR6	—	—	_	EEIE	—	CMP3IE	CMP2IE	CMP1IE	75
RCON	IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	74

Legend: Shaded cells are not used by the interrupts.

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商 11.0 I/O PORTS

Depending on the device selected and features enabled, there are up to nine ports available. Some pins of the I/O ports are multiplexed with an alternate function from the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

Each port has three memory mapped registers for its operation:

- TRIS register (Data Direction register)
- PORT register (reads the levels on the pins of the device)
- LAT register (Output Latch register)

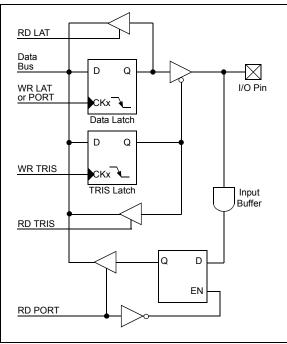
Reading the PORT register reads the current status of the pins, whereas writing to the PORT register writes to the Output Latch (LAT) register.

Setting a TRIS bit (= 1) makes the corresponding port pin an input (putting the corresponding output driver in a High-Impedance mode). Clearing a TRIS bit (= 0) makes the corresponding port pin an output (i.e., put the contents of the corresponding LAT bit on the selected pin).

The Output Latch (LAT register) is useful for read-modify-write operations on the value that the I/O pins are driving. Read-modify-write operations on the LAT register read and write the latched output value for the PORT register.

A simplified model of a generic I/O port, without the interfaces to other peripherals, is shown in Figure 11-1.

FIGURE 11-1: GENERIC I/O PORT OPERATION



11.1 I/O Port Pin Capabilities

When developing an application, the capabilities of the port pins must be considered. Outputs on some pins have higher output drive strength than others. Similarly, some pins can tolerate higher than VDD input levels.

All of the digital ports are 5.5V input tolerant. The analog ports have the same tolerance, having clamping diodes implemented internally.

11.1.1 PIN OUTPUT DRIVE

When used as digital I/O, the output pin drive strengths vary, according to the pins' grouping to meet the needs for a variety of applications. In general, there are two classes of output pins, in terms of drive capability:

- Outputs designed to drive higher current loads such as LEDs:
 - PORTA PORTB
 - PORTC
- Outputs with lower drive levels, but capable of driving normal digital circuit loads with a high input impedance. Able to drive LEDs, but only those with smaller current requirements:
 - PORTD PORTE
 - PORTF PORTG
 - PORTH^(†) PORTJ^(†)
 - † These ports are not available on 64-pin devices.

For more details, see "Absolute Maximum Ratings" in **Section 31.0 "Electrical Characteristics"**.

Regardless of its port, all output pins in LCD Segment or Common-mode have sufficient output to directly drive a display.

11.1.2 PULL-UP CONFIGURATION

Four of the I/O ports (PORTB, PORTD, PORTE and PORTJ) implement configurable weak pull-ups on all pins. These are internal pull-ups that allow floating digital input signals to be pulled to a consistent level without the use of external resistors.

The pull-ups are enabled with a single bit for each of the ports: RBPU (INTCON2<7>) for PORTB, and RDPU, REPU and RJPU (PADCFG1<7:5>) for the other ports. By setting RDPU, REPU and RJPU, each of the pull-ups on these ports can be enabled. The pull-ups are disabled on a POR event.

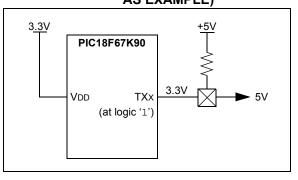
查询PIC18F67K90供应商 11.1.3 OPEN-DRAIN OUTPUTS

The output pins for several peripherals are also equipped with a configurable, open-drain output option. This allows the peripherals to communicate with external digital logic, operating at a higher voltage level, without the use of level translators.

The open-drain option is implemented on port pins specifically associated with the data and clock outputs of the USARTs, the MSSP module (in SPI mode) and the CCP modules. This option is selectively enabled by setting the open-drain control bits in the registers ODCON1, ODCON2 and ODCON3.

When the open-drain option is required, the output pin must also be tied through an external pull-up resistor provided by the user to a higher voltage level, up to 5V (Figure 11-2). When a digital logic high signal is output, it is pulled up to the higher voltage level.

FIGURE 11-2: USING THE OPEN-DRAIN OUTPUT (USART SHOWN AS EXAMPLE)



REGISTER 11-1: ODCON1: PERIPHERAL OPEN-DRAIN CONTROL REGISTER 1

R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0	R/W-0
SSP10D	CCP2OD	CCP10D	_	—	—	—	SSP2OD
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as 'O'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	SSP10D: SPI1 Open-Drain Output Enable bit
	 1 = Open-drain capability is enabled
	0 = Open-drain capability is disabled
bit 6	CCP2OD: ECCP2 Open-Drain Output Enable bit
	1 = Open-drain capability is enabled
	0 = Open-drain capability is disabled
bit 5	CCP10D: ECCP1 Open-Drain Output Enable bit
	1 = Open-drain capability is enabled
	0 = Open-drain capability is disabled
bit 4-1	Unimplemented: Read as '0'
bit 0	SSP2OD: SPI2 Open-Drain Output Enable bit
	1 = Open-drain capability is enabled
	0 = Open drein eenshility is disabled

0 = Open-drain capability is disabled

R/W-0

查询PIC18F67K90供应商 REGISTER 11-2: ODCON2: PERIPHERAL OPEN-DRAIN CONTROL REGISTER 2 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0

CCP100D ⁽¹⁾	DD ⁽¹⁾ CCP9OD ⁽¹⁾ CCP8OD CCP7OD CCP6OD CCP5OD						CCP3OD										
bit 7																	
Legend:																	
R = Readable I	bit	W = Writable	bit	•	nented bit, read	as '0'											
-n = Value at P	OR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	Iown										
				(1)													
bit 7	CCP100D: C	•	•	able bit ⁽¹⁾													
		in capability is in capability is															
bit 6	•	, ,		bla hit(1)													
	CCP9OD: CC	in capability is		DE DIL													
		in capability is															
bit 5	CCP8OD: CC			ole bit													
		1 = Open-drain capability is enabled															
	0 = Open-dra	in capability is	disabled														
bit 4	CCP7OD: CC	P7 Open-Drai	n Output Enab	ole bit													
		in capability is															
	•	in capability is															
bit 3		P6 Open-Drai	•	ole bit													
	•	in capability is															
	•	in capability is		1- 6:4													
bit 2	CCP5OD: CC	•	•	DIE DIT													
		in capability is in capability is															
bit 1	•			ole bit													
		CP4 Open-Drain Output Enable bit rain capability is enabled															
	0 = Open-drain capability is disabled																
bit 0 CCP3OD: ECCP3 Open-Drain Output Enable bit																	
	1 = Open-dra	in capability is	enabled														
	0 = Open-dra	in capability is	disabled				 1 = Open-drain capability is enabled 0 = Open-drain capability is disabled 										

Note 1: Unimplemented on PIC18FX5K90 devices.

查询PIC18F67K90供应商

REGISTER 11-3: ODCON3: PERIPHERAL OPEN-DRAIN CONTROL REGISTER 3

			-	_				
R/W-0	R/W-0	U-0	U-0	U-0	U-0	U-0	R/W-0	
U2OD	U10D	_	_	—	—		CTMUDS	
bit 7		·					bit	
Legend:								
R = Readab	le bit	W = Writable	bit	U = Unimpler	nented bit, read	l as '0'		
-n = Value a	t POR	'1' = Bit is set	'1' = Bit is set		ared	x = Bit is unknown		
bit 7	U2OD: EUS	SART2 Open-Dra	in Output Ena	able bit				
	1 = Open-d	Irain capability is	enabled					
	0 = Open-d	Irain capability is	disabled					
bit 6	U10D: EUS	SART1 Open-Dra	in Output Ena	able bit				
	1 = Open-d	Irain capability is	enabled					
	0 = Open-d	Irain capability is	disabled					
bit 5-1	Unimpleme	ented: Read as 'o	0'					

bit 0 CTMUDS: CTMU Pulse Delay Enable bit

1 = Pulse delay input for CTMU is enabled on pin, RF1

0 = Pulse delay input for CTMU is disabled on pin, RF1

11.1.4 ANALOG AND DIGITAL PORTS

Many of the ports multiplex analog and digital functionality, providing a lot of flexibility for hardware designers. PIC18F87K90 family devices can make any analog pin analog or digital, depending on an application's needs. The ports' analog/digital functionality is controlled by the registers: ANCON0, ANCON1 and ANCON2. Setting these registers makes the corresponding pins analog and clearing the registers makes the ports digital. For details on these registers, see Section 23.0 "12-Bit Analog-to-Digital Converter (A/D) Module".

查询PIC18F67K90供应商 **11.2 PORTA, TRISA** and

LATA Registers

PORTA is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISA and LATA.

RA4/T0CKI is a Schmitt Trigger input. All other PORTA pins have TTL input levels and full CMOS output drivers.

The RA4 pin is multiplexed with the Timer0 clock input and one of the LCD segment drives. RA5 and RA<3:0> are multiplexed with analog inputs for the A/D Converter. RA1 is multiplexed with analog as well as the LCD segment drive.

The operation of the analog inputs as A/D Converter inputs is selected by clearing or setting the ANSEL<3:0> control bits in the ANCON1 register. The corresponding TRISA bits control the direction of these pins, even when they are being used as analog inputs. The user must ensure the bits in the TRISA register are maintained set when using them as analog inputs.

Note: RA5 and RA<3:0> are configured as analog inputs on any Reset and are read as '0'. RA4 is configured as a digital input.

OSC2/CLKO/RA6 and OSC1/CLKI/RA7 normally serve as the external circuit connections for the external (primary) oscillator circuit (HS Oscillator modes) or the external clock input and output (EC Oscillator modes). In these cases, RA6 and RA7 are not available as digital I/O and their corresponding TRIS and LAT bits are read as '0'. When the device is configured to use HF-INTOSC, MF-INTOSC or LF-INTOSC as the default oscillator mode, RA6 and RA7 are automatically configured as digital I/O; the oscillator and clock in/clock out functions are disabled.

RA1, RA4 and RA5 are multiplexed with LCD segment drives that are controlled by bits in the LCDSE1 and LCDSE2 registers. I/O port functionality is only available when the LCD segments are disabled.

RA5 has additional functionality for Timer1 and Timer3. It can be configured as the Timer1 clock input or the Timer3 external clock gate input.

EXAMPLE 11-1: INITIALIZING PORTA

CLRF	PORTA	; Initialize PORTA by
		; clearing output latches
CLRF	LATA	; Alternate method to
		; clear output data latches
BANKSEL	ANCON1	
MOVLW	00h	; Configure A/D
MOVWF	ANCON1	; for digital inputs
MOVLW	0BFh	; Value used to initialize
		; data direction
MOVWF	TRISA	; Set RA<7, 5:0> as inputs,
		; RA<6> as output
		_

查询PIC18F67K90供应商 TABLE 11-1: PORTA FUNCTIONS

		TRIS	_	I/O	
Pin Name	Function	Setting	I/O	Туре	Description
RA0/AN0/ULPWU	RA0	0	0	DIG	LATA<0> data output; not affected by analog input.
		1	I	TTL	PORTA<0> data input; disabled when analog input enabled.
	AN0	1	I	ANA	A/D Input Channel 0. Default input configuration on POR; does not affect digital output.
	ULPWU	1	I	ANA	Ultra low-power wake-up input.
RA1/AN1/SEG18	RA1	0	0	DIG	LATA<1> data output; not affected by analog input.
		1	I	TTL	PORTA<1> data input; disabled when analog input is enabled.
	AN1	1	I	ANA	A/D Input Channel 1. Default input configuration on POR; does not affect digital output.
	SEG18	1	0	ANA	LCD Segment 18 output; disables all other pin functions.
RA2/AN2/VREF-	RA2	0	0	DIG	LATA<2> data output; not affected by analog input.
		1	I	TTL	PORTA<2> data input; disabled when analog functions are enabled.
	AN2	1	I	ANA	A/D Input Channel 2. Default input configuration on POR.
	VREF-	1	I	ANA	A/D and comparator low reference voltage input.
RA3/AN3/VREF+	RA3	0	0	DIG	LATA<3> data output; not affected by analog input.
		1	I	TTL	PORTA<3> data input; disabled when analog input is enabled.
	AN3	1	I	ANA	A/D Input Channel 3. Default input configuration on POR.
	VREF+	1	I	ANA	A/D and comparator high reference voltage input.
RA4/T0CKI/	RA4	0	0	DIG	LATA<4> data output.
SEG14		1	I	ST	PORTA<4> data input. Default configuration on POR.
	TOCKI	x	I	ST	Timer0 clock input.
	SEG14	1	0	ANA	LCD Segment 14 output; disables all other pin functions.
RA5/AN4/SEG15/	RA5	0	0	DIG	LATA<5> data output; not affected by analog input.
T1CKI/T3G/ HLVDIN		1	Ι	TTL	PORTA<5> data input; disabled when analog input is enabled.
	AN4	1	I	ANA	A/D Input Channel 4. Default configuration on POR.
	SEG15	1	0	ANA	LCD Segment 15 output; disables all other pin functions.
	T1CKI	x	I	ST	Timer1 clock input.
	T3G	x	I	ST	Timer3 external clock gate input.
	HLVDIN	1	I	ANA	High/Low-Voltage Detect external trip point input.
OSC2/CLKO/RA6	OSC2	x	0	ANA	Main oscillator feedback output connection (HS, XT and LP modes).
	CLKO	x	0	DIG	System cycle clock output (Fosc/4, EC and INTOSC modes).
	RA6	0	0	DIG	LATA<6> data output; disabled when OSC2 Configuration bit is set.
		1	I	TTL	PORTA<6> data input; disabled when OSC2 Configuration bit is set.
OSC1/CLKI/RA7	OSC1	х	I	ANA	Main oscillator input connection (HS, XT and LP modes).
	CLKI	x	I	ANA	Main external clock source input (EC modes).
	RA7	0	0	DIG	LATA<7> data output; disabled when OSC2 Configuration bit is set.
		1	I	TTL	PORTA<7> data input; disabled when OSC2 Configuration bit is set.

O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, Legend:

TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

查询PIC18F67K90供应商 TABLE 11-2: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTA	RA7 ⁽¹⁾	RA6 ⁽¹⁾	RA5	RA4	RA3	RA2	RA1	RA0	76
LATA	LATA7 ⁽¹⁾	LATA6 ⁽¹⁾	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0	76
TRISA	TRISA7 ⁽¹⁾	TRISA6 ⁽¹⁾	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	76
ANCON1	ANSEL15	ANSEL14	ANSEL13	ANSEL12	ANSEL11	ANSEL10	ANSEL9	ANSEL8	79
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE09	SE08	81
LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	81

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTA.

Note 1: These bits are enabled depending on the oscillator mode selected. When not enabled as PORTA pins, they are disabled and read as 'x'.

查询PIC18F67K90供应商

11.3 PORTB, TRISB and LATB Registers

PORTB is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISB and LATB. All pins on PORTB are digital only.

EXAMPLE 11-2: INITIALIZING PORTB

CLRF	PORTB	; Initialize PORTB by ; clearing output
CURF		; data latches ; Alternate method
CLRF	LATB	, Alternate method
		; to clear output
		; data latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISB	; Set RB<3:0> as inputs
		; RB<5:4> as outputs
		; RB<7:6> as inputs

Each of the PORTB pins has a weak internal pull-up. A single control bit can turn on all the pull-ups. This is performed by clearing bit, RBPU (INTCON2<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on a Power-on Reset.

Four of the PORTB pins (RB<7:4>) have an interrupt-on-change feature. Only pins configured as inputs can cause this interrupt to occur; any RB<7:4> pin configured as an output would be excluded from the interrupt-on-change comparison.

Comparisons with the input pins (of RB<7:4>) are made with the old value latched on the last read of PORTB. The "mismatch" outputs of RB<7:4> are ORed together to generate the RB Port Change Interrupt with Flag bit, RBIF (INTCON<0>).

This interrupt can wake the device from power-managed modes. To clear the interrupt in the Interrupt Service Routine:

- a) Any read or write of PORTB (except with the MOVFF (ANY), PORTB instruction). This will end the mismatch condition.
- b) Wait one instruction cycle (such as executing a NOP instruction).
- c) Clear flag bit, RBIF.

A mismatch condition will continue to set flag bit, RBIF. Reading PORTB will end the mismatch condition and allow flag bit, RBIF, to be cleared after one TCY delay.

The interrupt-on-change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt-on-change feature. Polling of PORTB is not recommended while using the interrupt-on-change feature.

The RB<3:2> pins are multiplexed as CTMU edge inputs. RB5 has an additional function for Timer3 and Timer1. It can be configured for Timer3 clock input or Timer1 external clock gate input.

The RB<5:0> pins also are multiplexed with LCD segment drives that are controlled by bits in the registers, LCDSE1 and LCDSE3. I/O port functionality is only available when the LCD segments are disabled.

查询PIC18F67K90供应商 TABLE 11-3: PORTB FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RB0/INT0/SEG30/	RB0	0	0	DIG	LATB<0> data output.
FLT0		1	Ι	TTL	PORTB<0> data input; weak pull-up when RBPU bit is cleared.
	INT0	1	I	ST	External Interrupt 0 input.
	SEG30	1	0	ANA	LCD Segment 30 output; disables all other pin functions.
	FLT0	x	I	ST	Enhanced PWM Fault input for ECCPx.
RB1/INT1/SEG8	RB1	0	0	DIG	LATB<1> data output.
		1	I	TTL	PORTB<1> data input; weak pull-up when RBPU bit is cleared.
	INT1	1	I	ST	External Interrupt 1 input.
	SEG8	1	0	ANA	LCD Segment 8 output; disables all other pin functions.
RB2/INT2/SEG9/	RB2	0	0	DIG	LATB<2> data output.
CTED1		1	Ι	TTL	PORTB<2> data input; weak pull-up when RBPU bit is cleared.
	INT2	1	I	ST	External Interrupt 2 input.
	SEG9	1	0	ANA	LCD Segment 9 output; disables all other pin functions.
	CTED1	x	I	ST	CTMU Edge 1 input.
RB3/INT3/SEG10/	RB3	0	0	DIG	LATB<3> data output.
CTED2/ECCP2/ P2A		1	Ι	TTL	PORTB<3> data input; weak pull-up when RBPU bit is cleared.
PZA	INT3	1	I	ST	External Interrupt 3 input.
	SEG10	1	0	ANA	LCD Segment 10 output; disables all other pin functions.
	CTED2	x	I	ST	CTMU Edge 2 input.
	ECCP2	0	0	DIG	ECCP2 compare output and ECCP2 PWM output. Takes priority over port data.
		1	-	ST	ECCP2 capture input.
	P2A	0	0	DIG	ECCP2 Enhanced PWM output, Channel A. May be configured for tri-state during Enhanced PWM shutdown events. Takes priority over port data.
RB4/KBI0/SEG11	RB4	0	0	DIG	LATB<4> data output.
		1	I	TTL	PORTB<4> data input; weak pull-up when RBPU bit is cleared.
	KBI0	1	I	TTL	Interrupt-on-pin change.
	SEG11	1	0	ANA	LCD Segment 11 output; disables all other pin functions.
RB5/KBI1/SEG29/	RB5	0	0	DIG	LATB<5> data output.
T3CKI/T1G		1	Ι	TTL	PORTB<5> data input; weak pull-up when RBPU bit is cleared.
	KBI1	1	Ι	TTL	Interrupt-on-pin change.
	SEG29	1	0	ANA	LCD Segment 29 output; disables all other pin functions.
	T3CKI	x	Ι	ST	Timer3 clock input.
	T1G	x	Ι	ST	Timer1 external clock gate input.
RB6/KBI2/PGC	RB6	0	0	DIG	LATB<6> data output.
		1	Ι	TTL	PORTB<6> data input; weak pull-up when RBPU bit is cleared.
	KBI2	1	Ι	TTL	Interrupt-on-pin change.
	PGC	x	Ι	ST	Serial execution (ICSP) clock input for ICSP and ICD operation.
RB7/KBI3/PGD	RB7	0	0	DIG	LATB<7> data output.
		1	I	TTL	PORTB<7> data input; weak pull-up when RBPU bit is cleared.
	KBI3	1	I	TTL	Interrupt-on-pin change.
	PGD	x	0	DIG	Serial execution data output for ICSP and ICD operation.
		x	I	ST	Serial execution data input for ICSP and ICD operation.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

查询PIC18F67K90供应商 TABLE 11-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTB

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	76
LATB	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	76
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	76
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP	73
INTCON3	INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF	73
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE09	SE08	81
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	81

Legend: Shaded cells are not used by PORTB.

查询PIC18F67K90供应商 11.4 PORTC, TRISC and

LATC Registers

PORTC is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISC and LATC. Only PORTC pins, RC2 through RC7, are digital only pins.

PORTC is multiplexed with ECCP, MSSP and EUSART peripheral functions (Table 11-5). The pins have Schmitt Trigger input buffers. The pins for ECCP, SPI and EUSART are also configurable for open-drain output whenever these functions are active. Open-drain configuration is selected by setting the SSP1OD, CCPxOD and U1OD control bits in the registers, ODCON1 and ODCON3.

RC1 is normally configured as the default peripheral pin for the ECCP2 module. Assignment of ECCP2 is controlled by Configuration bit, CCP2MX (default state, CCP2MX = 1).

When enabling peripheral functions, use care in defining TRIS bits for each PORTC pin. Some peripherals can override the TRIS bit to make a pin an output or input. Consult the corresponding peripheral section for the correct TRIS bit settings.

Note: These pins are configured as digital inputs on any device Reset.

The contents of the TRISC register are affected by peripheral overrides. Reading TRISC always returns the current contents, even though a peripheral device may be overriding one or more of the pins.

The RC<7:1> pins are multiplexed with LCD segment drives that are controlled by bits in the registers, LCDSE1, LCDSE2, LCDSE3 and LCDSE4.

RC0 and RC1 pins serve as the input pins for the SOSC oscillator. On a power-up, these pins are defined as SOSC pins. In order to make these ports have digital I/O port functionality, the CONFI1L<4:3> should be set to '10' (Digital SCLKI mode). I/O port functionality is only available when the LCD segments are disabled.

EXAMPLE 11-3:	INITIALIZING PORTC

CLRF	PORTC	; Initialize PORTC by ; clearing output
CLRF	LATC	; data latches ; Alternate method
		; to clear output ; data latches
MOVLW	OCFh	; Value used to ; initialize data
		; direction
MOVWF	TRISC	; Set RC<3:0> as inputs ; RC<5:4> as outputs ; RC<7:6> as inputs

查询PIC18F67K90供应商

TABLE 11-5: PORTC FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RC0/SOSCO/	RC0	0	0	DIG	LATC<0> data output.
SCLKI/		1	I	ST	PORTC<0> data input.
	SOSCO	1	I	ST	SOSC oscillator output.
	SCLKI	x	0	ANA	Digital clock input; enabled when SOSC oscillator is disabled.
RC1/SOSCI/	RC1	0	0	DIG	LATC<1> data output.
ECCP2/P2A/		1	I	ST	PORTC<1> data input.
SEG32	SOSCI	x	Ι	ANA	SOSC oscillator input.
	ECCP2 ⁽¹⁾	0	0	DIG	ECCP2 compare output and ECCP2 PWM output. Takes priority over port data
		1	I	ST	ECCP2 capture input.
	P2A	0	0	DIG	ECCP2 Enhanced PWM output, Channel A. May be configured for tri-state during Enhanced PWM shutdown events. Takes priority over port data.
	SEG32	1	0	ANA	LCD Segment 32 output; disables all other pin functions.
RC2/ECCP1/	RC2	0	0	DIG	LATC<2> data output.
P1A/SEG13		1	I	ST	PORTC<2> data input.
	ECCP1	0	0	DIG	ECCP1 compare output and ECCP1 PWM output. Takes priority over port data.
		1	I	ST	ECCP1 capture input.
	P1A	0	0	DIG	ECCP1 Enhanced PWM output, Channel A. May be configured for tri-state during Enhanced PWM shutdown events. Takes priority over port data.
	SEG13	1	0	ANA	LCD Segment 13 output; disables all other pin functions.
RC3/SCK1/	RC3	0	0	DIG	LATC<3> data output.
SCL1/SEG17		1	I	ST	PORTC<3> data input.
	SCK1	0	0	DIG	SPI clock output (MSSP module); takes priority over port data.
		1	I	ST	SPI clock input (MSSP module).
	SCL1	0	0	DIG	I ² C [™] clock output (MSSP module); takes priority over port data.
		1	-	l ² C	I ² C clock input (MSSP module); input type depends on module setting.
	SEG17	1	0	ANA	LCD Segment 17 output; disables all other pin functions.
RC4/SDI1/	RC4	0	0	DIG	LATC<4> data output.
SDA1/SEG16		1	Ι	ST	PORTC<4> data input.
	SDI1		Ι	ST	SPI data input (MSSP module).
	SDA1	1	0	DIG	I ² C data output (MSSP module); takes priority over port data.
		1	-	l ² C	I ² C data input (MSSP module); input type depends on module setting.
	SEG16	1	0	ANA	LCD Segment 16 output; disables all other pin functions.
RC5/SDO1/	RC5	0	0	DIG	LATC<5> data output.
SEG12		1	-	ST	PORTC<5> data input.
	SDO1	0	0	DIG	SPI data output (MSSP module).
	SEG12	1	0	ANA	LCD Segment 12 output; disables all other pin functions.
RC6/TX1/CK1/	RC6	0	0	DIG	LATC<6> data output.
SEG27		1	Ι	ST	PORTC<6> data input.
	TX1	1	0	DIG	Synchronous serial data output (EUSART module); takes priority over port data.
	CK1	1	0	DIG	Synchronous serial data input (EUSART module); user must configure as an input
		1	Ι	ST	Synchronous serial clock input (EUSART module).
	SEG27	1	0	ANA	LCD Segment 27 output; disables all other pin functions.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, TTL = TTL Buffer Input, $I^2C = I^2C$ Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

查询PIC18F67K90供应商 TABLE 11-5: PORTC FUNCTIONS (CONTINUED)

Pin Name	Function	TRIS Setting	I/O	I/O Туре	Description
RC7/RX1/DT1/	RC7	0	0	DIG	LATC<7> data output.
SEG28		1	Ι	ST	PORTC<7> data input.
	RX1	1	Ι	ST	Asynchronous serial receive data input (EUSART module).
	DT1	1	0	DIG	Synchronous serial data output (EUSART module); takes priority over port data.
		1	Ι	ST	Synchronous serial data input (EUSART module); user must configure as an input.
	SEG28	1	0	ANA	LCD Segment 28 output; disables all other pin functions.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, TTL = TTL Buffer Input, $I^2C = I^2C$ Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

TABLE 11-6: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	76
LATC	LATC7	LATBC6	LATC5	LATCB4	LATC3	LATC2	LATC1	LATC0	76
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	76
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE09	SE08	81
LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	81
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	81
LCDSE4	SE39 ⁽¹⁾	SE38 ⁽¹⁾	SE37 ⁽¹⁾	SE36 ⁽¹⁾	SE35 ⁽¹⁾	SE34 ⁽¹⁾	SE33 ⁽¹⁾	SE32	81
ODCON1	SSP10D	CCP2OD	CCP10D	_	_	_	_	SSP2OD	79

Legend: Shaded cells are not used by PORTC.

Note 1: Unimplemented on PIC18F6XK90 devices, read as '0'.

查询PIC18F67K90供应商

11.5 PORTD, TRISD and LATD Registers

PORTD is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISD and LATD.

All pins on PORTD are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

Note:	These pins are configured as digital inputs
	on any device Reset.

Each of the PORTD pins has a weak internal pull-up. A single control bit can turn off all the pull-ups. This is performed by clearing bit, RDPU (PADCFG1<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on all device Resets.

All of the PORTD pins are multiplexed with LCD segment drives that are controlled by bits in the LCDSE0 register. RD0 is multiplexed with the CTMU pulse generator output.

I/O port functionality is only available when the LCD segments are disabled.

The PORTD also has the I^2C and SPI functionality on RD4, RD5 and RD6. The pins for SPI are also configurable for open-drain output. Open-drain configuration is selected by setting the SSPxOD control bits in the ODCON1 register.

RD0 has a CTMU functionality. RD1 has the functionality for a Timer5 clock input and also Timer7 has functionality for an external clock gate input.

		INITIALIZING FORTD
CLRF	PORTD	; Initialize PORTD by ; clearing output ; data latches
CLRF	LATD	; Alternate method ; to clear output
MOVLW	0CFh	; data latches ; Value used to ; initialize data
MOVWF	TRISD	; direction ; Set RD<3:0> as inputs ; RD<5:4> as outputs ; RD<7:6> as inputs

EXAMPLE 11-4: INITIALIZING PORTD

查询PIC18F67K90供应商 TABLE 11-7: PORTD FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RD0/SEG0/	RD0	0	0	DIG	LATD<0> data output.
CTPLS		1	Ι	ST	PORTD<0> data input.
	SEG0	1	0	ANA	LCD Segment 0 output; disables all other pin functions.
	CTPLS	x	0	DIG	CTMU pulse generator output.
RD1/SEG1/	RD1	0	0	DIG	LATD<1> data output.
T5CKI/T7G		1	Ι	ST	PORTD<1> data input.
	SEG1	1	0	ANA	LCD Segment 1 output; disables all other pin functions.
	T5CKI	x	Ι	ST	Timer5 clock input.
	T7G	x	Ι	ST	Timer7 external clock gate input.
RD2/SEG2	RD2	0	0	DIG	LATD<2> data output.
		1	Ι	ST	PORTD<2> data input.
	SEG2	1	0	ANA	LCD Segment 2 output; disables all other pin functions.
RD3/SEG3	RD3	0	0	DIG	LATD<3> data output.
		1	Ι	ST	PORTD<3> data input.
	SEG3	1	0	ANA	LCD Segment 3 output; disables all other pin functions.
RD4/SEG4/	RD4	0	0	DIG	LATD<4> data output.
SDO2		1	Ι	ST	PORTD<4> data input.
	SEG4	1	0	ANA	LCD Segment 4 output; disables all other pin functions.
	SDO2	0	Р	DOG	SPI data output (MSSP module).
RD5/SEG5/	RD5	0	0	DIG	LATD<5> data output.
SDI2/SDA2		1	Ι	ST	PORTD<5> data input.
	SEG5	1	0	ANA	LCD Segment 5 output; disables all other pin functions.
	SDI2	1	Ι	ST	SPI data input (MSSP module).
	SDA2	0	0	l ² C	I ² C [™] data input (MSSP module). Input type depends on module setting.
		1	Ι	ANA	LCD Segment 5 output; disables all other pin functions.
RD6/SEG6/	RD6	0	0	DIG	LATD<6> data output.
SCK2/SCL2		1	Ι	ST	PORTD<6> data input.
	SEG6	1	0	ANA	LCD Segment 6 output; disables all other pin functions.
	SCK2	0	0	DIG	SPI clock output (MSSP module). Takes priority over port data.
		1	Ι	ST	SPI clock input (MSSP module).
	SCL2	0	0	DIG	I ² C clock output (MSSP module). Takes priority over port data.
		1	Ι	l ² C	I ² C clock input (MSSP module). Input type depends on module setting.
RD7/SEG7/	RD7	0	0	DIG	LATD<7> data output.
SS2		1	I	ST	PORTD<7> data input.
	SEG7	1	I	ANA	LCD Segment 7 output; disables all other pin functions.
	SS2	1		TTL	Slave select input for MSSP module.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, $I^2C = I^2C$ Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

查询PIC18F67K90供应商 TABLE 11-8: SUMMARY OF REGISTERS ASSOCIATED WITH PORTD

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	76
LATD	LATD7	LATD6	LATD5	LATD4	LATD3	LATD2	LATD1	LATD0	76
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	76
LCDSE0	SE07	SE06	SE05	SE04	SE03	SE02	SE01	SE00	81
PADCFG1	RDPU	REPU	RJPU ⁽¹⁾	_	_	RTSECSEL1	RTSECSEL0	_	78

Legend: Shaded cells are not used by PORTD.

Note 1: Not available on 64-pin devices.

查询PIC18F67K90供应商 11.6 PORTE, TRISE and LATE Registers

PORTE is a 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISE and LATE.

All pins on PORTE are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output. The RE7 pin is also configurable for open-drain output when ECCP2 is active on this pin. Open-drain configuration is selected by setting the CCP2OD control bit (ODCON1<6>)

Note:	These pins are configured as digital inputs	
	on any device Reset.	

Each of the PORTE pins has a weak internal pull-up. A single control bit can turn off all the pull-ups. This is performed by clearing bit, REPU (PADCFG1<6>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on any device Reset.

Pins, RE<6:3>, are multiplexed with the LCD common drives. I/O port functions are available only on those PORTE pins according to which commons are active. The configuration is determined by the LMUX<1:0> control bits (LCDCON<1:0>). The availability is summarized in Table 11-9.

TABLE 11-9:PORTE PINS AVAILABLE IN
DIFFERENT LCD DRIVE
CONFIGURATIONS⁽¹⁾

LCDCON <1:0>	Active LCD Commons	PORTE Pins Available for I/O
00	COM0	RE6, RE5, RE4
01	COM0, COM1	RE6, RE5
10	COM0, COM1 and COM2	RE6
11	All (COM0 through COM3)	None

Note 1: If the LCD bias voltages are generated using the internal resistor ladder, the LCDBIASx pins are also available as I/O ports (RE0, RE1 and RE2).

Pins, RE2, RE1 and RE0, are multiplexed with the functions of LCDBIAS3, LCDBIAS2 and LCDBIAS1. When LCD bias generation is required (in any application where the device is connected to an external LCD), these pins cannot be used as digital I/O. These pins can be used as digital I/O, however, when the internal resistor ladder is used for bias generation.

PORTE is also multiplexed with Enhanced PWM outputs, B and C for ECCP1 and ECCP3, and outputs, B, C and D for ECCP2. For all devices, their default assignments are on PORTE<6:0>. On 80-pin devices, the multiplexing for the outputs of ECCP1 and ECCP3 is controlled by the ECCPMX Configuration bit. Clearing this bit reassigns the P1B/P1C and P3B/P3C outputs to PORTH.

RE7 is multiplexed with the LCD segment drive (SEG31) that is controlled by the LCDSE3<7> bit. I/O port function is only available when the segment is disabled. RE7 can also be configured as the alternate peripheral pin for the ECCP2 module. This is done by clearing the CCP2MX Configuration bit.

RE3 can also be configured as the Reference Clock Output (REFO) from the system clock. For further details, refer to **Section 3.7 "Reference Clock Output"**.

CLRF	PORTE	; Initialize PORTE by ; clearing output
		; data latches
CLRF	LATE	; Alternate method
		; to clear output
		; data latches
MOVLW	03h	; Value used to
		; initialize data
		; direction
MOVWF	TRISE	; Set RE<1:0> as inputs
		; RE<7:2> as outputs

查询PIC18F67K90供应商

TABLE 11-10: PORTE FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	l/O Type	Description
RE0/LCDBIAS1/	RE0	0	0	DIG	LATE<0> data output.
P2D		1	I	ST	PORTE<0> data input.
	LCDBIAS1	_	Ι	ANA	LCD module bias voltage input.
	P2D	0	0		ECCP2 PWM Output D. May be configured for tri-state during Enhanced PWM shutdown events.
RE1/LCDBIAS2/	RE1	0	0	DIG	LATE<1> data output.
P2C		1	Ι	ST	PORTE<1> data input.
	LCDBIAS2		Ι	ANA	LCD module bias voltage input.
	P2C	0	0	_	ECCP2 PWM Output C. May be configured for tri-state during Enhanced PWM shutdown events
RE2/LCDBIAS3/	RE2	0	0	DIG	LATE<2> data output.
P2B		1	Ι	ST	PORTE<2> data input.
	LCDBIAS3	x	Ι	ANA	LCD module bias voltage input.
	P2B	0	0	—	ECCP2 PWM Output B. May be configured for tri-state during Enhanced PWM shutdown events.
RE3/COM0/	RE3	0	0	DIG	LATE<3> data output.
P3C/CCP9/ REFO		1	-	ST	PORTE<3> data input.
REFU	COM0	x	0	ANA	LCD Common 0 output; disables all other outputs.
	P3C	0	0		ECCP3 PWM Output C. May be configured for tri-state during Enhanced PWM shutdown events.
	CCP9	0	0	DIG	CCP9 compare/PWM output. Takes priority over port data.
		1	Ι	ST	CCP9 capture input.
	REFO	x	0	DIG	Reference output clock.
RE4/COM1/	RE4	0	0	DIG	LATE<4> data output.
P3B/CCP8		1	Ι	ST	PORTE<4> data input.
	COM1	x	0	ANA	LCD Common 1 output; disables all other outputs.
	P3B	0	0	_	ECCP3 PWM Output B. May be configured for tri-state during Enhanced PWM shutdown events.
	CCP8	0	0	DIG	CCP8 Compare/PWM output. Takes priority over port data.
		1	-	ST	CCP8 capture input.
RE5/COM2/	RE5	0	0	DIG	LATE<5> data output.
P1C/CCP7		1	Ι	ST	PORTE<5> data input.
	COM2	x	0	ANA	LCD Common 2 output; disables all other outputs.
	P1C	0	0		ECCP1 PWM Output C. May be configured for tri-state during Enhanced PWM shutdown events.
	CCP7	0	0	DIG	CCP7 Compare/PWM output. Takes priority over port data.
		1	Ι	ST	CCP7 capture input.
RE6/COM3/	RE6	0	0	DIG	LATE<6> data output.
P1B/CCP6		1	I	ST	PORTE<6> data input.
	COM3	х	0	ANA	LCD Common 3 output; disables all other outputs.
	P1B	0	0	—	ECCP1 PWM Output B. May be configured for tri-state during Enhanced PWM shutdown events.
	CCP6	0	0	DIG	CCP6 Compare/PWM output. Takes priority over port data.
		1	I	ST	CCP9 capture input.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

查询PIC18F67K90供应商 TABLE 11-10: PORTE FUNCTIONS (CONTINUED)

Pin Name	Function	TRIS Setting	I/O	l/O Type	Description
RE7/ECCP2/	RE7	0	0	DIG	LATE<7> data output.
P2A/SEG31		1	Ι	ST	PORTE<7> data input.
	ECCP2 ⁽¹⁾	0	0	DIG	ECCP2 compare/PWM output; takes priority over port data.
		1	Ι	ST	ECCP2 capture input.
	P2A	0	0	—	ECCP2 PWM Output A. May be configured for tri-state during Enhanced PWM shutdown event.
	SEG31	1	0	ANA	Segment 31 analog output for LCD; disables digital output.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

x = Don't care (TRIS bit does not affect port direction or is overridden for this option). Note 1: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

TABLE 11-11: SUMMARY OF REGISTERS ASSOCIATED WITH PORTE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTE	RE7	RE6	RE5	RE4	RE3	RE2	RE1	RE0	76
LATE	LATE7	LATE6	LATE5	LATE4	LATE3	LATE2	LATE1	LATE0	76
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	76
LCDCON	LCDEN	SLPEN	WERR	—	CS1	CS0	LMUX1	LMUX0	81
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	81
ODCON1	SSP10D	CCP2OD	CCP10D	_	_	—	—	SSP2OD	79
ODCON2	CCP10OD	CCP90D	CCP8OD	CCP7OD	CCP6OD	CCP5OD	CCP4OD	CCP3OD	79
PADCFG1	RDPU	REPU	RJPU ⁽¹⁾	—	—	RTSECSEL1	RTSECSEL0	_	78

Legend: Shaded cells are not used by PORTE.

Note 1: Not available on 64-pin devices.

查询PIC18F67K90供应商

11.7 PORTF, LATF and TRISF Registers

PORTF is a 7-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISF and LATF. All pins on PORTF are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

PORTF is multiplexed with analog peripheral functions, as well as LCD segments. Pins, RF1 through RF6, may be used as comparator inputs or outputs by setting the appropriate bits in the CMCON register. To use RF<7:1> as digital inputs, it is also necessary to turn off the comparators.

- **Note 1:** On device Resets, pins, RF<7:1>, are configured as analog inputs and are read as '0'.
 - 2: To configure PORTF as a digital I/O, turn off the comparators and clear ANCON1 and ANCON2 to digital.

PORTF is also multiplexed with LCD segment drives controlled by bits in the LCDSE2 and LCDSE3 registers. I/O port functions are only available when the segments are disabled.

EXAMPLE 11-6: INITIALIZING PORTF

	-	
CLRF	PORTF	; Initialize PORTF by
		; clearing output
		; data latches
CLRF	LATF	; Alternate method
		; to clear output
		; data latches
BANKSEL	ANCON1	
MOVLW	01Fh	; Make AN6, AN7 and AN5 digital
MOVWF	ANCON1	;
MOVLW	0F0h	; Make AN8, AN9, AN10 and AN11
		digital
MOVWF	ANCON2	; Set PORTF as digital I/O
MOVLW	0CEh	; Value used to
		; initialize data
		; direction
MOVWF	TRISF	; Set RF3:RF1 as inputs
		; RF5:RF4 as outputs
		; RF7:RF6 as inputs

查询PIC18F67K90供应商 TABLE 11-12: PORTF FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	l/O Type	Description				
RF1/AN6/C2OUT/	RF1	0	0	DIG	LATF<1> data output; not affected by analog input.				
SEG19/CTDIN		1	Ι	ST	PORTF<1> data input; disabled when analog input is enabled.				
	AN6	1	Ι	ANA	A/D Input Channel 6. Default configuration on POR.				
	C2OUT	0	0	DIG	Comparator 2 output; takes priority over port data.				
	SEG19	1	0	ANA	LCD Segment 19 output; disables all other pin functions.				
	CTDIN	1	Ι	ST	CTMU pulse delay input.				
RF2/AN7/C1OUT/	RF2	0	0	DIG	LATF<2> data output; not affected by analog input.				
SEG20		1		ST	PORTF<2> data input; disabled when analog input is enabled.				
	AN7	1	Ι	ANA	A/D Input Channel 7. Default configuration on POR.				
	C10UT	0	0	DIG	DIG Comparator 1 output; takes priority over port data.				
	SEG20	1	0	ANA	LCD Segment 20 output; disables all other pin functions.				
RF3/AN8/SEG21/	RF3	0	0	DIG	LATF<3> data output; not affected by analog input.				
C2INB/CTMUI		1	Ι	ST	PORTF<3> data input; disabled when analog input is enabled.				
	AN8	1	I	ANA	A/D Input Channel 8 and Comparator C2+ input. Default input configuration on POR; not affected by analog output.				
	SEG21	1	0	ANA	LCD Segment 21 output; disables all other pin functions.				
	C2INB	1	Ι	ANA	Comparator 2 Input B.				
	CTMUI	x	0	_	CTMU pulse generator charger for the C2INB comparator input.				
RF4/AN9/SEG22/	RF4	0	0	DIG	LATF<4> data output; not affected by analog input.				
C2INA		1	Ι	ST	PORTF<4> data input; disabled when analog input is enabled.				
	AN9	1	Ι	ANA	A/D Input Channel 9 and Comparator C2- input. Default input configuration on POR; does not affect digital output.				
	SEG22	1	0	ANA	LCD Segment 22 output; disables all other pin functions.				
	C2INA	1	I	ANA	Comparator 2 Input A.				
RF5/AN10/CVREF/ SEG23/C1INB	RF5	0	0	DIG	LATF<5> data output; not affected by analog input. Disabled when CVREF output is enabled.				
		1	I	ST	PORTF<5> data input; disabled when analog input is enabled. Disabled when CVREF output is enabled.				
	AN10	1	I	ANA	A/D Input Channel 10 and Comparator C1+ input. Default input configuration on POR.				
	CVREF	х	0	ANA	Comparator voltage reference output. Enabling this feature disables digital I/O.				
	SEG23	1	0	ANA	LCD Segment 23 output; disables all other pin functions.				
	C1INB	1	Ι	ANA	Comparator 1 Input B.				
RF6/AN11/SEG24/	RF6	0	0	DIG	LATF<6> data output; not affected by analog input.				
C1INA		1	I	ST	PORTF<6> data input; disabled when analog input is enabled.				
	AN11	1	Ι	ANA	A/D Input Channel 11 and Comparator C1- input. Default input configuration on POR; does not affect digital output.				
	SEG24	1	0	ANA	LCD Segment 24 output; disables all other pin functions.				
	C1INA	1	Ι	ANA	Comparator 1 Input A.				
RF7/AN5/SS1/	RF7	0	0	DIG	LATF<7> data output; not affected by analog input.				
SEG25		1	I	ST	PORTF<7> data input; disabled when analog input is enabled.				
	AN5	1	I	ANA	A/D Input Channel 5. Default configuration on POR.				
	SS1	1	I	TTL	Slave select input for MSSP module.				
	SEG25	1	0	ANA	LCD Segment 25 output; disables all other pin functions.				

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

查询PIC18F67K90供应商 TABLE 11-13: SUMMARY OF REGISTERS ASSOCIATED WITH PORTF

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1		76
LATF	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1		76
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	76
ANCON0	ANSEL7	ANSEL6	ANSEL5	ANSEL4	ANSEL3	ANSEL2	ANSEL1	ANSEL0	79
ANCON1	ANSEL15	ANSEL14	ANSEL13	ANSEL12	ANSEL11	ANSEL10	ANSEL9	ANSEL8	79
CMSTAT	CMP3OUT	CMP2OUT	CMP1OUT	_	—	—	_	_	75
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	75
LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	81
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	81

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTF.

查询PIC18F67K90供应商 11.8 PORTG, TRISG and LATG Registers

PORTG is a 5-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISG and LATG.

PORTG is multiplexed with EUSART, LCD and CCP/ECCP/Analog/Comparator/RTCC/Timer input functions (Table 11-14). When operating as I/O, all PORTG pins have Schmitt Trigger input buffers. The open-drain functionality for the CCPx and UART can be configured using ODCONx.

RG4 is multiplexed with LCD segment drives controlled by bits in the LCDSE2 register and as the RG4/SEG26/RTCC/T7XKI/T5G/CCP5/AN16/P1D/C3INC pin. The I/O port function is only available when the segments are disabled.

The RG5 pin is multiplexed with the MCLR pin and is available only as an input port. To configure this port for input only, set the MCLRE pin (CONFIG3H<7>).

When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTG pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. The user should refer to the corresponding peripheral section for the correct TRIS bit settings. The pin override value is not loaded into the TRIS register. This allows read-modify-write of the TRIS register without concern due to peripheral overrides.

EXAMPLE 11-7: INITIALIZING PORTG

(CLRF	PORTG	; Initialize PORTG by ; clearing output ; data latches
1	BCF	CM1CON, CON	; disable
			; comparator 1
(CLRF	LATG	; Alternate method
			; to clear output
			; data latches
]	BANKSEL	ANCON2	
I	MOVLW	0F0h	; make AN16 to AN19
			; digital
I	MOVWF	ANCON2	
I	MOVLW	04h	; Value used to
			; initialize data
			; direction
I	MOVWF	TRISG	; Set RG1:RG0 as
			; outputs
			; RG2 as input
			; RG4:RG3 as inputs

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RG0/ECCP3/	RG0	0	0	DIG	LATG<0> data output.
P3A		1	I	ST	PORTG<0> data input.
	ECCP3	0	0	DIG	ECCP3 compare output and ECCP3 PWM output. Takes priority over port data.
		1	Ι	ST	ECCP3 capture input.
	P3A	0	0	—	ECCP3 PWM Output A. May be configured for tri-state during Enhanced PWM shutdown events.
RG1/TX2/CK2/	RG1	0	0	DIG	LATG<1> data output.
AN19/C3OUT		1	Ι	ST	PORTG<1> data input.
	TX2	1	0	DIG	Synchronous serial data output (EUSART module); takes priority over port data.
	CK2	1	0	DIG	Synchronous serial data input (EUSART module); user must configure as an input.
		1	I	ST	Synchronous serial clock input (EUSART module).
	AN19			ANA	A/D Input Channel 19. Default input configuration on POR. Does not affect digital output.
	C3OUT	x	0	DIG	Comparator 3 output.

TABLE 11-14: PORTG FUNCTIONS

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

 \mathbf{x} = Don't care (TRIS bit does not affect port direction or is overridden for this option).

查询PIC18F67K90供应商 TABLE 11-14: PORTG FUNCTIONS (CONTINUED)

Pin Name	Function	TRIS Setting	I/O	l/O Type	Description
RG2/RX2/DT2/	RG2	0	0	DIG	LATG<2> data output.
AN18/C3INA		1	I	ST	PORTG<2> data input.
	RX2	1	Ι	ST	Asynchronous serial receive data input (EUSART module).
·	DT2	1	0	DIG	Synchronous serial data output (EUSART module); takes priority over port data.
		1	I	ST	Synchronous serial data input (EUSART module); user must configure as an input.
	AN18	1	I	ANA	A/D Input Channel 18. Default input configuration on POR. Does not affect digital output.
	C3INA	x	Ι	ANA	Comparator 3 Input A.
RG3/CCP4/AN17/	RG3	0	0	DIG	LATG<3> data output.
P3D/C3INB		1	Ι	ST	PORTG<3> data input.
	CCP4	0	0	DIG	CCP4 compare/PWM output. Takes priority over port data.
		1	Ι	ST	CCP4 capture input.
	AN17	1	Ι	ANA	A/D Input Channel 17. Default input configuration on PR. Does not affect digital output.
	C3INB	x	I	ANA	Comparator 3 Input B.
	P3D	0	0	—	ECCP3 PWM Output D. May be configured for tri-state during Enhanced PWM.
RG4/SEG26/	RG4	0	0	DIG	LATG<4> data output.
RTCC/T7CKI/		1	Ι	ST	PORTG<4> data input.
T5G/CCP5/ AN16/P1D/	SEG26	1	0	ANA	LCD Segment 26 output; disables all other pin functions.
C3INC	RTCC	x	0	DIG	RTCC output.
	T7CKI	x	-	ST	Timer7 clock input.
	T5G	х	-	ST	Timer5 external clock gate input.
	CCP5	0	0	DIG	CCP5 compare/PWM output. Takes priority over port data.
		1	Ι	ST	CCP5 capture input.
	AN16	1	Ι	ANA	A/D Input Channel 17. Default input configuration on POR. Does not affect digital output.
	C3INC	x	I	ANA	Comparator 3 Input C.
	P1D	0	0	—	ECCP1 PWM Output D. May be configured for tri-state during Enhanced PWM.
RG5			Ι	ST	See the MCLR/RG5 pin.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input,

x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 11-15: SUMMARY OF REGISTERS ASSOCIATED WITH PORTG

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTG	—	—	RG5 ⁽¹⁾	RG4	RG3	RG2	RG1	RG0	76
TRISG	—	—	—	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	76
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	81
ANCON2	ANSEL23	ANSEL22	ANSEL21	ANSEL20	ANSEL19	ANSEL18	ANSEL17	ANSEL16	79
ODCON1	SSP10D	CCP2OD	CCP10D	—	—	_	_	SSP2OD	79
ODCON2	CCP100D	CCP90D	CCP8OD	CCP7OD	CCP6OD	CCP5OD	CCP4OD	CCP3OD	79
			(· · · · ·						

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTG.

Note 1: Bit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, the bit is unimplemented.

查询PIC18F67K90供应商 11.9 PORTH, LATH and

TRISH Registers

Note:	PORTH is	available	only	on	the	80-pin
	devices.					

PORTH is an 8-bit wide, bidirectional I/O port. The corresponding Data Direction and Output Latch registers are TRISH and LATH.

All pins on PORTH are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

All PORTH pins are multiplexed with the ADC/CCP/Comparator and LCD segment drives controlled by the LCDSE5 register. I/O port functions are only available when the segments are disabled.

EXAMPLE 11-8: INITIALIZING PORTH

CLRF	PORTH	;	Initialize PORTH by
		;	clearing output
		;	data latches
CLRF	LATH	;	Alternate method
		;	to clear output
		;	data latches
BANKSEL	ANCON2		
MOVLW	0Fh	;	Configure PORTH as
MOVWF	ANCON2	;	digital I/O
MOVLW	0Fh	;	Configure PORTH as
MOVWF	ANCON1	;	digital I/O
MOVLW	0CFh	;	Value used to
		;	initialize data
		;	direction
MOVWF	TRISH	;	Set RH3:RH0 as inputs
		;	RH5:RH4 as outputs
		;	RH7:RH6 as inputs
			_

查询PIC18F67K90供应商

TABLE 11-16: PORTH FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	l/O Type	Description
RH0/SEG47/	RH0	0	0	DIG	LATH<0> data output.
AN23		1	Ι	ST	PORTH<0> data input.
	SEG47	1	0	ANA	LCD Segment 47 output; disables all other pin functions.
	AN23	1	Ι	ANA	A/D Input Channel 23. Default input configuration on POR. Does not affect digital input.
RH1/SEG46/	RH1	0	0	DIG	LATH<1> data output.
AN22		1	I	ST	PORTH<1> data input.
	SEG46	1	0	ANA	LCD Segment 46 output; disables all other pin functions.
	AN22	1	I	ANA	A/D Input Channel 22. Default input configuration on POR. Does not affect digital input.
RH2/SEG45/	RH2	0	0	DIG	LATH<2> data output.
AN21		1	Ι	ST	PORTH<2> data input.
	SEG45	1	0	ANA	LCD Segment 45 output; disables all other pin functions.
	AN21	1	Ι	ANA	A/D Input Channel 21. Default input configuration on POR. Does not affect digital input.
RH3/SEG44/	RH3	0	0	DIG	LATH<3> data output.
AN20		1	I	ST	PORTH<3> data input.
	SEG44	1	0	ANA	LCD Segment 44 output; disables all other pin functions.
	AN20	1	Ι	ANA	A/D Input Channel 20. Default input configuration on POR. Does not affect digital input.
RH4/SEG40/	RH4	0	0	DIG	LATH<4> data output.
CCP9/P3C/		1	I	ST	PORTH<4> data input.
AN12/C2INC	SEG40	1	0	ANA	LCD Segment 40 output; disables all other pin functions.
	CCP9	0	0	DIG	CCP9 compare/PWM output. Takes priority over port data.
		1	I	ST	CCP9 capture input.
	P3C	0	0	_	ECCP3 PWM Output C. May be configured for tri-state during Enhanced PWM.
	AN12	1	Ι	ANA	A/D Input Channel 12. Default input configuration on POR. Does not affect digital input.
	C2INC	x	I	ANA	Comparator 2 Input C.
RH5/SEG41/	RH5	0	0	DIG	LATH<5> data output.
CCP8/P3B/		1	I	ST	PORTH<5> data input.
AN13/C2IND	SEG41	1	0	ANA	LCD Segment 41 output; disables all other pin functions.
	CCP8	0	0	DIG	CCP8 compare/PWM output. Takes priority over port data.
		1	I	ST	CCP8 capture input.
	P3B	0	0	—	ECCP3 PWM Output B. May be configured for tri-state during Enhanced PWM.
	AN13	1	I	ANA	A/D Input Channel 13. Default input configuration on POR. Does not affect digital input.
	C2IND	x	1	ANA	Comparator 2 Input D.

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

查询PIC18F67K90供应商 TABLE 11-16: PORTH FUNCTIONS (CONTINUED)

Pin Name	Function	TRIS Setting	I/O	l/O Type	Description				
RH6/SEG42/	RH6	0	0	DIG	LATH<6> data output.				
CCP7/P1C/		1	I	ST	PORTH<6> data input.				
AN14/C1INC	SEG42	1	0	ANA	LCD Segment 42 output; disables all other pin functions.				
	CCP7	0	0	DIG	CCP7 compare/PWM output. Takes priority over port data.				
		1	I	ST	CCP7 capture input.				
	P1C	0	0		ECCP1 PWM Output C. May be configured for tri-state during Enhanced PWM.				
	AN14	1	I	ANA	A/D Input Channel 14. Default input configuration on POR. Does not affect digital input.				
	C1INC	x	Ι	ANA	Comparator 1 Input C.				
RH7/SEG43/	RH7	0	0	DIG	LATH<7> data output.				
CCP6/P1B/		1	I	ST	PORTH<7> data input.				
AN15	SEG43	1	0	ANA	LCD Segment 43 output; disables all other pin functions.				
	CCP6	0	0	DIG	CCP6 compare/PWM output. Takes priority over port data.				
		1	I	ST	CCP6 capture input.				
	P1B	0	0	—	ECCP1 PWM Output B. May be configured for tri-state during Enhanced PWM.				
	AN15	1	Ι	ANA	A/D Input Channel 15. Default input configuration on POR. Does not affect digital input.				

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 11-17:	SUMMARY OF REGISTERS ASSOCIATED WITH PORTH
--------------	--

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTH	RH7	RH6	RH5	RH4	RH3	RH2	RH1	RH0	76
LATH	LATH7	LATH6	LATH5	LATH4	LATH3	LATH2	LATH1	LATH0	76
TRISH	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	76
LCDSE5	SE47	SE46	SE45	SE44	SE43	SE42	SE41	SE40	81
ANCON1	ANSEL15	ANSEL14	ANSEL13	ANSEL12	ANSEL11	ANSEL10	ANSEL9	ANSEL8	79
ANCON2	ANSEL23	ANSEL22	ANSEL21	ANSEL20	ANSEL19	ANSEL18	ANSEL17	ANSEL16	79
ODCON2	CCP100D	CCP90D	CCP8OD	CCP7OD	CCP6OD	CCP50D	CCP4OD	CCP3OD	79

<u>查询PIC18F67K90供应商</u> 11.10 PORTJ, TRISJ and

LATJ Registers

Note: PORTJ is available only on 80-pin devices.

PORTJ is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISJ and LATJ.

All pins on PORTJ are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

Note: These pins are configured as digital inputs on any device Reset.

All PORTJ pins except RJ0 are multiplexed with LCD segment drives controlled by the LCDSE4 register. I/O port functions are only available on these pins when the segments are disabled.

Each of the PORTJ pins has a weak internal pull-up. The pull-ups are provided to keep the inputs at a known state for the external memory interface while powering up. A single control bit can turn off all the pull-ups. This is performed by clearing bit RJPU (PADCFG1<5>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on any device Reset.

EXAMPLE 11-9: INITIALIZING PORTJ

CLRF	PORTJ	; Initialize PORTJ by
		; clearing output latches
CLRF	LATJ	; Alternate method
		; to clear output latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISJ	; Set RJ3:RJ0 as inputs
		; RJ5:RJ4 as output
		; RJ7:RJ6 as inputs

查询PIC18F67K90供应商 TABLE 11-18: PORTJ FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Туре	Description				
RJ0	RJ0	0	0	DIG	LATJ<0> data output.				
		1	I	ST	PORTJ<0> data input.				
RJ1/SEG33	RJ1	0	0	DIG	LATJ<1> data output.				
		1	I	ST	PORTJ<1> data input.				
	SEG33	1	0	ANA	LCD Segment 33 output; disables all other pin functions.				
RJ2/SEG34	RJ2	0	0	DIG	LATJ<2> data output.				
		1	I	ST	PORTJ<2> data input.				
	SEG34	1	0	ANA	LCD Segment 34 output; disables all other pin functions.				
RJ3/SEG35	RJ3	0	0	DIG	LATJ<3> data output.				
		1	I	ST	PORTJ<3> data input.				
	SEG35	1	0	ANA	LCD Segment 35 output; disables all other pin functions.				
RJ4/SEG39	RJ4	0	0	DIG	LATJ<4> data output.				
		1	I	ST	PORTJ<4> data input.				
	SEG39	1	0	ANA	LCD Segment 39 output; disables all other pin functions.				
RJ5/SEG38	RJ5	0	0	DIG	LATJ<5> data output.				
		1	I	ST	PORTJ<5> data input.				
	SEG38	1	0	ANA	LCD Segment 38 output; disables all other pin functions.				
RJ6/SEG37	RJ6	0	0	DIG	LATJ<6> data output.				
		1	I	ST	PORTJ<6> data input.				
	SEG37	1	0	ANA	LCD Segment 37 output; disables all other pin functions.				
RJ7/SEG36	RJ7	0	0	DIG	LATJ<7> data output.				
		1	I	ST	PORTJ<7> data input.				
	SEG36	1	0	ANA	LCD Segment 36 output; disables all other pin functions.				

Legend: O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Trigger Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 11-19:	SUMMARY OF REGISTERS ASSOCIATED WITH PORTJ
--------------	--

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTJ	RJ7	RJ6	RJ5	RJ4	RJ3	RJ2	RJ1	RJ0	76
LATJ	LATJ7	LATJ6	LATJ5	LATJ4	LATJ3	LATJ2	LATJ1	LATJ0	76
TRISJ	TRISJ7	TRISJ6	TRISJ5	TRISJ4	TRISJ3	TRISJ2	TRISJ1	TRISJ0	76
LCDSE4	SE39	SE38	SE37	SE36	SE35	SE34	SE33	SE32	81
PADCFG1	RDPU	REPU	RJPU ⁽¹⁾	—	—	RTSECSEL1	RTSECSEL0	_	78

Legend: Shaded cells are not used by PORTJ.

Note 1: Unimplemented on PIC18F6XK90 devices, read as '0'.

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商 12.0 TIMER0 MODULE

The Timer0 module incorporates the following features:

- Software-selectable operation as a timer or counter in both 8-bit or 16-bit modes
- · Readable and writable registers
- Dedicated 8-bit, software programmable
 prescaler
- Selectable clock source (internal or external)
- · Edge select for external clock
- Interrupt-on-overflow

The T0CON register (Register 12-1) controls all aspects of the module's operation, including the prescale selection. It is both readable and writable.

Figure 12-1 provides a simplified block diagram of the Timer0 module in 8-bit mode. Figure 12-2 provides a simplified block diagram of the Timer0 module in 16-bit mode.

REGISTER 12-1: TOCON: TIMER0 CONTROL REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
TMR00N	T08BIT	TOCS	T0SE	PSA	T0PS2	T0PS1	T0PS0
bit 7							bit 0

Legend:					
R = Reada	ble bit	W = Writable bit	U = Unimplemented bit,	read as '0'	
-n = Value	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	
bit 7		: Timer0 On/Off Control bit			
		les Timer0			
	0 = Stops	Timer0			
bit 6	T08BIT: T	imer0 8-Bit/16-Bit Control bi	t		
		0 is configured as an 8-bit ti			
	0 = Timer	0 is configured as a 16-bit til	mer/counter		
bit 5	TOCS: Tir	TOCS: Timer0 Clock Source Select bit			
		ition on T0CKI pin input edg	e		
	0 = Intern	al clock (Fosc/4)			
bit 4	TOSE: Tir	ner0 Source Edge Select bit			
		ment on high-to-low transition	•		
	0 = Increr	ment on low-to-high transition	n on the T0CKI pin		
bit 3	PSA: Tim	er0 Prescaler Assignment bi	it		
			Timer0 clock input bypasses the	•	
	0 = Timer	0 prescaler is assigned; Tim	er0 clock input comes from the	e prescaler output	
bit 2-0	T0PS<2:0	0> : Timer0 Prescaler Select	bits		
		256 Prescale value			
		28 Prescale value			
		4 Prescale value			
		2 Prescale value 6 Prescale value			
		Prescale value			
		Prescale value			
	••	Prescale value			

查询PIC18F67K90供应商 12.1 Timer0 Operation

Timer0 can operate as either a timer or a counter. The mode is selected with the TOCS bit (TOCON<5>). In Timer mode (TOCS = 0), the module increments on every clock by default unless a different prescaler value is selected (see **Section 12.3 "Prescaler"**). If the TMR0 register is written to, the increment is inhibited for the following two instruction cycles. The user can work around this by writing an adjusted value to the TMR0 register.

The Counter mode is selected by setting the T0CS bit (= 1). In this mode, Timer0 increments either on every rising edge or falling edge of the T0CKI pin. The incrementing edge is determined by the Timer0 Source Edge Select bit, T0SE (T0CON<4>); clearing this bit selects the rising edge. Restrictions on the external clock input are discussed below.

An external clock source can be used to drive Timer0; however, it must meet certain requirements to ensure that the external clock can be synchronized with the internal phase clock (Tosc). There is a delay between synchronization and the onset of incrementing the timer/counter.

12.2 Timer0 Reads and Writes in 16-Bit Mode

TMR0H is not the actual high byte of Timer0 in 16-bit mode. It is actually a buffered version of the real high byte of Timer0, which is not directly readable nor writable. (See Figure 12-2.) TMR0H is updated with the contents of the high byte of Timer0 during a read of TMR0L. This provides the ability to read all 16 bits of Timer0 without having to verify that the read of the high and low byte were valid, due to a rollover between successive reads of the high and low byte.

Similarly, a write to the high byte of Timer0 must also take place through the TMR0H Buffer register. The high byte is updated with the contents of TMR0H when a write occurs to TMR0L. This allows all 16 bits of Timer0 to be updated at once.

FIGURE 12-1: TIMER0 BLOCK DIAGRAM (8-BIT MODE)

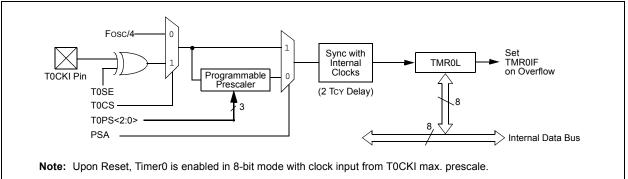
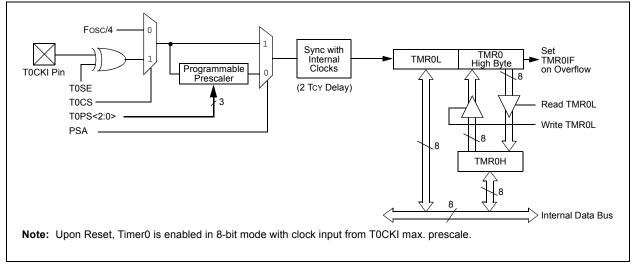


FIGURE 12-2: TIMER0 BLOCK DIAGRAM (16-BIT MODE)



查询PIC18F67K90供应商 12.3 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module. The prescaler is not directly readable or writable. Its value is set by the PSA and T0PS<2:0> bits (T0CON<3:0>), which determine the prescaler assignment and prescale ratio.

Clearing the PSA bit assigns the prescaler to the Timer0 module. When it is assigned, prescale values from 1:2 through 1:256 in power-of-two increments are selectable.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (for example, CLRF TMR0, MOVWF TMR0, BSF TMR0) clear the prescaler count.

Note: Writing to TMR0 when the prescaler is assigned to Timer0 will clear the prescaler count but will not change the prescaler assignment.

12.3.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control and can be changed "on-the-fly" during program execution.

12.4 Timer0 Interrupt

The TMR0 interrupt is generated when the TMR0 register overflows from FFh to 00h in 8-bit mode, or from FFFFh to 0000h in 16-bit mode. This overflow sets the TMR0IF flag bit. The interrupt can be masked by clearing the TMR0IE bit (INTCON<5>). Before reenabling the interrupt, the TMR0IF bit must be cleared in software by the Interrupt Service Routine (ISR).

Since Timer0 is shut down in Sleep mode, the TMR0 interrupt cannot awaken the processor from Sleep.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
TMR0L	Timer0 Reg	Timer0 Register Low Byte					74		
TMR0H	Timer0 Register High Byte					74			
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
T0CON	TMR0ON	T08BIT	TOCS	TOSE	PSA	T0PS2	T0PS1	T0PS0	74

 TABLE 12-1:
 REGISTERS ASSOCIATED WITH TIMER0

Legend: — = unimplemented, read as '0'. Shaded cells are not used by Timer0.

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商

13.0 TIMER1 MODULE

The Timer1 timer/counter module incorporates these features:

- Software-selectable operation as a 16-bit timer or counter
- Readable and writable 8-bit registers (TMR1H and TMR1L)
- Selectable clock source (internal or external) with device clock or SOSC oscillator internal options
- Interrupt-on-overflow
- Reset on ECCP Special Event Trigger
- Timer with gated control

Figure 13-1 displays a simplified block diagram of the Timer1 module.

The SOSC oscillator can also be used as a low-power clock source for the microcontroller in power-managed operation. Timer1 can also work on the SOSC oscillator.

Timer1 is controlled through the T1CON Control register (Register 13-1). It also contains the SOSC Oscillator Enable bit (SOSCEN). Timer1 can be enabled or disabled by setting or clearing control bit, TMR1ON (T1CON<0>).

The FOSC clock source should not be used with the ECCP capture/compare features. If the timer will be used with the capture or compare features, always select one of the other timer clocking options.

REGISTER 13-1: T1CON: TIMER1 CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
TMR1CS1	TMR1CS0	T1CKPS1	T1CKPS0	SOSCEN	T1SYNC	RD16	TMR10N
bit 7							bit 0

Legend:				
R = Reada	ble bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR '1' = Bit is set		'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
bit 7-6	10 = The <u>SO</u> Ext <u>SO</u> Cry SO 01 = Time	<u>SCEN = 0:</u> ernal clock is from the T1CKI <u>SCEN = 1:</u>	er a pin or an oscillator depend I pin (on the rising edge). SCI/SOSCO pins or an extended on clock (Fosc) ⁽¹⁾	ding on the SOSCEN bit. ded clock on SCKLI (depends or
bit 5-4	11 = 1:8 F 10 = 1:4 F 01 = 1:2 F	:1:0>: Timer1 Input Clock Pro Prescale value Prescale value Prescale value Prescale value Prescale value	escale Select bits	
bit 3	SOSCEN: SOSC Oscillator Enable bit 1 = SOSC is enabled for Timer1 (based on SOSCSEL fuses) 0 = SOSC is disabled for Timer1 The oscillator inverter and feedback resistor are turned off to eliminate power drain.			
bit 2	TISYNC: Timer1 External Clock Input Synchronization Select bit <u>TMR1CS<1:0> = 10:</u> 1 = Do not synchronize the external clock input 0 = Synchronize the external clock input <u>TMR1CS<1:0> = 0x:</u> This bit is ignored. Timer1 uses the internal clock when TMR1CS<1:0> = 1x.			
bit 1	RD16: 16 1 = Enab	-Bit Read/Write Mode Enable les register read/write of Tim les register read/write of Tim	e bit er1 in one 16-bit operation	
bit 0	-	: Timer1 On bit les Timer1 s Timer1		

Note 1: The Fosc clock source should not be selected if the timer will be used with the ECCP capture/compare features.

查询PIC18F67K90供应商

13.1 Timer1 Gate Control Register

The Timer1 Gate Control register (T1GCON), displayed in Register 13-2, is used to control the Timer1 gate.

REGISTER 13-2: T1GCON: TIMER1 GATE CONTROL REGISTER⁽¹⁾

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-x	R/W-0	R/W-0
TMR1GE	T1GPOL	T1GTM	T1GSPM	T1GGO/T1DONE	T1GVAL	T1GSS1	T1GSS0
bit 7							bit 0
							
Legend:							
R = Readab		W = Writable		U = Unimplemented	d bit, read as		
-n = Value a	t POR	'1' = Bit is se		'0' = Bit is cleared		x = Bit is unkn	own
bit 7	TMR1GE: T	imer1 Gate Ena	able bit				
	If TMR10N	<u>= 0</u> :					
	This bit is ig	nored.					
	If TMR10N						
				Timer1 gate function er1 gate function			
bit 6		mer1 Gate Pol		ser gate randaat			
				ounts when gate is hi	gh)		
	0 = Timer1 gate is active-low (Timer1 counts when gate is low)						
bit 5	T1GTM: Tim	ner1 Gate Togg	le Mode bit				
		Gate Toggle m					
		flip-flop toggle m		d and toggle flip-flop ing edge.	is cleared		
bit 4	-	imer1 Gate Sin	-				
	1 = Timer1 (Gate Single Pu	se mode is e	nabled and is controll	ing Timer1 ga	ate	
	0 = Timer1 (Gate Single Pu	se mode is di	sabled			
bit 3	T1GGO/T1D	ONE: Timer1	Gate Single F	ulse Acquisition State	us bit		
				is ready, waiting for a		o sto d	
				has completed or ha GSPM is cleared.	is not been st	aneo	
bit 2		mer1 Gate Cur					
	Indicates the current state of the Timer1 gate that could be provided to TMR1H:TMR1L; unaffected					unaffected by	
	the Timer1 Gate Enable (TMR1GE) bit.						
bit 1-0		: Timer1 Gate	Source Sele	ct bits			
	11 = Comparator 2 output 10 = Comparator 1 output						
		to match PR2 o	outout				
	00 = Timer1						
Note 1: D				is recommended			

Note 1: Programming the T1GCON prior to T1CON is recommended.

查询PIC18F67K90供应商

13.2 Timer1 Operation

The Timer1 module is an 8 or 16-bit incrementing counter that is accessed through the TMR1H:TMR1L register pair.

When used with an internal clock source, the module is a timer and increments on every instruction cycle. When used with an external clock source, the module can be used as either a timer or counter. It increments on every selected edge of the external source.

Timer1 is enabled by configuring the TMR1ON and TMR1GE bits in the T1CON and T1GCON registers, respectively.

When SOSC is selected as a Crystal mode (by SOSCEL), the RC1/SOSCI/ECCP2/P2A/SEG32 and RC0/SOSCO/SCLKI pins become inputs. This means the values of TRISC<1:0> are ignored and the pins are read as '0'.

13.3 Clock Source Selection

The TMR1CS<1:0> and SOSCEN bits of the T1CON register are used to select the clock source for Timer1. Register 13-1 displays the clock source selections.

13.3.1 INTERNAL CLOCK SOURCE

When the internal clock source is selected, the TMR1H:TMR1L register pair will increment on multiples of Fosc as determined by the Timer1 prescaler.

13.3.2 EXTERNAL CLOCK SOURCE

When the external clock source is selected, the Timer1 module may work as a timer or a counter.

When enabled to count, Timer1 is incremented on the rising edge of the external clock input, T1CKI. Either of these external clock sources can be synchronized to the microcontroller system clock or they can run asynchronously.

When used as a timer with a clock oscillator, an external, 32.768 kHz crystal can be used in conjunction with the dedicated internal oscillator circuit.

Note:	In Counter mode, a falling edge must be registered by the counter prior to the first
	incrementing rising edge after any one or more of the following conditions:

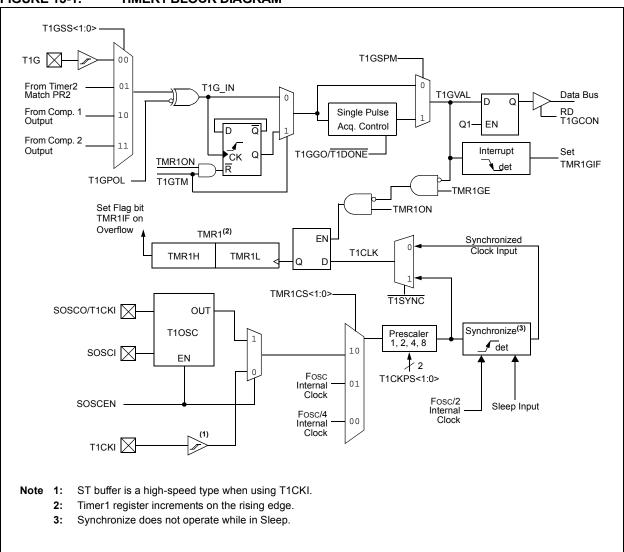
• Timer1 is enabled after a POR Reset

- Write to TMR1H or TMR1L
- Timer1 is disabled
- Timer1 is disabled (TMR1ON = 0)

When T1CKI is high, Timer1 is enabled (TMR1ON = 1) when T1CKI is low.

TMR1CS1	TMR1CS0	SOSCEN	Clock Source
0	1	х	Clock Source (Fosc)
0	0	х	Instruction Clock (Fosc/4)
1	0	0	External Clock on T1CKI Pin
1	0	1	Oscillator Circuit on SOSCI/SOSCO Pins

查询PIC18F67K90供应商 FIGURE 13-1: TIMER1 BLOCK DIAGRAM



查询PIC18F67K90供应商 13.4 Timer1 16-Bit Read/Write Mode

Timer1 can be configured for 16-bit reads and writes. When the RD16 control bit (T1CON<1>) is set, the address for TMR1H is mapped to a buffer register for the high byte of Timer1. A read from TMR1L loads the contents of the high byte of Timer1 into the Timer1 High Byte Buffer register. This provides the user with the ability to accurately read all 16 bits of Timer1 without having to determine whether a read of the high byte, followed by a read of the low byte, has become invalid due to a rollover between reads.

A write to the high byte of Timer1 must also take place through the TMR1H Buffer register. The Timer1 high byte is updated with the contents of TMR1H when a write occurs to TMR1L. This allows a user to write all 16 bits at once to both the high and low bytes of Timer1.

The high byte of Timer1 is not directly readable or writable in this mode. All reads and writes must take place through the Timer1 High Byte Buffer register. Writes to TMR1H do not clear the Timer1 prescaler. The prescaler is only cleared on writes to TMR1L.

13.5 SOSC Oscillator

An on-chip crystal oscillator circuit is incorporated between pins, SOSCI (input) and SOSCO (amplifier output). It is enabled by setting one of five bits: any of the four SOSCEN bits in the TxCON registers (TxCON<3>) or the SOSCGO bit in the OSCCON2 register (OSCCON2<3>). The oscillator is a low-power circuit rated for 32 kHz crystals. It will continue to run during all power-managed modes. The circuit for a typical LP oscillator is depicted in Figure 13-2. Table 13-2 provides the capacitor selection for the SOSC oscillator.

The user must provide a software time delay to ensure proper start-up of the SOSC oscillator.

FIGURE 13-2: EXTERNAL COMPONENTS FOR THE SOSC OSCILLATOR

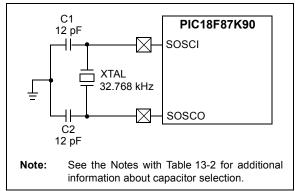


TABLE 13-2: CAPACITOR SELECTION FOR THE TIMER OSCILLATOR^(2,3,4,5)

Oscillator Type	Freq.	C1	C2	
LP	32 kHz	12 pF ⁽¹⁾	12 pF ⁽¹⁾	

- Note 1: Microchip suggests these values as a starting point in validating the oscillator circuit.
 - 2: Higher capacitance increases the stability of the oscillator, but also increases the start-up time.
 - 3: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
 - 4: Capacitor values are for design guidance only. Values listed would be typical of a CL = 10 pF rated crystal, when SOSCSEL = 11.
 - Incorrect capacitance value may result in a frequency not meeting the crystal manufacturer's tolerance specification.

The SOSC crystal oscillator drive level is determined based on the SOSCSEL (CONFIG1L<4:3>) Configuration bits. The High Drive Level mode, SOSCSEL<1:0> = 11, is intended to drive a wide variety of 32.768 kHz crystals with a variety of load capacitance (CL) ratings.

The Low Drive Level mode is highly optimized for extremely low-power consumption. It is not intended to drive all types of 32.768 kHz crystals. In the Low Drive Level mode, the crystal oscillator circuit may not work correctly if excessively large discrete capacitors are placed on the SOSCO and SOSCI pins. This mode is designed to work only with discrete capacitances of approximately 3 pF-10 pF on each pin.

Crystal manufacturers usually specify a CL (load capacitance) rating for their crystals. This value is related to, but not necessarily the same as, the values that should be used for C1 and C2 in Figure 13-2.

For more details on selecting the optimum C1 and C2 for a given crystal, see the crystal manufacture's applications information. The optimum value depends in part on the amount of parasitic capacitance in the circuit, which is often unknown. For that reason, it is highly recommended that thorough testing and validation of the oscillator be performed after values have been selected.

查询PIC18F67K90供应商 13.5.1 USING SOSC AS A CLOCK SOURCE

The SOSC oscillator is also available as a clock source in power-managed modes. By setting the clock select bits, SCS<1:0> (OSCCON<1:0>), to '01', the device switches to SEC_RUN mode and both the CPU and peripherals are clocked from the SOSC oscillator. If the IDLEN bit (OSCCON<7>) are cleared and a SLEEP instruction is executed, the device enters SEC_IDLE mode. Additional details are available in **Section 4.0 "Power-Managed Modes"**.

Whenever the SOSC oscillator is providing the clock source, the SOSC System Clock Status Flag, SOSCRUN (OSCCON2<6>), is set. This can be used to determine the controller's current clocking mode. It can also indicate the clock source currently being used by the Fail-Safe Clock Monitor.

If the Clock Monitor is enabled and the SOSC oscillator fails while providing the clock, polling the SOCSRUN bit will indicate whether the clock is being provided by the SOSC oscillator or another source.

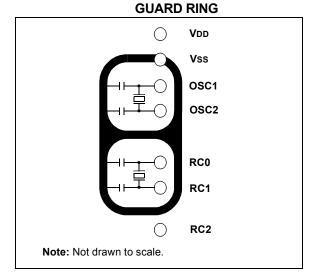
13.5.2 SOSC OSCILLATOR LAYOUT CONSIDERATIONS

The SOSC oscillator circuit draws very little power during operation. Due to the low-power nature of the oscillator, it may also be sensitive to rapidly changing signals in close proximity. This is especially true when the oscillator is configured for extremely low-power mode (CONFIG1L<4:3> (SOSCSEL) = 01).

The oscillator circuit, displayed in Figure 13-2, should be located as close as possible to the microcontroller. There should be no circuits passing within the oscillator circuit boundaries other than VSS or VDD.

If a high-speed circuit must be located near the oscillator, it may help to have a grounded guard ring around the oscillator circuit. The guard, as displayed in Figure 13-3, could be used on a single-sided PCB or in addition to a ground plane. (Examples of a high-speed circuit include the ECCP1 pin, in Output Compare or PWM mode, or the primary oscillator, using the OSC2 pin.)

FIGURE 13-3: OSCILLATOR CIRCUIT WITH GROUNDED



In the Low Drive Level mode, SOSCSEL<1:0> = 01, it is critical that RC2 I/O pin signals be kept away from the oscillator circuit. Configuring RC2 as a digital output, and toggling it, can potentially disturb the oscillator circuit, even with a relatively good PCB layout. If possible, either leave RC2 unused or use it as an input pin with a slew rate limited signal source. If RC2 must be used as a digital output, it may be necessary to use the High Drive Level Oscillator mode (SOSCSEL<1:0> = 11) with many PCB layouts.

Even in the High Drive Level mode, careful layout procedures should still be followed when designing the oscillator circuit.

In addition to dV/dt induced noise considerations, it is important to ensure that the circuit board is clean. Even a very small amount of conductive soldering flux residue can cause PCB leakage currents that can overwhelm the oscillator circuit.

13.6 Timer1 Interrupt

The TMR1 register pair (TMR1H:TMR1L) increments from 0000h to FFFFh and rolls over to 0000h. The Timer1 interrupt, if enabled, is generated on overflow which is latched in interrupt flag bit, TMR1IF (PIR1<0>). This interrupt can be enabled or disabled by setting or clearing the Timer1 Interrupt Enable bit, TMR1IE (PIE1<0>).

查询PIC18F67K90供应商

13.7 Resetting Timer1 Using the ECCP Special Event Trigger

If ECCP modules are configured to use Timer1 and to generate a Special Event Trigger in Compare mode (CCPxM<3:0> = 1011), this signal will reset Timer1. The trigger from ECCP2 will also start an A/D conversion, if the A/D module is enabled. (For more information, see **Section 19.3.4 "Special Event Trigger"**.)

To take advantage of this feature, the module must be configured as either a timer or a synchronous counter. When used this way, the CCPRxH:CCPRxL register pair effectively becomes a period register for Timer1.

If Timer1 is running in Asynchronous Counter mode, this Reset operation may not work.

In the event that a write to Timer1 coincides with a Special Event Trigger, the write operation will take precedence.

Note:	The Special Event Trigger from the
	ECCPx module will only clear the TMR1
	register's content, but not set the TMR1IF
	interrupt flag bit (PIR1<0>).

13.8 Timer1 Gate

Timer1 can be configured to count freely or the count can be enabled and disabled using the Timer1 gate circuitry. This is also referred to as Timer1 gate count enable.

Timer1 gate can also be driven by multiple selectable sources.

13.8.1 TIMER1 GATE COUNT ENABLE

The Timer1 Gate Enable mode is enabled by setting the TMR1GE bit of the T1GCON register. The polarity of the Timer1 Gate Enable mode is configured using the T1GPOL bit (T1GCON<6>).

When Timer1 Gate Enable mode is enabled, Timer1 will increment on the rising edge of the Timer1 clock source. When Timer1 Gate Enable mode is disabled, no incrementing will occur and Timer1 will hold the current count. See Figure 13-4 for timing details.

TABLE 13-3:	TIMER1 GATE ENABLE
	SELECTIONS

T1CLK ^(†)	T1GPOL (T1GCON<6>)	T1G Pin	Timer1 Operation	
\uparrow	0	0	Counts	
\uparrow	0	1	Holds Count	
\uparrow	1	0	Holds Count	
\uparrow	1	1	Counts	

† The clock on which TMR1 is running. For more information, see Figure 13-1.

Note: The CCP and ECCP modules use Timers, 1 through 8, for some modes. The assignment of a particular timer to a CCP/ECCP module is determined by the Timer to CCP enable bits in the CCPTMRSx registers. For more details, see Register 19-2, Register 18-2 and Register 18-3.

13.8.2 TIMER1 GATE SOURCE SELECTION

The Timer1 gate source can be selected from one of four sources. Source selection is controlled by the T1GSSx bits, T1GCON<1:0> (see Table 13-4).

TABLE 13-4:	TIMER1 GATE SOURCES
-------------	---------------------

T1GSS<1:0>	Timer1 Gate Source
00	Timer1 Gate Pin
01	TMR2 to Match PR2 (TMR2 increments to match PR2)
10	Comparator 1 Output (Comparator logic high output)
11	Comparator 2 Output (Comparator logic high output)

The polarity for each available source is also selectable, controlled by the T1GPOL bit (T1GCON<6>).

13.8.2.1 T1G Pin Gate Operation

The T1G pin is one source for Timer1 gate control. It can be used to supply an external source to the Timer1 gate circuitry.

13.8.2.2 Timer2 Match Gate Operation

The TMR2 register will increment until it matches the value in the PR2 register. On the very next increment cycle, TMR2 will be reset to 00h. When this Reset occurs, a low-to-high pulse will automatically be generated and internally supplied to the Timer1 gate circuitry. The pulse will remain high for one instruction cycle and will return back to a low state until the next match.

Depending on T1GPOL, Timer1 increments differently when TMR2 matches PR2. When T1GPOL = 1, Timer1 increments for a single instruction cycle following a TMR2 match with PR2. When T1GPOL = 0, Timer1 increments continuously, except for the cycle following the match, when the gate signal goes from low-to-high.

13.8.2.3 Comparator 1 Output Gate Operation

The output of Comparator 1 can be internally supplied to the Timer1 gate circuitry. After setting up Comparator 1 with the CM1CON register, Timer1 will increment depending on the transition of the CMP1OUT (CMSTAT<5>) bit.

13.8.2.4 Comparator 2 Output Gate Operation

The output of Comparator 2 can be internally supplied to the Timer1 gate circuitry. After setting up Comparator 2 with the CM2CON register, Timer1 will increment depending on the transition of the CMP2OUT (CMSTAT<6>) bit.

查询PIC18F67K90供应商

13.8.3 TIMERI GATE TOGGLE MODE

When Timer1 Gate Toggle mode is enabled, it is possible to measure the full cycle length of a Timer1 gate signal, as opposed to the duration of a single level pulse.

The Timer1 gate source is routed through a flip-flop that changes state on every incrementing edge of the signal. (For timing details, see Figure 13-5.)

The T1GVAL bit (T1GCON<2>) indicates when the Toggled mode is active and the timer is counting.

The Timer1 Gate Toggle mode is enabled by setting the T1GTM bit (T1GCON<5>). When T1GTM is cleared, the flip-flop is cleared and held clear. This is necessary in order to control which edge is measured.

00KE 10-0.		
TMR1GE		
T1GPOL		
T1GTM		
T1G_IN	[
Т1СКІ		
T1GVAL		
Timer1	N	$\sqrt{N+1}$ $\sqrt{N+2}$ $\sqrt{N+3}$ $N+4$ $\sqrt{N+5}$ $\sqrt{N+6}$ $\sqrt{N+7}$ $N+8$

FIGURE 13-5: TIMER1 GATE TOGGLE MODE

查询PIC18F67K90供应商

13.8.4 TIMER1 GATE SINGLE PULSE MODE

When Timer1 Gate Single Pulse mode is enabled, it is possible to capture a single pulse gate event. Timer1 Gate Single Pulse mode is enabled by setting the T1GSPM bit (T1GCON<4>) and the T1GGO/T1DONE bit (T1GCON<3>). The Timer1 will be fully enabled on the next incrementing edge.

On the next trailing edge of the pulse, the T1GGO/ T1DONE bit will automatically be cleared. No other gate events will be allowed to increment Timer1 until the T1GGO/T1DONE bit is once again set in software. Clearing the T1GSPM <u>bit of the</u> T1GCON register will also clear the T1GGO/T1DONE bit. (For timing details, see Figure 13-6.)

Simultaneously enabling the Toggle and Single Pulse modes will permit both sections to work together. This allows the cycle times on the Timer1 gate source to be measured. (For timing details, see Figure 13-7.)

13.8.5 TIMER1 GATE VALUE STATUS

When the Timer1 gate value status is utilized, it is possible to read the most current level of the gate control value. The value is stored in the T1GVAL bit (T1GCON<2>). This bit is valid even when the Timer1 gate is not enabled (TMR1GE bit is cleared).

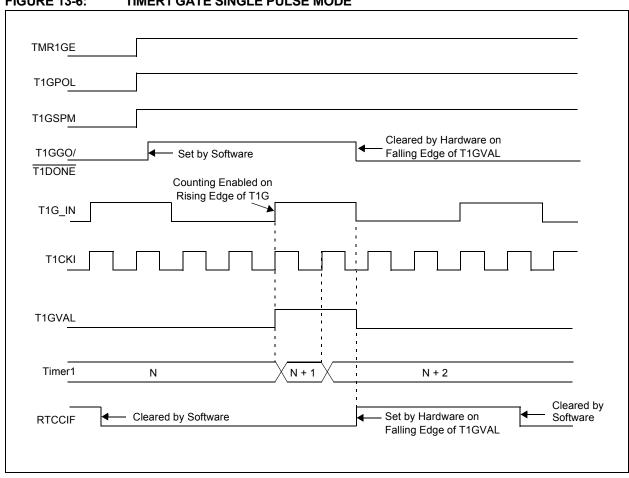


FIGURE 13-6: TIMER1 GATE SINGLE PULSE MODE

查询PIC18F67K90供应商 FIGURE 13-7: TIMER1 GATE SINGLE PULSE AND TOGGLE COMBINED MODE TMR1GE T1GPOL T1GSPM T1GTM Cleared by Hardware on T1GGO/ Set by Software Falling Edge of T1GVAL T1DONE Counting Enabled on Rising Edge of T1G T1G_IN T1CKI T1GVAL Timer1 Ν N + 1 N + 2 N + 3 N + 4 Set by Hardware on Cleared by Cleared by Software Software RTCCIF Falling Edge of T1GVAL

TABLE 13-5: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	—	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
TMR1L	Timer1 Reg	jister Low By	/te						74
TMR1H	Timer1 Reg	jister High B	yte						74
T1CON	TMR1CS1	TMR1CS0	T1CKPS1	T1CKPS0	SOSCEN	T1SYNC	RD16	TMR10N	74
T1GCON	TMR1GE	T1GPOL	T1GTM	T1GSPM	T1GGO/ T1DONE	T1GVAL	T1GSS1	T1GSS0	75
OSCCON2	_	SOSCRUN	—	_	SOSCGO	_	MFIOFS	MFIOSEL	77
CCPTMRS0	C3TSEL1	C3TSEL0	C2TSEL2	C2TSEL1	C2TSEL0	C1TSEL2	C1TSEL1	C1TSEL0	79
CCPTMRS1	C7TSEL1	C7TSEL0	_	C6TSEL0	_	C5TSEL0	C4TSEL1	C4TSEL0	79
CCPTMRS2	_		_	C10TSEL0	_	C9TSEL0	C8TSEL1	C8TSEL0	79

Legend: Shaded cells are not used by the Timer1 module.

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商 14.0 TIMER2 MODULE

The Timer2 module incorporates the following features:

- 8-bit Timer and Period registers (TMR2 and PR2, respectively)
- · Both registers readable and writable
- Software programmable prescaler (1:1, 1:4 and 1:16)
- Software programmable postscaler (1:1 through 1:16)
- Interrupt on TMR2 to PR2 match
- Optional use as the shift clock for the MSSP modules

The module is controlled through the T2CON register (Register 14-1) that enables or disables the timer, and configures the prescaler and postscaler. Timer2 can be shut off by clearing control bit, TMR2ON (T2CON<2>), to minimize power consumption.

A simplified block diagram of the module is shown in Figure 14-1.

14.1 Timer2 Operation

In normal operation, TMR2 is incremented from 00h on each clock (Fosc/4). A 4-bit counter/prescaler on the clock input gives the prescale options of direct input, divide-by-4 or divide-by-16. These are selected by the prescaler control bits, T2CKPS<1:0> (T2CON<1:0>).

The value of TMR2 is compared to that of the Period register, PR2, on each clock cycle. When the two values match, the comparator generates a match signal as the timer output. This signal also resets the value of TMR2 to 00h on the next cycle and drives the output counter/ postscaler. (See **Section 14.2 "Timer2 Interrupt"**.)

The TMR2 and PR2 registers are both directly readable and writable. The TMR2 register is cleared on any device Reset, while the PR2 register initializes at FFh. Both the prescaler and postscaler counters are cleared on the following events:

- A write to the TMR2 register
- · A write to the T2CON register
- Any device Reset (Power-on Reset (POR), MCLR Reset, Watchdog Timer Reset (WDTR) or Brown-out Reset [BOR])

TMR2 is not cleared when T2CON is written.

Note: The CCP and ECCP modules use Timers 1 through 8 for some modes. The assignment of a particular timer to a CCP/ECCP module is determined by the Timer to CCP enable bits in the CCPTMRSx registers. For more details, see Register 19-2, Register 18-2 and Register 18-3.

REGISTER 14-1: T2CON: TIMER2 CONTROL REGISTER

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 Unimplemented: Read as '0'

bit 6-3	T2OUTPS<3:0>: Timer2 Output Postscale Select bits
	0000 = 1:1 Postscale
	0001 = 1:2 Postscale
	•
	•
	•
	1111 = 1:16 Postscale
bit 2	TMR2ON: Timer2 On bit
	1 = Timer2 is on
	0 = Timer2 is off
bit 1-0	T2CKPS<1:0>: Timer2 Clock Prescale Select bits
	00 = Prescaler is 1
	01 = Prescaler is 4
	1x = Prescaler is 16

查询PIC18F67K90供应商 14.2 Timer2 Interrupt

Timer2 can also generate an optional device interrupt. The Timer2 output signal (TMR2 to PR2 match) provides the input for the 4-bit output counter/postscaler. This counter generates the TMR2 match interrupt flag, which is latched in TMR2IF (PIR1<1>). The interrupt is enabled by setting the TMR2 Match Interrupt Enable bit, TMR2IE (PIE1<1>).

A range of 16 postscaler options (from 1:1 through 1:16 inclusive) can be selected with the postscaler control bits, T2OUTPS<3:0> (T2CON<6:3>).

14.3 Timer2 Output

The unscaled output of TMR2 is available primarily to the ECCP modules, where it is used as a time base for operations in PWM mode.

Timer2 can optionally be used as the shift clock source for the MSSP modules operating in SPI mode. Additional information is provided in Section 21.0 "Master Synchronous Serial Port (MSSP) Module".

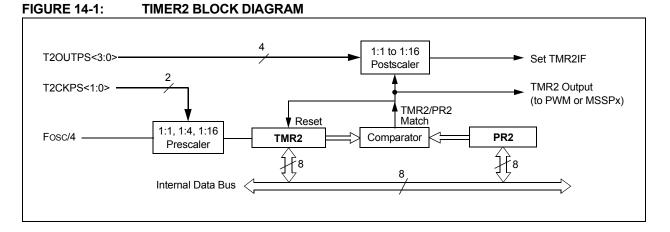


TABLE 14-1: REGISTERS ASSOCIATED WITH TIMER2 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	—	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	—	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	—	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
TMR2	Timer2 Re	gister							74
T2CON	_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	74
PR2	Timer2 Per	riod Register							74

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Timer2 module.

查询PIC18F67K90供应商 15.0 TIMER3/5/7 MODULES

The Timer3/5/7 timer/counter modules incorporate these features:

- Software-selectable operation as a 16-bit timer or counter
- Readable and writable 8-bit registers (TMRxH and TMRxL)
- Selectable clock source (internal or external) with device clock or SOSC oscillator internal options
- Interrupt-on-overflow
- · Module Reset on ECCP Special Event Trigger

Timer7 is unimplemented for devices with program memory of 32 Kbytes (PIC18FX5K90).

Note: Throughout this section, generic references are used for register and bit names that are the same, except for an 'x' variable that indicates the item's association with the Timer3, Timer5 or Timer7 module. For example, the control register is named TxCON and refers to T3CON, T5CON and T7CON.

A simplified block diagram of the Timer3/5/7 module is shown in Figure 15-1.

The Timer3/5/7 module is controlled through the TxCON register (Register 15-1). It also selects the clock source options for the ECCP modules. (For more information, see Section 19.1.1 "ECCP Module and Timer Resources".)

The Fosc clock source should not be used with the ECCP capture/compare features. If the timer will be used with the capture or compare features, always select one of the other timer clocking options.

查询PIC18F67K90供应商 REGISTER 15-1: TXCON: TIMERx CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
TMRxCS1	TMRxCS0	TxCKPS1	TxCKPS0	SOSCEN	TxSYNC	RD16	TMRxON			
bit 7							bit			
Legend:										
R = Readable	e bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unk	nown			
bit 7-6	TMRxCS<1:0	>: Timerx Cloc	k Source Sele	ct bits						
	SOSCE Externa <u>SOSCE</u> Crystal 01 = Timerx	EN = 0: al clock is from EN = 1: oscillator is on clock source is	the T1CKI pin the SOSCI/SC		dge).	on the SOSCE	N bit.			
bit 5-4		>: Timerx Input)					
	11 = 1:8 Pres 10 = 1:4 Pres 01 = 1:2 Pres 00 = 1:1 Pres	cale value cale value cale value								
bit 3	SOSCEN: SC	SC Oscillator I	Enable bit							
		enabled for Tim disabled for Tin	•	SOSCSEL fuse	es)					
bit 2	TxSYNC : Timerx External Clock Input Synchronization Control bit (Not usable if the device clock comes from Timer1/Timer3.)									
		<u>S<1:0> = 10:</u> nchronize exte ize external clo		t						
	When TMRxC This bit is igno	<u>S<1:0> = 0x:</u> pred; Timer3 us	ses the internal	clock.						
bit 1	RD16: 16-Bit Read/Write Mode Enable bit									
				one 16-bit ope two 8-bit opera						
bit 0	TMRxON: Tin	nerx On bit								
	1 = Enables Timerx 0 = Stops Timerx									

Note 1: The Fosc clock source should not be selected if the timer will be used with the ECCP capture/compare features.

查询PIC18F67K90供应商

15.1 Timer3/5/7 Gate Control Register

The Timer3/5/7 Gate Control register (TxGCON), provided in Register 14-2, is used to control the Timerx gate.

REGISTER 15-2: TxGCON: TIMERx GATE CONTROL REGISTER⁽¹⁾

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-x	R/W-0	R/W-0
TMRxGE	TxGPOL	TxGTM	TxGSPM	TxGGO/TxDONE	TxGVAL	TxGSS1	TxGSS0
bit 7							bit 0
Legend:							
R = Readal		W = Writable		U = Unimplemented	bit, read as '(
-n = Value a	at POR	'1' = Bit is se	t	'0' = Bit is cleared		x = Bit is unkn	own
bit 7	TMRxGE: Ti	merx Gate En	able bit				
	If TMRxON =	<u>= 0:</u>					
	This bit is igr	nored.					
	<u>If TMRxON =</u>						
				Timerx gate function erx gate function			
bit 6		merx Gate Po					
				ounts when gate is hi	iah)		
				ounts when gate is low			
bit 5	TxGTM: Tim	erx Gate Togo	le Mode bit				
		Gate Toggle m					
		Gate Toggle m flip-flop toggle		ed and toggle flip-flop	is cleared		
bit 4	-	merx Gate Sir	-				
			-	nabled and is control	llina the Timer	x gate	
		Sate Single Pu				Julio	
bit 3	TxGGO/TxD	ONE: Timerx	Gate Single F	Pulse Acquisition Stat	us bit		
				n is ready, waiting for			
				n has completed or ha xGSPM is cleared.	as not been st	arted	
bit 2		nerx Gate Cu		KOSFINIIS Cleared.			
				gate that could be pro	ovided to TMR	xH:TMRxL. Un	affected by the
		Enable (TMR		gate that could be pre			
bit 1-0	TxGSS<1:0>	>: Timerx Gate	e Source Sele	ect bits			
		rator 2 output					
		rator 1 output + 1) to match	$DD(x \pm 1)$ out	tout(2)			
	01 = Time(x) 00 = Timer1			ipul ⁽)			
			is turned on i	f TMRxGE = 1, regar	dless of the st	ate of TMRxON	۸.
Note 1:	Programming th	ne TxGCON p	rior to TxCON	l is recommended.			

- **Note 1:** Programming the TxGCON prior to TxCON is recommended.
 - **2:** Timer(x+1) will be Timer4/6/8 or Timerx Timer3/5/7, respectively.

查询PIC18F67K90供应商 REGISTER 15-3: OSCCON2: OSCILLATOR CONTROL REGISTER 2

U-0	R-0	U-0	U-0	R/W-0	U-0	R-x	R/W-0			
_	SOSCRUN	_	_	SOSCGO	_	MFIOFS	MFIOSEL			
bit 7							bit 0			
Legend:										
R = Readal	ble bit	W = Writable	oit	U = Unimplem	nented bit, read	l as '0'				
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	iown			
bit 7	Unimplemen	ted: Read as ')'							
bit 6	SOSCRUN: S	SOSC Run Stat	us bit							
	•	lock comes fro	•							
	0 = System c	lock comes fro	m an oscillator	other than SO	SC					
bit 5-4	Unimplemen	ted: Read as ')'							
bit 3	SOSCGO: Os	scillator Start C	ontrol bit							
		is running, even			-	SOSC is select	ed to run from			
		clock input, rath			J (
bit 2	Unimplemen	ted: Read as ')'							
bit 1	MFIOFS: MF-	INTOSC Frequ	ency Stable bi	t						
		1 = MF-INTOSC is stable 0 = MF-INTOSC is not stable								
bit 0	MFIOSEL: MI	F-INTOSC Sele	ect bit							
		SC is used in p SC is not used		TOSC frequence	ies of 500 kHz	, 250 kHz and 3	31.25 kHz			

The operating mode is determined by the clock select

bits, TMRxCSx (TxCON<7:6>). When the TMRxCSx bits

are cleared (= 00), Timer3/5/7 increments on every inter-

nal instruction cycle (Fosc/4). When TMRxCSx = 01, the

Timer3/5/7 clock source is the system clock (Fosc), and when it is '10', Timer3/5/7 works as a counter from the

external clock from the TxCKI pin (on the rising edge after

the first falling edge) or the SOSC oscillator.

查询PIC18F67K90供应商 15.2 Timer3/5/7 Operation

Timer3, Timer5 and Timer7 can operate in these modes:

- Timer
- Synchronous Counter
- Asynchronous Counter
- · Timer with Gated Control

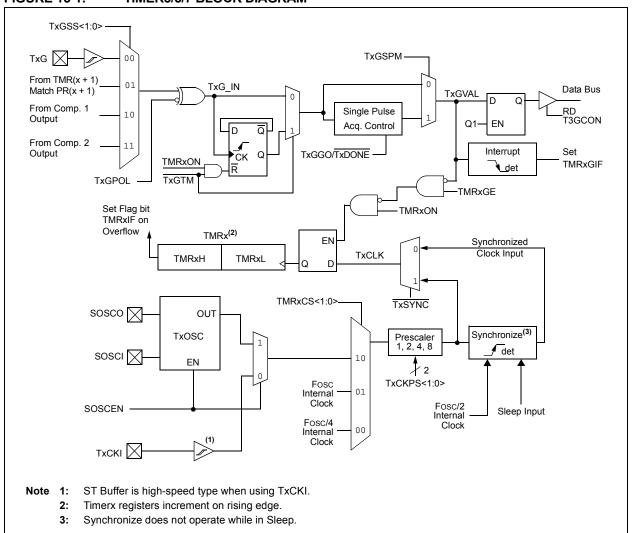


FIGURE 15-1: TIMER3/5/7 BLOCK DIAGRAM

 $\ensuremath{\textcircled{}^{\circ}}$ 2010 Microchip Technology Inc.

查询PIC18F67K90供应商

15.3 Timer3/5/7 16-Bit Read/Write Mode

Timer3/5/7 can be configured for 16-bit reads and writes (see Figure 15.3). When the RD16 control bit (TxCON<1>) is set, the address for TMRxH is mapped to a buffer register for the high byte of Timer3/5/7. A read from TMRxL will load the contents of the high byte of Timer3/5/7 into the Timerx High Byte Buffer register. This provides users with the ability to accurately read all 16 bits of Timer3/5/7 without having to determine whether a read of the high byte, followed by a read of the low byte, has become invalid due to a rollover between reads.

A write to the high byte of Timer3/5/7 must also take place through the TMRxH Buffer register. The Timer3/5/7 high byte is updated with the contents of TMRxH when a write occurs to TMRxL. This allows users to write all 16 bits to both the high and low bytes of Timer3/5/7 at once.

The high byte of Timer3/5/7 is not directly readable or writable in this mode. All reads and writes must take place through the Timerx High Byte Buffer register.

Writes to TMRxH do not clear the Timer3/5/7 prescaler. The prescaler is only cleared on writes to TMRxL.

15.4 Using the SOSC Oscillator as the Timer3/5/7 Clock Source

The SOSC internal oscillator may be used as the clock source for Timer3/5/7. The SOSC oscillator is enabled by setting one of five bits: any of the four SOSCEN bits in the TxCON registers (TxCON<3>) or the SOSCGO bit in the OSCCON2 register (OSCCON2<3>). To use it as the Timer3/5/7 clock source, the TMRxCS bit must

also be set. As previously noted, this also configures Timer3/5/7 to increment on every rising edge of the oscillator source.

The SOSC oscillator is described in **Section 13.0** "Timer1 Module".

15.5 Timer3/5/7 Gates

Timer3/5/7 can be configured to count freely or the count can be enabled and disabled using the Timer3/5/7 gate circuitry. This is also referred to as the Timer3/5/7 gate count enable.

The Timer3/5/7 gate can also be driven by multiple selectable sources.

15.5.1 TIMER3/5/7 GATE COUNT ENABLE

The Timerx Gate Enable mode is enabled by setting the TMRxGE bit (TxGCON<7>). The polarity of the Timerx Gate Enable mode is configured using the TxGPOL bit (TxGCON<6>).

When Timerx Gate Enable mode is enabled, Timer3/5/ 7 will increment on the rising edge of the Timer3/5/7 clock source. When Timerx Gate Enable mode is disabled, no incrementing will occur and Timer3/5/7 will hold the current count. See Figure 15-2 for timing details.

TABLE 15-1:	TIMER3/5/7 GATE ENABLE
	SELECTIONS

TxCLK ^(†)	TxGPOL (TxGCON<6>)	TxG Pin	Timerx Operation
\uparrow	0	0	Counts
\uparrow	0	1	Holds Count

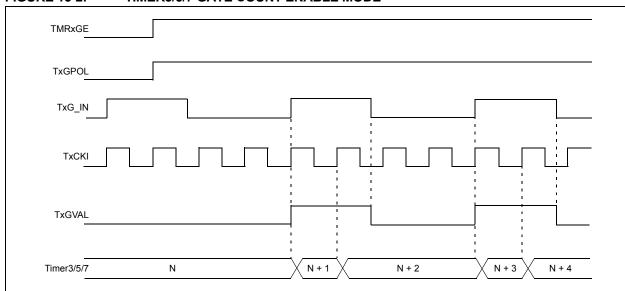


FIGURE 15-2: TIMER3/5/7 GATE COUNT ENABLE MODE

查询PIC18F67K90供应商 15.5.2 TIMER3/5/7 GATE SOURCE SELECTION

The Timer3/5/7 gate source can be selected from one of four different sources. Source selection is controlled by the TxGSS<1:0> bits (TxGCON<1:0>). The polarity for each available source is also selectable and is controlled by the TxGPOL bit (TxGCON <6>).

TABLE 15-2:	TIMER3/5/7 GA	TE SOURCES
IADLL IJ-2.		

TxGSS<1:0>	Timerx Gate Source	
00	Timerx Gate Pin	
01	TMR(x + 1) to Match PR(x + 1) (TMR(x + 1) increments to match PR(x + 1)	
10	Comparator 1 Output (Comparator logic high output)	
11	Comparator 2 Output (Comparator logic high output)	

15.5.2.1 TxG Pin Gate Operation

The TxG pin is one source for Timer3/5/7 gate control. It can be used to supply an external source to the Timerx gate circuitry.

15.5.2.2 Timer4/6/8 Match Gate Operation

The Timer4/6/8 register will increment until it matches the value in the PRx register. On the very next increment cycle, TMRx will be reset to 00h. When this Reset occurs, a low-to-high pulse will automatically be generated and internally supplied to the Timerx gate circuitry. The pulse will remain high for one instruction cycle and will return back to a low state until the next match. Depending on TxGPOL, Timerx increments differently when TMR(x + 1) matches PR(x + 1). When TxGPOL = 1, Timerx increments for a single instruction cycle following a TMR(x + 1) match with PR(x + 1). When TxGPOL = 0, Timerx increments continuously except for the cycle following the match when the gate signal goes from low-to-high.

15.5.2.3 Comparator 1 Output Gate Operation

The output of Comparator 1 can be internally supplied to the Timerx gate circuitry. After setting up Comparator 1 with the CM1CON register, Timerx will increment depending on the transitions of the CMP1OUT (CMSTAT<5>) bit.

15.5.2.4 Comparator 2 Output Gate Operation

The output of Comparator 2 can be internally supplied to the Timerx gate circuitry. After setting up Comparator 2 with the CM2CON register, Timerx will increment depending on the transitions of the CMP2OUT (CMSTAT<6>) bit.

15.5.3 TIMER3/5/7 GATE TOGGLE MODE

When Timer3/5/7 Gate Toggle mode is enabled, it is possible to measure the full cycle length of a Timer3/5/7 gate signal, as opposed to the duration of a single level pulse.

The Timerx gate source is routed through a flip-flop that changes state on every incrementing edge of the signal. (For timing details, see Figure 15-3.)

The TxGVAL bit will indicate when the Toggled mode is active and the timer is counting.

Timer3/5/7 Gate Toggle mode is enabled by setting the TxGTM bit (TxGCON<5>). When the TxGTM bit is cleared, the flip-flop is cleared and held clear. This is necessary in order to control which edge is measured.

FIGURE 15-3: TIMER3/5/7 GATE TOGGLE MODE

查询PIC18F67K90供应商

15.5.4 TIMER3/5/7 GATE SINGLE PULSE MODE

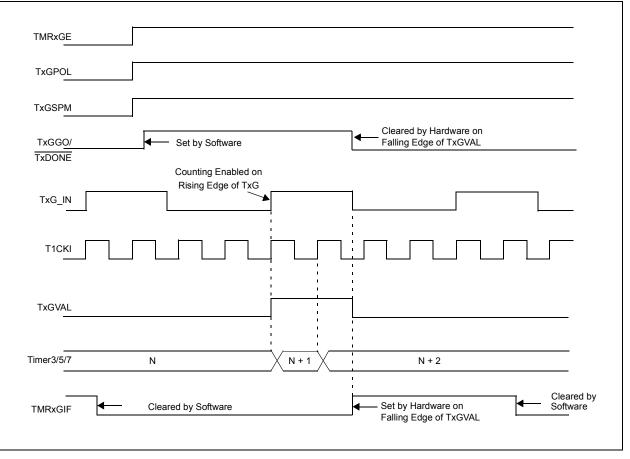
When Timer3/5/7 Gate Single Pulse mode is enabled, it is possible to capture a single pulse gate event. Timer3/5/7 Gate Single Pulse mode is first enabled by setting the TxGSPM bit (TxGCON<4>). Next, the TxGGO/TxDONE bit (TxGCON<3>) must be set.

The Timer3/5/7 will be fully enabled on the next incrementing edge. On the next trailing edge of the pulse, the TxGGO/TxDONE bit will automatically be cleared. No other gate events will <u>be allowed</u> to increment Timer3/5/7 until the TxGGO/TxDONE bit is once again set in software.

Clearing the TxGSPM bit also will clear the TxGGO/ TxDONE bit. (For timing details, see Figure 15-4.)

Simultaneously enabling the Toggle mode and the Single Pulse mode will permit both sections to work together. This allows the cycle times on the Timer3/5/7 gate source to be measured. (For timing details, see Figure 15-5.)

FIGURE 15-4: TIMER3/5/7 GATE SINGLE PULSE MODE



查询PIC18F67K90供应商 FIGURE 15-5: TIMER3/5/7 GATE SINGLE PULSE AND TOGGLE COMBINED MODE TMRxGE TxGPOL TxGSPM TxGTM Cleared by Hardware on TxGGO/ Set by Software Falling Edge of TxGVAL TxDONE Counting Enabled on Rising Edge of TxG TxG_IN TxCKI TxGVAL Timer3/5/7 N + 1 Ν N + 2 N + 3 N + 4 Set by Hardware on Cleared by Cleared by Software Falling Edge of TxGVAL Software TMRxGIF

15.5.5 TIMER3/5/7 GATE VALUE STATUS

When Timer3/5/7 gate value status is utilized, it is possible to read the most current level of the gate control value. The value is stored in the TxGVAL bit (TxGCON<2>). The TxGVAL bit is valid even when the Timer3/5/7 gate is not enabled (TMRxGE bit is cleared).

15.5.6 TIMER3/5/7 GATE EVENT INTERRUPT

When the Timer3/5/7 gate event interrupt is enabled, it is possible to generate an interrupt upon the completion of a gate event. When the falling edge of TxGVAL occurs, the TMRxGIF flag bit in the PIRx register will be set. If the TMRxGIE bit in the PIEx register is set, then an interrupt will be recognized.

The TMRxGIF flag bit operates even when the Timer3/ 5/7 gate is not enabled (TMRxGE bit is cleared).

查询PIC18F67K90供应商

15.6 Timer3/5/7 Interrupt

The TMRx register pair (TMRxH:TMRxL) increments from 0000h to FFFFh and overflows to 0000h. The Timerx interrupt, if enabled, is generated on overflow and is latched in the interrupt flag bit, TMRxIF. Table 15-3 gives each module's flag bit.

TABLE 15-3: TIMER3/5/7 INTERRUPT FLAG BITS

Timer Module	Flag Bit
3	PIR2<1>
5	PIR5<1>
7	PIR5<3>

This interrupt can be enabled or disabled by setting or clearing the TMRxIE bit, respectively. Table 15-4 gives each module's enable bit.

TABLE 15-4: TIMER3/5/7 INTERRUPT ENABLE BITS

Timer Module	Flag Bit
3	PIE2<1>
5	PIE5<1>
7	PIE5<3>

15.7 Resetting Timer3/5/7 Using the ECCP Special Event Trigger

If the ECCP modules are configured to use Timerx and to generate a Special Event Trigger in Compare mode (CCPxM<3:0> = 1011), this signal will reset Timerx. The trigger from ECCP2 will also start an A/D conversion if the A/D module is enabled (For more information, see **Section 19.3.4 "Special Event Trigger"**.)

The module must be configured as either a timer or synchronous counter to take advantage of this feature. When used this way, the CCPRxH:CCPRxL register pair effectively becomes a Period register for Timerx.

If Timerx is running in Asynchronous Counter mode, the Reset operation may not work.

In the event that a write to Timerx coincides with a Special Event Trigger from an ECCP module, the write will take precedence.

Note:	The Special Event Triggers from the
	ECCPx module will only clear the TMR3
	register's content, but not set the TMR3IF
	interrupt flag bit (PIR1<0>).

Note: The CCP and ECCP modules use Timers, 1 through 8, for some modes. The assignment of a particular timer to a CCP/ECCP module is determined by the Timer to CCP enable bits in the CCPTMRSx registers. For more details, see Register 19-2, Register 18-2 and Register 18-3.

查询PIC18F67K90供应商 TABLE 15-5: REGISTERS ASSOCIATED WITH TIMER3/5/7 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR5	TMR7GIF ⁽¹⁾	TMR12IF ⁽¹⁾	TMR10IF ⁽¹⁾	TMR8IF	TMR7IF ⁽¹⁾	TMR6IF	TMR5IF	TMR4IF	75
PIE5	TMR7GIE ⁽¹⁾	TMR12IE ⁽¹⁾	TMR10IE ⁽¹⁾	TMR8IE	TMR7IE ⁽¹⁾	TMR6IE	TMR5IE	TMR4IE	75
PIR2	OSCFIF	_	SSP2IF	BCL2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF	75
PIE2	OSCFIE	_	SSP2IE	BCL2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	75
PIR3	TMR5GIF ⁽¹⁾	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE ⁽¹⁾	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
TMR3H	Timer3 Regi	ster High Byt	е						75
TMR3L	Timer3 Regi	ster Low Byte	e						75
T3GCON	TMR3GE	T3GPOL	T3GTM	T3GSPM	T3GGO/ T3DONE	T3GVAL	T3GSS1	T3GSS0	75
T3CON	TMR3CS1	TMR3CS0	T3CKPS1	T3CKPS0	SOSCEN	T3SYNC	RD16	TMR3ON	75
TMR5H	Timer5 Register High Byte						80		
TMR5L	Timer5 Regi	ster Low Byte	Э						80
T5GCON	TMR5GE	T5GPOL	T5GTM	T5GSPM	T5GGO/ T5DONE	T5GVAL	T5GSS1	T5GSS0	80
T5CON	TMR5CS1	TMR5CS0	T5CKPS1	T5CKPS0	SOSCEN	T5SYNC	RD16	TMR5ON	80
TMR7H	H Timer7 Register High Byte						79		
TMR7L	Timer7 Register Low Byte					79			
T7GCON	TMR7GE	T7GPOL	T7GTM	T7GSPM	T7GGO/ T7DONE	T7GVAL	T7GSS1	T7GSS0	79
T7CON	TMR7CS1	TMR7CS0	T7CKPS1	T7CKPS0	SOSCEN	T7SYNC	RD16	TMR7ON	79
OSCCON2	—	SOSCRUN	—	—	SOSCGO	—	MFIOFS	MFIOSEL	77
CCPTMRS0	C3TSEL1	C3TSEL0	C2TSEL2	C2TSEL1	C2TSEL0	C1TSEL2	C1TSEL1	C1TSEL0	79
CCPTMRS1	C7TSEL1	C7TSEL0	—	C6TSEL0	—	C5TSEL0	C4TSEL1	C4TSEL0	79
CCPTMRS1		_	—	C10TSEL0	_	C9TSEL0	C8TSEL1	C8TSEL0	79

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Timer3/5/7 module.

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商 16.0 TIMER4/6/8/10/12 MODULES

The Timer4/6/8/10/12 timer modules have the following features:

- 8-Bit Timer register (TMRx)
- 8-Bit Period register (PRx)
- Readable and writable (all registers)
- Software programmable prescaler (1:1, 1:4, 1:16)
- Software programmable postscaler (1:1 to 1:16)
- Interrupt on TMRx match of PRx

Timer10 and Timer12 are unimplemented for devices with program memory of 32 Kbytes (PIC18FX5K90).

Note:	Throughout this section, generic references are used for register and bit names that are the
	same, except for an 'x' variable that indicates
	the item's association with the Timer4, Timer6,
	Timer8, Timer10 or Timer12 module. For
	example, the control register is named TxCON
	and refers to T4CON, T6CON, T8CON,
	T10CON and T12CON.

The Timer4/6/8/10/12 modules have a control register shown in Register 16-1. Timer4/6/8/10/12 can be shut off by clearing control bit, TMRxON (TxCON<2>), to minimize power consumption. The prescaler and post-scaler selection of Timer4/6/8/10/12 also are controlled by this register. Figure 16-1 is a simplified block diagram of the Timer4/6/8/10/12 modules.

16.1 Timer4/6/8/10/12 Operation

Timer4/6/8/10/12 can be used as the PWM time base for the PWM mode of the ECCP modules. The TMRx registers are readable and writable, and are cleared on any device Reset. The input clock (Fosc/4) has a prescale option of 1:1, 1:4 or 1:16, selected by control bits, TxCKPS<1:0> (TxCON<1:0>). The match output of TMRx goes through a 4-bit postscaler (that gives a 1:1 to 1:16 inclusive scaling) to generate a TMRx interrupt, latched in the flag bit, TMRxIF. Table 16-1 gives each module's flag bit.

Timer Module	Flag Bit PIR5 <x></x>	Timer Module	Flag Bit PIR5 <x></x>			
4	0	10	5			
6	2	12	6			
8	4					

TABLE 16-1: TIMER4/6/8/10/12 FLAG BITS

The interrupt can be enabled or disabled by setting or clearing the Timerx Interrupt Enable bit (TMRxIE), shown in Table 16-2.

TABLE 16-2:	TIMER4/6/8/10/12 INTERRUPT		
	ENABLE BITS		

Timer Module	Flag Bit PIE5 <x></x>	Timer Module	Flag Bit PIE5 <x></x>
4	0	10	5
6	2	12	6
8	4		

The prescaler and postscaler counters are cleared when any of the following occurs:

- A write to the TMRx register
- A write to the TxCON register
- Any device Reset (Power-on Reset (POR), MCLR Reset, Watchdog Timer Reset (WDTR) or Brown-out Reset (BOR))

A TMRx is not cleared when a TxCON is written.

Note: The CCP and ECCP modules use Timers, 1 through 8, for some modes. The assignment of a particular timer to a CCP/ECCP module is determined by the Timer to CCP enable bits in the CCPTMRSx registers. For more details, see Register 19-2, Register 18-2 and Register 18-3.

查询PIC18F67K90供应商

REGISTER 16-1: TXCON: TIMER4/6/8/10/12 CONTROL REGISTER

U-0	R/W-0	R/W-0 R/W-0		R/W-0 R/W-0		R/W-0	R/W-0	
—	TxOUTPS3	TxOUTPS2	TxOUTPS1	TxOUTPS0	TMRxON	TxCKPS1	TxCKPS0	
bit 7							bit 0	

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'					
bit 6-3	TxOUTPS<3:0>: Timerx Output Postscale Select bits					
	0000 = 1:1 Postscale					
	0001 = 1:2 Postscale					
	•					
	•					
	•					
	1111 = 1:16 Postscale					
bit 2	TMRxON: Timerx On bit					
	1 = Timerx is on					
	0 = Timerx is off					
bit 1-0	TxCKPS<1:0>: Timerx Clock Prescale Select bits					
	00 = Prescaler is 1					
	01 = Prescaler is 4					
	1x = Prescaler is 16					

16.2 Timer4/6/8/10/12 Interrupt

The Timer4/6/8/10/12 modules have 8-bit period registers, PRx, that are both readable and writable. Timer4/6/8/10/12 increment from 00h until they match PR4/6/8/10/12 and then reset to 00h on the next increment cycle. The PRx registers are initialized to FFh upon Reset.

16.3 Output of TMRx

The outputs of TMRx (before the postscaler) are used only as a PWM time base for the ECCP modules. They are not used as baud rate clocks for the MSSP modules as is the Timer2 output.

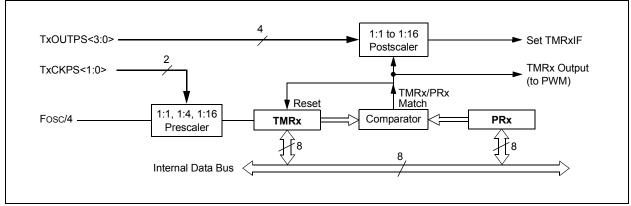


FIGURE 16-1: TIMER4/6/8/10/12 BLOCK DIAGRAM

查询PIC18F67K90供应商 TABLE 16-3: REGISTERS ASSOCIATED WITH TIMER4/6/8/10/12 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
IPR5	TMR7GIP ⁽¹⁾	TMR12IP ⁽¹⁾	TMR10IP ⁽¹⁾	TMR8IP	TMR7IP ⁽¹⁾	TMR6IP	TMR5IP	TMR4IP	74
PIR5	TMR7GIF ⁽¹⁾	TMR12IF ⁽¹⁾	TMR10IF ⁽¹⁾	TMR8IF	TMR7IF ⁽¹⁾	TMR6IF	TMR5IF	TMR4IF	75
PIE5	TMR7GIE ⁽¹⁾	TMR12IE ⁽¹⁾	TMR10IE ⁽¹⁾	TMR8IE	TMR7IE ⁽¹⁾	TMR6IE	TMR5IE	TMR4IE	75
TMR4	Timer4 Register							80	
T4CON	_	T4OUTPS3	T4OUTPS2	T4OUTPS1	T4OUTPS0	TMR4ON	T4CKPS1	T4CKPS0	80
PR4	Timer4 Period Register							80	
TMR6	Timer6 Register							79	
T6CON	_	T6OUTPS3	T6OUTPS2	T6OUTPS1	T6OUTPS0	TMR6ON	T6CKPS1	T6CKPS0	79
PR6	Timer6 Period Register							79	
TMR8	Timer8 Register							79	
T8CON	_	T8OUTPS3	T8OUTPS2	T8OUTPS1	T8OUTPS0	TMR8ON	T8CKPS1	T8CKPS0	79
PR8	Timer8 Period Register							79	
TMR10	Timer10 Register							79	
T10CON	_	T10OUTPS3	T10OUTPS2	T10OUTPS1	T10OUTPS0	TMR100N	T10CKPS1	T10CKPS0	79
PR10	Timer10 Period Register							79	
TMR12	Timer12 Register							79	
T12CON	_	T12OUTPS3	T12OUTPS2	T12OUTPS1	T12OUTPS0	TMR12ON	T12CKPS1	T12CKPS0	79
PR12	Timer12 Period Register							79	
CCPTMRS0	C3TSEL1	C3TSEL0	C2TSEL2	C2TSEL1	C2TSEL0	C1TSEL2	C1TSEL1	C1TSEL0	79
CCPTMRS1	C7TSEL1	C7TSEL0	_	C6TSEL0	—	C5TSEL0	C4TSEL1	C4TSEL0	79
CCPTMRS2	_	_	_	C10TSEL0 ⁽¹⁾	_	C9TSEL0 ⁽¹⁾	C8TSEL1	C8TSEL0	79

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Timer4/6/8/10/12 module.

Note 1: Unimplemented on devices with a program memory of 32k bytes (PIC18FX5K22).

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商

17.0 REAL-TIME CLOCK AND CALENDAR (RTCC)

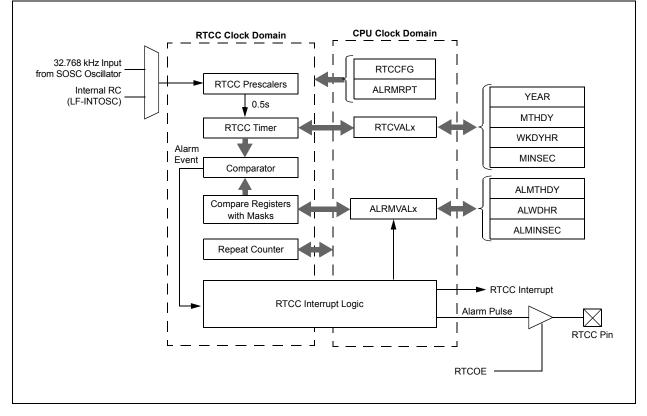
The key features of the Real-Time Clock and Calendar (RTCC) module are:

- Time: hours, minutes and seconds
- Twenty-four hour format (military time)
- Calendar: weekday, date, month and year
- · Alarm configurable
- Year range: 2000 to 2099
- · Leap year correction
- · BCD format for compact firmware
- Optimized for low-power operation
- · User calibration with auto-adjust
- Calibration range: ±2.64 seconds error per month
- Requirements: external 32.768 kHz clock crystal
- · Alarm pulse or seconds clock output on RTCC pin

The RTCC module is intended for applications where accurate time must be maintained for an extended period with minimum to no intervention from the CPU. The module is optimized for low-power usage in order to provide extended battery life while keeping track of time.

The module is a 100-year clock and calendar with automatic leap year detection. The range of the clock is from 00:00:00 (midnight) on January 1, 2000 to 23:59:59 on December 31, 2099.

Hours are measured in 24-hour (military time) format. The clock provides a granularity of one second with half-second visibility to the user.





查询PIC18F67K90供应商 17.1 RTCC MODULE REGISTERS

The RTCC module registers are divided into the following categories:

RTCC Control Registers

- RTCCFG
- RTCCAL
- PADCFG1
- ALRMCFG
- ALRMRPT

RTCC Value Registers

- RTCVALH
- RTCVALL

Both registers access the following registers:

- YEAR
- MONTH
- DAY
- WEEKDAY
- HOUR
- MINUTE
- SECOND

Alarm Value Registers

- ALRMVALH
- ALRMVALL
 Both registers access the following registers:
 - ALRMMNTH
 - ALRMDAY
 - ALRMWD
 - ALRMHR
 - ALRMMIN
 - ALRMSEC
- Note: The RTCVALH and RTCVALL registers can be accessed through RTCRPT<1:0> (RTCCFG<1:0>). ALRMVALH and ALRMVALL can be accessed through ALRMPTR<1:0> (ALRMCFG<1:0>).

查询PIC18F67K90供应商 17.1.1 RICC CONTROL RE

17.1.1 RICC CONTROL REGISTERS

REGISTER 17-1: RTCCFG: RTCC CONFIGURATION REGISTER⁽¹⁾

R/W-0	U-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0
RTCEN ⁽²⁾		RTCWREN ⁽⁴⁾	RTCSYNC	HALFSEC ⁽³⁾	RTCOE	RTCPTR1	RTCPTR0
bit 7							bit (
Legend:							
R = Readable		W = Writable b	it	-	nented bit, rea		
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	lown
bit 7	RTCEN: RT	CC Enable bit ⁽²⁾					
		nodule is enabled	ł				
		module is disable					
bit 6	Unimpleme	ented: Read as '0	,				
bit 5	RTCWREN:	RTCC Value Re	gisters Write I	Enable bit ⁽⁴⁾			
		LH and RTCVALI					
		LH and RTCVALI	-		-	n to by the user	
bit 4		RTCC Value Reg		•			
		LH, RTCVALL an					
		valid data read. If ed to be valid.	the register i	is read twice ar	nd results in th	e same data, tr	ie data can b
		LH, RTCVALL an	d ALCFGRPT	registers can b	e read withou	t concern over a	rollover ripple
bit 3		Half-Second Stat		•			
	1 = Second	I half period of a s	econd				
	0 = First ha	If period of a seco	ond				
bit 2	RTCOE: RT	CC Output Enabl	e bit				
		clock output is en					
		clock output is dis					
bit 1-0		:0>: RTCC Value					
		e corresponding R R<1:0> value dec					
	RTCVALH:						
	00 = Minute	S					
	01 = Weekd	lay					
	10 = Month						
	11 = Reserv	/ed					
	RTCVALL:	1.					
	00 = Secon 01 = Hours	ds					
	10 = Day						
	10 – Day 11 – Year						
			–				
		egister is only affe	•				
2: A	write to the RT	FCEN bit is only a	llowed when	RICWREN = 1			

- 2: A write to the RTCEN bit is only allowed when RTCWREN = 1.
- **3:** This bit is read-only; it is cleared to '0' on a write to the lower half of the MINSEC register.
- 4: The RTCWREN bit can only be written with the unlock sequence (see **Example 17-1**).

查询PIC18F67K90供应商

.

REGISTER 17-2: RTCCAL: RTCC CALIBRATION REGISTER

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| CAL7 | CAL6 | CAL5 | CAL4 | CAL3 | CAL2 | CAL1 | CAL0 |
| bit 7 | | | | | | | bit 0 |

Legend:				
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7-0 CAL<7:0>: RTC Drift Calibration bits

01111111 = Maximum positive adjustment. Adds 508 RTC clock pulses every minute.

00000001 = Minimum positive adjustment. Adds four RTC clock pulses every minute. 00000000 = No adjustment 11111111 = Minimum negative adjustment. Subtracts four RTC clock pulses every minute.
•
•
•

10000000 = Maximum negative adjustment. Subtracts 512 RTC clock pulses every minute.

REGISTER 17-3: PADCFG1: PAD CONFIGURATION REGISTER

R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	U-0
RDPU	REPU	RJPU ⁽²⁾	_	_	RTSECSEL1 ⁽¹⁾	RTSECSEL0 ⁽¹⁾	—
bit 7							bit 0

Legend:				
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7	RDPU: PORTD Pull-up Enable bit
	 1 = PORTD pull-up resistors are enabled by individual port latch values 0 = All PORTD pull-up resistors are disabled
bit 6	REPU: PORTE Pull-up Enable bit
	 1 = PORTE pull-up resistors are enabled by individual port latch values 0 = All PORTE pull-up resistors are disabled
bit 5	RJPU: PORTJ Pull-up Enable bit ⁽²⁾
	 1 = PORTJ pull-up resistors are enabled by individual port latch values 0 = All PORTJ pull-up resistors are disabled
bit 4-3	Unimplemented: Read as '0'
bit 2-1	RTSECSEL<1:0>: RTCC Seconds Clock Output Select bit ⁽¹⁾
	 11 = Reserved; do not use 10 = RTCC source clock is selected for the RTCC pin (pin can be LF-INTOSC or SOSC, depending on the RTCOSC (CONFIG3L<1>) bit setting) 01 = RTCC seconds clock is selected for the RTCC pin 00 = RTCC alarm pulse is selected for the RTCC pin
bit 0	Unimplemented: Read as '0'

Note 1: To enable the actual RTCC output, the RTCOE (RTCCFG<2>) bit must be set.

2: Available only in 80-pin parts.

Γ.

查询PIC18F67K90供应商 REGISTER 17-4: **ALRMCFG: ALARM CONFIGURATION REGISTER** R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 ALRMEN CHIME AMASK3 AMASK2 AMASK1 AMASK0 ALRMPTR1 ALRMPTR0 bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 7 ALRMEN: Alarm Enable bit 1 = Alarm is enabled (cleared automatically after an alarm event whenever ALRMPTR<1:0> = 00 and CHIME = 0) 0 = Alarm is disabled bit 6 CHIME: Chime Enable bit 1 = Chime is enabled; ALRMPTR<1:0> bits are allowed to roll over from 00h to FFh 0 = Chime is disabled; ALRMPTR<1:0> bits stop once they reach 00h bit 5-2 AMASK<3:0>: Alarm Mask Configuration bits 0000 = Every half second 0001 = Every second 0010 = Every 10 seconds 0011 = Every minute 0100 = Every 10 minutes 0101 = Every hour 0110 = Once a day 0111 = Once a week 1000 = Once a month 1001 = Once a year (except when configured for February 29th, once every four years) 101x = Reserved – Do not use 11xx = Reserved – Do not use bit 1-0 ALRMPTR<1:0>: Alarm Value Register Window Pointer bits Points to the corresponding Alarm Value registers when reading the ALRMVALH and ALRMVALL registers. The ALRMPTR<1:0> value decrements on every read or write of ALRMVALH until it reaches '00'. ALRMVALH: 00 = ALRMMIN 01 = ALRMWD 10 = ALRMMNTH 11 = Unimplemented ALRMVALL: 00 = ALRMSEC 01 = ALRMHR 10 = ALRMDAY 11 = Unimplemented

查询PIC18F67K90供应商

REGISTER 17-5: ALRMRPT: ALARM REPEAT REGISTER

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| ARPT7 | ARPT6 | ARPT5 | ARPT4 | ARPT3 | ARPT2 | ARPT1 | ARPT0 |
| bit 7 | | | | | | | bit 0 |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 ARPT<7:0>: Alarm Repeat Counter Value bits 1111111 = Alarm will repeat 255 more times .

> . 00000000 = Alarm will not repeat The counter decrements on any alarm event. The counter is prevented from rolling over from 00h to FFh unless CHIME = 1.

17.1.2 RTCVALH AND RTCVALL REGISTER MAPPINGS

REGISTER 17-6: RESERVED REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	—	—	—	—	—	—	—
bit 7							bit 0

Legend:					
R = Readable bit	W = Writable bit	U = Unimplemented bit,	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 7-0 Unimplemented: Read as '0'

查询PIC18F67K90供应商

REGISTER 17-7: YEAR: YEAR VALUE REGISTER⁽¹⁾

| R/W-x |
|--------|--------|--------|--------|--------|--------|--------|--------|
| YRTEN3 | YRTEN2 | YRTEN1 | YRTEN0 | YRONE3 | YRONE2 | YRONE1 | YRONE0 |
| bit 7 | | | | | | | bit 0 |

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7-4	YRTEN<3:0>: Binary Coded Decimal Value of Year's Tens Digit bits
	Contains a value from 0 to 9.

bit 3-0 **YRONE<3:0>:** Binary Coded Decimal Value of Year's Ones Digit bits Contains a value from 0 to 9.

Note 1: A write to the YEAR register is only allowed when RTCWREN = 1.

REGISTER 17-8: MONTH: MONTH VALUE REGISTER⁽¹⁾

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	—	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
bit 7							bit 0

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7-5 Unimplemented: Read	as '0'
------------------------------------	---------------

bit 4 **MTHTEN0:** Binary Coded Decimal Value of Month's Tens Digit bits Contains a value of '0' or '1'.

bit 3-0 **MTHONE<3:0>:** Binary Coded Decimal Value of Month's Ones Digit bits Contains a value from 0 to 9.

Note 1: A write to this register is only allowed when RTCWREN = 1.

© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商

Γ.

REGISTER 17-9: DAY: DAY VALUE REGISTER⁽¹⁾

U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6	Unimplemented: Read as '0'
bit 5-4	DAYTEN<1:0>: Binary Coded Decimal value of Day's Tens Digit bits Contains a value from 0 to 3.
bit 3-0	DAYONE<3:0>: Binary Coded Decimal Value of Day's Ones Digit bits Contains a value from 0 to 9.

Note 1: A write to this register is only allowed when RTCWREN = 1.

REGISTER 17-10: WEEKDAY: WEEKDAY VALUE REGISTER⁽¹⁾

U-0	U-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x
—	—	—	—	—	WDAY2	WDAY1	WDAY0
bit 7							bit 0

Legend:			
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-3 Unimplemented: Read as '0'

bit 2-0 **WDAY<2:0>:** Binary Coded Decimal Value of Weekday Digit bits Contains a value from 0 to 6.

Note 1: A write to this register is only allowed when RTCWREN = 1.

查询PIC18F67K90供应商 REGISTER 17-11: HOUR: HOUR VALUE REGISTER⁽¹⁾

U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6	Unimplemented: Read as '0'
bit 5-4	HRTEN<1:0>: Binary Coded Decimal Value of Hour's Tens Digit bits Contains a value from 0 to 2.
bit 3-0	HRONE<3:0>: Binary Coded Decimal Value of Hour's Ones Digit bits Contains a value from 0 to 9.

Note 1: A write to this register is only allowed when RTCWREN = 1.

REGISTER 17-12: MINUTE: MINUTE VALUE REGISTER

U-0	R/W-x						
—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6-4	MINTEN<2:0>: Binary Coded Decimal Value of Minute's Tens Digit bits Contains a value from 0 to 5.
bit 3-0	MINONE<3:0>: Binary Coded Decimal Value of Minute's Ones Digit bits Contains a value from 0 to 9.

REGISTER 17-13: SECOND: SECOND VALUE REGISTER

U-0	R/W-x						
—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6-4	SECTEN<2:0>: Binary Coded Decimal Value of Second's Tens Digit bits Contains a value from 0 to 5.
bit 3-0	SECONE<3:0>: Binary Coded Decimal Value of Second's Ones Digit bits Contains a value from 0 to 9.

查询PIC18F67K90供应商

17.1.3 ALRMVALH AND ALRMVALL

REGISTER MAPPINGS

REGISTER 17-14: ALRMMNTH: ALARM MONTH VALUE REGISTER⁽¹⁾

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	—	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5	Unimplemented: Read as '0'
bit 4	MTHTEN0: Binary Coded Decimal Value of Month's Tens Digit bits Contains a value of '0' or '1'.
bit 3-0	MTHONE<3:0>: Binary Coded Decimal Value of Month's Ones Digit bits Contains a value from 0 to 9.

Note 1: A write to this register is only allowed when RTCWREN = 1.

REGISTER 17-15: ALRMDAY: ALARM DAY VALUE REGISTER⁽¹⁾

U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6	Unimplemented: Read as '0'
bit 5-4	DAYTEN<1:0>: Binary Coded Decimal Value of Day's Tens Digit bits
	Contains a value from 0 to 3.
bit 3-0	DAYONE<3:0>: Binary Coded Decimal Value of Day's Ones Digit bits
	Contains a value from 0 to 9.

Note 1: A write to this register is only allowed when RTCWREN = 1.

查询PIC18F67K90供应商

REGISTER 17-16: ALRMWD: ALARM WEEKDAY VALUE REGISTER⁽¹⁾

U-0	U-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x
—	—	—	_	—	WDAY2	WDAY1	WDAY0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	1 as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-3 Unimplemented: Read a	s '0'
-------------------------------	--------------

bit 2-0 **WDAY<2:0>:** Binary Coded Decimal Value of Weekday Digit bits Contains a value from 0 to 6.

Note 1: A write to this register is only allowed when RTCWREN = 1.

REGISTER 17-17: ALRMHR: ALARM HOURS VALUE REGISTER⁽¹⁾

U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6	Unimplemented: Read as '0'
bit 5-4	HRTEN<1:0>: Binary Coded Decimal Value of Hour's Tens Digit bits
	Contains a value from 0 to 2.
bit 3-0	HRONE<3:0>: Binary Coded Decimal Value of Hour's Ones Digit bits
	Contains a value from 0 to 9.

Note 1: A write to this register is only allowed when RTCWREN = 1.

© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商

REGISTER 17-18: ALRMMIN: ALARM MINUTES VALUE REGISTER

U-0	R/W-x						
—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6-4	MINTEN<2:0>: Binary Coded Decimal Value of Minute's Tens Digit bits
	Contains a value from 0 to 5.
bit 3-0	MINONE<3:0>: Binary Coded Decimal Value of Minute's Ones Digit bits Contains a value from 0 to 9.

REGISTER 17-19: ALRMSEC: ALARM SECONDS VALUE REGISTER

U-0	R/W-x						
—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 Unimplemented: Read as '0'

bit 6-4 SECTEN<2:0>: Binary Coded Decimal Value of Second's Tens Digit bits Contains a value from 0 to 5.

bit 3-0 SECONE<3:0>: Binary Coded Decimal Value of Second's Ones Digit bits Contains a value from 0 to 9.

查询PIC18F67K90供应商 17.1.4 RICEN BIT WRITE

RTCWREN (RTCCFG<5>) must be set before a write to RTCEN can take place. Any write to the RTCEN bit, while RTCWREN = 0, will be ignored.

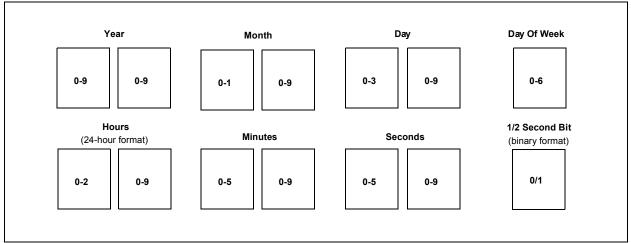
Like the RTCEN bit, the RTCVALH and RTCVALL registers can only be written to when RTCWREN = 1. A write to these registers, while RTCWREN = 0, will be ignored.

FIGURE 17-2: TIMER DIGIT FORMAT

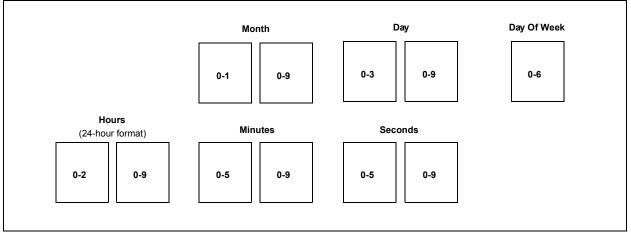
17.2 Operation

17.2.1 REGISTER INTERFACE

The register interface for the RTCC and alarm values is implemented using the Binary Coded Decimal (BCD) format. This simplifies the firmware when using the module as each of the digits is contained within its own 4-bit value (see Figure 17-2 and Figure 17-3).



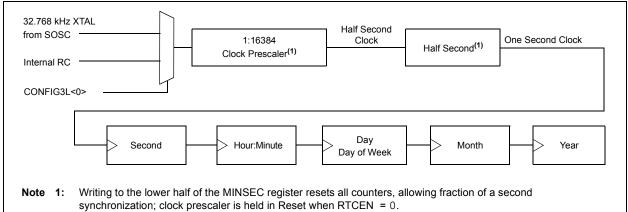




查询PIC18F67K90供应商 17.2.2 CLOCK SOURCE

As mentioned earlier, the RTCC module is intended to be clocked by an external Real-Time Clock (RTCC) crystal oscillating at 32.768 kHz, but an internal oscillator can be used. The RTCC clock selection is decided by the RTCOSC bit (CONFIG3L<0>). Calibration of the crystal can be done through this module to yield an error of 3 seconds or less per month. (For further details, see **Section 17.2.9 "Calibration"**.)

FIGURE 17-4: CLOCK SOURCE MULTIPLEXING



17.2.2.1 Real-Time Clock Enable

The RTCC module can be clocked by an external 32.768 kHz crystal (SOSC oscillator), or the LF-INTOSC oscillator, which can be selected in CONFIG3L<0>.

If the external clock is used, the SOSC oscillator should be enabled. If LF-INTOSC is providing the clock, the INTOSC clock can be brought out to the RTCC pin by the RTSECSEL<1:0> bits (PADCFG<2:1>).

17.2.3 DIGIT CARRY RULES

This section explains which timer values are affected when there is a rollover:

- Time of Day: From 23:59:59 to 00:00:00 with a carry to the Day field
- Month: From 12/31 to 01/01 with a carry to the Year field
- Day of Week: From 6 to 0 with no carry (see Table 17-1)
- Year Carry: From 99 to 00; this also surpasses the use of the RTCC

For the day-to-month rollover schedule, see Table 17-2.

Because the following values are in BCD format, the carry to the upper BCD digit occurs at the count of 10, not 16 (SECONDS, MINUTES, HOURS, WEEKDAY, DAYS and MONTHS).

TABLE 17-1: DAY OF WEEK SCHEDULE

Day of Week						
Sunday	0					
Monday	1					
Tuesday	2					
Wednesday	3					
Thursday	4					
Friday	5					
Saturday	6					

TABLE 17-2:DAY-TO-MONTH ROLLOVER
SCHEDULE

Month	Maximum Day Field
01 (January)	31
02 (February)	28 or 29 ⁽¹⁾
03 (March)	31
04 (April)	30
05 (May)	31
06 (June)	30
07 (July)	31
08 (August)	31
09 (September)	30
10 (October)	31
11 (November)	30
12 (December)	31

Note 1: See Section 17.2.4 "Leap Year".

查询PIC18F67K90供应商 17.2.4 LEAP YEAR

Since the year range on the RTCC module is 2000 to 2099, the leap year calculation is determined by any year divisible by four in the above range. Only February is affected in a leap year.

February will have 29 days in a leap year and 28 days in any other year.

17.2.5 GENERAL FUNCTIONALITY

All Timer registers containing a time value of seconds or greater are writable. The user configures the time by writing the required year, month, day, hour, minutes and seconds to the Timer registers, via Register Pointers. (See Section 17.2.8 "Register Mapping".)

The timer uses the newly written values and proceeds with the count from the required starting point.

The RTCC is enabled by setting the RTCEN bit (RTCCFG<7>). If enabled while adjusting these registers, the timer still continues to increment. However, any time the MINSEC register is written to, both of the timer prescalers are reset to '0'. This allows fraction of a second synchronization.

The Timer registers are updated in the same cycle as the write instruction's execution by the CPU. The user must ensure that when RTCEN = 1, the updated registers will not be incremented at the same time. This can be accomplished in several ways:

- By checking the RTCSYNC bit (RTCCFG<4>)
- By checking the preceding digits from which a carry can occur
- By updating the registers immediately following the seconds pulse (or an alarm interrupt)

The user has visibility to the half-second field of the counter. This value is read-only and can be reset only by writing to the lower half of the SECONDS register.

17.2.6 SAFETY WINDOW FOR REGISTER READS AND WRITES

The RTCSYNC bit indicates a time window during which the RTCC clock domain registers can be safely read and written without concern about a rollover. When RTCSYNC = 0, the registers can be safely accessed by the CPU.

Whether RTCSYNC = 1 or 0, the user should employ a firmware solution to ensure that the data read did not fall on a rollover boundary, resulting in an invalid or partial read. This firmware solution would consist of reading each register twice and then comparing the two values. If the two values matched, then a rollover did not occur.

17.2.7 WRITE LOCK

In order to perform a write to any of the RTCC Timer registers, the RTCWREN bit (RTCCFG<5>) must be set.

To avoid accidental writes to the RTCC Timer register, it is recommended that the RTCWREN bit (RTCCFG<5>) be kept clear when not writing to the register. For the RTCWREN bit to be set, there is only one instruction cycle time window allowed between the 55h/AA sequence and the setting of RTCWREN. For that reason, it is recommended that users follow the code example in Example 17-1.

EXAMPLE 17-1: SETTING THE RTCWREN BIT

movlw	0x55
movwf	EECON2
movlw	AAx0
movwf	EECON2
bsf	RTCCFG, RTCWREN

17.2.8 REGISTER MAPPING

To limit the register interface, the RTCC Timer and Alarm Timer registers are accessed through corresponding Register Pointers. The RTCC Value register window (RTCVALH and RTCVALL) uses the RTCPTRx bits (RTCCFG<1:0>) to select the required Timer register pair.

By reading or writing to the RTCVALH register, the RTCC Pointer value (RTCPTR<1:0>) decrements by '1' until it reaches '00'. When '00' is reached, the MINUTES and SECONDS value is accessible through RTCVALH and RTCVALL until the pointer value is manually changed.

TABLE 17-3:	RTCVALH AND RTCVALL
	REGISTER MAPPING

RTCPTR<1:0>	RTCC Value Register Window				
	RTCVALH	RTCVALL			
00	MINUTES	SECONDS			
01	WEEKDAY	HOURS			
10	MONTH	DAY			
11	—	YEAR			

The Alarm Value register windows (ALRMVALH and ALRMVALL) use the ALRMPTR bits (ALRMCFG<1:0>) to select the desired alarm register pair.

By reading or writing to the ALRMVALH register, the Alarm Pointer value, ALRMPTR<1:0>, decrements by '1' until it reaches '00'. When it reaches '00', the ALRMMIN and ALRMSEC value is accessible through ALRMVALH and ALRMVALL until the pointer value is manually changed.

查询PIC18F67K90供应商 TABLE 17-4: ALRMVAL REGISTER

MAFFING							
ALRMPTR<1:0>	Alarm Value Register Window						
ALRIVIPIR 1.02	ALRMVALH	ALRMVALL					
00	ALRMMIN	ALRMSEC					
01	ALRMWD	ALRMHR					
10	ALRMMNTH	ALRMDAY					
11	—	—					

17.2.9 CALIBRATION

The real-time crystal input can be calibrated using the periodic auto-adjust feature. When properly calibrated, the RTCC can provide an error of less than three seconds per month.

To perform this calibration, find the number of error clock pulses and store the value into the lower half of the RTCCAL register. The 8-bit, signed value, loaded into RTCCAL, is multiplied by four and will be either added or subtracted from the RTCC timer, once every minute.

To calibrate the RTCC module:

- 1. Use another timer resource on the device to find the error of the 32.768 kHz crystal.
- 2. Convert the number of error clock pulses per minute (see Equation 17-1).

EQUATION 17-1: CONVERTING ERROR CLOCK PULSES

(Ideal Frequency (32,758) – Measured Frequency) * 60 = Error Clocks per Minute

- If the oscillator is *faster* than ideal (negative result from step 2), the RCFGCALL register value needs to be negative. This causes the specified number of clock pulses to be subtracted from the timer counter once every minute.
- If the oscillator is *slower* than ideal (positive result from step 2), the RCFGCALL register value needs to be positive. This causes the specified number of clock pulses to be added to the timer counter once every minute.
- 3. Load the RTCCAL register with the correct value.

Writes to the RTCCAL register should occur only when the timer is turned off or immediately after the rising edge of the seconds pulse.

Note:	In determining the crystal's error value, it is the user's responsibility to include the
	crystal's initial error from drift due to temperature or crystal aging.

17.3 Alarm

The Alarm features and characteristics are:

- · Configurable from half a second to one year
- Enabled using the ALRMEN bit (ALRMCFG<7>, Register 17-4)
- Offers one-time and repeat alarm options

17.3.1 CONFIGURING THE ALARM

The alarm feature is enabled using the ALRMEN bit.

This bit is cleared when an alarm is issued. The bit will not be cleared if the CHIME bit = $1 \text{ or if } ALRMRPT \neq 0$.

The interval selection of the alarm is configured through the ALRMCFG bits (AMASK<3:0>) (see Figure 17-5). These bits determine which and how many digits of the alarm must match the clock value for the alarm to occur.

The alarm can also be configured to repeat based on a preconfigured interval. The number of times this occurs, after the alarm is enabled, is stored in the ALRMRPT register.

Note:	While the alarm is enabled (ALRMEN = 1), changing any of the registers, other than the RTCCAL, ALRMCFG and ALRMRPT registers and the CHIME bit, can result in a false alarm event leading to a false alarm interrupt. To avoid this, only change the timer and alarm values while the alarm is disabled (ALRMEN = 0). It is recommended that the ALRMCFG and ALRMRPT registers and CHIME bit be
	changed when RTCSYNC = 0.

查询PIC18F67K90供应商

Alarm Mask Setting AMASK<3:0>	Day of the Week	e Month Day	Hours	Minutes Seconds
0000 – Every half second 0001 – Every second				:
0010 – Every 10 seconds				: S
0011 – Every minute				: S S
0100 – Every 10 minutes				m : s s
0101 – Every hour				: m m : s s
0110 – Every day			hh	mm:ss
0111 – Every week	d		hh	m m : s s
1000 – Every month			hh	: m m : s s
1001 – Every year ⁽¹⁾		m m / d d	hh	; m m ; s s
Note 1: Annually, except when c	configured for	February 29.		

When ALRMCFG = 00 and the CHIME bit = 0 (ALRMCFG<6>), the repeat function is disabled and only a single alarm will occur. The alarm can be repeated up to 255 times by loading the ALRMRPT register with FFh.

After each alarm is issued, the ALRMRPT register is decremented by one. Once the register has reached '00', the alarm will be issued one last time.

After the alarm is issued a last time, the ALRMEN bit is cleared automatically and the alarm turned off. Indefinite repetition of the alarm can occur if the CHIME bit = 1.

When CHIME = 1, the alarm is not disabled when the ALRMRPT register reaches '00', but it rolls over to FF and continues counting indefinitely.

17.3.2 ALARM INTERRUPT

At every alarm event, an interrupt is generated. Additionally, an alarm pulse output is provided that operates at half the frequency of the alarm.

The alarm pulse output is completely synchronous with the RTCC clock and can be used as a trigger clock to other peripherals. This output is available on the RTCC pin. The output pulse is a clock with a 50% duty cycle and a frequency half that of the alarm event (see Figure 17-6).

The RTCC pin also can output the seconds clock. The user can select between the alarm pulse, generated by the RTCC module, or the seconds clock output.

The RTSECSEL<1:0> bits (PADCFG1<2:1>) select between these two outputs:

- Alarm pulse RTSECSEL<1:0> = 00
- Seconds clock RTSECSEL<1:0> = 01

查询PIC18F67K90	供应商
FIGURE 17-6:	TIMER PULSE GENERATION
RTCEN bit	t
ALRMEN bit	
RTCC Alarm Event	
RTCC Pin	

17.4 Sleep Mode

The timer and alarm continue to operate while in Sleep mode. The operation of the alarm is not affected by Sleep, as an alarm event can always wake up the CPU.

The Idle mode does not affect the operation of the timer or alarm.

17.5 Reset

17.5.1 DEVICE RESET

When a device Reset occurs, the ALRMRPT register is forced to its Reset state causing the alarm to be disabled (if enabled prior to the Reset). If the RTCC was enabled, it will continue to operate when a basic device Reset occurs.

17.5.2 POWER-ON RESET (POR)

The RTCCFG and ALRMRPT registers are reset only on a POR. Once the device exits the POR state, the clock registers should be reloaded with the desired values.

The timer prescaler values can be reset only by writing to the SECONDS register. No device Reset can affect the prescalers.

查询PIC18F67K90供应商

17.6 Register Maps

Table 17-5, Table 17-6 and Table 17-7 summarize the registers associated with the RTCC module.

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets on Page:
RTCCFG	RTCEN	_	RTCWREN	RTCSYNC	HALFSEC	RTCOE	RTCPTR1	RTCPTR0	78
RTCCAL	CAL7	CAL6	CAL5	CAL4	CAL3	CAL2	CAL1	CAL0	78
PADCFG1	RDPU	REPU	RJPU ⁽¹⁾	_	_	RTSECSEL1	RTSECSEL0	—	78
ALRMCFG	ALRMEN	CHIME	AMASK3	AMASK2	AMASK1	AMASK0	ALRMPTR1	ALRMPTR0	78
ALRMRPT	ARPT7	ARPT6	ARPT5	ARPT4	ARPT3	ARPT2	ARPT1	ARPT0	78

TABLE 17-5: RTCC CONTROL REGISTERS

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal for 80-pin devices.

Note 1: Not available on 64-pin devices.

TABLE 17-6: RTCC VALUE REGISTERS

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets on Page:
RTCVALH	TCVALH RTCC Value High Register Window Based on RTCPTR<1:0>								78
RTCVALL	RTCVALL RTCC Value Low Register Window Based on RTCPTR<1:0>								78

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal for 80-pin devices.

TABLE 17-7: ALARM VALUE REGISTERS

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets on Page:
ALRMVALH	Alarm Value High Register Window Based on ALRMPTR<1:0>								78
ALRMVALL	Alarm Value L	Alarm Value Low Register Window Based on ALRMPTR<1:0>							

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal for 80-pin devices.

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商

18.0 CAPTURE/COMPARE/PWM (CCP) MODULES

PIC18F87K90 family devices have seven CCP (Capture/Compare/PWM) modules, designated CCP4 through CCP10. All the modules implement standard Capture, Compare and Pulse-Width Modulation (PWM) modes.

Note: Throughout this section, generic references are used for register and bit names that are the same, except for an 'x' variable that indicates the item's association with the specific CCP module. For example, the control register is named CCPxCON and refers to CCP4CON through CCP10CON. Each CCP module contains a 16-bit register that can operate as a 16-bit Capture register, a 16-bit Compare register or a PWM Master/Slave Duty Cycle register. For the sake of clarity, all CCP module operation in the following sections is described with respect to CCP4, but is equally applicable to CCP5 through CCP10.

Note: The CCP9 and CCP10 modules are disabled on the devices with 32 Kbytes of program memory (PIC18FX5K90).

REGISTER 18-1: CCPxCON: CCPx CONTROL REGISTER (CCP4-CCP10 MODULES)⁽¹⁾

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
	_	DCxB1	DCxB0	CCPxM3	CCPxM2	CCPxM1	CCPxM0				
bit 7							bit 0				
Legend:											
R = Readab		W = Writable		•	nented bit, read						
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown				
bit 7-6	Unimpleme	nted: Read as ')'								
bit 5-4	DCxB<1:0>:	PWM Duty Cyc	le for CCPx N	Iodule bits (bit 1	, bit 0)						
	Capture mod	<u>le:</u>									
	Unused.										
		Compare mode:									
	Unused.										
	PWM mode:		o				. .				
		re the two Least ant bits (DCxB<					ie. The eight				
bit 3-0	Most Significant bits (DCxB<9:2>) of the duty cycle are found in CCPRxL. CCPxM<3:0>: CCPx Module Mode Select bits										
	0000 = Cap	oture/Compare/F	WM disabled	(resets CCPx m	nodule)						
	0001 = Res	0001 = Reserved									
		npare mode: tog	gle output on	match (CCPxIF	bit is set)						
	0011 = Res		n falling adap								
		0100 = Capture mode: every falling edge 0101 = Capture mode: every rising edge									
		oture mode: eve		dae							
		oture mode: eve		•							
	1000 = Cor	npare mode: init	initialize CCPx pin low; on compare match, force CCPx pin high (CCPxIF bit								
	is s	et)									
		npare mode: init	ialize CCPx p	in high; on comp	pare match, for	et)					

- 1011 = Compare mode: Special Event Trigger; reset timer on CCPx match (CCPxIF bit is set)⁽²⁾
- 11xx = PWM mode
- **Note 1:** The CCP9 and CCP10 modules are not available on devices with 32 Kbytes of program memory (PIC18FX5K90).
 - 2: CCPxM<3:0> = 1011 will only reset the timer and not start A/D conversion on CCPx match.

查询PIC18F67K90供应商

REGISTER 18-2: CCPTMRS1: CCPx TIMER SELECT REGISTER 1

R/W-0	R/W-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
C7TSEL1	C7TSEL0	—	C6TSEL0	_	C5TSEL0	C4TSEL1	C4TSEL0
bit 7							bit 0

Legend:									
R = Readal	ble bit	W = Writable bit	U = Unimplemented bit,	read as '0'					
-n = Value a	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown					
bit 7-6	C7TSEL	<1:0>: CCP7 Timer Selection	n bits						
	01 = CC 10 = CC	CP7 is based off of TMR1/TM CP7 is based off of TMR5/TM CP7 is based off of TMR5/TM CP7 is based off of TMR5/TM	IR4 IR6						
bit 5	Unimple	mented: Read as '0'							
bit 4	C6TSEL	C6TSEL0: CCP6 Timer Selection bit							
		P6 is based off of TMR1/TMR P6 is based off of TMR5/TMR							
bit 3	Unimple	mented: Read as '0'							
bit 2	C5TSEL	0: CCP5 Timer Selection bit							
		P5 is based off of TMR1/TMR P5 is based off of TMR5/TMR							
bit 1-0	C4TSEL<1:0>: CCP4 Timer Selection bits								
	01 = CO 10 = CO	CP4 is based off of TMR1/TM CP4 is based off of TMR3/TM CP4 is based off of TMR3/TM eserved; do not use	1R4						

查询PIC18F67K90供应商 REGISTER 18-3: CCPTMRS2: CCPx TIMER SELECT REGISTER 2

U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
	_	_	C10TSEL0 ⁽¹⁾	_	C9TSEL0 ⁽¹⁾	C8TSEL1	C8TSEL0
bit 7							bit 0

Legend:				
R = Reada	able bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
bit 7-5	Unimple	mented: Read as '0'		
bit 4	0 = CCF	L0: CCP10 Timer Selection b P10 is based off of TMR1/TMF P10 is based off of TMR7/TMF	82	
bit 3	Unimple	mented: Read as '0'		
bit 2	0 = CCF	0: CCP9 Timer Selection bit P9 is based off of TMR1/TMR2 P9 is based off of TMR7/TMR4	-	
bit 1-0	$ \begin{array}{r} On non 3 \\ 00 = C0 \\ 01 = C0 \\ 10 = C0 \\ 11 = Re \\ On 32-K \\ 00 = C0 \\ 01 = C0 \\ 10 = C0 \end{array} $	<1:0>: CCP8 Timer Selection <u>32-Kbyte device variants</u> : CP8 is based off of TMR1/TMI CP8 is based off of TMR7/TMI CP8 is based off of TMR7/TMI eserved; do not use <u>byte device variants (PIC18F8</u> CP8 is based off of TMR1/TMI CP8 is based off of TMR1/TMI	R2 R4 R6 8 <u>5K90/65K90:</u> R2 R4	

Note 1: This bit is unimplemented and reads as '0' on devices with 32 Kbytes of program memory (PIC18FX5K90).

查询PIC18F67K90供应商

REGISTER 18-4: CCPRxL: CCPx PERIOD LOW BYTE REGISTER

| R/W-x |
|---------|---------|---------|---------|---------|---------|---------|---------|
| CCPRxL7 | CCPRxL6 | CCPRxL5 | CCPRxL4 | CCPRxL3 | CCPRxL2 | CCPRxL1 | CCPRxL0 |
| bit 7 | | | | | | | bit 0 |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 CCPRxL<7:0>: CCPx Period Register Low Byte bits Capture Mode: Capture register low byte. Compare Mode: Compare register low byte. <u>PWM Mode:</u> Duty Cycle register low byte.

REGISTER 18-5: CCPRxH: CCPx PERIOD HIGH BYTE REGISTER

| R/W-x |
|---------|---------|---------|---------|---------|---------|---------|---------|
| CCPRxH7 | CCPRxH6 | CCPRxH5 | CCPRxH4 | CCPRxH3 | CCPRxH2 | CCPRxH1 | CCPRxH0 |
| bit 7 | | | | | | | bit 0 |

Legend:					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 7-0 CCPRxH<7:0>: CCPx Period Register High Byte bits <u>Capture Mode:</u> Capture register high byte. <u>Compare Mode:</u> Compare register high byte. <u>PWM Mode:</u> Duty Cycle Buffer register high byte.

查询PIC18F67K90供应商 18.1 CCP Module Configuration

Each Capture/Compare/PWM module is associated with a control register (generically, CCPxCON) and a data register (CCPRx). The data register, in turn, is comprised of two 8-bit registers: CCPRxL (low byte) and CCPRxH (high byte). All registers are both readable and writable.

18.1.1 CCP MODULES AND TIMER RESOURCES

The CCP modules utilize Timers, 1 through 8, varying with the selected mode. Various timers are available to the CCP modules in Capture, Compare or PWM modes, as shown in Table 18-1.

TABLE 18-1: CCP MODE – TIMER RESOURCE

CCP Mode	Timer Resource
Capture	Timor1 Timor2 Timor 5 or Timor7
Compare	Timer1, Timer3, Timer 5 or Timer7
PWM	Timer2, Timer4, Timer 6 or Timer8

The assignment of a particular timer to a module is determined by the Timer to CCP enable bits in the CCPTMRSx registers. (See Register 18-2 and Register 18-3.) All of the modules may be active at once and may share the same timer resource if they are configured to operate in the same mode (Capture/Compare or PWM) at the same time.

The CCPTMRS1 register selects the timers for CCP modules, 7, 6, 5 and 4, and the CCPTMRS2 register selects the timers for CCP modules, 10, 9 and 8. The possible configurations are shown in Table 18-2 and Table 18-3.

TABLE 18-2: TIMER ASSIGNMENTS FOR CCP MODULES 4, 5, 6 AND 7

	CCPTMRS1 Register										
CCP4 CCP5						CCP6			CCP7		
C4TSEL <1:0>	Capture/ Compare Mode	PWM Mode	C5TSEL0	Capture/ Compare Mode	PWM Mode	C6TSEL0	Capture/ Compare Mode	PWM Mode	C7TSEL <1:0>	Capture/ Compare Mode	PWM Mode
0 0	TMR1	TMR2	0	TMR1	TMR2	0	TMR1	TMR2	0 0	TMR1	TMR2
0 1	TMR3	TMR4	1	TMR5	TMR4	1	TMR5	TMR2	0 1	TMR5	TMR4
1 0	TMR3	TMR6							1 0	TMR5	TMR6
1 1	Reserve	ed ⁽¹⁾							1 1	TMR5	TMR8

Note 1: Do not use the reserved bits.

TABLE 18-3: TIMER ASSIGNMENTS FOR CCP MODULES 8, 9 AND 10

				C	CPTMF	RS2 Regist	ter				
	CCP8	CCP8 Devices with 32 Kbytes			oytes ⁽¹⁾	CCP9 ⁽¹⁾			CCP10 ⁽¹⁾		
C8TSEL <1:0>	Capture/ Compare Mode	PWM Mode	C8TSEL <1:0>	Capture/ Compare Mode	PWM Mode	C9TSEL0 Mode		C10TSEL0	Capture/ Compare Mode	PWM Mode	
0 0	TMR1	TMR2	0 0	TMR1	TMR2	0	TMR1	TMR2	0	TMR1	TMR2
0 1	TMR7	TMR4	0 1	TMR1	TMR4	1	TMR7	TMR4	1	TMR7	TMR2
1 0	TMR7	TMR6	1 0	TMR1	TMR6						
1 1	Reserve	ed ⁽²⁾	11	Reserve	ed ⁽²⁾						

Note 1: Module not available for devices with 32 Kbytes of program memory.

2: Do not use the reserved bits.

查询PIC18F67K90供应商

18.1.2 OPEN-DRAIN OUTPUT OPTION

When operating in Output mode (the Compare or PWM modes), the drivers for the CCPx pins can be optionally configured as open-drain outputs. This feature allows the voltage level on the pin to be pulled to a higher level through an external pull-up resistor and allows the output to communicate with external circuits without the need for additional level shifters.

The open-drain output option is controlled by the CCPxOD bits (ODCON2<7:2>). Setting the appropriate bit configures the pin for the corresponding module for open-drain operation.

18.1.3 PIN ASSIGNMENT FOR CCP6, CCP7, CCP8 AND CCP9

The pin assignment for CCP6/7/8/9 (Capture input, Compare and PWM output) can change, based on the device configuration.

The ECCPMX Configuration bit (CONFIG3H<1>) determines the pin to which CCP6/7/8/9 is multiplexed. The pin assignments for these CCP modules are given in Table 18-4.

TABLE 18-4: CCP PIN ASSIGNMENT

ЕССРМХ	Pin Mapped To								
Value	CCP6	CCP7	CCP8	CC9					
1 (Default)	RE6	RE5	RE4	RE3					
0	RH7	RH6	RH5	RH4					

18.2 Capture Mode

In Capture mode, the CCPR4H:CCPR4L register pair captures the 16-bit value of the TMR1 or TMR3 register when an event occurs on the CCP4 pins. An event is defined as one of the following:

- · Every falling edge
- Every rising edge
- Every 4th rising edge
- · Every 16th rising edge

The event is selected by the mode select bits, CCP4M<3:0> (CCP4CON<3:0>). When a capture is made, the interrupt request flag bit, CCP4IF (PIR4<1>), is set. (It must be cleared in software.) If another capture occurs before the value in CCPR4 is read, the old captured value is overwritten by the new captured value.

Figure 18-1 shows the Capture mode block diagram.

18.2.1 CCP PIN CONFIGURATION

In Capture mode, the appropriate CCPx pin should be configured as an input by setting the corresponding TRIS direction bit.

Note:	If RC1 or RE7 is configured as a CCP4
	output, a write to the port causes a capture
	condition.

18.2.2 TIMER1/3/5/7 MODE SELECTION

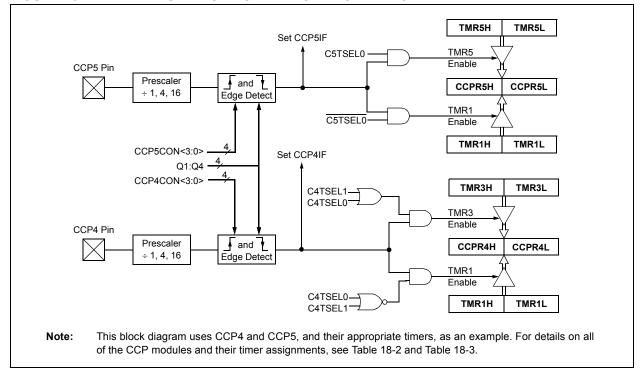
For the available timers (1/3/5/7) to be used for the capture feature, the used timers must be running in Timer mode or Synchronized Counter mode. In Asynchronous Counter mode, the capture operation may not work.

The timer to be used with each CCP module is selected in the CCPTMRSx registers. (See Section 18.1.1 "CCP Modules and Timer Resources".)

Details of the timer assignments for the CCP modules are given in Table 18-2 and Table 18-3.

查询PIC18F67K90供应商





18.2.3 SOFTWARE INTERRUPT

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep the CCP4IE bit (PIE4<1>) clear to avoid false interrupts and should clear the flag bit, CCP4IF, following any such change in operating mode.

18.2.4 CCP PRESCALER

There are four prescaler settings in Capture mode. They are specified as part of the operating mode selected by the mode select bits (CCP4M<3:0>). Whenever the CCP module is turned off, or the CCP module is not in Capture mode, the prescaler counter is cleared. This means that any Reset will clear the prescaler counter. Switching from one capture prescaler to another may generate an interrupt. Doing that also will not clear the prescaler counter – meaning the first capture may be from a non-zero prescaler.

Example 18-1 shows the recommended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the "false" interrupt.

EXAMPLE 18-1: CHANGING BETWEEN CAPTURE PRESCALERS

CLRF	CCP4CON	;	Turn CCP module off
MOVLW	NEW_CAPT_PS	;	Load WREG with the
		;	new prescaler mode
		;	value and CCP ON
MOVWF	CCP4CON	;	Load CCP4CON with
		;	this value

查询PIC18F67K90供应商 18.3 Compare Mode

In Compare mode, the 16-bit CCPR4 register value is constantly compared against either the TMR1 or TMR3 register pair value. When a match occurs, the CCP4 pin can be:

- Driven high
- · Driven low
- Toggled (high-to-low or low-to-high)
- Unchanged (that is, reflecting the state of the I/O latch)

The action on the pin is based on the value of the mode select bits (CCP4M<3:0>). At the same time, the interrupt flag bit, CCP4IF, is set.

Figure 18-2 shows the Compare mode block diagram

18.3.1 CCP PIN CONFIGURATION

The user must configure the CCPx pin as an output by clearing the appropriate TRIS bit.

Note: Clearing the CCP4CON register will force the RC1 or RE7 compare output latch (depending on device configuration) to the default low level. This is not the PORTC or PORTE I/O data latch.

18.3.2 TIMER1/3/5/7 MODE SELECTION

If the CCP module is using the compare feature in conjunction with any of the Timer1/3/5/7 timers, the timers must be running in Timer mode or Synchronized Counter mode. In Asynchronous Counter mode, the compare operation may not work.

Note:	Details of the timer assignments for the
	CCP modules are given in Table 18-2 and
	Table 18-3.

18.3.3 SOFTWARE INTERRUPT MODE

When the Generate Software Interrupt mode is chosen (CCP4M<3:0> = 1010), the CCP4 pin is not affected. Only a CCP interrupt is generated, if enabled, and the CCP4IE bit is set.

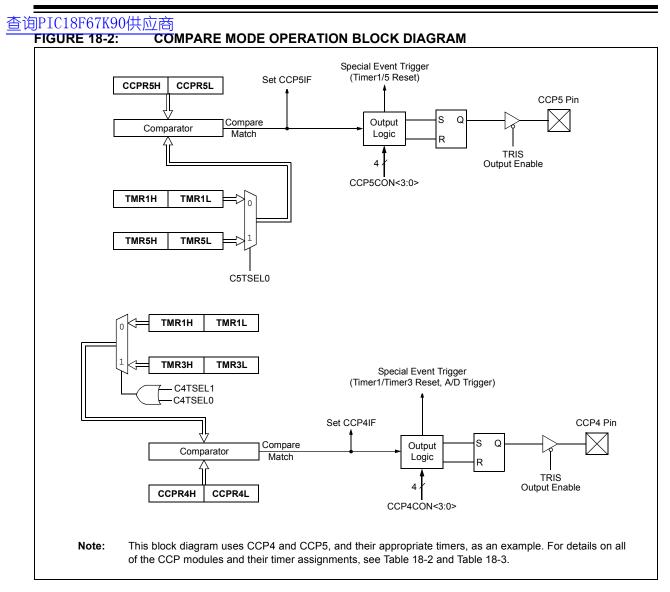
18.3.4 SPECIAL EVENT TRIGGER

Both CCP modules are equipped with a Special Event Trigger. This is an internal hardware signal generated in Compare mode to trigger actions by other modules. The Special Event Trigger is enabled by selecting the Compare Special Event Trigger mode (CCP4M<3:0> = 1011).

For either CCP module, the Special Event Trigger resets the timer register pair for whichever timer resource is currently assigned as the module's time base. This allows the CCPRx registers to serve as a programmable period register for either timer.

The Special Event Trigger for CCP4 cannot start an A/D conversion.

Note: The Special Event Trigger of ECCP1 can start an A/D conversion, but the A/D Converter needs to be enabled. For more information, see Section 19.0 "Enhanced Capture/Compare/PWM (ECCP) Module".



查询PIC18F67K90供应商

TABLE 18-5: REGISTERS ASSOCIATED WITH CAPTURE, COMPARE, TIMER1/3/5/7

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
RCON	IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	74
PIR4	CCP10IF ⁽¹⁾	CCP9IF ⁽¹⁾	CCP8IF	CCP7IF	CCP6IF	CCP5IF	CCP4IF	CCP3IF	75
PIE4	CCP10IE ⁽¹⁾	CCP9IE ⁽¹⁾	CCP8IE	CCP7IE	CCP6IE	CCP5IE	CCP4IE	CCP3IE	75
IPR4	CCP10IP ⁽¹⁾	CCP9IP ⁽¹⁾	CCP8IP	CCP7IP	CCP6IP	CCP5IP	CCP4IP	CCP3IP	75
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	76
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	76
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	76
TRISH ⁽¹⁾	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	76
TMR1L	Timer1 Reg	ister Low By	/te						74
TMR1H	Timer1 Reg	ister High B	yte						74
TMR3L	Timer3 Reg	ister Low By	/te						75
TMR3H	Timer3 Reg	ister High B	yte						75
TMR5L	Timer5 Reg	ister Low By	/te						80
TMR5H	Timer5 Reg	Fimer5 Register High Byte							
TMR7L	Timer7 Reg	Timer7 Register Low Byte							
TMR7H	Timer7 Reg	ister High B	yte						79
T1CON	TMR1CS1	TMR1CS0	T1CKPS1	T1CKPS0	SOSCEN	T1SYNC	RD16	TMR10N	74
T3CON	TMR3CS1	TMR3CS0	T3CKPS1	T3CKPS0	SOSCEN	T3SYNC	RD16	TMR3ON	75
T5CON	TMR5CS1	TMR5CS0	T5CKPS1	T5CKPS0	SOSCEN	T5SYNC	RD16	TMR5ON	80
T7CON	TMR7CS1	TMR7CS0	T7CKPS1	T7CKPS0	SOSCEN	T7SYNC	RD16	TMR7ON	79
CCPR4L	Capture/Co	mpare/PWM	1 Register	4 Low Byte					80
CCPR4H	Capture/Co	mpare/PWM	1 Register	4 High Byte					80
CCPR5L	Capture/Co	mpare/PWM	1 Register	5 Low Byte					80
CCPR5H	Capture/Co	mpare/PWM	1 Register	5 High Byte					80
CCPR6L	Capture/Co	mpare/PWM	1 Register	6 Low Byte					80
CCPR6H	Capture/Co	mpare/PWM	1 Register	6 High Byte					80
CCPR7L	Capture/Co	mpare/PWM	1 Register	7 Low Byte					80
CCPR7H	Capture/Co	mpare/PWM	1 Register	7 High Byte					80
CCPR8L	Capture/Co	mpare/PWM	1 Register	8 Low Byte					78
CCPR8H	Capture/Co	mpare/PWM	1 Register	8 High Byte					78
CCPR9L ⁽¹⁾	Capture/Co	mpare/PWM	1 Register	9 Low Byte					78
CCPR9H ⁽¹⁾	Capture/Co	mpare/PWM	1 Register	9 High Byte					78
CCPR10L ⁽¹⁾	Capture/Co	mpare/PWM	1 Register	10 Low Byte	;				79
CCPR10H ⁽¹⁾	Capture/Co	mpare/PWM	1 Register	10 High Byte	Э				78
CCP4CON			DC4B1	DC4B0	CCP4M3	CCP4M2	CCP4M1	CCP4M0	80
CCP5CON		—	DC5B1	DC5B0	CCP5M3	CCP5M2	CCP5M1	CCP5M0	80

Legend: — = unimplemented, read as '0'. Shaded cells are not used by Capture/Compare or Timer1/3/5/7.

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商 TABLE 18-5: REGISTERS ASSOCIATED WITH CAPTURE, COMPARE, TIMER1/3/5/7 (CONTINUED)

				1	, 	· · · · ·		· · · · · · · · · · · · · · · · · · ·	· · · · · · · · · · · · · · · · · · ·
Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
CCP6CON	_	_	DC6B1	DC6B0	CCP6M3	CCP6M2	CCP6M1	CCP6M0	80
CCP7CON	_	—	DC7B1	DC7B0	CCP7M3	CCP7M2	CCP7M1	CCP7M0	80
CCP8CON	_	—	DC8B1	DC8B0	CCP8M3	CCP8M2	CCP8M1	CCP8M0	78
CCP9CON ⁽¹⁾	_	—	DC9B1	DC9B0	CCP9M3	CCP9M2	CCP9M1	CCP9M0	78
CCP10CON ⁽¹⁾	_	—	DC10B1	DC10B0	CCP10M3	CCP10M2	CCP10M1	CCP10M0	79
CCPTMRS1	C7TSEL1	C7TSEL0	—	C6TSEL0	—	C5TSEL0	C4TSEL1	C4TSEL0	79
CCPTMRS2		_	_	C10TSEL0	—	C9TSEL0	C8TSEL1	C8TSEL0	79

Legend: — = unimplemented, read as '0'. Shaded cells are not used by Capture/Compare or Timer1/3/5/7.

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

18.4 PWM Mode

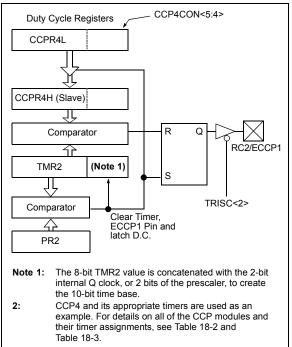
In Pulse-Width Modulation (PWM) mode, the CCP4 pin produces up to a 10-bit resolution PWM output. Since the CCP4 pin is multiplexed with a PORTC or PORTE data latch, the appropriate TRIS bit must be cleared to make the CCP4 pin an output.

Note:	Clearing the CCP4CON register will force the RC1 or RE7 output latch (depending
	on device configuration) to the default low
	level. This is not the PORTC or PORTE
	I/O data latch.

Figure 18-3 shows a simplified block diagram of the ECCP1 module in PWM mode.

For a step-by-step procedure on how to set up the CCP module for PWM operation, see **Section 18.4.3** "Setup for PWM Operation".

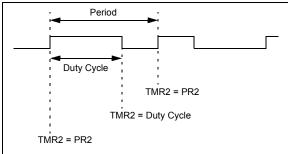




查询PIC18F67K90供应商

A PWM output (Figure 18-4) has a time base (period) and a time that the output stays high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).

FIGURE 18-4: PWM OUTPUT



18.4.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following formula:

EQUATION 18-1:

 $PWM Period = [(PR2) + 1] \cdot 4 \cdot TOSC \cdot (TMR2 Prescale Value)$

PWM frequency is defined as 1/[PWM period].

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- TMR2 is cleared
- The CCP4 pin is set
 - (An exception: If PWM duty cycle = 0%, the CCP4 pin will not be set)
- The PWM duty cycle is latched from CCPR4L into CCPR4H
- Note: The Timer2 postscalers (see Section 14.0 "Timer2 Module") are not used in the determination of the PWM frequency. The postscaler could be used to have a servo update rate at a different frequency than the PWM output.

18.4.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR4L register (using CCP4 as an example) and to the CCP4CON<5:4> bits. Up to 10-bit resolution is available. The CCPR4L contains the eight MSbs and the CCP4CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPR4L:CCP4CON<5:4>. The following equation is used to calculate the PWM duty cycle in time:

EQUATION 18-2:

```
PWM Duty Cycle = (CCPR4L:CCP4CON<5:4>) •
Tosc • (TMR2 Prescale Value)
```

CCPR4L and CCP4CON<5:4> can be written to at any time, but the duty cycle value is not latched into CCPR4H until after a match between PR2 and TMR2 occurs (that is, the period is complete). In PWM mode, CCPR4H is a read-only register.

The CCPR4H register and a 2-bit internal latch are used to double-buffer the PWM duty cycle. This double-buffering is essential for glitchless PWM operation.

When the CCPR4H and 2-bit latch match TMR2, concatenated with an internal 2-bit Q clock or two bits of the TMR2 prescaler, the CCP4 pin is cleared.

The maximum PWM resolution (bits) for a given PWM frequency is given by the equation:

EQUATION 18-3:

PWM Resolution (max) =
$$\frac{\log(\frac{FOSC}{FPWM})}{\log(2)}$$
 bits

Note: If the PWM duty cycle value is longer than the PWM period, the CCP4 pin will not be cleared.

TABLE 18-6: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 40 MHz

PWM Frequency	2.44 kHz	9.77 kHz	39.06 kHz	156.25 kHz	312.50 kHz	416.67 kHz
Timer Prescaler (1, 4, 16)	16	4	1	1	1	1
PR2 Value	FFh	FFh	FFh	3Fh	1Fh	17h
Maximum Resolution (bits)	14	12	10	8	7	6.58

查询PIC18F67K90供应商 18.4.3 SETUP FOR PWM OPERATION

To configure the CCP module for PWM operation (with CCP4 as an example):

- 1. Set the PWM period by writing to the PR2 register.
- 2. Set the PWM duty cycle by writing to the CCPR4L register and CCP4CON<5:4> bits.
- 3. Make the CCP4 pin an output by clearing the appropriate TRIS bit.
- 4. Set the TMR2 prescale value, then enable Timer2 by writing to T2CON.
- 5. Configure the CCP4 module for PWM operation.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
RCON	IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	74
PIR4	CCP10IF ⁽¹⁾	CCP9IF ⁽¹⁾	CCP8IF	CCP7IF	CCP6IF	CCP5IF	CCP4IF	CCP3IF	75
PIE4	CCP10IE ⁽¹⁾	CCP9IE ⁽¹⁾	CCP8IE	CCP7IE	CCP6IE	CCP5IE	CCP4IE	CCP3IE	75
IPR4	CCP10IP ⁽¹⁾	CCP9IP ⁽¹⁾	CCP8IP	CCP7IP	CCP6IP	CCP5IP	CCP4IP	CCP3IP	75
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	76
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	76
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	76
TRISH	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	76
TMR2	Timer2 Regis	ter					•		74
TMR4	Timer4 Regis	ter							80
TMR6	Timer6 Regis	ter							79
TMR8	Timer8 Regis	ter							79
PR2	Timer2 Period	d Register							74
PR4	Timer4 Period	d Register							80
PR6	Timer6 Period	d Register							79
PR8	Timer8 Period	d Register							79
T2CON	—	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	74
T4CON	_	T4OUTPS3	T4OUTPS2	T4OUTPS1	T4OUTPS0	TMR4ON	T4CKPS1	T4CKPS0	80
T6CON	—	T6OUTPS3	T6OUTPS2	T6OUTPS1	T6OUTPS0	TMR6ON	T6CKPS1	T6CKPS0	79
T8CON	—	T8OUTPS3	T8OUTPS2	T8OUTPS1	T8OUTPS0	TMR8ON	T8CKPS1	T8CKPS0	79
CCPR4L	Capture/Com	pare/PWM R	egister 4 Low	v Byte					80
CCPR4H	Capture/Com	pare/PWM R	egister 4 Hig	h Byte					80
CCPR5L	Capture/Com	pare/PWM R	egister 5 Lov	v Byte					80
CCPR5H	Capture/Com	pare/PWM R	egister 5 Hig	h Byte					80
CCPR6L	Capture/Com	pare/PWM R	egister 6 Lov	v Byte					80
CCPR6H	Capture/Com	pare/PWM R	egister 6 Hig	h Byte					80
CCPR7L	Capture/Com	pare/PWM R	egister 7 Lov	v Byte					80
CCPR7H	Capture/Com	pare/PWM R	egister 7 Hig	h Byte					80
CCPR8L	Capture/Com	pare/PWM R	egister 8 Lov	v Byte					78
CCPR8H	Capture/Com	pare/PWM R	egister 8 Hig	h Byte					78
CCPR9L ⁽¹⁾	Capture/Compare/PWM Register 9 Low Byte								78
CCPR9H ⁽¹⁾	Capture/Compare/PWM Register 9 High Byte								78
CCPR10L ⁽¹⁾	Capture/Com	pare/PWM R	egister 10 Lo	w Byte					79

TABLE 18-7: REGISTERS ASSOCIATED WITH PWM AND TIMERS

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PWM or Timer2/4/6/8.

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商

TABLE 18-7: REGISTERS ASSOCIATED WITH PWM AND TIMERS (CONTINUED)

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
CCPR10H ⁽¹⁾	Capture/Com	pare/PWM R	egister 10 Hi	gh Byte					78
CCP4CON	_	_	DC4B1	DC4B0	CCP4M3	CCP4M2	CCP4M1	CCP4M0	80
CCP5CON	_	_	DC5B1	DC5B0	CCP5M3	CCP5M2	CCP5M1	CCP5M0	80
CCP6CON	_	_	DC6B1	DC6B0	CCP6M3	CCP6M2	CCP6M1	CCP6M0	80
CCP7CON	_	_	DC7B1	DC7B0	CCP7M3	CCP7M2	CCP7M1	CCP7M0	80
CCP8CON	_	_	DC8B1	DC8B0	CCP8M3	CCP8M2	CCP8M1	CCP8M0	78
CCP9CON ⁽¹⁾	_	_	DC9B1	DC9B0	CCP9M3	CCP9M2	CCP9M1	CCP9M0	78
CCP10CON ⁽¹⁾	_	_	DC10B1	DC10B0	CCP10M3	CCP10M2	CCP10M1	CCP10M0	79
CCPTMRS1	C7TSEL1	C7TSEL0		C6TSEL0		C5TSEL0	C4TSEL1	C4TSEL0	79
CCPTMRS2		—		C10TSEL0		C9TSEL0	C8TSEL1	C8TSEL0	79

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PWM or Timer2/4/6/8.

Note 1: Unimplemented on devices with a program memory of 32 Kbytes (PIC18FX5K90).

查询PIC18F67K90供应商 19.0 ENHANCED

CAPTURE/COMPARE/PWM (ECCP) MODULE

PIC18F87K90 family devices have three Enhanced Capture/Compare/PWM (ECCP) modules: ECCP1, ECCP2 and ECCP3. These modules contain a 16-bit register, which can operate as a 16-bit Capture register, a 16-bit Compare register or a PWM Master/Slave Duty Cycle register. These ECCP modules are upward compatible with CCP

Note: Throughout this section, generic references are used for register and bit names that are the same, except for an 'x' variable that indicates the item's association with the ECCP1, ECCP2 or ECCP3 module. For example, the control register is named CCPxCON and refers to CCP1CON, CCP2CON and CCP3CON.

ECCP1, ECCP2 and ECCP3 are implemented as standard CCP modules with Enhanced PWM capabilities. These include:

- Provision for two or four output channels
- · Output Steering modes
- · Programmable polarity
- Programmable dead-band control
- · Automatic shutdown and restart

The enhanced features are discussed in detail in Section 19.4 "PWM (Enhanced Mode)".

The ECCP1, ECCP2 and ECCP3 modules use the control registers, CCP1CON, CCP2CON and CCP3CON. The control registers, CCP4CON through CCP10CON, are for the CCP4 through CCP10 modules.

查询PIC18F67K90供应商

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
PxM1	PxM0	DCxB1	DCxB0	CCPxM3	CCPxM2	CCPxM1	CCPxM0				
bit 7			1		I		bit				
Legend:											
R = Readab		W = Writable		-	mented bit, read						
-n = Value a	t POR	'1' = Bit is set	l	'0' = Bit is cle	ared	x = Bit is unkr	nown				
bit 7-6	PxM<1:0>:	Enhanced PWM	l Output Confi	guration bits							
	If CCPxM<3:2> = $00, 01, 10$:										
	xx = PxA is assigned as a capture/compare input/output; PxB, PxC and PxD are assigned as port pin										
	If CCPxM<3:2> = 11:										
	00 = Single output: PxA, PxB, PxC and PxD are controlled by steering (see Section 19.4.7 "Puls										
	Steering Mode")										
	01 = Full-bridge output forward: PxD is modulated; PxA is active; PxB, PxC are inactive 10 = Half-bridge output: PxA, PxB are modulated with dead-band control; PxC and PxD are										
	assigned as port pins										
	11 = Full-bridge output reverse: PxB is modulated; PxC is active; PxA and PxD are inactive										
oit 5-4	DCxB<1:0> : PWM Duty Cycle bit 1 and bit 0										
	Capture mode:										
	Unused.										
	Compare mode:										
	Unused.										
	PWM mode:										
	These bits are the two LSbs of the 10-bit PWM duty cycle. The eight MSbs of the duty cycle are found in CCDDvl										
bit 3-0	in CCPRxL. CCPxM<3:0>: ECCPx Mode Select bits										
DIL 3-0		pture/Compare/			lulo)						
	0000 - Ca				lule)						
		mpare mode: to	aale output or	n match							
	0011 = Ca		00								
	0100 = Capture mode: every falling edge										
	0101 = Capture mode: every rising edge										
		pture mode: eve									
	0111 = Capture mode: every 16 th rising edge										
	1000 = Compare mode: initialize the ECCPx pin low; set the output on a compare match (set CCPxIF										
	1001 = Compare mode: initialize the ECCPx pin high; clear the output on a compare match (set CCPxIF										
	1010 = Compare mode: generate a software interrupt only, ECCPx pin reverts to an I/O state										
	1011 = Compare mode: trigger special event (ECCPx resets TMR1 or TMR3, starts A/D conversion,										

- 1011 = Compare mode: trigger special event (ECCPx resets TMR1 or TMR3, starts A/D conversion, sets CCxIF bit)
- 1100 = PWM mode: PxA and PxC are active-high; PxB and PxD are active-high
- 1101 = PWM mode: PxA and PxC are active-high; PxB and PxD are active-low
- 1110 = PWM mode: PxA and PxC are active-low; PxB and PxD are active-high
- 1111 = PWM mode: PxA and PxC are active-low; PxB and PxD are active-low

查询PIC18F67K90供应商 REGISTER 19-2: CCPTMRS0: CCP TIMER SELECT 0 REGISTER

| R/W-0 |
|---------|---------|---------|---------|---------|---------|---------|---------|
| C3TSEL1 | C3TSEL0 | C2TSEL2 | C2TSEL1 | C2TSEL0 | C1TSEL2 | C1TSEL1 | C1TSEL0 |
| bit 7 | | | | | | | bit 0 |

				_egend:	
	read as '0'	U = Unimplemented bit,	W = Writable bit	R = Readable bit	
Iown	x = Bit is unknown	'0' = Bit is cleared	'1' = Bit is set	-n = Value at POR	
1		· · · · · · · · · · · · · · · · · · ·	'1' = Bit is set	POR	

	00 = ECCP3 is based off of TMR1/TMR2 01 = ECCP3 is based off of TMR3/TMR4 10 = ECCP3 is based off of TMR3/TMR6 11 = ECCP3 is based off of TMR3/TMR8
bit 5-3	C2TSEL<2:0>: ECCP2 Timer Selection bit
	000 = ECCP2 is based off of TMR1/TMR2
	001 = ECCP2 is based off of TMR3/TMR4
	010 = ECCP2 is based off of TMR3/TMR6 011 = ECCP2 is based off of TMR3/TMR8
	100 = ECCP2 is based off of TMR3/TMR10; option is reserved on the 32-Kbyte device variant; do not use
	101 = Reserved; do not use
	110 = Reserved; do not use
	111 = Reserved; do not use
bit 2-0	C1TSEL<2:0>: ECCP1 Timer Selection bit
	000 = ECCP1 is based off of TMR1/TMR2
	001 = ECCP1 is based off of TMR3/TMR4
	010 = ECCP1 is based off of TMR3/TMR6
	011 = ECCP1 is based off of TMR3/TMR8
	100 = ECCP1 is based off of TMR3/TMR10; option is reserved on the 32-Kbyte device variant; do not use
	101 = ECCP1 is based off of TMR3/TMR12; option is reserved on the 32-Kbyte device variant; do not use 110 = Reserved; do not use
	111 = Reserved; do not use

查询PIC18F67K90供应商

In addition to the expanded range of modes available through the CCPxCON and ECCPxAS registers, the ECCP modules have two additional registers associated with Enhanced PWM operation and auto-shutdown features. They are:

- ECCPxDEL Enhanced PWM Control
- PSTRxCON Pulse Steering Control

19.1 ECCP Outputs and Configuration

The Enhanced CCP module may have up to four PWM outputs, depending on the selected operating mode. The CCPxCON register is modified to allow control over four PWM outputs: ECCPx/PxA, PxB, PxC and PxD. Applications can use one, two or four of these outputs.

The outputs that are active depend on the ECCP operating mode selected. The pin assignments are summarized in Table 19-3.

To configure the I/O pins as PWM outputs, the proper PWM mode must be selected by setting the PxM<1:0> and CCPxM<3:0> bits. The appropriate TRIS direction bits for the port pins must also be set as outputs.

19.1.1 ECCP MODULE AND TIMER RESOURCES

The ECCP modules use Timers, 1, 2, 3, 4, 6, 8, 10 or 12, depending on the mode selected. These timers are available to CCP modules in Capture, Compare or PWM modes, as shown in Table 19-1.

TABLE 19-1:ECCP MODE – TIMERRESOURCE

ECCP Mode	Timer Resource
Capture	Timer1 or Timer3
Compare	Timer1 or Timer3
PWM	Timer2, Timer4, Timer6, Timer8,
	Timer10 or Timer12

The assignment of a particular timer to a module is determined by the Timer to ECCP enable bits in the CCPTMRSx register (Register 19-2). The interactions between the two modules are depicted in Figure 19-1. Capture operations are designed to be used when the timer is configured for Synchronous Counter mode. Capture operations may not work as expected if the associated timer is configured for Asynchronous Counter mode.

19.1.2 ECCP PIN ASSIGNMENT

The pin assignment for ECCPx (capture input, compare and PWM output) can change, based on device configuration. The ECCPMX (CONFIG3H<1>) Configuration bit determines to which pin, ECCP1 and ECCP3, are multiplexed to.

- Default/ECCPMX = 1:
 - ECCP1 (P1B/P1C) multiplexed onto RE6 and RE5
 - ECCP3 (P3B/P3C) multiplexed onto RE4 and RE3
- ECCPMX = 0:
 - ECCP1 (P1B/P1C) multiplexed onto RH7 and RH6
 - ECCP3 (P3B/P3C) multiplexed onto RH5 and RH4.

The pin assignment for ECCP2 (capture input, compare and PWM output) can change, based on device configuration.

The CCP2MX Configuration bit (CONFIG3H<0>) determines to which pin, ECCP2, is multiplexed.

- If CCP2MX = 1 (default) ECCP2 is multiplexed to RC1
- If CCP2MX = 0 ECCP2 is multiplexed to:
- RE7 is the ECCP2 pin with CCP2MX = 0

查询PIC18F67K90供应商 **19.2 Capture Mode**

In Capture mode, the CCPRxH:CCPRxL register pair captures the 16-bit value of the TMR1 or TMR3 registers when an event occurs on the corresponding ECCPx pin. An event is defined as one of the following:

- · Every falling edge
- · Every rising edge
- Every fourth rising edge
- Every 16th rising edge

The event is selected by the mode select bits, CCPxM<3:0> (CCPxCON register<3:0>). When a capture is made, the interrupt request flag bit, CCPxIF, is set (see Table 19-2). The flag must be cleared by software. If another capture occurs before the value in the CCPRxH/L register is read, the old captured value is overwritten by the new captured value.

TABLE 19-2: ECCP1/2/3 INTERRUPT FLAG BITS

ECCP Module	Flag Bit
1	PIR3<1>
2	PIR3<2>
3	PIR4<0>

19.2.1 ECCP PIN CONFIGURATION

In Capture mode, the appropriate ECCPx pin should be configured as an input by setting the corresponding TRIS direction bit.

Note:	If the ECCPx pin is configured as an out-
	put, a write to the port can cause a capture
	condition.

19.2.2 TIMER1/TIMER3 MODE SELECTION

The timers that are to be used with the capture feature (Timer1 and/or Timer3) must be running in Timer mode or Synchronized Counter mode. In Asynchronous Counter mode, the capture operation may not work. The timer to be used with each ECCP module is selected in the CCPTMRS0 register (Register 19-2).

19.2.3 SOFTWARE INTERRUPT

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep the CCPxIE interrupt enable bit clear to avoid false interrupts. The interrupt flag bit, CCPxIF, should also be cleared following any such change in operating mode.

19.2.4 ECCP PRESCALER

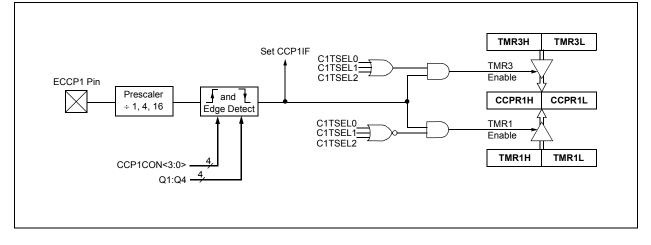
There are four prescaler settings in Capture mode; they are specified as part of the operating mode selected by the mode select bits (CCPxM<3:0>). Whenever the ECCP module is turned off, or Capture mode is disabled, the prescaler counter is cleared. This means that any Reset will clear the prescaler counter.

Switching from one capture prescaler to another may generate an interrupt. Also, the prescaler counter will not be cleared; therefore, the first capture may be from a non-zero prescaler. Example 19-1 provides the recommended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the "false" interrupt.

EXAMPLE 19-1: CHANGING BETWEEN CAPTURE PRESCALERS

			Turn ECCP module off
MOVLW	NEW_CAPT_PS	;	Load WREG with the
		;	new prescaler mode
		;	value and ECCP ON
MOVWF	CCP1CON	;	Load CCP1CON with
		;	this value

FIGURE 19-1: CAPTURE MODE OPERATION BLOCK DIAGRAM



查询PIC18F67K90供应商 19.3 Compare Mode

In Compare mode, the 16-bit CCPRx register value is constantly compared against either the TMR1 or TMR3 register pair value. When a match occurs, the ECCPx pin can be:

- Driven high
- Driven low
- Toggled (high-to-low or low-to-high)
- Unchanged (that is, reflecting the state of the I/O latch)

The action on the pin is based on the value of the mode select bits (CCPxM<3:0>). At the same time, the interrupt flag bit, CCPxIF, is set.

19.3.1 ECCP PIN CONFIGURATION

Users must configure the ECCPx pin as an output by clearing the appropriate TRIS bit.

Note:	Clearing the CCPxCON register will force
	the ECCPx compare output latch (depend-
	ing on device configuration) to the default
	low level. This is not the PORTx I/O data
	latch.

19.3.2 TIMER1/TIMER3 MODE SELECTION

Timer1 and/or Timer3 must be running in Timer mode or Synchronized Counter mode if the ECCP module is using the compare feature. In Asynchronous Counter mode, the compare operation will not work reliably.

19.3.3 SOFTWARE INTERRUPT MODE

When the Generate Software Interrupt mode is chosen (CCPxM<3:0> = 1010), the ECCPx pin is not affected; only the CCPxIF interrupt flag is affected.

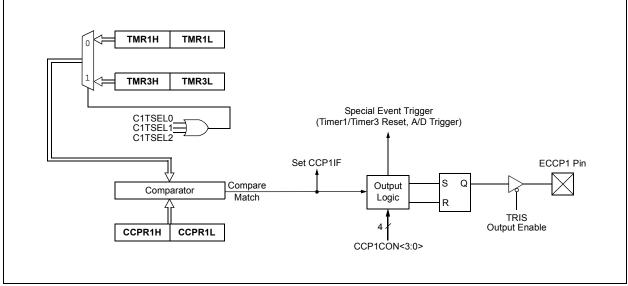
19.3.4 SPECIAL EVENT TRIGGER

The ECCP module is equipped with a Special Event Trigger. This is an internal hardware signal generated in Compare mode to trigger actions by other modules. The Special Event Trigger is enabled by selecting the Compare Special Event Trigger mode (CCPxM<3:0> = 1011).

The Special Event Trigger resets the Timer register pair for whichever timer resource is currently assigned as the module's time base. This allows the CCPRx registers to serve as a programmable period register for either timer.

The Special Event Trigger can also start an A/D conversion. In order to do this, the A/D Converter must already be enabled.





查询PIC18F67K90供应商

19.4 PWM (Enhanced Mode)

The Enhanced PWM mode can generate a PWM signal on up to four different output pins with up to 10 bits of resolution. It can do this through four different PWM Output modes:

- Single PWM
- Half-Bridge PWM
- Full-Bridge PWM, Forward mode
- · Full-Bridge PWM, Reverse mode

To select an Enhanced PWM mode, the PxM bits of the CCPxCON register must be set appropriately.

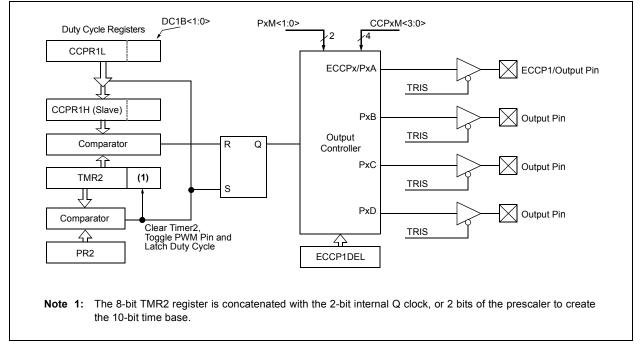
The PWM outputs are multiplexed with I/O pins and are designated: PxA, PxB, PxC and PxD. The polarity of the PWM pins is configurable and is selected by setting the CCPxM bits in the CCPxCON register appropriately.

Table 19-1 provides the pin assignments for each Enhanced PWM mode.

Figure 19-3 provides an example of a simplified block diagram of the Enhanced PWM module.

Note: To prevent the generation of an incomplete waveform when the PWM is first enabled, the ECCP module waits until the start of a new PWM period before generating a PWM signal.

FIGURE 19-3: EXAMPLE SIMPLIFIED BLOCK DIAGRAM OF THE ENHANCED PWM MODE



Note:The TRIS register value for each PWM output must be configured appropriately.Any pin not used by an Enhanced PWM mode is available for alternate pin functions.

查询PIC18F67K90供应商

TABLE 19-3: EXAMPLE PIN ASSIGNMENTS FOR VARIOUS PWM ENHANCED MODES

ECCP Mode	PxM<1:0>	PxA	PxB	PxC	PxD
Single	00	Yes ⁽¹⁾	Yes ⁽¹⁾	Yes ⁽¹⁾	Yes ⁽¹⁾
Half-Bridge	10	Yes	Yes	No	No
Full-Bridge, Forward	01	Yes	Yes	Yes	Yes
Full-Bridge, Reverse	11	Yes	Yes	Yes	Yes

Note 1: Outputs are enabled by pulse steering in Single mode (see Register 19-5).

FIGURE 19-4: EXAMPLE PWM (ENHANCED MODE) OUTPUT RELATIONSHIPS (ACTIVE-HIGH STATE)

				Period	
00	(Single Output)	PxA Modulated	Delay ⁽¹⁾	Delay ⁽¹⁾	
		PxA Modulated			_
10	(Half-Bridge)	PxB Modulated	_ ' 		
		PxA Active		<u>·</u>	
	(Full-Bridge, Forward)	PxB Inactive	_		
01		PxC Inactive		 	
		PxD Modulated			
		PxA Inactive			
11	(Full-Bridge, Reverse)	PxB Modulated	=		
		PxC Active —	_ <u>·</u> _ ¦		
		PxD Inactive		1 1 1	<u> </u>

Note 1: Dead-band delay is programmed using the ECCPxDEL register (Section 19.4.6 "Programmable Dead-Band Delay Mode").

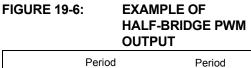
查询PIC18F67K90供应商 FIGURE 19-5: EXAMPLE ENHANCED PWM OUTPUT RELATIONSHIPS (ACTIVE-LOW STATE)

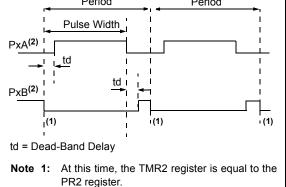
				Period —	
00	(Single Output)	PxA Modulated	i		
		PxA Modulated	<mark>⊲ →</mark> Delay ⁽¹⁾	→→ Delay ⁽¹⁾	
10	(Half-Bridge)	PxB Modulated			
		PxA Active			
01	(Full-Bridge, Forward)	PxB Inactive	- :		j I I
		PxC Inactive			
		PxD Modulated		\	
		PxA Inactive	!		1 1 1
11	(Full-Bridge,	PxB Modulated			1
	Reverse)	PxC Active			
		PxD Inactive			
	 Pulse Width = Tos 	* (PR2 + 1) * (TMR2 Pre sc * (CCPRxL<7:0>:CCP * (ECCPxDEL<6:0>)	scale Value) «CON<5:4>) * (TMR2 Presc	ale Value)	'

查询PIC18F67K90供应商 19.4.1 HALF-BRIDGE MODE

In Half-Bridge mode, two pins are used as outputs to drive push-pull loads. The PWM output signal is output on the PxA pin, while the complementary PWM output signal is output on the PxB pin (see Figure 19-6). This mode can be used for half-bridge applications, as shown in Figure 19-7, or for full-bridge applications, where four power switches are being modulated with two PWM signals.

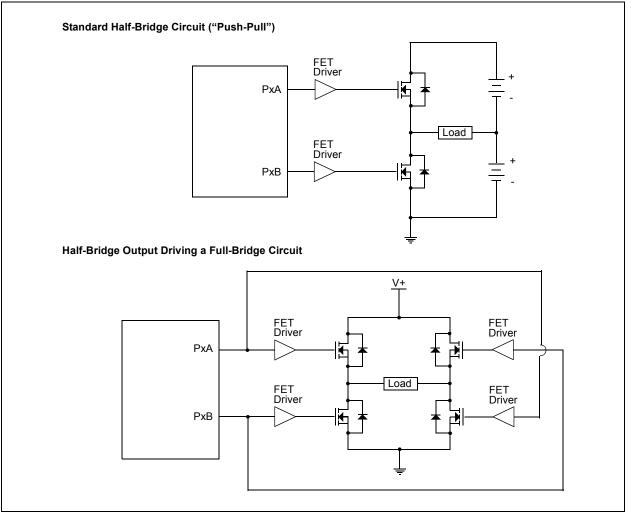
In Half-Bridge mode, the programmable dead-band delay can be used to prevent shoot-through current in half-bridge power devices. The value of the PxDC<6:0> bits of the ECCPxDEL register sets the number of instruction cycles before the output is driven active. If the value is greater than the duty cycle, the corresponding output remains inactive during the entire cycle. For more details on the dead-band delay operations, see **Section 19.4.6 "Programmable Dead-Band Delay Mode"**. Since the PxA and PxB outputs are multiplexed with the port data latches, the associated TRIS bits must be cleared to configure PxA and PxB as outputs.





2: Output signals are shown as active-high.

FIGURE 19-7: EXAMPLE OF HALF-BRIDGE APPLICATIONS



查询PIC18F67K90供应商 19.4.2 FULL-BRIDGE MODE

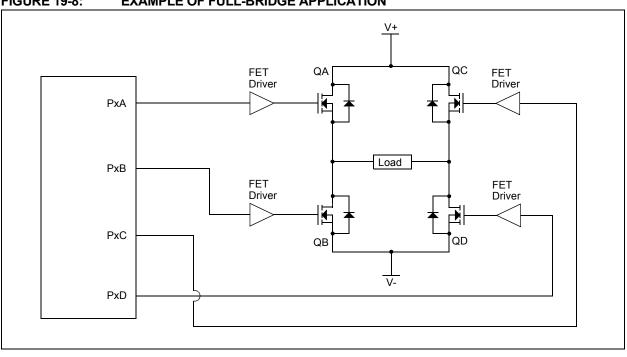
In Full-Bridge mode, all four pins are used as outputs. An example of a full-bridge application is provided in Figure 19-8.

In the Forward mode, the PxA pin is driven to its active state and the PxD pin is modulated, while the PxB and PxC pins are driven to their inactive state, as provided in Figure 19-9.

FIGURE 19-8: EXAMPLE OF FULL-BRIDGE APPLICATION

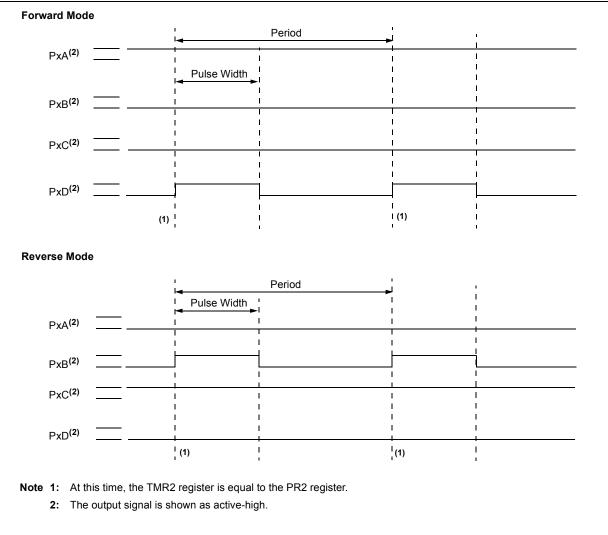
In the Reverse mode, the PxC pin is driven to its active state and the PxB pin is modulated, while the PxA and PxD pins are driven to their inactive state, as provided Figure 19-9.

The PxA, PxB, PxC and PxD outputs are multiplexed with the port data latches. The associated TRIS bits must be cleared to configure the PxA, PxB, PxC and PxD pins as outputs.



查询PIC18F67K90供应商

FIGURE 19-9: EXAMPLE OF FULL-BRIDGE PWM OUTPUT



查询PIC18F67K90供应商

19.4.2.1 Direction Change in Full-Bridge Mode

In the Full-Bridge mode, the PxM1 bit in the CCPxCON register allows users to control the forward/reverse direction. When the application firmware changes this direction control bit, the module will change to the new direction on the next PWM cycle.

A direction change is initiated in software by changing the PxM1 bit of the CCPxCON register. The following sequence occurs prior to the end of the current PWM period:

- The modulated outputs (PxB and PxD) are placed in their inactive state.
- The associated unmodulated outputs (PxA and PxC) are switched to drive in the opposite direction.
- PWM modulation resumes at the beginning of the next period.

For an illustration of this sequence, see Figure 19-10.

The Full-Bridge mode does not provide a dead-band delay. As one output is modulated at a time, a dead-band delay is generally not required. There is a situation where a dead-band delay is required. This situation occurs when both of the following conditions are true:

- The direction of the PWM output changes when the duty cycle of the output is at or near 100%.
- The turn-off time of the power switch, including the power device and driver circuit, is greater than the turn-on time.

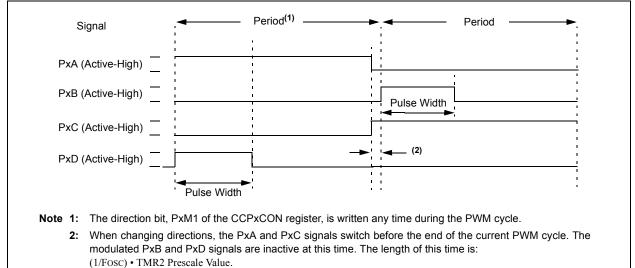
Figure 19-11 shows an example of the PWM direction changing from forward to reverse, at a near 100% duty cycle. In this example, at time, t1, the PxA and PxD outputs become inactive, while the PxC output becomes active. Since the turn-off time of the power devices is longer than the turn-on time, a shoot-through current will flow through power devices, QC and QD (see Figure 19-8), for the duration of 't'. The same phenomenon will occur to power devices, QA and QB, for PWM direction change from reverse to forward.

If changing PWM direction at high duty cycle is required for an application, two possible solutions for eliminating the shoot-through current are:

- Reduce PWM duty cycle for one PWM period before changing directions.
- Use switch drivers that can drive the switches off faster than they can drive them on.

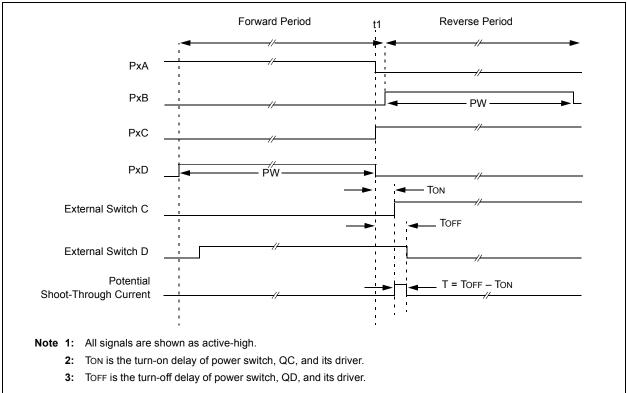
Other options to prevent shoot-through current may exist.

FIGURE 19-10: EXAMPLE OF PWM DIRECTION CHANGE



查询PIC18F67K90供应商

FIGURE 19-11: EXAMPLE OF PWM DIRECTION CHANGE AT NEAR 100% DUTY CYCLE



19.4.3 START-UP CONSIDERATIONS

When any PWM mode is used, the application hardware must use the proper external pull-up and/or pull-down resistors on the PWM output pins.

Note:	When the microcontroller is released from Reset, all of the I/O pins are in the High-Impedance state. The external circuits must keep the power switch devices in the OFF state until the micro- controller drives the I/O pins with the proper signal levels or activates the PWM
	output(s).

The CCPxM<1:0> bits of the CCPxCON register allow the user to choose whether the PWM output signals are active-high or active-low for each pair of PWM output pins (PxA/PxC and PxB/PxD). The PWM output polarities must be selected before the PWM pin output drivers are enabled. Changing the polarity configuration while the PWM pin output drivers are enabled is not recommended since it may result in damage to the application circuits.

The PxA, PxB, PxC and PxD output latches may not be in the proper states when the PWM module is initialized. Enabling the PWM pin output drivers at the same time as the Enhanced PWM modes may cause damage to the application circuit. The Enhanced PWM modes must be enabled in the proper Output mode and complete a full PWM cycle before enabling the PWM pin output drivers. The completion of a full PWM cycle is indicated by the TMR2IF or TMR4IF bit of the PIR1 or PIR5 register being set as the second PWM period begins.

19.4.4 ENHANCED PWM AUTO-SHUTDOWN MODE

The PWM mode supports an Auto-Shutdown mode that will disable the PWM outputs when an external shutdown event occurs. Auto-Shutdown mode places the PWM output pins into a predetermined state. This mode is used to help prevent the PWM from damaging the application.

The auto-shutdown sources are selected using the ECCPxAS<2:0> bits (ECCPxAS<6:4>). A shutdown event may be generated by:

- A logic '0' on the pin that is assigned the FLT0 input function
- Comparator C1
- Comparator C2
- · Setting the ECCPxASE bit in firmware

A shutdown condition is indicated by the ECCPxASE (Auto-Shutdown Event Status) bit (ECCPxAS<7>). If the bit is a '0', the PWM pins are operating normally. If the bit is a '1', the PWM outputs are in the shutdown state.

查询PIC18F67K90供应商

When a shutdown event occurs, two things happen:

- The ECCPxASE bit is set to '1'. The ECCPxASE will remain set until cleared in firmware or an auto-restart occurs. (See Section 19.4.5 "Auto-Restart Mode".)
- The enabled PWM pins are asynchronously placed in their shutdown states. The PWM output pins are grouped into pairs: PxA/PxC and PxB/PxD. The state of each pin pair is determined by the PSSxAC and PSSxBD bits (ECCPxAS<3:2> and <1:0>, respectively).

Each pin pair may be placed into one of three states:

- Drive logic '1'
- Drive logic '0'
- Tri-state (high-impedance)

REGISTER 19-3: ECCPxAS: ECCPx AUTO-SHUTDOWN CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ECCPxASE	ECCPxAS2	ECCPxAS1	ECCPxAS0	PSSxAC1	PSSxAC0	PSSxBD1	PSSxBD0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	ECCPxASE: ECCP Auto-Shutdown Event Status bit
	1 = A shutdown event has occurred; ECCP outputs are in a shutdown state
	0 = ECCP outputs are operating
bit 6-4	
	000 = Auto-shutdown is disabled
	001 = Comparator C1OUT output is high
	010 = Comparator C2OUT output is high 011 = Either Comparator C1OUT or C2OUT is high
	100 = ViL on FLTO pin
	101 = VIL on FLT0 pin or Comparator C1OUT output is high
	110 = VIL on FLT0 pin or Comparator C2OUT output is high
	111 = VIL on FLT0 pin, Comparator C1OUT or Comparator C2OUT is high
bit 3-2	PSSxAC<1:0>: Pins PxA and PxC Shutdown State Control bits
	00 = Drive the PxA and PxC pins to '0'
	01 = Drive the PxA and PxC pins to '1'
	1x = PxA and PxC pins tri-state
bit 1-0	PSSxBD<1:0>: Pins PxB and PxD Shutdown State Control bits
	00 = Drive the PxB and PxD pins to '0'
	01 = Drive the PxB and PxD pins to '1'
	1x = PxB and PxD pins tri-state
Nata	The suite shutdown condition is a lovel beand simply not an odre based signal. As long as the lovel
Note	: The auto-shutdown condition is a level-based signal, not an edge-based signal. As long as the level present, the auto-shutdown will persist.

Writing to the ECCPxASE bit is disabled while an auto-shutdown condition persists. Once the auto-shutdown condition has been removed and the PWM restarted (either through firmware or auto-restart), the PWM signal will always restart at the beginning of the next PWM period.

is

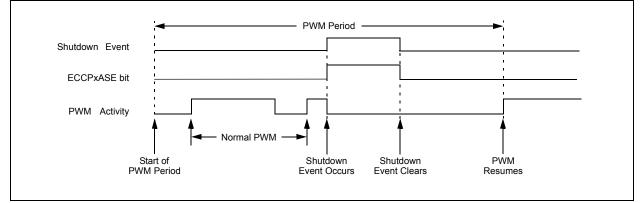
查询PIC18F67K90供应商 **FIGURE 19-12:** PWM AUTO-SHUTDOWN WITH FIRMWARE RESTART (PxRSEN = 0) PWM Period Shutdown Event ECCPxASE bit PWM Activity Normal PWM ECCPXASE Cleared by Firmware PWM Start of Shutdown Shutdown Event Occurs Event Clears PWM Period Resumes

19.4.5 AUTO-RESTART MODE

The Enhanced PWM can be configured to automatically restart the PWM signal once the auto-shutdown condition has been removed. Auto-restart is enabled by setting the PxRSEN bit (ECCPxDEL<7>).

If auto-restart is enabled, the ECCPxASE bit will remain set as long as the auto-shutdown condition is active. When the auto-shutdown condition is removed, the ECCPxASE bit will be cleared via hardware and normal operation will resume. The module will wait until the next PWM period begins, however, before re-enabling the output pin. This behavior allows the auto-shutdown with auto-restart features to be used in applications based on current mode of PWM control.

FIGURE 19-13: PWM AUTO-SHUTDOWN WITH AUTO-RESTART ENABLED (PxRSEN = 1)



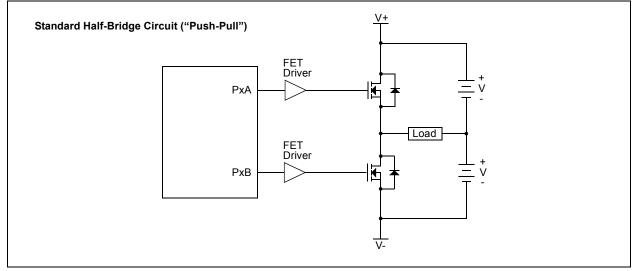
查询PIC18F67K90供应商 19.4.6 PROGRAMMABLE DEAD-BAND DELAY MODE

In half-bridge applications, where all power switches are modulated at the PWM frequency, the power switches normally require more time to turn off than to turn on. If both the upper and lower power switches are switched at the same time (one turned on and the other turned off), both switches may be on for a short period until one switch completely turns off. During this brief interval, a very high current (shoot-through current) will flow through both power switches, shorting the bridge supply. To avoid this potentially destructive shoot-through current from flowing during switching, turning on either of the power switches is normally delayed to allow the other switch to completely turn off.

In Half-Bridge mode, a digitally programmable dead-band delay is available to avoid shoot-through current from destroying the bridge power switches. The delay occurs at the signal transition from the non-active state to the active state. For an illustration, see Figure 19-14. The lower seven bits of the associated ECCPxDEL register (Register 19-4) set the delay period in terms of microcontroller instruction cycles (TcY or 4 Tosc).

FIGURE 19-14: EXAMPLE OF HALF-BRIDGE PWM OUTPUT Period Period Pulse Width PxA⁽²⁾ td I PxB⁽²⁾ (1) (1) (1) td = Dead-Band Delay Note 1: At this time, the TMR2 register is equal to the PR2 register. 2: Output signals are shown as active-high.

FIGURE 19-15: EXAMPLE OF HALF-BRIDGE APPLICATIONS



查询PIC18F67K90供应商

REGISTER 19-4: ECCPxDEL: ENHANCED PWM CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PxRSEN	PxDC6	PxDC5	PxDC4	PxDC3	PxDC2	PxDC1	PxDC0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 PxRSEN: PWM Restart Enable bit

1 = Upon auto-shutdown, the ECCPxASE bit clears automatically once the shutdown event goes away; the PWM restarts automatically

0 = Upon auto-shutdown, ECCPxASE must be cleared by software to restart the PWM

bit 6-0 PxDC<6:0>: PWM Delay Count bits

PxDCn = Number of Fosc/4 (4 * Tosc) cycles between the scheduled time when a PWM signal **should** transition active and the **actual** time it does transition active.

19.4.7 PULSE STEERING MODE

In Single Output mode, pulse steering allows any of the PWM pins to be the modulated signal. Additionally, the same PWM signal can simultaneously be available on multiple pins.

Once the Single Output mode is selected (CCPxM<3:2> = 11 and PxM<1:0> = 00 of the CCPxCON register), the user firmware can bring out the same PWM signal to one, two, three or four output pins by setting the appropriate STR<D:A> bits (PSTRxCON<3:0>), as provided in Table 19-3.

Note: The associated TRIS bits must be set to output ('0') to enable the pin output driver in order to see the PWM signal on the pin.

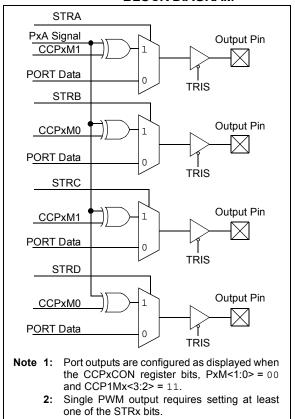
While the PWM Steering mode is active, the CCPxM<1:0> bits (CCPxCON<1:0>) select the PWM output polarity for the Px<D:A> pins.

The PWM auto-shutdown operation also applies to the PWM Steering mode, as described in **Section 19.4.4 "Enhanced PWM Auto-shutdown mode"**. An auto-shutdown event will only affect pins that have PWM outputs enabled.

查询PIC18F67K90供应商 REGISTER 19-5: PSTRxCON: PULSE STEERING CONTROL⁽¹⁾ R/W-0 R/W-0 U-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-1 CMPL1 CMPL0 STRSYNC STRD STRC STRB STRA bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 7-6 CMPL<1:0>: Complementary Mode Output Assignment Steering Sync bits 00 = See STRD:STRA 01 = PA and PB are selected as the complementary output pair 10 = PA and PC are selected as the complementary output pair 11 = PA and PD are selected as the complementary output pair bit 5 Unimplemented: Read as '0' bit 4 STRSYNC: Steering Sync bit 1 = Output steering update occurs on the next PWM period 0 = Output steering update occurs at the beginning of the instruction cycle boundary STRD: Steering Enable bit D bit 3 1 = PxD pin has the PWM waveform with polarity control from CCPxM<1:0> 0 = PxD pin is assigned to a port pin bit 2 STRC: Steering Enable bit C 1 = PxC pin has the PWM waveform with polarity control from CCPxM<1:0> 0 = PxC pin is assigned to a port pinbit 1 STRB: Steering Enable bit B 1 = PxB pin has the PWM waveform with polarity control from CCPxM<1:0> 0 = PxB pin is assigned to a port pin STRA: Steering Enable bit A bit 0 1 = PxA pin has the PWM waveform with polarity control from CCPxM<1:0> 0 = PxA pin is assigned to a port pin

Note 1: The PWM Steering mode is available only when the CCPxCON register bits, CCPxM<3:2> = 11 and PxM<1:0> = 00.

查询PIC18F67K90供应商 FIGURE 19-16: SIMPLIFIED STEERING BLOCK DIAGRAM



19.4.7.1 Steering Synchronization

The STRSYNC bit of the PSTRxCON register gives the user two choices for when the steering event will happen. When the STRSYNC bit is '0', the steering event will happen at the end of the instruction that writes to the PSTRxCON register. In this case, the output signal at the Px<D:A> pins may be an incomplete PWM waveform. This operation is useful when the user firmware needs to immediately remove a PWM signal from the pin.

When the STRSYNC bit is '1', the effective steering update will happen at the beginning of the next PWM period. In this case, steering on/off the PWM output will always produce a complete PWM waveform.

Figures 19-17 and 19-18 illustrate the timing diagrams of the PWM steering depending on the STRSYNC setting.

FIGURE 19-17: EXAMPLE OF STEERING EVENT AT END OF INSTRUCTION (STRSYNC = 0)

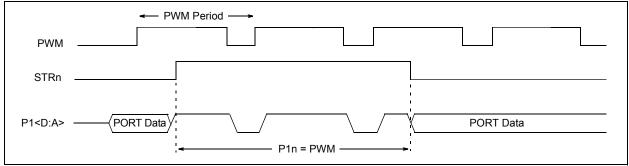
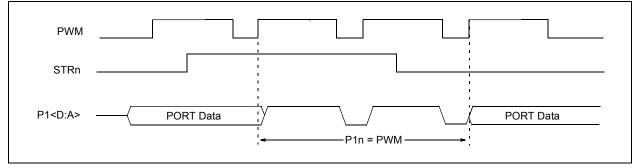


FIGURE 19-18: EXAMPLE OF STEERING EVENT AT BEGINNING OF INSTRUCTION (STRSYNC = 1)



查询PIC18F67K90供应商

19.4.8 OPERATION IN POWER-MANAGED MODES

In Sleep mode, all clock sources are disabled. Timer2/4/6/8 will not increment and the state of the module will not change. If the ECCPx pin is driving a value, it will continue to drive that value. When the device wakes up, it will continue from this state. If Two-Speed Start-ups are enabled, the initial start-up frequency from HF-INTOSC and the postscaler may not be stable immediately.

In PRI_IDLE mode, the primary clock will continue to clock the ECCPx module without change.

19.4.8.1 Operation with Fail-Safe Clock Monitor (FSCM)

If the Fail-Safe Clock Monitor (FSCM) is enabled, a clock failure will force the device into the power-managed RC_RUN mode and the OSCFIF bit of the PIR2/4/6/8 register will be set. The ECCPx will then be clocked from the internal oscillator clock source, which may have a different clock frequency than the primary clock.

19.4.9 EFFECTS OF A RESET

Both Power-on Reset and subsequent Resets will force all ports to Input mode and the ECCP registers to their Reset states.

This forces the ECCP module to reset to a state compatible with previous, non-enhanced CCP modules used on other PIC18 and PIC16 devices.

查询PIC18F67K90供应商 TABLE 19-4: REGISTERS ASSOCIATED WITH ECCP1/2/3 MODULE AND TIMER1/2/3/4/6/8/10/12

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
RCON	IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	74
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIR4	CCP10IF ⁽¹⁾	CCP9IF ⁽¹⁾	CCP8IF	CCP7IF	CCP6IF	CCP5IF	CCP4IF	CCP3IF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
PIE4	CCP10IE ⁽¹⁾	CCP9IE ⁽¹⁾	CCP8IE	CCP7IE	CCP6IE	CCP5IE	CCP4IE	CCP3IE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
IPR4	CCP10IP ⁽¹⁾	CCP9IP ⁽¹⁾	CCP8IP	CCP7IP	CCP6IP	CCP5IP	CCP4IP	CCP3IP	75
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	76
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	76
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	76
TRISH ⁽²⁾	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	76
TMR1H	Timer1 Regist								74
TMR1L	Timer1 Regist								74
TMR2	Timer2 Regist								74
TMR3H	Timer3 Regist	er High Byte							75
	Timer3 Regist								75
	Timer4 Regist								80
	Timer6 Regist								79
TMR8	Timer8 Register							79	
	TMR10 Register							79	
	TMR10 Register							79	
PR2	Timer2 Period								74
PR4	Timer4 Period								80
PR6	Timer6 Period								79
PR8	Timer8 Period								79
PR10	Timer10 Perio								79
PR12	Timer12 Perio								79
T1CON	TMR1CS1	TMR1CS0	T1CKPS1	T1CKPS0	SOSCEN	T1SYNC	RD16	TMR10N	74
T2CON	_			T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	74
T3CON	TMR3CS1	TMR3CS0	T3CKPS1	T3CKPS0	SOSCEN	T3SYNC	RD16	TMR30N	75
T4CON	_	T4OUTPS3		T4OUTPS1	T4OUTPS0		T4CKPS1	T4CKPS0	80
T6CON		T6OUTPS3		T6OUTPS1	T6OUTPS0	TMR6ON	T6CKPS1	T6CKPS0	79
T8CON		T8OUTPS3		T8OUTPS1	T8OUTPS0	TMR8ON	T8CKPS1	T8CKPS0	79
T10CON		T10OUTPS3			T10OUTPS0	TMR100N	T10CKPS1	T10CKPS0	79
T12CON						TMR120N	T12CKPS1	T12CKPS0	79
								75	
							75		
								78	
								78	
								78	
								78	
CCP1CON	P1M1	P1M0	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	75
CCP2CON	P2M1	P2M0	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	78
CCP3CON	P3M1	P3M0	DC3B1	DC3B0	CCP3M3	CCP3M2	CCP3M1	CCP3M0	78
	Unimplemente								

2: Unimplemented on PIC18F6XK90 devices.

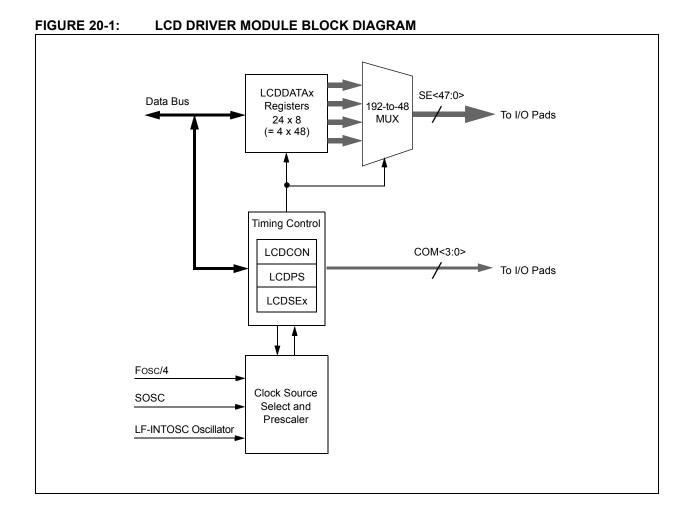
查询PIC18F67K90供应商 20.0 LIQUID CRYSTAL DISPLAY (LCD) DRIVER MODULE

The Liquid Crystal Display (LCD) driver module generates the timing control to drive a static or multiplexed LCD panel. In the 80-pin devices (PIC18F8XK90), the module drives the panels of up to four commons and up to 48 segments and in the 64-pin devices (PIC18F6XK90), the module drives the panels of up to four commons and up to 33 segments. It also provides control of the LCD pixel data.

The LCD driver module supports:

- Direct driving of LCD panel
- · Three LCD clock sources with selectable prescaler
- Up to four commons:
 - Static (One common)
 - 1/2 multiplex (two commons)
 - 1/3 multiplex (three commons)
 - 1/4 multiplex (four commons)
- Up to 48 (in 80-pin devices), 32 (in 64-pin devices) segments
- Static, 1/2 or 1/3 LCD bias
- · Internal resistors for bias voltage generation
- Software contrast control for LCD using the internal biasing

A simplified block diagram of the module is shown in Figure 20-1.



© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商 20.1 LCD Registers

The LCD driver module has 32 registers:

- LCD Control Register (LCDCON)
- LCD Phase Register (LCDPS)
- LCD Reference Ladder Register (LCDRL)
- LCD Reference Voltage Control Register (LCDREF)
- Six LCD Segment Enable Registers (LCDSE5:LCDSE0)
- 24 LCD Data Registers (LCDDATA23:LCDDATA0)

The LCDCON register, shown in Register 20-1, controls the overall operation of the module. Once the module is configured, the LCDEN (LCDCON<7>) bit is used to enable or disable the LCD module. The LCD panel can also operate during Sleep by clearing the SLPEN (LCDCON<6>) bit.

The LCDPS register, shown in Register 20-2, configures the LCD clock source prescaler and the type of waveform, Type-A or Type-B. For details on these features, see Section 20.2 "LCD Clock Source Selection", Section 20.3 "LCD Bias Types" and Section 20.8 "LCD Waveform Generation".

REGISTER 20-1: LCDCON: LCD CONTROL REGISTER

R/W-0	R/W-0	R/C-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
LCDEN	SLPEN	WERR	—	CS1	CS0	LMUX1	LMUX0
bit 7							bit 0

Legend:	C = Clearable bit			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7	LCDEN: LCD Driver Enable bit 1 = LCD driver module is enabled 0 = LCD driver module is disabled
bit 6	SLPEN: LCD Driver Enable in Sleep mode bit 1 = LCD driver module is disabled in Sleep mode 0 = LCD driver module is enabled in Sleep mode
bit 5	WERR: LCD Write Failed Error bit 1 = LCDDATAx register is written while WA (LCDPS<4>) = 0 (must be cleared in software) 0 = No LCD write error
bit 4	Unimplemented: Read as '0'
bit 3-2	CS<1:0>: Clock Source Select bits 00 = (Fosc/4)/8192 01 = SOSC oscillator/32 1x = INTRC (31.25 kHz)/32
bit 1-0	LMUX<1:0>: Commons Select bits

LMUX<1:0>	Multiplex	Maximum Number of Pixels (PIC18F6X90)	Maximum Number of Pixels (PIC18F8X90)	Bias
00	Static (COM0)	33	48	Static
01	1/2 (COM<1:0>)	66	96	1/2 or 1/3
10	1/3 (COM<2:0>)	99	144	1/2 or 1/3
11	1/4 (COM<3:0>)	132	192	1/3

查询PIC18F67K90供应商 REGISTER 20-2: LCDPS: LCD PHASE REGISTER R/W-0 R-0 R-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 WFT BIASMD LCDA WA LP3 LP2 LP1 LP0 bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 7 WFT: Waveform Type Select bit 1 = Type-B waveform (phase changes on each frame boundary) 0 = Type-A waveform (phase changes within each common type) bit 6 BIASMD: Bias Mode Select bit When LMUX<1:0> = 00: 0 = Static Bias mode (do not set this bit to '1') When LMUX<1:0> = 01: 1 = 1/2 Bias mode 0 = 1/3 Bias mode When LMUX<1:0> = 10: 1 = 1/2 Bias mode 0 = 1/3 Bias mode When LMUX<1:0> = 11: 0 = 1/3 Bias mode (do not set this bit to '1') bit 5 LCDA: LCD Active Status bit 1 = LCD driver module is active 0 = LCD driver module is inactive bit 4 WA: LCD Write Allow Status bit 1 = Write into the LCDDATAx registers is allowed 0 = Write into the LCDDATAx registers is not allowed bit 3-0 LP<3:0>: LCD Prescaler Select bits 1111 = 1:16 1110 **= 1:15** 1101 = 1:14 1100 = 1:13 1011 = 1:12 1010 = 1:11 1001 = 1:10 1000 = 1:9 0111 = 1:8 0110 = 1:7 0101 = 1:6 0100 = 1:5 0011 = 1:4 0010 = 1:3 0001 = 1:2 0000 = 1:1

查询PIC18F67K90供应商 REGISTER 20-3: LCDREF: LCD REFERENCE VOLTAGE CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
LCDIRE	LCDIRS	LCDCST2	LCDCST1	LCDCST0	VLCD3PE	VLCD2PE	VLCD1PE			
bit 7							bit			
Legend:										
R = Readab	le bit	W = Writable	bit	U = Unimplem	nented bit, read	d as '0'				
-n = Value a	POR	'1' = Bit is set		'0' = Bit is clea		x = Bit is unki	nown			
bit 7	LCDIRE: LC	D Internal Refe	ence Enable	bit						
		LCD reference LCD reference		d connected to	the internal co	ntrast control c	ircuit			
bit 6	LCDIRS: LC If LCDIRE =	D Internal Refe	rence Source	bit						
	1 = Internal L	_CD contrast co _CD contrast co			e (3.3V) voltage	9				
	If LCDIRE =			·	gap buffer is di	sabled.				
bit 5-3		0>: LCD Contra								
	Selects the r	esistance of the	LCD contrast	t control resisto	r ladder:					
		tor ladder is at i		•	,					
		tor ladder is at (tor ladder is at {								
		tor ladder is at								
		011 = Resistor ladder is at 3/7th of maximum resistance								
		010 = Resistor ladder is at 2/7th of maximum resistance 001 = Resistor ladder is at 1/7th of maximum resistance								
		num resistance				ed				
bit 2		Bias 3 Pin Enabl	•							
	1 = Bias 3 le	vel is connected vel is internal (ir	to the extern		S3					
bit 1		Bias 2 Pin Enabl		,						
		vel is connecteo vel is internal (ir			S2					
bit 0		Bias 1 Pin Enabl		,						
	1 = Bias 1 le	vel is connected	to the extern	al pin. LCDBIA	S1					

查询PIC18F67K90供应商 REGISTER 20-4: LCDRL: LCD REFERENCE LADDER CONTROL REGISTER R/W-0 R/W-0 R/W-0 R/W-0 U-0 R/W-0 R/W-0 R/W-0 (1) LRLAP1 LRLAP0 LRLBP1 LRLBP0 LRLAT2 LRLAT1 LRLAT0 bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 7-6 LRLAP<1:0>: LCD Reference Ladder A Time Power Control bits During Time Interval A: 11 = Internal LCD reference ladder is powered in High-Power mode 10 = Internal LCD reference ladder is powered in Medium Power mode 01 = Internal LCD reference ladder is powered in Low-Power mode 00 = Internal LCD reference ladder is powered down and unconnected bit 5-4 LRLBP<1:0>: LCD Reference Ladder B Time Power Control bits During Time Interval B: 11 = Internal LCD reference ladder is powered in High-Power mode 10 = Internal LCD reference ladder is powered in Medium Power mode 01 = Internal LCD reference ladder is powered in Low-Power mode 00 = Internal LCD reference ladder is powered down and unconnected Unimplemented: Read as '0'(1) bit 3 bit 2-0 LRLAT<2:0>: LCD Reference Ladder A Time Interval Control bits Sets the number of 32 clock counts when the A Time Interval Power mode is active. For Type-A Waveforms (WFT = 0): 000 = Internal LCD reference ladder is always in B Power mode 001 = Internal LCD reference ladder is in A Power mode for 1 clock and B Power mode for 15 clocks 010 = Internal LCD reference ladder is in A Power mode for 2 clocks and B Power mode for 14 clocks 011 = Internal LCD reference ladder is in A Power mode for 3 clocks and B Power mode for 13 clocks 100 = Internal LCD reference ladder is in A Power mode for 4 clocks and B Power mode for 12 clocks 101 = Internal LCD reference ladder is in A Power mode for 5 clocks and B Power mode for 11 clocks 110 = Internal LCD reference ladder is in A Power mode for 6 clocks and B Power mode for 10 clocks 111 = Internal LCD reference ladder is in A Power mode for 7 clocks and B Power mode for 9 clocks For Type-B Waveforms (WFT = 1): 000 = Internal LCD reference ladder is always in B Power mode 001 = Internal LCD reference ladder is in A Power mode for 1 clock and B Power mode for 31 clocks 010 = Internal LCD reference ladder is in A Power mode for 2 clocks and B Power mode for 30 clocks 011 = Internal LCD reference ladder is in A Power mode for 3 clocks and B Power mode for 29 clocks 100 = Internal LCD reference ladder is in A Power mode for 4 clocks and B Power mode for 28 clocks 101 = Internal LCD reference ladder is in A Power mode for 5 clocks and B Power mode for 27 clocks 110 = Internal LCD reference ladder is in A Power mode for 6 clocks and B Power mode for 26 clocks 111 = Internal LCD reference ladder is in A Power mode for 7 clocks and B Power mode for 25 clocks

Note 1: LCDRL<3> should be maintained as '0'.

查询PIC18F67K90供应商

The LCDSE5:LCDSE0 registers configure the functions of the port pins. Setting the segment enable bit for a particular segment configures that pin as an LCD driver. There are six LCD Segment Enable registers, as shown in Table 20-1. The prototype LCDSEx register is shown in Register 20-5.

TABLE 20-1: LCDSE REGISTERS AND ASSOCIATED SEGMENTS

Register	Segments
LCDSE0	7:0 (RD<7:0>)
LCDSE1	15:8 (RA<5:4>, RC2, RC5, RB<4:1>)
LCDSE2	23:16 (RF<5:1>, RA1, RC<4:3>)
LCDSE3	31:24 (RE7, RB0, RB5, RC<7:6>, RG4, RF<7:6>)
LCDSE4	39:32 (RJ<4:7>, RJ<3:1>, RC1)
LCDSE5	47:40 (RH<0:3>, RH<7:4>)

Note:	The LCDSE5:LCDSE4 registers are not					
	implemented in PIC18F6XK90 devices.					

Once the module is initialized for the LCD panel, the individual bits of the LCDDATA23:LCDDATA0 registers are cleared or set to represent a clear or dark pixel, respectively.

Specific sets of LCDDATA registers are used with specific segments and common signals. Each bit represents a unique combination of a specific segment connected to a specific common.

Individual LCDDATA bits are named by the convention, "SxxCy", with "xx" as the segment number and "y" as the common number. The relationship is summarized in Table 20-2. The prototype LCDDATAx register is shown in Register 20-6.

Note:	In PIC18F6XK90 devices, writing into the					
	registers, LCDDATA4, LCDDATA5,					
	LCDDATA10, LCDDATA11, LCDDATA16,					
	LCDDATA17, LCDDATA22 and					
	LCDDATA23, will not affect the status of					
	any pixel. These registers can be used as					
	general purpose registers.					

REGISTER 20-5: LCDSEx: LCD SEGMENTx ENABLE REGISTER

R/W-0	R/W-0						
SE(n + 7)	SE(n + 6)	SE(n + 5)	SE(n + 4)	SE(n + 3)	SE(n + 2)	SE(n + 1)	SE(n)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 SE(n + 7):SE(n): Segment Enable bits For LCDSE0: n = 0 For LCDSE1: n = 8 For LCDSE2: n = 16 For LCDSE3: n = 24 For LCDSE4: n = 32 For LCDSE5: n = 40 1 = Segment function of the pin is enabled, digital I/O is disabled 0 = I/O function of the pin is enabled

查询PIC18F67K90供应商 TABLE 20-2: LCDDATA REGISTERS AND BITS FOR SEGMENT AND COM COMBINATIONS

Segments	COM Lines				
	0	1	2	3	
	LCDDATA0	LCDDATA6	LCDDATA12	LCDDATA18	
0 through 7	S00C0:S07C0	S00C1:S07C1	S00C2:S07C2	S00C3:S07C3	
9 through 15	LCDDATA1	LCDDATA7	LCDDATA13	LCDDATA19	
8 through 15	S08C0:S15C0	S08C1:S15C1	S08C2:S15C2	S08C0:S15C3	
16 through 22	LCDDATA2	LCDDATA8	LCDDATA14	LCDDATA20	
16 through 23	S16C0:S23C0	S16C1:S23C1	S16C2:S23C2	S16C3:S23C3	
24 through 31	LCDDATA3	LCDDATA9	LCDDATA15	LCDDATA21	
	S24C0:S31C0	S24C1:S31C1	S24C2:S31C2	S24C3:S31C3	
32 through 39	LCDDATA4 ⁽¹⁾	LCDDATA10 ⁽¹⁾	LCDDATA16 ⁽¹⁾	LCDDATA22 ⁽¹⁾	
	S32C0:S39C0	S32C1:S39C1	S32C2:S39C2	S32C3:S39C3	
40 through 47	LCDDATA5 ⁽²⁾	LCDDATA11 ⁽²⁾	LCDDATA17 ⁽²⁾	LCDDATA23 ⁽²⁾	
	S40C0:S47C0	S40C1:S47C1	S40C2:S47C2	S40C3:S47C3	

Note 1: Bits<7:1> of these registers are not implemented in PIC18F6XK90 devices. Bit 0 of these registers (SEG32Cy) is always implemented.

2: These registers are not implemented in PIC18F6XK90 devices.

REGISTER 20-6: LCDDATAX: LCD DATAX REGISTER

R/W-0	R/W-0						
S(n + 7)Cy	S(n + 6)Cy	S(n + 5)Cy	S(n + 4)Cy	S(n + 3)Cy	S(n + 2)Cy	S(n + 1)Cy	S(n)Cy
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0	S(n + 7)Cy:S(n)Cy: Pixel On bits
	For registers, LCDDATA0 through LCDDATA5: n = (8x), y = 0
	<u>For registers, LCDDATA6 through LCDDATA11: n = (8(x – 6)), y = 1</u>
	<u>For registers, LCDDATA12 through LCDDATA17: n = (8(x – 12)), y = 2</u>
	For registers, LCDDATA18 through LCDDATA23: n = (8(x – 18)), y = 3
	1 = Pixel on (dark) 0 = Pixel off (clear)

查询PIC18F67K90供应商 20.2 LCD Clock Source Selection

The LCD driver module has three possible clock sources:

- (Fosc/4)/8192
- SOSC Clock/32
- INTRC/32

The first clock source is the system clock divided by 8,192 ((Fosc/4)/8192). This divider ratio is chosen to provide about 1 kHz output when the system clock is 8 MHz. The divider is not programmable. Instead, the LCD prescaler bits, LCDPS<3:0>, are used to set the LCD frame clock rate.

The second clock source is the SOSC oscillator/32. This also outputs about 1 kHz when a 32.768 kHz crystal is used with the SOSC oscillator. To use the SOSC oscillator as a clock source, set the SOSCEN (T1CON<3>) bit.

The third clock source is a 31.25 kHz internal RC oscillator/32 that provides approximately 1 kHz output.

The second and third clock sources may be used to continue running the LCD while the processor is in Sleep.

These clock sources are selected through the bits CS<1:0> (LCDCON<3:2>).

20.2.1 LCD PRESCALER

A 16-bit counter is available as a prescaler for the LCD clock. The prescaler is not directly readable or writable. Its value is set by the LP<3:0> bits (LCDPS<3:0>) that determines the prescaler assignment and prescale ratio.

Selectable prescale values are from 1:1 through 1:32,768, in power-of-2 increments.

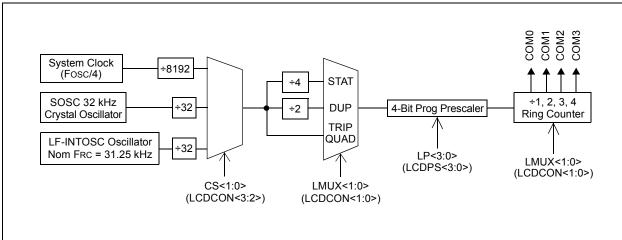


FIGURE 20-2: LCD CLOCK GENERATION

查询PIC18F67K90供应商 20.3 LCD Bias Types

The LCD module can be configured in one of three bias types:

- Static bias (two voltage levels: Vss and VDD)
- 1/2 bias (three voltage levels: Vss, 1/2 VDD and VDD)
- 1/3 bias (four voltage levels: Vss, 1/3 VDD, 2/3 VDD and VDD)

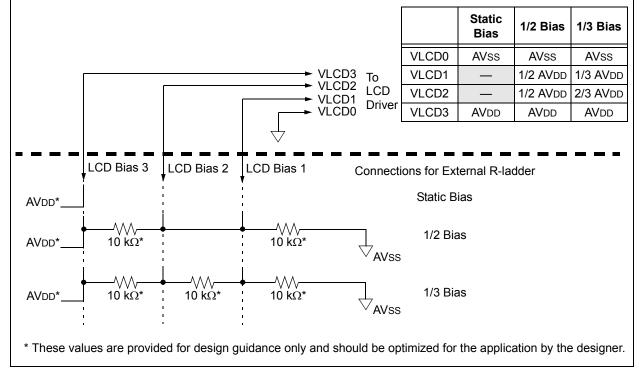
LCD bias voltages can be generated with an internal or external resistor ladder. The internal resistor ladder eliminates the external solution's use of up to three pins. If the internal reference ladder is used to generate bias voltages, it also can provide software contrast control (using LCDCST<2:0>). An external resistor ladder can not do this.

20.3.1 EXTERNAL RESISTOR BIASING

The external resistor ladder should be connected to the VLCD1 pin (Bias 1), VLCD2 pin (Bias 2), VLCD3 pin (Bias 3) and Vss. The VLCD3 pin is used to set the highest voltage to the LCD glass and can be connected to VDD or a lower voltage.

Figure 20-3 shows the proper way to connect the resistor ladder to the Bias pins.





查询PIC18F67K90供应商 20.3.2 INTERNAL RESISTOR BIASING

This mode does not use external resistors, but rather internal resistor ladders that are configured to generate the bias voltage.

The internal reference ladder actually consists of three separate ladders. Disabling the internal reference ladder disconnects all of the ladders, allowing external voltages to be supplied.

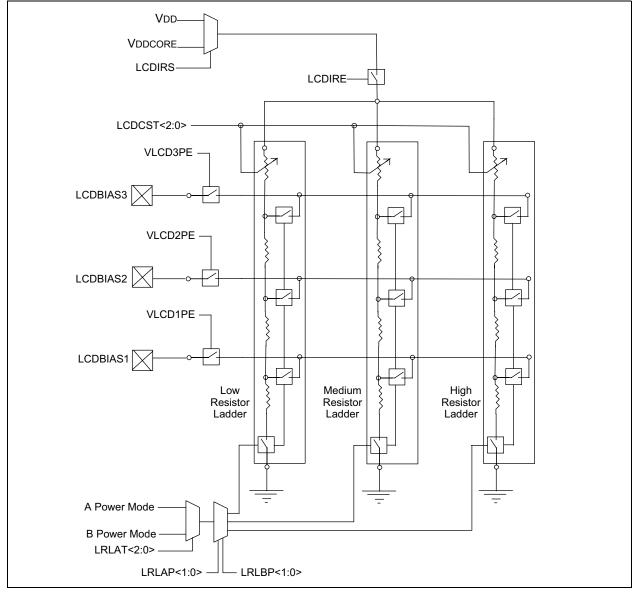
Depending on the total resistance of the resistor ladders, the biasing can be classified as low, medium or high power.

Table 20-3 shows the total resistance of each of the ladders. Figure 20-4 shows the internal resister ladder connections. When the internal resistor ladder is selected, the bias voltage can either be from VDD or from VDDCORE, depending on the LCDIRS setting.

TABLE 20-3: INTERNAL RESISTANCE LADDER POWER MODES

Power Mode	Nominal Resistance of Entire Ladder	IDD	
Low	3 ΜΩ	1 μA	
Medium	300 kΩ	10 μA	
High	30 kΩ	100 μA	

FIGURE 20-4: LCD BIAS INTERNAL RESISTOR LADDER CONNECTION DIAGRAM



查询PIC18F67K90供应商

There are two power modes designated as "Mode A" and "Mode B". Mode A is set by the bits, LRLAP<1:0> and Mode B by LRLB<1:0>. The resistor ladder to use for Modes A and B are selected by the bits, LRLAP<1:0> and LRLBP<1:0>, respectively

Each ladder has a matching contrast control ladder, tuned to the nominal resistance of the reference ladder. This contrast control resistor can be controlled by LCDREF<5:3> (LCDCST<2:0>). Disabling the internal reference ladder results in all of the ladders being disconnected, allowing external voltages to be supplied.

To get additional current in High-Power mode, when LCDRL<7:6> (LRLAP<1:0>) = 11, both the medium and high-power resistor ladders are activated.

Whenever the LCD module is inactive (LCDA (LCDPS < 5>) = 0), the reference ladder will be turned off.

20.3.2.1 Automatic Power Mode Switching

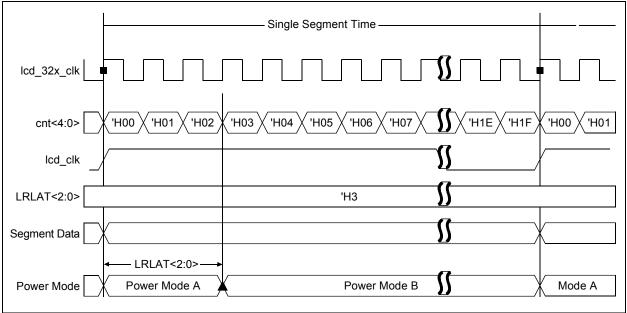
As an LCD segment is electrically only a capacitor, current is drawn only during the interval when the voltage is switching. To minimize total device current, the LCD reference ladder can be operated in a different power mode for the transition portion of the duration. This is controlled by the LCDRL register.

Mode A Power mode is active for a programmable time, beginning at the time when the LCD segment waveform is transitioning. The LCDRL<2:1> (LRLAT<2:0>) bits select how long, or if the Mode A is active. Mode B Power mode is active for the remaining time before the segments or commons change again.

As shown in Figure 20-5, there are 32 counts in a single segment time. Type-A can be chosen during the time when the wave form is in transition. Type-B can be used when the clock is stable or not in transition.

By using this feature of automatic power switching, using Type-A/Type-B, the power consumption can be optimized for a given contrast.

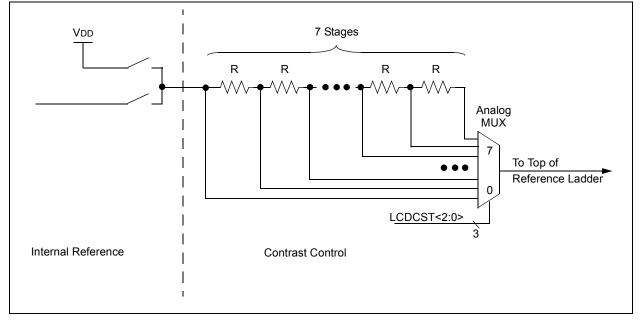




查询PIC18F67K90供应商 20.3.2.2 Contrast Control

The LCD contrast control circuit consists of a 7-tap resistor ladder, controlled by the LCDCST bits (see Figure 20-6.).





查询PIC18F67K90供应商

20.3.2.3 Internal Reference

Under firmware control, an internal reference for the LCD bias voltages can be enabled. When enabled, the source of this voltage can be VDD.

When no internal reference is selected, the LCD contrast control circuit is disabled and LCD bias must be provided externally. Whenever the LCD module is inactive (LCDA = 0), the internal reference will be turned off.

20.3.2.4 VLCDx Pins

The VLCD3, VLCD2 and VLCD1 pins provide the ability for an external LCD bias network to be used instead of the internal ladder. Use of the VLCDx pins does not prevent use of the internal ladder.

Each VLCD pin has an independent control in the LCDREF register, allowing access to any or all of the LCD bias signals.

This architecture allows for maximum flexibility in different applications. The VLCDx pins could be used to add capacitors to the internal reference ladder for increasing the drive capacity. For applications where the internal contrast control is insufficient, the firmware can choose to enable only the VLCD3 pin, allowing an external contrast control circuit to use the internal reference divider.

20.4 LCD Multiplex Types

The LCD driver module can be configured into four multiplex types:

- Static (only COM0 used)
- 1/2 multiplex (COM0 and COM1 are used)
- 1/3 multiplex (COM0, COM1 and COM2 are used)
- 1/4 multiplex (COM0, COM1, COM2 and COM3 are used)

The LMUX<1:0> setting (LCDCON<1:0>) decides the function of the PORTE<6:4> bits. (For details, see Table 20-4.)

If the pin is a digital I/O, the corresponding TRIS bit controls the data direction. If the pin is a COM drive, the TRIS setting of that pin is overridden.

Note:	On a Power-on Reset, the LMUX<1:0>
	bits are '00'.

TABLE 20-4: PORTE<6:4> FUNCTION

LMUX<1:0>	PORTE<6>	PORTE<5>	PORTE<4>
00	Digital I/O	Digital I/O	Digital I/O
01	Digital I/O	Digital I/O	COM1 Driver
10	Digital I/O	COM2 Driver	COM1 Driver
11	COM3 Driver	COM2 Driver	COM1 Driver

20.5 Segment Enables

The LCDSEx registers are used to select the pin function for each segment pin. The selection allows each pin to operate as either an LCD segment driver or a digital only pin. To configure the pin as a segment pin, the corresponding bits in the LCDSEx registers must be set to '1'.

If the pin is a digital I/O, the corresponding TRIS bit controls the data direction. Any bit set in the LCDSEx registers overrides any bit settings in the corresponding TRIS register.

Note: On a Power-on Reset, these pins are configured as digital I/O.

20.6 Pixel Control

The LCDDATAx registers contain bits that define the state of each pixel. Each bit defines one unique pixel.

Table 20-2 shows the correlation of each bit in the LCDDATAx registers to the respective common and segment signals.

Any LCD pixel location not being used for display can be used as general purpose RAM.

查询PIC18F67K90供应商 20.7 LCD Frame Frequency

The rate at which the COM and SEG outputs change is called the LCD frame frequency.

TABLE 20-5: FRAME FREQUENCY FORMULAS

Multiplex	Frame Frequency =	
Static	Clock Source/(4 x 1 x (LP<3:0> + 1))	
1/2	Clock Source/(2 x 2 x (LP<3:0> + 1))	
1/3	Clock Source/(1 x 3 x (LP<3:0> + 1))	
1/4	Clock Source/(1 x 4 x (LP<3:0> + 1))	

Note: Clock source is (Fosc/4)/8192, Timer1 Osc/32 or INTRC/32.

TABLE 20-6: APPROXIMATE FRAME FREQUENCY (IN Hz) USING Fosc AT 32 MHz, TIMER1 AT 32.768 kHz OR INTRC OSC

LP<3:0>	Static	1/2	1/3	1/4
1	125	125	167	125
2	83	83	111	83
3	62	62	83	62
4	50	50	67	50
5	42	42	56	42
6	36	36	48	36
7	31	31	42	31

20.8 LCD Waveform Generation

LCD waveform generation is based on the philosophy that the net AC voltage across the dark pixel should be maximized and the net AC voltage across the clear pixel should be minimized. The net DC voltage across any pixel should be zero.

The COM signal represents the time slice for each common, while the SEG contains the pixel data.

The pixel signal (COM-SEG) will have no DC component and can take only one of the two rms values. The higher rms value will create a dark pixel and a lower rms value will create a clear pixel.

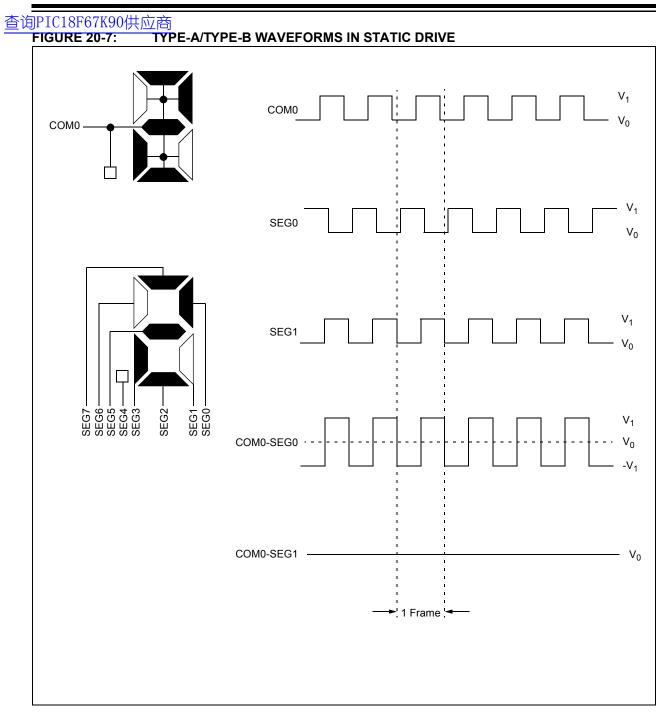
As the number of commons increases, the delta between the two rms values decreases. The delta represents the maximum contrast that the display can have.

The LCDs can be driven by two types of waveforms: Type-A and Type-B. In a Type-A waveform, the phase changes within each common type, whereas a Type-B waveform's phase changes on each frame boundary. Thus, Type-A waveforms maintain 0 VDc over a single frame, whereas Type-B waveforms take two frames.

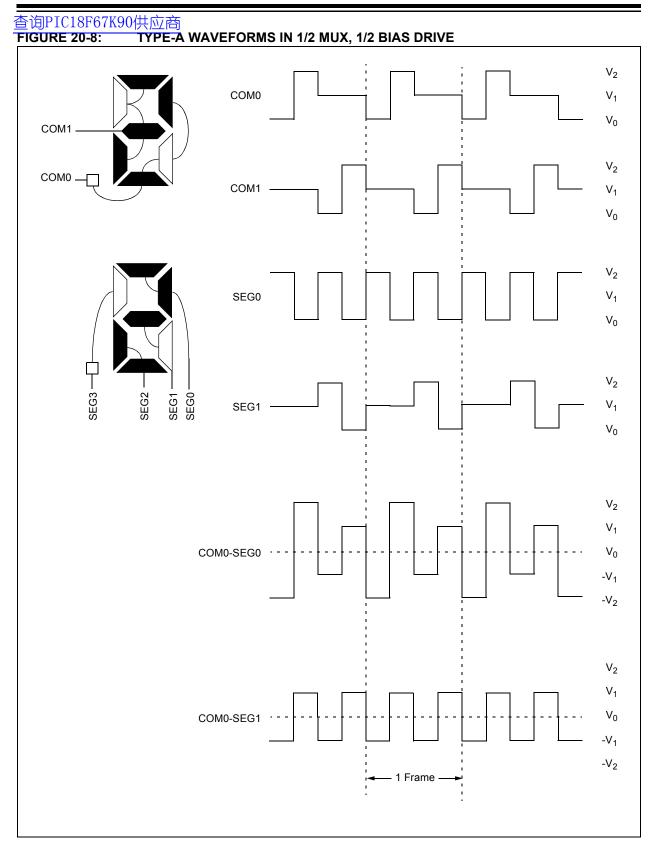
Note 1:	If Sleep has to be executed with LCD Sleep			
	enabled (SLPEN (LCDCON<6>) = 1),			
	care must be taken to execute Sleep only			
	when VDC on all the pixels is '0'.			

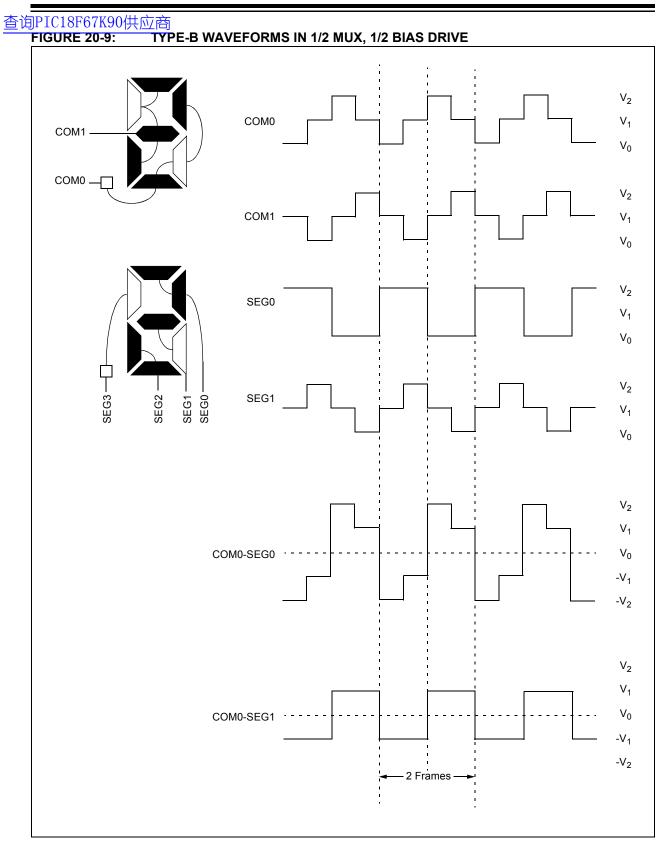
2: When the LCD clock source is (Fosc/4)/ 8192, if Sleep is executed irrespective of the LCDCON<SLPEN> setting, the LCD goes into Sleep. Thus, take care to see that VDc on all pixels is '0' when Sleep is executed.

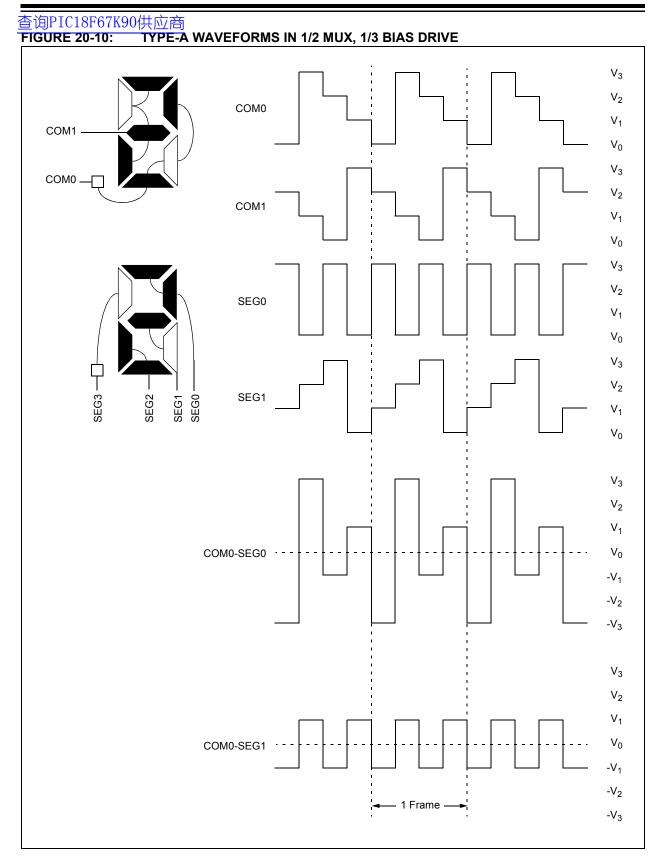
Figure 20-7 through Figure 20-17 provide waveforms for static, half-multiplex, one-third multiplex and quarter multiplex drives for Type-A and Type-B waveforms.

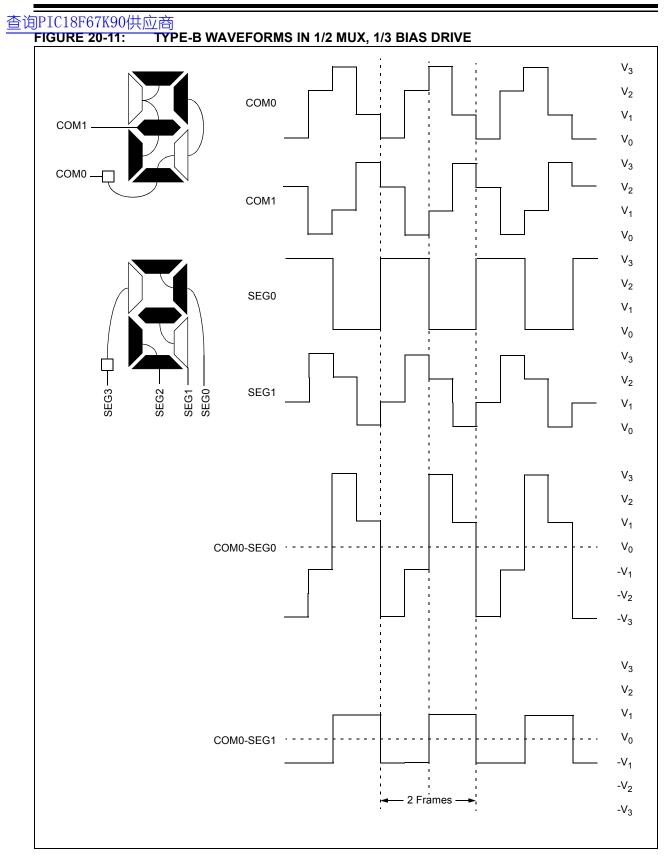


© 2010 Microchip Technology Inc.





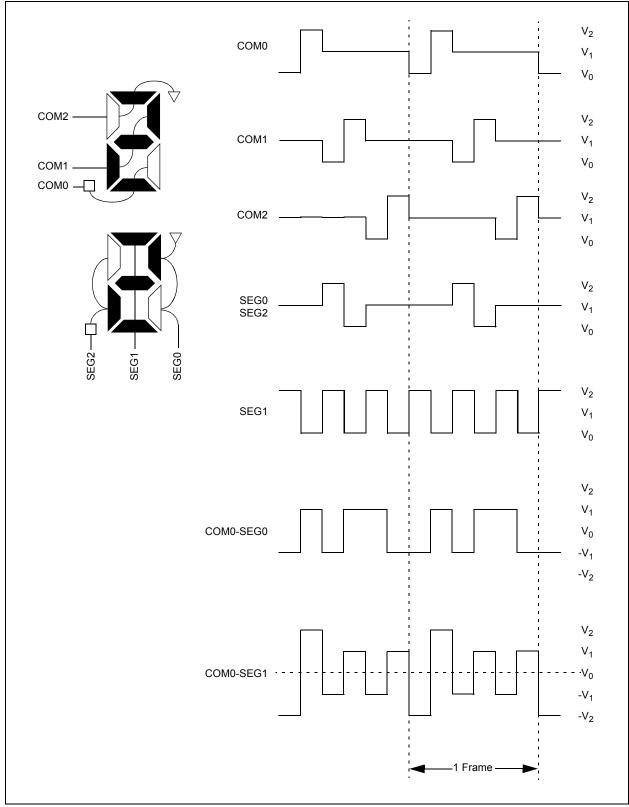


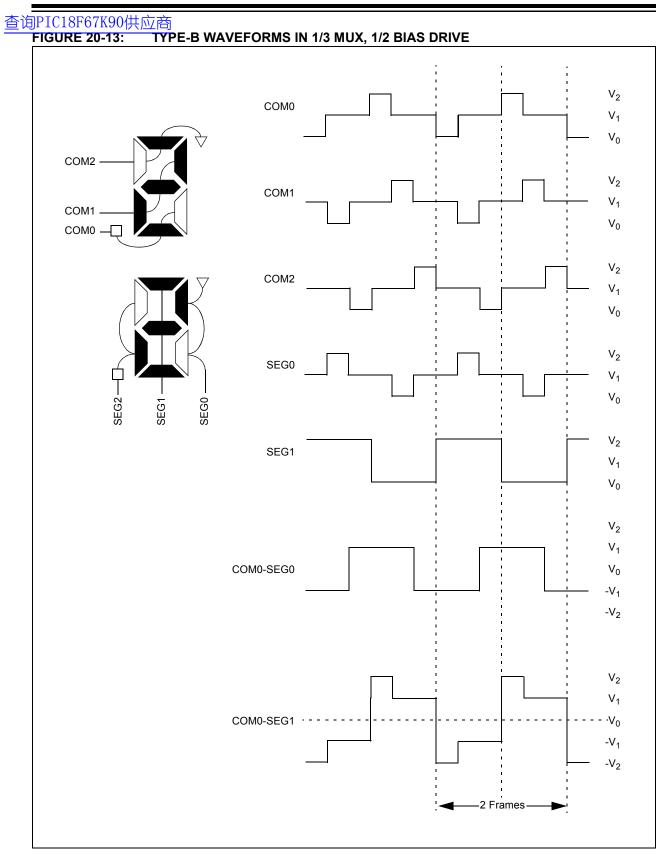


© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商

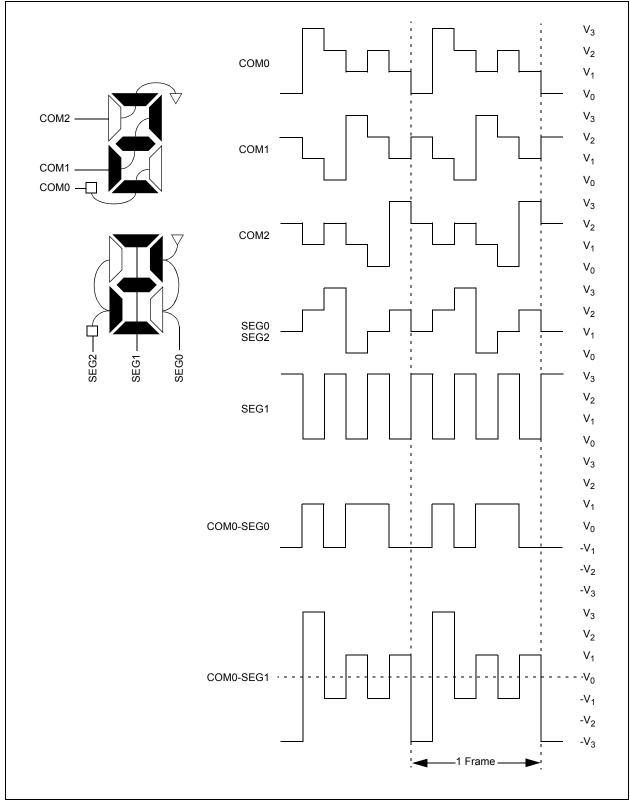
FIGURE 20-12: TYPE-A WAVEFORMS IN 1/3 MUX, 1/2 BIAS DRIVE

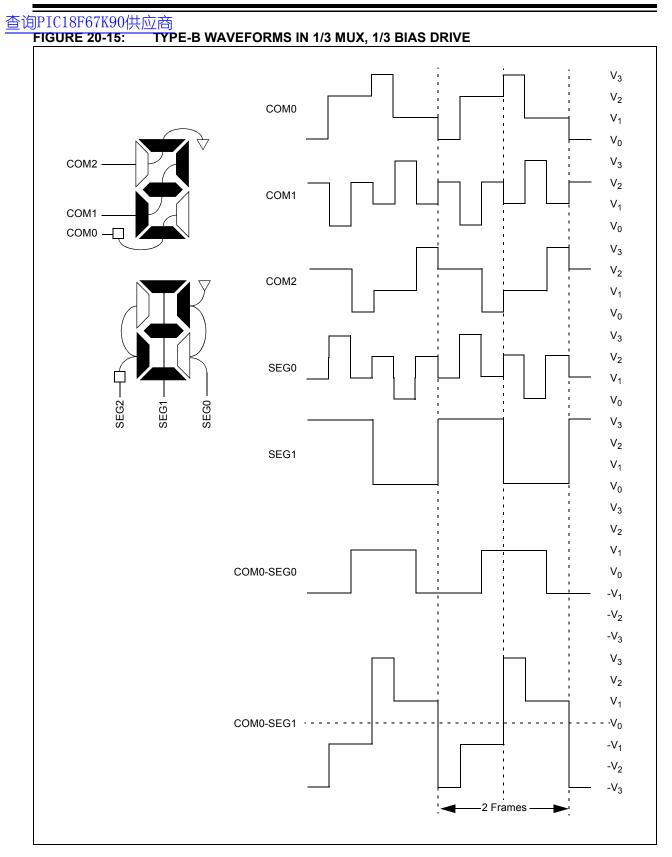




查询PIC18F67K90供应商

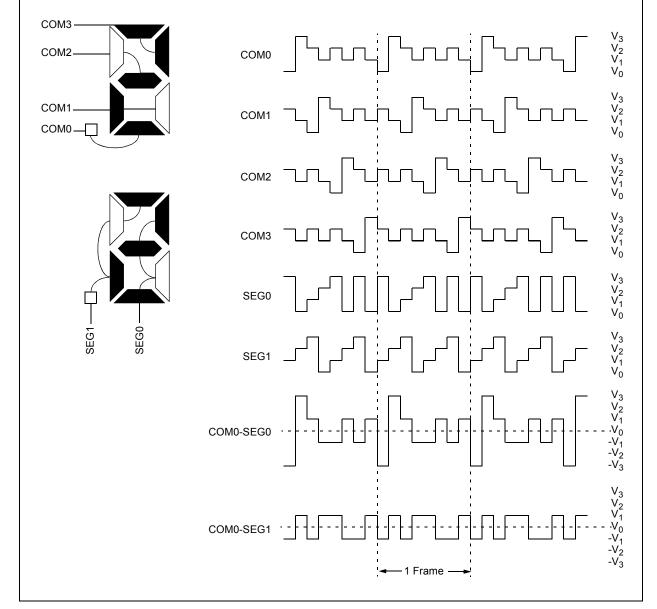
FIGURE 20-14: TYPE-A WAVEFORMS IN 1/3 MUX, 1/3 BIAS DRIVE

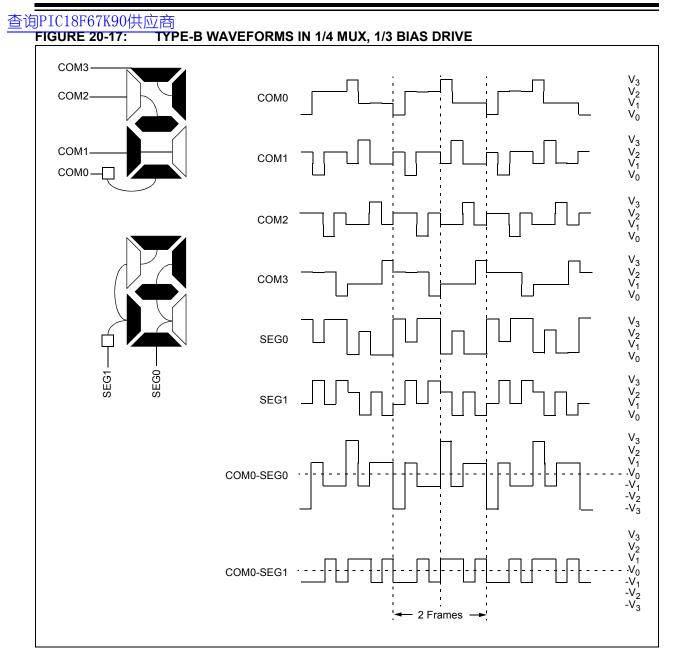




查询PIC18F67K90供应商







查询PIC18F67K90供应商 20.9 LCD Interrupts

The LCD timing generation provides an interrupt that defines the LCD frame timing. This interrupt can be used to coordinate the writing of the pixel data with the start of a new frame, which produces a visually crisp transition of the image.

This interrupt can also be used to synchronize external events to the LCD. For example, the interface to an external segment driver can be synchronized for segment data updates to the LCD frame.

A new frame is defined as beginning at the leading edge of the COM0 common signal. The interrupt will be set immediately after the LCD controller completes accessing all pixel data required for a frame. This will occur at a fixed interval before the frame boundary (TFINT), as shown in Figure 20-18.

The LCD controller will begin to access data for the next frame within the interval from the interrupt to when the controller begins accessing data after the interrupt (TFWR). New data must be written within TFWR, as this is when the LCD controller will begin to access the data for the next frame.

When the LCD driver is running with Type-B waveforms and the LMUX<1:0> bits are not equal to '00', there are some additional issues.

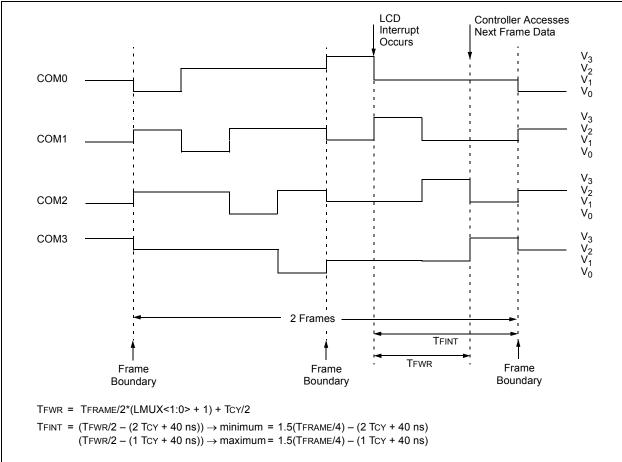
Since the DC voltage on the pixel takes two frames to maintain 0V, the pixel data must not change between subsequent frames. If the pixel data were allowed to change, the waveform for the odd frames would not necessarily be the complement of the waveform generated in the even frames and a DC component would be introduced into the panel.

Because of this, using Type-B waveforms requires synchronizing the LCD pixel updates to occur within a subframe after the frame interrupt.

To correctly sequence writing in Type-B, the interrupt only occurs on complete phase intervals. If the user attempts to write when the write is disabled, the WERR bit (LCDCON<5>) is set.

Note:	The inte	errupt	is no	t generate	d when	the
				selected a		
	Type-B	with	no	multiplex	(static)	is
	selected					





查询PIC18F67K90供应商 20.10 Operation During Sleep

FIGURE 20-19:

The LCD module can operate during Sleep. Setting the SLPEN bit (LCDCON<6>) allows the LCD module to go to Sleep. Clearing this bit allows the module to continue operating during Sleep.

If a SLEEP instruction is executed and SLPEN = 1, the LCD module will cease all functions and go into a very low-current consumption mode. The module will stop operation immediately and drive the minimum LCD voltage on both segment and common lines. Figure 20-19 shows this operation.

The LCD module current consumption will not decrease in this mode, but the overall consumption of the device will be lower due to shut down of the core and other peripheral functions.

To ensure that no DC component is introduced on the panel, the SLEEP instruction should be executed immediately after an LCD frame boundary. The LCD

interrupt can be used to determine the frame boundary. For the formulas to calculate the delay, see Section 20.9 "LCD Interrupts".

If a SLEEP instruction is executed and SLPEN = 0, the module will continue to display the current contents of the LCDDATA registers. The LCD data cannot be changed.

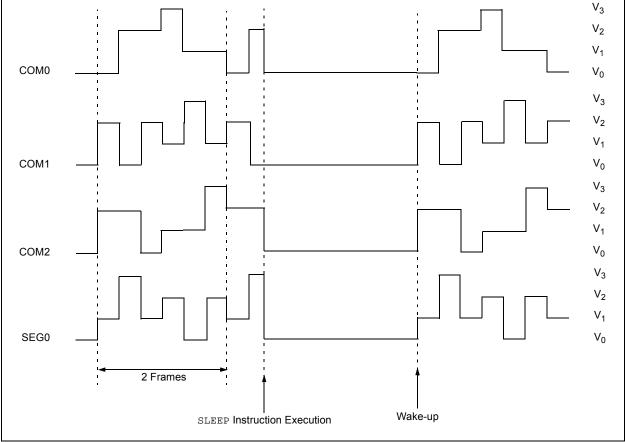
To allow the module to continue operation while in Sleep, the clock source must be either the internal RC oscillator or Timer1 external oscillator.

If the system clock is selected and the module is programmed to not Sleep, the module will ignore the SLPEN bit and stop operation immediately. The minimum LCD voltage then will be driven onto the segments and commons.

The internal RC oscillator or external Note: SOSC oscillator must be used to operate the LCD module during Sleep.



SLEEP ENTRY/EXIT WHEN SLPEN = 1 OR CS<1:0> = 00



查询PIC18F67K90供应商

20.11 Configuring the LCD Module

To configure the LCD module.

- 1. Select the frame clock prescale, using bits, LP<3:0> (LCDPS<3:0>).
- 2. Configure the appropriate pins to function as segment drivers using the LCDSEx registers.
- 3. If using the internal reference resistors for biasing, enable the internal reference ladder and:
 - Define the Mode A and Mode B interval by using the LRLAT<2:0> bits (LCDRL<2:0>)
 - Define the low, medium or high ladder for Mode A and Mode B by using the LRLAP<1:0> bits (LCDRL<7:6>) and the LRLBP<1:0> bits (LCDRL<5:4>), respectively
 - Set the VLCDxPE bits and enable the LCDIRE bit (LCDREF<7>)

- 4. Configure the following LCD module functions using the LCDCON register:
 - Multiplex and Bias mode LMUX<1:0> bits
 - Timing Source CS<1:0> bits
 - Sleep mode SLPEN bit
- 5. Write initial values to the pixel data registers, LCDDATA0 through LCDDATA23.
- 6. Clear the LCD Interrupt Flag, LCDIF (PIR3<6>), and if desired, enable the interrupt by setting bit, LCDIE (PIE3<6>).
- Enable the LCD module by setting bit, LCDEN (LCDCON<7>).

查询PIC18F67K90供应商 TABLE 20-7: REGISTERS ASSOCIATED WITH LCD OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
RCON	IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	74
LCDDATA23(1)	S47C3	S46C3	S45C3	S44C3	S43C3	S42C3	S41C3	S40C3	77
LCDDATA22(1)	S39C3	S38C3	S37C3	S36C3	S35C3	S34C3	S33C3	S32C3	77
LCDDATA21	S31C3	S30C3	S29C3	S28C3	S27C3	S26C3	S25C3	S24C3	77
LCDDATA20	S23C3	S22C3	S21C3	S20C3	S19C3	S18C3	S17C3	S16C3	77
LCDDATA19	S15C3	S14C3	S13C3	S12C3	S11C3	S10C3	S09C3	S08C3	77
LCDDATA18	S07C3	S06C3	S05C3	S04C3	S03C3	S02C3	S01C3	S00C3	77
LCDDATA17 ⁽¹⁾	S47C2	S46C2	S45C2	S44C2	S43C2	S42C2	S41C2	S40C2	77
LCDDATA16(1)	S39C2	S38C2	S37C2	S36C2	S35C2	S34C2	S33C2	S32C2	77
LCDDATA15	S31C2	S30C2	S29C2	S28C2	S27C2	S26C2	S25C2	S24C2	77
LCDDATA14	S23C2	S22C2	S21C2	S20C2	S19C2	S18C2	S17C2	S16C2	77
LCDDATA13	S15C2	S14C2	S13C2	S12C2	S11C2	S10C2	S09C2	S08C2	77
LCDDATA12	S07C2	S06C2	S05C2	S04C2	S03C2	S02C2	S01C2	S00C2	77
LCDDATA11 ⁽¹⁾	S47C1	S46C1	S45C1	S44C1	S43C1	S42C1	S41C1	S40C1	77
LCDDATA10 ⁽¹⁾	S39C1	S38C1	S37C1	S36C1	S35C1	S34C1	S33C1	S32C1	77
LCDDATA9	S31C1	S30C1	S29C1	S28C1	S27C1	S26C1	S25C1	S24C1	77
LCDDATA8	S23C1	S22C1	S21C1	S20C1	S19C1	S18C1	S17C1	S16C1	77
LCDDATA7	S15C1	S14C1	S13C1	S12C1	S11C1	S10C1	S09C1	S08C1	77
LCDDATA6	S07C1	S06C1	S05C1	S04C1	S03C1	S02C1	S01C1	S00C1	77
LCDDATA5 ⁽¹⁾	S47C0	S46C0	S45C0	S44C0	S43C0	S42C0	S41C0	S40C0	77
LCDDATA4 ⁽¹⁾	S39C0	S38C0	S37C0	S36C0	S35C0	S34C0	S33C0	S32C0	77
LCDDATA3	S31C0	S30C0	S29C0	S28C0	S27C0	S26C0	S25C0	S24C0	77
LCDDATA2	S23C0	S22C0	S21C0	S20C0	S19C0	S18C0	S17C0	S16C0	77
LCDDATA1	S15C0	S14C0	S13C0	S12C0	S11C0	S10C0	S09C0	S08C0	77
LCDDATA0	S07C0	S06C0	S05C0	S04C0	S03C0	S02C0	S01C0	S00C0	77
LCDSE5 ⁽²⁾	SE47	SE46	SE45	SE44	SE43	SE42	SE41	SE40	81
LCDSE4 ⁽²⁾	SE39	SE38	SE37	SE36	SE35	SE34	SE33	SE32	81
LCDSE3	SE31	SE30	SE29	SE28	SE27	SE26	SE25	SE24	81
LCDSE2	SE23	SE22	SE21	SE20	SE19	SE18	SE17	SE16	81
LCDSE1	SE15	SE14	SE13	SE12	SE11	SE10	SE9	SE8	81
LCDSE0	SE7	SE6	SE5	SE4	SE3	SE2	SE1	SE0	81
LCDCON	LCDEN	SLPEN	WERR		CS1	CS0	LMUX1	LMUX0	81
LCDPS	WFT	BIASMD	LCDA	WA	LP3	LP2	LP1	LP0	81
LCDREF	LCDIRE	LCDIRS	LCDCST2	LCDCST1	LCDCST0	VLCD3PE	VLCD2PE	VLCD1PE	81
LCDRL	LRLAP1	LRLAP0	LRLBP1	LRLBP0	—	LRLAT2	LRLAT1	LRLAT0	81

Legend: — = unimplemented, read as '0'. Shaded cells are not used for LCD operations.

Note 1: These registers are implemented, but unused on 64-pin devices and may be used as general purpose data RAM.

2: These registers are unimplemented on 64-pin devices.

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商

21.0 MASTER SYNCHRONOUS SERIAL PORT (MSSP) MODULE

21.1 Master SSP (MSSP) Module Overview

The Master Synchronous Serial Port (MSSP) module is a serial interface, useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D Converters, etc. The MSSP module can operate in one of two modes:

- Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I²C[™])
 - Full Master mode
 - Slave mode (with general address call)

The I²C interface supports the following modes in hardware:

- Master mode
- Multi-Master mode
- Slave mode with 5-bit and 7-bit address masking (with address masking for both 10-bit and 7-bit addressing)

All members of the PIC18F87K90 family have two MSSP modules, designated as MSSP1 and MSSP2. Each module operates independently of the other.

Note: Throughout this section, generic references to an MSSP module in any of its operating modes may be interpreted as being equally applicable to MSSP1 or MSSP2. Register names and module I/O signals use the generic designator 'x' to indicate the use of a numeral to distinguish a particular module when required. Control bit names are not individuated.

21.2 Control Registers

Each MSSP module has three associated control registers. These include a status register (SSPxSTAT) and two control registers (SSPxCON1 and SSPxCON2). The use of these registers and their individual configuration bits differ significantly depending on whether the MSSP module is operated in SPI or I^2C mode.

Additional details are provided under the individual sections.

Note:	In devices with more than one MSSP module, it is very important to pay close attention to SSPxCON register names. SSP1CON1 and SSP1CON2 control
	different operational aspects of the same module, while SSP1CON1 and SSP2CON1 control the same features for two different modules.

21.3 SPI Mode

The SPI mode allows 8 bits of data to be synchronously transmitted and received simultaneously. All four modes of SPI are supported. To accomplish communication, typically three pins are used:

- Serial Data Out (SDOx) RC5/SDO1/SEG12 or RD4/SEG4/SDO2
- Serial Data In (SDIx) RC4/SDI1/SDA1/SEG16 or RD5/SEG5/SDI2/SDA2
- Serial Clock (SCKx) RC3/SCK1/SCL1/SEG17 or RD6/SEG6/SCK2/SCL2

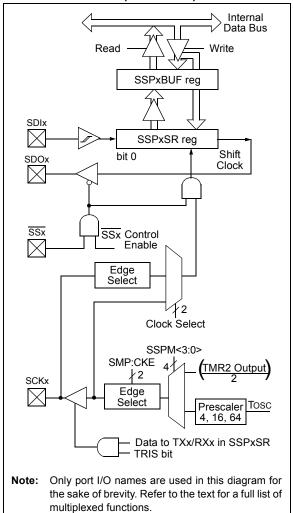
Additionally, a fourth pin may be used when in a Slave mode of operation:

 Slave Select (SSx) – RF7/AN5/SS1/SEG25 or RD7/SEG7/SS2

Figure 21-1 shows the block diagram of the MSSP module when operating in SPI mode.



MSSPx BLOCK DIAGRAM (SPI MODE)



查询PIC18F67K90供应商 21.3.1 REGISTERS

Each MSSP module has four registers for SPI mode operation. These are:

- MSSPx Control Register 1 (SSPxCON1)
- MSSPx Status Register (SSPxSTAT)
- Serial Receive/Transmit Buffer Register (SSPxBUF)
- MSSPx Shift Register (SSPxSR) Not directly accessible

SSPxCON1 and SSPxSTAT are the control and status registers in SPI mode operation. The SSPxCON1 register is readable and writable. The lower 6 bits of the SSPxSTAT are read-only. The upper two bits of the SSPxSTAT are read/write.

SSPxSR is the shift register used for shifting data in or out. SSPxBUF is the buffer register to which data bytes are written to or read from. In receive operations, SSPxSR and SSPxBUF together create a double-buffered receiver. When SSPxSR receives a complete byte, it is transferred to SSPxBUF and the SSPxIF interrupt is set.

During transmission, the SSPxBUF is not double-buffered. A write to SSPxBUF will write to both SSPxBUF and SSPxSR.

Note: The SSPxBUF register cannot be used with read-modify-write instructions, such as BCF, COMF, etc. To avoid lost data in Master mode, a read of the SSPxBUF must be performed to clear the Buffer Full (BF) detect bit (SSPxSTAT<0>) between each transmission.

REGISTER 21-1: SSPxSTAT: MSSPx STATUS REGISTER (SPI MODE)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE ⁽¹⁾	D/Ā	Р	S	R/W	UA	BF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	SMP: Sample bit
	SPI Master mode:
	1 = Input data sampled at the end of data output time
	0 = Input data sampled at the middle of data output time
	SPI Slave mode:
	SMP must be cleared when SPI is used in Slave mode.
bit 6	CKE: SPI Clock Select bit ⁽¹⁾
	1 = Transmit occurs on transition from active to Idle clock state
	0 = Transmit occurs on transition from Idle to active clock state
bit 5	D/A: Data/Address bit
	Used in I ² C™ mode only.
bit 4	P: Stop bit
	Used in I ² C mode only. This bit is cleared when the MSSPx module is disabled; SSPEN is cleared.
bit 3	Start bit
	Used in I ² C mode only.
bit 2	R/W: Read/Write Information bit
	Used in I ² C mode only.
bit 1	UA: Update Address bit
	Used in I ² C mode only.
bit 0	BF: Buffer Full Status bit (Receive mode only)
	1 = Receive complete, SSPxBUF is full
	0 = Receive not complete, SSPxBUF is empty
Note 1	Delevity of the electric state is get by the CKD bit (CCD) $(CON(1/4))$

Note 1: Polarity of the clock state is set by the CKP bit (SSPxCON1<4>).

查询PIC18F67K90供应商 REGISTER 21-2: SSPxCON1: MSSPx CONTROL REGISTER 1 (SPI MODE)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WCOL	SSPOV ⁽¹⁾	SSPEN ⁽²⁾	CKP	SSPM3 ⁽³⁾	SSPM2 ⁽³⁾	SSPM1 ⁽³⁾	SSPM0 ⁽³⁾
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	WCOL: Write Collision Detect bit
	1 = The SSPxBUF register is written while it is still transmitting the previous word (must be cleared in
	software)
	0 = No collision
bit 6	SSPOV: Receive Overflow Indicator bit ⁽¹⁾
	SPI Slave mode:
	1 = A new byte is received while the SSPxBUF register is still holding the previous data. In case of over- flow, the data in SSPxSR is lost. Overflow can only occur in Slave mode. The user must read the SSPxBUF, even if only transmitting data, to avoid setting overflow (must be cleared in software).
	0 = No overflow
bit 5	SSPEN: Master Synchronous Serial Port Enable bit ⁽²⁾
	1 = Enables serial port and configures SCKx, SDOx, SDIx and SSx as serial port pins
	0 = Disables serial port and configures these pins as I/O port pins
bit 4	CKP: Clock Polarity Select bit
	1 = Idle state for clock is a high level
	0 = Idle state for clock is a low level
bit 3-0	SSPM<3:0>: Master Synchronous Serial Port Mode Select bits ⁽³⁾
	1010 = SPI Master mode: Clock = Fosc/8
	0101 = SPI Slave mode: Clock = SCKx pin; \overline{SSx} pin control disabled; \overline{SSx} can be used as I/O pin
	0100 = SPI Slave mode: Clock = SCKx pin; SSx pin control enabled
	0011 = SPI Master mode: Clock = TMR2 Output/2 0010 = SPI Master mode: Clock = Fosc/64
	0010 = SPI Master mode: Clock = Fosc/16
	0000 = SPI Master mode: Clock = Fosc/4
Note 1	···· ··· · · · · · · · · · · · · · · ·
	writing to the SSPxBUF register.
•	Miller en ele le difference d'une accest le superior d'en andre de la constante de

- 2: When enabled, these pins must be properly configured as inputs or outputs.
- **3:** Bit combinations not specifically listed here are either reserved or implemented in I^2C^{TM} mode only.

查询PIC18F67K90供应商 21.3.2 OPERATION

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits (SSPxCON1<5:0> and SSPxSTAT<7:6>). These control bits allow the following to be specified:

- Master mode (SCKx is the clock output)
- Slave mode (SCKx is the clock input)
- Clock Polarity (Idle state of SCKx)
- Data Input Sample Phase (middle or end of data output time)
- Clock Edge (output data on rising/falling edge of SCKx)
- Clock Rate (Master mode only)
- Slave Select mode (Slave mode only)

Each MSSP module consists of a transmit/receive shift register (SSPxSR) and a buffer register (SSPxBUF). The SSPxSR shifts the data in and out of the device, MSb first. The SSPxBUF holds the data that was written to the SSPxSR until the received data is ready. Once the 8 bits of data have been received, that byte is moved to the SSPxBUF register. Then, the Buffer Full detect bit, BF (SSPxSTAT<0>), and the interrupt flag bit, SSPxIF, are set. This double-buffering of the received data (SSPxBUF) allows the next byte to start reception before reading the data that was just received. Any write to the SSPxBUF register during transmission/reception of data will be ignored and the Write Collision Detect bit, WCOL (SSPxCON1<7>), will be set. User software must clear the WCOL bit so that it can be determined if the following write(s) to the SSPxBUF register completed successfully.

When the application software is expecting to receive valid data, the SSPxBUF should be read before the next byte of data to transfer is written to the SSPxBUF. The Buffer Full bit, BF (SSPxSTAT<0>), indicates when SSPxBUF has been loaded with the received data (transmission is complete). When the SSPxBUF is read, the BF bit is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally, the MSSP interrupt is used to determine when the transmission/reception has completed. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur. Example 21-1 shows the loading of the SSPxBUF (SSPxSR) for data transmission.

The SSPxSR is not directly readable or writable and can only be accessed by addressing the SSPxBUF register. Additionally, the SSPxSTAT register indicates the various status conditions.

21.3.3 OPEN-DRAIN OUTPUT OPTION

The drivers for the SDOx output and SCKx clock pins can be optionally configured as open-drain outputs. This feature allows the voltage level on the pin to be pulled to a higher level through an external pull-up resistor, and allows the output to communicate with external circuits without the need for additional level shifters. For more information, see **Section 11.1.3 "Open-Drain Outputs"**.

The open-drain output option is controlled by the SSP2OD (ODCON1<0>) and SSP1OD bits (ODCON1<7>). Setting an SSPxOD bit configures the SDOx and SCKx pins for the corresponding module for open-drain operation.

Note: To avoid lost data in Master mode, a read of the SSPxBUF must be performed to clear the Buffer Full (BF) detect bit (SSPxSTAT<0>) between each transmission.

EXAMPLE 21-1: LOADING THE SSP1BUF (SSP1SR) REGISTER

LOOP	BTFSS BRA MOVF	LOOP	;Has data been received (transmit complete)? ;No ;WREG reg = contents of SSP1BUF
	MOVWF	RXDATA	;Save in user RAM, if data is meaningful
	MOVF MOVWF	TXDATA, W SSP1BUF	;W reg = contents of TXDATA ;New data to xmit

查询PIC18F67K90供应商 21.3.4 ENABLING SPI I/O

To enable the serial port, MSSP Enable bit, SSPEN (SSPxCON1<5>), must be set. To reset or reconfigure SPI mode, clear the SSPEN bit, reinitialize the SSPxCON registers and then set the SSPEN bit. This configures the SDIx, SDOx, SCKx and SSx pins as serial port pins. For the pins to behave as the serial port function, some must have their data direction bits (in the TRIS register) appropriately programmed as follows:

- SDIx is automatically controlled by the SPI module
- SDOx must have the TRISC<5> or TRISD<4> bit cleared
- SCKx (Master mode) must have the TRISC<3> or TRISD<6>bit cleared
- SCKx (Slave mode) must have the TRISC<3> or TRISD<6> bit set
- SSx must have the TRISF<7> or TRISD<7> bit set

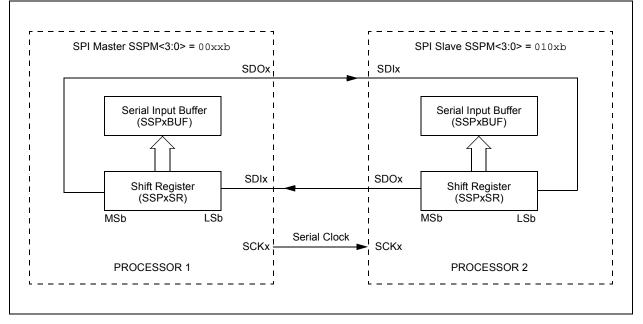
Any serial port function that is not desired may be overridden by programming the corresponding Data Direction (TRIS) register to the opposite value.

21.3.5 TYPICAL CONNECTION

Figure 21-2 shows a typical connection between two microcontrollers. The master controller (Processor 1) initiates the data transfer by sending the SCKx signal. Data is shifted out of both shift registers on their programmed clock edge and latched on the opposite edge of the clock. Both processors should be programmed to the same Clock Polarity (CKP), then both controllers would send and receive data at the same time. Whether the data is meaningful (or dummy data) depends on the application software. This leads to three scenarios for data transmission:

- · Master sends data Slave sends dummy data
- Master sends data Slave sends data
- Master sends dummy data Slave sends data

FIGURE 21-2: SPI MASTER/SLAVE CONNECTION



查询PIC18F67K90供应商 21.3.6 MASTER MODE

The master can initiate the data transfer at any time because it controls the SCKx. The master determines when the slave (Processor 1, Figure 21-2) is to broadcast data by the software protocol.

In Master mode, the data is transmitted/received as soon as the SSPxBUF register is written to. If the SPI is only going to receive, the SDOx output could be disabled (programmed as an input). The SSPxSR register will continue to shift in the signal present on the SDIx pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPxBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a "Line Activity Monitor" mode.

The clock polarity is selected by appropriately programming the CKP bit (SSPxCON1<4>). This, then, would give waveforms for SPI communication as

shown in Figure 21-3, Figure 21-5 and Figure 21-6, where the MSB is transmitted first. In Master mode, the SPI clock rate (bit rate) is user-programmable to be one of the following:

- Fosc/4 (or Tcy)
- Fosc/16 (or 4 Tcy)
- Fosc/64 (or 16 Tcy)
- Timer2 output/2

This allows a maximum data rate (at 40 MHz) of 10.00 Mbps.

Figure 21-3 shows the waveforms for Master mode. When the CKE bit is set, the SDOx data is valid before there is a clock edge on SCKx. The change of the input sample is shown based on the state of the SMP bit. The time when the SSPxBUF is loaded with the received data is shown.

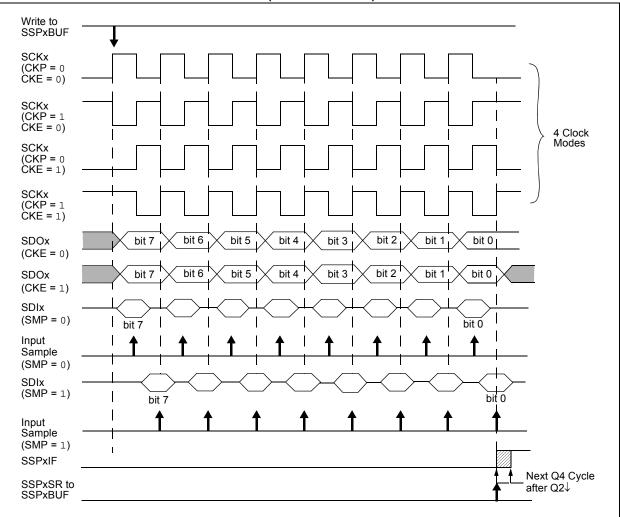


FIGURE 21-3: SPI MODE WAVEFORM (MASTER MODE)

查询PIC18F67K90供应商 21.3.7 SLAVE MODE

In Slave mode, the data is transmitted and received as the external clock pulses appear on SCKx. When the last bit is latched, the SSPxIF interrupt flag bit is set.

While in Slave mode, the external clock is supplied by the external clock source on the SCKx pin. This external clock must meet the minimum high and low times as specified in the electrical specifications.

While in Sleep mode, the slave can transmit/receive data. When a byte is received, the device can be configured to wake-up from Sleep.

21.3.8 SLAVE SELECT SYNCHRONIZATION

The \overline{SSx} pin allows a Synchronous Slave mode. The SPI must be in Slave mode with the \overline{SSx} pin control enabled (SSPxCON1<3:0> = 04h). When the \overline{SSx} pin is low, transmission and reception are enabled and the SDOx pin is driven. When the \overline{SSx} pin goes high, the SDOx pin is no longer driven, even if in the middle of a

transmitted byte and becomes a floating output. External pull-up/pull-down resistors may be desirable depending on the application.

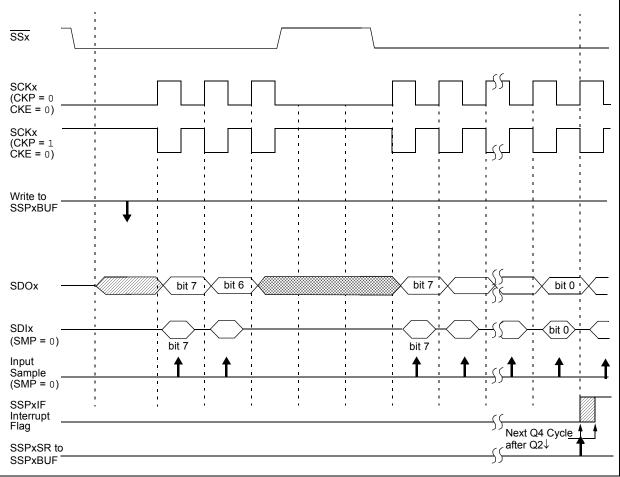
Note 1:	When	the	SPI	is	in	Slave	mode
	with	SSx	pin	C	contr	ol e	nabled
	(SSPx	CON1	<3:0>	= 0	100), the	SPI
	module	will re	set if th	ne S	SSx p	in is set	to VDD.

2: If the SPI is used in Slave mode with CKE set, then the SSx pin control must be enabled.

When the SPI module resets, the bit counter is forced to '0'. This can be done by either forcing the SSx pin to a high level or clearing the SSPEN bit.

To emulate two-wire communication, the SDOx pin can be connected to the SDIx pin. When the SPI needs to operate as a receiver, the SDOx pin can be configured as an input. This disables transmissions from the SDOx. The SDIx can always be left as an input (SDIx function) since it cannot create a bus conflict.





查询PIC18F67K90供应商

FIGURE 21-5: SPI MODE WAVEFORM (SLAVE MODE WITH CKE = 0)

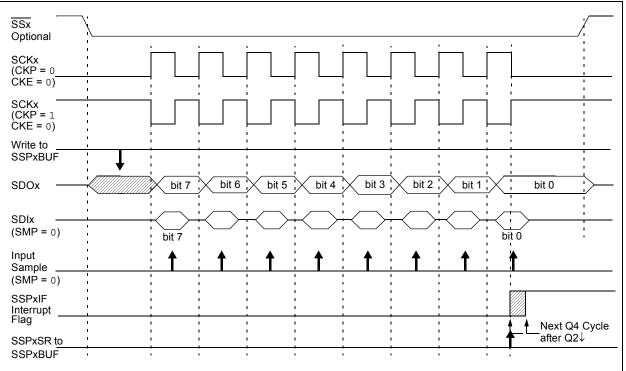
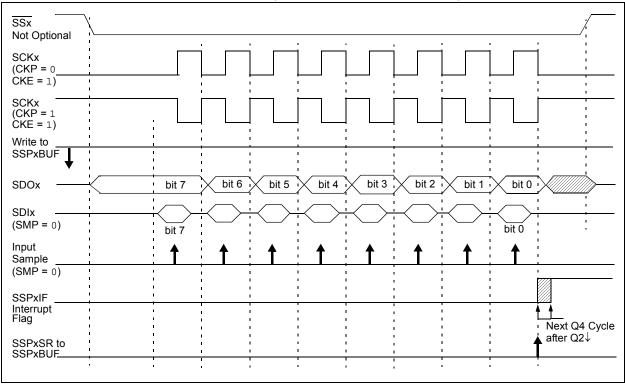


FIGURE 21-6: SPI MODE WAVEFORM (SLAVE MODE WITH CKE = 1)



查询PIC18F67K90供应商

21.3.9 OPERATION IN POWER-MANAGED MODES

In SPI Master mode, module clocks may be operating at a different speed than when in full-power mode; in the case of the Sleep mode, all clocks are halted.

In Idle modes, a clock is provided to the peripherals. That clock can be from the primary clock source, the secondary clock (SOSC oscillator) or the INTOSC source. See **Section 3.3** "**Clock Sources and Oscillator Switching**" for additional information.

In most cases, the speed that the master clocks SPI data is not important; however, this should be evaluated for each system.

If MSSP interrupts are enabled, they can wake the controller from Sleep mode, or one of the Idle modes, when the master completes sending data. If an exit from Sleep or Idle mode is not desired, MSSP interrupts should be disabled.

If the Sleep mode is selected, all module clocks are halted and the transmission/reception will remain in that state until the device wakes. After the device returns to Run mode, the module will resume transmitting and receiving data.

In SPI Slave mode, the SPI Transmit/Receive Shift register operates asynchronously to the device. This allows the device to be placed in any power-managed mode and data to be shifted into the SPI Transmit/Receive Shift register. When all 8 bits have been received, the MSSP interrupt flag bit will be set, and if enabled, will wake the device.

21.3.10 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

21.3.11 BUS MODE COMPATIBILITY

Table 21-1 shows the compatibility between the standard SPI modes and the states of the CKP and CKE control bits.

Standard SPI Mode	Control Bits State				
Terminology	СКР	CKE			
0, 0	0	1			
0, 1	0	0			
1, 0	1	1			
1, 1	1	0			

There is also an SMP bit which controls when the data is sampled.

21.3.12 SPI CLOCK SPEED AND MODULE INTERACTIONS

Because MSSP1 and MSSP2 are independent modules, they can operate simultaneously at different data rates. Setting the SSPM<3:0> bits of the SSPxCON1 register determines the rate for the corresponding module.

An exception is when both modules use Timer2 as a time base in Master mode. In this instance, any changes to the Timer2 module's operation will affect both MSSP modules equally. If different bit rates are required for each module, the user should select one of the other three time base options for one of the modules.

查询PIC18F67K90供应商 TABLE 21-2: REGISTERS ASSOCIATED WITH SPI OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	—	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	—	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR2	OSCFIF	_	SSP2IF	BCL2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF	75
PIE2	OSCFIE		SSP2IE	BCL2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	75
IPR2	OSCFIP	_	SSP2IP	BCL2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP	75
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	76
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	76
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	76
SSP1BUF	MSSP1 Rec	eive Buffer/Tra	ansmit Regi	ster					80
SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	74
SSP1CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	74
SSP1STAT	SMP	CKE	D/Ā	Р	S	R/W	UA	BF	74
SSP2CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	80
SSP2CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	81
SSP2STAT	SMP	CKE	D/Ā	Р	S	R/W	UA	BF	80
SSP2BUF	MSSP2 Rec	eive Buffer/Tra	ansmit Regi	ster				•	80
ODCON3	U2OD	U10D	—	—	—	—	—	CTMUDS	79

Legend: Shaded cells are not used by the MSSP module in SPI mode.

查询PIC18F67K90供应商 **21.4 I²C™ Mode**

FIGURE 21-7

The MSSP module in I²C mode fully implements all master and slave functions (including general call support), and provides interrupts on Start and Stop bits in hardware to determine a free bus (multi-master function). The MSSP module implements the standard mode specifications, as well as 7-bit and 10-bit addressing.

Two pins are used for data transfer:

- Serial Clock (SCLx) RC3/SCK1/SCL1/SEG17 or RD6/SEG6/SCK2/SCL2
- Serial Data (SDAx) RC4/SDI1/SDA1/SEG16 or RD5/SEG5/SDI2/SDA2

The user must configure these pins as inputs by setting the associated TRIS bits.

MSSPX BLOCK DIAGRAM

FIGURE	(I ² C [™] MODE)
SCLX SDAX	Read Write SSPxBUF reg Shift Clock SSPxSR reg MSb LSb Match Detect Addr Match Address Mask SSPxADD reg
	Start and Stop bit Detect S, P bits (SSPxSTAT reg)
t	Only port I/O names are used in this diagram for he sake of brevity. Refer to the text for a full list of nultiplexed functions.

21.4.1 REGISTERS

The MSSP module has seven registers for ${\rm I}^2{\rm C}$ operation. These are:

- MSSPx Control Register 1 (SSPxCON1)
- MSSPx Control Register 2 (SSPxCON2)
- MSSPx Status Register (SSPxSTAT)
- Serial Receive/Transmit Buffer Register (SSPxBUF)
- MSSPx Shift Register (SSPxSR) Not directly accessible
- MSSPx Address Register (SSPxADD)
- I²C Slave Address Mask Register (SSPxMSK)

SSPxCON1, SSPxCON2 and SSPxSTAT are the control and status registers in l^2 C mode operation. The SSPxCON1 and SSPxCON2 registers are readable and writable. The lower 6 bits of the SSPxSTAT are read-only. The upper two bits of the SSPxSTAT are read/write.

SSPxSR is the shift register used for shifting data in or out. SSPxBUF is the buffer register to which data bytes are written to or read from.

SSPxADD contains the slave device address when the MSSP is configured in I^2C Slave mode. When the MSSP is configured in Master mode, the lower seven bits of SSPxADD act as the Baud Rate Generator reload value.

SSPxMSK holds the slave address mask value when the module is configured for 7-Bit Address Masking mode. While it is a separate register, it shares the same SFR address as SSPxADD. It is only accessible when the SSPM<3:0> bits are specifically set to permit access. Additional details are provided in Section 21.4.3.4 "7-Bit Address Masking Mode".

In receive operations, SSPxSR and SSPxBUF together, create a double-buffered receiver. When SSPxSR receives a complete byte, it is transferred to SSPxBUF and the SSPxIF interrupt is set.

During transmission, the SSPxBUF is not double-buffered. A write to SSPxBUF will write to both SSPxBUF and SSPxSR.

查询PIC18F67K90供应商 REGISTER 21-3: SSPxSTAT: MSSPx STATUS REGISTER (I²C™ MODE)

SMP	CKE										
		D/A	P ⁽¹⁾	S ⁽¹⁾	R/W ^(2,3)	UA	BF				
bit 7		1				1	bit				
Legend:											
R = Readabl	le bit	W = Writable	bit	U = Unimple	emented bit, read	1 as '0'					
-n = Value at		'1' = Bit is se		'0' = Bit is cl		x = Bit is unkn	nown				
				o Bitio di							
bit 7	SMP: Slew Rate Control bit										
	In Master or Slave mode: 1 = Slew rate control is disabled for Standard Speed mode (100 kHz and 1 MHz)										
						1 MHz)					
			bled for High-S	beed mode (4	100 kHz)						
bit 6	CKE: SMBu										
		Slave mode: MBus-specific	innuts								
		SMBus-specific	•								
bit 5	D/A: Data/A	•	•								
	In Master mode:										
	Reserved.										
	In Slave mode: 1 = Indicates that the last byte received or transmitted was data										
bit 4	 0 = Indicates that the last byte received or transmitted was an address P: Stop bit⁽¹⁾ 										
JIL 4	•										
	 1 = Indicates that a Stop bit has been detected last 0 = Stop bit was not detected last 										
bit 3	S: Start bit ⁽¹⁾										
	1 = Indicates that a Start bit has been detected last										
	0 = Start bit was not detected last										
bit 2	R/W: Read/Write Information bit ^(2,3)										
	In Slave mode:										
	1 = Read 0 = Write										
	0 = white In Master mode:										
		is in progress									
		is not in progre	ess								
bit 1	UA: Update	Address bit (10	-Bit Slave mod	e only)							
	1 = Indicates that the user needs to update the address in the SSPxADD register										
		does not need	to be updated								
bit 0	BF: Buffer Full Status bit										
	In Transmit mode: 1 = SSPxBUF is full										
	1 = SSPXBU 0 = SSPXBU										
	In Receive n										
			not include the A								
	0 = SSPxBU	IF is empty (do	es not include th	ne ACK and S	Stop bits)						
Note 1: ⊤	his bit is cleare	d on Reset and	I when SSPEN	is cleared.							
					ess match. This I	bit is onlv valid	from the				

- address match to the next Start bit, Stop bit or not \overline{ACK} bit.
- 3: ORing this bit with SEN, RSEN, PEN, RCEN or ACKEN will indicate if the MSSPx is in Active mode.

查询PIC18F67K90供应商 REGISTER 21-4: SSPxCON1: MSSPx CONTROL REGISTER 1 (I²C™ MODE) R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 WCOL SSPOV SSPEN⁽¹⁾ CKP SSPM3⁽²⁾ SSPM2⁽²⁾ SSPM1⁽²⁾ SSPM0⁽²⁾ bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 7 WCOL: Write Collision Detect bit In Master Transmit mode: 1 = A write to the SSPxBUF register was attempted while the I²C conditions were not valid for a transmission to be started (must be cleared in software) 0 = No collisionIn Slave Transmit mode: 1 = The SSPxBUF register is written while it is still transmitting the previous word (must be cleared in software) 0 = No collisionIn Receive mode (Master or Slave modes): This is a "don't care" bit. bit 6 SSPOV: Receive Overflow Indicator bit In Receive mode: 1 = A byte is received while the SSPxBUF register is still holding the previous byte (must be cleared in software) 0 = No overflow In Transmit mode: This is a "don't care" bit in Transmit mode. bit 5 SSPEN: Master Synchronous Serial Port Enable bit⁽¹⁾ 1 = Enables the serial port and configures the SDAx and SCLx pins as the serial port pins 0 = Disables the serial port and configures these pins as I/O port pins bit 4 CKP: SCKx Release Control bit In Slave mode: 1 = Releases clock 0 = Holds clock low (clock stretch), used to ensure data setup time In Master mode: Unused in this mode. SSPM<3:0>: Master Synchronous Serial Port Mode Select bits⁽²⁾ bit 3-0 1111 = I^2C Slave mode: 10-bit address with Start and Stop bit interrupts enabled $1110 = I^2C$ Slave mode: 7-bit address with Start and Stop bit interrupts enabled $1011 = I^2C$ Firmware Controlled Master mode (slave Idle) 1001 = Load the SSPMSK register at the SSPxADD SFR address^(3,4) $1000 = I^2C$ Master mode: Clock = Fosc/(4 * (SSPxADD + 1)) 0111 = I^2C Slave mode: 10-bit address $0110 = I^2C$ Slave mode: 7-bit address Note 1: When enabled, the SDAx and SCLx pins must be configured as inputs. 2: Bit combinations not specifically listed here are either reserved or implemented in SPI mode only. 3: When SSPM<3:0> = 1001, any reads or writes to the SSPxADD SFR address actually access the SSPxMSK register.

4: This mode is only available when 7-Bit Address Masking mode is selected (MSSPMSK Configuration bit is '1').

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
GCEN	ACKSTAT	ACKDT ⁽¹⁾	ACKEN ⁽²⁾	RCEN ⁽²⁾	PEN ⁽²⁾	RSEN ⁽²⁾	SEN ⁽²⁾				
bit 7							bit				
Legend:											
R = Readal	ole bit	W = Writable	oit	U = Unimplen	nented bit, read	1 as '0'					
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkn	own				
bit 7		ral Call Enable	bit								
	Unused in Ma										
oit 6		-		r Transmit mod	e only)						
		dge was not re		ave							
		dge was receiv			(1)						
oit 5			bit (Master Re	ceive mode on	ly)('')						
	1 = Not Ackno										
L:1 4		0 = Acknowledge ACKEN: Acknowledge Sequence Enable bit ⁽²⁾									
bit 4					Cly ning and	transmite ACL	(DT data b				
		cally cleared by		SDAX and S	CLX pins and	transmits ACI					
		edge sequence									
bit 3		•		e mode only) ⁽²⁾	1						
		Receive mode f	-	,							
	0 = Receive is										
bit 2	PEN: Stop Co	ndition Enable	bit ⁽²⁾								
	1 = Initiates S 0 = Stop cond	•	n SDAx and S	CLx pins; autor	matically cleare	d by hardware					
bit 1	RSEN: Repea	ated Start Cond	ition Enable b	it ⁽²⁾							
		Repeated Start d Start conditior		DAx and SCLx	pins; automati	cally cleared by	/ hardware				
bit 0	SEN: Start Co	ondition Enable	bit ⁽²⁾								
						ed by hardware					

2: If the I²C module is active, these bits may not be set (no spooling) and the SSPxBUF may not be written (or writes to the SSPxBUF are disabled).

GCEN ACKSTAT ADMSK5 ADMSK4 ADMSK3 ADMSK2 ADMSK1 SE GCEN GCEN ACKSTAT ADMSK5 ADMSK4 ADMSK3 ADMSK2 ADMSK1 SE Legend: R R e Readable bit W = Writable bit U = Unimplemented bit, read as '0'	REGISTER 2	21-6: SSPx	CON2: MSSF	Px CONTROL	REGISTER	2 (I ² C™ SLA	VE MODE)		
bit 7 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' .n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 7 GCEN: General Call Enable bit 1 = Enables interrupt when a general call address (0000h) is received in the SSPxSR 0 = General call address is disabled 0' = General call address is disabled bit 6 ACKSTAT: Acknowledge Status bit Unused in Slave mode. Unused in Slave mode. bit 5-2 ADMSK<5:2>: Slave Address Mask Select bits (5-Bit Address Masking mode) 1 = Masking of corresponding bits of SSPxADD is enabled 0 = Masking of corresponding bits of SSPxADD is enabled bit 1 ADMSK1: Slave Address Least Significant bit(s) Mask Select bit In 7-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1:> is enabled 0 = Masking of SSPxADD<1:> is enabled 0 = Masking of SSPxADD<1:> is enabled 0 = Masking of SSPxADD<1:> is enabled 0 = Masking of SSPxADD<1:> is disabled bit 0 SEN: Stretch Enable bit ⁽¹⁾ 1 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' in = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 7 GCEN: General Call Enable bit 1 = Enables interrupt when a general call address (0000h) is received in the SSPxSR 0 = General call address is disabled 0 GCKSTAT: Acknowledge Status bit Unused in Slave mode. bit 5-2 ADMSK<5:2>: Slave Address Mask Select bits (5-Bit Address Masking mode) 1 = Masking of corresponding bits of SSPxADD is enabled bit 1 ADMSK1: Slave Address Least Significant bit(s) Mask Select bit In 7-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD 0 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is disabled In 0-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is disabled In 0-Bit Addressing mode: 1 = Masking of SSPxADD<10> is oil disabled In 0-Bit Addressing mode: 1 = Masking of SSPxADD<10> is disabled In 0-Bit Addressing mode: 1 = Masking of SSPxADD<10> is disabled In 0-Bit Addressing mode: 1 = Masking of SSPxADD<10> is disabled In 0-Bit Addressing mode: 1 = Masking of SSPxADD<10> is disabled <td>GCEN</td> <td>ACKSTAT</td> <td>ADMSK5</td> <td>ADMSK4</td> <td>ADMSK3</td> <td>ADMSK2</td> <td>ADMSK1</td> <td>SEN⁽¹</td>	GCEN	ACKSTAT	ADMSK5	ADMSK4	ADMSK3	ADMSK2	ADMSK1	SEN ⁽¹	
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' .n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 7 GCEN: General Call Enable bit 1 = Enables interrupt when a general call address (0000h) is received in the SSPxSR 0 = General call address is disabled 0 = General call address is disabled ACKSTAT: Acknowledge Status bit bit 6 ACKSTAT: Acknowledge Status bit Unused in Slave mode. bit 5-2 ADMSK<5:2>: Slave Address Mask Select bits (5-Bit Address Masking mode) 1 = Masking of corresponding bits of SSPxADD is enabled 0 = Masking of corresponding bits of SSPxADD is disabled bit 1 ADMSK1: Slave Address Least Significant bit(s) Mask Select bit In 7-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled bit 1 ADMSK1: Slave Address is enabled 0 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1:0> is enabled 0 = Masking of SSPxADD<1:0> is enabled 0 = Masking of SSPxADD<1:0> is disabled bit 0 SEN: Stretch Enable bit ⁽¹⁾ 1 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled) <td>bit 7</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td>	bit 7								
Image: International internatinternatintentities international international intern	Legend:								
bit 7 GCEN: General Call Enable bit 1 = Enables interrupt when a general call address (0000h) is received in the SSPxSR 0 = General call address is disabled bit 6 ACKSTAT: Acknowledge Status bit Unused in Slave mode. bit 5-2 ADMSK<5:2>: Slave Address Mask Select bits (5-Bit Address Masking mode) 1 = Masking of corresponding bits of SSPxADD is enabled 0 = Masking of corresponding bits of SSPxADD is disabled bit 1 ADMSK1: Slave Address Least Significant bit(s) Mask Select bit In 7-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1:0> is enabled 0 = Masking of SSPxADD<1:0> is disabled In 10-Bit Stretch Enable bit ⁽¹⁾ 1 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)	R = Readable	e bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'		
 1 = Enables interrupt when a general call address (0000h) is received in the SSPxSR 0 = General call address is disabled bit 6 ACKSTAT: Acknowledge Status bit Unused in Slave mode. bit 5-2 ADMSK<5:2>: Slave Address Mask Select bits (5-Bit Address Masking mode) 1 = Masking of corresponding bits of SSPxADD is enabled 0 = Masking of corresponding bits of SSPxADD is disabled bit 1 ADMSK1: Slave Address Least Significant bit(s) Mask Select bit I = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled In 2-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1:0> is enabled 0 = Masking of SSPxADD<1:0> is disabled 	-n = Value at I	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkne	own	
1 = Masking of corresponding bits of SSPxADD is enabled 0 = Masking of corresponding bits of SSPxADD is disabled bit 1 ADMSK1: Slave Address Least Significant bit(s) Mask Select bit In 7-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1:0> is enabled 0 = Masking of SSPxADD<1:0> is disabled bit 0 SEN: Stretch Enable bit ⁽¹⁾ 1 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)	bit 6		0	atus bit					
Unused in Slave mode. bit 5-2 ADMSK<5:2>: Slave Address Mask Select bits (5-Bit Address Masking mode) 1 = Masking of corresponding bits of SSPxADD is enabled 0 = Masking of corresponding bits of SSPxADD is disabled bit 1 ADMSK1: Slave Address Least Significant bit(s) Mask Select bit <u>In 7-Bit Addressing mode:</u> 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled <u>In 10-Bit Addressing mode:</u> 1 = Masking of SSPxADD<1> is enabled 0 = Masking of SSPxADD<1:0> is enabled 0 = Masking of SSPxADD<1:0> is disabled 1 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)									
1 = Masking of corresponding bits of SSPxADD is enabled 0 = Masking of corresponding bits of SSPxADD is disabled bit 1 ADMSK1: Slave Address Least Significant bit(s) Mask Select bit In 7-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1:0> is enabled 0 = Masking of SSPxADD<1:0> is disabled bit 0 SEN: Stretch Enable bit ⁽¹⁾ 1 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)									
 0 = Masking of corresponding bits of SSPxADD is disabled bit 1 ADMSK1: Slave Address Least Significant bit(s) Mask Select bit In 7-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1:0> is enabled 0 = Masking of SSPxADD<1:0> is disabled D = Masking of SSPxADD<1:0> is disabled D = Masking of SSPxADD<1:0> is disabled D = Masking of SSPxADD<1:0> is disabled D = Masking of SSPxADD<1:0> is disabled D = Masking of SSPxADD<1:0> is disabled D = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled) 	bit 5-2					•	node)		
In 7-Bit Addressing mode: 1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1:0> is enabled 0 = Masking of SSPxADD<1:0> is enabled 0 = Masking of SSPxADD<1:0> is disabled 0 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)									
1 = Masking of SSPxADD<1> only is enabled 0 = Masking of SSPxADD<1> only is disabled In 10-Bit Addressing mode: 1 = Masking of SSPxADD<1:0> is enabled 0 = Masking of SSPxADD<1:0> is enabled 0 = Masking of SSPxADD<1:0> is disabled 0 = Masking of SSPxADD<1:0> is disabled 0 = Masking of SSPxADD<1:0> is disabled bit 0 SEN: Stretch Enable bit ⁽¹⁾ 1 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)	bit 1	ADMSK1: Sla	ave Address Le	ast Significant	bit(s) Mask Se	lect bit			
1 = Masking of SSPxADD<1:0> is enabled 0 = Masking of SSPxADD<1:0> is disabled bit 0 SEN: Stretch Enable bit ⁽¹⁾ 1 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)		1 = Masking of SSPxADD<1> only is enabled							
1 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)		1 = Masking o	of SSPxADD<1						
•	bit 0	SEN: Stretch	Enable bit ⁽¹⁾						
			•		ve transmit and	I slave receive	(stretch enable	d)	

If the I²C module is active, this bit may not be set (no spooling) and the SSPxBUF may not be written (or Note 1: writes to the SSPxBUF are disabled).

REGISTER 2	1-7: SSPX	MSK: I ² C ™ S	LAVE ADDR	ESS MASK R	EGISTER (7-	BIIMASKIN	G MODE)
R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
MSK7	MSK6	MSK5	MSK4	MSK3	MSK2	MSK1	MSK0 ⁽²⁾

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7-0 MSK<7:0>: Slave Address Mask Select bit

1 = Masking of the corresponding bit of SSPxADD is enabled

0 = Masking of the corresponding bit of SSPxADD is disabled

Note 1: This register shares the same SFR address as SSPxADD and is only addressable in select MSSPx operating modes. See Section 21.4.3.4 "7-Bit Address Masking Mode" for more details.

2: MSK0 is not used as a mask bit in 7-bit addressing.

bit 7

bit 0

查询PIC18F67K90供应商 21.4.2 OPERATION

The MSSP module functions are enabled by setting the MSSP Enable bit, SSPEN (SSPxCON1<5>).

The SSPxCON1 register allows control of the I^2C operation. Four mode selection bits (SSPxCON1<3:0>) allow one of the following I^2C modes to be selected:

- I²C Master mode, clock
- I²C Slave mode (7-bit address)
- I²C Slave mode (10-bit address)
- I²C Slave mode (7-bit address) with Start and Stop bit interrupts enabled
- I²C Slave mode (10-bit address) with Start and Stop bit interrupts enabled
- I²C Firmware Controlled Master mode, slave is Idle

Selection of any I²C mode with the SSPEN bit set forces the SCLx and SDAx pins to be open-drain, provided these pins are programmed as inputs by setting the appropriate TRISC or TRISD bits. To ensure proper operation of the module, pull-up resistors must be provided externally to the SCLx and SDAx pins.

21.4.3 SLAVE MODE

In Slave mode, the SCLx and SDAx pins must be configured as inputs (TRISC<4:3> set). The MSSP module will override the input state with the output data when required (slave-transmitter).

The I^2C Slave mode hardware will always generate an interrupt on an address match. Address masking will allow the hardware to generate an interrupt for more than one address (up to 31 in 7-bit addressing and up to 63 in 10-bit addressing). Through the mode select bits, the user can also choose to interrupt on Start and Stop bits.

When an address is matched, or the data transfer after an address match is received, the hardware automatically will generate the Acknowledge (ACK) pulse and load the SSPxBUF register with the received value currently in the SSPxSR register.

Any combination of the following conditions will cause the MSSP module not to give this ACK pulse:

- The Buffer Full bit, BF (SSPxSTAT<0>), was set before the transfer was received.
- The overflow bit, SSPOV (SSPxCON1<6>), was set before the transfer was received.

In this case, the SSPxSR register value is not loaded into the SSPxBUF, but bit, SSPxIF, is set. The BF bit is cleared by reading the SSPxBUF register, while bit, SSPOV, is cleared through software.

The SCLx clock input must have a minimum high and low for proper operation. The high and low times of the I^2C specification, as well as the requirement of the MSSP module, are shown in timing parameter 100 and parameter 101.

21.4.3.1 Addressing

Once the MSSP module has been enabled, it waits for a Start condition to occur. Following the Start condition, the 8 bits are shifted into the SSPxSR register. All incoming bits are sampled with the rising edge of the clock (SCLx) line. The value of register, SSPxSR<7:1>, is compared to the value of the SSPxADD register. The address is compared on the falling edge of the eighth clock (SCLx) pulse. If the addresses match and the BF and SSPOV bits are clear, the following events occur:

- 1. The SSPxSR register value is loaded into the SSPxBUF register.
- 2. The Buffer Full bit, BF, is set.
- 3. An ACK pulse is generated.
- 4. The MSSP Interrupt Flag bit, SSPxIF, is set (and interrupt is generated, if enabled) on the falling edge of the ninth SCLx pulse.

In 10-Bit Addressing mode, two address bytes need to be received by the slave. The five Most Significant bits (MSbs) of the first address byte specify if this is a 10-bit address. The R/\overline{W} bit (SSPxSTAT<2>) must specify a write so the slave device will receive the second address byte. For a 10-bit address, the first byte would equal '11110 A9 A8 0', where 'A9' and 'A8' are the two MSbs of the address. The sequence of events for 10-bit addressing is as follows, with steps, 7 through 9, for the slave-transmitter:

- 1. Receive first (high) byte of address (bits, SSPxIF, BF and UA, are set on address match).
- 2. Update the SSPxADD register with second (low) byte of address (clears bit, UA, and releases the SCLx line).
- 3. Read the SSPxBUF register (clears bit, BF) and clear flag bit, SSPxIF.
- 4. Receive second (low) byte of address (bits, SSPxIF, BF and UA, are set).
- 5. Update the SSPxADD register with the first (high) byte of address. If match releases the SCLx line, this will clear bit, UA.
- 6. Read the SSPxBUF register (clears bit, BF) and clear flag bit, SSPxIF.
- 7. Receive Repeated Start condition.
- 8. Receive first (high) byte of address (bits, SSPxIF and BF, are set).
- 9. Read the SSPxBUF register (clears bit, BF) and clear flag bit, SSPxIF.

查询PIC18F67K90供应商

21.4.3.2 Address Masking Modes

Masking an address bit causes that bit to become a "don't care". When one address bit is masked, two addresses will be Acknowledged and cause an interrupt. It is possible to mask more than one address bit at a time, which greatly expands the number of addresses Acknowledged.

The l^2C slave behaves the same way whether address masking is used or not. However, when address masking is used, the l^2C slave can Acknowledge multiple addresses and cause interrupts. When this occurs, it is necessary to determine which address caused the interrupt by checking the SSPxBUF.

The PIC18F87K90 family of devices is capable of using two different Address Masking modes in I²C slave operation: 5-Bit Address Masking and 7-Bit Address Masking. The Masking mode is selected at device configuration using the MSSPMSK Configuration bit. The default device configuration is 7-Bit Address Masking.

Both Masking modes, in turn, support address masking of 7-bit and 10-bit addresses. The combination of Masking modes and addresses provide different ranges of Acknowledgable addresses for each combination.

While both Masking modes function in roughly the same manner, the way they use address masks are different.

21.4.3.3 5-Bit Address Masking Mode

As the name implies, 5-Bit Address Masking mode uses an address mask of up to 5 bits to create a range of addresses to be Acknowledged, using bits, 5 through 1, of the incoming address. This allows the module to Acknowledge up to 31 addresses when using 7-bit addressing, or 63 addresses with 10-bit addressing (see Example 21-2). This Masking mode is selected when the MSSPMSK Configuration bit is programmed ('0').

The address mask in this mode is stored in the SSPxCON2 register, which stops functioning as a control register in l^2C Slave mode (Register 21-6). In 7-Bit Address Masking mode, address mask bits, ADMSK<5:1> (SSPxCON2<5:1>), mask the corresponding address bits in the SSPxADD register. For any ADMSK bits that are set (ADMSK<n> = 1), the corresponding address bit is ignored (SSPxADD<n> = x). For the module to issue an address Acknowledge, it is sufficient to match only on addresses that do not have an active address mask.

In 10-Bit Address Masking mode, bits, ADMSK<5:2>, mask the corresponding address bits in the SSPxADD register. In addition, ADMSK1 simultaneously masks the two LSbs of the address (SSPxADD<1:0>). For any ADMSK bits that are active (ADMSK<n> = 1), the corresponding address bit is ignored (SPxADD<n> = x). Also note, that although in 10-Bit Address Masking mode, the upper address bits reuse part of the SSPxADD register bits. The address mask bits do not interact with those bits; they only affect the lower address bits.

Note 1: ADMSK1 masks the two Least Significant bits of the address.

 The two Most Significant bits of the address are not affected by address masking.

EXAMPLE 21-2: ADDRESS MASKING EXAMPLES IN 5-BIT MASKING MODE

7-Bit Addressing:

SSPxADD<7:1>= A0h (1010000) (SSPxADD<0> is assumed to be '0')

```
ADMSK<5:1> = 00111
```

Addresses Acknowledged: A0h, A2h, A4h, A6h, A8h, AAh, ACh, AEh

10-Bit Addressing:

SSPxADD<7:0> = A0h (10100000) (The two MSb of the address are ignored in this example, since they are not affected by masking)

ADMSK<5:1> = 00111

Addresses Acknowledged: A0h, A1h, A2h, A3h, A4h, A5h, A6h, A7h, A8h, A9h, AAh, ABh, ACh, ADh, AEh, AFh

查询PIC18F67K90供应商

21.4.3.4 7-Bit Address Masking Mode

Unlike 5-bit masking, 7-Bit Address Masking mode uses a mask of up to 8 bits (in 10-bit addressing) to define a range of addresses that can be Acknowledged, using the lowest bits of the incoming address. This allows the module to Acknowledge up to 127 different addresses with 7-bit addressing, or 255 with 10-bit addressing (see Example 21-3). This mode is the default configuration of the module and is selected when MSSPMSK is unprogrammed ('1').

The address mask for 7-Bit Address Masking mode is stored in the SSPxMSK register, instead of the SSPxCON2 register. SSPxMSK is a separate hardware register within the module, but it is not directly addressable. Instead, it shares an address in the SFR space with the SSPxADD register. To access the SSPxMSK register, it is necessary to select MSSP mode, '1001' (SSPxCON1<3:0> = 1001) and then read or write to the location of SSPxADD.

To use 7-Bit Address Masking mode, it is necessary to initialize SSPxMSK with a value before selecting the I^2C Slave Addressing mode. Thus, the required sequence of events is:

- 1. Select SSPxMSK Access mode (SSPxCON2<3:0> = 1001).
- Write the mask value to the appropriate SSPxADD register address (FC8h for MSSP1, F6Eh for MSSP2).
- 3. Set the appropriate I²C Slave mode (SSPxCON2<3:0> = 0111 for 10-bit addressing, 0110 for 7-bit addressing).

Setting or clearing mask bits in SSPxMSK behaves in the opposite manner of the ADMSK bits in 5-Bit Address Masking mode. That is, clearing a bit in SSPxMSK causes the corresponding address bit to be masked; setting the bit requires a match in that position. SSPxMSK resets to all '1's upon any Reset condition and, therefore, has no effect on the standard MSSP operation until written with a mask value.

With 7-bit addressing, SSPxMSK<7:1> bits mask the corresponding address bits in the SSPxADD register. For any SSPxMSK bits that are active (SSPxMSK<n> = 0), the corresponding SSPxADD address bit is ignored (SSPxADD<n> = x). For the module to issue an address Acknowledge, it is sufficient to match only on addresses that do not have an active address mask.

With 10-bit addressing, SSPxMSK<7:0> bits mask the corresponding address bits in the SSPxADD register. For any SSPxMSK bits that are active (= 0), the corresponding SSPxADD address bit is ignored (SSPxADD

Note: The two Most Significant bits of the address are not affected by address masking.

EXAMPLE 21-3: ADDRESS MASKING EXAMPLES IN 7-BIT MASKING MODE

7-Bit Addressing:

SSPxADD<7:1> = 1010 000

SSPxMSK<7:1> = 1111 001

Addresses Acknowledged = ACh, A8h, A4h, A0h

10-Bit Addressing:

SSPxADD<7:0> = 1010 0000

SSPxMSK<7:0> = 1111 0011

Addresses Acknowledged = ACh, A8h, A4h, A0h

查询PIC18F67K90供应商 21.4.3.5 Reception

When the R/\overline{W} bit of the address byte is clear and an address match occurs, the R/\overline{W} bit of the SSPxSTAT register is cleared. The received address is loaded into the SSPxBUF register and the SDAx line is held low (ACK).

When the address byte overflow condition exists, then the no Acknowledge (ACK) pulse is given. An overflow condition is defined as either bit, BF (SSPxSTAT<0>), is set or bit, SSPOV (SSPxCON1<6>), is set.

An MSSP interrupt is generated for each data transfer byte. The interrupt flag bit, SSPxIF, must be cleared in software. The SSPxSTAT register is used to determine the status of the byte.

If SEN is enabled (SSPxCON2<0> = 1), SCLx will be held low (clock stretch) following each data transfer. The clock must be released by setting bit, CKP (SSPxCON1<4>). See **Section 21.4.4** "**Clock Stretching**" for more details.

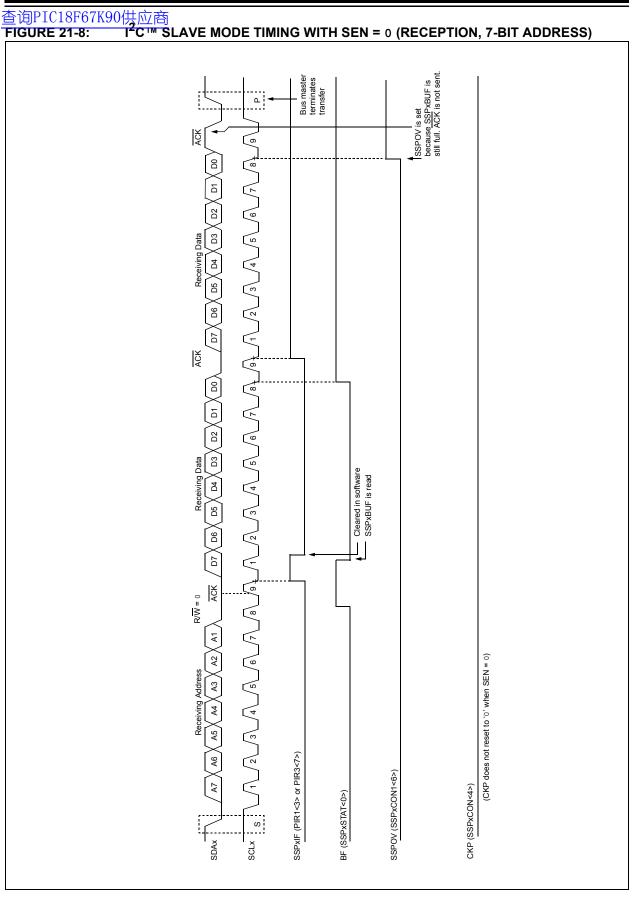
21.4.3.6 Transmission

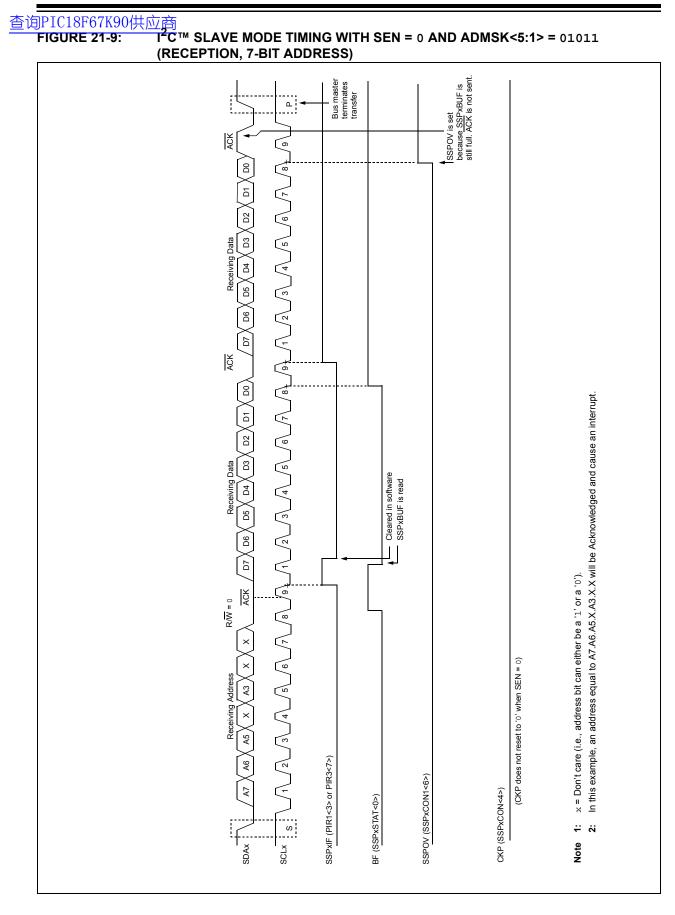
When the R/W bit of the incoming address byte is set and an address match occurs, the R/\overline{W} bit of the SSPxSTAT register is set. The received address is loaded into the SSPxBUF register. The ACK pulse will be sent on the ninth bit and pin, SCLx, is held low regardless of SEN (see Section 21.4.4 "Clock Stretching" for more details). By stretching the clock, the master will be unable to assert another clock pulse until the slave is done preparing the transmit data. The transmit data must be loaded into the SSPxBUF register which also loads the SSPxSR register. Then, pin, SCLx, should be enabled by setting bit, CKP (SSPxCON1<4>). The eight data bits are shifted out on the falling edge of the SCLx input. This ensures that the SDAx signal is valid during the SCLx high time (Figure 21-10).

The \overline{ACK} pulse from the master-receiver is latched on the rising edge of the ninth SCLx input pulse. If the SDAx line is high (not \overline{ACK}), then the data transfer is complete. In this case, when the \overline{ACK} is latched by the slave, the slave logic is reset and the slave monitors for another occurrence of the Start bit. If the SDAx line was low (\overline{ACK}), the next transmit data must be loaded into the SSPxBUF register. Again, pin, SCLx, must be enabled by setting bit, CKP.

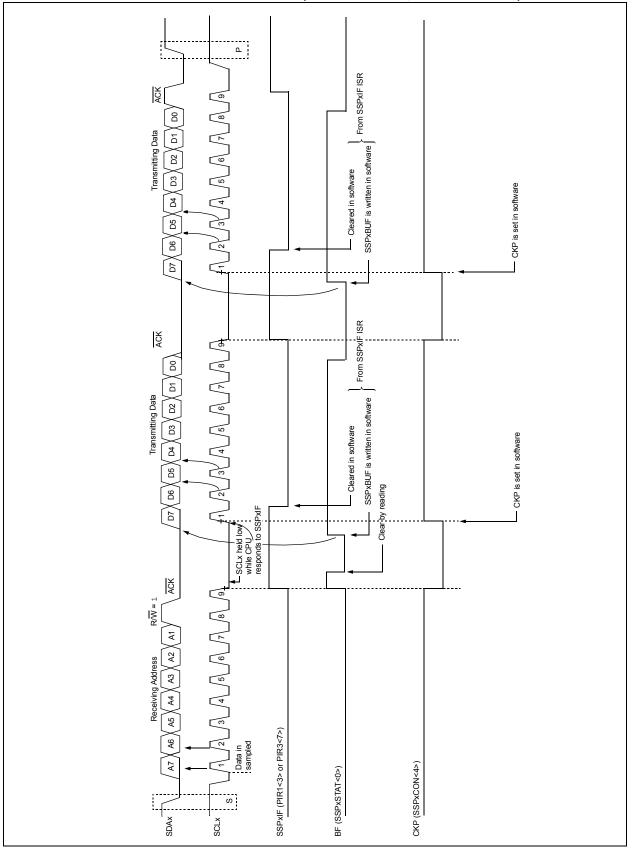
An MSSP interrupt is generated for each data transfer byte. The SSPxIF bit must be cleared in software and the SSPxSTAT register is used to determine the status of the byte. The SSPxIF bit is set on the falling edge of the ninth clock pulse.

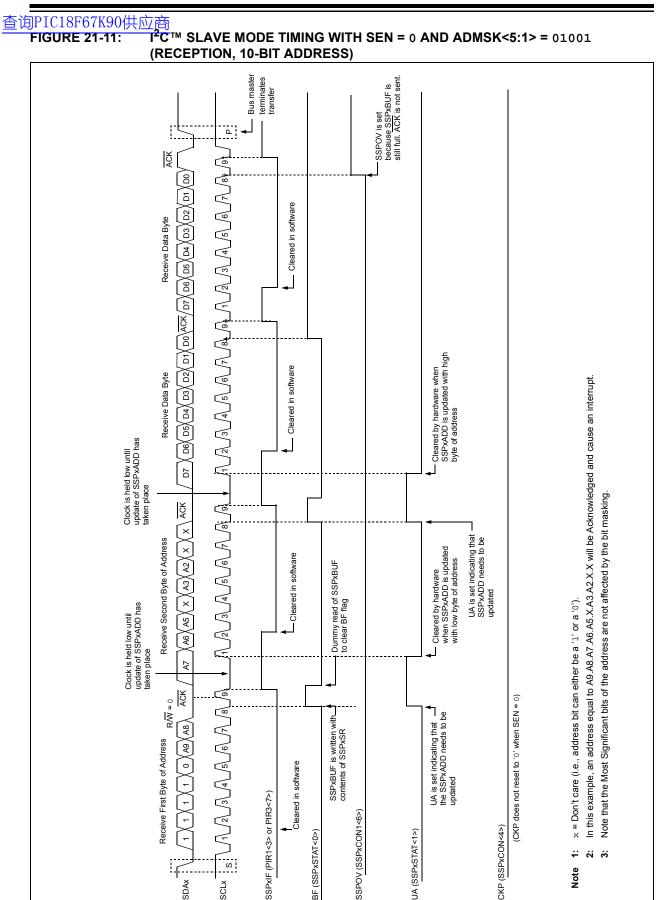






查询PIC18F67K90供应商 FIGURE 21-10: I²C™ SLAVE MODE TIMING (TRANSMISSION, 7-BIT ADDRESS)





© 2010 Microchip Technology Inc.

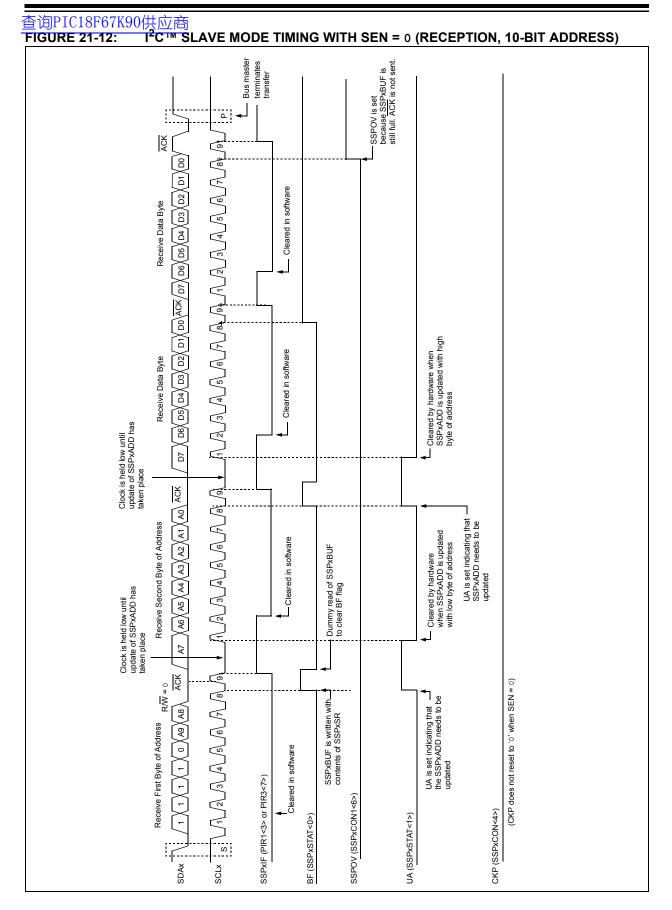
١ ۲

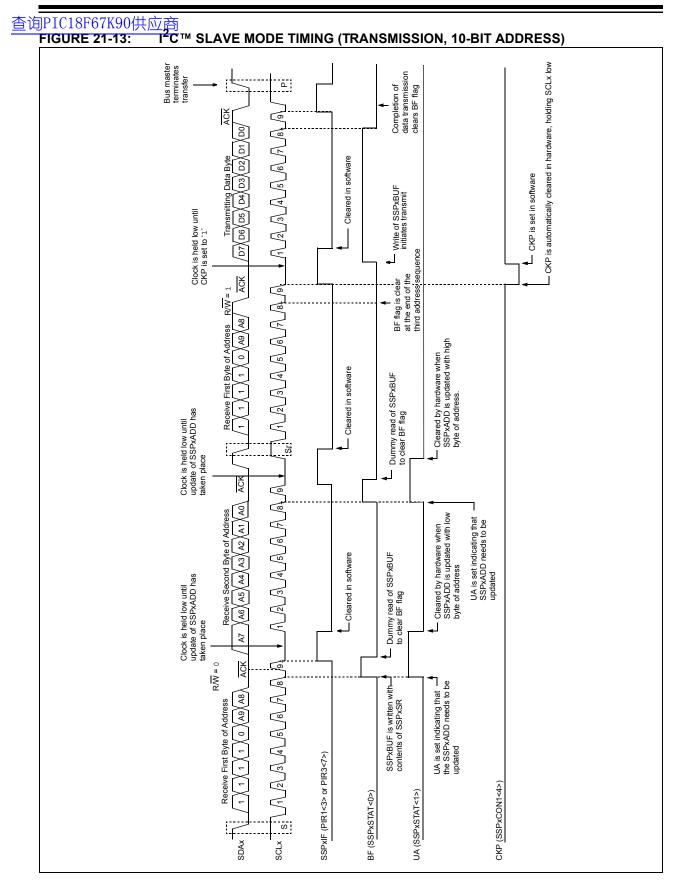
SDAX

SCLX

÷ äй

Note





查询PIC18F67K90供应商 21.4.4 CLOCK STRETCHING

Both 7-Bit and 10-Bit Slave modes implement automatic clock stretching during a transmit sequence.

The SEN bit (SSPxCON2<0>) allows clock stretching to be enabled during receives. Setting SEN will cause the SCLx pin to be held low at the end of each data receive sequence.

21.4.4.1 Clock Stretching for 7-Bit Slave Receive Mode (SEN = 1)

In 7-Bit Slave Receive mode, on the falling edge of the ninth clock at the end of the ACK sequence, if the BF bit is set, the CKP bit in the SSPxCON1 register is automatically cleared, forcing the SCLx output to be held low. The CKP bit being cleared to '0' will assert the SCLx line low. The CKP bit must be set in the user's ISR before reception is allowed to continue. By holding the SCLx line low, the user has time to service the ISR and read the contents of the SSPxBUF before the master device can initiate another receive sequence. This will prevent buffer overruns from occurring (see Figure 21-15).

- Note 1: If the user reads the contents of the SSPxBUF before the falling edge of the ninth clock, thus clearing the BF bit, the CKP bit will not be cleared and clock stretching will not occur.
 - 2: The CKP bit can be set in software regardless of the state of the BF bit. The user should be careful to clear the BF bit in the ISR before the next receive sequence in order to prevent an overflow condition.

21.4.4.2 Clock Stretching for 10-Bit Slave Receive Mode (SEN = 1)

In 10-Bit Slave Receive mode, during the address sequence, clock stretching automatically takes place but CKP is not cleared. During this time, if the UA bit is set after the ninth clock, clock stretching is initiated. The UA bit is set after receiving the upper byte of the 10-bit address and following the receive of the second byte of the 10-bit address with the R/W bit cleared to '0'. The release of the clock line occurs upon updating SSPxADD. Clock stretching will occur on each data receive sequence as described in 7-bit mode.

Note: If the user polls the UA bit and clears it by updating the SSPxADD register before the falling edge of the ninth clock occurs, and if the user hasn't cleared the BF bit by reading the SSPxBUF register before that time, then the CKP bit will still NOT be asserted low. Clock stretching on the basis of the state of the BF bit only occurs during a data sequence, not an address sequence.

21.4.4.3 Clock Stretching for 7-Bit Slave Transmit Mode

The 7-Bit Slave Transmit mode implements clock stretching by clearing the CKP bit after the falling edge of the ninth clock if the BF bit is clear. This occurs regardless of the state of the SEN bit.

The user's ISR must set the CKP bit before transmission is allowed to continue. By holding the SCLx line low, the user has time to service the ISR and load the contents of the SSPxBUF before the master device can initiate another transmit sequence (see Figure 21-10).

- Note 1: If the user loads the contents of SSPxBUF, setting the BF bit before the falling edge of the ninth clock, the CKP bit will not be cleared and clock stretching will not occur.
 - 2: The CKP bit can be set in software regardless of the state of the BF bit.

21.4.4.4 Clock Stretching for 10-Bit Slave Transmit Mode

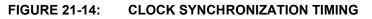
In 10-Bit Slave Transmit mode, clock stretching is controlled during the first two address sequences by the state of the UA bit, just as it is in 10-Bit Slave Receive mode. The first two addresses are followed by a third address sequence, which contains the high-order bits of the 10-bit address and the R/W bit set to '1'. After the third address sequence is performed, the UA bit is not set, the module is now configured in Transmit mode and clock stretching is controlled by the BF flag as in 7-Bit Slave Transmit mode (see Figure 21-13).

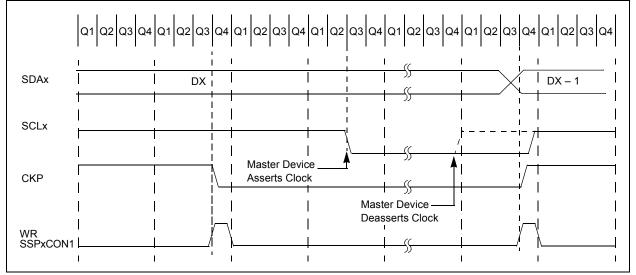
查询PIC18F67K90供应商

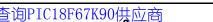
21.4.4.5 Clock Synchronization and the CKP bit

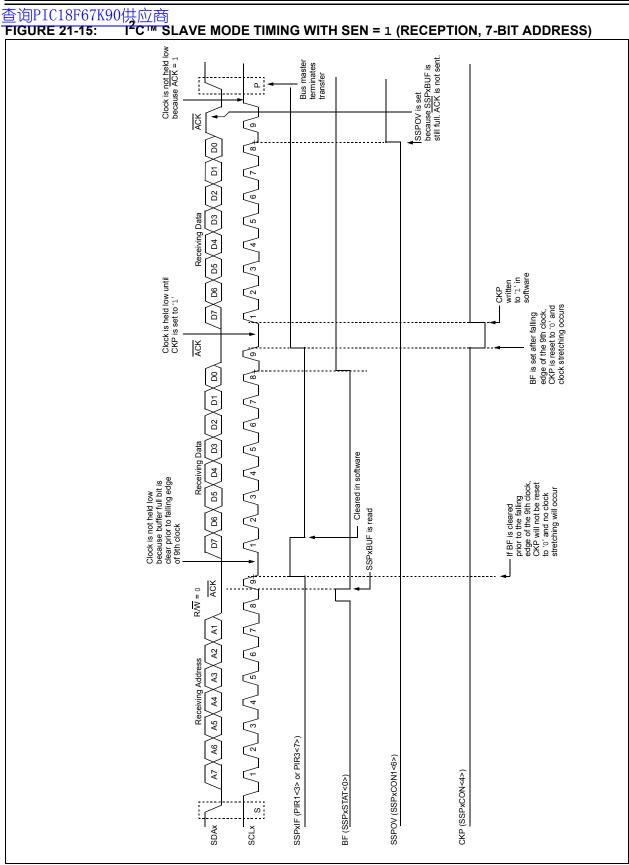
When the CKP bit is cleared, the SCLx output is forced to '0'. However, clearing the CKP bit will not assert the SCLx output low until the SCLx output is already sampled low. Therefore, the CKP bit will not assert the SCLx line until an external I^2C master device has

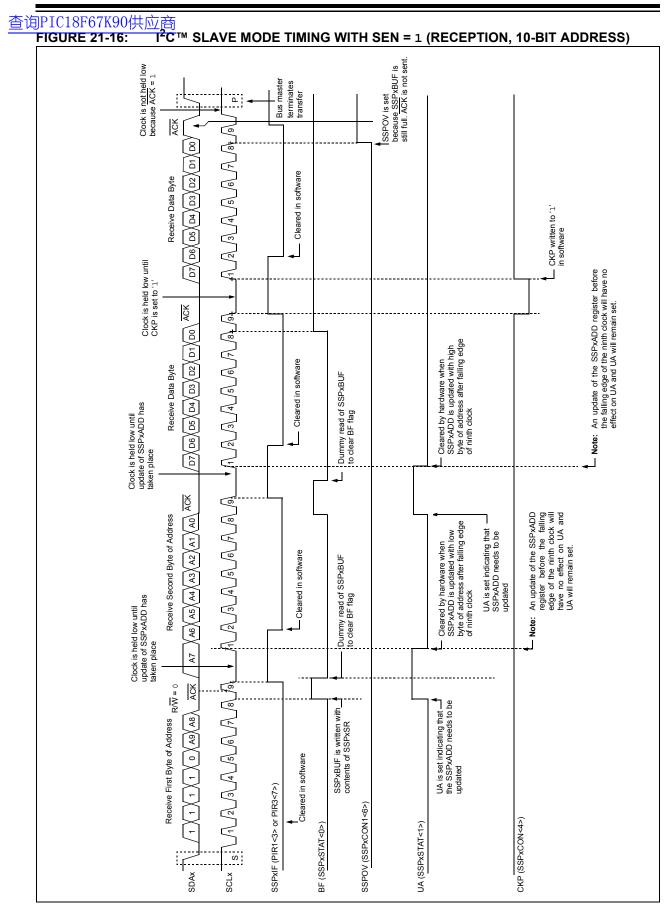
already asserted the SCLx line. The SCLx output will remain low until the CKP bit is set and all other devices on the I^2C bus have deasserted SCLx. This ensures that a write to the CKP bit will not violate the minimum high time requirement for SCLx (see Figure 21-14).











查询PIC18F67K90供应商

21.4.5 GENERAL CALL ADDRESS SUPPORT

The addressing procedure for the I^2C bus is such that the first byte after the Start condition usually determines which device will be the slave addressed by the master. The exception is the general call address which can address all devices. When this address is used, all devices should, in theory, respond with an Acknowledge.

The general call address is one of eight addresses reserved for specific purposes by the I^2C protocol. It consists of all '0's with R/W = 0.

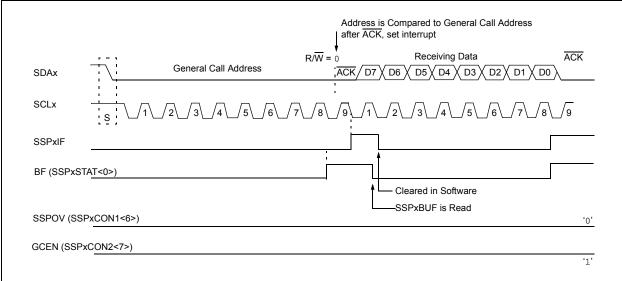
The general call address is recognized when the General Call Enable bit, GCEN, is enabled (SSPxCON2<7> set). Following a Start bit detect, 8 bits are shifted into the SSPxSR and the address is compared against the SSPxADD. It is also compared to the general call address and fixed in hardware.

If the general call address matches, the SSPxSR is transferred to the SSPxBUF, the BF flag bit is set (eighth bit), and on the falling edge of the ninth bit (ACK bit), the SSPxIF interrupt flag bit is set.

When the interrupt is serviced, the source for the interrupt can be checked by reading the contents of the SSPxBUF. The value can be used to determine if the address was device-specific or a general call address.

In 10-Bit Addressing mode, the SSPxADD is required to be updated for the second half of the address to match and the UA bit is set (SSPxSTAT<1>). If the general call address is sampled when the GCEN bit is set, while the slave is configured in 10-Bit Addressing mode, then the second half of the address is not necessary, the UA bit will not be set and the slave will begin receiving data after the Acknowledge (Figure 21-17).





查询PIC18F67K90供应商 21.4.6 MASTER MODE

Master mode is enabled by setting and clearing the appropriate SSPM bits in SSPxCON1 and by setting the SSPEN bit. In Master mode, the SCLx and SDAx lines are manipulated by the MSSP hardware if the TRIS bits are set.

Master mode of operation is supported by interrupt generation on the detection of the Start and Stop conditions. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the I^2C bus may be taken when the P bit is set, or the bus is Idle, with both the S and P bits clear.

In Firmware Controlled Master mode, user code conducts all I^2C bus operations based on Start and Stop bit conditions.

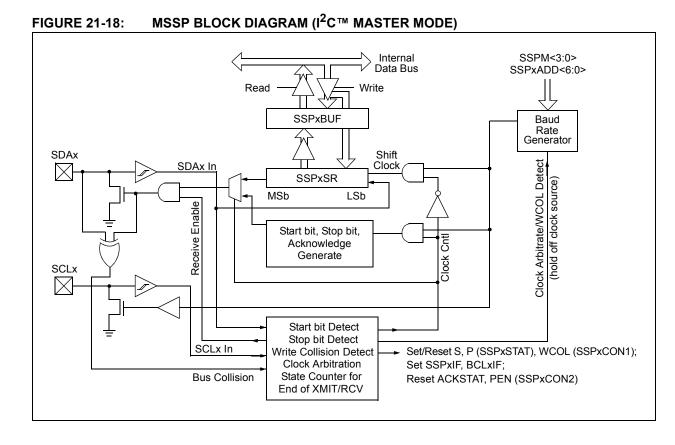
Once Master mode is enabled, the user has six options.

- 1. Assert a Start condition on SDAx and SCLx.
- 2. Assert a Repeated Start condition on SDAx and SCLx.
- 3. Write to the SSPxBUF register initiating transmission of data/address.
- 4. Configure the I^2C port to receive data.
- 5. Generate an Acknowledge condition at the end of a received byte of data.
- 6. Generate a Stop condition on SDAx and SCLx.

Note: The MSSPx module, when configured in I²C Master mode, does not allow queueing of events. For instance, the user is not allowed to initiate a Start condition and immediately write the SSPxBUF register to initiate transmission before the Start condition is complete. In this case, the SSPxBUF will not be written to and the WCOL bit will be set, indicating that a write to the SSPxBUF did not occur.

The following events will cause the MSSPx Interrupt Flag bit, SSPxIF, to be set (and MSSP interrupt, if enabled):

- Start condition
- · Stop condition
- Data transfer byte transmitted/received
- Acknowledge transmitted
- Repeated Start



© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商

21.4.6.1 I²C Master Mode Operation

The master device generates all of the serial clock pulses and the Start and Stop conditions. A transfer is ended with a Stop condition or with a Repeated Start condition. Since the Repeated Start condition is also the beginning of the next serial transfer, the I²C bus will not be released.

In Master Transmitter mode, serial data is output through SDAx while SCLx outputs the serial clock. The first byte transmitted contains the slave address of the receiving device (7 bits) and the Read/Write (R/W) bit. In this case, the R/W bit will be logic '0'. Serial data is transmitted 8 bits at a time. After each byte is transmitted, an Acknowledge bit is received. Start and Stop conditions are output to indicate the beginning and the end of a serial transfer.

In Master Receive mode, the first byte transmitted contains the slave address of the transmitting device (7 bits) and the R/W bit. In this case, the R/W bit will be logic '1'. Thus, the first byte transmitted is a 7-bit slave address, followed by a '1' to indicate the receive bit. Serial data is received via SDAx, while SCLx outputs the serial clock. Serial data is received 8 bits at a time. After each byte is received, an Acknowledge bit is transmitted. Start and Stop conditions indicate the beginning and end of transmission.

The Baud Rate Generator, used for the SPI mode operation, is used to set the SCLx clock frequency for either 100 kHz, 400 kHz or 1 MHz I²C operation. See **Section 21.4.7 "Baud Rate"** for more details.

A typical transmit sequence would go as follows:

- 1. The user generates a Start condition by setting the Start Enable bit, SEN (SSPxCON2<0>).
- SSPxIF is set. The MSSPx module will wait the required start time before any other operation takes place.
- 3. The user loads the SSPxBUF with the slave address to transmit.
- 4. Address is shifted out the SDAx pin until all 8 bits are transmitted.
- The MSSPx module shifts in the ACK bit from the slave device and writes its value into the SSPxCON2 register (SSPxCON2<6>).
- The MSSPx module generates an interrupt at the end of the ninth clock cycle by setting the SSPxIF bit.
- 7. The user loads the SSPxBUF with eight bits of data.
- 8. Data is shifted out the SDAx pin until all 8 bits are transmitted.
- The MSSPx module shifts in the ACK bit from the slave device and writes its value into the SSPxCON2 register (SSPxCON2<6>).
- 10. The MSSPx module generates an interrupt at the end of the ninth clock cycle by setting the SSPxIF bit.
- 11. The user generates a Stop condition by setting the Stop Enable bit, PEN (SSPxCON2<2>).
- 12. Interrupt is generated once the Stop condition is complete.

查询PIC18F67K90供应商 21.4.7 BAUD RATE

In I²C Master mode, the Baud Rate Generator (BRG) reload value is placed in the lower 7 bits of the SSPxADD register (Figure 21-19). When a write occurs to SSPxBUF, the Baud Rate Generator will automatically begin counting. The BRG counts down to 0 and stops until another reload has taken place. The BRG count is decremented twice per instruction cycle (TcY) on the Q2 and Q4 clocks. In I²C Master mode, the BRG is reloaded automatically.

Once the given operation is complete (i.e., transmission of the last data bit is followed by ACK), the internal clock will automatically stop counting and the SCLx pin will remain in its last state.

Table 21-3 demonstrates clock rates based on instruction cycles and the BRG value loaded into SSPxADD. The SSPxADD BRG value of $0 \ge 00$ is not supported.

21.4.7.1 Baud Rate and Module Interdependence

Because MSSP1 and MSSP2 are independent, they can operate simultaneously in I²C Master mode at different baud rates. This is done by using different BRG reload values for each module.

Because this mode derives its basic clock source from the system clock, any changes to the clock will affect both modules in the same proportion. It may be possible to change one or both baud rates back to a previous value by changing the BRG reload value.

FIGURE 21-19: BAUD RATE GENERATOR BLOCK DIAGRAM

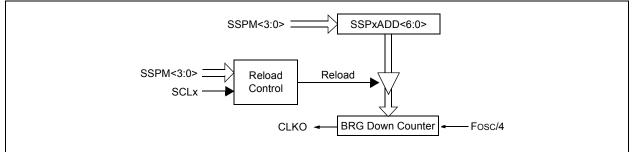


TABLE 21-3: I²C[™] CLOCK RATE w/BRG

Fosc	Fcy	Fcy * 2	BRG Value	FscL (2 Rollovers of BRG)
40 MHz	10 MHz	20 MHz	18h	400 kHz ⁽¹⁾
40 MHz	10 MHz	20 MHz	1Fh	312.5 kHz
40 MHz	10 MHz	20 MHz	63h	100 kHz
16 MHz	4 MHz	8 MHz	09h	400 kHz ⁽¹⁾
16 MHz	4 MHz	8 MHz	0Ch	308 kHz
16 MHz	4 MHz	8 MHz	27h	100 kHz
4 MHz	1 MHz	2 MHz	02h	333 kHz ⁽¹⁾
4 MHz	1 MHz	2 MHz	09h	100 kHz
16 MHz ⁽²⁾	4 MHz	8 MHz	03h	1 MHz ⁽¹⁾

Note 1: The I²C[™] interface does not conform to the 400 kHz I²C specification (which applies to rates greater than 100 kHz) in all details, but may be used with care where higher rates are required by the application.

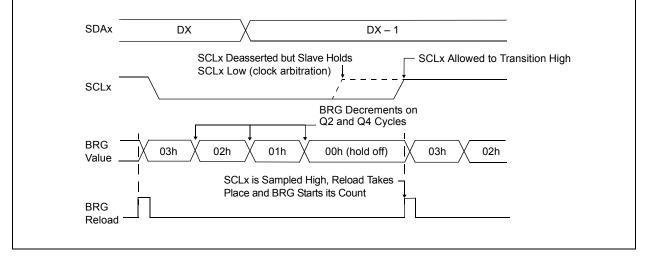
2: A minimum of 16 MHz Fosc is required to get the 1 MHz I²C.

查询PIC18F67K90供应商 21.4.7.2 Clock Arbitration

Clock arbitration occurs when the master, during any receive, transmit or Repeated Start/Stop condition, deasserts the SCLx pin (SCLx allowed to float high). When the SCLx pin is allowed to float high, the Baud Rate Generator (BRG) is suspended from counting until the SCLx pin is actually sampled high. When the

SCLx pin is sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and begins counting. This ensures that the SCLx high time will always be at least one BRG rollover count in the event that the clock is held low by an external device (Figure 21-20).





查询PIC18F67K90供应商 21.4.8 ℃™ MASTER MODE START CONDITION TIMING

To initiate a Start condition, the user sets the Start Enable bit, SEN (SSPxCON2<0>). If the SDAx and SCLx pins are sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and starts its count. If SCLx and SDAx are both sampled high when the Baud Rate Generator times out (TBRG), the SDAx pin is driven low. The action of the SDAx being driven low while SCLx is high is the Start condition and causes the S bit (SSPxSTAT<3>) to be set. Following this, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and resumes its count. When the Baud Rate Generator times out (TBRG), the SEN bit (SSPxCON2<0>) will be automatically cleared by hardware. The Baud Rate Generator is suspended, leaving the SDAx line held low and the Start condition is complete.

Note: If, at the beginning of the Start condition, the SDAx and SCLx pins are already sampled low or if during the Start condition, the SCLx line is sampled low before the SDAx line is driven low, a bus collision occurs, the Bus Collision Interrupt Flag, BCLxIF, is set, the Start condition is aborted and the I²C module is reset into its Idle state.

21.4.8.1 WCOL Status Flag

If the user writes the SSPxBUF when a Start sequence is in progress, the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing to the lower 5 bits of SSPxCON2 is disabled until the Start condition is complete.

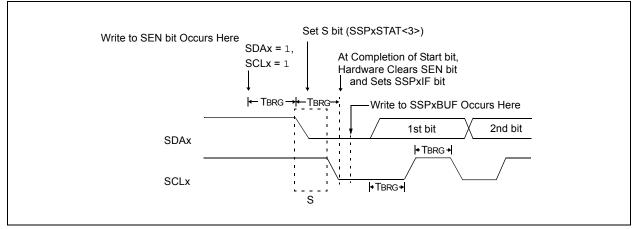


FIGURE 21-21: FIRST START BIT TIMING

查询PIC18F67K90供应商

21.4.9 I²C[™] MASTER MODE REPEATED START CONDITION TIMING

A Repeated Start condition occurs when the RSEN bit (SSPxCON2<1>) is programmed high and the I²C logic module is in the Idle state. When the RSEN bit is set, the SCLx pin is asserted low. When the SCLx pin is sampled low, the Baud Rate Generator is loaded with the contents of SSPxADD<5:0> and begins counting. The SDAx pin is released (brought high) for one Baud Rate Generator count (TBRG). When the Baud Rate Generator times out, and if SDAx is sampled high, the SCLx pin will be deasserted (brought high). When SCLx is sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and begins counting. SDAx and SCLx must be sampled high for one TBRG. This action is then followed by assertion of the SDAx pin (SDAx = 0) for one TBRG while SCLx is high. Following this, the RSEN bit (SSPxCON2<1>) will be automatically cleared and the Baud Rate Generator will not be reloaded, leaving the SDAx pin held low. As soon as a Start condition is detected on the SDAx and SCLx pins, the S bit (SSPxSTAT<3>) will be set. The SSPxIF bit will not be set until the Baud Rate Generator has timed out.

- **Note 1:** If RSEN is programmed while any other event is in progress, it will not take effect.
 - **2:** A bus collision during the Repeated Start condition occurs if:
 - SDAx is sampled low when SCLx goes from low-to-high.
 - SCLx goes low before SDAx is asserted low. This may indicate that another master is attempting to transmit a data '1'.

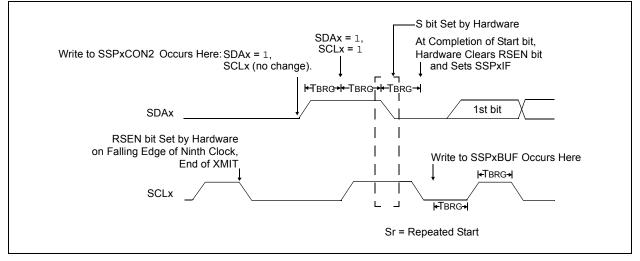
Immediately following the SSPxIF bit getting set, the user may write the SSPxBUF with the 7-bit address in 7-bit mode or the default first address in 10-bit mode. After the first eight bits are transmitted and an ACK is received, the user may then transmit an additional eight bits of address (10-bit mode) or eight bits of data (7-bit mode).

21.4.9.1 WCOL Status Flag

If the user writes the SSPxBUF when a Repeated Start sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing of the lower 5 bits of SSPxCON2 is disabled until the Repeated Start condition is complete.

FIGURE 21-22: REPEATED START CONDITION WAVEFORM



查询PIC18F67K90供应商 21.4.10 I²C™ MASTER MODE TRANSMISSION

Transmission of a data byte, a 7-bit address or the other half of a 10-bit address, is accomplished by simply writing a value to the SSPxBUF register. This action will set the Buffer Full flag bit, BF, and allow the Baud Rate Generator to begin counting and start the next transmission. Each bit of address/data will be shifted out onto the SDAx pin after the falling edge of SCLx is asserted (see data hold time specification parameter 106). SCLx is held low for one Baud Rate Generator rollover count (TBRG). Data should be valid before SCLx is released high (see data setup time specification parameter 107). When the SCLx pin is released high, it is held that way for TBRG. The data on the SDAx pin must remain stable for that duration and some hold time after the next falling edge of SCLx. After the eighth bit is shifted out (the falling edge of the eighth clock), the BF flag is cleared and the master releases SDAx. This allows the slave device being addressed to respond with an ACK bit during the ninth bit time if an address match occurred, or if data was received properly. The status of ACK is written into the ACKDT bit on the falling edge of the ninth clock. If the master receives an Acknowledge, the Acknowledge Status bit, ACKSTAT, is cleared; if not, the bit is set. After the ninth clock, the SSPxIF bit is set and the master clock (Baud Rate Generator) is suspended until the next data byte is loaded into the SSPxBUF, leaving SCLx low and SDAx unchanged (Figure 21-23).

After the write to the SSPxBUF, each bit of the address will be shifted out on the falling edge of SCLx until all seven address bits and the R/W bit are completed. On the falling edge of the eighth clock, the master will deassert the SDAx pin, allowing the slave to respond with an Acknowledge. On the falling edge of the ninth clock, the master will sample the SDAx pin to see if the address was recognized by a slave. The status of the ACK bit is loaded into the ACKSTAT status bit (SSPxCON2<6>). Following the falling edge of the ninth clock transmission of the address, the SSPxIF flag is set, the BF flag is cleared and the Baud Rate Generator is turned off until another write to the SSPxBUF takes place, holding SCLx low and allowing SDAx to float.

21.4.10.1 BF Status Flag

In Transmit mode, the BF bit (SSPxSTAT<0>) is set when the CPU writes to SSPxBUF and is cleared when all 8 bits are shifted out.

21.4.10.2 WCOL Status Flag

If the user writes the SSPxBUF when a transmit is already in progress (i.e., SSPxSR is still shifting out a data byte), the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur) after 2 TCY after the SSPxBUF write. If SSPxBUF is rewritten within 2 TCY, the WCOL bit is set and SSPxBUF is updated. This may result in a corrupted transfer.

The user should verify that the WCOL bit is clear after each write to SSPxBUF to ensure the transfer is correct. In all cases, WCOL must be cleared in software.

21.4.10.3 ACKSTAT Status Flag

In Transmit mode, the ACKSTAT bit (SSPxCON2<6>) is cleared when the slave has sent an Acknowledge $(\overline{ACK} = 0)$ and is set when the slave does not Acknowledge $(\overline{ACK} = 1)$. A slave sends an Acknowledge when it has recognized its address (including a general call), or when the slave has properly received its data.

21.4.11 I²C MASTER MODE RECEPTION

Master mode reception is enabled by programming the Receive Enable bit, RCEN (SSPxCON2<3>).

Note: The MSSP module must be in an inactive state before the RCEN bit is set or the RCEN bit will be disregarded.

The Baud Rate Generator begins counting, and on each rollover, the state of the SCLx pin changes (high-to-low/low-to-high) and data is shifted into the SSPxSR. After the falling edge of the eighth clock, the receive enable flag is automatically cleared, the contents of the SSPxSR are loaded into the SSPxBUF, the BF flag bit is set, the SSPxIF flag bit is set and the Baud Rate Generator is suspended from counting, holding SCLx low. The MSSP is now in Idle state awaiting the next command. When the buffer is read by the CPU, the BF flag bit is automatically cleared. The user can then send an Acknowledge bit at the end of reception by setting the Acknowledge Sequence Enable bit, ACKEN (SSPxCON2<4>).

21.4.11.1 BF Status Flag

In receive operation, the BF bit is set when an address or data byte is loaded into SSPxBUF from SSPxSR. It is cleared when the SSPxBUF register is read.

21.4.11.2 SSPOV Status Flag

In receive operation, the SSPOV bit is set when 8 bits are received into the SSPxSR and the BF flag bit is already set from a previous reception.

21.4.11.3 WCOL Status Flag

If the user writes the SSPxBUF when a receive is already in progress (i.e., SSPxSR is still shifting in a data byte), the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).

查询PIC18F67K90供应商 FIGURE 21-23: 1²C™ MASTER MODE WAVEFORM (TRANSMISSION, 7 OR 10-BIT ADDRESS) SSPxCON2 = 1 software ACKSTAT in ٩ Cleared 6 ACK From slave, clear ACKSTAT bit (SSPxCON2<6>) $\sqrt{3}$ $\sqrt{4}$ $\sqrt{5}$ $\sqrt{6}$ $\sqrt{7}$ $\sqrt{8}$ DO Cleared in software service routine from MSSP interrupt Б SSPxBUF is written in software Transmitting Data or Second Half $D3 \times$ D4 ess D5X of 10-bit De 2 1 SCLx held low while CPU \ responds to SSPxIF 17 (~ ACK = 06 R/W = 0 After Start condition, SEN cleared by hardware $\mathsf{SSPxBUF}$ written with 7-bit address and $\mathsf{R}\overline{\mathsf{W}},$ start transmit 8 5 F /5/ /6 A6 🗙 A5 🗙 A4 🗙 A3 🗙 A2 👌 Transmit Address to Slave

Write SSPxCON2<0> (SEN = 1),

Start condition begins SEN = 0 Cleared in software

SSPxBUF written

SEN

PEN

R/V

BF (SSPxSTAT<0>)

4

2 3

 $\overline{}$

SCLX

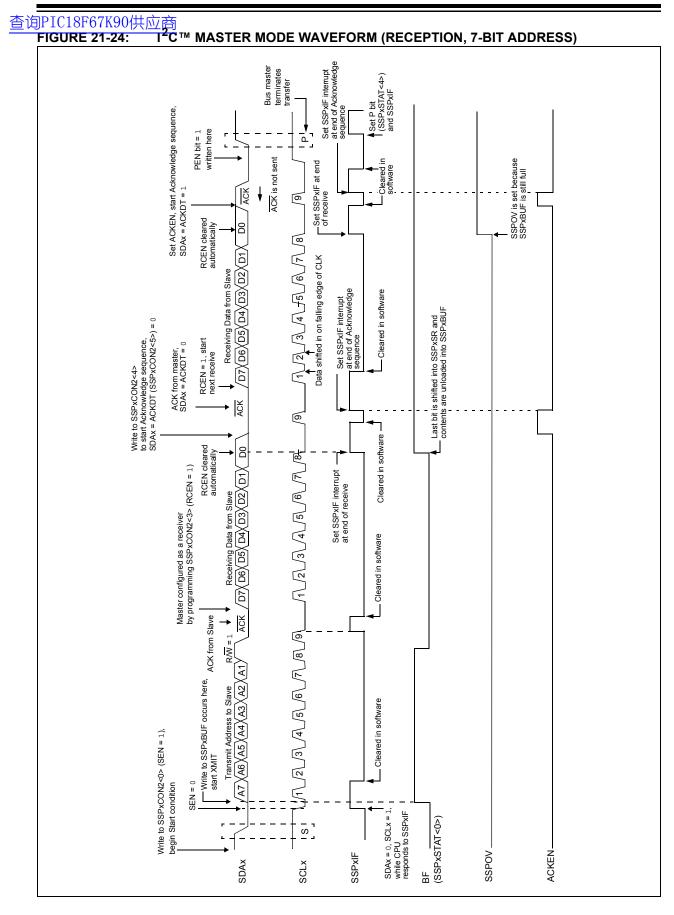
S

SSPxIF

Ā

SDAX

.



查询PIC18F67K90供应商

21.4.12 ACKNOWLEDGE SEQUENCE TIMING

An Acknowledge sequence is enabled by setting the Acknowledge Sequence Enable bit. ACKEN (SSPxCON2<4>). When this bit is set, the SCLx pin is pulled low and the contents of the Acknowledge data bit are presented on the SDAx pin. If the user wishes to generate an Acknowledge, then the ACKDT bit should be cleared. If not, the user should set the ACKDT bit before starting an Acknowledge sequence. The Baud Rate Generator then counts for one rollover period (TBRG) and the SCLx pin is deasserted (pulled high). When the SCLx pin is sampled high (clock arbitration), the Baud Rate Generator counts for TBRG; the SCLx pin is then pulled low. Following this, the ACKEN bit is automatically cleared, the Baud Rate Generator is turned off and the MSSP module then goes into an inactive state (Figure 21-25).

21.4.12.1 WCOL Status Flag

If the user writes the SSPxBUF when an Acknowledge sequence is in progress, then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

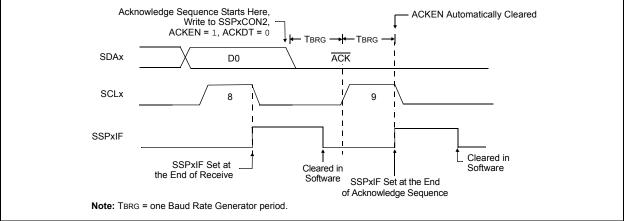
21.4.13 STOP CONDITION TIMING

A Stop bit is asserted on the SDAx pin at the end of a receive/transmit by setting the Stop Sequence Enable bit, PEN (SSPxCON2<2>). At the end of a receive/transmit, the SCLx line is held low after the falling edge of the ninth clock. When the PEN bit is set, the master will assert the SDAx line low. When the SDAx line is sampled low, the Baud Rate Generator is reloaded and counts down to 0. When the Baud Rate Generator times out, the SCLx pin will be brought high and one TBRG (Baud Rate Generator rollover count) later, the SDAx pin will be deasserted. When the SDAx pin is sampled high while SCLx is high, the P bit (SSPxSTAT<4>) is set. A TBRG later, the PEN bit is cleared and the SSPxIF bit is set (Figure 21-26).

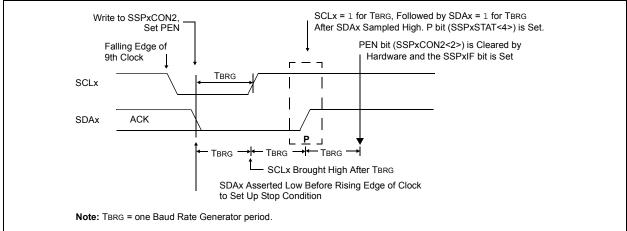
21.4.13.1 WCOL Status Flag

If the user writes the SSPxBUF when a Stop sequence is in progress, then the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).









查询PIC18F67K90供应商 21.4.14 SLEEP OPERATION

While in Sleep mode, the I²C module can receive addresses or data and when an address match or complete byte transfer occurs, wake the processor from Sleep (if the MSSP interrupt is enabled).

21.4.15 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

21.4.16 MULTI-MASTER MODE

In Multi-Master mode, the interrupt generation on the detection of the Start and Stop conditions allows the determination of when the bus is free. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the I^2C bus may be taken when the P bit (SSPxSTAT<4>) is set, or the bus is Idle, with both the S and P bits clear. When the bus is busy, enabling the MSSP interrupt will generate the interrupt when the Stop condition occurs.

In multi-master operation, the SDAx line must be monitored for arbitration to see if the signal level is the expected output level. This check is performed in hardware with the result placed in the BCLxIF bit.

The states where arbitration can be lost are:

- · Address Transfer
- Data Transfer
- A Start Condition
- A Repeated Start Condition
- An Acknowledge Condition

21.4.17 MULTI -MASTER COMMUNICATION, BUS COLLISION AND BUS ARBITRATION

Multi-Master mode support is achieved by bus arbitration. When the master outputs address/data bits onto the SDAx pin, arbitration takes place when the master outputs a '1' on SDAx, by letting SDAx float high, and another master asserts a '0'. When the SCLx pin floats high, data should be stable. If the expected data on SDAx is a '1' and the data sampled on the SDAx pin = 0, then a bus collision has taken place. The master will set the Bus Collision Interrupt Flag, BCLxIF, and reset the l^2C port to its Idle state (Figure 21-27).

If a transmit was in progress when the bus collision occurred, the transmission is halted, the BF flag is cleared, the SDAx and SCLx lines are deasserted and the SSPxBUF can be written to. When the user services the bus collision Interrupt Service Routine and if the I^2C bus is free, the user can resume communication by asserting a Start condition.

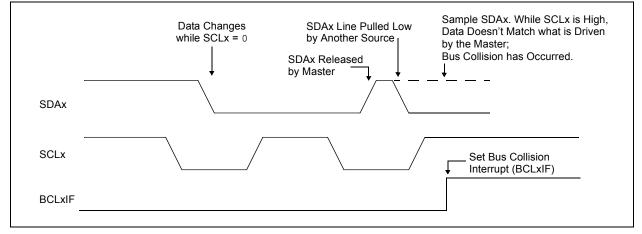
If a Start, Repeated Start, Stop or Acknowledge condition was in progress when the bus collision occurred, the condition is aborted, the SDAx and SCLx lines are deasserted and the respective control bits in the SSPxCON2 register are cleared. When the user services the bus collision Interrupt Service Routine, and if the I²C bus is free, the user can resume communication by asserting a Start condition.

The master will continue to monitor the SDAx and SCLx pins. If a Stop condition occurs, the SSPxIF bit will be set.

A write to the SSPxBUF will start the transmission of data at the first data bit regardless of where the transmitter left off when the bus collision occurred.

In Multi-Master mode, the interrupt generation on the detection of Start and Stop conditions allows the determination of when the bus is free. Control of the I²C bus can be taken when the P bit is set in the SSPxSTAT register, or the bus is Idle and the S and P bits are cleared.

FIGURE 21-27: BUS COLLISION TIMING FOR TRANSMIT AND ACKNOWLEDGE



查询PIC18F67K90供应商

21.4.17.1 Bus Collision During a Start Condition

During a Start condition, a bus collision occurs if:

- a) SDAx or SCLx is sampled low at the beginning of the Start condition (Figure 21-28).
- b) SCLx is sampled low before SDAx is asserted low (Figure 21-29).

During a Start condition, both the SDAx and the SCLx pins are monitored.

If the SDAx pin is already low, or the SCLx pin is already low, then all of the following occur:

- · the Start condition is aborted,
- the BCLxIF flag is set and
- the MSSP module is reset to its inactive state (Figure 21-28)

The Start condition begins with the SDAx and SCLx pins deasserted. When the SDAx pin is sampled high, the Baud Rate Generator is loaded from SSPxADD<6:0> and counts down to 0. If the SCLx pin is sampled low while SDAx is high, a bus collision occurs because it is assumed that another master is attempting to drive a data '1' during the Start condition.

If the SDAx pin is sampled low during this count, the BRG is reset and the SDAx line is asserted early (Figure 21-30). If, however, a '1' is sampled on the SDAx pin, the SDAx pin is asserted low at the end of the BRG count. The Baud Rate Generator is then reloaded and counts down to 0. If the SCLx pin is sampled as '0' during this time, a bus collision does not occur. At the end of the BRG count, the SCLx pin is asserted low.

Note: The reason that bus collision is not a factor during a Start condition is that no two bus masters can assert a Start condition at the exact same time. Therefore, one master will always assert SDAx before the other. This condition does not cause a bus collision because the two masters must be allowed to arbitrate the first address following the Start condition. If the address is the same, arbitration must be allowed to continue into the data portion, Repeated Start or Stop conditions.

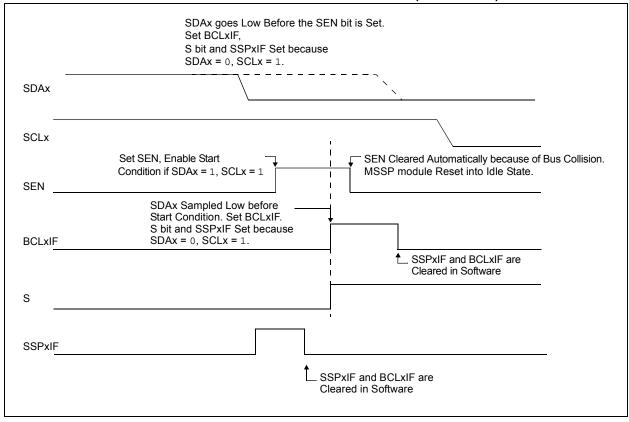


FIGURE 21-28: BUS COLLISION DURING START CONDITION (SDAx ONLY)

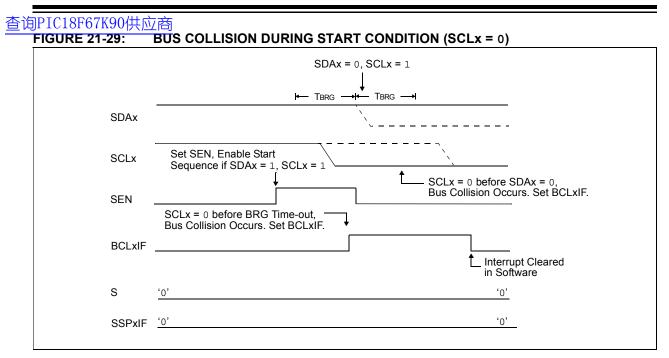
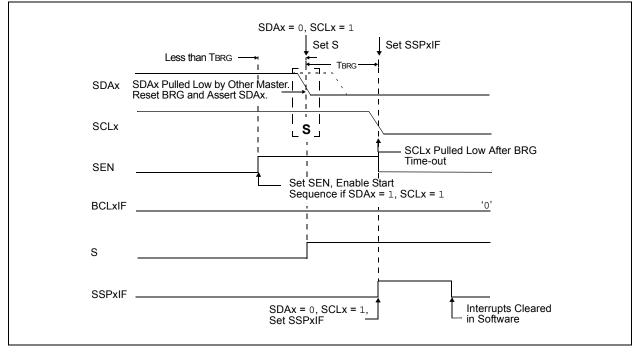


FIGURE 21-30: BRG RESET DUE TO SDAX ARBITRATION DURING START CONDITION



© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商

21.4.17.2 Bus Collision During a Repeated Start Condition

During a Repeated Start condition, a bus collision occurs if:

- a) A low level is sampled on SDAx when SCLx goes from a low level to a high level.
- SCLx goes low before SDAx is asserted low, indicating that another master is attempting to transmit a data '1'.

When the user deasserts SDAx and the pin is allowed to float high, the BRG is loaded with SSPxADD<6:0> and counts down to 0. The SCLx pin is then deasserted and when sampled high, the SDAx pin is sampled.

If SDAx is low, a bus collision has occurred (i.e., another master is attempting to transmit a data '0', Figure 21-31). If SDAx is sampled high, the BRG is reloaded and begins counting. If SDAx goes from high-to-low before the BRG times out, no bus collision occurs because no two masters can assert SDAx at exactly the same time.

If SCLx goes from high-to-low before the BRG times out and SDAx has not already been asserted, a bus collision occurs. In this case, another master is attempting to transmit a data '1' during the Repeated Start condition (see Figure 21-32).

If, at the end of the BRG time-out, both SCLx and SDAx are still high, the SDAx pin is driven low and the BRG is reloaded and begins counting. At the end of the count, regardless of the status of the SCLx pin, the SCLx pin is driven low and the Repeated Start condition is complete.

FIGURE 21-31: BUS COLLISION DURING A REPEATED START CONDITION (CASE 1)

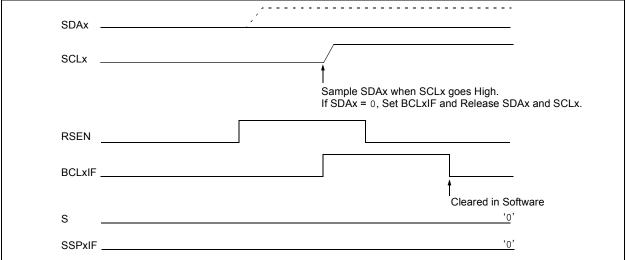
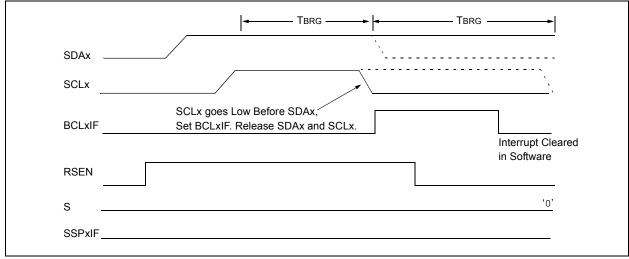


FIGURE 21-32: BUS COLLISION DURING REPEATED START CONDITION (CASE 2)



查询PIC18F67K90供应商

21.4.17.3 Bus Collision During a Stop Condition

Bus collision occurs during a Stop condition if:

- After the SDAx pin has been deasserted and allowed to float high, SDAx is sampled low after the BRG has timed out.
- b) After the SCLx pin is deasserted, SCLx is sampled low before SDAx goes high.

The Stop condition begins with SDAx asserted low. When SDAx is sampled low, the SCLx pin is allowed to float. When the pin is sampled high (clock arbitration), the Baud Rate Generator is loaded with SSPxADD<6:0> and counts down to 0. After the BRG times out, SDAx is sampled. If SDAx is sampled low, a bus collision has occurred. This is due to another master attempting to drive a data '0' (Figure 21-33). If the SCLx pin is sampled low before SDAx is allowed to float high, a bus collision occurs. This is another case of another master attempting to drive a data '0' (Figure 21-34).

FIGURE 21-33: BUS COLLISION DURING A STOP CONDITION (CASE 1)

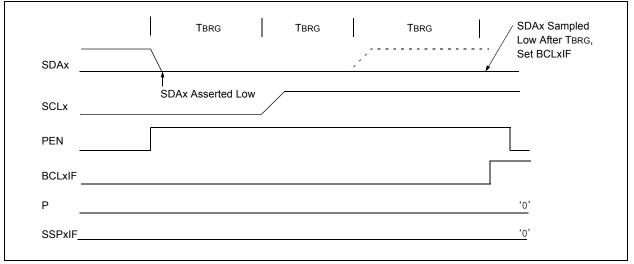
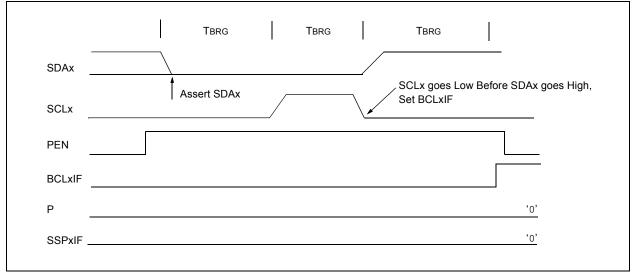


FIGURE 21-34: BUS COLLISION DURING A STOP CONDITION (CASE 2)



查询PIC18F67K90供应商

TABLE 21-4: REGISTERS ASSOCIATED WITH I²C™ OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	—	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1		ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	—	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR2	OSCFIF		SSP2IF	BLC2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF	75
PIE2	OSCFIE	_	SSP2IE	BLC2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	75
IPR2	OSCFIP	_	SSP2IP	BLC2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	76
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	76
SSP1BUF	MSSP1 R	eceive Buffe	r/Transmit R	legister					74
SSP1ADD		ddress Regis aud Rate Re							74
SSP1MSK ⁽¹⁾	MSK7	MSK6	MSK5	MSK4	MSK3	MSK2	MSK1	MSK0	—
SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	74
	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	74
SSP1CON2	GCEN	ACKSTAT	ADMSK5(2)	ADMSK4 ⁽²⁾	ADMSK3(2)	ADMSK2(2)	ADMSK1(2)	SEN	74
SSP1STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	74
SSP2BUF	MSSP2 R	eceive Buffe	r/Transmit R	legister	1				80
SSP2ADD		ddress Regis aud Rate Re			er mode)				80
SSP2MSK ⁽¹⁾	MSK7	MSK6	MSK5	MSK4	MSK3	MSK2	MSK1	MSK0	—
SSP2CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	80
00000000	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	04
SSP2CON2	GCEN	ACKSTAT	ADMSK5(2)	ADMSK4(2)	ADMSK3(2)	ADMSK2(2)	ADMSK1(2)	SEN	81
SSP2STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	80

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the MSSP module in I^2C^{TM} mode.

Note 1: SSPxMSK shares the same address in SFR space as SSPxADD, but is only accessible in certain I²C[™] Slave operating modes in 7-Bit Masking mode. See Section 21.4.3.4 "7-Bit Address Masking Mode" for more details.

2: Alternate bit definitions for use in I²C Slave mode operations only.

查询PIC18F67K90供应商 22.0 ENHANCED UNIVERSAL

SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER (EUSART)

The Enhanced Universal Synchronous Asynchronous Receiver Transmitter (EUSART) module is one of two serial I/O modules. (Generically, the EUSART is also known as a Serial Communications Interface or SCI.) The EUSART can be configured as a full-duplex, asynchronous system that can communicate with peripheral devices, such as CRT terminals and personal computers. It can also be configured as a half-duplex synchronous system that can communicate with peripheral devices, such as A/D or D/A integrated circuits, serial EEPROMs, etc.

The Enhanced USART module implements additional features, including automatic baud rate detection and calibration, automatic wake-up on Sync Break reception and 12-bit Break character transmit. These make it ideally suited for use in Local Interconnect Network bus (LIN/J2602 bus) systems.

All members of the PIC18F87K90 family are equipped with two independent EUSART modules, referred to as EUSART1 and EUSART2. They can be configured in the following modes:

- Asynchronous (full duplex) with:
 - Auto-wake-up on character reception
 - Auto-baud calibration
 - 12-bit Break character transmission
- Synchronous Master (half duplex) with selectable clock polarity
- Synchronous Slave (half duplex) with selectable clock polarity

The pins of EUSART1 and EUSART2 are multiplexed with the functions of PORTC (RC6/TX1/CK1/ SEG27 and RC7/RX1/DT1/SEG28) and PORTG (RG1/TX2/CK2/AN19/C3OUT and RG2/RX2/DT2/ AN18/C3INA), respectively. In order to configure these pins as an EUSART:

- For EUSART1:
 - SPEN (RCSTA1<7>) bit must be set (= 1)
 - TRISC<7> bit must be set (= 1)
 - TRISC<6> bit must be cleared (= 0) for Asynchronous and Synchronous Master modes
 - TRISC<6> bit must be set (= 1) for Synchronous Slave mode
- For EUSART2:
 - SPEN (RCSTA2<7>) bit must be set (= 1)
 - TRISG<2> bit must be set (= 1)
 - TRISG<1> bit must be cleared (= 0) for Asynchronous and Synchronous Master modes
 - TRISC<6> bit must be set (= 1) for Synchronous Slave mode

Note:	The EUSART control will automatically
	reconfigure the pin from input to output as
	needed.

The operation of each Enhanced USART module is controlled through three registers:

- Transmit Status and Control (TXSTAx)
- Receive Status and Control (RCSTAx)
- Baud Rate Control (BAUDCONx)

These are detailed in Register 22-1, Register 22-2 and Register 22-3, respectively, on the following pages.

Note: Throughout this section, references to register and bit names that may be associated with a specific EUSART module are referred to generically by the use of 'x' in place of the specific module number. Thus, "RCSTAx" might refer to the Receive Status register for either EUSART1 or EUSART2.

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-1	R/W-0
CSRC	TX9	TXEN ⁽¹⁾	SYNC	SENDB	BRGH	TRMT	TX9D
bit 7	1		l	-			bit (
Legend:							
R = Readab	le bit	W = Writable	bit	U = Unimplen	nented bit, rea	d as '0'	
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
bit 7	CSRC: Cloc	ck Source Select	bit				
	Asynchrono Don't care.						
		<u>is mode:</u> mode (clock gene iode (clock from e					
bit 6		ransmit Enable b					
		9-bit transmissio 8-bit transmissio					
bit 5		smit Enable bit ⁽¹					
		iit is enabled iit isndisabled					
bit 4	SYNC: EUS	SART Mode Sele	ct bit				
		onous mode ronous mode					
bit 3	SENDB: Se	end Break Charac	cter bit				
		<u>us mode:</u> ync Break on nex eak transmission			rdware upon o	completion)	
	<u>Synchronou</u> Don't care.	<u>is mode:</u>					
bit 2	BRGH: Higl	h Baud Rate Sele	ect bit				
	Asynchrono 1 = High sp 0 = Low spe	eed					
	Synchronou Unused in th	<u>is mode:</u>					
bit 1	TRMT: Tran	smit Shift Regist	er Status bit				
	1 = TSR is e 0 = TSR is f						
bit 0	TX9D: 9th b	oit of Transmit Da	ita				

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R->
SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9
bit 7							
Legend: R = Readab	la hit	$\Lambda = \Lambda $	h it		nanted bit rea	d aa '0'	
-n = Value a		W = Writable	UIL	0 = Onimpien 0' = Bit is clea	nented bit, rea	x = Bit is unkn	
		I - DILIS SEL			areu	X - DILISUIKI	IOWIT
bit 7	SPEN: Seria	I Port Enable bit	t				
		ort is enabled port disabled (h	eld in Reset)				
bit 6	RX9: 9-Bit R	eceive Enable b	oit				
		9-bit reception 8-bit reception					
bit 5	SREN: Singl	e Receive Enab	le bit				
	<u>Asynchronou</u> Don't care.	<u>is mode</u> :					
		<u>s mode – Master</u>	<u>:</u>				
		single receive single receive					
		ared after recep	tion is compl	ete.			
	<u>Synchronous</u> Don't care.	<u>s mode – Slave:</u>					
bit 4	CREN: Cont	inuous Receive	Enable bit				
	Asynchronou 1 = Enables 0 = Disables						
				ole bit, CREN, is	cleared (CRE	N overrides SR	EN)
bit 3		dress Detect En					
Situ		is mode 9-Bit (R					
	1 = Enables	address detecti	on, enables i	nterrupt and load			
			-	are received an	d ninth bit can	be used as pari	ity bit
	Asynchronou Don't care.	IS mode 9-Bit (R	<u>(X9 = 0):</u>				
bit 2	FERR: Fram	ing Error bit					
		error (can be cl	eared by read	ding the RCREG	Gx register and	receiving the n	ext valid
bit 1	OERR: Over	run Error bit					
	1 = Overrun 0 = No over	-	eared by clea	ring bit, CREN)			
		t of Received D					

R/W-0	R-1	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	_	WUE	ABDEN
bit 7		I.	1				bit
Legend:							
R = Readabl	le bit	W = Writable	bit	U = Unimplem	nented bit, read	d as '0'	
-n = Value at	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown
				.			
bit 7		Auto-Baud Acquis			Detectmede		
		rollover has occur e cleared in soft	•	uto-Baud Rate	Detect mode		
	•	G rollover has oc	,				
bit 6	RCIDL: Rec	eive Operation I	dle Status bit				
	1 = Receive	operation is Idle	•				
		operation is acti					
bit 5		ta/Receive Polar	ity Select bit				
	Asynchrono		anted (active				
		data (RXx) is in data (RXx) is no	· ·	,			
	Synchronou		(
	•	Tx) is inverted (a					
	•	Tx) is not inverte					
bit 4	-	nchronous Clock	Polarity Selec	ct bit			
	Asynchrono	<u>us mode:</u> e for transmit (T)	(x) is a low lev	رما			
		e for transmit (T)	,				
	<u>Synchronou</u>						
		e for clock (CKx)	-	I			
h:4 0		e for clock (CKx)		. h. ; t			
bit 3		Bit Baud Rate R aud Rate Genera	-		~		
		ud Rate Generat				RGHx value is	ianored
bit 2		nted: Read as '		, , , , , , , , , ,	,, -		0
bit 1	-	-up Enable bit					
	Asynchrono	=					
		T will continue to			pt generated c	on the falling ed	ge; bit cleare
		ware on the follow					
	<u>Synchronou</u>		a or the fishing	euge delected			
	Unused in th						
bit 0	ABDEN: Au	ito-Baud Detect I	Enable bit				
	<u>Asynchrono</u>						
		baud rate meas		e next characte	er. Requires re	ception of a Sy	nc field (55h
		in hardware upo ate measuremen		completed			
	Synchronou			completed			
	Unused in th						

查询PIC18F67K90供应商 22.1 Baud Rate Generator (BRG)

The BRG is a dedicated, 8-bit or 16-bit generator that supports both the Asynchronous and Synchronous modes of the EUSART. By default, the BRG operates in 8-bit mode; setting the BRG16 bit (BAUDCONx<3>) selects 16-bit mode.

The SPBRGHx:SPBRGx register pair controls the period of a free-running timer. In Asynchronous mode, bits, BRGH (TXSTAx<2>) and BRG16 (BAUDCONx<3>), also control the baud rate. In Synchronous mode, BRGH is ignored. Table 22-1 shows the formula for computation of the baud rate for different EUSART modes which only apply in Master mode (internally generated clock).

Given the desired baud rate and Fosc, the nearest integer value for the SPBRGHx:SPBRGx registers can be calculated using the formulas in Table 22-1. From this, the error in baud rate can be determined. An example calculation is shown in Example 22-1. Typical baud rates and error values for the various Asynchronous modes are shown in Table 22-2. It may be advantageous to use the high baud rate (BRGH = 1) or the 16-bit BRG to reduce the baud rate error, or achieve a slow baud rate for a fast oscillator frequency.

Writing a new value to the SPBRGHx:SPBRGx registers causes the BRG timer to be reset (or cleared). This ensures the BRG does not wait for a timer overflow before outputting the new baud rate. When operated in Synchronous mode, SPBRGH:SPBRG values of 0000h and 0001h are not supported. In the Asynchronous mode, all BRG values may be used.

22.1.1 OPERATION IN POWER-MANAGED MODES

The device clock is used to generate the desired baud rate. When one of the power-managed modes is entered, the new clock source may be operating at a different frequency. This may require an adjustment to the value in the SPBRGx register pair.

22.1.2 SAMPLING

The data on the RXx pin (either RC7/RX1/DT1/SEG28 or RG2/RX2/DT2/AN18/C3INA) is sampled three times by a majority detect circuit to determine if a high or a low level is present at the RXx pin.

C	onfiguration B	its		David Data Commula
SYNC	BRG16	BRGH	BRG/EUSART Mode	Baud Rate Formula
0	0	0	8-Bit/Asynchronous	Fosc/[64 (n + 1)]
0	0	1	8-Bit/Asynchronous	$\Gamma_{000}/[16(n+1)]$
0	1	0	16-Bit/Asynchronous	Fosc/[16 (n + 1)]
0	1	1	16-Bit/Asynchronous	
1	0	x	8-Bit/Synchronous	Fosc/[4 (n + 1)]
1	1	х	16-Bit/Synchronous	

TABLE 22-1: BAUD RATE FORMULAS

Legend: x = Don't care, n = value of SPBRGHx:SPBRGx register pair

查询PIC18F67K90供应商 EXAMPLE 22-1: CALCULATING BAUD RATE ERROR

For a device with Fosc of 16	6 MH	z, desired baud rate of 9600, Asynchronous mode, and 8-bit BRG:
Desired Baud Rate	=	Fosc/(64 ([SPBRGHx:SPBRGx] + 1))
Solving for SPBRGHx:	SPB	RGx:
Х	=	((FOSC/Desired Baud Rate)/64) – 1
	=	((16000000/9600)/64) – 1
	=	[25.042] = 25
Calculated Baud Rate	=	16000000/(64 (25 + 1))
	=	9615
Error	=	(Calculated Baud Rate - Desired Baud Rate)/Desired Baud Rate
	=	(9615 - 9600)/9600 = 0.16%

TABLE 22-2: REGISTERS ASSOCIATED WITH BAUD RATE GENERATOR

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:		
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	75		
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	75		
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	77		
SPBRGH1	EUSART1	SART1 Baud Rate Generator Register High Byte									
SPBRG1	EUSART1	Baud Rate	Generator I	Register Lo	w Byte				75		
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	79		
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	79		
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	79		
SPBRGH2	EUSART2	ART2 Baud Rate Generator Register High Byte									
SPBRG2	EUSART2	Baud Rate	Generator I	Register Lo	w Byte				80		

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the BRG.

查询PIC18F67K90供应商 TABLE 22-3: BAUD RATES FOR ASYNCHRONOUS MODES

IADLL	22-3.	2-3. BAOD NATES FOR ASTRCHNONOUS MODES												
					SYNC	= 0, BRGH	I = 0, BRG	616 = 0						
BAUD	Fosc	Fosc = 40.000 MHz			= 20.000) MHz	Foso	: = 10.000	MHz	Fos	c = 8.000	MHz		
RATE (K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)		
0.3	_			_		_	_	_	_	_	_	_		
1.2	—	_	—	1.221	1.73	255	1.202	0.16	129	1.201	-0.16	103		
2.4	2.441	1.73	255	2.404	0.16	129	2.404	0.16	64	2.403	-0.16	51		
9.6	9.615	0.16	64	9.766	1.73	31	9.766	1.73	15	9.615	-0.16	12		
19.2	19.531	1.73	31	19.531	1.73	15	19.531	1.73	7	_	_	_		
57.6	56.818	-1.36	10	62.500	8.51	4	52.083	-9.58	2	—	_	_		
115.2	125.000	8.51	4	104.167	-9.58	2	78.125	-32.18	1	—	_	_		

			S	YNC = 0, E	BRGH = (, BRG16 =	0				
BAUD RATE	Fos	c = 4.000	MHz	Fos	c = 2.000	MHz	Fos	Fosc = 1.000 MHz			
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)		
0.3	0.300	0.16	207	0.300	-0.16	103	0.300	-0.16	51		
1.2	1.202	0.16	51	1.201	-0.16	25	1.201	-0.16	12		
2.4	2.404	0.16	25	2.403	-0.16	12	—	_	_		
9.6	8.929	-6.99	6	—	_	_	—	_	_		
19.2	20.833	8.51	2	—	_	_	—	_	_		
57.6	62.500	8.51	0	—	_	_	—	_	_		
115.2	62.500	-45.75	0	—	_		—				

					SYNC	= 0, BRGH	i = 1, BRG	i 16 = 0					
BAUD RATE	Fosc	Fosc = 40.000 MHz			Fosc = 20.000 MHz			= 10.000) MHz	Fos	Fosc = 8.000 MHz		
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	
0.3	—	_	_	_	_	_	_	_	_	—	_	_	
1.2	—	—	_	—	—	—	—	—	—	—	—	—	
2.4	—	_	_	—	_	_	2.441	1.73	255	2.403	-0.16	207	
9.6	9.766	1.73	255	9.615	0.16	129	9.615	0.16	64	9.615	-0.16	51	
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19.230	-0.16	25	
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55.555	3.55	8	
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4	_	—	—	

	SYNC = 0, BRGH = 1, BRG16 = 0											
BAUD RATE	Foso	= 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz					
(К)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)			
0.3	_		_		_	_	0.300	-0.16	207			
1.2	1.202	0.16	207	1.201	-0.16	103	1.201	-0.16	51			
2.4	2.404	0.16	103	2.403	-0.16	51	2.403	-0.16	25			
9.6	9.615	0.16	25	9.615	-0.16	12	—	—	—			
19.2	19.231	0.16	12	_	_	_	_	_	_			
57.6	62.500	8.51	3	—	—	—	_	_	—			
115.2	125.000	8.51	1	_	_	—	_	_	_			

© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商

TABLE 22-3: BAUD RATES FOR ASYNCHRONOUS MODES (CONTINUED)

		SYNC = 0, BRGH = 0, BRG16 = 1													
BAUD RATE (K)	Fosc = 40.000 MHz			Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz					
	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)			
0.3	0.300	0.00	8332	0.300	0.02	4165	0.300	0.02	2082	0.300	-0.04	1665			
1.2	1.200	0.02	2082	1.200	-0.03	1041	1.200	-0.03	520	1.201	-0.16	415			
2.4	2.402	0.06	1040	2.399	-0.03	520	2.404	0.16	259	2.403	-0.16	207			
9.6	9.615	0.16	259	9.615	0.16	129	9.615	0.16	64	9.615	-0.16	51			
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19.230	-0.16	25			
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55.555	3.55	8			
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4	—	_	_			

	SYNC = 0, BRGH = 0, BRG16 = 1											
BAUD RATE	Foso	c = 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz					
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)			
0.3	0.300	0.04	832	0.300	-0.16	415	0.300	-0.16	207			
1.2	1.202	0.16	207	1.201	-0.16	103	1.201	-0.16	51			
2.4	2.404	0.16	103	2.403	-0.16	51	2.403	-0.16	25			
9.6	9.615	0.16	25	9.615	-0.16	12	_	_	_			
19.2	19.231	0.16	12	—	_	_	_	_	_			
57.6	62.500	8.51	3	—	_	_	—	_	_			
115.2	125.000	8.51	1	—	_	—	_	_	—			

		SYNC = 0, BRGH = 1, BRG16 = 1 or SYNC = 1, BRG16 = 1													
BAUD RATE (K)	Fosc = 40.000 MHz			Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz					
	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)			
0.3	0.300	0.00	33332	0.300	0.00	16665	0.300	0.00	8332	0.300	-0.01	6665			
1.2	1.200	0.00	8332	1.200	0.02	4165	1.200	0.02	2082	1.200	-0.04	1665			
2.4	2.400	0.02	4165	2.400	0.02	2082	2.402	0.06	1040	2.400	-0.04	832			
9.6	9.606	0.06	1040	9.596	-0.03	520	9.615	0.16	259	9.615	-0.16	207			
19.2	19.193	-0.03	520	19.231	0.16	259	19.231	0.16	129	19.230	-0.16	103			
57.6	57.803	0.35	172	57.471	-0.22	86	58.140	0.94	42	57.142	0.79	34			
115.2	114.943	-0.22	86	116.279	0.94	42	113.636	-1.36	21	117.647	-2.12	16			

		SYNC = 0, BRGH = 1, BRG16 = 1 or SYNC = 1, BRG16 = 1											
BAUD RATE	Fosc = 4.000 MHz			Fos	c = 2.000	MHz	Fosc = 1.000 MHz						
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)				
0.3	0.300	0.01	3332	0.300	-0.04	1665	0.300	-0.04	832				
1.2	1.200	0.04	832	1.201	-0.16	415	1.201	-0.16	207				
2.4	2.404	0.16	415	2.403	-0.16	207	2.403	-0.16	103				
9.6	9.615	0.16	103	9.615	-0.16	51	9.615	-0.16	25				
19.2	19.231	0.16	51	19.230	-0.16	25	19.230	-0.16	12				
57.6	58.824	2.12	16	55.555	3.55	8	—	—	—				
115.2	111.111	-3.55	8	—	_	_	—	_	—				

查询PIC18F67K90供应商 22.1.3 AUTO-BAUD RATE DETECT

The Enhanced USART module supports the automatic detection and calibration of baud rate. This feature is active only in Asynchronous mode and while the WUE bit is clear.

The automatic baud rate measurement sequence (Figure 22-1) begins whenever a Start bit is received and the ABDEN bit is set. The calculation is self-averaging.

In the Auto-Baud Rate Detect (ABD) mode, the clock to the BRG is reversed. Rather than the BRG clocking the incoming RXx signal, the RXx signal is timing the BRG. In ABD mode, the internal Baud Rate Generator is used as a counter to time the bit period of the incoming serial byte stream.

Once the ABDEN bit is set, the state machine will clear the BRG and look for a Start bit. The Auto-Baud Rate Detect must receive a byte with the value, 55h (ASCII "U", which is also the LIN/J2602 bus Sync character), in order to calculate the proper bit rate. The measurement is taken over both a low and a high bit time in order to minimize any effects caused by asymmetry of the incoming signal. After a Start bit, the SPBRGx begins counting up, using the preselected clock source on the first rising edge of RXx. After eight bits on the RXx pin or the fifth rising edge, an accumulated value totalling the proper BRG period is left in the SPBRGHx:SPBRGx register pair. Once the 5th edge is seen (this should correspond to the Stop bit), the ABDEN bit is automatically cleared.

If a rollover of the BRG occurs (an overflow from FFFFh to 0000h), the event is trapped by the ABDOVF status bit (BAUDCONx<7>). It is set in hardware by BRG rollovers and can be set or cleared by the user in software. ABD mode remains active after rollover events and the ABDEN bit remains set (Figure 22-2).

While calibrating the baud rate period, the BRG registers are clocked at 1/8th the preconfigured clock rate. Note that the BRG clock can be configured by the BRG16 and BRGH bits. The BRG16 bit must be set to use both SPBRG1 and SPBRGH1 as a 16-bit counter. This allows the user to verify that no carry occurred for 8-bit modes by checking for 00h in the SPBRGHx register. Refer to Table 22-4 for counter clock rates to the BRG.

While the ABD sequence takes place, the EUSART state machine is held in Idle. The RCxIF interrupt is set once the fifth rising edge on RXx is detected. The value in the RCREGx needs to be read to clear the RCxIF interrupt. The contents of RCREGx should be discarded.

Note 1:	If the WUE bit is set with the ABDEN bit,
	Auto-Baud Rate Detection will occur on
	the byte following the Break character.

- 2: It is up to the user to determine that the incoming character baud rate is within the range of the selected BRG clock source. Some combinations of oscillator frequency and EUSART baud rates are not possible due to bit error rates. Overall system timing and communication baud rates must be taken into consideration when using the Auto-Baud Rate Detection feature.
- **3:** To maximize baud rate range, it is recommended to set the BRG16 (BAUDCONx<3>) bit if the auto-baud feature is used.

TABLE 22-4:BRG COUNTER
CLOCK RATES

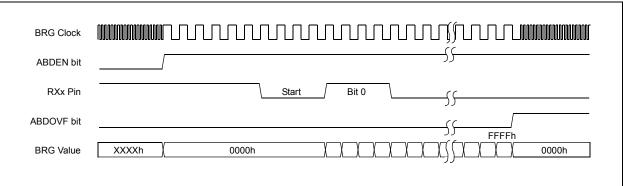
BRG16	BRGH	BRG Counter Clock
0	0	Fosc/512
0	1	Fosc/128
1	0	Fosc/128
1	1	Fosc/32

22.1.3.1 ABD and EUSART Transmission

Since the BRG clock is reversed during ABD acquisition, the EUSART transmitter cannot be used during ABD. This means that whenever the ABDEN bit is set, TXREGx cannot be written to. Users should also ensure that ABDEN does not become set during a transmit sequence. Failing to do this may result in unpredictable EUSART operation.

查询PIC18F67K90供应商 FIGURE 22-1: **AUTOMATIC BAUD RATE CALCULATION** BRG Value XXXXh 0000h 001Ch Edge #1 Edge #2 Edge #3 Edge #4 Start Bit 0 Bit 1 Bit 2 Bit 3 Bit 4 Bit 5 Bit 6 Bit 7 - Edge #5 RXx Pin Stop Bit - Auto-Cleared Set by User -ABDEN bit RCxIF bit (Interrupt) Read RCREGx SPBRGx XXXXh 1Ch XXXXh 00h SPBRGHx Note: The ABD sequence requires the EUSART module to be configured in Asynchronous mode and WUE = 0.

FIGURE 22-2: BRG OVERFLOW SEQUENCE



查询PIC18F67K90供应商 22.2 EUSART Asynchronous Mode

The Asynchronous mode of operation is selected by clearing the SYNC bit (TXSTAx<4>). In this mode, the EUSART uses standard Non-Return-to-Zero (NRZ) format (one Start bit, eight or nine data bits and one Stop bit). The most common data format is 8 bits. An on-chip, dedicated 8-bit/16-bit Baud Rate Generator can be used to derive standard baud rate frequencies from the oscillator.

The EUSART transmits and receives the LSb first. The EUSART's transmitter and receiver are functionally independent but use the same data format and baud rate. The Baud Rate Generator produces a clock, either x16 or x64 of the bit shift rate, depending on the BRGH and BRG16 bits (TXSTAx<2> and BAUDCONx<3>). Parity is not supported by the hardware but can be implemented in software and stored as the 9th data bit.

When operating in Asynchronous mode, the EUSART module consists of the following important elements:

- Baud Rate Generator
- · Sampling Circuit
- Asynchronous Transmitter
- Asynchronous Receiver
- Auto-Wake-up on Sync Break Character
- 12-Bit Break Character Transmit
- Auto-Baud Rate Detection

22.2.1 EUSART ASYNCHRONOUS TRANSMITTER

The EUSART transmitter block diagram is shown in Figure 22-3. The heart of the transmitter is the Transmit (Serial) Shift Register (TSR). The Shift register obtains its data from the Read/Write Transmit Buffer register, TXREGx. The TXREGx register is loaded with data in software. The TSR register is not loaded until the Stop bit has been transmitted from the previous load. As soon as the Stop bit is transmitted, the TSR is loaded with new data from the TXREGx register (if available). Once the TXREGx register transfers the data to the TSR register (occurs in one TcY), the TXREGx register is empty and the TXxIF flag bit is set. This interrupt can be enabled or disabled by setting or clearing the interrupt enable bit, TXxIE. TXxIF will be set regardless of the state of TXxIE; it cannot be cleared in software. TXxIF is also not cleared immediately upon loading TXREGx, but becomes valid in the second instruction cycle following the load instruction. Polling TXxIF immediately following a load of TXREGx will return invalid results.

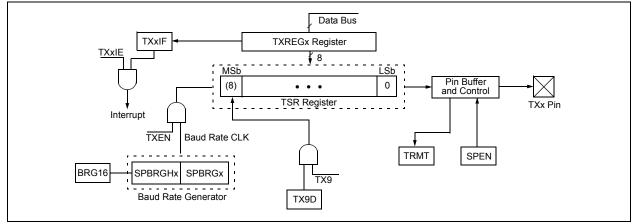
While TXxIF indicates the status of the TXREGx register; another bit, TRMT (TXSTAx<1>), shows the status of the TSR register. TRMT is a read-only bit which is set when the TSR register is empty. No interrupt logic is tied to this bit so the user has to poll this bit in order to determine if the TSR register is empty.

Note 1: The TSR register is not mapped in data memory, so it is not available to the user.
2: Flag bit, TXxIF, is set when enable bit, TXEN, is set.

To set up an Asynchronous Transmission:

- 1. Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- 2. Enable the asynchronous serial port by clearing bit, SYNC, and setting bit, SPEN.
- 3. If interrupts are desired, set enable bit, TXxIE.
- 4. If 9-bit transmission is desired, set transmit bit, TX9. Can be used as address/data bit.
- 5. Enable the transmission by setting bit, TXEN, which will also set bit, TXxIF.
- 6. If 9-bit transmission is selected, the ninth bit should be loaded in bit, TX9D.
- 7. Load data to the TXREGx register (starts transmission).
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

FIGURE 22-3: EUSART TRANSMIT BLOCK DIAGRAM



© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商 FIGURE 22-4: ASYNCHRONOUS TRANSMISSION

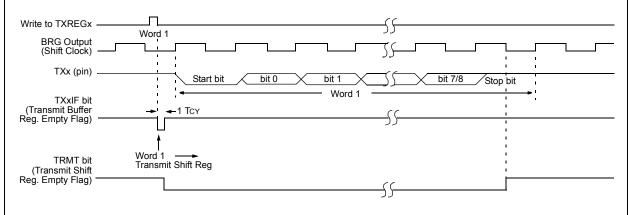
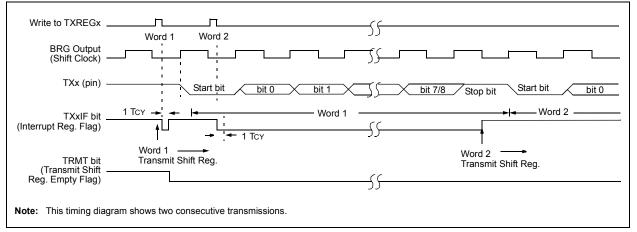


FIGURE 22-5: ASYNCHRONOUS TRANSMISSION (BACK-TO-BACK)



查询PIC18F67K90供应商 TABLE 22-5: REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73	
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75	
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75	
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75	
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75	
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75	
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75	
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	75	
TXREG1	EUSART1	Transmit Re	gister						75	
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	75	
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16		WUE	ABDEN	77	
SPBRGH1	EUSART1	Baud Rate (Generator R	egister Higl	n Byte				74	
SPBRG1	EUSART1	Baud Rate (Generator R	egister Low	/ Byte				75	
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	79	
TXREG2	EUSART2	Transmit Re	gister						80	
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	79	
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	79	
SPBRGH2	EUSART2 Baud Rate Generator Register High Byte									
SPBRG2	EUSART2	Baud Rate (Generator R	egister Low	/ Byte				80	
Legende										

Legend: — = unimplemented locations read as '0'. Shaded cells are not used for asynchronous transmission.

查询PIC18F67K90供应商

22.2.2 EUSART ASYNCHRONOUS RECEIVER

The receiver block diagram is shown in Figure 22-6. The data is received on the RXx pin and drives the data recovery block. The data recovery block is actually a high-speed shifter operating at x16 times the baud rate, whereas the main receive serial shifter operates at the bit rate or at Fosc. This mode would typically be used in RS-232 systems.

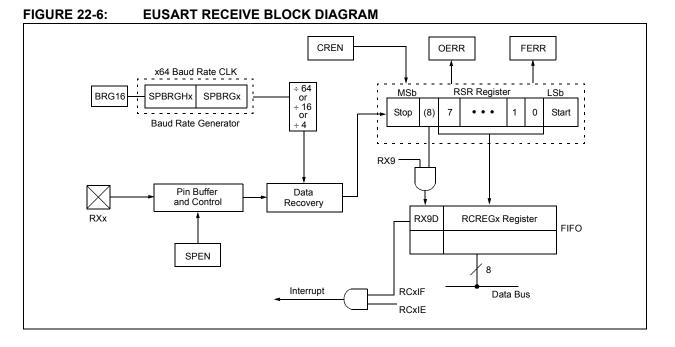
To set up an Asynchronous Reception:

- 1. Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- 2. Enable the asynchronous serial port by clearing bit, SYNC, and setting bit, SPEN.
- 3. If interrupts are desired, set enable bit, RCxIE.
- 4. If 9-bit reception is desired, set bit, RX9.
- 5. Enable the reception by setting bit, CREN.
- Flag bit, RCxIF, will be set when reception is complete and an interrupt will be generated if enable bit, RCxIE, was set.
- 7. Read the RCSTAx register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- 8. Read the 8-bit received data by reading the RCREGx register.
- 9. If any error occurred, clear the error by clearing enable bit, CREN.
- 10. If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

22.2.3 SETTING UP 9-BIT MODE WITH ADDRESS DETECT

This mode would typically be used in RS-485 systems. To set up an Asynchronous Reception with Address Detect Enable:

- 1. Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- 2. Enable the asynchronous serial port by clearing the SYNC bit and setting the SPEN bit.
- 3. If interrupts are required, set the RCEN bit and select the desired priority level with the RCxIP bit.
- 4. Set the RX9 bit to enable 9-bit reception.
- 5. Set the ADDEN bit to enable address detect.
- 6. Enable reception by setting the CREN bit.
- The RCxIF bit will be set when reception is complete. The interrupt will be Acknowledged if the RCxIE and GIE bits are set.
- 8. Read the RCSTAx register to determine if any error occurred during reception, as well as read bit 9 of data (if applicable).
- 9. Read RCREGx to determine if the device is being addressed.
- 10. If any error occurred, clear the CREN bit.
- 11. If the device has been addressed, clear the ADDEN bit to allow all received data into the receive buffer and interrupt the CPU.



查询PIC18F67K90供应商 FIGURE 22-7: ASYNCHRO

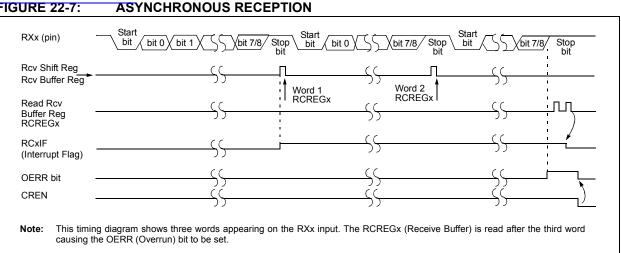


TABLE 22-6: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	—	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	—	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	75
RCREG1	EUSART1 Receive Register								75
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	75
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	77
SPBRGH1	EUSART1	Baud Rate G	Generator R	egister High	n Byte				74
SPBRG1	EUSART1	Baud Rate G	Generator Re	egister Low	Byte				75
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	79
RCREG2	EUSART2	Receive Reg	jister						80
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	79
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	79
SPBRGH2	EUSART2	Baud Rate G	Senerator R	egister High	Byte			-	80
SPBRG2	EUSART2	Baud Rate G	Benerator R	egister Low	Byte				80

Legend: — = unimplemented locations read as '0'. Shaded cells are not used for asynchronous reception.

查询PIC18F67K90供应商

22.2.4 AUTO-WAKE-UP ON SYNC BREAK CHARACTER

During Sleep mode, all clocks to the EUSART are suspended. Because of this, the Baud Rate Generator is inactive and a proper byte reception cannot be performed. The auto-wake-up feature allows the controller to wake-up due to activity on the RXx/DTx line while the EUSART is operating in Asynchronous mode.

The auto-wake-up feature is enabled by setting the WUE bit (BAUDCONx<1>). Once set, the typical receive sequence on RXx/DTx is disabled and the EUSART remains in an Idle state, monitoring for a wake-up event independent of the CPU mode. A wake-up event consists of a high-to-low transition on the RXx/DTx line. (This coincides with the start of a Sync Break or a Wake-up Signal character for the LIN/J2602 protocol.)

Following a wake-up event, the module generates an RCxIF interrupt. The interrupt is generated synchronously to the Q clocks in normal operating modes (Figure 22-8) and asynchronously if the device is in Sleep mode (Figure 22-9). The interrupt condition is cleared by reading the RCREGx register.

The WUE bit is automatically cleared once a low-to-high transition is observed on the RXx line following the wake-up event. At this point, the EUSART module is in Idle mode and returns to normal operation. This signals to the user that the Sync Break event is over.

22.2.4.1 Special Considerations Using Auto-Wake-up

Since auto-wake-up functions by sensing rising edge transitions on RXx/DTx, information with any state changes before the Stop bit may signal a false End-of-Character (EOC) and cause data or framing errors. To work properly, therefore, the initial character in the transmission must be all '0's. This can be 00h (8 bits) for standard RS-232 devices or 000h (12 bits) for LIN/J2602 bus.

Oscillator start-up time must also be considered, especially in applications using oscillators with longer start-up intervals (i.e., HS or HSPLL mode). The Sync Break (or Wake-up Signal) character must be of sufficient length and be followed by a sufficient interval to allow enough time for the selected oscillator to start and provide proper initialization of the EUSART.

查询PIC18F67K90供应商

22.2.4.2 Special Considerations Using the WUE Bit

The timing of WUE and RCxIF events may cause some confusion when it comes to determining the validity of received data. As noted, setting the WUE bit places the EUSART in an Idle mode. The wake-up event causes a receive interrupt by setting the RCxIF bit. The WUE bit is cleared after this when a rising edge is seen on RXx/DTx. The interrupt condition is then cleared by reading the RCREGx register. Ordinarily, the data in RCREGx will be dummy data and should be discarded.

The fact that the WUE bit has been cleared (or is still set) and the RCxIF flag is set should not be used as an indicator of the integrity of the data in RCREGx. Users should consider implementing a parallel method in firmware to verify received data integrity.

To assure that no actual data is lost, check the RCIDL bit to verify that a receive operation is not in process. If a receive operation is not occurring, the WUE bit may then be set just prior to entering the Sleep mode.

FIGURE 22-8: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING NORMAL OPERATION

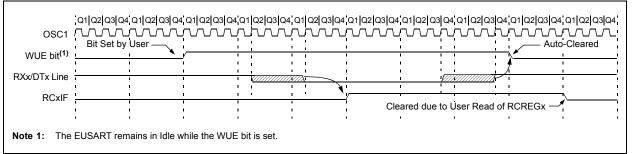
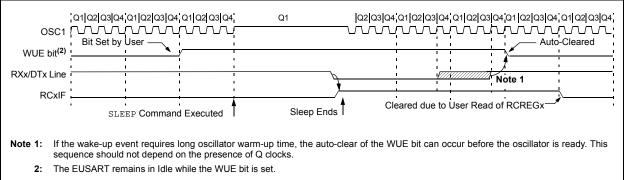


FIGURE 22-9: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING SLEEP



查询PIC18F67K90供应商

22.2.5 BREAK CHARACTER SEQUENCE

The EUSART module has the capability of sending the special Break character sequences that are required by the LIN/J2602 bus standard. The Break character transmit consists of a Start bit, followed by twelve '0' bits and a Stop bit. The Frame Break character is sent whenever the SENDB and TXEN bits (TXSTAx<3> and TXSTAx<5>, respectively) are set while the Transmit Shift Register is loaded with data. Note that the value of data written to TXREGx will be ignored and all '0's will be transmitted.

The SENDB bit is automatically reset by hardware after the corresponding Stop bit is sent. This allows the user to preload the transmit FIFO with the next transmit byte following the Break character (typically, the Sync character in the LIN/J2602 specification).

Note that the data value written to the TXREGx for the Break character is ignored. The write simply serves the purpose of initiating the proper sequence.

The TRMT bit indicates when the transmit operation is active or Idle, just as it does during normal transmission. See Figure 22-10 for the timing of the Break character sequence.

22.2.5.1 Break and Sync Transmit Sequence

The following sequence will send a message frame header made up of a Break, followed by an Auto-Baud Sync byte. This sequence is typical of a LIN/J2602 bus master.

- 1. Configure the EUSART for the desired mode.
- 2. Set the TXEN and SENDB bits to set up the Break character.
- 3. Load the TXREGx with a dummy character to initiate transmission (the value is ignored).
- 4. Write '55h' to TXREGx to load the Sync character into the transmit FIFO buffer.
- 5. After the Break has been sent, the SENDB bit is reset by hardware. The Sync character now transmits in the preconfigured mode.

When the TXREGx becomes empty, as indicated by the TXxIF, the next data byte can be written to TXREGx.

22.2.6 RECEIVING A BREAK CHARACTER

The Enhanced USART module can receive a Break character in two ways.

The first method forces configuration of the baud rate at a frequency of 9/13 the typical speed. This allows for the Stop bit transition to be at the correct sampling location (13 bits for Break versus Start bit and 8 data bits for typical data).

The second method uses the auto-wake-up feature described in **Section 22.2.4 "Auto-Wake-up on Sync Break Character"**. By enabling this feature, the EUSART will sample the next two transitions on RXx/DTx, cause an RCxIF interrupt and receive the next data byte followed by another interrupt.

Note that following a Break character, the user will typically want to enable the Auto-Baud Rate Detect feature. For both methods, the user can set the ABDEN bit once the TXxIF interrupt is observed.

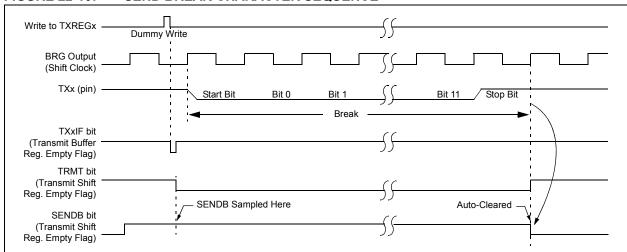


FIGURE 22-10: SEND BREAK CHARACTER SEQUENCE

查询PIC18F67K90供应商 22.3 EUSART Synchronous Master Mode

The Synchronous Master mode is entered by setting the CSRC bit (TXSTAx<7>). In this mode, the data is transmitted in a half-duplex manner (i.e., transmission and reception do not occur at the same time). When transmitting data, the reception is inhibited and vice versa. Synchronous mode is entered by setting bit, SYNC (TXSTAx<4>). In addition, enable bit, SPEN (RCSTAx<7>), is set in order to configure the TXx and RXx pins to CKx (clock) and DTx (data) lines, respectively.

The Master mode indicates that the processor transmits the master clock on the CKx line. Clock polarity is selected with the TXCKP bit (BAUDCONx<4>). Setting TXCKP sets the Idle state on CKx as high, while clearing the bit sets the Idle state as low. This option is provided to support Microwire devices with this module.

22.3.1 EUSART SYNCHRONOUS MASTER TRANSMISSION

The EUSART transmitter block diagram is shown in Figure 22-3. The heart of the transmitter is the Transmit (Serial) Shift Register (TSR). The TSR register obtains its data from the Read/Write Transmit Buffer register, TXREGx. The TXREGx register is loaded with data in software. The TSR register is not loaded until the last bit has been transmitted from the previous load. As soon as the last bit is transmitted, the TSR is loaded with new data from the TXREGx (if available).

Once the TXREGx register transfers the data to the TSR register (occurs in one TcY), the TXREGx is empty and the TXxIF flag bit is set. The interrupt can be enabled or disabled by setting or clearing the interrupt enable bit, TXxIE. TXxIF is set regardless of the state of enable bit, TXxIE; it cannot be cleared in software. It will reset only when new data is loaded into the TXREGx register.

While flag bit, TXxIF, indicates the status of the TXREGx register, another bit, TRMT (TXSTAx<1>), shows the status of the TSR register. TRMT is a read-only bit which is set when the TSR is empty. No interrupt logic is tied to this bit, so the user must poll this bit in order to determine if the TSR register is empty. The TSR is not mapped in data memory so it is not available to the user.

To set up a Synchronous Master Transmission:

- Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRG16 bit, as required, to achieve the desired baud rate.
- 2. Enable the synchronous master serial port by setting bits, SYNC, SPEN and CSRC.
- 3. If interrupts are desired, set enable bit, TXxIE.
- 4. If 9-bit transmission is desired, set bit, TX9.
- 5. Enable the transmission by setting bit, TXEN.
- 6. If 9-bit transmission is selected, the ninth bit should be loaded in bit, TX9D.
- 7. Start transmission by loading data to the TXREGx register.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

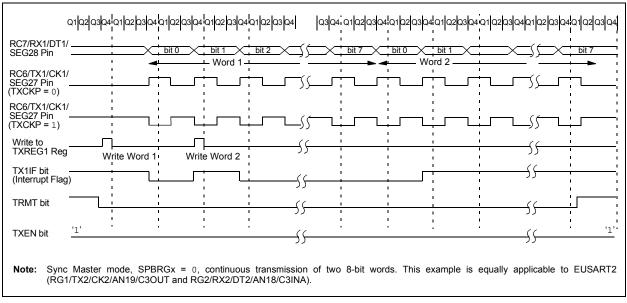


FIGURE 22-11: SYNCHRONOUS TRANSMISSION

查询PIC18F67K90供应商

FIGURE 22-12: SYNCHRONOUS TRANSMISSION (THROUGH TXEN)

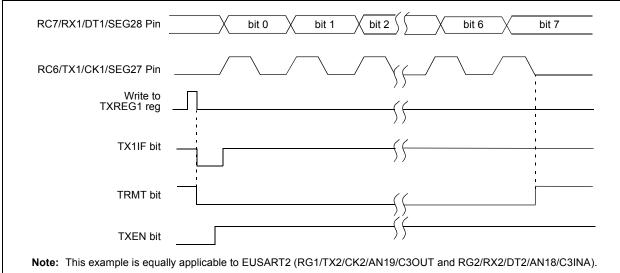


TABLE 22-7 :	REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	—	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	75
TXREG1	EUSART1 Transmit Register								75
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	75
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16		WUE	ABDEN	77
SPBRGH1	EUSART1	Baud Rate C	Generator R	egister Higl	n Byte				74
SPBRG1	EUSART1	Baud Rate C	Generator R	egister Low	v Byte				75
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	79
TXREG2	EUSART2	Transmit Re	gister						80
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	79
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	79
SPBRGH2	EUSART2	Baud Rate C	Generator R	egister Higl	n Byte				80
SPBRG2	EUSART2 Baud Rate Generator Register Low Byte							80	

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous master transmission.

查询PIC18F67K90供应商 22.3.2 EUSART SYNCHRONOUS MASTER RECEPTION

Once Synchronous mode is selected, reception is enabled by setting either the Single Receive Enable bit, SREN (RCSTAx<5>) or the Continuous Receive Enable bit, CREN (RCSTAx<4>). Data is sampled on the RXx pin on the falling edge of the clock.

If enable bit, SREN, is set, only a single word is received. If enable bit, CREN, is set, the reception is continuous until CREN is cleared. If both bits are set, then CREN takes precedence.

To set up a Synchronous Master Reception:

- 1. Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRG16 bit, as required, to achieve the desired baud rate.
- 2. Enable the synchronous master serial port by setting bits, SYNC, SPEN and CSRC.

- 3. Ensure bits, CREN and SREN, are clear.
- 4. If interrupts are desired, set enable bit, RCxIE.
- 5. If 9-bit reception is desired, set bit, RX9.
- 6. If a single reception is required, set bit, SREN. For continuous reception, set bit, CREN.
- 7. Interrupt flag bit, RCxIF, will be set when reception is complete and an interrupt will be generated if the enable bit, RCxIE, was set.
- 8. Read the RCSTAx register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- 9. Read the 8-bit received data by reading the RCREGx register.
- 10. If any error occurred, clear the error by clearing bit CREN.
- 11. If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

FIGURE 22-13: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)

02/03/04/01/02/03/04 RC7/RX1/DT1/ bit 0 bit 1 bit 2 bit 3 bit 4 bit 5 bit 6 bit 7 SEG28 Pin RC6/TX1/CK1/ SEG27 Pin (TXCKP = 0) RC6/TX1/CK1/ SEG27 Pin (TXCKP = 1) Write to bit. SREN SREN bit CREN bit '0' '0' RC1IF bit (Interrupt) Read RCREG1 Note: Timing diagram demonstrates Sync Master mode with bit, SREN = 1, and bit, BRGH = 0. This example is equally applicable to EUSART2 (RG1/TX2/CK2/AN19/C3OUT and RG2/RX2/DT2/AN18/C3INA).

查询PIC18F67K90供应商

TABLE 22-8: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	—	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	75
RCREG1	EUSART1 Receive Register								75
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	75
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	77
SPBRGH1	EUSART1	Baud Rate (Generator	Register H	ligh Byte				74
SPBRG1	EUSART1	Baud Rate (Generator	Register L	ow Byte				75
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	79
RCREG2	EUSART2	Receive Re	gister						80
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	79
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	79
SPBRGH2	2 EUSART2 Baud Rate Generator Register High Byte							80	
SPBRG2	EUSART2	Baud Rate (Generator	Register L	ow Byte				80

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous master reception.

查询PIC18F67K90供应商

22.4 EUSART Synchronous Slave Mode

Synchronous Slave mode is entered by clearing bit, CSRC (TXSTAx<7>). This mode differs from the Synchronous Master mode in that the shift clock is supplied externally at the CKx pin (instead of being supplied internally in Master mode). This allows the device to transfer or receive data while in any low-power mode.

22.4.1 EUSART SYNCHRONOUS SLAVE TRANSMISSION

The operation of the Synchronous Master and Slave modes is identical, except in the case of Sleep mode.

If two words are written to the TXREGx and then the SLEEP instruction is executed, the following will occur:

- a) The first word will immediately transfer to the TSR register and transmit.
- b) The second word will remain in the TXREGx register.
- c) Flag bit, TXxIF, will not be set.
- When the first word has been shifted out of TSR, the TXREGx register will transfer the second word to the TSR and flag bit, TXxIF, will now be set.

e) If enable bit, TXxIE, is set, the interrupt will wake the chip from Sleep. If the global interrupt is enabled, the program will branch to the interrupt vector.

To set up a Synchronous Slave Transmission:

- 1. Enable the synchronous slave serial port by setting bits, SYNC and SPEN, and clearing bit, CSRC.
- 2. Clear bits, CREN and SREN.
- 3. If interrupts are desired, set enable bit, TXxIE.
- 4. If 9-bit transmission is desired, set bit, TX9.
- 5. Enable the transmission by setting enable bit, TXEN.
- 6. If 9-bit transmission is selected, the ninth bit should be loaded in bit, TX9D.
- 7. Start transmission by loading data to the TXREGx register.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	75
TXREG1	EUSART1 Transmit Register								75
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	75
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16		WUE	ABDEN	77
SPBRGH1	EUSART1	Baud Rate G	enerator R	egister High	n Byte				74
SPBRG1	EUSART1	Baud Rate G	enerator R	egister Low	Byte				75
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	79
TXREG2	EUSART2	Transmit Reg	gister						80
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	79
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	79
SPBRGH2	EUSART2	Baud Rate G	enerator R	egister High	n Byte				80
SPBRG2	EUSART2	Baud Rate G	enerator R	egister Low	Byte				80

TABLE 22-9: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE TRANSMISSION

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous slave transmission.

查询PIC18F67K90供应商

22.4.2 EUSART SYNCHRONOUS SLAVE RECEPTION

The operation of the Synchronous Master and Slave modes is identical, except in the case of Sleep, or any Idle mode and bit, SREN, which is a "don't care" in Slave mode.

If receive is enabled by setting the CREN bit prior to entering Sleep or any Idle mode, then a word may be received while in this low-power mode. Once the word is received, the RSR register will transfer the data to the RCREGx register. If the RCxIE enable bit is set, the interrupt generated will wake the chip from the low-power mode. If the global interrupt is enabled, the program will branch to the interrupt vector. To set up a Synchronous Slave Reception:

- 1. Enable the synchronous master serial port by setting bits, SYNC and SPEN, and clearing bit, CSRC.
- 2. If interrupts are desired, set enable bit, RCxIE.
- 3. If 9-bit reception is desired, set bit, RX9.
- 4. To enable reception, set enable bit, CREN.
- 5. Flag bit, RCxIF, will be set when reception is complete. An interrupt will be generated if enable bit, RCxIE, was set.
- 6. Read the RCSTAx register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- 7. Read the 8-bit received data by reading the RCREGx register.
- 8. If any error occurred, clear the error by clearing bit, CREN.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	—	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	75
RCREG1	EUSART1 Receive Register								75
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	75
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	77
SPBRGH1	EUSART1	Baud Rate C	Generator R	egister High	n Byte				74
SPBRG1	EUSART1	Baud Rate C	Generator R	egister Low	' Byte				75
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	79
RCREG2	EUSART2	Receive Reo	gister						80
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	79
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	79
SPBRGH2	EUSART2	Baud Rate (Generator R	egister High	n Byte				80
SPBRG2									80

TABLE 22-10: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE RECEPTION

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous slave reception.

查询PIC18F67K90供应商

23.0 12-BIT ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The Analog-to-Digital (A/D) Converter module in the PIC18F87K90 family of devices has 16 inputs for the 64-pin devices and 24 inputs for the 80-pin devices. This module allows conversion of an analog input signal to a corresponding signed 12-bit digital number.

The module has these registers:

- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)
- A/D Control Register 2 (ADCON2)
- A/D Port Configuration Register 0 (ANCON0)
- A/D Port Configuration Register 1 (ANCON1)
- A/D Port Configuration Register 2 (ANCON2)
- ADRESH (the upper A/D Results register)
- ADRESL (the lower A/D Results register)

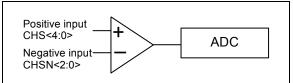
The ADCON0 register, shown in Register 23-1, controls the operation of the A/D module. The ADCON1 register, shown in Register 23-2, configures the voltage reference and special trigger selection. The ADCON2 register, shown in Register 23-3, configures the A/D clock source and programmed acquisition time and justification.

23.1 Differential A/D Converter

The converter in PIC18F87K90 family devices is implemented as a differential A/D where the differential voltage between two channels is measured and converted to digital values (see Figure 23-1).

The converter also can be configured to measure a voltage from a single input by clearing the CHSN bits (ADCON1<2:0>). With this configuration, the negative channel input is connected internally to AVss (see Figure 23-2).

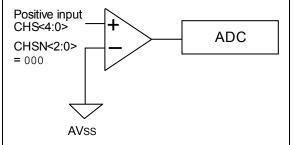
FIGURE 23-1: DIFFERENTIAL CHANNEL MEASUREMENT



Differential conversion feeds the two input channels to a unity gain differential amplifier. The positive channel input is selected using the CHS bits (ADCON0<6:2>) and the negative channel input is selected using the CHSN bits (ADCON1<2:0>).

The output from the amplifier is fed to the A/D convert, as shown in Figure 23-1. The 12-bit result is available on the ADRESH and ADRESL registers. There is also a sign bit, along with the 12-bit result, indicating if the result is a positive or negative value.





In the Single Channel Measurement mode, the negative input is connected to Avss by clearing the CHSN bits (ADCON1<2:0>).

查询PIC18F67K90供应商

23.2 A/D Registers

23.2.1 A/D CONTROL REGISTERS

REGISTER 23-1: ADCON0: A/D CONTROL REGISTER 0

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	CHS4	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON
bit 7							bit 0

Legend:					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 7 Unimplemented: Read as '0'

bit 6-2	CHS<4:0>: Analog Channel Select bits	
	00000 = Channel 00 (AN0)	10000 = Channel 16 (AN16)
	00001 = Channel 01 (AN1)	10001 = Channel 17 (AN17)
	00010 = Channel 02 (AN2)	10010 = Channel 18 (AN18)
	00011 = Channel 03 (AN3)	10011 = Channel 19 (AN19)
	00100 = Channel 04 (AN4)	10100 = Channel 20 (AN20) ^(1,2)
	00101 = Channel 05 (AN5)	10101 = Channel 21 (AN21) ^(1,2)
	00110 = Channel 06 (AN6)	10110 = Channel 22 (AN22) ^(1,2)
	00111 = Channel 07 (AN7)	10111 = Channel 23 (AN23) ^(1,2)
	01000 = Channel 08 (AN8)	$11000 = (Reserved)^{(2)}$
	01001 = Channel 09 (AN9)	11001 = (Reserved) ⁽²⁾
	01010 = Channel 10 (AN10)	11010 = (Reserved) ⁽²⁾
	01011 = Channel 11 (AN11)	11011 = (Reserved) ⁽²⁾
	01100 = Channel 12 (AN12) ^(1,2)	11100 = Channel 28 (Reserved CTMU)
	01101 = Channel 13 (AN13) ^(1,2)	11101 = Channel 29 (Internal temperature diode)
	01110 = Channel 14 (AN14) ^(1,2)	11110 = Channel 30 (VDDCORE)
	01111 = Channel 15 (AN15) ^(1,2)	11111 = Channel 31 (1.024V band gap)
bit 1	GO/DONE: A/D Conversion Status bit	
		ess. Setting this bit starts an A/D conversion cycle. The bit is /hen the A/D conversion is completed.
	0 = A/D conversion is completed or not i	•
bit 0	ADON: A/D On bit	n progress
DILU		
	1 = A/D Converter is operating	Leansuming no encreting current
	0 = A/D Converter module is shut off and	i consuming no operating current
	T	

Note 1: These channels are not implemented on 64-pin devices.

2: Performing a conversion on unimplemented channels will return random values.

查询PIC18F67K90供应商 REGISTER 23-2: ADCON1: A/D CONTROL REGISTER 1 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 TRIGSEL1 **TRIGSEL0** VCFG1 VCFG0 VNCFG CHSN2 CHSN1 CHSN0 bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 7-6 TRIGSEL<1:0>: Special Trigger Select bits 11 = Selects the special trigger from the RTCC 10 = Selects the special trigger from the Timer1 01 = Selects the special trigger from the CTMU 00 = Selects the special trigger from the ECCP2 bit 5-4 VCFG<1:0>: A/D VREF+ Configuration bits 11 = Internal VREF+ (4.096V) 10 = Internal VREF+ (2.048V) 01 = External VREF+ 00 = AVDD bit 3 VNCFG: A/D VREF- Configuration bit 1 = External VREF 0 = AVss bit 2-0 CHSN<2:0>: Analog Negative Channel Select bits 111 = Channel 07 (AN6) 110 = Channel 06 (AN5) 101 = Channel 05 (AN4) 100 = Channel 04 (AN3) 011 = Channel 03 (AN2) 010 = Channel 02 (AN1) 001 = Channel 01 (AN0) 000 = Selecting '000' chooses AVss/external VREF- as a negative channel based on VNCFG

Note 1: If the A/D FRC clock source is selected, a delay of one TCY (instruction cycle) is added before the A/D clock starts. This allows the SLEEP instruction to be executed before starting a conversion.

查询PIC18F67K90供应商 REGISTER 23-3: ADCON2: A/D CONTROL REGISTER 2

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADFM		ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0
bit 7							bit C
Legend:							
R = Readat	ole bit	W = Writable I	oit	U = Unimplem	nented bit, rea	d as '0'	
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown
bit 7	ADFM: A/D F 1 = Right jus 0 = Left justif		elect bit				
bit 6	-	nted: Read as '(,				
bit 5-3	-	A/D Acquisition		hits			
	$111 = 20 \text{ TAC} \\ 110 = 16 \text{ TAC} \\ 101 = 12 \text{ TAC} \\ 100 = 8 \text{ TAD} \\ 011 = 6 \text{ TAD} \\ 010 = 4 \text{ TAD} \\ 001 = 2 \text{ TAD} \\ 000 = 0 \text{ TAD} \\ 0 TA$	5					
bit 2-0	111 = FRC (0 110 = Fosc/ 101 = Fosc/ 100 = Fosc/	16 4 clock derived fro 32 8	m A/D RC osc	sillator) ⁽¹⁾			

Note 1: If the A/D FRC clock source is selected, a delay of one TcY (instruction cycle) is added before the A/D clock starts. This allows the SLEEP instruction to be executed before starting a conversion.

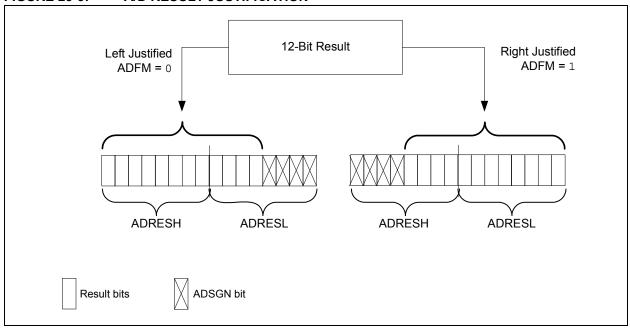
查询PIC18F67K90供应商 23.2.2 A/D RESULT REGISTERS

The ADRESH:ADRESL register pair is where the 12-bit A/D result and extended sign bits (ADSGN) are loaded at the completion of a conversion. This register pair is 16 bits wide. The A/D module gives the flexibility of left or right justifying the 12-bit result in the 16-bit result register. The A/D Format Select bit (ADFM) controls this justification.

FIGURE 23-3: A/D RESULT JUSTIFICATION

Figure 23-3 shows the operation of the A/D result justification and location of the sign bit (ADSGN). The extended sign bits allow for easier 16-bit math to be performed on the result.

When the A/D Converter is disabled, these 8-bit registers can be used as two, general purpose registers.



REGISTER 23-4: ADRESH: A/D RESULT HIGH BYTE REGISTER, LEFT JUSTIFIED (ADFM = 0)

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
ADRES11	ADRES10	ADRES9	ADRES8	ADRES7	ADRES6	ADRES5	ADRES4
bit 7							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 ADRES<11:4>: A/D Result High Byte bits

查询PIC18F67K90供应商 REGISTER 23-5: ADRESL: A/D RESULT LOW BYTE REGISTER, LEFT JUSTIFIED (ADFM = 0)

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
ADRES3	ADRES2	ADRES1	ADRES0	ADSGN	ADSGN	ADSGN	ADSGN
bit 7							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-4 ADRES<3:0>: A/D Result Low Byte bits

ADSGN: A/D Result Sign bits bit 3-0

REGISTER 23-6: ADRESH: A/D RESULT HIGH BYTE REGISTER, RIGHT JUSTIFIED (ADFM = 1)

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
ADSGN	ADSGN	ADSGN	ADSGN	ADRES11	ADRES10	ADRES9	ADRES8
bit 7							

Legend:				
R = Readable bit	R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7-4 ADSGN: A/D Result Sign bits

bit 3-0 ADRES<11:8>: A/D Result High Byte bits

REGISTER 23-7: ADRESL: A/D RESULT LOW BYTE REGISTER, RIGHT JUSTIFIED (ADFM = 1)

| R/W-x |
|--------|--------|--------|--------|--------|--------|--------|--------|
| ADRES7 | ADRES6 | ADRES5 | ADRES4 | ADRES3 | ADRES2 | ADRES1 | ADRES0 |
| bit 7 | | | | | | | |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 ADRES<7:0>: A/D Result Low Byte bits

查询PIC18F67K90供应商

The ANCONx registers are used to configure the operation of the I/O pin associated with each analog channel. Clearing a ANSELx bit configures the corresponding pin (ANx) to operate as a digital only I/O. Setting a bit configures the pin to operate as an analog input for either the A/D Converter or the comparator module, with all digital peripherals disabled and digital inputs read as '0'.

As a rule, I/O pins that are multiplexed with analog inputs default to analog operation on any device Reset.

REGISTER 23-8: ANCON0: A/D PORT CONFIGURATION REGISTER 0

| R/W-1 |
|--------|--------|--------|--------|--------|--------|--------|--------|
| ANSEL7 | ANSEL6 | ANSEL5 | ANSEL4 | ANSEL3 | ANSEL2 | ANSEL1 | ANSEL0 |
| bit 7 | | | | | | | bit 0 |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0

ANSEL<7:0>: Analog Port Configuration bits (AN7 and AN0)

0 = Pin configured as a digital port

1 = Pin configured as an analog channel – digital input disabled and any inputs read as '0'

REGISTER 23-9: ANCON1: A/D PORT CONFIGURATION REGISTER 1

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
ANSEL15 ⁽¹⁾	ANSEL14 ⁽¹⁾	ANSEL13 ⁽¹⁾	ANSEL12 ⁽¹⁾	ANSEL11	ANSEL10	ANSEL9	ANSEL8
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 ANSEL<15:8>: Analog Port Configuration bits (AN15 through AN8)

0 = Pin is configured as a digital port

1 = Pin is configured as an analog channel – digital input is disabled and any inputs read as '0'

Note 1: AN12 through AN15, and AN20 to AN23, are implemented only on 80-pin devices. For 64-pin devices, the corresponding ANSELx bits are still implemented for these channels, but have no effect.

© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商

REGISTER 23-10: ANCON2: A/D PORT CONFIGURATION REGISTER 2

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
ANSEL23 ⁽¹⁾	ANSEL22 ⁽¹⁾	ANSEL21 ⁽¹⁾	ANSEL20 ⁽¹⁾	ANSEL19	ANSEL18	ANSEL17	ANSEL16
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **ANSEL<23:16>:** Analog Port Configuration bits (AN23 through AN16)

- 1 = Pin configured as an analog channel digital input disabled and any inputs read as '0'
- **Note 1:** AN12 through AN15, and AN20 to AN23, are implemented only on 80-pin devices. For 64-pin devices, the corresponding ANSELx bits are still implemented for these channels, but have no effect.

The analog reference voltage is software-selectable to either the device's positive and negative supply voltage (AVDD and AVSS) or the voltage level on the RA3/AN3/VREF+ and RA2/AN2/VREF- pins. VREF+ has two additional internal voltage reference selections: 2.048V and 4.096V.

The A/D Converter can uniquely operate while the device is in Sleep mode. To operate in Sleep, the A/D conversion clock must be derived from the A/D's internal RC oscillator.

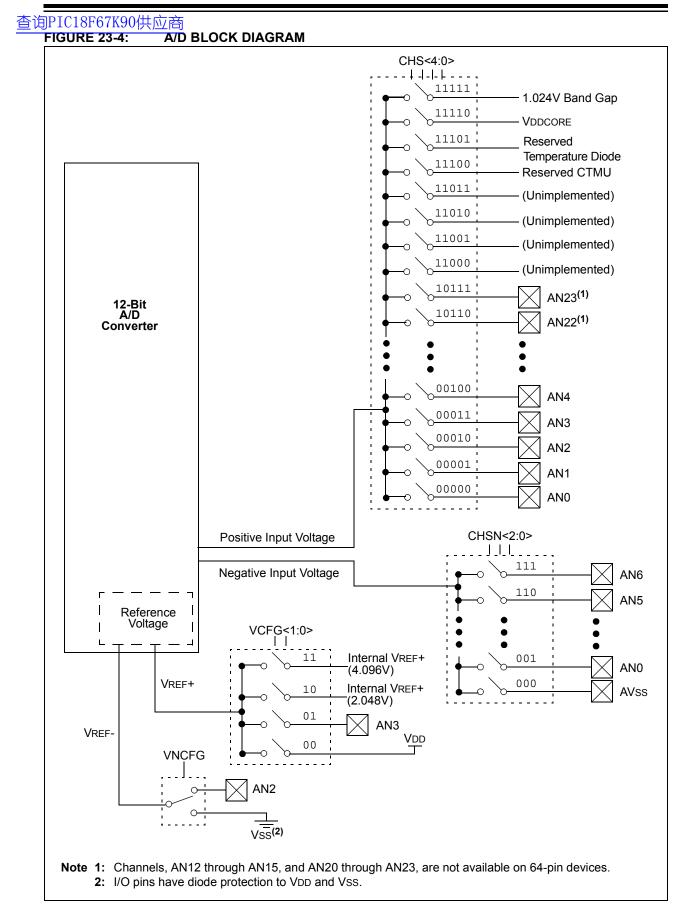
The output of the sample and hold is the input into the converter, which generates the result via successive approximation.

Each port pin associated with the A/D Converter can be configured as an analog input or a digital I/O. The ADRESH and ADRESL registers contain the result of the A/D conversion. When the A/D conversion is complete, the result is loaded into the ADRESH:ADRESL register pair, the GO/DONE bit (ADCON0<1>) is cleared and the A/D Interrupt Flag bit, ADIF (PIR1<6>), is set.

A device Reset forces all registers to their Reset state. This forces the A/D module to be turned off and any conversion in progress is aborted. The value in the ADRESH:ADRESL register pair is not modified for a Power-on Reset. These registers will contain unknown data after a Power-on Reset.

The block diagram of the A/D module is shown in Figure 23-4.

^{0 =} Pin configured as a digital port



查询PIC18F67K90供应商

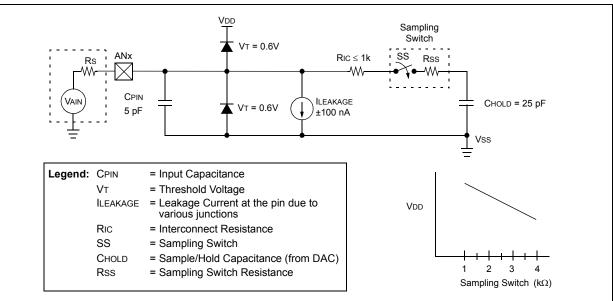
After the A/D module has been configured as desired, the selected channel must be acquired before the conversion can start. The analog input channels must have their corresponding TRIS bits selected as an input. To determine acquisition time, see Section 23.3 "A/D Acquisition Requirements". After this acquisition time has elapsed, the A/D conversion can be started. An acquisition time can be programmed to occur between setting the GO/DONE bit and the actual start of the conversion.

To do an A/D conversion, follow these steps:

- 1. Configure the A/D module:
 - Configure the required ADC pins as analog pins (ANCON0, ANCON1 and ANCON2)
 - Set the voltage reference (ADCON1)
 - Select the A/D positive and negative input channels (ADCON0 and ADCON1)
 - Select the A/D acquisition time (ADCON2)
 - Select the A/D conversion clock (ADCON2)
 - Turn on the A/D module (ADCON0)
- FIGURE 23-5: ANALOG INPUT MODEL

- 2. Configure the A/D interrupt (if desired):
 - Clear the ADIF bit (PIR1<6>)
 - Set the ADIE bit (PIE1<6>)
 - Set the GIE bit (INTCON<7>)
- 3. Wait the required acquisition time (if required).
- 4. Start the conversion:
 - Set the GO/DONE bit (ADCON0<1>)
- 5. Wait for A/D conversion to complete, by either:
 Polling for the GO/DONE bit to be cleared OR
 - Waiting for the A/D interrupt
- 6. Read A/D Result registers (ADRESH:ADRESL), and if required, clear bit, ADIF.
- 7. For the next conversion, begin with step 1 or 2, as required.

The A/D conversion time per bit is defined as TAD. Before the next acquisition starts, a minimum wait of 2 TAD is required.



查询PIC18F67K90供应商 23.3 A/D Acquisition Requirements

For the A/D Converter to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 23-5. The source impedance (Rs) and the internal sampling switch (Rss) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (Rss) impedance varies over the device voltage (VDD).

The source impedance affects the offset voltage at the analog input (due to pin leakage current). The maximum recommended impedance for analog sources is 2.5 k Ω . After the analog input channel is selected or changed, the channel must be sampled for at least the minimum acquisition time before starting a conversion.

Note:	When	the	conversion	is	started,	the
	holding	, capa	acitor is disco	nne	ected from	the
	input p	in.				

To calculate the minimum acquisition time, Equation 23-1 can be used. This equation assumes that 1/2 LSb error is used (1,024 steps for the A/D). The 1/2 LSb error is the maximum error allowed for the A/D to meet its specified resolution.

Equation 23-3 shows the calculation of the minimum required acquisition time, TACQ. This calculation is based on the following application system assumptions:

• CHOLD	=	25 pF
• Rs	=	2.5 kΩ
Conversion Error	\leq	1/2 LSb
• Vdd	=	$3V \rightarrow Rss = 2 \ k\Omega$
Temperature	=	85°C (system max.)

EQUATION 23-1: ACQUISITION TIME

TACQ	=	Amplifier Settling Time + Holding Capacitor Charging Time + Temperature Coefficient
	=	TAMP + TC + TCOFF

EQUATION 23-2: A/D MINIMUM CHARGING TIME

VHOLD	=	$(\text{VREF} - (\text{VREF}/2048)) \bullet (1 - e^{(-\text{TC/CHOLD}(\text{Ric} + \text{Rss} + \text{Rs}))})$
or		
TC	=	-(CHOLD)(RIC + RSS + RS) ln(1/2048)

EQUATION 23-3: CALCULATING THE MINIMUM REQUIRED ACQUISITION TIME

TACQ	=	TAMP + TC + TCOFF
TAMP	=	0.2 μs
TCOFF	=	(Temp – 25°C)(0.02 μs/°C) (85°C – 25°C)(0.02 μs/°C) 1.2 μs
Tempera	ature c	coefficient is only required for temperatures $> 25^{\circ}$ C. Below 25°C, TCOFF = 0 ms.
ТС	=	-(Chold)(Ric + Rss + Rs) $\ln(1/2048) \ \mu s$ -(25 pF) (1 k Ω + 2 k Ω + 2.5 k Ω) ln(0.0004883) μs 1.05 μs
TACQ	=	0.2 μs + 1.05 μs + 1.2 μs 2.45 μs

查询PIC18F67K90供应商

23.4 Selecting and Configuring Automatic Acquisition Time

The ADCON2 register allows the user to select an acquisition time that occurs each time the GO/\overline{DONE} bit is set.

When the GO/DONE bit is set, sampling is stopped and a conversion begins. The user is responsible for ensuring the required acquisition time has passed between selecting the desired input channel and setting the GO/DONE bit.

This occurs when the ACQT<2:0> bits (ADCON2<5:3>) remain in their Reset state ('000'), which is compatible with devices that do not offer programmable acquisition times.

If desired, the ACQTx bits can be set to select a programmable acquisition time for the A/D module. When the GO/DONE bit is set, the A/D module continues to sample the input for the selected acquisition time, then automatically begins a conversion. Since the acquisition time is programmed, there may be no need to wait for an acquisition time between selecting a channel and setting the GO/DONE bit.

In either case, when the conversion is completed, the GO/DONE bit is cleared, the ADIF flag is set and the A/D begins sampling the currently selected channel again. If an acquisition time is programmed, there is nothing to indicate if the acquisition time has ended or if the conversion has begun.

23.5 Selecting the A/D Conversion Clock

The A/D conversion time per bit is defined as TAD. The A/D conversion requires 14 TAD per 12-bit conversion. The source of the A/D conversion clock is software-selectable.

The possible options for TAD are:

- 2 Tosc
- 4 Tosc
- 8 Tosc
- 16 Tosc
- 32 Tosc
- 64 Tosc
- Using the internal RC Oscillator

For correct A/D conversions, the A/D conversion clock (TAD) must be as short as possible but greater than the minimum TAD. (For more information, see parameter 130 in Table 31-26.)

Table 23-1 shows the resultant TAD times derived from the device operating frequencies and the A/D clock source selected.

TABLE 23-1: TAD vs. DEVICE OPERATING FREQUENCIES

AD Clock S	Maximum	
Operation	ADCS<2:0>	Device Frequency
2 Tosc	000	2.86 MHz
4 Tosc	100	5.71 MHz
8 Tosc	001	11.43 MHz
16 Tosc	101	22.86 MHz
32 Tosc	010	40.00 MHz
64 Tosc	110	40.00 MHz
RC ⁽²⁾	x11	1.00 MHz ⁽¹⁾

Note 1: The RC source has a typical TAD time of 4 $\mu s.$

2: For device frequencies above 1 MHz, the device must be in Sleep mode for the entire conversion or the A/D accuracy may be out of specification.

23.6 Configuring Analog Port Pins

The ANCON0, ANCON1, ANCON2, TRISA, TRISF, TRISG and TRISH registers control the operation of the A/D port pins. The port pins needed as analog inputs must have their corresponding TRISx bits set (input). If the TRISx bit is cleared (output), the digital output level (VOH or VOL) will be converted.

The A/D operation is independent of the state of the CHS<3:0> bits and the TRISx bits.

- Note 1: When reading the PORT register, all pins configured as analog input channels will read as cleared (a low level). Pins configured as digital inputs will convert an analog input. Analog levels on a digitally configured input will be accurately converted.
 - 2: Analog levels on any pin defined as a digital input may cause the digital input buffer to consume current out of the device's specification limits.

查询PIC18F67K90供应商 23.7 A/D Conversions

Figure 23-6 shows the operation of the A/D Converter after the GO/DONE bit has been set and the ACQT<2:0> bits are cleared. A conversion is started after the following instruction to allow entry into Sleep mode before the conversion begins.

Figure 23-7 shows the operation of the A/D Converter after the GO/DONE bit has been set, the ACQT<2:0> bits set to '010' and a 4 TAD acquisition time selected.

Clearing the GO/DONE bit during a conversion will abort the current conversion. The A/D Result register pair will NOT be updated with the partially completed A/D conversion sample. This means the ADRESH:ADRESL registers will continue to contain the value of the last completed conversion (or the last value written to the ADRESH:ADRESL registers).

After the A/D conversion is completed or aborted, a 2 TAD wait is required before the next acquisition can be started. After this wait, acquisition on the selected channel is automatically started.

Note:	The GO/DONE bit should NOT be set in
	the same instruction that turns on the A/D.

FIGURE 23-6: A/D CONVERSION TAD CYCLES (ACQT<2:0> = 000, TACQ = 0)

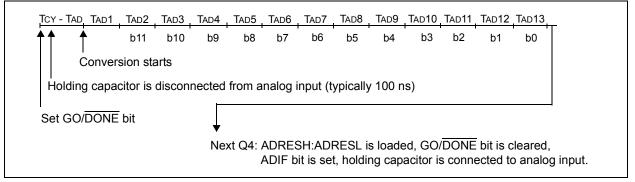
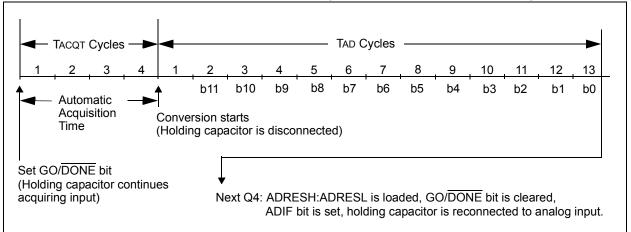


FIGURE 23-7: A/D CONVERSION TAD CYCLES (ACQT<2:0> = 010, TACQ = 4 TAD)



查询PIC18F67K90供应商

23.8 Use of the Special Event Triggers

A/D conversion can be started by the Special Event Trigger of any of these modules:

- ECCP2 Requires CCP2M<3:0> bits (CCP2CON<3:0>) set at '1011'
- CTMU Requires the setting of the CTTRIG bit (CTMUCONH<0>)
- Timer1
- RTCC
- To start an A/D conversion:
- The A/D module must be enabled (ADON = 1)
- The appropriate analog input channel selected
- The minimum acquisition period set one of these ways:
 - Timing provided by the user
 - Selection made of an appropriate TACQ time

With these conditions met, the trigger sets the GO/DONE bit and the A/D acquisition starts.

If the A/D module is not enabled (ADON = 0), the module ignores the Special Event Trigger.

Note: With an ECCP2 trigger, Timer1 or Timer3 is cleared. The timers reset to automatically repeat the A/D acquisition period with minimal software overhead (moving ADRESH:ADRESL to the desired location). If the A/D module is not enabled, the Special Event Trigger is ignored by the module, but the timer's counter resets.

23.9 Operation in Power-Managed Modes

The selection of the automatic acquisition time and A/D conversion clock is determined in part by the clock source and frequency while in a power-managed mode.

If the A/D is expected to operate while the device is in a power-managed mode, the ACQT<2:0> and ADCS<2:0> bits in ADCON2 should be updated in accordance with the power-managed mode clock that will be used.

After the power-managed mode is entered (either of the power-managed Run modes), an A/D acquisition or conversion may be started. Once an acquisition or conversion is started, the device should continue to be clocked by the same power-managed mode clock source until the conversion has been completed. If desired, the device may be placed into the corresponding power-managed Idle mode during the conversion.

If the power-managed mode clock frequency is less than 1 MHz, the A/D RC clock source should be selected.

Operation in Sleep mode requires that the A/D RC clock be selected. If bits, ACQT<2:0>, are set to '000' and a conversion is started, the conversion will be delayed one instruction cycle to allow execution of the SLEEP instruction and entry into Sleep mode. The IDLEN and SCS<1:0> bits in the OSCCON register must have already been cleared prior to starting the conversion.

查询PIC18F67K90供应商 TABLE 23-2: SUMMARY OF A/D REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR1	—	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	75
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	75
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	75
ADRESH	A/D Result	t Register H	igh Byte						74
ADRESL	A/D Result	t Register Lo	ow Byte						74
ADCON0	_	CHS4	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON	74
ADCON1	TRIGSEL1	TRIGSEL0	VCFG1	VCFG0	VNCFG	CHSN2	CHSN1	CHSN0	74
ADCON2	ADFM	—	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0	74
ANCON0	ANSEL7	ANSEL6	ANSEL5	ANSEL4	ANSEL3	ANSEL2	ANSEL1	ANSEL0	79
ANCON1	ANSEL15	ANSEL14	ANSEL13	ANSEL12	ANSEL11	ANSEL10	ANSEL9	ANSEL8	79
ANCON2	ANSEL23	ANSEL22	ANSEL21	ANSEL20	ANSEL19	ANSEL18	ANSEL17	ANSEL16	79
CCP2CON	P2M1	P2M0	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	78
PORTA	RA7 ⁽²⁾	RA6 ⁽²⁾	RA5	RA4	RA3	RA2	RA1	RA0	76
TRISA	TRISA7 ⁽²⁾	TRISA6 ⁽²⁾	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	76
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	76
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	76
PORTG	—	—	RG5/ LATG5 ⁽³⁾	RG4	RG3	RG2	RG1	RG0	76
TRISG	_	_	_	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	76
PORTH ⁽¹⁾	RH7	RH6	RH5	RH4	RH3	RH2	RH1	RH0	76
TRISH ⁽¹⁾	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	76

Legend: — = unimplemented, read as '0'. Shaded cells are not used for A/D conversion.

Note 1: This register is not implemented on 64-pin devices.

2: These bits are available only in certain oscillator modes, when the OSC2 Configuration bit = 0. If that Configuration bit is cleared, this signal is not implemented.

3: Bit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, bit is unimplemented.

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商 24.0 COMPARATOR MODULE

The analog comparator module contains three comparators that can be independently configured in a variety of ways. The inputs can be selected from the analog inputs and two internal voltage references. The digital outputs are available at the pin level and can also be read through the control register. Multiple output and interrupt event generation are also available. A generic single comparator from the module is shown in Figure 24-1.

Key features of the module includes:

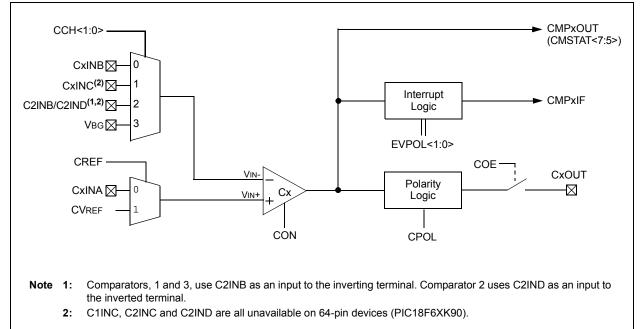
- · Independent comparator control
- · Programmable input configuration
- · Output to both pin and register levels
- · Programmable output polarity
- Independent interrupt generation for each comparator with configurable interrupt-on-change

24.1 Registers

The CMxCON registers (CM1CON, CM2CON and CM3CON) select the input and output configuration for each comparator, as well as the settings for interrupt generation (see Register 24-1).

The CMSTAT register (Register 24-2) provides the output results of the comparators. The bits in this register are read-only.





查询PIC18F67K90供应商

REGISTER 24-1: CMxCON: COMPARATOR CONTROL x REGISTER

R/W-0	R/W-0	R/W-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1			
CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0			
bit 7	ł						bit (
Legend:										
R = Reada	abla bit	W = Writable	hit		opted bit read	aa '0'				
-n = Value		'1' = Bit is set		0 – Onimpien 0' = Bit is clea	nented bit, read	x = Bit is unkn	0.000			
-n = value	alPUR	I = DILIS SEL			areu		IOWII			
bit 7	CON: Compa	rator Enable bi	t							
	•	tor is enabled								
		tor is disabled								
bit 6	COE: Compa	rator Output Er	nable bit							
		tor output is pre		xOUT pin						
	•	tor output is inte	-							
bit 5	•	POL: Comparator Output Polarity Select bit								
		 1 = Comparator output is inverted 0 = Comparator output is not inverted 								
L:1 0	•	•								
bit 4-3		 Interrupt Pola generation on 	•							
		U	, ,	w transition of t	he output					
		U	, ,	gh transition of t						
	00 = Interrup	t generation is o	disabled							
bit 2	CREF: Comp	arator Referen	ce Select bit (r	non-inverting inp	out)					
		• •		ernal CVREF volt	age					
		ting input conn		-						
bit 1-0		Comparator Cha								
		y input of comparing input of comparing the second s		s to VBG s to the C2INB	or C2IND pin(2	,3)				
				s to the CxINC		-				
				s to the CxINB						
Note 1:	The CMPxIF bit is after the initial co		set any time th	is mode is seled	cted and must l	be cleared by t	he application			
		0								

3: C1INC, C2INC and C2IND are all unavailable for 64-pin devices (PIC18F6XK90).

查询PIC18F67K90供应商

REGISTER 24-2: CMSTAT: COMPARATOR STATUS REGISTER

R-1	R-1	R-1	U-0	U-0	U-0	U-0	U-0
CMP3OUT	CMP2OUT	CMP1OUT	_	_		—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

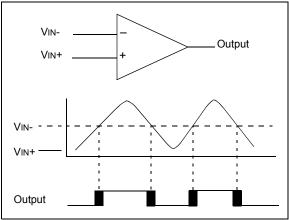
bit 7-5	CMPxOUT<3:1>: Comparator x Status bits
	If CPOL (CMxCON<5>)= 0 (non-inverted polarity):
	1 = Comparator x's VIN+ > VIN-
	0 = Comparator x's VIN+ < VIN-
	If CPOL = 1 (inverted polarity):
	1 = Comparator x's VIN+ < VIN-
	0 = Comparator x's VIN+ > VIN-

bit 4-0 Unimplemented: Read as '0'

查询PIC18F67K90供应商 24.2 Comparator Operation

A single comparator is shown in Figure 24-2, along with the relationship between the analog input levels and the digital output. When the analog input at VIN+ is less than the analog input, VIN-, the output of the comparator is a digital low level. When the analog input at VIN+ is greater than the analog input, VIN-, the output of the comparator is a digital high level. The shaded areas of the output of the comparator in Figure 24-2 represent the uncertainty due to input offsets and response time.

FIGURE 24-2: SINGLE COMPARATOR



24.3 Comparator Response Time

Response time is the minimum time, after selecting a new reference voltage or input source, before the comparator output has a valid level. The response time of the comparator differs from the settling time of the voltage reference. Therefore, both of these times must be considered when determining the total response to a comparator input change. Otherwise, the maximum delay of the comparators should be used (see **Section 31.0 "Electrical Characteristics"**).

24.4 Analog Input Connection Considerations

A simplified circuit for an analog input is shown in Figure 24-3. Since the analog pins are connected to a digital output, they have reverse biased diodes to VDD and VSS. The analog input, therefore, must be between VSS and VDD. If the input voltage deviates from this range by more than 0.6V in either direction, one of the diodes is forward biased and a latch-up condition may occur.

A maximum source impedance of $10 \text{ k}\Omega$ is recommended for the analog sources. Any external component connected to an analog input pin, such as a capacitor or a Zener diode, should have very little leakage current.

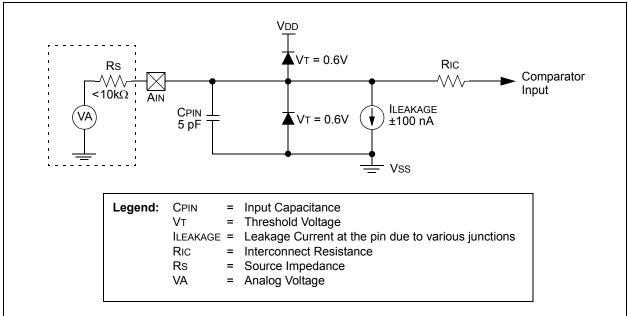


FIGURE 24-3: COMPARATOR ANALOG INPUT MODEL

查询PIC18F67K90供应商

24.5 Comparator Control and Configuration

Each comparator has up to eight possible combinations of inputs: up to four external analog inputs and one of two internal voltage references.

All of the comparators allow a selection of the signal from pin, CxINA, or the voltage from the Comparator Voltage Reference (CVREF) on the non-inverting channel. This is compared to either CxINB, CxINC, C2INB/C2IND or the microcontroller's fixed internal reference voltage (VBG, 1.024V nominal) on the inverting channel. The comparator inputs and outputs are tied to fixed I/O pins, defined in Table 24-1. The available comparator configurations and their corresponding bit settings are shown in Figure 24-4.

TABLE 24-1:	COMPARATOR INPUTS AND
	OUTPUTS

Comparator	Input or Output	I/O Pin			
	C1INA (VIN+)	RF6			
	C1INB (VIN-)	RF5			
1	C1INC ⁽¹⁾ (VIN-)	RH6			
	C2INB (VIN-)	RF3			
	C1OUT	RF2			
	C2INA (VIN+)	RF4			
	C2INB (VIN-)	RF3			
2	C2INC ⁽¹⁾ (VIN-)	RH4			
	C2IND ⁽¹⁾ (VIN-)	RH5			
	C2OUT	RF1			
	C3INA (VIN+)	RG2			
3	C3INB (VIN-)	RG3			
	C3INC (VIN-)	RG4			
	C2INB (VIN-)	RF3			
	C3OUT	RG1			

Note 1: C1INC, C2INC and C2IND are all unavailable for 64-pin devices (PIC18F6XK90).

24.5.1 COMPARATOR ENABLE AND INPUT SELECTION

Setting the CON bit of the CMxCON register (CMxCON<7>) enables the comparator for operation. Clearing the CON bit disables the comparator, resulting in minimum current consumption.

The CCH<1:0> bits in the CMxCON register (CMxCON<1:0>) direct either one of three analog input pins, or the Internal Reference Voltage (VBG), to the comparator, VIN-. Depending on the comparator

operating mode, either an external or internal voltage reference may be used. For external analog pins that are unavailable in 64-pin devices (C1INC, C2INC and C2IND), the corresponding configurations that use them as inputs are unavailable.

The analog signal present at VIN- is compared to the signal at VIN+ and the digital output of the comparator is adjusted accordingly.

The external reference is used when CREF = 0 (CMxCON<2>) and VIN+ is connected to the CxINA pin. When external voltage references are used, the comparator module can be configured to have the reference sources externally. The reference signal must be between Vss and VDD and can be applied to either pin of the comparator.

The comparator module also allows the selection of an internally generated voltage reference from the Comparator Voltage Reference (CVREF) module. This module is described in more detail in **Section 25.0 "Comparator Voltage Reference Module**". The reference from the comparator voltage reference module is only available when CREF = 1. In this mode, the internal voltage reference is applied to the comparator's VIN+ pin.

Note:	The comparator input pin selected by
	CCH<1:0> must be configured as an input
	by setting both the corresponding TRISF,
	TRISG or TRISH bit and the corresponding
	ANSELx bit in the ANCONx register.

24.5.2 COMPARATOR ENABLE AND OUTPUT SELECTION

The comparator outputs are read through the CMSTAT register. The CMSTAT<5> bit reads the Comparator 1 output, CMSTAT<6> reads Comparator 2 output and CMSTAT<7> reads Comparator 3 output. These bits are read-only.

The comparator outputs may also be directly output to the RF2, RF1 and RG1 I/O pins by setting the COE bit (CMxCON<6>). When enabled, multiplexers in the output path of the pins switch to the output of the comparator. While in this mode, the TRISF<2:1> and TRISG<1> bits still function as the digital output enable bits for the RF2, RF1 and RG1 pins.

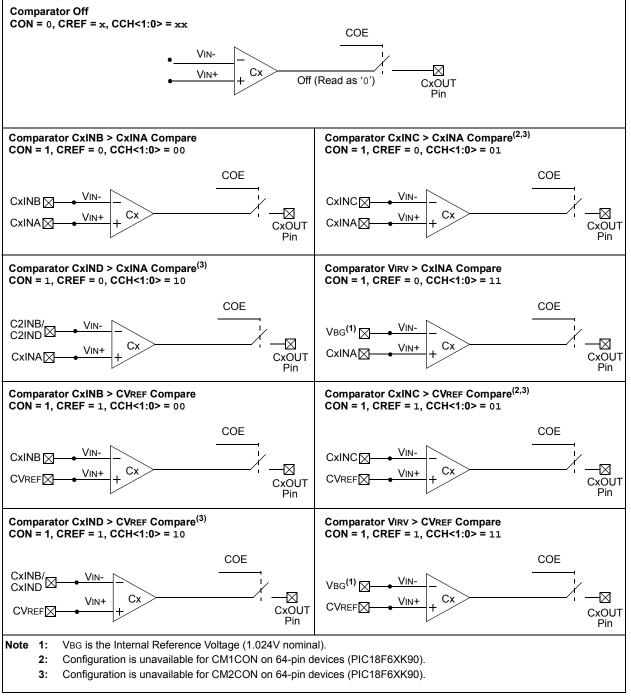
By default, the comparator's output is at logic high whenever the voltage on VIN+ is greater than on VIN-. The polarity of the comparator outputs can be inverted using the CPOL bit (CMxCON<5>).

The uncertainty of each of the comparators is related to the input offset voltage and the response time given in the specifications, as discussed in **Section 24.2 "Comparator Operation"**.

查询PIC18F67K90供应商

FIGURE 24-4: COMPARATOR CONFIGURATIONS





查询PIC18F67K90供应商

24.6 Comparator Interrupts

The comparator interrupt flag is set whenever any of the following occurs:

- · Low-to-high transition of the comparator output
- High-to-low transition of the comparator output
- Any change in the comparator output

The comparator interrupt selection is done by the EVPOL<1:0> bits in the CMxCON register (CMxCON<4:3>).

In order to provide maximum flexibility, the output of the comparator may be inverted using the CPOL bit in the CMxCON register (CMxCON<5>). This is functionally identical to reversing the inverting and non-inverting inputs of the comparator for a particular mode.

An interrupt is generated on the low-to-high or high-tolow transition of the comparator output. This mode of interrupt generation is dependent on EVPOL<1:0> in the CMxCON register. When EVPOL<1:0> = 01 or 10, the interrupt is generated on a low-to-high or high-tolow transition of the comparator output. Once the interrupt is generated, it is required to clear the interrupt flag by software. When EVPOL<1:0> = 11, the comparator interrupt flag is set whenever there is a change in the output value of either comparator. Software will need to maintain information about the status of the output bits, as read from CMSTAT<7:5>, to determine the actual change that occurred.

The CMPxIF bits (PIR6<2:0>) are the Comparator Interrupt Flags. The CMPxIF bits must be reset by clearing them. Since it is also possible to write a '1' to this register, a simulated interrupt may be initiated. Table 24-2 shows the interrupt generation with respect to comparator input voltages and EVPOL bit settings.

Both the CMPxIE bits (PIE6<2:0>) and the PEIE bit (INTCON<6>) must be set to enable the interrupt. In addition, the GIE bit (INTCON<7>) must also be set. If any of these bits are clear, the interrupt is not enabled, though the CMPxIF bits will still be set if an interrupt condition occurs.

A simplified diagram of the interrupt section is shown in Figure 24-3.

Note: CMPxIF will not be set when EVPOL<1:0> = 00.

CPOL	EVPOL<1:0>	Comparator Input Change	CxOUT Transition	Interrupt Generated
	0.0	VIN+ > VIN-	Low-to-High	No
	00	VIN+ < VIN-	High-to-Low	No
	01	VIN+ > VIN-	Low-to-High	Yes
0	01	VIN+ < VIN-	High-to-Low	No
0	10	VIN+ > VIN-	Low-to-High	No
	10	VIN+ < VIN-	High-to-Low	Yes
	11	VIN+ > VIN-	Low-to-High	Yes
		VIN+ < VIN-	High-to-Low	Yes
	00	VIN+ > VIN-	High-to-Low	No
		VIN+ < VIN-	Low-to-High	No
	01	VIN+ > VIN-	High-to-Low	No
1		VIN+ < VIN-	Low-to-High	Yes
	10	VIN+ > VIN-	High-to-Low	Yes
		VIN+ < VIN-	Low-to-High	No
	11	VIN+ > VIN-	High-to-Low	Yes
	11	VIN+ < VIN-	Low-to-High	Yes

TABLE 24-2: COMPARATOR INTERRUPT GENERATION

查询PIC18F67K90供应商

24.7 Comparator Operation During Sleep

When a comparator is active and the device is placed in Sleep mode, the comparator remains active and the interrupt is functional, if enabled. This interrupt will wake-up the device from Sleep mode, when enabled. Each operational comparator will consume additional current. To minimize power consumption while in Sleep mode, turn off the comparators (CON = 0) before entering Sleep. If the device wakes up from Sleep, the contents of the CMxCON register are not affected.

24.8 Effects of a Reset

A device Reset forces the CMxCON registers to their Reset state. This forces both comparators and the voltage reference to the OFF state.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR6	_	_	_	EEIF	_	CMP3IF	CMP2IF	CMP1IF	75
PIE6		_	_	EEIE	_	CMP3IE	CMP2IE	CMP1IE	78
IPR6	_	_	_	EEIP	_	CMP3IP	CMP2IP	CMP1IP	75
CM1CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	78
CM2CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	79
CM3CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	79
CVRCON	CVREN	CVROE	CVRSS	CVR4	CVR3	CVR2	CVR1	CVR0	75
CMSTAT	CMP3OUT	CMP2OUT	CMP1OUT		—	_	—	_	75
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	76
LATF	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1	_	76
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	—	76
PORTG	_	_	RG5	RG4	RG3	RG2	RG1	RG0	76
LATG	_	_	_	LATG4	LATG3	LATG2	LATG1	LATG0	76
TRISG			_	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	76
PORTH	RH7	RH6	RH5	RH4	RH3	RH2	RH1	RH0	76
LATH	LATH7	LATH6	LATH5	LATH4	LATH3	LATH2	LATH1	LATH0	76
TRISH	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	76

TABLE 24-3: REGISTERS ASSOCIATED WITH COMPARATOR MODULE

Legend: — = unimplemented, read as '0'.

查询PIC18F67K90供应商

25.0 COMPARATOR VOLTAGE REFERENCE MODULE

The comparator voltage reference is a 32-tap resistor ladder network that provides a selectable reference voltage. Although its primary purpose is to provide a reference for the analog comparators, it may also be used independently of them.

A block diagram of the module is shown in Figure 25-1. The resistor ladder is segmented to provide a range of CVREF values and has a power-down function to conserve power when the reference is not being used. The module's supply reference can be provided from either device VDD/VSS or an external voltage reference.

25.1 Configuring the Comparator Voltage Reference

The comparator voltage reference module is controlled through the CVRCON register (Register 25-1). The comparator voltage reference provides a range of output voltage with 32 levels.

The CVR<4:0> selection bits (CVRCON<4:0>) offer a range of output voltages. Equation 25-1 shows how the comparator voltage reference is computed.

EQUATION 25-1:

If CVRSS = 1:

 $CVREF = (VREF-) + (CVR < 4:0 > /32) \cdot (VREF+ - VREF-)$

If CVRSS = 0:

 $C_{VREF} = (AVSS) + (CVR < 4:0 > /32) \cdot (AVDD - AVSS)$

The comparator reference supply voltage can come from either VDD and VSS, or the external VREF+ and VREF- that are multiplexed with RA3 and RA2. The voltage source is selected by the CVRSS bit (CVRCON<5>).

The settling time of the comparator voltage reference must be considered when changing the CVREF output (see Table 31-2 in **Section 31.0 "Electrical Characteristics"**).

REGISTER 25-1: CVRCON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER

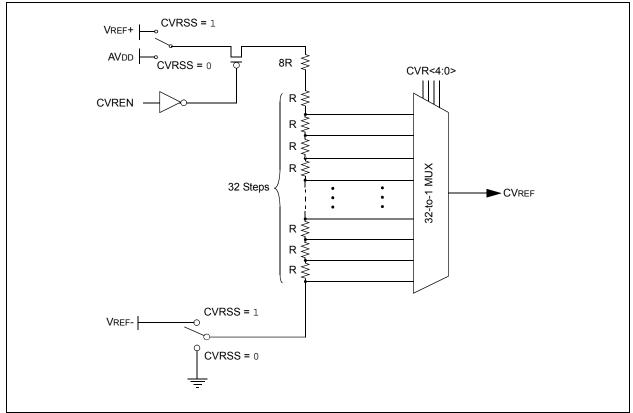
| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| CVREN | CVROE | CVRSS | CVR4 | CVR3 | CVR2 | CVR1 | CVR0 |
| bit 7 | • | | | | | | bit 0 |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

CVREN: Comparator Voltage Reference Enable bit 1 = CVREF circuit is powered on 0 = CVREF circuit is powered down
CVROE: Comparator VREF Output Enable bit
 1 = CVREF voltage level is output on the CVREF pin 0 = CVREF voltage level is disconnected from the CVREF pin
CVRSS: Comparator VREF Source Selection bit
 1 = Comparator reference source, CVRSRC = VREF+ – VREF- 0 = Comparator reference source, CVRSRC = AVDD – AVSS
CVR<4:0>: Comparator VREF Value Selection ($0 \le CVR<4:0> \le 31$) bits
When CVRSS = 1:
CVREF = (VREF-) + (CVR<4:0>/32) • (VREF+ – VREF-)
$\frac{\text{When CVRSS} = 0}{2}$
$CVREF = (AVSS) + (CVR<4:0>/32) \bullet (AVDD - AVSS)$

查询PIC18F67K90供应商

FIGURE 25-1: COMPARATOR VOLTAGE REFERENCE BLOCK DIAGRAM



25.2 Voltage Reference Accuracy/Error

The full range of voltage reference cannot be realized due to the construction of the module. The transistors on the top and bottom of the resistor ladder network (Figure 25-1) keep CVREF from approaching the reference source rails. The voltage reference is derived from the reference source; therefore, the CVREF output changes with fluctuations in that source. The tested absolute accuracy of the voltage reference can be found in **Section 31.0 "Electrical Characteristics"**.

25.3 Operation During Sleep

When the device wakes up from Sleep through an interrupt or a Watchdog Timer time-out, the contents of the CVRCON register are not affected. To minimize current consumption in Sleep mode, the voltage reference should be disabled.

25.4 Effects of a Reset

A device Reset disables the voltage reference by clearing bit, CVREN (CVRCON<7>). This Reset also disconnects the reference from the RF5 pin by clearing bit, CVROE (CVRCON<6>).

25.5 Connection Considerations

The voltage reference module operates independently of the comparator module. The output of the reference generator may be connected to the RF5 pin if the CVROE bit is set. Enabling the voltage reference output onto RF5 when it is configured as a digital input will increase current consumption. Connecting RF5 as a digital output with CVRSS enabled will also increase current consumption.

The RF5 pin can be used as a simple D/A output with limited drive capability. Due to the limited current drive capability, a buffer must be used on the voltage reference output for external connections to VREF. Figure 25-2 shows an example buffering technique.

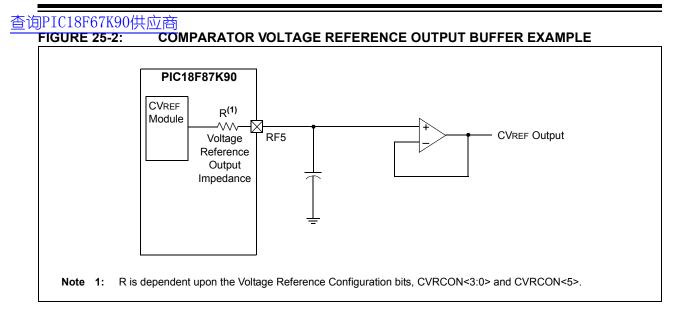


TABLE 25-1	: REGIS	STERS AS	SOCIATE	D WITH O	COMPARA	TOR VOL	TAGE REF	ERENCE	
									F

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
CVRCON	CVREN	CVROE	CVRSS	CVR4	CVR3	CVR2	CVR1	CVR0	75
CM1CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	78
CM2CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	79
CM3CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	79
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1		76

Legend: — = unimplemented, read as '0'. Shaded cells are not used with the comparator voltage reference.

查询PIC18F67K90供应商 NOTES:

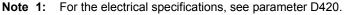
查询PIC18F67K90供应商 **26.0 HIGH/LOW-VOLTAGE DETECT** (HLVD)

The PIC18F87K90 family of devices has a High/Low-Voltage Detect module (HLVD). This is a programmable circuit that sets both a device voltage trip point and the direction of change from that point. If the device experiences an excursion past the trip point in that direction, an interrupt flag is set. If the interrupt is enabled, the program execution branches to the interrupt vector address and the software responds to the interrupt. The High/Low-Voltage Detect Control register (Register 26-1) completely controls the operation of the HLVD module. This allows the circuitry to be "turned off" by the user under software control, which minimizes the current consumption for the device.

The module's block diagram is shown in Figure 26-1.

REGISTER 26-1: HLVDCON: HIGH/LOW-VOLTAGE DETECT CONTROL REGISTER

R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-1	R/W-0	R/W-0			
VDIRMAG	BGVST	IRVST	HLVDEN	HLVDL3 ⁽¹⁾	HLVDL2 ⁽¹⁾	HLVDL1 ⁽¹⁾	HLVDL0 ⁽¹⁾			
bit 7							bit 0			
Legend:										
R = Readable	e bit	W = Writable	bit	U = Unimpler	nented bit, read	l as '0'				
-n = Value at	POR	'1' = Bit is set	1	'0' = Bit is cle	ared	x = Bit is unkr	nown			
bit 7		oltage Directio	•							
					oint (HLVDL<3:0 point (HLVDL<					
bit 6	BGVST: Ban	BGVST: Band Gap Reference Voltages Stable Status Flag bit								
	 1 = Internal band gap voltage references are stable 0 = Internal band gap voltage references are not stable 									
bit 5	IRVST: Internal Reference Voltage Stable Flag bit									
			•	•	e interrupt flag	at the specified	voltage range			
	0 = Indicates	that the voltage	ge detect logic	•	ate the interrup	•	• •			
bit 4	•	gh/Low-Voltage	•							
	1 = HLVD is 0 = HLVD is	enabled								
bit 3-0	HLVDL<3:0>	: Voltage Dete	ction Limit bits	(1)						
	1111 = Exte r 1110 = Maxi i	• •	ut is used (inp	ut comes from	the HLVDIN pir	1)				
		num setting								
	0000 = Minin	num setting								
Note 1. Fr	or the electrical s	Ū.	oo poromotor	- 0420						



查询PIC18F67K90供应商

The module is enabled by setting the HLVDEN bit (HLVDCON<4>). Each time the HLVD module is enabled, the circuitry requires some time to stabilize. The IRVST bit (HLVDCON<5>) is a read-only bit used to indicate when the circuit is stable. The module can only generate an interrupt after the circuit is stable and IRVST is set.

The VDIRMAG bit (HLVDCON<7>) determines the overall operation of the module. When VDIRMAG is cleared, the module monitors for drops in VDD below a predetermined set point. When the bit is set, the module monitors for rises in VDD above the set point.

26.1 Operation

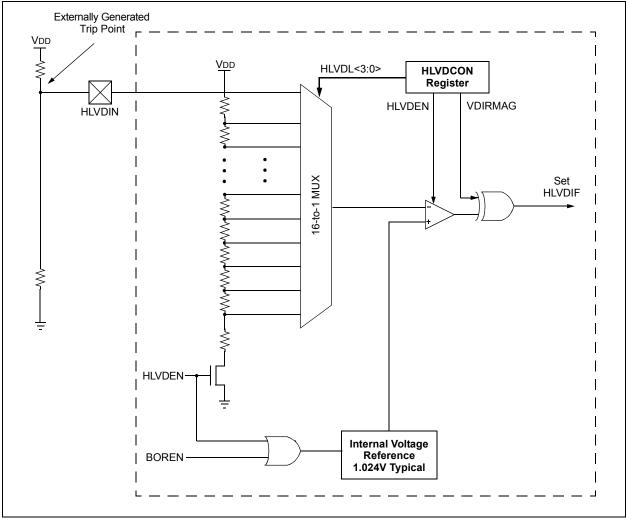
When the HLVD module is enabled, a comparator uses an internally generated reference voltage as the set point. The set point is compared with the trip point, where each node in the resistor divider represents a trip point voltage. The "trip point" voltage is the voltage level at which the device detects a high or low-voltage event, depending on the configuration of the module.

When the supply voltage is equal to the trip point, the voltage tapped off of the resistor array is equal to the internal reference voltage generated by the voltage reference module. The comparator then generates an interrupt signal by setting the HLVDIF bit.

The trip point voltage is software programmable to any of 16 values. The trip point is selected by programming the HLVDL<3:0> bits (HLVDCON<3:0>).

The HLVD module has an additional feature that allows the user to supply the trip voltage to the module from an external source. This mode is enabled when bits, HLVDL<3:0>, are set to '1111'. In this state, the comparator input is multiplexed from the external input pin, HLVDIN. This gives users the flexibility of configuring the High/Low-Voltage Detect interrupt to occur at any voltage in the valid operating range.





查询PIC18F67K90供应商 26.2 HLVD Setup

To set up the HLVD module:

- 1. Select the desired HLVD trip point by writing the value to the HLVDL<3:0> bits.
- 2. Set the VDIRMAG bit to detect high voltage (VDIRMAG = 1) or low voltage (VDIRMAG = 0).
- 3. Enable the HLVD module by setting the HLVDEN bit.
- 4. Clear the HLVD interrupt flag (PIR2<2>), which may have been set from a previous interrupt.
- If interrupts are desired, enable the HLVD interrupt by setting the HLVDIE and GIE bits (PIE2<2> and INTCON<7>, respectively).

An interrupt will not be generated until the IRVST bit is set.

Note: Before changing any module settings (VDIRMAG, HLVDL<3:0>), first disable the module (HLVDEN = 0), make the changes and re-enable the module. This prevents the generation of false HLVD events.

26.3 Current Consumption

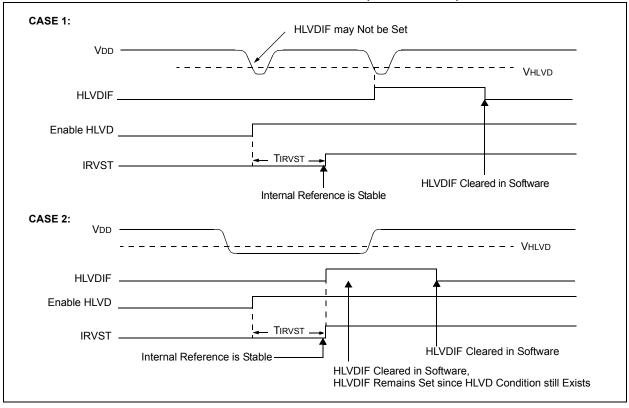
When the module is enabled, the HLVD comparator and voltage divider are enabled and consume static current. The total current consumption, when enabled, is specified in electrical specification parameter D022B (Table 31-10). Depending on the application, the HLVD module does not need to operate constantly. To reduce current requirements, the HLVD circuitry may only need to be enabled for short periods where the voltage is checked. After such a check, the module could be disabled.

26.4 HLVD Start-up Time

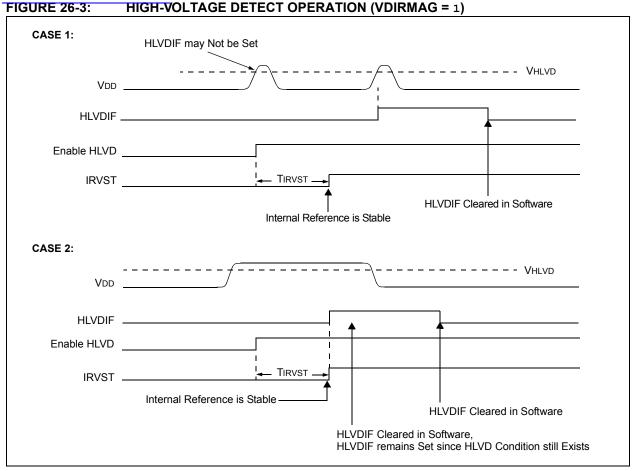
The internal reference voltage of the HLVD module, specified in electrical specification parameter 37 (Section 31.0 "Electrical Characteristics"), may be used by other internal circuitry, such as the programmable Brown-out Reset. If the HLVD or other circuits using the voltage reference are disabled to lower the device's current consumption, the reference voltage circuit will require time to become stable before a low or high-voltage condition can be reliably detected. This start-up time, TIRVST, is an interval that is independent of device clock speed. It is specified in electrical specification parameter 36 (Table 31-10).

The HLVD interrupt flag is not enabled until TIRVST has expired and a stable reference voltage is reached. For this reason, brief excursions beyond the set point may not be detected during this interval (see Figure 26-2 or Figure 26-3).

FIGURE 26-2: LOW-VOLTAGE DETECT OPERATION (VDIRMAG = 0)



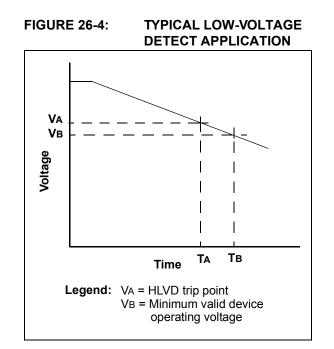
查询PIC18F67K90供应商



26.5 Applications

In many applications, it is desirable to detect a drop below, or rise above, a particular voltage threshold. For example, the HLVD module could be periodically enabled to detect Universal Serial Bus (USB) attach or detach. This assumes the device is powered by a lower voltage source than the USB when detached. An attach would indicate a high-voltage detect from, for example, 3.3V to 5V (the voltage on USB) and vice versa for a detach. This feature could save a design a few extra components and an attach signal (input pin).

For general battery applications, Figure 26-4 shows a possible voltage curve. Over time, the device voltage decreases. When the device voltage reaches voltage, VA, the HLVD logic generates an interrupt at time, TA. The interrupt could cause the execution of an ISR, which would allow the application to perform "house-keeping tasks" and a controlled shutdown before the device voltage exits the valid operating range at TB. This would give the application a time window, represented by the difference between TA and TB, to safely exit.



查询PIC18F67K90供应商

26.6 Operation During Sleep

When enabled, the HLVD circuitry continues to operate during Sleep. If the device voltage crosses the trip point, the HLVDIF bit will be set and the device will wake-up from Sleep. Device execution will continue from the interrupt vector address if interrupts have been globally enabled.

26.7 Effects of a Reset

A device Reset forces all registers to their Reset state. This forces the HLVD module to be turned off.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
HLVDCON	VDIRMAG	BGVST	IRVST	HLVDEN	HLVDL3	HLVDL2	HLVDL1	HLVDL0	75
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	73
PIR2	OSCFIF	—	SSP2IF	BLC2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF	75
PIE2	OSCFIE	—	SSP2IE	BLC2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	75
IPR2	OSCFIP	_	SSP2IP	BLC2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP	75
TRISA	TRISA7 ⁽¹⁾	TRISA6 ⁽¹⁾	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	76

TABLE 26-1: REGISTERS ASSOCIATED WITH HIGH/LOW-VOLTAGE DETECT MODULE

Legend: — = unimplemented, read as '0'. Shaded cells are unused by the HLVD module.

Note 1: PORTA<7:6> and their direction bits are individually configured as port pins based on various primary oscillator modes. When disabled, these bits read as '0'.

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商

27.0 CHARGE TIME MEASUREMENT UNIT (CTMU)

The Charge Time Measurement Unit (CTMU) is a flexible analog module that provides accurate differential time measurement between pulse sources, as well as asynchronous pulse generation. By working with other on-chip analog modules, the CTMU can precisely measure time, capacitance and relative changes in capacitance or generate output pulses with a specific time delay. The CTMU is ideal for interfacing with capacitive-based sensors.

The module includes these key features:

- Up to 24 channels available for capacitive or time measurement input
- · On-chip precision current source
- Four-edge input trigger sources
- Polarity control for each edge source
- Control of edge sequence

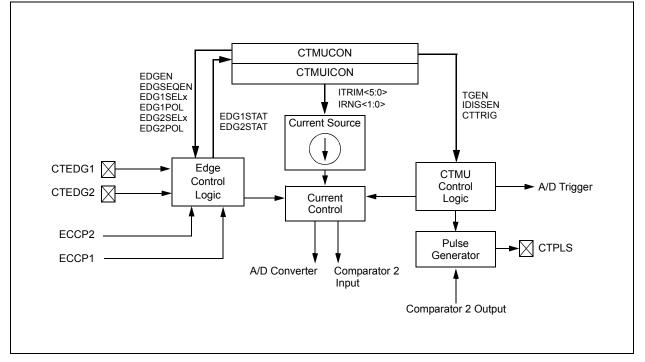
FIGURE 27-1: CTMU BLOCK DIAGRAM

- Control of response to edges
- · Time measurement resolution of 1 nanosecond
- · High-precision time measurement
- Time delay of external or internal signal asynchronous to system clock
- Accurate current source suitable for capacitive measurement

The CTMU works in conjunction with the A/D Converter to provide up to 24 channels for time or charge measurement, depending on the specific device and the number of A/D channels available. When configured for time delay, the CTMU is connected to one of the analog comparators. The level-sensitive input edge sources can be selected from four sources: two external inputs or the ECCP1/ECCP2 Special Event Triggers.

The CTMU special event can trigger the Analog-to-Digital Converter module.

Figure 27-1 provides a block diagram of the CTMU.



查询PIC18F67K90供应商 27.1 CTMU Registers

The control registers for the CTMU are:

- CTMUCONH
- CTMUCONL
- CTMUICON

The CTMUCONH and CTMUCONL registers (Register 27-1 and Register 27-2) contain control bits for configuring the CTMU module edge source selection, edge source polarity selection, edge sequencing, A/D trigger, analog circuit capacitor discharge and enables. The CTMUICON register (Register 27-3) has bits for selecting the current source range and current source trim.

REGISTER 27-1: CTMUCONH: CTMU CONTROL HIGH REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CTMUEN	—	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	CTTRIG
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	CTMUEN: CTMU Enable bit
	1 = Module is enabled0 = Module is disabled
bit 6	Unimplemented: Read as '0'
bit 5	CTMUSIDL: Stop in Idle Mode bit
	1 = Discontinue module operation when device enters Idle mode0 = Continue module operation in Idle mode
bit 4	TGEN: Time Generation Enable bit
	1 = Enables edge delay generation0 = Disables edge delay generation
bit 3	EDGEN: Edge Enable bit
	1 = Edges are not blocked0 = Edges are blocked
bit 2	EDGSEQEN: Edge Sequence Enable bit
	 1 = Edge 1 event must occur before Edge 2 event can occur 0 = No edge sequence is needed
bit 1	IDISSEN: Analog Current Source Control bit
	1 = Analog current source output is grounded0 = Analog current source output is not grounded
bit 0	CTTRIG: Trigger Control bit 1 = Trigger output is enabled 0 = Trigger output is disabled

查询PIC18F67K90供应商 REGISTER 27-2: CTMUCONL: CTMU CONTROL LOW REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
EDG2POL	EDG2SEL1	EDG2SEL0	EDG1POL	EDG1SEL1	EDG1SEL0	EDG2STAT	EDG1STAT
bit 7	•						bit 0

Legend:								
R = Readable bit -n = Value at POR		W = Writable bit	U = Unimplemented bit	, read as '0'				
		'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown				
bit 7	EDG2PO	L: Edge 2 Polarity Select bit	t					
		 Edge 2 is programmed for a positive edge response Edge 2 is programmed for a negative edge response 						
bit 6-5	EDG2SE	L<1:0>: Edge 2 Source Sele	ect bits					
		•						
bit 4	EDG1PO	L: Edge 1 Polarity Select bit	t					
	•	e 1 is programmed for a posi e 1 is programmed for a nega	•					
bit 3-2	EDG1SE	L<1:0>: Edge 1 Source Sele	ect bits					
		•						
bit 1	EDG2ST	AT: Edge 2 Status bit						
	•	e 2 event has occurred e 2 event has not occurred						
bit 0	1 = Edge	AT: Edge 1 Status bit e 1 event has occurred e 1 event has not occurred						

查询PIC18F67K90供应商 REGISTER 27-3: CTMUICON: CTMU CURRENT CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
ITRIM5	ITRIM4	ITRIM3	ITRIM2	ITRIM1	ITRIM0	IRNG1	IRNG0	
bit 7							bit C	
Legend:								
R = Readab	le bit	W = Writable	bit	U = Unimplem	nented bit, read	d as '0'		
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unki	nown	
011111 = Maximum positive change from nominal current 011110								
	000001 = Minimum positive change from nominal current 000000 = Nominal current output specified by IRNG<1:0> 111111 = Minimum negative change from nominal current							
		•	•	nominal currer	nt			
bit 1-0	0 IRNG<1:0>: Current Source Range Select bits 11 = 100 x Base Current 10 = 10 x Base Current							

- 01 = Base current level (0.55 μ A nominal) 00 = Current source disabled

查询PIC18F67K90供应商

27.2 CTMU Operation

The CTMU works by using a fixed current source to charge a circuit. The type of circuit depends on the type of measurement being made.

In the case of charge measurement, the current is fixed and the amount of time the current is applied to the circuit is fixed. The amount of voltage read by the A/D becomes a measurement of the circuit's capacitance.

In the case of time measurement, the current, as well as the capacitance of the circuit, is fixed. In this case, the voltage read by the A/D is representative of the amount of time elapsed from the time the current source starts and stops charging the circuit.

If the CTMU is being used as a time delay, both capacitance and current source are fixed, as well as the voltage supplied to the comparator circuit. The delay of a signal is determined by the amount of time it takes the voltage to charge to the comparator threshold voltage.

27.2.1 THEORY OF OPERATION

The operation of the CTMU is based on the equation for charge:

 $C = I \bullet \frac{dV}{dT}$

More simply, the amount of charge measured in coulombs in a circuit is defined as current in amperes (I) multiplied by the amount of time in seconds that the current flows (t). Charge is also defined as the capacitance in farads (C) multiplied by the voltage of the circuit (V). It follows that:

 $I \bullet t = C \bullet V$

The CTMU module provides a constant, known current source. The A/D Converter is used to measure (V) in the equation, leaving two unknowns: capacitance (C) and time (t). The above equation can be used to calculate capacitance or time, by either the relationship using the known fixed capacitance of the circuit:

 $t = (C \bullet V)/I$

or by:

$C = (I \bullet t)/V$

using a fixed time that the current source is applied to the circuit.

27.2.2 CURRENT SOURCE

At the heart of the CTMU is a precision current source, designed to provide a constant reference for measurements. The level of current is user-selectable across three ranges or a total of two orders of magnitude, with the ability to trim the output in $\pm 2\%$ increments (nominal). The current range is selected by the IRNG<1:0> bits (CTMUICON<1:0>), with a value of '00' representing the lowest range.

Current trim is provided by the ITRIM<5:0> bits (CTMUICON<7:2>). These six bits allow trimming of the current source in steps of approximately 2% per step. Half of the range adjusts the current source positively and the other half reduces the current source. A value of '000000' is the neutral position (no change). A value of '100000' is the maximum negative adjustment (approximately -62%) and '011111' is the maximum positive adjustment (approximately +62%).

27.2.3 EDGE SELECTION AND CONTROL

CTMU measurements are controlled by edge events occurring on the module's two input channels. Each channel, referred to as Edge 1 and Edge 2, can be configured to receive input pulses from one of the edge input pins (CTEDG1 and CTEDG2) or CCPx Special Event Triggers. The input channels are level-sensitive, responding to the instantaneous level on the channel rather than a transition between levels. The inputs are selected using the EDG1SEL and EDG2SEL bit pairs (CTMUCONL<3:2, 6:5>).

In addition to source, each channel can be configured for event polarity using the EDGE2POL and EDGE1POL bits (CTMUCONL<7,4>). The input channels can also be filtered for an edge event sequence (Edge 1 occurring before Edge 2) by setting the EDGSEQEN bit (CTMUCONH<2>).

27.2.4 EDGE STATUS

The CTMUCON register also contains two status bits, EDG2STAT and EDG1STAT (CTMUCONL<1:0>). Their primary function is to show if an edge response has occurred on the corresponding channel. The CTMU automatically sets a particular bit when an edge response is detected on its channel. The level-sensitive nature of the input channels also means that the status bits become set immediately if the channel's configuration is changed and matches the channel's current state.

The module uses the edge status bits to control the current source output to external analog modules (such as the A/D Converter). Current is only supplied to external modules when only one (not both) of the status bits is set. Current is shut off when both bits are either set or cleared. This allows the CTMU to measure current only during the interval between edges. After both status bits are set, it is necessary to clear them before another measurement is taken. Both bits should be cleared simultaneously, if possible, to avoid re-enabling the CTMU current source.

In addition to being set by the CTMU hardware, the edge status bits can also be set by software. This permits a user application to manually enable or disable the current source. Setting either (but not both) of the bits enables the current source. Setting or clearing both bits at once disables the source.

查询PIC18F67K90供应商 27.2.5 INTERRUPTS

The CTMU sets its interrupt flag (PIR3<3>) whenever the current source is enabled, then disabled. An interrupt is generated only if the corresponding interrupt enable bit (PIE3<3>) is also set. If edge sequencing is not enabled (i.e., Edge 1 must occur before Edge 2), it is necessary to monitor the edge status bits and determine which edge occurred last and caused the interrupt.

27.3 CTMU Module Initialization

The following sequence is a general guideline used to initialize the CTMU module:

- 1. Select the current source range using the IRNGx bits (CTMUICON<1:0>).
- 2. Adjust the current source trim using the ITRIMx bits (CTMUICON<7:2>).
- Configure the edge input sources for Edge 1 and Edge 2 by setting the EDG1SEL and EDG2SEL bits (CTMUCONL<3:2> and <6:5>, respectively).
- Configure the input polarities for the edge inputs using the EDG1POL and EDG2POL bits (CTMUCONL<4,7>).

The default configuration is for negative edge polarity (high-to-low transitions).

5. Enable edge sequencing using the EDGSEQEN bit (CTMUCONH<2>).

By default, edge sequencing is disabled.

6. Select the operating mode (Measurement or Time Delay) with the TGEN bit.

The default mode is Time/Capacitance Measurement.

 Configure the module to automatically trigger an A/D conversion when the second edge event has occurred using the CTTRIG bit (CTMUCONH<0>).

The conversion trigger is disabled by default.

- 8. Discharge the connected circuit by setting the IDISSEN bit (CTMUCONH<1>).
- 9. After waiting a sufficient time for the circuit to discharge, clear IDISSEN.
- 10. Disable the module by clearing the CTMUEN bit (CTMUCONH<7>).
- 11. Clear the Edge Status bits, EDG2STAT and EDG1STAT (CTMUCONL<1:0>).
- 12. Enable both edge inputs by setting the EDGEN bit (CTMUCONH<3>).
- 13. Enable the module by setting the CTMUEN bit.

Depending on the type of measurement or pulse generation being performed, one or more additional modules may also need to be initialized and configured with the CTMU module:

- Edge Source Generation: In addition to the external edge input pins, CCPx Special Event Triggers can be used as edge sources for the CTMU.
- Capacitance or Time Measurement: The CTMU module uses the A/D Converter to measure the voltage across a capacitor that is connected to one of the analog input channels.
- Pulse Generation: When generating system clock independent, output pulses, the CTMU module uses Comparator 2 and the associated comparator voltage reference.

27.4 Calibrating the CTMU Module

The CTMU requires calibration for precise measurements of capacitance and time, as well as for accurate time delay. If the application only requires measurement of a relative change in capacitance or time, calibration is usually not necessary. An example of a lesser precision application is a capacitive touch switch, in which the touch circuit has a baseline capacitance and the added capacitance of the human body changes the overall capacitance of a circuit.

If actual capacitance or time measurement is required, two hardware calibrations must take place:

- The current source needs calibration to set it to a precise current.
- The circuit being measured needs calibration to measure or nullify any capacitance other than that to be measured.

27.4.1 CURRENT SOURCE CALIBRATION

The current source on board the CTMU module has a range of $\pm 60\%$ nominal for each of three current ranges. For precise measurements, it is possible to measure and adjust this current source by placing a high-precision resistor, RCAL, onto an unused analog channel. An example circuit is shown in Figure 27-2.

To measure the current source:

- 1. Initialize the A/D Converter.
- 2. Initialize the CTMU.
- Enable the current source by setting EDG1STAT (CTMUCONL<0>).
- 4. Issue the settling time delay.
- 5. Perform the A/D conversion.
- 6. Calculate the current source current using I = V/RCAL, where RCAL is a high-precision resistance and V is measured by performing an A/D conversion.

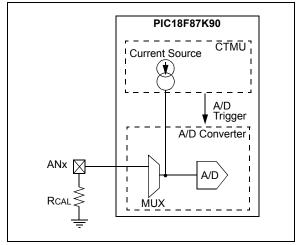
查询PIC18F67K90供应商

The CTMU current source may be trimmed with the trim bits in CTMUICON using an iterative process to get the exact current desired. Alternatively, the nominal value without adjustment may be used. That value may be stored by software, for use in all subsequent capacitive or time measurements.

To calculate the value for $\ensuremath{\mathrm{RCAL}}$, the nominal current must be chosen. Then, the resistance can be calculated.

For example, if the A/D Converter reference voltage is 3.3V, use 70% of full scale (or 2.31V) as the desired approximate voltage to be read by the A/D Converter. If the range of the CTMU current source is selected to be 0.55 μ A, the resistor value needed is calculated as, RCAL = 2.31V/0.55 μ A, for a value of 4.2 MΩ. Similarly, if the current source is chosen to be 5.5 μ A, RCAL would be 420,000Ω, and 42,000Ω if the current source is set to 55 μ A.

FIGURE 27-2: CTMU CURRENT SOURCE CALIBRATION CIRCUIT



A value of 70% of full-scale voltage is chosen to make sure that the A/D Converter was in a range that is well above the noise floor. If an exact current is chosen to incorporate the trimming bits from CTMUICON, the resistor value of RCAL may need to be adjusted accordingly. RCAL also may be adjusted to allow for available resistor values. RCAL should be of the highest precision available, in light of the precision needed for the circuit that the CTMU will be measuring. A recommended minimum would be 0.1% tolerance.

The following examples show a typical method for performing a CTMU current calibration.

• Example 27-1 demonstrates how to initialize the A/D Converter and the CTMU.

This routine is typical for applications using both modules.

• Example 27-2 demonstrates one method for the actual calibration routine.

This method manually triggers the A/D Converter to demonstrate the entire step-wise process. It is also possible to automatically trigger the conversion by setting the CTMU's CTTRIG bit (CTMUCONH<0>).

```
查询PIC18F67K90供应商
             SETUP FOR CTMU CALIBRATION ROUTINES
EXAMPLE 27-1:
#include "p18cxxx.h"
 void setup(void)
 { //CTMUCON - CTMU Control register
   CTMUCONH = 0 \times 00;
                          //make sure CTMU is disabled
   CTMUCONL = 0X90;
   //CTMU continues to run when emulator is stopped,CTMU continues
   //to run in idle mode, Time Generation mode disabled, Edges are blocked
   //No edge sequence order, Analog current source not grounded, trigger
   //output disabled, Edge2 polarity = positive level, Edge2 source =
   //source 0, Edgel polarity = positive level, Edgel source = source 0,
   // Set Edge status bits to zero
    //CTMUICON - CTMU Current Control Register
   CTMUICON = 0 \times 01;
                         //0.55uA, Nominal - No Adjustment
 //Setup AD converter;
 TRISA=0x04;
                          //set channel 2 as an input
   // Configured AN2 as an analog channel
   // ANCONO
   ANCON0 = 0 \times 04;
   // ANCON1
   ANCON1 = 0 XE0;
   // ADCON1
   ADCON2bits.ADFM=1;
                      //Resulst format 1= Right justified
                         //Acquition time 7 = 20TAD 2 = 4TAD 1=2TAD
   ADCON2bits.ACQT=1;
   ADCON2bits.ADCS=2;
                          //Clock conversion bits 6= FOSC/64 2=FOSC/32
   // ADCON0
                        //Vref+ = AVdd
   ADCON1bits.VCFG0 =0;
   ADCON1bits.VCFG1 =0;
                         //Vref+ = AVdd
   ADCON1bits.VNCFG =0;
                         //Vref- = AVss
   ADCON0bits.CHS=2;
                          //Select ADC channel
   ADCON0bits.ADON=1;
                          //Turn on ADC
}
```

查询PIC18F67K90供应商 EXAMPLE 27-2: CURRENT CALIBRATION ROUTINE

```
#include "pl8cxxx.h"
#define COUNT 500
                                          //@ 8MHz = 125uS.
#define DELAY for(i=0;i<COUNT;i++)</pre>
#define RCAL .027
                                          //R value is 4200000 (4.2M)
                                          //scaled so that result is in
                                          //1/100th of uA
#define ADSCALE 1023
                                         //for unsigned conversion 10 sig bits
#define ADREF 3.3
                                          //Vdd connected to A/D Vr+
int main(void)
{
    int i;
    int j = 0; //index for loop
    unsigned int Vread = 0;
    double VTot = 0;
    float Vavg=0, Vcal=0, CTMUISrc = 0; //float values stored for calcs
//assume CTMU and A/D have been setup correctly
//see Example 25-1 for CTMU & A/D setup
setup();
CTMUCONHbits.CTMUEN = 1;
                                          //Enable the CTMU
    for(j=0;j<10;j++)</pre>
    {
        CTMUCONHbits.IDISSEN = 1;
                                          //drain charge on the circuit
        DELAY;
                                          //wait 125us
        CTMUCONHbits.IDISSEN = 0;
                                          //end drain of circuit
        CTMUCONLbits.EDG1STAT = 1;
                                          //Begin charging the circuit
                                          //using CTMU current source
        DELAY;
                                          //wait for 125us
        CTMUCONLbits.EDG1STAT = 0;
                                          //Stop charging circuit
        PIR1bits.ADIF = 0;
                                          //make sure A/D Int not set
        ADCON0bits.GO=1;
                                          //and begin A/D conv.
        while(!PIR1bits.ADIF);
                                          //Wait for A/D convert complete
        Vread = ADRES;
                                          //Get the value from the A/D
        PIR1bits.ADIF = 0;
                                          //Clear A/D Interrupt Flag
        VTot += Vread;
                                          //Add the reading to the total
    }
    Vavg = (float)(VTot/10.000);
                                          //Average of 10 readings
    Vcal = (float)(Vavg/ADSCALE*ADREF);
    CTMUISrc = Vcal/RCAL;
                                          //CTMUISrc is in 1/100ths of uA
}
```

查询PIC18F67K90供应商 27.4.2 CAPACITANCE CALIBRATION

There is a small amount of capacitance from the internal A/D Converter sample capacitor as well as stray capacitance from the circuit board traces and pads that affect the precision of capacitance measurements. A measurement of the stray capacitance can be taken by making sure the desired capacitance to be measured has been removed.

After removing the capacitance to be measured:

- 1. Initialize the A/D Converter and the CTMU.
- 2. Set EDG1STAT (= 1).
- 3. Wait for a fixed delay of time, *t*.
- 4. Clear EDG1STAT.
- 5. Perform an A/D conversion.
- 6. Calculate the stray and A/D sample capacitances:

```
COFFSET = CSTRAY + CAD = (I \cdot t)/V
```

Where:

- I is known from the current source measurement step
- t is a fixed delay
- V is measured by performing an A/D conversion

This measured value is then stored and used for calculations of time measurement or subtracted for capacitance measurement. For calibration, it is expected that the capacitance of CSTRAY + CAD is approximately known; CAD is approximately 4 pF.

An iterative process may be required to adjust the time, *t*, that the circuit is charged to obtain a reasonable voltage reading from the A/D Converter. The value of *t* may be determined by setting *C*OFFSET to a theoretical value and solving for *t*. For example, if *C*STRAY is theoretically calculated to be 11 pF, and V is expected to be 70% of VDD or 2.31V, t would be:

or 63 µs.

See Example 27-3 for a typical routine for CTMU capacitance calibration.

查询PIC18F67K90供应商 EXAMPLE 27-3: CAPACITANCE CALIBRATION ROUTINE

```
#include "pl8cxxx.h"
#define COUNT 25
                                          //@ 8MHz INTFRC = 62.5 us.
#define ETIME COUNT*2.5
                                          //time in uS
#define DELAY for(i=0;i<COUNT;i++)</pre>
#define ADSCALE 1023
                                         //for unsigned conversion 10 sig bits
#define ADREF 3.3
                                         //Vdd connected to A/D Vr+
#define RCAL .027
                                          //R value is 4200000 (4.2M)
                                          //scaled so that result is in
                                          //1/100th of uA
int main(void)
{
    int i;
   int j = 0;
                                          //index for loop
   unsigned int Vread = 0;
   float CTMUISrc, CTMUCap, Vavg, VTot, Vcal;
//assume CTMU and A/D have been setup correctly
//see Example 25-1 for CTMU & A/D setup
setup();
CTMUCONHbits.CTMUEN = 1;
                                          //Enable the CTMU
    for(j=0;j<10;j++)</pre>
    {
        CTMUCONHbits.IDISSEN = 1;
                                          //drain charge on the circuit
        DELAY;
                                          //wait 125us
        CTMUCONHbits.IDISSEN = 0;
                                          //end drain of circuit
        CTMUCONLbits.EDG1STAT = 1;
                                          //Begin charging the circuit
                                          //using CTMU current source
        DELAY;
                                          //wait for 125us
        CTMUCONLbits.EDG1STAT = 0;
                                          //Stop charging circuit
        PIR1bits.ADIF = 0;
                                         //make sure A/D Int not set
        ADCON0bits.GO=1;
                                         //and begin A/D conv.
        while(!PIR1bits.ADIF);
                                          //Wait for A/D convert complete
        Vread = ADRES;
                                          //Get the value from the A/D
        PIR1bits.ADIF = 0;
                                          //Clear A/D Interrupt Flag
        VTot += Vread;
                                          //Add the reading to the total
    }
   Vavg = (float)(VTot/10.000);
                                          //Average of 10 readings
   Vcal = (float)(Vavg/ADSCALE*ADREF);
                                          //CTMUISrc is in 1/100ths of uA
    CTMUISrc = Vcal/RCAL;
    CTMUCap = (CTMUISrc*ETIME/Vcal)/100;
}
```

© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商

27.5 Measuring Capacitance with the CTMU

There are two ways to measure capacitance with the CTMU. The absolute method measures the actual capacitance value. The relative method only measures for any change in the capacitance.

27.5.1 ABSOLUTE CAPACITANCE MEASUREMENT

For absolute capacitance measurements, both the current and capacitance calibration steps found in **Section 27.4 "Calibrating the CTMU Module"** should be followed.

To perform these measurements:

- 1. Initialize the A/D Converter.
- 2. Initialize the CTMU.
- 3. Set EDG1STAT.
- 4. Wait for a fixed delay, T.
- 5. Clear EDG1STAT.
- 6. Perform an A/D conversion.
- 7. Calculate the total capacitance, CTOTAL = (I * T)/V, where:
 - I is known from the current source measurement step (Section 27.4.1 "Current Source Calibration")
 - T is a fixed delay
 - V is measured by performing an A/D conversion
- 8. Subtract the stray and A/D capacitance (COFFSET from Section 27.4.2 "Capacitance Calibration") from CTOTAL to determine the measured capacitance.

27.5.2 RELATIVE CHARGE MEASUREMENT

Not all applications require precise capacitance measurements. When detecting a valid press of a capacitance-based switch, only a relative change of capacitance needs to be detected.

In such an application, when the switch is open (or not touched), the total capacitance is the capacitance of the combination of the board traces, the A/D Converter and other elements. A larger voltage will be measured by the A/D Converter. When the switch is closed (or touched), the total capacitance is larger due to the addition of the capacitance of the human body to the above listed capacitances and a smaller voltage will be measured by the A/D Converter.

To detect capacitance changes simply:

- 1. Initialize the A/D Converter and the CTMU.
- 2. Set EDG1STAT.
- 3. Wait for a fixed delay.
- 4. Clear EDG1STAT.
- 5. Perform an A/D conversion.

The voltage measured by performing the A/D conversion is an indication of the relative capacitance. In this case, no calibration of the current source or circuit capacitance measurement is needed. (For a sample software routine for a capacitive touch switch, see Example 27-4.)

查询PIC18F67K90供应商 EXAMPLE 27-4: ROUTINE FOR CAPACITIVE TOUCH SWITCH

```
#include "p18cxxx.h"
#define COUNT 500
                                          //@ 8MHz = 125uS.
#define DELAY for(i=0;i<COUNT;i++)</pre>
#define OPENSW 1000
                                          //Un-pressed switch value
#define TRIP 300
                                          //Difference between pressed
                                         //and un-pressed switch
#define HYST 65
                                         //amount to change
                                          //from pressed to un-pressed
#define PRESSED 1
#define UNPRESSED 0
int main(void)
{
    unsigned int Vread;
                                         //storage for reading
    unsigned int switchState;
    int i;
    //assume CTMU and A/D have been setup correctly
    //see Example 27-1 for CTMU & A/D setup
    setup();
    CTMUCONHbits.CTMUEN = 1;
                                         //Enable the CTMU
    CTMUCONHbits.IDISSEN = 1;
                                         //drain charge on the circuit
                                         //wait 125us
   DELAY;
    CTMUCONHbits.IDISSEN = 0;
                                         //end drain of circuit
    CTMUCONLbits.EDG1STAT = 1;
                                         //Begin charging the circuit
                                         //using CTMU current source
                                         //wait for 125us
   DELAY;
    CTMUCONLbits.EDG1STAT = 0;
                                         //Stop charging circuit
    PIR1bits.ADIF = 0;
                                         //make sure A/D Int not set
    ADCON0bits.GO=1;
                                         //and begin A/D conv.
    while(!PIR1bits.ADIF);
                                         //Wait for A/D convert complete
    Vread = ADRES;
                                         //Get the value from the A/D
    if(Vread < OPENSW - TRIP)
    {
        switchState = PRESSED;
    else if(Vread > OPENSW - TRIP + HYST)
        switchState = UNPRESSED;
    }
}
```

© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商

27.6 Measuring Time with the CTMU Module

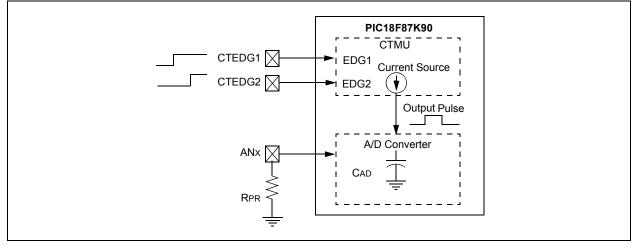
Time can be precisely measured after the ratio $({\rm C/I})$ is measured from the current and capacitance calibration step. To do that:

- 1. Initialize the A/D Converter and the CTMU.
- 2. Set EDG1STAT.
- 3. Set EDG2STAT.
- 4. Perform an A/D conversion.
- 5. Calculate the time between edges as $T = (C/I) \cdot V$, where:
 - I is calculated in the current calibration step (Section 27.4.1 "Current Source Calibration")
 - C is calculated in the capacitance calibration step (Section 27.4.2 "Capacitance Calibration")
 - V is measured by performing the A/D conversion

It is assumed that the time measured is small enough that the capacitance, *C*OFFSET, provides a valid voltage to the A/D Converter. For the smallest time measurement, always set the A/D Channel Select register (AD1CHS) to an unused A/D channel, the corresponding pin for which is not connected to any circuit board trace. This minimizes added stray capacitance, keeping the total circuit capacitance close to that of the A/D Converter itself (25 pF).

To measure longer time intervals, an external capacitor may be connected to an A/D channel and that channel selected whenever making a time measurement.

FIGURE 27-3: TYPICAL CONNECTIONS AND INTERNAL CONFIGURATION FOR TIME MEASUREMENT



查询PIC18F67K90供应商

27.7 Creating a Delay with the CTMU Module

A unique feature on board the CTMU module is its ability to generate system clock independent output pulses based on either an internal voltage or an external capacitor value. When using an external voltage, this is accomplished using the CTDIN input pin as a trigger for the pulse delay. When using an internal capacitor value, this is accomplished using the internal comparator voltage reference module and Comparator 2 input pin. The pulse is output onto the CTPLS pin. To enable this mode, set the TGEN bit.

See Figure 27-4 for an example circuit. When CTMUDS (ODCON3<0>) is cleared, the pulse delay is determined by the output of Comparator 2, and when it is set, the pulse delay is determined by the input of CTDIN. CDELAY is chosen by the user to determine the output pulse width on CTPLS. The pulse width is calculated by T = (CDELAY/I) * V, where I is known from the current source measurement step (Section 27.4.1 "Current Source Calibration") and V is the internal reference voltage (CVREF).

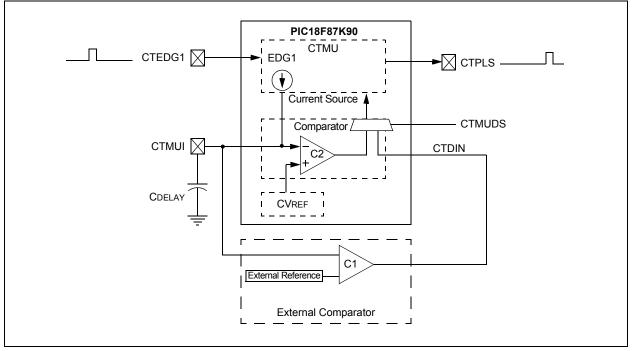
An example use of the external capacitor feature is interfacing with variable capacitive-based sensors, such as a humidity sensor. As the humidity varies, the pulse-width output on CTPLS will vary. An example use of the CTDIN feature is interfacing with a digital sensor. The CTPLS output pin can be connected to an input capture pin and the varying pulse width measured to determine the humidity in the application.

To use this feature:

- 1. If CTMUDS is cleared, initialize Comparator 2.
- 2. If CTMUDS is cleared, initialize the comparator voltage reference.
- 3. Initialize the CTMU and enable time delay generation by setting the TGEN bit.
- 4. Set EDG1STAT.

When CTMUDS is cleared, as soon as CDELAY charges to the value of the voltage reference trip point, an output pulse is generated on CTPLS. When CTMUDS is set, as soon as CTDIN is set, an output pulse is generated on CTPLS.

FIGURE 27-4: TYPICAL CONNECTIONS AND INTERNAL CONFIGURATION FOR PULSE DELAY GENERATION



查询PIC18F67K90供应商

27.8 Measuring Temperature Using the CTMU Module

The CTMU, along with an internal diode, can be used to measure the temperature. The ADC can be connected to the internal diode and the CTMU module can

source the current to the diode. The ADC reading will reflect the temperature. With the increase, the ADC readings will go low. This can be used for low-cost temperature measurement applications.

EXAMPLE 27-5: ROUTINE FOR TEMPERATURE MEASUREMENT USING INTERNAL DIODE

<pre>//Initialize CTMU CTMUICON=0x03; CTMUCONHbits.CTMUEN=1;</pre>	
CTMUCONLbits.EDG1STAT=1;	
//Initialize ADC	
ADCON0=0xE5;	//ADCON and connect to Internal diode
ADCON1=0;	
ADCON2=0xBE;	//Right justified
ADCON0bits.GO=1;	
while(ADCON0bits.GO==1);	
Temp=ADRES;	;//read ADC results (inversely proportional to temperature)
Temp=ADRES;	;//read ADC results (inversely proportional to temperature

DS39957B-page 420

查询PIC18F67K90供应商 **27.9 Operation Du**ring Sleep/Idle Modes

27.9.1 SLEEP MODE

When the device enters any Sleep mode, the CTMU module current source is always disabled. If the CTMU is performing an operation that depends on the current source when Sleep mode is invoked, the operation may not terminate correctly. Capacitance and time measurements may return erroneous values.

27.9.2 IDLE MODE

The behavior of the CTMU in Idle mode is determined by the CTMUSIDL bit (CTMUCONH<5>). If CTMUSIDL is cleared, the module will continue to operate in Idle mode. If CTMUSIDL is set, the module's current source is disabled when the device enters Idle mode. If the module is performing an operation when Idle mode is invoked, in this case, the results will be similar to those with Sleep mode.

27.10 Effects of a Reset on CTMU

Upon Reset, all registers of the CTMU are cleared. This disables the CTMU module, turns off its current source and returns all configuration options to their default settings. The module needs to be re-initialized following any Reset.

If the CTMU is in the process of taking a measurement at the time of Reset, the measurement will be lost. A partial charge may exist on the circuit that was being measured, which should be properly discharged before the CTMU makes subsequent attempts to make a measurement. The circuit is discharged by setting and clearing the IDISSEN bit (CTMUCONH<1>) while the A/D Converter is connected to the appropriate channel.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
CTMUCONH	CTMUEN	_	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	CTTRIG	78
CTMUCONL	EDG2POL	EDG2SEL1	EDG2SEL0	EDG1POL	EDG1SEL1	EDG1SEL0	EDG2STAT	EDG1STAT	78
CTMUICON	ITRIM5	ITRIM4	ITRIM3	ITRIM2	ITRIM1	ITRIM0	IRNG1	IRNG0	78
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	75
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	75
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	75

TABLE 27-1: REGISTERS ASSOCIATED WITH CTMU MODULE

Legend: — = unimplemented, read as '0'

查询PIC18F67K90供应商 NOTES:

查询PIC18F67K90供应商

28.0 SPECIAL FEATURES OF THE CPU

The PIC18F87K90 family of devices includes several features intended to maximize reliability and minimize cost through elimination of external components. These include:

- Oscillator Selection
- Resets:
 - Power-on Reset (POR)
 - Power-up Timer (PWRT)
 - Oscillator Start-up Timer (OST)
- Brown-out Reset (BOR)
- Interrupts
- · Watchdog Timer (WDT) and On-Chip Regulator
- · Fail-Safe Clock Monitor
- Two-Speed Start-up
- Code Protection
- ID Locations
- In-Circuit Serial Programming[™]

The oscillator can be configured for the application depending on frequency, power, accuracy and cost. All of the options are discussed in detail in **Section 3.0 "Oscillator Configurations"**.

A complete discussion of device Resets and interrupts is available in previous sections of this data sheet.

In addition to their Power-up and Oscillator Start-up Timers provided for Resets, the PIC18F87K90 family of devices has a Watchdog Timer, which is either permanently enabled via the Configuration bits or software controlled (if configured as disabled).

The inclusion of an internal RC (LF-INTOSC) oscillator also provides the additional benefits of a Fail-Safe Clock Monitor (FSCM) and Two-Speed Start-up. FSCM provides for background monitoring of the peripheral clock and automatic switchover in the event of its failure. Two-Speed Start-up enables code to be executed almost immediately on start-up, while the primary clock source completes its start-up delays.

All of these features are enabled and configured by setting the appropriate Configuration register bits.

28.1 Configuration Bits

The Configuration bits can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped starting at program memory location, 300000h.

The user will note that address, 300000h, is beyond the user program memory space. In fact, it belongs to the configuration memory space (300000h-3FFFFh), which can only be accessed using table reads and table writes.

Software programming the Configuration registers is done in a manner similar to programming the Flash memory. The WR bit in the EECON1 register starts a self-timed write to the Configuration register. In normal operation mode, a TBLWT instruction with the TBLPTR pointing to the Configuration register sets up the address and the data for the Configuration register write. Setting the WR bit starts a long write to the Configuration register. The Configuration registers are written a byte at a time. To write or erase a configuration cell, a TBLWT instruction can write a '1' or a '0' into the cell. For additional details on Flash programming, refer to Section 7.5 "Writing to Flash Program Memory".

查询PIC18F67K90供应商 TABLE 28-1: CONFIGURATION BITS AND DEVICE IDs

File	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default/ Unprogrammed Value
300000h	CONFIG1L	—	XINST	_	SOSCSEL1	SOSCSEL0	INTOSCSEL	_	RETEN	-1-1 11
300001h	CONFIG1H	IESO	FCMEN	_	PLLCFG	FOSC3	FOSC2	FOSC1	FOSC0	0000 1000
300002h	CONFIG2L	_	BORPWR1	BORWPR0	BORV1	BORV0	BOREN1	BOREN0	PWRTEN	-111 1111
300003h	CONFIG2H	_	WDTPS4	WDTPS3	WDTPS2	WDTPS1	WDTPS0	WDTEN1	WDTEN0	-111 1111
300004h	CONFIG3L	_	_	_	_	—	—	_	RTCOSC	1
300005h	CONFIG3H	MCLRE	_			MSSPMSK	—	ECCPMX ⁽²⁾	CCP2MX	1 1-11
300006h	CONFIG4L	DEBUG	_		BBSIZ0	_	_	-	STVREN	111
300008h	CONFIG5L	CP7 ⁽¹⁾	CP6 ⁽¹⁾	CP5 ⁽¹⁾	CP4 ⁽¹⁾	CP3	CP2	CP1	CP0	1111 1111
300009h	CONFIG5H	CPD	CPB	_	_	_	_	_		11
30000Ah	CONFIG6L	WRT7 ⁽¹⁾	WRT6 ⁽¹⁾	WRT5 ⁽¹⁾	WRT4 ⁽¹⁾	WRT3	WRT2	WRT1	WRT0	1111 1111
30000Bh	CONFIG6H	WRTD	WRTB	WRTC	_	—	—	_	_	111
30000Ch	CONFIG7L	EBTR7 ⁽¹⁾	EBTR6 ⁽¹⁾	EBTR5 ⁽¹⁾	EBTR4 ⁽¹⁾	EBTR3	EBTR2	EBTR1	EBTR0	1111 1111
30000Dh	CONFIG7H	_	EBTRB	_	_	—	—	_	_	-1
3FFFFEh	DEVID1 ⁽³⁾	DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0	XXXX XXXX
3FFFFFh	DEVID2 ⁽³⁾	DEV10	DEV9	DEV8	DEV7	DEV6	DEV5	DEV4	DEV3	XXXX XXXX

Legend: x = unknown, u = unchanged, - = unimplemented, q = value depends on condition. Shaded cells are unimplemented, read as '0'.

Note 1: Implemented in the PIC18F67K90 and PIC18F87K90 devices.

2: Implemented in the 80-pin devices (PIC18F8XK90).

3: See Register 28-14 for DEVID1 values. DEVID registers are read-only and cannot be programmed by the user.

查询PIC18F67K90供应商 REGISTER 28-1: CONFIG1L: CONFIGURATION REGISTER 1 LOW (BYTE ADDRESS 300000h)

U-0	R/P-1	U-0	R/P-1	R/P-1	R/P-1	U-0	R/P-1
_	XINST	—	SOSCSEL1	SOSCSEL0	INTOSCSEL0		RETEN
bit 7							bit 0

Legend:	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6	XINST: Extended Instruction Set Enable bit
	 1 = Instruction set extension and Indexed Addressing mode are enabled 0 = Instruction set extension and Indexed Addressing mode are disabled (Legacy mode)
bit 5	Unimplemented: Read as '0'
bit 4-3	SOSCSEL<1:0>: SOSC Power Selection and Mode Configuration bits
	 11 = High-power SOSC circuit is selected 10 = Digital (SCLKI) mode: I/O port functionality of RC0 and RC1 is enabled 01 = Low-power SOSC circuit is selected 00 = Reserved
bit 2	INTOSCSEL: LF-INTOSC Low-Power Enable bit
	 1 = LF-INTOSC is in High-Power mode during Sleep 0 = LF-INTOSC is in Low-Power mode during Sleep
bit 1	Unimplemented: Read as '0'
bit 0	RETEN: VREG Sleep Enable bit
	1 = Regulator power is in Sleep mode, controlled by VREGSLP (WDTCON<7>) 0 = Regulator power is in Sleep mode, controlled by SRETEN (WDTCON<4>) Ultra low-pow

= Regulator power is in Sleep mode, controlled by SRETEN (WDTCON<4>). Ultra low-power regulator is enabled.

查询PIC18F67K90供应商

0041-1

R/P-0	R/P-0	U-0	U-0	R/P-1	R/P-0	R/P-0	R/P-0				
IESO	FCMEN		PLLCFG ⁽¹⁾	FOSC3 ⁽²⁾	FOSC2 ⁽²⁾	FOSC1 ⁽²⁾	FOSC0 ⁽²⁾				
bit 7							bit (
		D D									
Legend:	I- 1-14	P = Program				1 (0)					
R = Readab		W = Writable			nented bit, read						
-n = Value a	t POR	'1' = Bit is s∈	et	'0' = Bit is cle	ared	x = Bit is unkr	nown				
bit 7	IESO: Interna	al/External Os	cillator Switchov	ver bit							
	1 = Two-Spee	ed Start-up is	enabled								
	0 = Two-Spee	ed Start-up is	disabled								
bit 6	FCMEN: Fail	-Safe Clock M	onitor Enable b	it							
		Clock Monitor									
		Clock Monitor									
bit 5	-	ted: Read as									
bit 4		PLL Enable b									
		is multiplied to the second seco									
bit 3-0		Oscillator Sel	•								
	1101 = EC1	, EC oscillator	(low power, DC	C-160 kHz)							
			or with CLKOU			r, DC-160 kHz)					
	1011 = EC2, EC oscillator (medium power, 160 kHz-4 MHz)										
	1010 = EC2IO, EC oscillator with CLKOUT function on RA6 (medium power, DC-160 kHz)										
	0101 = EC3, EC oscillator (high power, 4 MHz-64 MHz) 0100 = EC3IO, EC oscillator with CLKOUT function on RA6 (high power, 4 MHz-64 MHz)										
			(medium powe				,				
			(high power, 16	6 MHz-25 MHz	<u>z</u>)						
	0001 = XT o										
	0000 = LP o	scillator External RC c	acillator								
			Scillator with	CKI OUT fund	tion on RA6						
		02, Internal R									

2: INTIO+PLL can only be enabled by the PLLEN bit (OSCTUNE<6>). Other PLL modes can be enabled by either the PLLEN bit or the PLLCFG (CONFIG1H<4>) bit.

查询PIC18F67K90供应商 REGISTER 28-3: CONFIG2L: CONFIGURATION REGISTER 2 LOW (BYTE ADDRESS 300002h)

					-		
U-0	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
_	BORPWR1 ⁽¹⁾	BORPWR0 ⁽¹⁾	BORV1 ⁽¹⁾	BORV0 ⁽¹⁾	BOREN1 ⁽²⁾	BOREN0 ⁽²⁾	PWRTEN ⁽²⁾
bit 7							bit 0

Legend:	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

- bit 7 Unimplemented: Read as '0'
- bit 6-5 **BORPWR<1:0>:** BORMV Power Level bits⁽¹⁾
 - 11 = ZPBORVMV instead of BORMV is selected
 - 10 = BORMV is set to high-power level
 - 01 = BORMV is set to medium-power level
 - 00 = BORMV is set to low-power level
- bit 4-3 BORV<1:0>: Brown-out Reset Voltage bits⁽¹⁾
 - 11 = VBORMV is set to 1.8V
 - 10 = VBORMV is set to 2.0V
 - 01 = VBORMV is set to 2.7V
 - 00 = VBORMV is set to 3.0V

bit 2-1 BOREN<1:0>: Brown-out Reset Enable bits⁽²⁾

- 11 = Brown-out Reset is enabled in hardware only (SBOREN is disabled)
- 10 = Brown-out Reset is enabled in hardware only and disabled in Sleep mode (SBOREN is disabled)
- 01 = Brown-out Reset is enabled and controlled by software (SBOREN is enabled)
- 00 = Brown-out Reset is disabled in hardware and software

bit 0 **PWRTEN:** Power-up Timer Enable bit⁽²⁾

- 1 = PWRT is disabled
- 0 = PWRT is enabled
- Note 1: For the specifications, see Section 31.1 "DC Characteristics: Supply Voltage PIC18F87K90 Family (Industrial)".
 - **2:** The Power-up Timer is decoupled from Brown-out Reset, allowing these features to be independently controlled.

查询PIC18F67K90供应商

REGISTER 28-4: CONFIG2H: CONFIGURATION REGISTER 2 HIGH (BYTE ADDRESS 300003h)

U-0	R/P-1						
—	WDTPS4	WDTPS3	WDTPS2	WDTPS1	WDTPS0	WDTEN1	WDTEN0
bit 7							bit 0

Legend:	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6-2	WDTPS<4:0>: Watchdog Timer F

bit 6-2	WDTPS<4:0>: Watchdog Timer Postscale Select bits
	11111 = 1:1,048,576
	10011 = 1:524,288
	10010 = 1:262,144
	10001 = 1:131,072
	10000 = 1:65,536
	01111 = 1:32,768
	01110 = 1:16,384
	01101 = 1:8,192
	01100 = 1:4,096
	01011 = 1:2,048
	01010 = 1:1,024
	01001 = 1:512
	01000 = 1:256
	00111 = 1:128
	00110 = 1:64
	00101 = 1:32
	00100 = 1:16
	00011 = 1:8
	00010 = 1:4
	00001 = 1:2
	00000 = 1:1
bit 1-0	WDTEN<1:0>: Watchdog Timer Enable bits
	11 = WDT is enabled in hardware; SWDTEN bit is disabled
	10 = WDT is controlled by the SWDTEN bit setting
	01 = WDT is enabled only while device is active and is disabled in Sle

01 = WDT is enabled only while device is active and is disabled in Sleep mode; SWDTEN bit is disabled

00 = WDT is disabled in hardware; SWDTEN bit is disabled

查询PIC18F67K90供应商

bit 0

REGISTER 28-5: CONFIG3L: CONFIGURATION REGISTER 3 LOW (BYTE ADDRESS 300004h)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/P-1
—	—	—	—	_	—	_	RTCOSC
bit 7							bit 0

Legend:	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-1 Unimplemented: Read as '0'

RTCOSC: RTCC Reference Clock Select bit

1 = RTCC uses SOSC as a reference clock

0 = RTCC uses LF-INTOSC as a reference clock

REGISTER 28-6: CONFIG3H: CONFIGURATION REGISTER 3 HIGH (BYTE ADDRESS 300005h)

R/P-1	U-0	U-0	U-0	R/P-1	U-0	R/P-1	R/P-1
MCLRE	—	—	_	MSSPMSK	—	ECCPMX ⁽¹⁾	CCP2MX
bit 7							bit 0

Legend:	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	MCLRE: MCLR Pin Enable bit
	1 = \overline{MCLR} pin is enabled; RG5 input pin is disabled
	0 = RG5 input pin is enabled; MCLR is disabled
bit 6-4	Unimplemented: Read as '0'
bit 3	MSSPMSK: MSSP V3 7-Bit Address Masking Mode Enable bit
	1 = 7-Bit Address Masking mode is enabled
	0 = 5-Bit Address Masking mode is enabled
bit 2	Unimplemented: Read as '0'
bit 1	ECCPMX: ECCP MUX bit ⁽¹⁾
	1 = Enhanced ECCP1 (P1B/P1C) is multiplexed onto RE6 and RE5, CCP6 onto RE6, and CCP7 onto RE5
	Enhanced ECCP3 (P3B/P3C) is multiplexed onto RE4 and RE3, CCP6 onto RE4, and CCP7 onto RE3
	0 = Enhanced ECCP1 (P1B/P1C) is multiplexed onto RH7 and RH6, CCP8 onto RH7, and CCP9 onto RH6
	Enhanced ECCP3 (P3B/P3C) is multiplexed onto RH5 and RH4, CCP8 onto RH5, and CCP9 onto RH4
bit 0	CCP2MX: ECCP2 MUX bit
	1 = ECCP2 is multiplexed with RC1
	0 = ECCP2 input/output is multiplexed with RE7 ⁽¹⁾

Note 1: This feature is only available on 80-pin devices.

查询PIC18F67K90供应商 REGISTER 28-7: CONFIG4L: CONFIGURATION REGISTER 4 LOW (BYTE ADDRESS 300006h)

R/P-1	U-0	U-0	R/P-0	U-0	R/P-0	U-0	R/P-1
DEBUG	_	_	BBSIZ0	-	—	_	STVREN
bit 7							bit 0

Legend:	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	DEBUG: Background Debugger Enable bit
	 1 = Background debugger is disabled, RB6 and RB7 are configured as general purpose I/O pins 0 = Background debugger is enabled, RB6 and RB7 are dedicated to In-Circuit Debug
bit 6-5	Unimplemented: Read as '0'
bit 4	BBSIZ<0>: Boot Block Size Select bit
	1 = 2 kW boot block size
	0 = 1 kW boot block size
bit 3-1	Unimplemented: Read as '0'
bit 0	STVREN: Stack Full/Underflow Reset Enable bit
	 Stack full/underflow will cause a Reset Stack full/underflow will not cause a Reset

查询PIC18F67K90供应商 REGISTER 28-8: CONFIG5L: CONFIGURATION REGISTER 5 LOW (BYTE ADDRESS 300008h)⁽²⁾

R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1
CP7 ⁽¹⁾	CP6 ⁽¹⁾	CP5 ⁽¹⁾	CP4 ⁽¹⁾	CP3	CP2	CP1	CP0
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	CP7: Code Protection bit ⁽¹⁾
	1 = Block 7 is not code-protected0 = Block 7 is code-protected
bit 6	CP6: Code Protection bit ⁽¹⁾
	1 = Block 6 is not code-protected0 = Block 6 is code-protected
bit 5	CP5: Code Protection bit ⁽¹⁾
	1 = Block 5 is not code-protected0 = Block 5 is code-protected
bit 4	CP4: Code Protection bit ⁽¹⁾
	 1 = Block 4 is not code-protected 0 = Block 4 is code-protected
bit 3	CP3: Code Protection bit
	1 = Block 3 is not code-protected0 = Block 3 is code-protected
bit 2	CP2: Code Protection bit
	 1 = Block 2 is not code-protected 0 = Block 2 is code-protected
bit 1	CP1: Code Protection bit
	1 = Block 1 is not code-protected0 = Block 1 is code-protected
bit 0	CP0: Code Protection bit
	1 = Block 0 is not code-protected0 = Block 0 is code-protected
Note 1:	This bit is only available on PIC18F67K90 and PIC18F87K90.

2: For the memory size of the blocks, refer to Figure 28-6.

查询PIC18F67K90供应商

REGISTER 28-9: CONFIG5H: CONFIGURATION REGISTER 5 HIGH (BYTE ADDRESS 300009h)⁽¹⁾

R/C-1	R/C-1	U-0	U-0	U-0	U-0	U-0	U-0		
CPD	CPB	—	_	—	—	_	—		
bit 7		·					bit C		
Legend: C = Clearable bit		bit							
R = Readable bit W =		W = Writable	W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cleared x = Bit is unknown			nown		
bit 7	CPD: Data E	EPROM Code	Protection bit						
1 = Data EEPROM is not code-protected0 = Data EEPROM is code-protected									
bit 6 CPB: Boot Block Code Protection bit									

1 = Boot block is not code-protected 0 = Boot block is code-protected

bit 5-0 Unimplemented: Read as '0'

Note 1: For the memory size of the blocks, refer to Figure 28-6.

查询PIC18F67K90供应商 REGISTER 28-10: CONFIGEL: CONFIGURATION REGISTER 6 LOW (BYTE ADDRESS 30000Ah)⁽²⁾

R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1
WRT7 ⁽¹⁾	WRT6 ⁽¹⁾	WRT5 ⁽¹⁾	WRT4 ⁽¹⁾	WRT3	WRT2	WRT1	WRT0
bit 7							bit 0

Legend:		C = Clearable bit					
R = Readable bit		W = Writable bit	U = Unimplemented bit, read as '0'				
-n = Value	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			
bit 7	WRT7: V	Vrite Protection bit ⁽¹⁾					
		7 is not write-protected 7 is write-protected					
bit 6	WRT6: V	Vrite Protection bit ⁽¹⁾					
		< 6 is not write-protected < 6 is write-protected					
bit 5	WRT5: V	Vrite Protection bit ⁽¹⁾					
		< 5 is not write-protected					
bit 4	WRT4: V	Vrite Protection bit ⁽¹⁾					
	1 = Bloc	4 is not write-protected					

bit 3	WRT3: Write Protection bit 1 = Block 3 is not write-protected 0 = Block 3 is write-protected
bit 2	WRT2: Write Protection bit
	1 = Block 2 is not write-protected0 = Block 2 is write-protected
bit 1	WRT1: Write Protection bit
	1 = Block 1 is not write-protected0 = Block 1 is write-protected
bit 0	WRT0: Write Protection bit
	1 = Block 0 is not write-protected0 = Block 0 is write-protected

0 = Block 4 is write-protected

- **Note 1:** This bit is only available on PIC18F67K90 and PIC18F87K90.
 - 2: For the memory size of the blocks, refer to Figure 28-6.

查询PIC18F67K90供应商

REGISTER 28-11: CONFIG6H: CONFIGURATION REGISTER 6 HIGH (BYTE ADDRESS 30000Bh)⁽²⁾

R/C-1	R/C-1	R-1	U-0	U-0	U-0	U-0	U-0
WRTD	WRTB	WRTC ⁽¹⁾	—	—	—	—	—
bit 7	•						bit 0
Legend:		C = Clearable	e bit				
Legend: R = Readable	bit	C = Clearable W = Writable		U = Unimplen	nented bit, reac	l as '0'	

bit 7	WRTD: Data EEPROM Write Protection bit
	1 = Data EEPROM is not write-protected0 = Data EEPROM is write-protected
bit 6	WRTB: Boot Block Write Protection bit
	1 = Boot block is not write-protected
	0 = Boot block is write-protected
bit 5	WRTC: Configuration Register Write Protection bit ⁽¹⁾
	1 = Configuration registers are not write-protected
	0 = Configuration registers are write-protected
bit 4-0	Unimplemented: Read as '0'

Note 1: This bit is read-only in normal execution mode; it can be written only in Program mode.

2: For the memory size of the blocks, refer to Figure 28-6.

查询PIC18F67K90供应商

REGISTER 28-12: CONFIG7L: CONFIGURATION REGISTER 7 LOW (BYTE ADDRESS 30000Ch)⁽³⁾

R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1	R/C-1
EBTR7 ⁽¹⁾	EBTR6 ⁽¹⁾	EBTR5 ⁽¹⁾	EBTR4 ⁽¹⁾	EBTR3	EBTR2	EBTR1	EBTR0
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	EBTR7: Table Read Protection bit ⁽¹⁾
	 1 = Block 7 is not protected from table reads executed in other blocks 0 = Block 7 is protected from table reads executed in other blocks
bit 6	EBTR6: Table Read Protection bit ⁽¹⁾
	 1 = Block 6 is not protected from table reads executed in other blocks 0 = Block 6 is protected from table reads executed in other blocks
bit 5	EBTR5: Table Read Protection bit ⁽¹⁾
	 1 = Block 5 is not protected from table reads executed in other blocks 0 = Block 5 is protected from table reads executed in other blocks
bit 4	EBTR4: Table Read Protection bit ⁽¹⁾
	 1 = Block 4 is not protected from table reads executed in other blocks 0 = Block 4 is protected from table reads executed in other blocks
bit 3	EBTR3: Table Read Protection bit
	 1 = Block 3 is not protected from table reads executed in other blocks 0 = Block 3 is protected from table reads executed in other blocks
bit 2	EBTR2: Table Read Protection bit
	 1 = Block 2 is not protected from table reads executed in other blocks 0 = Block 2 is protected from table reads executed in other blocks
bit 1	EBTR1: Table Read Protection bit
	 1 = Block 1 is not protected from table reads executed in other blocks 0 = Block 1 is protected from table reads executed in other blocks
bit 0	EBTR0: Table Read Protection bit
	 1 = Block 0 is not protected from table reads executed in other blocks 0 = Block 0 is protected from table reads executed in other blocks
Note 1:	This bit is only available on PIC18F67K90 and PIC18F87K90.
2:	This bit is only available on PIC18F66K90, PIC18F67K90, PIC18F86K90 and PIC18F87K90.

- 2:
 - 3: For the memory size of the blocks, refer to Figure 28-6.

查询PIC18F67K90供应商

REGISTER 28-13: CONFIG7H: CONFIGURATION REGISTER 7 HIGH (BYTE ADDRESS 30000Dh)⁽¹⁾

U-0	R/C-1	U-0	U-0	U-0	U-0	U-0	U-0
—	EBTRB		—	—	—	—	—
bit 7							bit 0

Legend:	C = Clearable bit			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7 Unimplemented: Read as '0'

1 = Boot block is not protected from table reads executed in other blocks

0 = Boot block is protected from table reads executed in other blocks

bit 5-0 Unimplemented: Read as '0'

Note 1: For the memory size of the blocks, refer to Figure 28-6.

查询PIC18F67K90供应商

REGISTER 28-14: DEVID1: DEVICE ID REGISTER 1 FOR THE PIC18F87K90 FAMILY

R	R	R	R	R	R	R	R
DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5	DEV<2:0>: Device ID bits
	Devices with DEV<10:3> of 0101 0010 (see DEVID2):
	010 = PIC18F65K90
	000 = PIC18F66K90
	101 = PIC18F85K90
	011 = PIC18F86K90
	Devices with DEV<10:3> of 0101 0001:
	000 = PIC18F67K90
	010 = PIC18F87K90
bit 4-0	REV<4:0>: Revision ID bits
	These bits are used to indicate the device revision.

'1' = Bit is set

REGISTER 28-15: DEVID2: DEVICE ID REGISTER 2 FOR THE PIC18F87K90 FAMILY

R	R	R	R	R	R	R	R	
DEV10 ⁽¹⁾	DEV9 ⁽¹⁾	DEV8 ⁽¹⁾	DEV7 ⁽¹⁾	DEV6 ⁽¹⁾	DEV5 ⁽¹⁾	DEV4 ⁽¹⁾	DEV3 ⁽¹⁾	
bit 7			I.				bit 0	
Legend:								
R = Readable bi	t	W = Writable	bit	U = Unimplemented bit, read as '0'				

'0' = Bit is cleared

bit 7-0 **DEV<10:3>:** Device ID bits⁽¹⁾ These bits are used with the DEV<2:0> bits in the Device ID Register 1 to identify the part number. 0101 0010 = PIC18F65K90, PIC18F66K90, PIC18F85K90 and PIC18F86K90 0101 0001 = PIC18F67K90 and PIC18F87K90

Note 1: These values for DEV<10:3> may be shared with other devices. The specific device is always identified by using the entire DEV<10:0> bit sequence.

-n = Value at POR

x = Bit is unknown

查询PIC18F67K90供应商 28.2 Watchdog Timer (WDT)

For the PIC18F87K90 family of devices, the WDT is driven by the LF-INTOSC source. When the WDT is enabled, the clock source is also enabled. The nominal WDT period is 4 ms and has the same stability as the LF-INTOSC oscillator.

The 4 ms period of the WDT is multiplied by a 16-bit postscaler. Any output of the WDT postscaler is selected by a multiplexer, controlled by bits in Configuration Register 2H. Available periods range from 4 ms to 4,194 seconds (about one hour). The WDT and postscaler are cleared when any of the following events occur: a SLEEP or CLRWDT instruction is executed, the IRCF bits (OSCCON<6:4>) are changed or a clock failure has occurred.

The WDT can be operated in one of four modes as determined by CONFIG2H (WDTEN<1:0>) The four modes are:

- WDT Enabled
- WDT Disabled
- WDT under software control (WDTCON<0>, SWDTEN)
- WDT
 - Enabled during normal operation
 - Disabled during Sleep

Note 1: The CLRWDT and SLEEP instructions clear the WDT and postscaler counts when executed.

- 2: Changing the setting of the IRCF bits (OSCCON<6:4>) clears the WDT and postscaler counts.
- **3:** When a CLRWDT instruction is executed, the postscaler count will be cleared.

WDT Enabled, SWDTEN Disabled WDT Controlled with SWDTEN bit Setting WDT Enabled only While Device Active, Disabled WDT Disabled in Hardware, SWDTEN Disabled Enable WDT WDTEN1-WDTEN0 WDT Counter Wake-up from ÷128 INTRC Source Power-Managed Modes Change on IRCF<2:0> bits -WDT Programmable Postscaler Reset CLRWDT Reset 1:1 to 1:1,048,576 All Device Resets 4 WDTPS<3:0> Sleep Enable WDT SWDTEN WDTEN<1:0> **INTRC Source**

FIGURE 28-1: WDT BLOCK DIAGRAM

查询PIC18F67K90供应商 28.2.1 CONTROL REGISTER

Register 28-16 shows the WDTCON register. This is a readable and writable register which contains a control bit that allows software to override the WDT Enable Configuration bit, but only if the Configuration bit has disabled the WDT.

REGISTER 28-16: WDTCON: WATCHDOG TIMER CONTROL REGISTER

R/W-0	U-0	R-x	R/W-0	U-0	R/W-0	R/W-0	R/W-0
REGSLP	—	ULPLVL ⁽³⁾	SRETEN ⁽²⁾	—	ULPEN	ULPSINK ⁽³⁾	SWDTEN ⁽¹⁾
bit 7							bit 0

Legend:				
R = Readable bit		W = Writable bit	U = Unimplemented bit,	, read as '0'
-n = Value	at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
bit 7	REGSLP: R	egulator Voltage Sleep E	Enable bit	
	0	0	mode when device's Sleep mo when device's Sleep mode is a	
bit 6	Unimpleme	nted: Read as '0'		
bit 5	ULPLVL: UI	tra Low-Power Wake-up	Output bit ⁽³⁾	
		on RA0 > ~0.5V on RA0 < ~0.5V		
bit 4	SRETEN: R	egulator Voltage Sleep [Disable bit ⁽²⁾	
	1 = If RETE mode ir		nd the regulator is enabled, the	e device goes into Ultra Low-Pow
	0 = The reg by REG	•	's Sleep mode is enabled and	the Low-Power mode is controlle
bit 3	Unimpleme	nted: Read as '0'		
bit 2	ULPEN: Ult	ra Low-Power Wake-up	Module Enable bit	
		w-power wake-up modul w-power wake-up modul	e is enabled; ULPLVL bit indica e is disabled	ates comparator output
bit 1	ULPSINK: U	Jltra Low-Power Wake-u	p Current Sink Enable bit ⁽³⁾	
		w-power wake-up curren w power wake-up curren		
bit 0	SWDTEN: S	Software Controlled Wate	hdog Timer Enable bit ⁽¹⁾	
		og Timer is on	-	
		og Timer is off		

Note 1: This bit has no effect if the Configuration bits, WDTEN<1:0>, are enabled.

2: This bit is available only when ENVREG = 1 and $\overline{\text{RETEN}} = 0$.

3: Not valid unless ULPEN = 1.

TABLE 28-2 :	SUMMARY OF WATCHDOG TIMER REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
RCON	IPEN	SBOREN	CM	RI	то	PD	POR	BOR	74
WDTCON	REGSLP	—	ULPLVL	SRETEN		ULPEN	ULPSINK	SWDTEN	74

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Watchdog Timer.

查询PIC18F67K90供应商

28.3 On-Chip Voltage Regulator

All of the PIC18F87K90 family devices power their core digital logic at a nominal 3.3V. For designs that are required to operate at a higher typical voltage, such as 5V, all family devices incorporate two on-chip regulators that allows the device to run its core logic from VDD. Those regulators are:

- Normal On-Chip Regulator
- Ultra Low-Power, On-Chip Regulator

The hardware configuration of these regulators are the same and are explained in **Section 28.3.1**. The regulators' only differences relate to when the device enters Sleep, as explained in **Section 28.3.2**.

28.3.1 REGULATOR ENABLE/DISABLE BY HARDWARE

The regulator can be enabled or disabled only by hardware. The regulator is controlled by the ENVREG pin and the VDDCORE/VCAP pin.

28.3.1.1 Regulator Enable Mode

Tying VDD to the pin enables the regulator, which in turn, provides power to the core from the other VDD pins.

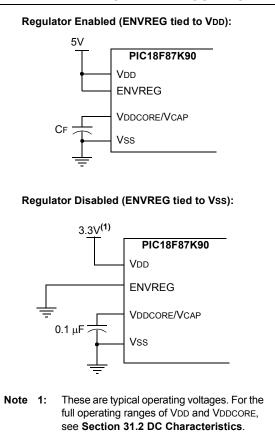
When the regulator is enabled, a low-ESR filter capacitor must be connected to the VDDCORE/VCAP pin (see Figure 28-2). This helps maintain the regulator's stability. The recommended value for the filter capacitor is given in **Section 31.2 DC Characteristics**.

28.3.1.2 Regulator Disable Mode

If ENVREG is tied to Vss, the regulator is disabled. In this case, a 0.1 μF capacitor should be connected to the VDDCORE/VCAP pin (see Figure 28-2).

When the regulator is being used, the overall voltage budget is very tight. The regulator should operate the device down to 1.8V. When VDD drops below 3.3V, the regulator no longer regulates, but the output voltage follows the input until VDD reaches 1.8V. Below this voltage, the output of the regulator output may drop to 0V.

FIGURE 28-2: CONNECTIONS FOR THE ON-CHIP REGULATOR



查询PIC18F67K90供应商

28.3.2 OPERATION OF REGULATOR IN SLEEP

The difference in the two regulators' operation arises with Sleep mode. The ultra low-power regulator gives the device the lowest current in the Regulator Enabled mode.

The on-chip regulator can go into a lower power mode when the device goes to Sleep by setting the REGSLP bit (WDTCON<7>). This puts the regulator in a standby mode so that the device consumes much less current.

The on-chip regulator can also go into the Ultra Low-Power mode, which consumes the lowest current possible with the regulator enabled. This mode is controlled by the RETEN bit (CONFIG1L<0>) and SRETEN bit (WDTCON<4>). The various modes of regulator operation are shown in Table 28-3.

When the ultra low-power regulator is in Sleep mode, the internal reference voltages in the chip will be shut off and any interrupts referring to the internal reference will not wake up the device. If the BOR or LVD is enabled, the regulator will keep the internal references on and the lowest possible current will not be achieved.

When using the ultra low-power regulator in Sleep mode, the device will take about 250 μ s, typical, to start executing the code after it wakes up.

Regulator	Power Mode	VREGSLP WDTCON<7>	SRETEN WDTCON<4>	RETEN CONFIG1L<0>
Enabled	Normal Operation (Sleep)	0	х	1
Enabled	Low-Power mode (Sleep)	1	x	1
Enabled	Normal Operation (Sleep)	0	0	x
Enabled	Low-Power mode (Sleep)	1	0	x
Enabled	Ultra Low-Power mode (Sleep)	x	1	0

TABLE 28-3: SLEEP MODE REGULATOR SETTINGS⁽¹⁾

Note 1: x = Indicates that VIT status is invalid.

查询PIC18F67K90供应商 28.4 Two-Speed Start-up

The Two-Speed Start-up feature helps to minimize the latency period from oscillator start-up to code execution by allowing the microcontroller to use the INTOSC (LF-INTOSC, MF-INTOSC, HF-INTOSC) oscillator as a clock source until the primary clock source is available. It is enabled by setting the IESO Configuration bit.

Two-Speed Start-up should be enabled only if the primary oscillator mode is LP, XT or HS (Crystal-Based modes). Other sources do not require an OST start-up delay; for these, Two-Speed Start-up should be disabled.

When enabled, Resets and wake-ups from Sleep mode cause the device to configure itself to run from the internal oscillator block as the clock source, following the time-out of the Power-up Timer after a Power-on Reset is enabled. This allows almost immediate code execution while the primary oscillator starts and the OST is running. Once the OST times out, the device automatically switches to PRI_RUN mode.

To use a higher clock speed on wake-up, the INTOSC or postscaler clock sources can be selected to provide a higher clock speed by setting bits, IRCF<2:0>, immediately after Reset. For wake-ups from Sleep, the INTOSC or postscaler clock sources can be selected by setting the IRCF2:0> bits prior to entering Sleep mode.

In all other power-managed modes, Two-Speed Startup is not used. The device will be clocked by the currently selected clock source until the primary clock source becomes available. The setting of the IESO bit is ignored.

28.4.1 SPECIAL CONSIDERATIONS FOR USING TWO-SPEED START-UP

While using the INTOSC oscillator in Two-Speed Startup, the device still obeys the normal command sequences for entering power-managed modes, including multiple SLEEP instructions (refer to **Section 4.1.4 "Multiple Sleep Commands"**). In practice, this means that user code can change the SCS<1:0> bit settings or issue SLEEP instructions before the OST times out. This would allow an application to briefly wake-up, perform routine "housekeeping" tasks and return to Sleep before the device starts to operate from the primary oscillator.

User code can also check if the primary clock source is currently providing the device clocking by checking the status of the OSTS bit (OSCCON<3>). If the bit is set, the primary oscillator is providing the clock. Otherwise, the internal oscillator block is providing the clock during wake-up from Reset or Sleep mode.

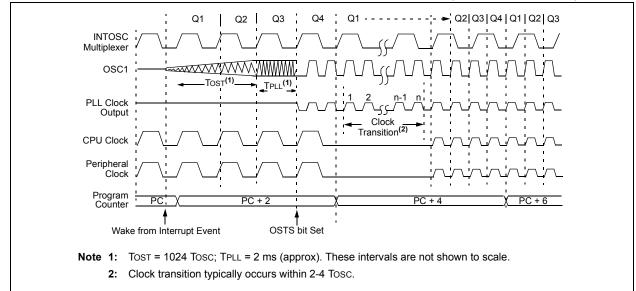
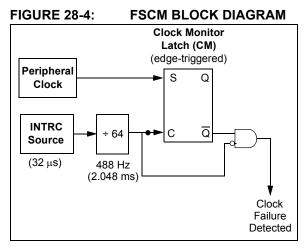


FIGURE 28-3: TIMING TRANSITION FOR TWO-SPEED START-UP (INTOSC TO HSPLL)

查询PIC18F67K90供应商 28.5 Fail-Safe Clock Monitor

The Fail-Safe Clock Monitor (FSCM) allows the microcontroller to continue operation in the event of an external oscillator failure by automatically switching the device clock to the internal oscillator block. The FSCM function is enabled by setting the FCMEN Configuration bit.

When FSCM is enabled, the LF-INTOSC oscillator runs at all times to monitor clocks to peripherals and provide a backup clock in the event of a clock failure. Clock monitoring (shown in Figure 28-4) is accomplished by creating a sample clock signal, which is the output from the LF-INTOSC divided by 64. This allows ample time between FSCM sample clocks for a peripheral clock edge to occur. The peripheral device clock and the sample clock are presented as inputs to the Clock Monitor (CM) latch. The CM is set on the falling edge of the device clock source, but cleared on the rising edge of the sample clock.



Clock failure is tested for on the falling edge of the sample clock. If a sample clock falling edge occurs while CM is still set, a clock failure has been detected (Figure 28-5). This causes the following:

- The FSCM generates an oscillator fail interrupt by setting bit, OSCFIF (PIR2<7>)
- The device clock source switches to the internal oscillator block (OSCCON is not updated to show the current clock source – this is the fail-safe condition)
- The WDT is reset

During switchover, the postscaler frequency from the internal oscillator block may not be sufficiently stable for timing-sensitive applications. In these cases, it may be desirable to select another clock configuration and enter an alternate power-managed mode. This can be done to attempt a partial recovery or execute a controlled shutdown. See Section 4.1.4 "Multiple Sleep Commands" and Section 28.4.1 "Special Considerations for Using Two-Speed Start-up" for more details.

To use a higher clock speed on wake-up, the INTOSC or postscaler clock sources can be selected to provide a higher clock speed by setting bits, IRCF<2:0>, immediately after Reset. For wake-ups from Sleep, the INTOSC or postscaler clock sources can be selected by setting the IRCF<2:0> bits prior to entering Sleep mode.

The FSCM will detect only failures of the primary or secondary clock sources. If the internal oscillator block fails, no failure would be detected nor would any action be possible.

28.5.1 FSCM AND THE WATCHDOG TIMER

Both the FSCM and the WDT are clocked by the INTOSC oscillator. Since the WDT operates with a separate divider and counter, disabling the WDT has no effect on the operation of the INTOSC oscillator when the FSCM is enabled.

As already noted, the clock source is switched to the INTOSC clock when a clock failure is detected. Depending on the frequency selected by the IRCF<2:0> bits, this may mean a substantial change in the speed of code execution. If the WDT is enabled with a small prescale value, a decrease in clock speed allows a WDT time-out to occur and a subsequent device Reset. For this reason, Fail-Safe Clock events also reset the WDT and postscaler, allowing it to start timing from when execution speed was changed, and decreasing the likelihood of an erroneous time-out.

28.5.2 EXITING FAIL-SAFE OPERATION

The Fail-Safe condition is terminated by either a device Reset or by entering a power-managed mode. On Reset, the controller starts the primary clock source specified in Configuration Register 1H (with any required start-up delays that are required for the oscillator mode, such as the OST or PLL timer). The INTOSC multiplexer provides the device clock until the primary clock source becomes ready (similar to a Two-Speed Start-up). The clock source is then switched to the primary clock (indicated by the OSTS bit in the OSCCON register becoming set). The Fail-Safe Clock Monitor then resumes monitoring the peripheral clock.

The primary clock source may never become ready during start-up. In this case, operation is clocked by the INTOSC multiplexer. The OSCCON register will remain in its Reset state until a power-managed mode is entered.

查询PIC18F67K90供应商 **FIGURE 28-5: FSCM TIMING DIAGRAM** Sample Clock Oscillator Device Failure Clock Output CM Output (\overline{Q}) Failure -Detected OSCFIF CM Test CM Test CM Test The device clock is normally at a much higher frequency than the sample clock. The relative frequencies in this Note: example have been chosen for clarity.

28.5.3 FSCM INTERRUPTS IN POWER-MANAGED MODES

By entering a power-managed mode, the clock multiplexer selects the clock source selected by the OSCCON register. Fail-Safe Monitoring of the powermanaged clock source resumes in the power-managed mode.

If an oscillator failure occurs during power-managed operation, the subsequent events depend on whether or not the oscillator failure interrupt is enabled. If enabled (OSCFIF = 1), code execution will be clocked by the INTOSC multiplexer. An automatic transition back to the failed clock source will not occur.

If the interrupt is disabled, subsequent interrupts while in Idle mode will cause the CPU to begin executing instructions while being clocked by the INTOSC source.

28.5.4 POR OR WAKE FROM SLEEP

The FSCM is designed to detect oscillator failure at any point after the device has exited Power-on Reset (POR) or low-power Sleep mode. When the primary device clock is EC, RC or INTRC modes, monitoring can begin immediately following these events. For oscillator modes involving a crystal or resonator (HS, HSPLL, LP or XT), the situation is somewhat different. Since the oscillator may require a start-up time considerably longer than the FCSM sample clock time, a false clock failure may be detected. To prevent this, the internal oscillator block is automatically configured as the device clock and functions until the primary clock is stable (when the OST and PLL timers have timed out).

This is identical to Two-Speed Start-up mode. Once the primary clock is stable, the INTOSC returns to its role as the FSCM source.

Note: The same logic that prevents false oscillator failure interrupts on POR, or wake from Sleep, also prevents the detection of the oscillator's failure to start at all following these events. This can be avoided by monitoring the OSTS bit and using a timing routine to determine if the oscillator is taking too long to start. Even so, no oscillator failure interrupt will be flagged.

As noted in **Section 28.4.1 "Special Considerations for Using Two-Speed Start-up"**, it is also possible to select another clock configuration and enter an alternate power-managed mode while waiting for the primary clock to become stable. When the new powermanaged mode is selected, the primary clock is disabled.

查询PIC18F67K90供应商

28.6 Program Verification and Code Protection

The user program memory is divided into four blocks for the PIC18FX5K90 device and PIC18FX6K90 devices, and eight blocks for PIC18FX7K90 devices. One of these is a boot block of 1 or 2 Kbytes. The remainder of the memory is divided into blocks on binary boundaries. Each of the blocks has three code protection bits associated with them. They are:

- Code-Protect bit (CPn)
- Write-Protect bit (WRTn)
- External Block Table Read bit (EBTRn)

Figure 28-6 shows the program memory organization for 48, 64, 96 and 128-Kbyte devices and the specific code protection bit associated with each block. The actual locations of the bits are summarized in Table 28-4.

FIGURE 28-6: CODE-PROTECTED PROGRAM MEMORY FOR THE PIC18F87K90 FAMILY

	\		PIC18	=X7K90	PIC18F	PIC18FX6K90		PIC18FX5K90	
		\land	BBSIZ = 1	BBSIZ = 0	BBSIZ = 1	BBSIZ = 0	BBSIZ = 1	BBSIZ = 0	Address
	Unimplemented		Boot Block	Boot Block	Boot Block	Boot Block	Boot Block	Boot Block	0000h
	Read as '0'		2 kW Block 0	Block 0 7 kW	2 kW Block 0 6 kW	Block 0 7 kW	2 kW Block 0 2 kW	Block 0 3 kW	0800h 1000h 17FFh
			6 kW	7 KVV			Block 1 4 kW	Block 1 4 kW	1800 3FFF
			Block 1	Block 1	Block 1 8 kW	Block 1 8 kW	Block 2 4 kW		4000h 5FFFh
200000h			8 kW	8 kW			Block 3 4 kW		6000h 7FFF
			Block 2 8 kW	Block 2 8 kW	Block 2 8 kW	Block 2 8 kW			8000h BFFFh
			Block 3 8 kW	Block 3 8 kW	Block 3 8 kW	Block 3 8 kW			C000h FFFFh
	Configuration and ID Space		Block 4 8 kW	Block 4 8 kW					10000h 13FFFh
	Cpull		Block 5 8 kW	Block 5 8 kW					14000h 17FFFh
			Block 6 8 kW	Block 6 8 kW					18000h 1BFFFh
			Block 7 8 kW	Block 7 8 kW					1C000h 1FFFFh
BFFFFFh									

查询PIC18F67K90供应商

TABLE 28-4: SUMMARY OF CODE PROTECTION REGISTERS

			-						_
File	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
300008h	CONFIG5L	CP7 ⁽¹⁾	CP6 ⁽¹⁾	CP5 ⁽¹⁾	CP4 ⁽¹⁾	CP3	CP2	CP1	CP0
300009h	CONFIG5H	CPD	CPB		—		_		_
30000Ah	CONFIG6L	WRT7 ⁽¹⁾	WRT6 ⁽¹⁾	WRT5 ⁽¹⁾	WRT4 ⁽¹⁾	WRT3	WRT2	WRT1	WRT0
30000Bh	CONFIG6H	WRTD	WRTB	WRTC	_				_
30000Ch	CONFIG7L	EBRT7 ⁽¹⁾	EBRT6 ⁽¹⁾	EBTR5 ⁽¹⁾	EBTR4 ⁽¹⁾	EBTR3	EBTR2	EBTR1	EBTR0
30000Dh	CONFIG7H	_	EBTRB			_			_

Legend: Shaded cells are unimplemented.

Note 1: This bit is available only on the PIC18F67K90 and PIC18F87K90 devices.

28.6.1 PROGRAM MEMORY CODE PROTECTION

The program memory may be read to, or written from, any location using the table read and table write instructions. The Device ID may be read with table reads. The Configuration registers may be read and written with the table read and table write instructions.

In normal execution mode, the CPn bits have no direct effect. CPn bits inhibit external reads and writes. A block of user memory may be protected from table writes if the WRTn Configuration bit is '0'.

The EBTRn bits control table reads. For a block of user memory with the EBTRn bit set to '0', a table read instruction that executes from within that block is allowed to read. A table read instruction that executes from a

location outside of that block is not allowed to read and will result in reading '0's. Figures 28-7 through 28-9 illustrate table write and table read protection.

Note: Code protection bits may only be written to a '0' from a '1' state. It is not possible to write a '1' to a bit in the '0' state. Code protection bits are only set to '1' by a full chip erase or block erase function. The full chip erase and block erase functions can only be initiated via ICSP or an external programmer. Refer to the device programming specification for more information.

Register Values Program Memory Configuration Bit Settings 000000h WRTB. EBTRB = 11 0007FFh 000800h TBLPTR = 0008FFh WRT0. EBTR0 = 01 PC = 003FFEhTBLWT* 003FFFh 004000h WRT1, EBTR1 = 11 007FFFh 008000h PC = 00BFFEhTBLWT* WRT2, EBTR2 = 11 00BFFFh 00C000h WRT3, EBTR3 = 11 00FFFFh **Results:** All table writes are disabled to Blockn whenever WRTn = 0.

FIGURE 28-7: TABLE WRITE (WRTn) DISALLOWED

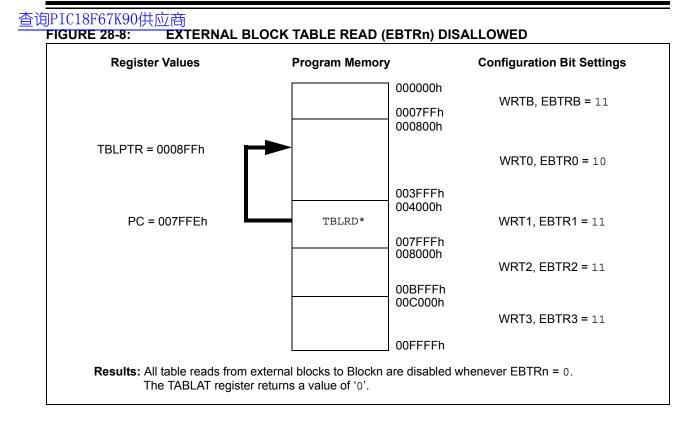
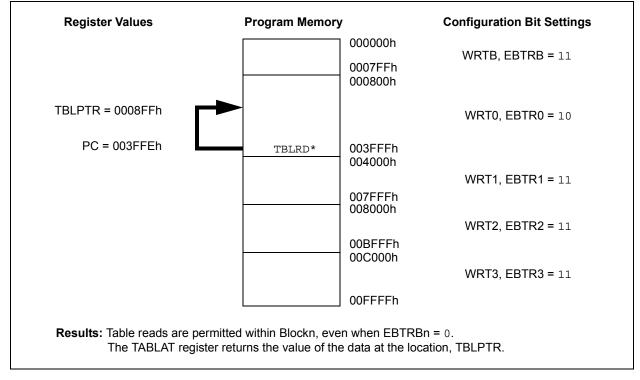


FIGURE 28-9: EXTERNAL BLOCK TABLE READ (EBTRn) ALLOWED



查询PIC18F67K90供应商 28.6.2 DATA EEPROM CODE PROTECTION

The entire data EEPROM is protected from external reads and writes by two bits: CPD and WRTD. CPD inhibits external reads and writes of data EEPROM. WRTD inhibits internal and external writes to data EEPROM. The CPU can always read data EEPROM under normal operation, regardless of the protection bit settings.

28.6.3 CONFIGURATION REGISTER PROTECTION

The Configuration registers can be write-protected. The WRTC bit controls protection of the Configuration registers. In normal execution mode, the WRTC bit is readable only. WRTC can only be written via ICSP or an external programmer.

28.7 ID Locations

Eight memory locations (20000h-200007h) are designated as ID locations, where the user can store checksum or other code identification numbers. These locations are both readable and writable during normal execution through the TBLRD and TBLWT instructions or during program/verify. The ID locations can be read when the device is code-protected.

28.8 In-Circuit Serial Programming

The PIC18F87K90 family of devices can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data, and three other lines for power, ground and the programming voltage. This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed. For the various programming modes, please refer to the device programming specification.

28.9 In-Circuit Debugger

When the DEBUG Configuration bit is programmed to a '0', the In-Circuit Debugger functionality is enabled. This function allows simple debugging functions when used with MPLAB[®] IDE. When the microcontroller has this feature enabled, some resources are not available for general use. Table 28-5 shows which resources are required by the background debugger.

I/O Pins:	RB6, RB7
Stack:	Two Levels
Program Memory:	512 Bytes
Data Memory:	10 Bytes

To use the In-Circuit Debugger function of the microcontroller, the design must implement In-Circuit Serial Programming connections to MCLR/RG5/VPP, VDD, Vss, RB7 and RB6. This will interface to the In-Circuit Debugger module available from Microchip or one of the third party development tool companies.

查询PIC18F67K90供应商 29.0 INSTRUCTION SET SUMMARY

The PIC18F87K90 family of devices incorporates the standard set of 75 PIC18 core instructions, as well as an extended set of 8 new instructions for the optimization of code that is recursive or that utilizes a software stack. The extended set is discussed later in this section.

29.1 Standard Instruction Set

The standard PIC18 MCU instruction set adds many enhancements to the previous PIC[®] MCU instruction sets, while maintaining an easy migration from these PIC MCU instruction sets. Most instructions are a single program memory word (16 bits), but there are four instructions that require two program memory locations.

Each single-word instruction is a 16-bit word divided into an opcode, which specifies the instruction type and one or more operands, which further specify the operation of the instruction.

The instruction set is highly orthogonal and is grouped into four basic categories:

- Byte-oriented operations
- Bit-oriented operations
- · Literal operations
- Control operations

The PIC18 instruction set summary in Table 29-2 lists **byte-oriented**, **bit-oriented**, **literal** and **control** operations. Table 29-1 shows the opcode field descriptions.

Most byte-oriented instructions have three operands:

- 1. The file register (specified by 'f')
- 2. The destination of the result (specified by 'd')
- 3. The accessed memory (specified by 'a')

The file register designator, 'f', specifies which file register is to be used by the instruction. The destination designator, 'd', specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the WREG register. If 'd' is one, the result is placed in the file register specified in the instruction.

All **bit-oriented** instructions have three operands:

- 1. The file register (specified by 'f')
- 2. The bit in the file register (specified by 'b')
- 3. The accessed memory (specified by 'a')

The bit field designator, 'b', selects the number of the bit affected by the operation, while the file register designator, 'f', represents the number of the file in which the bit is located.

The **literal** instructions may use some of the following operands:

- A literal value to be loaded into a file register (specified by 'k')
- The desired FSR register to load the literal value into (specified by 'f')
- No operand required (specified by '—')

The **control** instructions may use some of the following operands:

- A program memory address (specified by 'n')
- The mode of the CALL or RETURN instructions (specified by 's')
- The mode of the table read and table write instructions (specified by 'm')
- No operand required (specified by '—')

All instructions are a single word, except for four double-word instructions. These instructions were made double-word to contain the required information in 32 bits. In the second word, the 4 MSbs are '1's. If this second word is executed as an instruction (by itself), it will execute as a NOP.

All single-word instructions are executed in a single instruction cycle, unless a conditional test is true or the program counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles with the additional instruction cycle(s) executed as a NOP.

The double-word instructions execute in two instruction cycles.

One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μ s. If a conditional test is true, or the program counter is changed as a result of an instruction, the instruction execution time is 2 μ s. Two-word branch instructions (if true) would take 3 μ s.

Figure 29-1 shows the general formats that the instructions can have. All examples use the convention 'nnh' to represent a hexadecimal number.

The Instruction Set Summary, shown in Table 29-2, lists the standard instructions recognized by the Microchip MPASM[™] Assembler.

Section 29.1.1 "Standard Instruction Set" provides a description of each instruction.

▲ The second s

Field	Description
a	RAM access bit:
	a = 0: RAM location in Access RAM (BSR register is ignored)
	a = 1: RAM bank is specified by BSR register
bbb	Bit address within an 8-bit file register (0 to 7).
BSR	Bank Select Register. Used to select the current RAM bank.
C, DC, Z, OV, N	ALU Status bits: Carry, Digit Carry, Zero, Overflow, Negative.
d	Destination select bit:
	d = 0: store result in WREG
	d = 1: store result in file register f
dest	Destination: either the WREG register or the specified register file location.
f	8-bit register file address (00h to FFh), or 2-bit FSR designator (0h to 3h).
fs	12-bit register file address (000h to FFFh). This is the source address.
f _d	12-bit register file address (000h to FFFh). This is the destination address.
GIE	Global Interrupt Enable bit.
k	Literal field, constant data or label (may be either an 8-bit, 12-bit or a 20-bit value).
label	Label name.
mm	The mode of the TBLPTR register for the table read and table write instructions. Only used with table read and table write instructions:
*	No Change to register (such as TBLPTR with table reads and writes)
*+	Post-Increment register (such as TBLPTR with table reads and writes)
*_	Post-Decrement register (such as TBLPTR with table reads and writes)
+*	Pre-Increment register (such as TBLPTR with table reads and writes)
n	The relative address (2's complement number) for relative branch instructions or the direct address for
	Call/Branch and Return instructions.
PC	Program Counter.
PCL	Program Counter Low Byte.
PCH	Program Counter High Byte.
PCLATH	Program Counter High Byte Latch.
PCLATU	Program Counter Upper Byte Latch.
PD	Power-Down bit.
PRODH	Product of Multiply High Byte.
PRODL	Product of Multiply Low Byte.
S	Fast Call/Return mode select bit:
	s = 0: do not update into/from shadow registers
	s = 1: certain registers loaded into/from shadow registers (Fast mode)
TBLPTR	21-bit Table Pointer (points to a Program Memory location).
TABLAT	8-bit Table Latch.
TO	Time-out bit.
TOS	Top-of-Stack.
u	Unused or Unchanged.
WDT	Watchdog Timer.
WREG	Working register (accumulator).
x	Don't care ('0' or '1'). The assembler will generate code with $x = 0$. It is the recommended form of use for compatibility with all Microchip software tools.
Zs	7-bit offset value for Indirect Addressing of register files (source).
z _d	7-bit offset value for Indirect Addressing of register files (destination).
{ }	Optional argument.
[text]	Indicates an Indexed Address.
(text)	The contents of text.
[expr] <n></n>	Specifies bit n of the register indicated by the pointer expr.
\rightarrow	Assigned to.
< >	Register bit field.
E	In the set of.

Byte-oriented file register operations	Example Instruction
<u>15 10 9 8 7 0</u>	
OPCODE d a f (FILE #)	ADDWF MYREG, W, B
d = 0 for result destination to be WREG register	
d = 1 for result destination to be file register (f) a = 0 to force Access Bank	
a = 1 for BSR to select bank f = 8-bit file register address	
Byte to Byte move operations (2-word)	
15 12 11 0	
OPCODE f (Source FILE #)	MOVFF MYREG1, MYREG2
15 12 11 0	
1111 f (Destination FILE #)	
f = 12-bit file register address	
-	
Bit-oriented file register operations	
OPCODE b (BIT #) a f (FILE #)	BSF MYREG, bit, B
b = 3-bit position of bit in file register (f) a = 0 to force Access Bank	
a = 1 for BSR to select bank	
f = 8-bit file register address	
Literal operations	
15 8 7 0	
OPCODE k (literal)	MOVLW 7Fh
k = 8-bit immediate value	
Control operations	
CALL, GOTO and Branch operations	
15 8 7 0	
OPCODE n<7:0> (literal)	GOTO Label
15 12 11 0	
1111 n<19:8> (literal)	
n = 20-bit immediate value	
<u>15 8 7 0</u>	
OPCODE S n<7:0> (literal)	CALL MYFUNC
15 12 11 0	
1111 n<19:8> (literal)	
S = Fast bit	
15 11 10 0	
OPCODE n<10:0> (literal)	BRA MYFUNC
15 8 7 0 OPCODE n<7:0> (literal)	
$()\cup(:())\cup = n<7:0>(literal)$	BC MYFUNC

查询PIC18F67K90供应商

TABLE 29-2: PIC18F87K90 FAMILY INSTRUCTION SET

Mnemo	onic,	Description	Cueles	16-Bit Instruction Word				Status	Natas	
Operands		Description	Cycles	MSb	ISb LSb		LSb	Affected	Notes	
BYTE-ORI	ENTED	OPERATIONS								
ADDWF	f, d, a	Add WREG and f	1	0010	01da	ffff	ffff	C, DC, Z, OV, N	1, 2	
ADDWFC	f, d, a	Add WREG and Carry bit to f	1	0010	00da	ffff	ffff	C, DC, Z, OV, N	1, 2	
ANDWF	f, d, a	AND WREG with f	1	0001	01da	ffff	ffff	Z, N	1,2	
CLRF	f, a	Clear f	1	0110	101a	ffff	ffff	Z	2	
COMF	f, d, a	Complement f	1	0001	11da	ffff	ffff	Z, N	1, 2	
CPFSEQ	f, a	Compare f with WREG, Skip =	1 (2 or 3)	0110	001a	ffff	ffff	None	4	
CPFSGT	f, a	Compare f with WREG, Skip >	1 (2 or 3)	0110	010a	ffff	ffff	None	4	
CPFSLT	f, a	Compare f with WREG, Skip <	1 (2 or 3)	0110	000a	ffff	ffff	None	1, 2	
DECF	f, d, a	Decrement f	1	0000	01da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4	
DECFSZ	f, d, a	Decrement f, Skip if 0	1 (2 or 3)	0010	11da	ffff	ffff	None	1, 2, 3, 4	
DCFSNZ	f, d, a	Decrement f, Skip if Not 0	1 (2 or 3)	0100	11da	ffff	ffff	None	1, 2	
INCF	f, d, a	Increment f	1	0010	10da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4	
INCFSZ	f, d, a	Increment f, Skip if 0	1 (2 or 3)	0011	11da	ffff	ffff	None	4	
INFSNZ	f, d, a	Increment f, Skip if Not 0	1 (2 or 3)	0100	10da	ffff	ffff	None	1, 2	
IORWF	f, d, a	Inclusive OR WREG with f	1 ΄	0001	00da	ffff	ffff	Z, N	1, 2	
MOVF	f, d, a	Move f	1	0101	00da	ffff	ffff	Z, N	1	
MOVFF	f _s , f _d	Move f _s (source) to 1st word	2	1100	ffff	ffff	ffff	None		
	3, u	f _d (destination) 2nd word		1111	ffff	ffff	ffff			
MOVWF	f, a	Move WREG to f	1	0110	111a	ffff	ffff	None		
MULWF	f, a	Multiply WREG with f	1	0000	001a	ffff	ffff	None	1, 2	
NEGF	f, a	Negate f	1	0110	110a	ffff	ffff	C, DC, Z, OV, N	-	
RLCF	f, d, a	Rotate Left f through Carry	1	0011	01da	ffff	ffff	C, Z, N	1, 2	
RLNCF	f, d, a	Rotate Left f (No Carry)	1	0100	01da	ffff	ffff	Z, N	-	
RRCF	f, d, a	Rotate Right f through Carry	1	0011	00da	ffff	ffff	C, Z, N		
RRNCF	f, d, a	Rotate Right f (No Carry)	1	0100	00da	ffff	ffff	Z, N		
SETF	f, a	Set f	1	0110	100a	ffff	ffff	None	1, 2	
SUBFWB	f, d, a	Subtract f from WREG with	1	0101	01da	ffff	ffff	C, DC, Z, OV, N		
		Borrow								
SUBWF	f, d, a	Subtract WREG from f	1	0101	11da	ffff	ffff	C, DC, Z, OV, N	1, 2	
SUBWFB	f, d, a	Subtract WREG from f with	1	0101	10da	ffff	ffff	C, DC, Z, OV, N		
		Borrow								
SWAPF	f, d, a	Swap Nibbles in f	1	0011	10da	ffff	ffff	None	4	
TSTFSZ	f, a	Test f, Skip if 0	1 (2 or 3)	0110	011a	ffff	ffff	None	1, 2	
XORWF	f, d, a	Exclusive OR WREG with f	1	0001	10da	ffff	ffff	Z, N		

Note 1: When a PORT register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.

3: If the Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

4: Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

查询PIC18F67K90供应商

TABLE 29-2: PIC18F87K90 FAMILY INSTRUCTION SET (CONTINUED)

Mnem	onic,	Description	0	16-	Bit Instr	uction V	Vord	Status	Natas
Operands		Description	Cycles	MSb		LSb		Affected	Notes
BIT-ORIE	NTED O	PERATIONS							
BCF	f, b, a	Bit Clear f	1	1001	bbba	ffff	ffff	None	1, 2
BSF	f, b, a	Bit Set f	1	1000	bbba	ffff	ffff	None	1, 2
BTFSC	f, b, a	Bit Test f, Skip if Clear	1 (2 or 3)	1011	bbba	ffff	ffff	None	3, 4
BTFSS	f, b, a	Bit Test f, Skip if Set	1 (2 or 3)	1010	bbba	ffff	ffff	None	3, 4
BTG	f, b, a	Bit Toggle f	1	0111	bbba	ffff	ffff	None	1, 2
CONTRO	L OPER	ATIONS	•					•	
вс	n	Branch if Carry	1 (2)	1110	0010	nnnn	nnnn	None	
BN	n	Branch if Negative	1 (2)	1110	0110	nnnn	nnnn	None	
BNC	n	Branch if Not Carry	1 (2)	1110	0011	nnnn	nnnn	None	
BNN	n	Branch if Not Negative	1 (2)	1110	0111	nnnn	nnnn	None	
BNOV	n	Branch if Not Overflow	1 (2)	1110	0101	nnnn	nnnn	None	
BNZ	n	Branch if Not Zero	1 (2)	1110	0001	nnnn	nnnn	None	
BOV	n	Branch if Overflow	1 (2)	1110	0100	nnnn	nnnn	None	
BRA	n	Branch Unconditionally	2	1101	0nnn	nnnn	nnnn	None	
BZ	n	Branch if Zero	1 (2)	1110	0000	nnnn	nnnn	None	
CALL	n, s	Call Subroutine 1st word	2	1110	110s	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
CLRWDT	_	Clear Watchdog Timer	1	0000	0000	0000	0100	TO, PD	
DAW	_	Decimal Adjust WREG	1	0000	0000	0000	0111	С	
GOTO	n	Go to Address 1st word	2	1110	1111	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
NOP	—	No Operation	1	0000	0000	0000	0000	None	
NOP	—	No Operation	1	1111	xxxx	xxxx	xxxx	None	4
POP	_	Pop Top of Return Stack (TOS)	1	0000	0000	0000	0110	None	
PUSH	—	Push Top of Return Stack (TOS)	1	0000	0000	0000	0101	None	
RCALL	n	Relative Call	2	1101	1nnn	nnnn	nnnn	None	
RESET		Software Device Reset	1	0000	0000	1111	1111		
RETFIE	S	Return from Interrupt Enable	2	0000	0000	0001	000s	GIE/GIEH, PEIE/GIEL	
RETLW	k	Return with Literal in WREG	2	0000	1100	kkkk	kkkk	None	
RETURN	s	Return from Subroutine	2	0000	0000	0001	001s	None	
SLEEP	_	Go into Standby mode	1	0000	0000	0000	0011	TO, PD	

Note 1: When a PORT register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.

3: If the Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

4: Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

查询PIC18F67K90供应商

TABLE 29-2: PIC18F87K90 FAMILY INSTRUCTION SET (CONTINUED)

IABLE 2	J-Z.										
Mnemo	onic,	Description	Cycles	16-	Bit Inst	ruction	Word	Status	Notes		
Operands		Description	Cycles	MSb			LSb	Affected	Notes		
LITERAL	OPERA	TIONS									
ADDLW	k	Add Literal and WREG	1	0000	1111	kkkk	kkkk	C, DC, Z, OV, N			
ANDLW	k	AND Literal with WREG	1	0000	1011	kkkk	kkkk	Z, N			
IORLW	k	Inclusive OR Literal with WREG	1	0000	1001	kkkk	kkkk	Z, N			
LFSR	f, k	Move literal (12-bit) 2nd word	2	1110	1110	00ff	kkkk	None			
		to FSR(f) 1st word		1111	0000	kkkk	kkkk				
MOVLB	k	Move Literal to BSR<3:0>	1	0000	0001	0000	kkkk	None			
MOVLW	k	Move Literal to WREG	1	0000	1110	kkkk	kkkk	None			
MULLW	k	Multiply Literal with WREG	1	0000	1101	kkkk	kkkk	None			
RETLW	k	Return with Literal in WREG	2	0000	1100	kkkk	kkkk	None			
SUBLW	k	Subtract WREG from Literal	1	0000	1000	kkkk	kkkk	C, DC, Z, OV, N			
XORLW	k	Exclusive OR Literal with WREG	1	0000	1010	kkkk	kkkk	Z, N			
DATA MEI	MORY	→ PROGRAM MEMORY OPERAT	IONS								
TBLRD*		Table Read	2	0000	0000	0000	1000	None			
TBLRD*+		Table Read with Post-Increment		0000	0000	0000	1001	None			
TBLRD*-		Table Read with Post-Decrement		0000	0000	0000	1010	None			
TBLRD+*		Table Read with Pre-Increment		0000	0000	0000	1011	None			
TBLWT*		Table Write	2	0000	0000	0000	1100	None			
TBLWT*+		Table Write with Post-Increment		0000	0000	0000	1101	None			
TBLWT*-		Table Write with Post-Decrement		0000	0000	0000	1110	None			
TBLWT+*		Table Write with Pre-Increment		0000	0000	0000	1111	None			

Note 1: When a PORT register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.

3: If the Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

4: Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

ADD W to f ADDWF

 $0 \leq f \leq 255$ $d \in [0\,,1]$ a ∈ [0,1] $(W) + (f) \rightarrow dest$ N, OV, C, DC, Z

0010

GPR bank.

Q2

Read

register 'f

ADDWF

17h

0C2h

0D9h

0C2h

=

=

W

REG

f {,d {,a}}

01da

Add W to register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f'. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 29.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details.

Q3

Process

Data

REG, 0, 0

ffff

ffff

Q4

Write to

destination

查询PIC18F67K90供应商 STANDARD INSTRUCTION SET 29.1.1

ADD	LW	ADD Litera	l to W		ADDWF	AI
Synt	ax:	ADDLW	k		Syntax:	A
Oper	rands:	$0 \le k \le 255$			Operands:	0 :
Oper	ration:	$(W) + k \rightarrow V$	N			d
Statu	is Affected:	N, OV, C, D	Ю, Z		Operation:	a (W
Enco	oding:	0000	1111 kkl	kk kkkk	Status Affected:	(V) N,
Desc	cription:		ts of W are ad k' and the res	ded to the ult is placed in	Encoding: Description:	Ac
Word	ds:	1				re
Cycl	es:	1				re
QC	vcle Activity:					lf ' If '
	Q1	Q2	Q3	Q4		GI
	Decode	Read literal 'k'	Process Data	Write to W		lf ' se
<u>Exar</u>	n <u>ple:</u> Before Instruct W =		5h			in M Se Bi Li
	After Instructio W =	n 25h			Words:	1
	vv –	2011			Cycles:	1
					Q Cycle Activity: Q1	
					Decode	F reg
					Example:	AI
					Before Instructi W REG	on = =
					After Instruction	۱

All PIC18 instructions may take an optional label argument preceding the instruction mnemonic for use in Note: symbolic addressing. If a label is used, the instruction format then becomes: {label} instruction argument(s).

Preliminary

ADDWFC ADD W and Carry bit to f					
Syntax:	ADDWFC	f {,d {,a}]	}		
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d \in [0,1] \\ a \in [0,1] \end{array}$				
Operation:	(W) + (f) +	$(C) \rightarrow dest$	t		
Status Affected:	N,OV, C, D	C, Z			
Encoding:	0010	00da	ffff	ffff	
Description:	Add W, the location 'f'. placed in V placed in d	lf 'd' is '0', V. lf 'd' is '1	the resu	ult is sult is	
	If 'a' is '0', t If 'a' is '1', t GPR bank.	he BSR is i			
	If 'a' is '0' a set is enab in Indexed mode wher Section 29 Bit-Oriente Literal Offs	led, this ins Literal Offs never $f \le 95$ 0.2.3 "Byte ed Instruct	struction set Addre 5 (5Fh). -Oriente tions in	operates essing See ed and Indexed	
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
Decode	Read register 'f'	Process Data		/rite to stination	
Example:	ADDWFC	REG, (D, 1		
Before Instruct Carry bit REG W After Instructio Carry bit REG	= 1 = 02h = 4Dh				
W	= 50h				

	LW	AND Liter	al with W	1		
Synta	IX:	ANDLW	k			
Opera	ands:	$0 \le k \le 255$	5			
Opera	ation:	(W) .AND.	$k \rightarrow W$			
Status	s Affected:	N, Z				
Enco	ding:	0000	1011	kkk	kk kkkk	
Desci	ription:	The conter 8-bit literal				
Words:		1				
Cycle	s:	1				
QC	cle Activity:					
_	Q1	Q2	Q3	8		Q4
	Decode	Read literal 'k'	Proce Data		V	Vrite to W
<u>Exam</u>	iple:	ANDLW	05Fh			
Before Instructio W = After Instruction		= A3h				
/	W	= 03h				

查询PIC18F67K90供应商

ANDWF	AND W wit	h f	
Syntax:	ANDWF	f {,d {,a}}	
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d \in [0,1] \\ a \in [0,1] \end{array}$		
Operation:	(W) .AND. ((f) \rightarrow dest	
Status Affected:	N, Z		
Encoding:	0001	01da ff:	ff ffff
Description:	register 'f'. I	; '1', the result	IDed with esult is stored is stored back
			nk is selected. d to select the
	set is enabl in Indexed I mode when Section 29 Bit-Oriente	nd the extende ed, this instruct Literal Offset A lever f ≤ 95 (5) .2.3 "Byte-Or ed Instruction set Mode" for	ction operates Addressing Fh). See iented and s in Indexed
Words:	1		
Cycles:	1		
Q Cycle Activity:			
Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination
Example:	ANDWF	REG, 0, 0	
Before Instruc W REG	= 17h		
After Instructio	= C2h		

B 0		Duran h if i	•		
BC		Branch if (Sarry		
Synta	ax:	BC n			
Oper	ands:	-128 \leq n \leq	127		
Oper	ation:	if Carry bit (PC) + 2 +		;	
Statu	is Affected:	None			
Enco	oding:	1110	0010	nnnn	nnnn
Desc	cription:	If the Carry will branch.		, then the	program
The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.					
Word	ls:	1			
Cycle	es:	1(2)			
Q C If Ju	ycle Activity: imp:				
	Q1	Q2	Q3	3	Q4
	Decode	Read literal 'n'	Proce Data		Vrite to PC
	No	No	No		No
	operation	operation	operat	ion op	peration
lf No	o Jump:				<i></i>
	Q1	Q2	Q3		Q4
	Decode	Read literal 'n'	Proce Data		No peration
	<u> </u>	11	Dala		
Exan	nple:	HERE	BC	5	
	Before Instruct PC After Instruction	= ad	dress (1	HERE)	
	If Carry PC If Carry	= 0;		HERE + 1	L2)
	PC	= ad	dress (1	HERE + 2	2)

查询PIC18F67K90供应商

BCF	Bit Clear f			BN
Syntax:	BCF f, b	{,a}		Synta:
Operands:	$0 \leq f \leq 255$			Opera
	$\begin{array}{l} 0 \leq b \leq 7 \\ a \in [0,1] \end{array}$			Opera
Operation:	$0 \rightarrow f \le b >$			Status
Status Affected:	None			Encoc
Encoding:	1001	bbba ff	ff ffff	Descr
Description:	Bit 'b' in reg	jister 'f' is clea	red.	2000.
	,	he Access Bar he BSR is use	nk is selected. d to select the	
	set is enabl in Indexed I mode when Section 29 Bit-Oriente	nd the extende ed, this instruc Literal Offset A ever f ≤ 95 (51 .2.3 "Byte-Ori d Instruction	ction operates addressing =h). See iented and s in Indexed	Words Cycles Q Cy
\A/anda.		set Mode" for	detalls.	lf Jun
Words:	1			-
Cycles:	1			
Q Cycle Activity: Q1	Q2	Q3	Q4	-
Decode	Read	Process	Write	1
	register 'f'	Data	register 'f'	lf No
After Instruction	tion EG = C7h	LAG_REG,	7, 0	Exam E
				A

BN	Branch if N	legative		
Syntax:	BN n			
Operands:	-128 ≤ n ≤ ′	127		
Operation:	if Negative (PC) + 2 +			
Status Affected:	None			
Encoding:	1110	0110 n	nnn	nnnn
Description:	If the Nega program wi	tive bit is '1', Il branch.	then t	he
The 2's complement number '2n' is added to the PC. Since the PC will ha incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.				
Words:	1			
Cycles:	1(2)			
Q Cycle Activity: If Jump:				
Q1	Q2	Q3		Q4
Decode	Read literal 'n'	Process Data	V	/rite to PC
No operation	No operation	No operation	00	No eration
If No Jump:	operation	operation	U UP	eration
Q1	Q2	Q3		Q4
Decode	Read literal	Process		No
	'n'	Data	ор	eration
Example:	HERE	BN Jun	ıp	
Before Instruction PC = address (HERE) After Instruction If Negative = 1; PC = address (Jump) If Negative = 0;				

查询PIC18F67K90供应商

BNC	Branch if N	lot Carry		BNN		
Syntax:	BNC n	BNC n				
Operands:	-128 ≤ n ≤ ′	-128 ≤ n ≤ 127				
Operation:		if Carry bit is '0', (PC) + 2 + 2n \rightarrow PC				
Status Affected:	None			Status Affe		
Encoding:	1110	0011 nn	nn nnnn	Encoding:		
Description:	If the Carry will branch.	bit is '0', then	the program	Descriptio		
	added to the incremente instruction,	d to fetch the the new addr n. This instruc	e PC will have next ess will be			
Words:	1			Words:		
Cycles:	1(2)			Cycles:		
Q Cycle Activity: If Jump:				Q Cycle A If Jump:		
Q1	Q2	Q3	Q4			
Decode	Read literal 'n'	Process Data	Write to PC	De		
No operation	No operation	No operation	No operation	ope		
If No Jump:				If No Jum		
Q1	Q2	Q3	Q4	, <u> </u>		
Decode	Read literal 'n'	Process Data	No operation	De		
Example:	HERE	BNC Jump)	Example:		
Before Instru	ction			Befor		
PC		dress (HERE)	A G =		
After Instructi If Carry	on = 0;			After		
PC	= ad	dress (Jump)			
If Carry PC	= 1; = ad	dress (HERE	+ 2)			

BNN		Branch if N	Not Negative	9			
Synta	ax:	BNN n					
Oper	ands:	-128 ≤ n ≤ 1	127				
Oper	ation:	if Negative (PC) + 2 +					
Statu	is Affected:	None	None				
Enco	oding:	1110	0111 ni	nnn nnnn			
Desc	ription:	If the Nega program wi	tive bit is '0', Il branch.	then the			
		added to th incremente instruction, PC + 2 + 2	The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.				
Word	ls:	1					
Cycle	es:	1(2)					
Q C If Ju	•						
	Q1	Q2	Q3	Q4			
	Decode	Read literal 'n'	Process Data	Write to PC			
	No	No	No	No			
	operation	operation	operation	operation			
If No	o Jump:	~~	~	~ ~ ~			
	Q1	Q2 Read literal	Q3	Q4 No			
	Decode	read literal	Process Data	operation			
	<u> </u>		Data	operation			
Exan	nple:	HERE	BNN Jum	þ			
	Before Instruc PC After Instructio	= ad	dress (HER	Ε)			
	If Negativ PC	/e = 0; = ad	dress (Jumj	<u>o</u>)			
	If Negativ PC		dress (HER	E + 2)			

© 2010 Microchip Technology Inc.

BNOV Branch if Not Overflow					
Synta	ax:	BNOV n			
Oper	ands:	-128 ≤ n ≤ 1	127		
Oper	ation:	if Overflow (PC) + 2 + 2	,		
Statu	is Affected:	None			
Enco	oding:	1110	0101 nni	nn nnnn	
Desc	cription:	If the Overfi program wit	low bit is '0', th Il branch.	nen the	
The 2's complement number '2n' is added to the PC. Since the PC will hav incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.					
Word	ls:	1			
Cycle	es:	1(2)			
Q C If Ju	ycle Activity: imp:				
	Q1	Q2	Q3	Q4	
	Decode	Read literal 'n'	Process Data	Write to PC	
	No operation	No operation	No operation	No operation	
lf No	o Jump:				
	Q1	Q2	Q3	Q4	
	Decode	Read literal 'n'	Process Data	No operation	
Exan	nple:	HERE	BNOV Jump		
	Before Instruc PC After Instructio	= ad	dress (here)	
	If Overflo PC If Overflo PC	= ad w = 1;	dress (Jump dress (HERE	,	

Syntax: Operands: Operation: Status Affected: Encoding: Description:	BNZ n $-128 \le n \le 7$ if Zero bit is (PC) + 2 + 2 None 1110 If the Zero	s '0', 2n → PC	
Operation: Status Affected: Encoding:	if Zero bit is (PC) + 2 + 2 None	s '0', 2n → PC	
Status Affected: Encoding:	(PC) + 2 + 2 None	$2n \rightarrow PC$	
Encoding:	1110	0001 n	
e e		0001 m	
Description:	If the Zero I	0001 11	nnn nnnn
	will branch.	,	the program
	added to the incremente instruction,	d to fetch the the new add n. This instru	the PC will hav e next
Words:	1		
Cycles:	1(2)		
Q Cycle Activity: If Jump:			
Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation
If No Jump:			
Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	No operation
	•	•	•
Example:	HERE	BNZ Jum	Þ

PC After Instruction	=	address (HERE)
If Zero PC If Zero PC	= = =	0; address (Jump) 1; address (HERE + 2)

BRA	Unconditional Branch						
Synta	ax:	BRA n					
Oper	ands:	-1024 ≤ n ≤	1023				
Oper	ation:	(PC) + 2 + 2	$2n \rightarrow PC$				
Statu	s Affected:	None					
Enco	ding:	1101	0nnn	nnnn	nnnn		
Desc	ription:	Add the 2's complement number '2n' t the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is a two-cycle instruction.					
Word	ls:	1					
Cycle	es:	2	2				
QC	vcle Activity:						
	Q1	Q2	Q3		Q4		
	Decode	Read literal 'n'	Proces Data	s V	/rite to PC		
	No operation	No operation	No operatio	on op	No eration		
	n <u>ple:</u> Before Instruc PC After Instructio PC	= ad	dress (H	ump ERE) ump)			

BSF	Bit Set f					
Syntax:	BSF f, b {	,a}				
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ 0 \leq b \leq 7 \\ a \in [0, 1] \end{array}$					
Operation:	$1 \rightarrow \text{f}$					
Status Affected:	None	None				
Encoding:	1000	bbba	ffff	ffff		
Description:	Bit 'b' in reg	jister 'f' i	s set.	•		
	lf 'a' is '0', tl If 'a' is '1', tl GPR bank.					
	If 'a' is '0' an set is enable in Indexed I mode when Section 29. Bit-Oriente Literal Offs	ed, this i ₋iteral O ever f ≤ .2.3 "By d Instru	nstruction ffset Add 95 (5Fh) te-Orien ictions ir	n operates ressing . See ted and n Indexed		
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	Q3	5	Q4		
Decode	Read register 'f'	Proce Data		Write egister 'f'		
Example:	BSF F	LAG_RE	G, 7, 1	L		

BTFSC	Bit Test File	, Skip if Clea	·	BTFSS	Bit Tes	t File, Skip if Set	
Syntax:	BTFSC f, b	{,a}		Syntax:	BTFSS	f, b {,a}	
Operands:	$0 \le f \le 255$ $0 \le b \le 7$ $a \in [0, 1]$			Operands:	0 ≤ f ≤ 2 0 ≤ b < a ∈ [0 ,	7	
Operation:	skip if (f)	= 0		Operation:	skip if (1	f) = 1	
Status Affected:	None			Status Affect	ted: None		
Encoding:	1011	bbba ff	ff ffff	Encoding:	1010) bbba ff	ff ffff
Description:	instruction is the next inst current instru and a NOP is	gister 'f' is '0', skipped. If bit ruction fetched uction execution executed inst rcle instruction	'b' is '0', then I during the on is discarded ead, making	Description:	instruct the nex current and a N	in register 'f' is '1', ion is skipped. If bit t instruction fetched instruction executio IOP is executed inst vo-cycle instruction	"b' is '1', then d during the on is discarded read, making
		e Access Ban BSR is used to	k is selected. If o select the			0', the Access Banl , the BSR is used to ank.	
	is enabled, t Indexed Lite whenever f Section 29.3 Bit-Oriented	d the extended his instruction ral Offset Addu ≤ 95 (5Fh). See 2.3 "Byte-Orie d Instructions et Mode" for d	essing mode ented and in Indexed		set is er Indexed whenev Sectior Bit-Orio	0' and the extender nabled, this instruct d Literal Offset Addi ver f ≤ 95 (5Fh). Ser n 29.2.3 "Byte-Orie ented Instructions Offset Mode" for d	ion operates in ressing mode e ented and s in Indexed
Words:	1			Words:	1		
Cycles:		cles if skip and 2-word instrue		Cycles:	1(2) Note:	3 cycles if skip an by a 2-word instru	
Q Cycle Activity:				Q Cycle Ac	tivity.		
Q1	Q2	Q3	Q4	-	Q1 Q2	Q3	Q4
Decode	Read	Process	No		code Read	Process	No
	register 'f'	Data	operation		register	ʻʻf' Data	operation
lf skip:				If skip:			
Q1	Q2	Q3	Q4		Q1 Q2	Q3	Q4
No	No	No	No		lo No	No	No
operation	operation ved by 2-word ins	operation	operation		ation operation operation operation		operation
Q1	Q2	Q3	Q4		Q1 Q2	Q3	Q4
No	No	No	No			No	No
operation	operation	operation	operation		ation operatio		operation
No	No	No	No	Ν	lo No	No	No
operation	operation	operation	operation	oper	ation operation	on operation	operation
Example:	HERE B FALSE : TRUE :	IFSC FLAC	B, 1, 0	Example:	HERE FALSE TRUE	BTFSS FLAG : :	G, 1, 0
Before Instru PC After Instruc If FLAC Pr If FLAC Pr	= add tion G<1> = 0; C = add G<1> = 1;	ress (HERE) ress (TRUE) ress (FALSE)	P After Ir If	Instruction C = hstruction FLAG<1> = PC = FLAG<1> = PC =	address (HERE) 0; address (FALSE 1; address (TRUE))

BTG	Bit Toggle	f		BOV		Branch if C	Overflow			
Syntax:	BTG f, b {,a	1}		Synta	IX:	BOV n				
Operands:	$0 \leq f \leq 255$			Opera	ands:	-128 ≤ n ≤ ′	127			
	0 ≤ b < 7 a ∈ [0,1]			Opera	ation:	if Overflow (PC) + 2 + 2	,			
Operation:	$(\overline{f} > b) \to f <$:b>		Status	s Affected:	None				
Status Affected:	None			Enco	ding:	1110	0100 nr	inn nnnn		
Encoding:	0111	bbba ff	ff fff	Desc	ription:	If the Overf	If the Overflow bit is '1', then the			
Description:	Bit 'b' in da inverted.	ta memory loc	ation, 'f', is			program wi	ll branch. nplement nun	nhor '2n' is		
	,	he BSR is use	nk is selected. ed to select the			added to the incremente instruction,	e PC. Since the the the new addr	he PC will have next ress will be		
			ed instruction ction operates			PC + 2 + 2r two-cycle ir		ction is then a		
	in Indexed	Literal Offset	Addressing	Word	s:	1				
	mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and		Cycle	s:	1(2)					
	Bit-Oriente		is in Indexed	Q Cy If Ju	/cle Activity: mp:					
Words:	1			-	Q1	Q2	Q3	Q4		
Cycles:	1				Decode	Read literal 'n'	Process Data	Write to PC		
Q Cycle Activity:					No	No	No	No		
Q1	Q2	Q3	Q4		operation	operation	operation	operation		
Decode	Read	Process	Write	lf No	Jump:					
	register 'f'	Data	register 'f'	г	Q1	Q2	Q3	Q4		
Example:	BTG P	ORTC, 4,	0		Decode	Read literal 'n'	Process Data	No operation		
Before Instruc				L		•	L	1 •		
PORTC		0101 [75h]		Exam	<u>iple:</u>	HERE	BOV Jump	ç		
After Instruction		0101 [65h]			Before Instrue PC After Instructi	= ad	dress (here	Ξ)		
					lf Overfl PC If Overfl PC	= ad ow = 0;	dress (Jumg dress (HERE			

ΒZ		Branch if 2	Zero					
Synta	ax:	BZ n						
Oper	ands:	-128 ≤ n ≤ ′	127					
Operation: if Zero bit is '1', $(PC) + 2 + 2n \rightarrow PC$								
Statu	s Affected:	None						
Enco	oding:	1110	0000	nnnn	nnnn			
Desc	cription:	If the Zero will branch.	,	en the p	rogram			
		The 2's complement number '2n' is added to the PC. Since the PC will hav incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.						
Word	ls:	1						
Cycle	es:	1(2)	1(2)					
Q C If Ju	ycle Activity: Imp:							
	Q1	Q2	Q3		Q4			
	Decode	Read literal	Process	V	/rite to			
		ʻn'	Data		PC			
	No operation	No operation	No operation		No eration			
lf Nr	Jump:	operation	operation	, j ob				
	Q1	Q2	Q3		Q4			
	Decode	Read literal	Process		No			
		'n'	Data	ор	eration			
<u>Exan</u>	•	HERE	BZ Ju	mp				
Before Instruction PC After Instruction		= ad	dress (HE	RE)				
	If Zero PC If Zero PC	= 1; = ad = 0;	dress (Jun dress (HE)	mp) RE + 2	2)			

	Subroutine	e Call		
Syntax:	CALL k {,s	s}		
Operands:	$0 \le k \le 104$	8575		
.	S ∈ [0,1]			
Operation:	$(PC) + 4 \rightarrow k \rightarrow PC < 20$	-		
	if s = 1,	, ir,		
	$(W) \rightarrow WS,$			
	$(STATUS) - (BSR) \rightarrow B$		JSS,	
Status Affected:	None	0110		
Encoding:				
1st word (k<7:0>)	1110	110s	k ₇ kk	k kkk
2nd word(k<19:8>)	1111	k ₁₉ kkk	kkk	k kkk
	STATUSS a	and BSR	S. If 's	rs, WS, ' = 0, no
Words:	STATUSS a update occl is loaded in two-cycle ir 2	urs. Ther nto PC<2	n, the 2 0:1>. c	² = 0, no 20-bit value
Words: Cycles:	update occi is loaded in two-cycle ir	urs. Ther nto PC<2	n, the 2 0:1>. c	² = 0, no 20-bit value
	update occ is loaded in two-cycle ir 2	urs. Ther nto PC<2	n, the 2 0:1>. c	² = 0, no 20-bit value
Cycles:	update occ is loaded in two-cycle ir 2	urs. Ther nto PC<2	n, the 2 0:1>. c 1.	² = 0, no 20-bit value
Cycles: Q Cycle Activity:	update occi is loaded in two-cycle in 2 2 Q2 Read literal	urs. Ther no PC<2 nstruction Q3 Push P	n, the 2 0:1>. c n. C to	? = 0, no 20-bit value CALL is a Q4 Read litera
Cycles: Q Cycle Activity: Q1	update occi is loaded in two-cycle ir 2 2 Q2	urs. Ther nto PC<2 nstructior	n, the 2 0:1>. c n. C to	? = 0, no 20-bit value CALL is a Q4 Read litera 'k'<19:8>
Cycles: Q Cycle Activity: Q1	update occi is loaded in two-cycle in 2 2 Q2 Read literal	urs. Ther no PC<2 nstruction Q3 Push P	n, the 2 0:1>. c n. C to k	? = 0, no 20-bit value CALL is a Q4 Read litera
Cycles: Q Cycle Activity: Q1 Decode	update occi is loaded in two-cycle ir 2 2 Q2 Read literal 'k'<7:0>,	urs. Ther nto PC<2 nstruction Q3 Push P stac	n, the 2 0:1>. c n. C to k	? = 0, no 20-bit value CALL is a Q4 Read liter: 'k'<19:8> Write to P
Cycles: Q Cycle Activity: Q1 Decode No	update occi is loaded in two-cycle ir 2 2 Q2 Read literal 'k'<7:0>, No	urs. Ther nto PC<2 nstruction Q3 Push P stac No	n, the 2 0:1>. c n. C to k	? = 0, no 20-bit value CALL is a Q4 Read liter. 'k'<19:8> Write to P No operatior
Cycles: Q Cycle Activity: Q1 Decode No operation Example: Before Instruct	update occi is loaded in two-cycle ir 2 2 Q2 Read literal 'k'<7:0>, No operation HERE tion	urs. Ther no PC<2 nstruction Q3 Push P stac No operat	n, the 2 0:1>. c 1. C to k ion	? = 0, no 20-bit value CALL is a Q4 Read liter. 'k'<19:8> Write to P No operatior
Cycles: Q Cycle Activity: Q1 Decode No operation Example:	update occi is loaded in two-cycle in 2 2 Q2 Read literal 'k'<7:0>, No operation HERE tion = address	urs. Ther no PC<2 nstruction Q3 Push P stac No operat	n, the 2 0:1>. c 1. C to k ion	? = 0, no 20-bit value CALL is a Q4 Read liter. 'k'<19:8> Write to P No operatior

查询PIC18F67K90供应商

CLRF	Clear f					
Syntax:	CLRF f{,	a}				
Operands:	$0 \leq f \leq 255$					
	$a \in [0,1]$					
Operation:	$\begin{array}{l} 000h \rightarrow f, \\ 1 \rightarrow Z \end{array}$					
Status Affected:	Z					
Encoding:	0110	101a	ffff	ffff		
Description:	Clears the register.	contents	of the spe	ecified		
	If 'a' is '0', t If 'a' is '1', t GPR bank.					
	set is enabl in Indexed mode wher Section 29 Bit-Oriente	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	Q3		Q4		
Decode	Read register 'f'	Proce Data		Write gister 'f'		
Example: Before Instruc FLAG_R	EG = 5A	_	REG,1			
After Instruction	n					

FLAG_REG = 00h

CLRWDT	Clear Wate	Clear Watchdog Timer				
Syntax:	CLRWDT					
Operands:	None					
Operation:						
Status Affected:	TO, PD					
Encoding:	0000	0000	0000	0100		
Description:	ription: CLRWDT instruction resets the Watchdog Timer. It also resets the pos scaler of the WDT. Status bits, TO and PD, are set.					
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	2 Q3		Q4		
Decode	No operation	Proce Data		No operation		
Example:	CLRWDT					
Before Instruct WDT Cou After Instructio WDT Cou <u>WD</u> T Pos <u>TO</u> PD	unter = n unter =	? 00h 1 1				

© 2010 Microchip	Technology Inc.
------------------	-----------------

COMF	Compleme	ent f		CPF	SEQ	Compare f	with W, Skip	if f = W	
Syntax:	COMF f	{,d {,a}}		Synt	ax:	CPFSEQ	f {,a}		
Operands:	0 ≤ f ≤ 255			Oper	ands:	$0 \leq f \leq 255$			
	d ∈ [0,1]					a ∈ [0,1]			
	a ∈[0,1]			Oper	ation:	(f) – (W),			
Operation:	$f \rightarrow dest$					skip if (f) =			
Status Affected:	N, Z			Ctat	. Affected		comparison)		
Encoding:	0001	11da ff	ff ffff		is Affected:	None	0.01. 55		
Description:	The contents of register 'f' are complemented. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f'.			oding: cription:	0110 001a ffff ffff Compares the contents of data memory location 'f' to the contents of W by performing an unsigned subtraction. by				
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.						If 'f' = W, then the fetched instruction is discarded and a NOP is executed instead, making this a two-cycle instruction.		
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.				
						If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See			
Words:	1						.2.3 "Byte-Or	,	
Cycles:	1						d Instruction		
Q Cycle Activity:						Literal Offs	set Mode" for	details.	
Q1	Q2	Q3	Q4	Word		1			
Decode	Read register 'f'	Process Data	Write to destination	Cycle	es:		cles if skip and 2-word instru		
Evenale	COME	DEG 0 0		QC	ycle Activity:				
Example:	COMF	REG, 0, 0			Q1	Q2	Q3	Q4	
Before Instruc REG	tion = 13h				Decode	Read	Process	No	
After Instructio				lf sk	in:	register 'f'	Data	operation	
REG	= 13h			11 54	Q1	Q2	Q3	Q4	
W	= ECh				No	No	No	No	
					operation	operation	operation	operation	
				lf sk		d by 2-word in			
						Q2	Q3	Q4	
					No operation	No operation	No operation	No operation	
					No	No	No	No	
					operation	operation	operation	operation	
				Exar	nple:	HERE NEQUAL EOUAL	CPFSEQ REC :	G, O	
					Before Instruc	~			

=	HERE	
=	?	
=	?	
=	W;	
=	Address	(EQUAL)
≠	W;	
=	Address	(NEQUAL)
	= = = ≠	= ? = ? = W; = Address ≠ W;

<u> </u>	<u>,, ,, , ,</u>			
CPFSGT	Compare f	with W, Skip	if f > W	CPFSL
Syntax:	CPFSGT	f {,a}		Syntax
Operands:	$0 \le f \le 255$			Operan
	a ∈ [0,1]			Operal
Operation:	(f) - (W),			Oporat
	skip if (f) >	(W)		Operati
	(unsigned c	comparison)		
Status Affected:	None			Status
Encoding:	0110	010a ffi	ff ffff	
Description:	Compares t	he contents of	data memory	Encodi
·	location 'f' t	o the contents	of the W by	Descrip
	performing	an unsigned s	ubtraction.	
	If the conte	nts of 'f' are gr	eater than the	
		WREG, then t		
		s discarded ar		
	executed in two-cycle ir	stead, making	this a	
	•			
			nk is selected. d to select the	
	GPR bank.	THE DOK IS USE		
		nd the extend	adinatruction	
		nd the extende ed, this instruc		Words:
		Literal Offset A	•	Cycles
		ever f ≤ 95 (5l		
	Section 29	.2.3 "Byte-Or	iented and	
		d Instruction		Q Cyc
		set Mode" for	details.	
Words:	1			Γ
Cycles:	1(2)			
		ycles if skip ar		lf skip:
	by	a 2-word instr		
Q Cycle Activity: Q1	Q2	Q3	Q4	
Decode	Read	Process	No	
Decour	register 'f'	Data	operation	lf skip
lf skip:				·
Q1	Q2	Q3	Q4	
No	No	No	No	
operation	operation	operation	operation	
If skip and followe	•		<u>.</u>	
Q1	Q2	Q3	Q4	l –
No operation	No operation	No operation	No operation	<u>Examp</u>
No	No	No	No	
operation	operation	operation	operation	
				I Be
Example:	HERE	CPFSGT RE	G, 0	
	NGREATER	:		Af
	GREATER	:		
Before Instruc				
PC W	= Ad = ?	dress (HERE)	
After Instruction	•			
If REG	> W;			
PC If REG		dress (GREA	TER)	
PC	≤ W; = Ad	dress (NGRE	ATER)	
10				

FSL	FSLT Compare f with W, Skip if f < W								
ntax:		CPFSLT f	{,a}						
eran	ds:	0 ≤ f ≤ 255 a ∈ [0 , 1]							
eratio	on:		(f) – (W), skip if (f) < (W) (unsigned comparison)						
atus A	Affected:	None							
codin	iq:	0110	000a ff	ff ffff					
escription: Compares the contents of data m location 'f' to the contents of W b performing an unsigned subtract									
		contents of instruction i executed in two-cycle in If 'a' is '0', tl	he Access Ba	etched nd a NOP is g this a nk is selected.					
		GPR bank.	ne BSR is use	d to select the					
ords:		1							
cles: 1(2) Note: 3 cycles if skip and followed by a 2-word instruction.									
Cycl	e Activity: Q1	Q2	02	04					
	Decode	Read	Q3 Process	Q4 No					
	Debbae	register 'f'	Data	operation					
skip:									
	Q1	Q2	Q3	Q4					
	No	No	No	No					
-	peration	operation d by 2-word in:	operation	operation					
Skip a	Q1	Q2	Q3	Q4					
	No	No	No	No					
c	operation	operation	operation	operation					
	No	No	No	No					
C	operation	operation	operation	operation					
ample: HERE CPFSLT REG, 1 NLESS : LESS :									
	fore Instruc PC W	= Ad = ?	dress (here)					
Аπ	er Instructic If REG PC If REG PC	< W; = Ad ≥ W;	dress (LESS						

DAW	Decimal A	djust W Regis	ter	DECF	Decremen	tf		
Syntax:	DAW		Syntax:	DECF f{,	DECF f {,d {,a}}			
Operands:	None		Operands:	$0 \leq f \leq 255$				
Operation:	lf [W<3:0>	If [W<3:0> > 9] or [DC = 1], then			$d \in [0, 1]$			
	$(W<3:0>) + 6 \rightarrow W<3:0>;$ else, $(W<3:0>) \rightarrow W<3:0>;$ If $[W<7:4>> 9]$ or $[C = 1]$, then			Oreantian	a ∈ [0,1]	4		
				Operation:	1 ()			
				Status Affected:	C, DC, N, OV, Z			
				Encoding:	0000		ff ffff	
	(VV<7:4>) + C = 1:	$6 \rightarrow W < 7:4>;$		Description:		Decrement register 'f'. If 'd' is '0', the		
	else,				result is stored in W. If 'd' is '1', the result is stored back in register 'f'.			
	(W<7:4>) –	→ W<7:4>				If 'a' is '0', the Access Bank is selected.		
Status Affected:	С					If 'a' is '1', the BSR is used to select the		
Encoding:	0000	0000 000	00 0111		GPR bank.			
Description:		ts the 8-bit valu				If 'a' is '0' and the extended instruction		
	resulting from the earlier addition of two variables (each in packed BCD format) and produces a correct packed BCD result.					set is enabled, this instruction operates in Indexed Literal Offset Addressing		
						never f \leq 95 (5	0	
					Section 29.2.3 "Byte-Oriented and			
Words:	1					ed Instructior set Mode" for	ns in Indexed	
Cycles:	1			Words:	1	Set mode 101	uctano.	
Q Cycle Activity:				Cycles:	1			
Q1	Q2	Q3	Q4	Q Cycle Activity:	I			
Decode	Read	Process	Write	Q Cycle Activity.	Q2	Q3	Q4	
	register W	Data	W	Decode	Read	Process	Write to	
Example 1:	DAW				register 'f'	Data	destination	
Before Instru								
W	= A5h			Example:	DECF	CNT, 1, 0)	
C DC	= 0 = 0			Before Instru				
After Instructi	-			CNT Z	= 01h = 0			
W C	= 05h = 1			After Instructi	0			
ĎC	= 1 = 0			CNT Z	= 00h = 1			
Example 2:				2	- I			
Before Instru	ction							
W	= CEh							
C DC	= 0 = 0							
After Instructi								
W C	= 34h = 1							
ĎC	= 0							

DECFSZ	Decrement	f, Skip if 0		
Syntax:	DECFSZ f {,d {,a}}			
Operands:	$0 \le f \le 255$ $d \in [0, 1]$ $a \in [0, 1]$			
Operation:	(f) – $1 \rightarrow de$ skip if resul			
Status Affected:	None			
Encoding:	0010	11da ffi	ff ffff	
Description:	decremente placed in W	The contents of register 'f' are decremented. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f'. If the result is '0', the next instruction		
	,		nk is selected. d to select the	
	set is enabl in Indexed I mode when Section 29 Bit-Oriente		Fh). See iented and is in Indexed	
Words:	1			
Cycles:		cles if skip an 2-word instru		
Q Cycle Activity:				
Q1	Q2	Q3	Q4	
Decode	Read register 'f'	Process Data	Write to destination	
Decode	Read register 'f'			
If skip: Q1 No	register 'f' Q2 No	Data Q3 No	destination Q4 No	
If skip: Q1 No operation	Register 'f' Q2 No operation	Data Q3 No operation	destination Q4	
If skip: Q1 No	Register 'f' Q2 No operation	Data Q3 No operation	destination Q4 No	
If skip: Q1 No operation If skip and followe	register 'f' Q2 No operation ed by 2-word in:	Data Q3 No operation struction:	Q4 No operation	
If skip: Q1 No operation If skip and followe Q1	Q2 No operation Q2 d by 2-word in: Q2	Data Q3 No operation struction: Q3	destination Q4 No operation Q4	
If skip: Q1 No operation If skip and followe Q1 No operation No	Q2 No operation d by 2-word in: Q2 No operation No	Data Q3 No operation struction: Q3 No operation No	destination Q4 No operation Q4 No operation No	
If skip: Q1 No operation If skip and followe Q1 No operation	Q2 No operation d by 2-word in: Q2 No operation	Data Q3 No operation struction: Q3 No operation	destination Q4 No operation Q4 No operation	
If skip: Q1 No operation If skip and followe Q1 No operation No	register f Q2 No operation dby 2-word in: Q2 No operation No operation No operation No operation HERE	Data Q3 No operation struction: Q3 No operation No	destination Q4 No operation Q4 No operation No	
If skip: Q1 No operation If skip and follows Q1 No operation No operation Example: Before Instruct	register 'f' Q2 No operation ed by 2-word inaction Q2 No operation No operation No operation HERE CONTINUE Ction	Data Q3 No operation struction: Q3 No operation No operation DECFSZ GOTO	destination Q4 No operation Q4 No operation No operation	
If skip: Q1 No operation If skip and follows Q1 No operation No operation Example: Before Instruct PC After Instruction	register 'f' Q2 No operation ed by 2-word in: Q2 No operation No operation HERE CONTINUE ction = Address on	Data Q3 No operation struction: Q3 No operation No operation DECFSZ GOTO	destination Q4 No operation Q4 No operation No operation	
If skip: Q1 No operation If skip and follows Q1 No operation No operation Example: Before Instruct PC After Instruct CNT If CNT	register 'f' Q2 No operation dby 2-word in: Q2 No operation No operation HERE CONTINUE ction = Address on = CNT - '	Data Q3 No operation struction: Q3 No operation No operation DECFSZ GOTO	destination Q4 No operation Q4 No operation No operation CNT, 1, 1 LOOP	
If skip: Q1 No operation If skip and followe Q1 No operation No operation Example: Before Instruct PC After Instructi CNT	register 'f' Q2 No operation ed by 2-word inaction Q2 No operation Mo operation No operation HERE CONTINUE ction = Address or, = 0;	Data Q3 No operation struction: Q3 No operation No operation DECFSZ GOTO	destination Q4 No operation Q4 No operation CNT, 1, 1 LOOP	

DCF	SNZ	Decrement f, Skip if Not 0				
Synta	ax:	DCFSNZ	f {,d {,a}}			
Oper	ands:	0 ≤ f ≤ 255 d ∈ [0,1] a ∈ [0,1]	d ∈ [0, 1]			
Oper	ation:	(f) – $1 \rightarrow d$ skip if resu				
Statu	is Affected:	None				
Enco	oding:	0100	11da	ffff	ffff	
Desc	cription:	decrement placed in V	The contents of register 'f' are decremented. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f'.			
		If the result instruction discarded instead, ma instruction.	which is a and a NOP aking it a f	lready fe	etched is ited	
		lf 'a' is '0', f If 'a' is '1', f GPR bank.	he BSR is			
		If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Word	ds:	1				
Cycle			cycles if sl a 2-word			
QC	ycle Activity: Q1	02	02		04	
	Decode	Q2 Read	Q3 Proces	ss \	Q4 Vrite to	
	Decoue	register 'f'	Data		stination	
lf sk	ip:					
	Q1	Q2	Q3		Q4	
	No operation	No operation	No operati	on 0	No peration	
lf sk	ip and followed				Jeration	
ii on	Q1	Q2	Q3		Q4	
	No	No	No		No	
	operation	operation	operati	on o	peration	
	No	No	No		No	
	operation	operation	operati	on o	peration	
<u>Exan</u>	<u>nple:</u>	HERE ZERO NZERO	DCFSNZ : :	TEMP,	1, 0	
	Before Instruc TEMP After Instructio	=	?			
	TEMP If TEMP PC If TEMP PC	= = ≠	0;	– 1, SS (ZER) SS (NZE)		

查询PIC18F67K90供应商

GOT	0	Unconditi	Unconditional Branch				
Synta	ax:	GOTO k	GOTO k				
Oper	ands:	$0 \le k \le 10^{4}$	48575				
Oper	ation:	$k \rightarrow PC<2$	$k \rightarrow PC<20:1>$				
Statu	s Affected:	None	None				
	oding: vord (k<7:0>) word(k<19:8>)	1110 1111	1111 k ₁₉ kkk	k ₇ kk kkki		,	
Desc	ription:	anywhere range. The PC<20:1>	GOTO allows an unconditional branch anywhere within entire 2-Mbyte memory range. The 20-bit value 'k' is loaded into PC<20:1>. GOTO is always a two-cycle instruction.				
Word	ls:	2					
Cycle	es:	2					
QC	ycle Activity:						
	Q1	Q2	Q3		Q4		
	Decode	Read literal 'k'<7:0>,	No operat	ion	Read litera 'k'<19:8>, Write to PC	-	
	No operation	No operation	No operat	ion	No operation		
<u>Exan</u>	nple: After Instructio PC =	GOTO THE on Address (7				_	

INCF	Increment	f		
Syntax:	INCF f{,c	d {,a}}		
Operands:	$0 \le f \le 255$ $d \in [0, 1]$ $a \in [0, 1]$	d ∈ [0,1]		
Operation:	(f) + 1 \rightarrow d	est		
Status Affected:	C, DC, N,	OV, Z		
Encoding:	0010	10da	ffff	ffff
Description:	The conten incremente placed in V placed bac	ed. If 'd' is V. If 'd' is	'0', the re '1', the re	esult is
	If 'a' is '0', t If 'a' is '1', t GPR bank.	he BSR i		
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			
	Section 29 Bit-Oriente).2.3 "By ed Instru	te-Orient ctions in	ed and Indexed
Words:	Section 29 Bit-Oriente).2.3 "By ed Instru	te-Orient ctions in	ed and Indexed
Words: Cycles:	Section 29 Bit-Oriente Literal Offe).2.3 "By ed Instru	te-Orient ctions in	ed and Indexed
	Section 29 Bit-Oriente Literal Offs 1).2.3 "By ed Instru	te-Orient ctions in	ed and Indexed
Cycles:	Section 29 Bit-Oriente Literal Offs 1).2.3 "By ed Instru	te-Orient ctions in e" for deta	ed and Indexed
Cycles: Q Cycle Activity:	Section 29 Bit-Oriento Literal Offs 1 1).2.3 "By ed Instru set Mode	te-Orient ctions in " for deta	ed and Indexec ails.
Cycles: Q Cycle Activity: Q1	Section 29 Bit-Oriente Literal Off 1 1 Q2 Read	0.2.3 "Byted Instruset Mode Q3 Proce Data	te-Orient ctions in " for deta	ed and Indexed ails. Q4 Vrite to

INCFSZ	Increment	f, Skip if 0		INFSNZ
Syntax:	INCFSZ f	{,d {,a}}		Syntax:
Operands:	$0 \le f \le 255$ $d \in [0, 1]$ $a \in [0, 1]$			Operands:
Operation:	(f) + $1 \rightarrow de$ skip if resul			Operation:
Status Affected:	None			Status Affe
Encoding:	0011	11da ff	ff ffff	Encoding:
Description:	incremente placed in W	ts of register 'f d. If 'd' is '0', t /. If 'd' is '1', th k in register 'f'	he result is ne result is	Descriptior
	which is alr and a NOP i	is '0', the nex eady fetched i s executed ins le instruction.	s discarded	
	,		nk is selected. d to select the	
	set is enabl in Indexed mode wher Section 29 Bit-Oriente	nd the extend ed, this instruc- Literal Offset A rever $f \le 95$ (5 .2.3 "Byte-Or ed Instruction set Mode" for	ction operates Addressing Fh). See iented and is in Indexed	
Words:	1			Words:
Cycles:		cycles if skip a a 2-word insti		Cycles:
Q Cycle Activity:	~)			Q Cycle A
Q1	Q2	Q3	Q4	
Decode	Read register 'f'	Process Data	Write to destination	De
If skip:	. egietei .	2010	accanation	If skip:
Q1	Q2	Q3	Q4	
No	No	No	No	
operation	operation	operation	operation	оре
If skip and followe Q1	a by 2-wora in Q2	Q3	04	If skip and
No	No	No	Q4 No	
operation	operation	operation	operation	ope
No	No	No	No	
operation	operation	operation	operation	оре
Example:	NZERO	INCFSZ C1 : :	JT, 1, 0	Example:
Before Instru	ction			Befor
PC		(HERE)		٨. ٩
After Instruct	on = CNT + ⁻	1		After
If CNT	= 0;			
PC If CNT	= Address ≠ 0;	S (ZERO)		
PC		(NZERO)		I

3	NZ	Increment f, Skip if Not 0					
nta	ax:	INFSNZ f	INFSNZ f {,d {,a}}				
era	ands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d \in [0,1] \\ a \in [0,1] \end{array}$					
era	ation:	(f) + 1 \rightarrow description of the skip if result					
tu	s Affected:	None					
0	ding:	0100	10da fff	f ffff			
sc	ription:	incremented placed in W	ts of register 'f d. If 'd' is '0', th ⁄. If 'd' is '1', th < in register 'f'.	ne result is			
		instruction v discarded a	is not '0', the r which is alread nd a NOP is ex king it a two-c	y fetched is ecuted			
			he Access Bar he BSR is use				
		set is enabl in Indexed I mode when Section 29 Bit-Oriente Literal Offs	nd the extended ed, this instruc- Literal Offset A ever $f \le 95$ (5F 2.3 "Byte-Ori d Instructions at Mode" for	tion operates ddressing Th). See ented and s in Indexed			
rd	s:	1					
cle	es:		cles if skip and 2-word instru				
Cy	cle Activity:						
ſ	Q1	Q2	Q3	Q4			
	Decode	Read	Process				
		register 'f'	Data	Write to destination			
ski	ip:	register 'f'					
ski	ip: Q1	register 'f' Q2					
l ski	Q1 No	Q2 No	Data Q3 No	Q4 No			
[Q1 No operation	Q2 No operation	Data Q3 No operation	destination Q4			
[Q1 No operation ip and followed	Q2 No operation d by 2-word ins	Data Q3 No operation struction:	Q4 No operation			
[Q1 No operation ip and followed Q1	Q2 No operation d by 2-word ins Q2	Data Q3 No operation struction: Q3	Q4 No operation Q4			
[Q1 No operation ip and followed Q1 No	Q2 No operation d by 2-word ins Q2 No	Data Q3 No operation struction: Q3 No	Q4 No operation Q4 No			
[Q1 No operation ip and followed Q1 No operation	Q2 No operation d by 2-word ins Q2 No operation	Data Q3 No operation struction: Q3 No operation	Q4 No operation Q4 No operation			
[Q1 No operation ip and followed Q1 No	Q2 No operation d by 2-word ins Q2 No	Data Q3 No operation struction: Q3 No	Q4 No operation Q4 No			
ski	Q1 No operation ip and followed Q1 No operation No	Q2 No operation d by 2-word ins Q2 No operation No operation	Data Q3 No operation struction: Q3 No operation No operation	Q4 No operation Q4 No operation No			
ski	Q1 No operation ip and followed Q1 No operation No operation nple: Before Instruc	Q2 No operation d by 2-word ins Q2 No operation No operation HERE ZERO NZERO	Data Q3 No operation struction: Q3 No operation No operation	Q4 No operation Q4 No operation No operation			
ski am	Q1 No operation ip and followed Q1 No operation No operation uple: Before Instruc PC	Q2 No operation d by 2-word ins Q2 No operation No operation HERE ZERO NZERO NZERO	Data Q3 No operation struction: Q3 No operation No operation	Q4 No operation Q4 No operation No operation			
ski am	Q1 No operation ip and followed Q1 No operation No operation aple: Before Instruct PC After Instruction REG	Q2 No operation d by 2-word ins Q2 No operation No operation HERE ZERO NZERO NZERO	Data Q3 No operation struction: Q3 No operation No operation	Q4 No operation Q4 No operation No operation			
ski am	Q1 No operation ip and followed Q1 No operation No operation nple: Before Instruc PC After Instructio REG If REG	Q2 No operation d by 2-word ins Q2 No operation No operation HERE ZERO NZERO tion = Address on = REG + 7 ≠ 0;	Data Q3 No operation struction: Q3 No operation No operation	Q4 No operation Q4 No operation No operation			
ski am	Q1 No operation ip and followed Q1 No operation No operation aple: Before Instruct PC After Instruction REG	Q2 No operation d by 2-word ins Q2 No operation No operation HERE ZERO NZERO tion = Address on = REG + 7 ≠ 0;	Data Q3 No operation struction: Q3 No operation No operation UNFSNZ REG (HERE) 1 (NZERO)	Q4 No operation Q4 No operation No operation			

查询PIC18F67K90供应商

IORLW	Inclusive (Inclusive OR Literal with W			
Syntax:	IORLW k				
Operands:	$0 \le k \le 255$	5			
Operation:	(W) .OR. k	ightarrow W			
Status Affected:	N, Z				
Encoding:	0000	1001	kkkk	kkkk	
Description:	The conter 8-bit literal in W.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
Decode	Read literal 'k'	Proces Data		/rite to W	
Example:	IORLW	35h			

9Ah

=

IORWF	Inclusive (OR W wit	h f		
Syntax:	IORWF f	{,d {,a}}			
Operands:	$0 \le f \le 255$ $d \in [0, 1]$ $a \in [0, 1]$	d ∈ [0,1]			
Operation:	(W) .OR. (f	$) \rightarrow dest$			
Status Affected:	N, Z				
Encoding:	0001	00da	ffff	ffff	
Description:	Inclusive O '0', the resu the result is	ult is plac	ed in W. I	f 'd' is '1',	
		If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.			
	set is enab in Indexed mode wher Section 29 Bit-Oriente	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
Decode	Read register 'f'	Proce Data		Vrite to stination	
Example: Before Instruc		ESULT,	0, 1		

<u>mple:</u>	IO	RWF	RESU
Before Instruct	tion		
RESULT	=	13h	
W	=	91h	
After Instructio	n		
RESULT	=	13h	
W	=	93h	

BFh W =

After Instruction

Before Instruction W

查询PIC18F67K90供应商

LFSF	ર	Load FSR	2			
Synta	ax:	LFSR f, l	ĸ			
Oper	ands:	$\begin{array}{l} 0 \leq f \leq 2 \\ 0 \leq k \leq 40 \end{array}$	95			
Oper	ation:	$k\toFSRf$				
Statu	s Affected:	None				
Enco	ding:	1110 1111	1110 0000			
Desc	ription:	The 12-bit file select				
Word	ls:	2				
Cycle	es:	2				
QC	ycle Activity:					
	Q1	Q2	Q3		Q4	
	Decode	Read literal 'k' MSB	Proce Data	i lit	Write teral 'k' /ISB to FSRfH	
	Decode	Read literal 'k' LSB	Proce Data		ite literal to FSRfL	
<u>Exan</u>	nple:	LFSR 2,	3ABh			

After Instruction

FSR2H FSR2L	=	03h ABh
----------------	---	------------

MOVF	Move f			
Syntax:	MOVF f{	d {,a}}		
Operands:	$0 \leq f \leq 255$			
	d ∈ [0 , 1] a ∈ [0 , 1]			
Operation:	$\mathfrak{L} \subset [\mathfrak{S}, \mathfrak{L}]$ f \rightarrow dest			
Status Affected:	N, Z			
Encoding:	0101	00da ff	ff ffff	
Description:	The contents of register 'f' are moved to a destination dependent upon the status of 'd'. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f'. Location 'f' can be anywhere in the 256-byte bank.			
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.			
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			
Words:	1			
Cycles:	1			
Q Cycle Activity:				
Q1	Q2	Q3	Q4	
Decode	Read register 'f'	Process Data	Write W	
Example:	MOVF RI	EG, 0, 0		
Before Instruc				
REG W	= 22 = FF			
After Instruction				
REG W	= 22 = 22			

查询PIC18F67K90供应商

моу	'FF	Move f to	f				
Synta	ax:	MOVFF f	s,f _d				
Oper	ands:	$\begin{array}{l} 0 \leq f_s \leq 409 \\ 0 \leq f_d \leq 409 \end{array}$					
Oper	ation:	$(f_{\text{S}}) \to f_{\text{d}}$					
Statu	s Affected:	None					
	ding: vord (source) word (destin.)						
Description: The contents of source register 'f _s ' ar moved to destination register 'f _d '. Location of source 'f _s ' can be anywhe in the 4096-byte data space (000h to FFFh) and location of destination 'f _d ' can also be anywhere from 000h to FFFh.					ʻf _d '. anywhere 000h to tion ʻf _d '		
		Either source or destination can be W (a useful special situation).					
		MOVFF is p transferring peripheral buffer or ar	g a data n register (s	nemory loo such as th	cation to a		
		The MOVFF PCL, TOSI destination	J, TOSH				
Word	ls:	2	2				
Cycle	es:	2					
QC	ycle Activity:						
	Q1	Q2	Q3	}	Q4		
	Decode	Read register 'f' (src)	Proce Data		No peration		
	Decode	No operation No dummy read	No operat	ion re	Write gister 'f' (dest)		
<u>Exan</u>	n <u>ple:</u> Before Instruc		REG1, F	REG2			

Before Instruction		
REG1	=	33h
REG2	=	11h
After Instruction		
REG1	=	33h
REG2	=	33h

MOVLB	Move Lite	Move Literal to Low Nibble in BSR				
Syntax:	MOVLW	k				
Operands:	$0 \le k \le 255$	5				
Operation:	$k \to BSR$					
Status Affected:	None					
Encoding:	0000	0001	kkk	k	kkkk	
Description:	The 8-bit li Bank Sele of BSR<7: regardless	ct Registe 4> always	er (BSI s rema	R). T ains '	he value	
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	Q3	5		Q4	
Decode	Read literal 'k'	Proce Data			te literal to BSR	
Example:	MOVLB	5				
Before Instruct	ion					

02h

05h

BSR Register =

BSR Register =

After Instruction

DS39957B-page 474

查询PIC18F67K90供应商

W

=

5Ah

MOVLW	Move Lite	ral to W				
Syntax:	MOVLW	k				
Operands:	$0 \le k \le 255$	5				
Operation:	$k\toW$					
Status Affected:	None					
Encoding:	0000	1110	kkkk	kkkk		
Description:	The 8-bit li	The 8-bit literal 'k' is loaded into W.				
Words:	1	1				
Cycles:	1	1				
Q Cycle Activity:						
Q1	Q2	Q3	5	Q4		
Decode	Read literal 'k'	Proce Data		Vrite to W		
Example:	MOVLW	5Ah				
After Instruction						

MOVWF	Move W t	o f			
Syntax:	MOVWF	f {,a}			
Operands:	$0 \le f \le 255$	5			
	a ∈ [0,1]				
Operation:	$(W) \to f$				
Status Affected:	None				
Encoding:	0110	111a	ffff	ffff	
Description:	Location 'f	Move data from W to register 'f'. Location 'f' can be anywhere in the 256-byte bank.			
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.				
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
Decode	Read	Proce	SS	Write	
	register 'f'	Data	a re	gister 'f'	
Example:	MOVWF	reg, O			

uction	
=	4Fh
=	FFh
tion	
=	4Fh
=	4Fh
	= = tion =

© 2010 Microchip Technology Inc.

查询PIC18F67K90供应商

MULLW	Multiply Li	iteral with W		MULWF	Multiply W w	rith f	
Syntax:	MULLW	k		Syntax:	MULWF f {	,a}	
Operands:	$0 \le k \le 255$	5		Operands:	$0 \leq f \leq 255$		
Operation:	(W) x k \rightarrow PRODH:PRODL			a ∈ [0,1]			
Status Affected: None		Operation:	$(W) x (f) \to P$	RODH:PROD	L		
Encoding:	0000	1101 kk	kk kkkk	Status Affected:	None		
Description:	An unsigne	ed multiplication	n is carried	Encoding:	0000	001a ffi	ff ffff
	out between the contents of W and the 8-bit literal 'k'. The 16-bit result is placed in the PRODH:PRODL register pair. PRODH contains the high byte. W is unchanged. None of the Status flags are affected.		Description:	An unsigned multiplication is carried out between the contents of W and the register file location 'f'. The 16-bit result is stored in the PRODH:PRODL register pair. PRODH contains the high byte. Both W and 'f' are unchanged. None of the Status flags are affected.			
	possible in		w nor Carry is . A Zero result ed.		Note that neit	her Overflow is operation. A	
Words:	1				•		k is selected. If
Cycles: Q Cycle Activity:	1				'a' is '1', the E GPR bank.		
Q Cycle Activity. Q1	Q2	Q3	Q4			the extended	instruction set
Decode	Read literal 'k'	Process Data	Write registers PRODH: PRODL		is enabled, th Indexed Liter whenever f ≤ Section 29.2 Bit-Oriented Literal Offse	is instruction al Offset Addr 95 (5Fh). See .3 "Byte-Orie Instructions	operates in essing mode e nted and in Indexed
Example:	MULLW	0C4h		Words:			cialis.
Before Instruc				Cycles:	1 1		
W PRODH	= E2 = ?	2h		Q Cycle Activity			
PRODL	= ?			Q Cycle Activity	Q2	Q3	Q4
After Instructic W PRODH PRODL	90 = E2 = AI = 08	Dh		Decode	Read register 'f'	Process Data	Write registers PRODH: PRODL
				Example:	MULWF	REG, 1	
				Before Instr	uction		

 $\begin{array}{rrrr} \text{Before Instruction} \\ W & = & \text{C4h} \\ \text{REG} & = & \text{B5h} \\ \text{PRODH} & = & ? \\ \text{PRODL} & = & ? \\ \text{After Instruction} \\ W & = & \text{C4h} \\ \text{REG} & = & \text{B5h} \\ \text{PRODH} & = & \text{8Ah} \\ \text{PRODL} & = & 94h \\ \end{array}$

查询PIC18F67K90供应商

NEGF	Negate f				
Syntax:	NEGF f {,a}				
Operands:	$0 \le f \le 255$				
	$\mathbf{a} \in [0, 1]$				
Operation:	$(f) + 1 \rightarrow f$				
Status Affected:	N, OV, C, DC, Z				
Encoding:	0110 110a ffff ffff				
Description:	Location 'f' is negated using two's complement. The result is placed in the data memory location 'f'.				
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.				
If 'a' is '0' and the extended inst set is enabled, this instruction op in Indexed Literal Offset Addres mode whenever f ≤ 95 (5Fh). Se Section 29.2.3 "Byte-Oriented Bit-Oriented Instructions in In Literal Offset Mode" for details					
Words:	1				
Cycles:	1				
Q Cycle Activity:					

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example:	NEGF	REG,	1
----------	------	------	---

Before Instru	ction			
REG	=	0011	1010	[3Ah]
After Instructi	on			
REG	=	1100	0110	[C6h]

NOP No Operation							
Synta	ax:	NOP					
Oper	ands:	None					
Oper	ation:	No operati	on				
Statu	s Affected:	None					
Encoding:		0000	0000	000	00	0000	
		1111	XXXX	XXX	x	xxxx	
Desc	ription:	No operati	on.				
Word	ls:	1	1				
Cycle	es:	1					
QC	ycle Activity:						
	Q1	Q2	Q	3		Q4	
	Decode	No	No			No	
		operation	operat	tion	ор	eration	

Example:

None.

POP		Рор Тор о	of Return	Stack	Ĩ			
Syntax:		POP						
Operands:		None	None					
Operation:		$(TOS) \rightarrow b$	it bucket					
Status Affec	ted:	None						
Encoding:		0000	0000	000	0	0110		
Description:		The TOS v stack and i then becor was pushe This instru the user to stack to inc	is discard mes the p d onto th ction is pr properly	ed. Th reviou e retur rovideo mana	ne TO is va in sta d to o ge th	DS value lue that ack. enable ne return		
Words:		1						
Cycles:		1						
Q Cycle Ac	tivity:							
G	21	Q2	Q3	3		Q4		
Dec	ode	No operation	POP T valu		ор	No eration		
Example:		POP GOTO	NEW					
Т	Instruc OS ack (1	tion level down))031A2)14332				
	istructic OS C	n	-)14332 NEW	2h			

PUS	н	Push Top o	of Ret	urn Stac	:k	
Synta	ax:	PUSH				
Oper	ands:	None				
Oper	ation:	$(PC + 2) \rightarrow$	TOS			
Statu	is Affected:	None				
Enco	oding:	0000	0000	000	0	0101
Desc	ription:	The PC + 2 the return s value is pus This instruc software sta then pushin	tack. shed d tion a ack by	The prev lown on t llows imp modifyir	ious the s blem ng T	TOS stack. enting a OS and
Word	ls:	1				
Cycle	es:	1				
QC	ycle Activity:					
	Q1	Q2		Q3		Q4
	Decode	PUSH PC + 2 onto return stack		No ration	ор	No eration
Exan	nple:	PUSH				
	Before Instruc TOS PC	ction	= =	345Ah 0124h		
	After Instruction	าท				

查询PIC18F67K90供应商

RCA	LL	Relative C	all		
Synta	ax:	RCALL r	I		
Oper	ands:	-1024 ≤ n :	≤ 1023		
Oper	ation:	(PC) + 2 (PC) + 2 +		;	
Statu	s Affected:	None			
Enco	ding:	1101	1nnn	nnr	in nnnn
	ription:	address (F stack. The	urrent loca PC + 2) is n, add the n' to the P mented to , the new cn. This in	ation. pushe 2's c C. Sin o fetch addre	First, return ed onto the omplement ce the PC will the next ss will be
Word	ls:	1			
Cycle	es:	2			
QC	ycle Activity:				
	Q1	Q2	Q3	8	Q4
	Decode	Read literal 'n' PUSH PC	Proce Data		Write to PC

RESET	Reset			
Syntax:	RESET			
Operands:	None			
Operation:	Reset all re affected by	·	•	hat are
Status Affected:	All			
Encoding:	0000	0000	1111	1111
Description:	This instrue			
Words:	1			
Cycles:	1			
Q Cycle Activity:				
Q1	Q2	Q3		Q4
Decode	Start reset	No operat	ion o	No peration

Example:

•	nstruction	

After Instruction	
Registers =	Reset Value
Flags* =	Reset Value

RESET

Example: HERE RCALL Jump

to stack

No

operation

No

operation

No

operation

Before Instruction

No

operation

PC = Address (HERE) After Instruction PC = TOS= Address (Jump) Address (HERE + 2)

RETI	FIE	Return from	m Interrupt				
Synta	ax:	RETFIE {	s}				
Oper	ands:	$s \in [0,1]$	s ∈ [0,1]				
Oper	ation:	if s = 1, (WS) \rightarrow W, (STATUSS) (BSRS) \rightarrow	IEH or PEIE	,	nged		
Statu	s Affected:	GIE/GIEH,	PEIE/GIEL.				
Enco	ding:	0000	0000 0	001	000s		
Desc	ription:	and Top-of- the PC. Inte setting eithor global inter contents of STATUSS a their corres STATUS ar	n interrupt. S Stack (TOS) errupts are e er the high o rupt enable t the shadow and BSRS an ponding regi nd BSR. If 's' gisters occur	is load nabled f low-p bit. If 's registe re load sters N = 0, n	ded into I by priority S' = 1, the ers WS, led into <i>N</i> ,		
Word	ls:	1					
Cycle	es:	2					
-	ycle Activity:						
	Q1	Q2	Q3		Q4		
	Decode	No operation	No operation	fro Set	OP PC m stack GIEH or GIEL		
	No operation	No operation	No operation	ор	No eration		
<u>Exan</u>	After Interrupt PC W BSR STATUS	RETFIE	1 = TOS = WS = BSR = STA = 1	S TUSS			

RETLW	Return Lite	eral to W		
Syntax:	RETLW k			
Operands:	$0 \leq k \leq 255$			
Operation:	$k \rightarrow W$,			
	$(TOS) \rightarrow POP$,	e unchai	nged
Status Affected:	None			
Encoding:	0000	1100	kkkk	kkkk
Description:	W is loaded program co of the stack high addres unchanged.	unter is loa (the return is latch (P0	aded from addres	m the to s). The
Words:	1			
Cycles:	2			
Q Cycle Activity:				
Q1	Q2	Q3		Q4
Decode	Read	Process		OP PC
	literal 'k'	Data		n stack, ite to W
No	No	No		No
operation	operation	operatio	n op	eration
Example:				
CALL TABLE	; W contai	ns tabl	e	
	; offset v			
	; W now ha			
:	; table va	alue		
TABLE				
ADDWF PCL	; W = offs	set		
RETLW k0	; Begin ta	able		
RETLW kl	;			
:				
:				

iction	
=	07h
tion	
=	value of kn
	= tion

查询PIC18F67K90供应商

RET	URN	Return from	m Subro	utine			
Synta	ax:	RETURN	{s}				
Oper	ands:	$s \in [0,1]$	s ∈ [0,1]				
Oper	ation:	$(TOS) \rightarrow Prif s = 1,$ $(WS) \rightarrow W,$ (STATUSS) $(BSRS) \rightarrow PCLATU, Prif Not State Stat$	\rightarrow STAT	,	nanged		
Statu	s Affected:	None					
Enco	ding:	0000	0000	0001	001s		
		is loaded in 's'= 1, the c registers W loaded into registers W 's' = 0, no u occurs.	contents S, STATI their cor , STATU	of the sl USS an respond S and E	hadow d BSRS are ding BSR. If		
Word	ls:	1					
Cycle	es:	2					
QC	ycle Activity:						
	Q1	Q2	Q3	3	Q4		
	Decode	No operation	Proce Data		POP PC from stack		
	No	No	No		No		
	operation	operation	operat				

Example:	RETURN

After Instruction: PC = TOS

	Rotate Left	Tunoug		У
Syntax:	RLCF f {	,d {,a}}		
Operands:	$0 \le f \le 255$ $d \in [0, 1]$ $a \in [0, 1]$			
Operation:	$(f < n >) \rightarrow de$ $(f < 7 >) \rightarrow C,$ $(C) \rightarrow dest <$		>,	
Status Affected:	C, N, Z			
Encoding:	0011	01da	fff	f ffff
Description:	The content one bit to th If 'd' is '0', th is '1', the res 'f'.	e left thro ne result	ough th is place	e Carry flag ed in W. If 'c
	lf 'a' is '0', th If 'a' is '1', th GPR bank.			
	If 'a' is '0' ar set is enable in Indexed L mode when Section 29. Bit-Oriente Literal Offs	ed, this in _iteral Of ever f ≤ 9 2.3 "Byt d Instrue	nstruction fset Ad (55 (55 h te -Orie n fotions	on operates dressing). See nted and in Indexed
	C	• r	egister	f 🗕
Wordo	1			
Words:	1			
Cycles:	1 1			
Cycles: Q Cycle Activity:	1	Q	3	Q4
Cycles:	1 Q2 Read	Q: Proce	ess	Q4 Write to
Cycles: Q Cycle Activity: Q1	1 Q2		ess	
Cycles: Q Cycle Activity: Q1	1 Q2 Read	Proce Dat	ess	Write to destination
Cycles: Q Cycle Activity: Q1 Decode	1 Q2 Read register 'f' RLCF	Proce Dat	ess a	Write to destination
Cycles: Q Cycle Activity: Q1 Decode Example: Before Instruc	1 Q2 Read register 'f' RLCF tion = 1110 = 0	Proce Dat	ess a	Write to destination

RLNCF	Rotate Lef	ft f (No Carry)				
Syntax:	RLNCF	f {,d {,a}}				
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d \in [0,1] \\ a \in [0,1] \end{array}$	d ∈ [0,1]				
Operation:		$(f < n >) \rightarrow dest < n + 1 >,$ $(f < 7 >) \rightarrow dest < 0 >$				
Status Affected:	N, Z					
Encoding:	0100	01da ffi	ff ffff			
Description:	one bit to t is placed ir	The contents of register 'f' are rotated one bit to the left. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.				
		he Access Bar he BSR is use				
	set is enab in Indexed mode when Section 29 Bit-Oriente	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
	4	register f	_			
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	Q3	Q4			
Decode	Read register 'f'	Process Data	Write to destination			
Example: RLNCF REG, 1, 0 Before Instruction REG = 1010 1011 After Instruction REG = 0101 0111						

RRCF	Rotate Rig	nt i thro	-	
Syntax:	RRCF f{	,d {,a}}		
Operands:	$0 \leq f \leq 255$			
	d ∈ [0,1] a ∈ [0,1]			
Operation:	u ∈ [0, ⊥] (f <n>) → d</n>	ostan - 1	、	
	$(f<0>) \rightarrow C$ $(f<0>) \rightarrow C$ $(C) \rightarrow dest$;,	,	
Status Affected:	C, N, Z			
Encoding:	0011	00da	ffff	fff
Description:	The conter one bit to ti flag. If 'd' is If 'd' is '1', ' register 'f'.	he right the r	hrough t esult is p	the Carry placed in
	If 'a' is '0', ' If 'a' is '1', ' GPR bank.	he BSR i		
	set is enab in Indexed mode when Section 29	Literal O never f ≤	ffset Ad 95 (5Fh	dressing ı). See
	in Indexed	Literal O never f ≤ 0.2.3 "By ed Instru set Mode	ffset Ad 95 (5Fh te-Orie i I ctions	on opera dressing a). See nted and in Index etails.
Words	in Indexed mode when Section 29 Bit-Oriente Literal Off	Literal O never f ≤ 0.2.3 "By ed Instru set Mode	ffset Ad 95 (5Fh te-Orien ctions e" for de	on opera dressing n). See nted and in Index etails.
Words:	in Indexed mode when Section 29 Bit-Oriente Literal Off	Literal O never f ≤ 0.2.3 "By ed Instru set Mode	ffset Ad 95 (5Fh te-Orien ctions e" for de	on opera dressing n). See nted and in Index etails.
Cycles:	in Indexed mode when Section 29 Bit-Oriente Literal Off	Literal O never f ≤ 0.2.3 "By ed Instru set Mode	ffset Ad 95 (5Fh te-Orien ctions e" for de	on opera dressing n). See nted and in Index etails.
	in Indexed mode when Section 29 Bit-Oriente Literal Off	Literal O never f ≤ 0.2.3 "By ed Instru set Mode	ffset Ad 95 (5Fh te-Orien ctions 9" for de egister f	on opera dressing n). See nted and in Index etails.
Cycles: Q Cycle Activity:	in Indexed mode when Section 29 Bit-Oriente Literal Off C 1 1 1 Q2 Read	Literal O never f ≤ 0.2.3 "By ed Instru set Mode re re Q3	ffset Ad 95 (5Fh te-Orie ctions 9" for de egister f	on opera dressing i). See nted and in Index. etails.
Cycles: Q Cycle Activity: Q1	in Indexed mode when Section 29 Bit-Oriente Literal Off C 1 1 2 2	Literal O never f ≤ 0.2.3 "By ed Instru set Mode	ffset Ad 95 (5Fh te-Orie ctions 9" for de egister f	on opera dressing i). See nted and in Index. etails.
Cycles: Q Cycle Activity: Q1	in Indexed mode when Section 29 Bit-Oriente Literal Off C 1 1 1 Q2 Read	Literal O never f ≤ 0.2.3 "By ed Instru set Mode re re Q3 Proce Data	ffset Ad 95 (5Fh te-Orie ctions e" for de egister f	on opera dressing i). See nted and in Index. etails.
Cycles: Q Cycle Activity: Q1 Decode Example: Before Instruct	in Indexed mode when Section 29 Bit-Oriente Literal Off C 1 1 1 2 Read register 'f' RRCF	Literal O never f ≤ 0.2.3 "By ed Instru set Mode re re Q3 Proce Data	ffset Ad 95 (5Fh te-Orie ctions 9" for de egister f	on opera dressing i). See nted and in Index. etails.
Cycles: Q Cycle Activity: Q1 Decode Example:	in Indexed mode when Section 29 Bit-Oriente Literal Off C 1 1 1 2 Q2 Read register 'f' RRCF	Literal O never f ≤ 0.2.3 "By ed Instru set Mode re re Q3 Proce Data	ffset Ad 95 (5Fh te-Orie ctions 9" for de egister f	on opera dressing i). See nted and in Index. etails.
Cycles: Q Cycle Activity: Q1 Decode Example: Before Instruct REG C After Instruction	in Indexed mode when Section 25 Bit-Oriente Literal Off C 1 1 1 Q2 Read register 'f' RRCF stion = 1110 = 0	Literal O never f ≤ 0.2.3 "By ed Instru set Mode re Q3 Proce Data REG, 0110	ffset Ad 95 (5Fh te-Orie ctions 9" for de egister f	on opera dressing i). See nted and in Index. etails.
Cycles: Q Cycle Activity: Q1 Decode Example: Before Instruct REG C	in Indexed mode when Section 25 Bit-Oriente Literal Off C 1 1 1 Q2 Read register 'f' RRCF tion = 1110 con = 1110	Literal O never f ≤ 0.2.3 "By ed Instru set Mode re Q3 Proce Data REG, 0110	ffset Ad 95 (5Fh te-Orie ctions 9" for de egister f	on opera dressing i). See nted and in Index etails.

RRNCF	Rotata Pia	ht f (No Carry	d)		
			1		
Syntax:	RRNCF 1	{,u {,a}}			
Operands:	0 ≤ f ≤ 255 d ∈ [0,1]				
	$a \in [0, 1]$ $a \in [0, 1]$				
Operation:	$(f < n >) \rightarrow d$	est <n 1="" –="">,</n>			
	$(f<0>) \rightarrow d$	est<7>			
Status Affected:	N, Z				
Encoding:	0100	00da ff:	ff ffff		
Description:	one bit to t is placed ir	The contents of register 'f' are rotated one bit to the right. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f'.			
	If 'a' is '0', the Access Bank will be selected, overriding the BSR value. If 'a' is '1', then the bank will be selected as per the BSR value.				
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
		register	f		
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3	Q4		
Decode	Read	Process	Write to		
	register 'f'	Data	destination		
Example 1:		REG, 1, 0			
Before Instruc REG	= 1101	0111			
After Instructio REG	= 1110	1011			
Example 2:	RRNCF	REG, 0, 0			
Before Instruc	tion				
W	= ? = 1101	1111			
REG After Instructio	1101	JTTT			
W	= 1110				
REG	= 1101	0111			

SETF	Set f				
Syntax:	SETF f{,a	a}			
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ a \in [0,1] \end{array}$				
Operation:	$FFh\tof$				
Status Affected:	None				
Encoding:	0110	100a ffi	ff ffff		
Description:		The contents of the specified register are set to FFh.			
	,	he Access Bar he BSR is use			
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3	Q4		
Decode	Read register 'f'	Process Data	Write register 'f'		
Example: Before Instruc REG After Instructio	= 5A	REG,1			
REG	n = FF	h			

查询PIC18F67K90供应商

SLE	EP	Enter Sle	ep Mode					
Synt	ax:	SLEEP						
Ope	rands:	None						
Ope	ration:							
Statu	is Affected:	TO, PD	TO, PD					
Enco	oding:	0000	0000	0000	0011			
Desc	cription:	cleared. T is set. The	The Power-Down status bit (PD) is cleared. The Time-out status bit (TO) is set. The Watchdog Timer and its postscaler are cleared.					
		The proce with the or	•		eep mode			
Word	ds:	1						
Cycl	es:	1						
QC	ycle Activity:							
	Q1	Q2	Q3		Q4			
	Decode	No	Proce	ss	Go to			
		operation	Data	l	Sleep			
<u>Exar</u>	nple:	SLEEP						
	Before Instruct TO = PD = After Instruction TO = PD =	? ? on 1 † 0						
+ If	WDT causes v	wake-up, this I	bit is clea	red.				

† If WDT causes wake-up, this bit is cleared.

SUBFWB Subtract f from W with Borrow Syntax: SUBFWB f {,d {,a}} Operands: $0 \leq f \leq 255$ $d \in [0, 1]$ **a** ∈ [0,1] Operation: $(W) - (f) - (\overline{C}) \rightarrow dest$ N, OV, C, DC, Z Status Affected: Encoding: 0101 01da ffff ffff Description: Subtract register 'f' and Carry flag (borrow) from W (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored in register 'f'. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank. If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 29.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details. Words: 1 Cycles: 1 Q Cycle Activity: Q2 Q3 Q4 Q1 Decode Read Process Write to register 'f' Data destination Example 1: SUBFWB REG, 1, 0 **Before Instruction** REG = 3 W 2 1 = = After Instruction REG = FF 2 0 W = C Z N = = 0 = 1 ; result is negative Example 2: SUBFWB REG, 0, 0 **Before Instruction** REG = 2 5 1 Ŵ = С = After Instruction REG 2 3 W = C Z = 1 0 = N ; result is positive = 0 SUBFWB Example 3: REG, 1, 0 Before Instruction REG = 2 0 W = С = After Instruction REG W C Z N 0 2 = = 1 = = ; result is zero 1

=

SUBLW	9	Subtrac	t١	V from L	itera	I	
Syntax:		SUBLW	-	-			
Operands:)≤k≤2					
Operation:	ł	< – (W) -	→	W			
Status Affected:	I	N, OV, C	;, I	DC, Z			
Encoding:	Γ	0000		1000	kkk	ck	kkkk
Description:				acted from the result			
Words:		1					
Cycles:		1					
Q Cycle Activity:							
Q1		Q2		Q3			Q4
Decode		Read eral 'k'		Proces Data		V	/rite to W
Example 1:	5	SUBLW	0	2h			
Before Instruction W C	ction = =	01h ?					
After Instructi W C Z N	on = = =	01h 1 0 0	; I	result is p	oositiv	/e	
Example 2:	5	SUBLW	0	2h			
Before Instruct W C	=	02h ?					
After Instructi W C Z N	on = = = =	00h 1 1 0	; I	result is z	zero		
Example 3:	2	SUBLW	0	2h			
Before Instruc W C After Instructi W C	=	03h ? FFh 0	;;;	(2's comj result is r	oleme	ent)	
C Z N	=	0 1	, -		0-		

SUBWF	Subtract	W from f			
Syntax:	SUBWF	f{d{a}}			
Operands:	$0 \le f \le 25$				
operande.	$d \in [0, 1]$ $a \in [0, 1]$,			
Operation:	(f) – (W) –	→ dest			
Status Affected:	N, OV, C,	DC, Z			
Encoding:	0101 11da ffff ffff				
Description:	Subtract W from register 'f' (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f'.				
		the Access Bank the BSR is used			
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details				
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3	Q4		
Decode	Read register 'f	Process Data	Write to destination		
Example 1:	SUBWF	REG, 1, 0			
Before Instruc		, _, _			
REG	= 3				
W C	= 3 = 2 = ?				
After Instruction	on				
REG W	= 1 = 2				
С	= 1	; result is positive	e		
Z N	= 0 = 0				
Example 2:	SUBWF	REG, 0, 0			
Before Instruc		-, -, -			
REG	= 2				
W C	= 2 = 2 = ?				
After Instruction	on				
REG	= 2 = 0				
W C	= 0 = 1	; result is zero			
Ž N	= 1 = 0				
Example 3:	- U SUBWF	REG, 1, 0			
Before Instruc		REG, 1, 0			
REG	= 1				
W C	= 2 = ?				
After Instructio	-				
REG	= FFh	;(2's complemer	nt)		
W C	= 2 = 0	; result is negativ	ve		
Ž N	= 0 = 1	,	-		
IN	= 1				

SUBWFB	Subtract V	V from f with	n Borr	ow	SWA	
Syntax:	SUBWFB	f {,d {,a}}			Synt	
Operands:	0 ≤ f ≤ 255				Oper	
	d ∈ [0,1] a ∈ [0,1]	$\mathbf{d} \in [0, 1]$				
Operation:		$(\overline{C}) \rightarrow dest$			0	
Status Affected:	N, OV, C, [. ,			Oper	
Encoding:	0101		fff	ffff	Statu	
Description:	Subtract W	/ and the Car	ry flag	(borrow)	Enco	
	method). If	er 'f' (2's con ' 'd' is '0', the s '1', the resu 'f'.	Desc			
	If 'a' is '1', GPR bank		sed to	select the		
	set is enab in Indexed mode when Section 29 Bit-Oriente	f 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1				14/	
Cycles:	1				Word	
Q Cycle Activity:					Cycle	
Q1 Decode	Q2 Read	Q3 Process	L V	Q4 Vrite to	Q C 1	
Decode	register 'f'	Data		stination		
Example 1:	SUBWFB	REG, 1,	0		-	
Before Instruct	tion					
REG W	= 19h = 0Dh	(0001 1 (0000 1	,		Exan	
С	= 1	(,			
After Instructio REG	n = 0Ch	(0000 1	011)			
W	= 0Dh	(0000 1	- ,			
C Z	= 1 = 0					
N	= 0	; result is	•	/e		
Example 2:		REG, 0, 0)			
Before Instruct REG	= 1Bh	(0001 1	011)			
W	= 1Ah	(0001 1				
C After Instructio	= 0 n					
REG	= 1Bh	(0001 1	.011)			
W C	= 00h = 1					
Z N	= 1 = 0	; result is	zero			
Example 3:	SUBWFB	REG, 1,	0			
Before Instruct		100, 1,	0			
REG	= 03h	(0000 0				
W C	= 0Eh = 1	(0000 1	101)			
	= 0Eh = 1	(0000 1 (1111 0 ; [2's com (0000 1)100) np]			

Swap f				
SWAPF f	{,d {,a}}			
0 ≤ f ≤ 255 d ∈ [0,1] a ∈ [0,1]				
```				
None				
0011	10da	ffff	ffff	
'f' are exch is placed in	nanged. If n W. If 'd'	'd' is '0', is '1', the	the result	
lf 'a' is '1',	the BSR i			
If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details				
1				
1				
Q2	Q3	1	Q4	
Read register 'f'			Write to estination	
SWAPF ion = 53h n = 35h	REG, 1,	0		
	SWAPF f $0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$ $(f<3:0>) \rightarrow$ $(f<7:4>) \rightarrow$ None 0011 The upper 'f' are exch is placed in rull f'a' is '0', If 'a' is '0', If 'a' is '0', If 'a' is '0', If 'a' is '0', GPR bank If 'a' is '0', GPR bank If 'a' is '0', Set is enable in Indexed mode whe Section 25 Bit-Orient Literal Off 1 1 Q2 Read register 'f' SWAPF ion = 53h n	SWAPFf {,d {,a}} $0 \le f \le 255$ $\in [0, 1]$ $a \in [0, 1]$ $a \in [0, 1]$ $(f<3:0>) \rightarrow dest<7:4$ $(f<7:4>) \rightarrow dest<3:0$ None $0011$ 10daThe upper and lowe'f are exchanged. Ifis placed in W. If 'd'placed in register 'f'.If 'a' is '0', the AccessIf 'a' is '0', the AccessIf 'a' is '0' and the exset is enabled, this isin Indexed Literal Ofmode whenever $f \le$ Section 29.2.3 "ByBit-Oriented InstruLiteral Offset Mode11Q2Q3Readregister 'f'DataSWAPFREG, 1,ion= 53h	SWAPFf {,d {,a}} $0 \le f \le 255$ $\in [0, 1]$ $a \in [0, 1]$ $a \in [0, 1]$ $(f<3:0>) \rightarrow dest<7:4>,$ $(f<7:4>) \rightarrow dest<3:0>$ None $0011$ $10da$ ffffThe upper and lower nibbles'f' are exchanged. If 'd' is '0',is placed in W. If 'd' is '1', theplaced in register 'f'.If 'a' is '0', the Access Bank isIf 'a' is '0', the Access Bank isIf 'a' is '0' and the extended itset is enabled, this instructionin Indexed Literal Offset Addrmode whenever $f \le 95$ (5Fh).Section 29.2.3 "Byte-OrientedBit-Oriented Instructions inLiteral Offset Mode" for deta11Q2Q3ReadProcessregister 'f'DatadeSWAPFREG, 1, 0ion=53h	

Table Read (Continued)

TBLRD

#### 查询PIC18F67K90供应商

TBL	RD	Table Read					
Synta	ax:	TBLRD ( *; *	*+; *	-; +*)			
Oper	ands:	None					
Oper	ation:	if TBLRD *, (Prog Mem (TBLPTR)) $\rightarrow$ TABLAT, TBLPTR – No Change; if TBLRD *+, (Prog Mem (TBLPTR)) $\rightarrow$ TABLAT, (TBLPTR) + 1 $\rightarrow$ TBLPTR; if TBLRD *-, (Prog Mem (TBLPTR)) $\rightarrow$ TABLAT, (TBLPTR) – 1 $\rightarrow$ TBLPTR; if TBLRD +*, (TBLPTR) + 1 $\rightarrow$ TBLPTR, (Prog Mem (TBLPTR)) $\rightarrow$ TABLAT					
Statu	is Affected:	None					
Enco	oding:	0000	00	000	000	00	10nn nn=0 * =1 *+ =2 *- =3 +*
Desc	ription:	This instruction is used to read the contents of Program Memory (P.M.). To address the program memory, a pointer called Table Pointer (TBLPTR) is used.					
		The TBLPTI each byte in has a 2-Mby	the	progr	am me	mory	
		TBLPTR<	0> =				nt Byte of ory Word
		TBLPTR<		Pro	gram I	Memo	ory Word
		The TBLRD				nodify	the value
		<ul> <li>no chang</li> </ul>					
		post-incre					
		<ul> <li>post-decr</li> </ul>					
		<ul> <li>pre-increr</li> </ul>	men	t			
Word	ls:	1					
Cycle	es:	2					
QC	ycle Activity						
	Q1	Q2			23		Q4
	Decode	No operation		N opera	-	ор	No eration

Example 1:	TBLRD	*+	;	
Before Instruction	on			
TABLAT TBLPTR MEMORY(	(00 A 256b)		= = =	55h 00A356h 34h
After Instruction	· · · ·		-	3411
TABLAT TBLPTR			=	34h 00A357h
Example 2:	TBLRD	+*	;	
Before Instructio	on			
TABLAT TBLPTR MEMORY( MEMORY)			= = =	AAh 01A357h 12h 34h
After Instruction				
TABLAT TBLPTR			=	34h 01A358h

No operation (Read Program

Memory)

No

operation

No operation (Write TABLAT)

No

operation

### 查询PIC18F67K90供应商

TBLWT	Table Wri	te			
Syntax:	TBLWT (*	*; *+; *-; +*	*)		
Operands:	None				
Operation:	if TBLWT*, (TABLAT) $\rightarrow$ Holding Register, TBLPTR – No Change; if TBLWT*+, (TABLAT) $\rightarrow$ Holding Register, (TBLPTR) + 1 $\rightarrow$ TBLPTR; if TBLWT*-, (TABLAT) $\rightarrow$ Holding Register, (TBLPTR) – 1 $\rightarrow$ TBLPTR; if TBLWT+*, (TBLPTR) + 1 $\rightarrow$ TBLPTR,				
Status Affected	(TABLAT)		y Negistei		
Status Affected: Encoding:	None	0000	0000	11nn nn=0 * =1 *+ =2 *- =3 +*	
Description:	This instruction uses the 3 LSBs of TBLPTR to determine which of the 8 holding registers the TABLAT is written to. The holding registers are used to program the contents of Program Memory (P.M.). (Refer to <b>Section 6.0 "Memory</b> <b>Organization"</b> for additional details on programming Flash memory.) The TBLPTR (a 21-bit pointer) points to each byte in the program memory. TBLPTR has a 2-Mbyte address range. The LSb of the TBLPTR selects which byte of the program memory location to				
	TBLPT			nificant Byte m Memory	
	TBLPT	<b>R&lt;0&gt; =</b> 1:	Most Sign	ificant Byte n Memory	
	<ul> <li>word</li> <li>The TBLWT instruction can modify the value of TBLPTR as follows:</li> <li>no change</li> <li>post-increment</li> <li>post-decrement</li> <li>pre-increment</li> </ul>				
Words:	1	ement			
Cycles:	2				
Q Cycle Activity:	~				
	Q1	Q2	Q3	Q4	
	Decode	No	No	No	
	Decoue	-	operation	operation	
	No	No	No	No	
			operation	operation	

. (Read

TÀBLAT)

#### TBLWT Table Write (Continued)

Example 1:	TBLWT

Example 1:	TBLWT *+;		
Before Instrue	ction		
TABLAT TBLPTR		=	55h 00A356h
HOLDIN	IG REGISTER		
(00A356	Sh)	=	FFh
After Instructi	ons (table write	comp	letion)
TABLAT		=	55h
TBLPTR	-	=	00A357h
(00A356	IG REGISTER 3h)	=	55h
Example 2:	TBLWT +*;		
Before Instrue	ction		
TABLAT		=	34h
TBLPTR		=	01389Ah
	IG REGISTER		
(01389A	\h) IG REGISTER	=	FFh
(01389B		=	FFh
•	on (table write c	omple	etion)
TABLAT		=	34h
TBLPTR		=	01389Bh
	IG REGISTER		010000011
(01389A		=	FFh
HOLDIN	IG REGISTER		
(01389B	Bh)	=	34h

(Write to Holding

Register)

is discarded and a NOP is executed, making this a two-cycle instruction. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank. If 'a' is '0' and the extended instruction	TSTFSZ	Test f, Skip	if O			
$a \in [0, 1]$ Operation:skip if f = 0Status Affected:NoneEncoding: $0110$ $011a$ ffffDescription:If 'f' = 0, the next instruction fetched during the current instruction execution is discarded and a NOP is executed, making this a two-cycle instruction. If 'a' is '0', the Access Bank is selected. If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f $\leq$ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.Words:1Cycles:1(2) Note:Q1Q2Q3Q4Q4DecodeRead register 'f'Dataoperation operationIf skip:Q1Q2Q1Q2Q3Q4NoNoNoNooperationoperationIf skip and followed by 2-word instruction: operationQ4NoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNo<	Syntax:	TSTFSZ f {	TSTFSZ f {,a}			
Status Affected:NoneEncoding: $0110$ $011a$ ffffffffDescription:If 'f = 0, the next instruction fetched during the current instruction execution is discarded and a NOP is executed, making this a two-cycle instruction.If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.Words:1Cycles:1(2) Note:Note:3 cycles if skip and followed by a 2-word instruction.Q Cycle Activity: $Q1$ Q1Q2Q3Q4NoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNo <tr< td=""><td>Operands:</td><td></td><td></td><td></td></tr<>	Operands:					
Encoding:0110011affffffffDescription:If 'f' = 0, the next instruction fetched during the current instruction execution is discarded and a NOP is executed, making this a two-cycle instruction. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.Words:1Cycles:1(2) Note:Note:3 cycles if skip and followed by a 2-word instruction.Q Cycle Activity:Q1Q1Q2Q3Q4NoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNo	Operation:	skip if f = 0				
Description:If 'f' = 0, the next instruction fetched during the current instruction execution is discarded and a NOP is executed, making this a two-cycle instruction.If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.Words:1Cycles:1(2) Note:Q1Q2Q3Q4DecodeRead register 'f'Q1Q2Q3Q4NoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNoNo<	Status Affected:	None				
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Encoding:	0110	011a fff	f ffff		
If 'a' is '1', the BSR is used to select the GPR bank.         If 'a' is '0' and the extended instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.         Words:       1         Cycles:       1(2)         Note:       3 cycles if skip and followed by a 2-word instruction.         Q Cycle Activity:       Q1         Q1       Q2       Q3       Q4         Decode       Read       Process       No         If skip:       Q1       Q2       Q3       Q4         No       No       No       No       No         operation       operation       operation       operation         If skip and followed by 2-word instruction:       Q1       Q2       Q3       Q4         No       No       No       No       No       No </td <td>Description:</td> <td colspan="4">during the current instruction execution is discarded and a NOP is executed, making this a two-cycle instruction.</td>	Description:	during the current instruction execution is discarded and a NOP is executed, making this a two-cycle instruction.				
set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See         Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.         Words:       1         Cycles:       1(2)         Note:       3 cycles if skip and followed by a 2-word instruction.         Q Cycle Activity:       Q1       Q2       Q3       Q4         Decode       Read       Process       No         If skip:       Q1       Q2       Q3       Q4         Decode       Read       Process       No       operation         If skip:       Q1       Q2       Q3       Q4         If skip:       Q1       Q2       Q3       Q4         If skip and followed by 2-word instruction:       Operation       operation       operation         If skip and followed by 2-word instruction:       Q1       Q2       Q3       Q4         No       No       No       No       No       operation         If skip and followed by 2-word instruction:       Q1       Q2       Q3       Q4         No       No       No       No       No       operation         If skip and followed by 2-word instruction:       Q1       Q2 </td <td colspan="6">If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.</td>	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.					
Cycles:       1(2) Note: 3 cycles if skip and followed by a 2-word instruction.         Q Cycle Activity:       Q1       Q2       Q3       Q4         Decode       Read register 'f'       Process       No         Q1       Q2       Q3       Q4         Decode       Read register 'f'       Process       No         If skip:       Q1       Q2       Q3       Q4         No       No       No       No       operation         If skip and followed by 2-word instruction:       Q1       Q2       Q3       Q4         No       No       No       No       No       operation         If skip and followed by 2-word instruction:       Q1       Q2       Q3       Q4         No       No       No       No       No       operation         No       No       No       No       operation       operation         No       No       No       No       operation       operation	set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed					
Note: 3 cycles if skip and followed by a 2-word instruction.Q Cycle Activity:Q1Q2Q3Q4DecodeRead register 'f'ProcessNo operationIf skip:Q1Q2Q3Q4NoNoNoNo operationOperationIf skip and followed by 2-word instruction:Q1Q2Q3Q4NoNoNoNo operationOperationOperationIf skip and followed by 2-word instruction:Q1Q2Q3Q4NoNoNoNo operationNo operationNo operationNoNoNoNoNoNoNoNoNoNoNoNoNoNoNo	Words: 1					
Q1Q2Q3Q4DecodeRead register 'f'Process DataNo operationIf skip:Q1Q2Q3Q4NoNoNo operationNo operationNo operationIf skip and followed by 2-word instruction:Q1Q2Q3Q4Q1Q2Q3Q4MoNo operationNo operationNo operationIf skip and followed by 2-word instruction:Q1Q2Q3Q4NoNo operationNo operationNo operationNo 	Note: 3 cycles if skip and followed					
DecodeRead register 'f'Process DataNo operationIf skip:Q1Q2Q3Q4NoNoNoNooperationoperationoperationoperationIf skip and followed by 2-word instruction:Q1Q2Q3Q4NoNoNoNooperationIf skip and followed by 2-word instruction:Q1Q2Q3Q4NoNoNoNooperationIf skip and followed by 2-word instruction:Q1Q2Q3Q4NoNoNoNoNoNoNoNoNoNoNoNoNoNoNo	Q Cycle Activity:					
register 'f'     Data     operation       If skip:     Q1     Q2     Q3     Q4       No     No     No     No       operation     operation     operation     operation       If skip and followed by 2-word instruction:     Q1     Q2     Q3       Q1     Q2     Q3     Q4       No     No     No     operation       If skip and followed by 2-word instruction:     Q1     Q2     Q3       Q1     Q2     Q3     Q4       No     No     No     No       operation     operation     operation     operation       No     No     No     No     No       No     No     No     No	Q1	Q2	Q3	Q4		
If skip: Q1 Q2 Q3 Q4 No No No Operation Operation Operation If skip and followed by 2-word instruction: Q1 Q2 Q3 Q4 No No No No Operation Operation Operation No No No No No Operation	Decode			-		
Q1Q2Q3Q4NoNoNoNooperationoperationoperationoperationIf skip and followed by 2-word instruction:Q1Q2Q3Q4NoNoNoNooperationoperationoperationoperationoperationoperationNoNoNoNooperationNoNoNoNoNoNoNoNoNo	lf akin:	register 'f'	Data	operation		
No operationNo operationNo operationNo operationIf skip and followed by 2-word instruction:Q1Q2Q3Q4NoNoNoNo operationNo operationNo operationNoNoNoNoNo operationNoNoNoNoNoNoNoNoNoNo		02	03	04		
If skip and followed by 2-word instruction: Q1 Q2 Q3 Q4 No No No No operation operation operation No No No No No						
Q1Q2Q3Q4NoNoNoNooperationoperationoperationoperationNoNoNoNo	operation	operation	operation	operation		
NoNoNoNooperationoperationoperationoperationNoNoNoNo	If skip and followed	d by 2-word in	struction:			
operationoperationoperationNoNoNo						
No No No No		-	-	-		
Example: HERE TSTFSZ CNT, 1 NZERO : ZERO :						
Before Instruction	Before Instruct	tion				
PC = Address (HERE)			dress (HERE	)		
After Instruction If CNT = 00h,			h			
$PC = Address (ZERO)$ $If CNT \neq OOh,$ $PC = Address (NZERO)$	PC If CNT	= Ad ≠ 00	dress (ZERO h,			

XORLW Exclusive OR Literal with W						
Syntax:	XORLW	k				
Operands:	$0 \le k \le 25$	5				
Operation:	(W) .XOR	$k \to W$				
Status Affected:	N, Z					
Encoding:	0000	0000 1010 kkkk kkkk				
Description:	The contents of W are XORed with the 8-bit literal 'k'. The result is placed in W.					
Words: 1						
Cycles: 1						
Q Cycle Activity:						
Q1	Q2	Q3		Q4		
Decode	Read literal 'k'	Proces Data	s V	Vrite to W		
Example:	XORLW	0AFh				
Before Instruction W = B5h After Instruction W = 1Ah						

XORWF	Exclusive	OR W with f			
Syntax:	XORWF	f {,d {,a}}			
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d \in [0,1] \\ a \in [0,1] \end{array}$				
Operation:	(W) .XOR. (	(f) $\rightarrow$ dest			
Status Affected:	N, Z				
Encoding:	0001	10da ff:	ff ffff		
Description:	register 'f'. I in W. If 'd' is	Exclusive OR the contents of W with register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in the register 'f'.			
	, -	he Access Bai he BSR is use	nk is selected. d to select the		
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3	Q4		
Decode	Read register 'f'	Process Data	Write to destination		
Example:		REG, 1, 0			
Before Instruct REG W	tion = AFh = B5h				
After Instructio REG W	n = 1Ah = B5h				

#### 查询PIC18F67K90供应商 29.2 Extended Instruction Set

In addition to the standard 75 instructions of the PIC18 instruction set, the PIC18F87K90 family of devices also provides an optional extension to the core CPU functionality. The added features include eight additional instructions that augment Indirect and Indexed Addressing operations and the implementation of Indexed Literal Offset Addressing for many of the standard PIC18 instructions.

The additional features of the extended instruction set are enabled by default on unprogrammed devices. Users must properly set or clear the XINST Configuration bit during programming to enable or disable these features.

The instructions in the extended set can all be classified as literal operations, which either manipulate the File Select Registers, or use them for Indexed Addressing. Two of the instructions, ADDFSR and SUBFSR, each have an additional special instantiation for using FSR2. These versions (ADDULNK and SUBULNK) allow for automatic return after execution.

The extended instructions are specifically implemented to optimize re-entrant program code (that is, code that is recursive or that uses a software stack) written in high-level languages, particularly C. Among other things, they allow users working in high-level languages to perform certain operations on data structures more efficiently. These include:

- Dynamic allocation and deallocation of software stack space when entering and leaving subroutines
- Function Pointer invocation
- Software Stack Pointer manipulation
- Manipulation of variables located in a software stack

A summary of the instructions in the extended instruction set is provided in Table 29-3. Detailed descriptions are provided in **Section 29.2.2 "Extended Instruction Set"**. The opcode field descriptions in Table 29-1 (page 450) apply to both the standard and extended PIC18 instruction sets.

Note: The instruction set extension and the Indexed Literal Offset Addressing mode were designed for optimizing applications written in C; the user may likely never use these instructions directly in assembler. The syntax for these commands is provided as a reference for users who may be reviewing code that has been generated by a compiler.

#### 29.2.1 EXTENDED INSTRUCTION SYNTAX

Most of the extended instructions use indexed arguments, using one of the File Select Registers and some offset to specify a source or destination register. When an argument for an instruction serves as part of Indexed Addressing, it is enclosed in square brackets ("[]"). This is done to indicate that the argument is used as an index or offset. The MPASM[™] Assembler will flag an error if it determines that an index or offset value is not bracketed.

When the extended instruction set is enabled, brackets are also used to indicate index arguments in byte-oriented and bit-oriented instructions. This is in addition to other changes in their syntax. For more details, see Section 29.2.3.1 "Extended Instruction Syntax with Standard PIC18 Commands".

Note: In the past, square brackets have been used to denote optional arguments in the PIC18 and earlier instruction sets. In this text and going forward, optional arguments are denoted by braces ("{ }").

Mnemonic,		Description	Cycles	16-E	Bit Instru	uction V	Vord	Status
Opera	nds	Description	Cycles	Cycles MSb LSb		LSb	Affected	
ADDFSR	f, k	Add Literal to FSR	1	1110	1000	ffkk	kkkk	None
ADDULNK	k	Add Literal to FSR2 and Return	2	1110	1000	11kk	kkkk	None
CALLW		Call Subroutine using WREG	2	0000	0000	0001	0100	None
MOVSF	z _s , f _d	Move z _s (source) to 1st word	2	1110	1011	0zzz	ZZZZ	None
		f _d (destination) 2nd word		1111	ffff	ffff	ffff	
MOVSS	z _s , z _d	Move z _s (source) to 1st word	2	1110	1011	lzzz	ZZZZ	None
		z _d (destination) 2nd word		1111	xxxx	XZZZ	ZZZZ	
PUSHL	k	Store Literal at FSR2,	1	1110	1010	kkkk	kkkk	None
		Decrement FSR2						
SUBFSR	f, k	Subtract Literal from FSR	1	1110	1001	ffkk	kkkk	None
SUBULNK	k	Subtract Literal from FSR2 and Return	2	1110	1001	11kk	kkkk	None

#### TABLE 29-3: EXTENSIONS TO THE PIC18 INSTRUCTION SET

#### 查询PIC18F67K90供应商 29.2.2 EXTENDED INSTRUCTION SET

ADD	SR Add Literal to FSR						
Synta	ax:	ADDFSR f, k					
Oper	ands:	0 = 11 = 00	$0 \le k \le 63$				
		f ∈ [ 0, 1,	f ∈ [ 0, 1, 2 ]				
Operation:		FSR(f) + I	$FSR(f) + k \rightarrow FSR(f)$				
Status Affected: None							
Enco	ding:	1110	1000	ffkk	kkkk		
Desc	ription:	The 6-bit literal 'k' is added to the contents of the FSR specified by 'f'.					
Word	ls:	1		-	<b>,</b>		
Cycle	es:	1					
QC	ycle Activity:						
	Q1	Q2	Q3		Q4		
	Decode	Read	Proces	SS	Write to		
		literal 'k'	Data		FSR		

Example: ADDFSR 2, 23h

Before Instru		
FSR2	=	03FFh
After Instructi	on	
FSR2	=	0422h

ADD	DDULNK Add Literal to FSR2 and Return					
Synta	ax:	ADDULN	ADDULNK k			
Oper	ands:	$0 \le k \le 63$				
Oper	ation:	FSR2 + k	$\rightarrow$ FSR2	,		
		$(TOS) \rightarrow I$	С			
Statu	s Affected:	None	None			
Enco	ding:	1110	1000	11kl	k kkkk	
Desc	ription:	The 6-bit literal 'k' is added to the contents of FSR2. A RETURN is then executed by loading the PC with the TOS.				
	The instruction takes two cycles to execute; a NOP is performed during the second cycle.					
This may be thought of as a special case of the ADDFSR instruction, where f = 3 (binary '11'); it operates only on FSR2.				uction,		
Word	ls:	1				
Cycle	es:	2				
QC	vcle Activity:					
	Q1	Q2	Q3		Q4	
	Decode	Read	Proces	SS	Write to	
		literal 'k'	Data		FSR	
	No	No	No		No	
	Operation	Operation	Operati	on	Operation	
Example: ADDULNK 23h						

ampie:	A	DDULNK	2
Before Instruc	tion		
FSR2	=	03FFh	
PC	=	0100h	
After Instruction	n		
FSR2	=	0422h	
PC	=	(TOS)	

**Note:** All PIC18 instructions may take an optional label argument preceding the instruction mnemonic for use in symbolic addressing. If a label is used, the instruction format then becomes: {label} instruction argument(s).

CAL	LW	Subroutine Call Using WREG					
Synta	ax:	CALLW					
Oper	ands:	None					
Oper	ation:	$(PC + 2) \rightarrow$ $(W) \rightarrow PCL$ (PCLATH) - (PCLATU) -	, → PCH,				
Status Affected:		None					
Enco	oding:	0000 0000 0001 0100					
Desc	rription	pushed ont contents of existing val contents of latched into respectively executed as new next in Unlike CAL	turn address ( o the return sta W are written ue is discarded PCLATH and PCH and PCI y. The second s a NOP instruct struction is fet	ack. Next, the to PCL; the d. Then, the PCLATU are J, cycle is ction while the ched.			
update W, STATUS or BSR.							
Word		•					
Cycle		2					
QC	ycle Activity: Q1	Q2	Q3	Q4			
	Decode	Read WREG	Push PC to stack	No operation			
	No operation	No operation	No operation	No operation			
$\begin{array}{ccccc} \hline Example: & \text{HERE} & \text{CALLW} \\ \hline \\ Before Instruction \\ PC & = & address (HERE) \\ PCLATH & = & 10h \\ PCLATU & = & 00h \\ W & = & 06h \\ \hline \\ After Instruction \\ PC & = & 001006h \\ TOS & = & address (HERE + 2) \\ PCLATH & = & 10h \\ PCLATU & = & 00h \\ W & = & 06h \\ \end{array}$							

MOVSF	Move Inde	xed to f				
Syntax:	MOVSF [2	z _s ], f _d				
Operands:	$0 \le z_s \le 12$ $0 \le f_d \le 409$					
Operation:	((FSR2) + 2	$(z_s) \rightarrow f_d$				
Status Affected:	None					
Encoding: 1st word (source) 2nd word (destin.)	1110 1111		)zzz Efff	zzzz _s ffff _d		
Description:	The contents of the source register are moved to destination register 'f _d '. The actual address of the source register is determined by adding the 7-bit literal offset 'z _s ', in the first word, to the value of FSR2. The address of the destination register is specified by the 12-bit literal 'f _d ' in the second word. Both addresses can be anywhere in the 4096-byte data space (000h to FFFh).					
The MOVSF instruction cannot use the PCL, TOSU, TOSH or TOSL as the destination register.						
	If the resultant source address points to an Indirect Addressing register, the value returned will be 00h.					
Words:	2					
Cycles:	2					
Q Cycle Activity:						
Q1	Q2	Q3		Q4		
Decode	Determine source addr	Determine source add		Read urce reg		
Decode	No operation No dummy read	No operation	reę	Write gister 'f' (dest)		
Example: MOVSF [05h], REG2						
Before Instruc FSR2 Contents of 85h REG2 After Instructio FSR2 Contents of 85h REG2	tion = 80 = 33 = 11 on = 80	h h h h				

### 查询PIC18F67K90供应商

MOVSS	Move Inde	exed to Ir	ndexed			
Syntax:	MOVSS	[z _s ], [z _d ]				
Operands:	$0 \le z_s \le 12$ $0 \le z_d \le 12$					
Operation:	((FSR2) +	$z_s) \rightarrow ((F$	SR2) + z _d	)		
Status Affected:	None					
Encoding: 1st word (source) 2nd word (dest.)	1110 1011 1zzz zzzz _s 1111 xxxx xzzz zzzz _d					
Description	The contents of the source register are moved to the destination register. The addresses of the source and destination registers are determined by adding the 7-bit literal offsets, 'z _s ' or 'z _d ', respectively, to the value of FSR2. Both registers can be located anywhere in the 4096-byte data memory space (000h to FFFh). The MOVSS instruction cannot use the PCL, TOSU, TOSH or TOSL as the destination register.					
	If the resultant source address points to an Indirect Addressing register, the value returned will be 00h. If the resultant destination address points to an Indirect Addressing register, the instruction will execute as a NOP.					
Words:	2					
Cycles:	2					
Q Cycle Activity:	Q Cycle Activity:					

	-	
les:	2	
Cycle Activity:		
01	$\cap 2$	03

_	Q1	Q2	Q3	Q4
	Decode	Determine	Determine	Read
		source addr	source addr	source reg
	Decode	Determine	Determine	Write
		dest addr	dest addr	to dest reg

Example:	MOVSS	[05h],	[06h]

Before Instruction		
FSR2	=	80h
Contents of 85h Contents	=	33h
of 86h	=	11h
After Instruction		
FSR2	=	80h
Contents of 85h Contents	=	33h
of 86h	=	33h

PUSHL	Store Litera	I at FSR	2, Decre	ement FSR2		
Syntax:	PUSHL k	PUSHL k				
Operands:	$0 \leq k \leq 255$					
Operation:	· · ·	$k \rightarrow (FSR2),$ FSR2 – 1 $\rightarrow$ FSR2				
Status Affected:	None					
Encoding:	1111	1010	kkkk	kkkk		
	memory address specified by FSR2. FSR2 is decremented by 1 after the operation. This instruction allows users to push values onto a software stack.					
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	G	23	Q4		
Decode	Read 'k'	Proc da		Write to destination		
Example:	PUSHL 0	8h				

Before Instruction FSR2H:FSR2L Memory (01ECh) 01ECh = = 00h After Instruction FSR2H:FSR2L Memory (01ECh) 01EBh 08h = =

### 查询PIC18F67K90供应商

SUB	FSR	R Subtract Literal from FSR					
Synta	ax:	SUBFSR	SUBFSR f, k				
Oper	ands:	$0 \le k \le 63$	$0 \le k \le 63$				
		f ∈ [ 0, 1,	f ∈ [ 0, 1, 2 ]				
Oper	ation:	FSRf – k	$\rightarrow$ FSRf				
Statu	s Affected:	ected: None					
Enco	ding:	1110	1001	ffkk	kkkk		
Description: The 6-bit literal 'k' is subtracted from the contents of the FSR specified by 'f'.							
Word	ls:	1					
Cycle	es:	1					
QC	ycle Activity:						
	Q1	Q2	Q3		Q4		
	Decode	Read	Proce	SS	Write to		
		register 'f'	Data	a d	estination		
Example: SUBFSR 2, 23h							

	SUBLER	Ζ,	2 311
Before Instruction	ı		
FSR2 =	03FFh	I	
After Instruction			
FSR2 =	03DCł	n	

SUB	ULNK	Subtract Literal from FSR2 and Return					
Synta	ax:	SUBULNK	( k				
Oper	ands:	$0 \le k \le 63$					
Oper	ation:	$\begin{aligned} FSR2 &-k \to FSR2, \\ (TOS) &\to PC \end{aligned}$					
Statu	s Affected:	None					
Enco	ding:	1110	10	01	11kk		kkkk
Desc	ription:	The 6-bit literal 'k' is subtracted from the contents of the FSR2. A RETURN is then executed by loading the PC with the TOS.					
		The instruction takes two cycles to execute; a NOP is performed during the second cycle.					
		This may be thought of as a special case of the SUBFSR instruction, where f = 3 (binary '11'); it operates only on FSR2.					
Word	ls:	1					
Cycle	es:	2					
QC	ycle Activity:						
	Q1	Q2		C	23		Q4
	Decode	Read register	'f'	Proc Da	cess ata		Write to estination
	No	No		N	0		No
	Operation	Operatio	n	Oper	ation	0	peration

Example: SUBULNK 23h

Before Instru	ction	
FSR2	=	03FFh
PC	=	0100h
After Instruct	ion	
FSR2	=	03DCh
PC	=	(TOS)

#### 查询PIC18F67K90供应商

#### 29.2.3 BYTE-ORIENTED AND BIT-ORIENTED INSTRUCTIONS IN INDEXED LITERAL OFFSET MODE

Note:	Enabling the PIC18 instruction set exten-						
	sion may cause legacy applications to						
	behave erratically or fail entirely.						

In addition to eight new commands in the extended set, enabling the extended instruction set also enables Indexed Literal Offset Addressing (Section 6.6.1 "Indexed Addressing with Literal Offset"). This has a significant impact on the way that many commands of the standard PIC18 instruction set are interpreted.

When the extended set is disabled, addresses embedded in opcodes are treated as literal memory locations: either as a location in the Access Bank (a = 0) or in a GPR bank designated by the BSR (a = 1). When the extended instruction set is enabled and a = 0, however, a file register argument of 5Fh or less is interpreted as an offset from the pointer value in FSR2 and not as a literal address. For practical purposes, this means that all instructions that use the Access RAM bit as an argument – that is, all byte-oriented and bit-oriented instructions, or almost half of the core PIC18 instructions – may behave differently when the extended instruction set is enabled.

When the content of FSR2 is 00h, the boundaries of the Access RAM are essentially remapped to their original values. This may be useful in creating backward compatible code. If this technique is used, it may be necessary to save the value of FSR2 and restore it when moving back and forth between C and assembly routines in order to preserve the Stack Pointer. Users must also keep in mind the syntax requirements of the extended instruction set (see Section 29.2.3.1 "Extended Instruction Syntax with Standard PIC18 Commands").

Although the Indexed Literal Offset mode can be very useful for dynamic stack and pointer manipulation, it can also be very annoying if a simple arithmetic operation is carried out on the wrong register. Users who are accustomed to the PIC18 programming must keep in mind, that when the extended instruction set is enabled, register addresses of 5Fh or less are used for Indexed Literal Offset Addressing.

Representative examples of typical byte-oriented and bit-oriented instructions in the Indexed Literal Offset mode are provided on the following page to show how execution is affected. The operand conditions shown in the examples are applicable to all instructions of these types.

### 29.2.3.1 Extended Instruction Syntax with Standard PIC18 Commands

When the extended instruction set is enabled, the file register argument, 'f', in the standard byte-oriented and bit-oriented commands is replaced with the literal offset value, 'k'. As already noted, this occurs only when 'f' is less than or equal to 5Fh. When an offset value is used, it must be indicated by square brackets ("[]"). As with the extended instructions, the use of brackets indicates to the compiler that the value is to be interpreted as an index or an offset. Omitting the brackets, or using a value greater than 5Fh within the brackets, will generate an error in the MPASM[™] Assembler.

If the index argument is properly bracketed for Indexed Literal Offset Addressing, the Access RAM argument is never specified; it will automatically be assumed to be '0'. This is in contrast to standard operation (extended instruction set disabled), when 'a' is set on the basis of the target address. Declaring the Access RAM bit in this mode will also generate an error in the MPASM Assembler.

The destination argument, 'd', functions as before.

In the latest versions of the MPASM Assembler, language support for the extended instruction set must be explicitly invoked. This is done with either the command line option,  $/_{Y}$ , or the PE directive in the source listing.

#### 29.2.4 CONSIDERATIONS WHEN ENABLING THE EXTENDED INSTRUCTION SET

It is important to note that the extensions to the instruction set may not be beneficial to all users. In particular, users who are not writing code that uses a software stack may not benefit from using the extensions to the instruction set.

Additionally, the Indexed Literal Offset Addressing mode may create issues with legacy applications written to the PIC18 assembler. This is because instructions in the legacy code may attempt to address registers in the Access Bank below 5Fh. Since these addresses are interpreted as literal offsets to FSR2 when the instruction set extension is enabled, the application may read or write to the wrong data addresses.

When porting an application to the PIC18F87K90 family, it is very important to consider the type of code. A large, re-entrant application that is written in C and would benefit from efficient compilation will do well when using the instruction set extensions. Legacy applications that heavily use the Access Bank will most likely not benefit from using the extended instruction set.

### 查询PIC18F67K90供应商

ADDWF	ADD W to (Indexed L		fset n	nod	e)
Syntax:	ADDWF	[k] {,d}			
Operands:	$0 \le k \le 95$ d $\in [0, 1]$				
Operation:	(W) + ((FSF	R2) + k) -	$\rightarrow$ des	t	
Status Affected:	N, OV, C, DC, Z				
Encoding:	0010	01d0	kkł	ĸk	kkkk
Description:	The content contents of FSR2, offse	the regis	ster in	dica	
	If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default).				
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
Decode	Read 'k'	Proce Data		-	Vrite to stination
Example:	ADDWF	[OFST]	,0		
Before Instructi W OFST FSR2 Contents of 0A2Ch After Instruction W Contents of 0A2Ch	= = = =	17h 2Ch 0A00r 20h 37h 20h	1		

BSF	Bit Set Indexed (Indexed Literal Offset mode)		
Syntax:	BSF [k], b		
Operands:	$\begin{array}{l} 0 \leq f \leq 95 \\ 0 \leq b \leq 7 \end{array}$		
Operation:	$1 \rightarrow ((FSR2) + k) < b >$		
Status Affected:	None		
Encoding:	1000 bbb0 kkkk kkkk		
Description:	Bit 'b' of the register indicated by FSR2, offset by the value 'k', is set.		
Words:	1		
Cycles:	1		
Q Cycle Activity:			
Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination
Example:	BSF [	FLAG_OFST]	, 7
Before Instructi			,
FLAG_OF FSR2	ST = =	0Ah 0A00h	
Contents of 0A0Ah	=	55h	
After Instruction	ı		
Contents of 0A0Ah	=	D5h	
	Set Indexed (Indexed Literal Offset mode)		
SETF			node)
SETF Syntax:			node)
-	(Indexed L		node)
Syntax:	(Indexed L SETF [k]	iteral Offset n	node)
Syntax: Operands:	(Indexed L SETF [k] $0 \le k \le 95$	iteral Offset n	node)
Syntax: Operands: Operation:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS	iteral Offset n	
Syntax: Operands: Operation: Status Affected:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The content	iteral Offset n GR2) + k) 1000 kkł ts of the registe	kk kkkk er indicated by
Syntax: Operands: Operation: Status Affected: Encoding: Description:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The content FSR2, offset	iteral Offset r SR2) + k) 1000 kkł	kk kkkk er indicated by
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The content FSR2, offset 1	iteral Offset n GR2) + k) 1000 kkł ts of the registe	kk kkkk er indicated by
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The content FSR2, offset	iteral Offset n GR2) + k) 1000 kkł ts of the registe	kk kkkk er indicated by
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles: Q Cycle Activity:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The content FSR2, offset 1 1	iteral Offset n SR2) + k) 1000 kkł ts of the registe et by 'k', are se	kk kkkk er indicated by et to FFh.
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The content FSR2, offset 1	iteral Offset n GR2) + k) 1000 kkł ts of the registe	kk kkkk er indicated by
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles: Q Cycle Activity: Q1	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The content FSR2, offset 1 1 Q2	R2) + k) 1000 kkl ts of the registe t by 'k', are se Q3	kk kkkk er indicated by et to FFh. Q4
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles: Q Cycle Activity: Q1 Decode	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The content FSR2, offset 1 1 Q2	iteral Offset n SR2) + k) 1000 kkl ts of the registe t by 'k', are se Q3 Process	kk kkkk er indicated by et to FFh. Q4 Write
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles: Q Cycle Activity: Q1 Decode Example:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The content FSR2, offset 1 1 Q2 Read 'k'	iteral Offset n SR2) + k) 1000 kkl ts of the registe t by 'k', are se Q3 Process	kk kkkk er indicated by et to FFh. Q4 Write
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles: Q Cycle Activity: Q1 Decode Example: Before Instruction	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The content FSR2, offset 1 1 Q2 Read 'k' SETF [ on	iteral Offset n         3R2) + k)         1000       kkl         1000       kkl         sof the registe         et by 'k', are see         Q3         Process         Data         OFST]	kk kkkk er indicated by et to FFh. Q4 Write
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles: Q Cycle Activity: Q1 Decode Example:	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The content FSR2, offset 1 1 Q2 Read 'k' SETF [ on = 2C	iteral Offset n         3R2) + k)         1000       kkl         1000       kkl         sof the registe         et by 'k', are see         Q3         Process         Data         OFST]	kk kkkk er indicated by et to FFh. Q4 Write
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles: Q Cycle Activity: Q1 Decode Example: Before Instruction OFST FSR2 Contents	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The content FSR2, offset 1 1 Q2 Read 'k' SETF [ on = 2C = 0A	R2) + k) 1000 kkł ts of the registe t by 'k', are se Q3 Process Data OFST] h 00h	kk kkkk er indicated by et to FFh. Q4 Write
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles: Q Cycle Activity: Q1 Decode Example: Before Instruction OFST FSR2	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The content FSR2, offset 1 1 Q2 Read 'k' SETF [ on = 2C = 0A = 00	R2) + k) 1000 kkł ts of the registe t by 'k', are se Q3 Process Data OFST] h 00h	kk kkkk er indicated by et to FFh. Q4 Write
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles: Q Cycle Activity: Q1 Decode Example: Before Instruction OFST FSR2 Contents of 0A2Ch	(Indexed L SETF [k] $0 \le k \le 95$ FFh $\rightarrow$ ((FS None 0110 The content FSR2, offset 1 1 Q2 Read 'k' SETF [ on = 2C = 0A = 00	iteral Offset n (R2) + k) 1000 kkl ts of the registe et by 'k', are se Q3 Process Data OFST] h 00h h	kk kkkk er indicated by et to FFh. Q4 Write

#### 查询PIC18F67K90供应商

#### 29.2.5 SPECIAL CONSIDERATIONS WITH MICROCHIP MPLAB[®] IDE TOOLS

The latest versions of Microchip's software tools have been designed to fully support the extended instruction set for the PIC18F87K90 family family. This includes the MPLAB C18 C Compiler, MPASM assembly language and MPLAB Integrated Development Environment (IDE).

When selecting a target device for software development, MPLAB IDE will automatically set default Configuration bits for that device. The default setting for the XINST Configuration bit is '0', disabling the extended instruction set and Indexed Literal Offset Addressing. For proper execution of applications developed to take advantage of the extended instruction set, XINST must be set during programming.

To develop software for the extended instruction set, the user must enable support for the instructions and the Indexed Addressing mode in their language tool(s). Depending on the environment being used, this may be done in several ways:

- A menu option or dialog box within the environment that allows the user to configure the language tool and its settings for the project
- · A command line option
- · A directive in the source code

These options vary between different compilers, assemblers and development environments. Users are encouraged to review the documentation accompanying their development systems for the appropriate information.

#### 查询PIC18F67K90供应商 30.0 DEVELOPMENT SUPPORT

The PIC[®] microcontrollers and dsPIC[®] digital signal controllers are supported with a full range of software and hardware development tools:

- Integrated Development Environment
- MPLAB[®] IDE Software
- Compilers/Assemblers/Linkers
  - MPLAB C Compiler for Various Device Families
  - HI-TECH C for Various Device Families
  - MPASM[™] Assembler
  - MPLINK[™] Object Linker/ MPLIB[™] Object Librarian
  - MPLAB Assembler/Linker/Librarian for Various Device Families
- · Simulators
  - MPLAB SIM Software Simulator
- Emulators
  - MPLAB REAL ICE™ In-Circuit Emulator
- In-Circuit Debuggers
  - MPLAB ICD 3
  - PICkit™ 3 Debug Express
- Device Programmers
  - PICkit[™] 2 Programmer
  - MPLAB PM3 Device Programmer
- Low-Cost Demonstration/Development Boards, Evaluation Kits, and Starter Kits

#### 30.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16/32-bit microcontroller market. The MPLAB IDE is a Windows[®] operating system-based application that contains:

- A single graphical interface to all debugging tools
  - Simulator
  - Programmer (sold separately)
  - In-Circuit Emulator (sold separately)
  - In-Circuit Debugger (sold separately)
- A full-featured editor with color-coded context
- A multiple project manager
- Customizable data windows with direct edit of contents
- · High-level source code debugging
- · Mouse over variable inspection
- Drag and drop variables from source to watch windows
- · Extensive on-line help
- Integration of select third party tools, such as IAR C Compilers

The MPLAB IDE allows you to:

- Edit your source files (either C or assembly)
- One-touch compile or assemble, and download to emulator and simulator tools (automatically updates all project information)
- · Debug using:
  - Source files (C or assembly)
  - Mixed C and assembly
  - Machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost-effective simulators, through low-cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increased flexibility and power.

#### 查询PIC18F67K90供应商

#### 30.2 MPLAB C Compilers for Various Device Families

The MPLAB C Compiler code development systems are complete ANSI C compilers for Microchip's PIC18, PIC24 and PIC32 families of microcontrollers and the dsPIC30 and dsPIC33 families of digital signal controllers. These compilers provide powerful integration capabilities, superior code optimization and ease of use.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

#### 30.3 HI-TECH C for Various Device Families

The HI-TECH C Compiler code development systems are complete ANSI C compilers for Microchip's PIC family of microcontrollers and the dsPIC family of digital signal controllers. These compilers provide powerful integration capabilities, omniscient code generation and ease of use.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

The compilers include a macro assembler, linker, preprocessor, and one-step driver, and can run on multiple platforms.

#### 30.4 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel[®] standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code and COFF files for debugging.

The MPASM Assembler features include:

- · Integration into MPLAB IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process

#### 30.5 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler and the MPLAB C18 C Compiler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

#### 30.6 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC devices. MPLAB C Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- · Support for the entire device instruction set
- · Support for fixed-point and floating-point data
- Command line interface
- · Rich directive set
- Flexible macro language
- MPLAB IDE compatibility

#### 查询PIC18F67K90供应商 **30.7 MPLAB SIM Software Simulator**

The MPLAB SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC[®] DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB SIM Software Simulator fully supports symbolic debugging using the MPLAB C Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

#### 30.8 MPLAB REAL ICE In-Circuit Emulator System

MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs PIC[®] Flash MCUs and dsPIC[®] Flash DSCs with the easy-to-use, powerful graphical user interface of the MPLAB Integrated Development Environment (IDE), included with each kit.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with incircuit debugger systems (RJ11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB IDE. In upcoming releases of MPLAB IDE, new devices will be supported, and new features will be added. MPLAB REAL ICE offers significant advantages over competitive emulators including low-cost, full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, a ruggedized probe interface and long (up to three meters) interconnection cables.

#### 30.9 MPLAB ICD 3 In-Circuit Debugger System

MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost effective high-speed hardware debugger/programmer for Microchip Flash Digital Signal Controller (DSC) and microcontroller (MCU) devices. It debugs and programs PIC[®] Flash microcontrollers and dsPIC[®] DSCs with the powerful, yet easyto-use graphical user interface of MPLAB Integrated Development Environment (IDE).

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

#### 30.10 PICkit 3 In-Circuit Debugger/ Programmer and PICkit 3 Debug Express

The MPLAB PICkit 3 allows debugging and programming of PIC[®] and dsPIC[®] Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB Integrated Development Environment (IDE). The MPLAB PICkit 3 is connected to the design engineer's PC using a full speed USB interface and can be connected to the target via an Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the reset line to implement in-circuit debugging and In-Circuit Serial Programming[™].

The PICkit 3 Debug Express include the PICkit 3, demo board and microcontroller, hookup cables and CDROM with user's guide, lessons, tutorial, compiler and MPLAB IDE software.

#### 查询PIC18F67K90供应商

#### 30.11 PICkit 2 Development Programmer/Debugger and PICkit 2 Debug Express

The PICkit[™] 2 Development Programmer/Debugger is a low-cost development tool with an easy to use interface for programming and debugging Microchip's Flash families of microcontrollers. The full featured Windows[®] programming interface supports baseline (PIC10F, PIC12F5xx, PIC16F5xx), midrange (PIC12F6xx, PIC16F), PIC18F, PIC24, dsPIC30, dsPIC33, and PIC32 families of 8-bit, 16-bit, and 32-bit microcontrollers, and many Microchip Serial EEPROM products. With Microchip's powerful MPLAB Integrated Development Environment (IDE) the PICkit[™] 2 enables in-circuit debugging on most PIC[®] microcontrollers. In-Circuit-Debugging runs, halts and single steps the program while the PIC microcontroller is embedded in the application. When halted at a breakpoint, the file registers can be examined and modified.

The PICkit 2 Debug Express include the PICkit 2, demo board and microcontroller, hookup cables and CDROM with user's guide, lessons, tutorial, compiler and MPLAB IDE software.

#### 30.12 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages and a modular, detachable socket assembly to support various package types. The ICSP™ cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices and incorporates an MMC card for file storage and data applications.

#### 30.13 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM[™] and dsPICDEM[™] demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ[®] security ICs, CAN, IrDA[®], PowerSmart battery management, SEEVAL[®] evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

### 查询PIC18F67K90供应商

### 31.0 ELECTRICAL CHARACTERISTICS

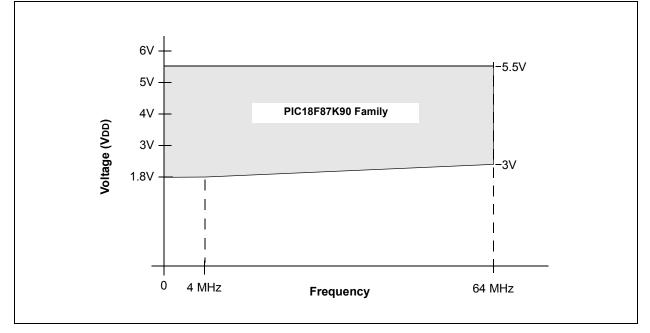
#### Absolute Maximum Ratings^(†)

Ambient temperature under bias40°C to +125°C
Storage temperature
Voltage on any digital only I/O pin or MCLR with respect to Vss (except VDD)
Voltage on any combined digital and analog pin with respect to Vss (except VDD and MCLR)0.3V to (VDD + 0.3V)
Voltage on VDD with respect to Vss (regulator enabled)
Voltage on VDD with respect to Vss (regulator disabled)
Total power dissipation (Note 1)
Maximum current out of Vss pin
Maximum current into VDD pin250 mA
Maximum output current sunk by PORTA<7:6> and any PORTB and PORTC I/O pins
Maximum output current sunk by any PORTD, PORTE and PORTJ I/O pins
Maximum output current sunk by PORTA<5:0> and any PORTF, PORTG and PORTH I/O pins
Maximum output current sourced by PORTA<7:6> and any PORTB and PORTC I/O pins
Maximum output current sourced by any PORTD, PORTE and PORTJ I/O pins
Maximum output current sourced by PORTA<5:0> and any PORTF, PORTG and PORTH I/O pins
Maximum current sunk by all ports combined
<b>Note 1:</b> Power dissipation is calculated as follows: Pdis = VDD x {IDD $-\Sigma$ IOH} + $\Sigma$ {(VDD $-$ VOH) x IOH} + $\Sigma$ (VOL x IOL)

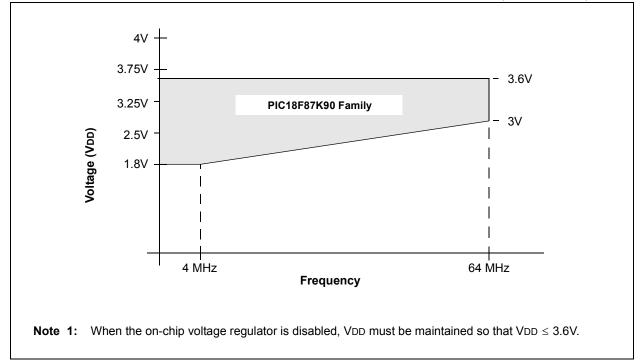
**† NOTICE:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

#### 查询PIC18F67K90供应商

FIGURE 31-1: VOLTAGE-FREQUENCY GRAPH, REGULATOR ENABLED (INDUSTRIAL)⁽¹⁾



#### FIGURE 31-2: VOLTAGE-FREQUENCY GRAPH, REGULATOR DISABLED (INDUSTRIAL)^(1,2)



### 查询PIC18F67K90供应商 31.1 DC Characteristics:

### Supply Voltage PIC18F87K90 Family (Industrial)

	87K90 Fan ustrial)	nily	Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial						
Param No.	Symbol	Characteristic	Min	Тур	Мах	Units	Conditions		
D001	Vdd	Supply Voltage	1.8 1.8		3.6 5.5	V V	ENVREG tied to Vss ENVREG tied to VDD		
D001C	AVdd	Analog Supply Voltage	VDD - 0.3	_	VDD + 0.3	V			
D001D	AVss	Analog Ground Potential	Vss – 0.3		Vss + 0.3	V			
D002	Vdr	RAM Data Retention Voltage ⁽¹⁾	1.5	_	—	V			
D003	Vpor	VDD Start Voltage to Ensure Internal Power-on Reset Signal	—	_	0.7	V	See Section 5.3 "Power-on Reset (POR)" for details		
D004	Svdd	<b>VDD Rise Rate</b> to Ensure Internal Power-on Reset Signal	0.05	_	-	V/ms	See Section 5.3 "Power-on Reset (POR)" for details		
D005	Bvdd	Brown-out Reset Voltage (High/Medium/Low-Power mode) BORV<1:0> = 11 BORV<1:0> = 10 BORV<1:0> = 01 BORV<1:0> = 00	1.69 1.88 2.53 2.82	1.8 2.0 2.7 3.0	1.91 2.12 2.86 3.18				

Note 1: This is the limit to which VDD can be lowered in Sleep mode, or during a device Reset, without losing RAM data.

## 查询PIC18F67K90供应商

#### 31.2 DC Characteristics:

### Power-Down and Supply Current PIC18F87K90 Family (Industrial)

PIC18F87K90 Family (Industrial)		Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial								
Param No.	Device	Тур	Max	Units	Conditions					
	Power-Down Current (IPD)	(1)								
	All devices	10	500	nA	-40°C					
		20	500	nA	+25°C	$V_{DD} = 1.8V^{(4)}$				
		120	600	nA	+60°C	(Sleep mode) Regulator Disabled				
		630	1800	nA	+85°C					
	All devices	50	700	nA	-40°C	(4)				
		60	700	nA	+25°C	$V_{DD} = 3.3 V^{(4)}$				
		170	800	nA	+60°C	(Sleep mode) Regulator Disabled				
		700	2700	nA	+85°C					
	All devices	350	1300	nA	-40°C	(5)				
		400	1400	nA	+25°C	$V_{DD} = 5V^{(5)}$				
		550	1500	nA	+60°C	(Sleep mode) Regulator Enabled				
		1350	4000	nA	+85°C					

**Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or VSS, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

- MCLR = VDD; WDT enabled/disabled as specified.
- 3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).

- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- 6: LCD glass is not connected; resistor current is not included.

#### 查询PIC18F67K90供应商 **31.2 DC Characteristics**:

## Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

	7K90 Family strial)	Standard Operating	-	-		<b>therwise stated)</b> +85°C for industrial		
Param No.	Device	Тур	Max	Units		Conditions		
	Supply Current (IDD) ^(2,3)							
	All devices	5.3	10	μA	-40°C	VDD = 1.8V ⁽⁴⁾		
		5.5	10	μA	+25°C	Regulator Disabled		
		5.5	10	μA	+85°C	riogulator Bioabioa		
	All devices	10	15	μΑ	-40°C	VDD = 3.3V ⁽⁴⁾	Fosc = 31 kHz	
		10	16	μA	+25°C	Regulator Disabled	(RC_RUN mode,	
		11	17	μA	+85°C	riogulator Bioabioa	LF-INTOSC)	
	All devices	70	180	μΑ	-40°C	V _{DD} = 5∨ ⁽⁵⁾		
		80	185	μA	+25°C	$VDD = 5V^{(0)}$ Regulator Enabled		
		90	190	μA	+85°C	riogulator Enabled		
	All devices	410	850	μA	-40°C	) (() (4)	Fosc = 1 MHz	
		410	800	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled		
		410	830	μA	+85°C	riogulator Bioabioa		
	All devices	680	990	μA	-40°C	) (====================================		
		680	960	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	(RC_RUN mode,	
		670	950	μA	+85°C	riogulator Bioabioa	HF-INTOSC)	
	All devices	760	1400	μA	-40°C	V _{DD} = 5∨ ⁽⁵⁾		
		780	1400	μA	+25°C	Regulator Enabled		
		800	1500	μA	+85°C	riogulator Enabloa		
	All devices	760	1300	μA	-40°C	VDD = 1.8V ⁽⁴⁾		
		760	1400	μA	+25°C	Regulator Disabled		
		770	1500	μA	+85°C	. logalator Dioublou		
	All devices	1.4	2.5	mA	-40°C	$V_{DD} = 3.3 V^{(4)}$	Fosc = 4 MHz	
		1.4	2.5	mA	+25°C	Regulator Disabled	(RC_RUN mode,	
		1.4	2.5	mA	+85°C		HF-INTOSC)	
	All devices	1.5	2.7	mA	-40°C	) (5)		
		1.5	2.7	mA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled		
		1.5	2.7	mA	+85°C			

**Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

**3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).

**6:** LCD glass is not connected; resistor current is not included.

#### 查询PIC18F67K90供应商 31.2 DC Characteristics:

### Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

	7K90 Family strial)	<b>Standard</b> Operating				otherwise stated) ≤ +85°C for industrial					
Param No.	Device	Тур	Max	Units		Conditions					
	Supply Current (IDD) Cont	(2,3)									
	All devices	2.1	5.5	μA	-40°C	) (= = - (- 0) ((4)					
		2.1	5.7	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled					
		2.2	6.0	μA	+85°C	regulator Disabled					
	All devices	3.7	7.5	μA	-40°C	(4)	Fosc = 31 kHz				
		3.9	7.8	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	(RC_IDLE mode,				
		3.9	8.5	μA	+85°C	regulator Disabled	LF-INTOSC)				
	All devices	70	180	μA	-40°C	VDD = 5V ⁽⁵⁾					
		80	190	μA	+25°C	VDD = 5V(*) Regulator Enabled					
		80	200	μA	+85°C	regulator Enabled					
	All devices	330	650	μA	-40°C	VDD = 1.8V ⁽⁴⁾	Fosc = 1 MHz				
		330	640	μA	+25°C	Regulator Disabled					
		330	630	μA	+85°C	regulator Disabled					
	All devices	520	850	μA	-40°C	$V_{DD} = 3.3 V^{(4)}$					
		520	900	μA	+25°C	$VDD = 3.3V^{(4)}$ Regulator Disabled	(RC_IDLE mode,				
		520	850	μA	+85°C	r togulator Bioabioa	HF-INTOSC)				
	All devices	590	940	μA	-40°C	VDD = 5V ⁽⁵⁾					
		600	960	μA	+25°C	Regulator Enabled					
		620	990	μA	+85°C	riogulator Enablea					
	All devices	470	770	μA	-40°C	VDD = 1.8V ⁽⁴⁾					
		470	770	μA	+25°C	Regulator Disabled					
		460	760	μA	+85°C	r togulator Bioabioa					
	All devices	800	1400	μA	-40°C	VDD = 3.3V ⁽⁴⁾	Fosc = 4 MHz				
		800	1350	μA	+25°C	Regulator Disabled	( <b>RC_IDLE</b> mode, internal HF-INTOSC)				
		790	1300	μA	+85°C	. logulator Bioabioa					
	All devices	880	1600	μA	-40°C	VDD = 5V ⁽⁵⁾					
		890	1700	μA	+25°C	VDD = 5V ^(e) Regulator Enabled					
		910	1800	μA	+85°C						

**Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

- **3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- **6:** LCD glass is not connected; resistor current is not included.

#### 查询PIC18F67K90供应商 **31.2 DC Characteristics**:

## Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

	7 <b>K90 Family</b> strial)	Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial									
Param No.	Device	Тур	Max	Units		Conditions					
	Supply Current (IDD) Cont	(2,3)									
	All devices	130	390	μA	-40°C						
		130	390	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled					
		130	390	μA	+85°C	Regulator Disabled					
	All devices	270	790	μA	-40°C		Fosc = 1 MHz				
		270	790	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	(PRI_RUN mode,				
		270	790	μA	+85°C	Regulator Disabled	EC oscillator)				
	All devices	430	990	μA	-40°C						
		450	980	μA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled					
		460	980	μA	+85°C						
	All devices	430	860	μA	-40°C						
		530	900	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled					
		490	880	μA	+85°C	Regulator Disabled					
	All devices	850	1750	μA	-40°C		Fosc = 4 MHz				
		850	1700	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	(PRI_RUN mode,				
		850	1800	μA	+85°C	riogulator Bioabioa	EC oscillator)				
	All devices	1.1	2.7	mA	-40°C	V _{DD} = 5∨ ⁽⁵⁾					
		1.1	2.6	mA	+25°C	Regulator Enabled					
		1.1	2.6	mA	+85°C						
	All devices	12	19	mA	-40°C	VDD = 3.3V ⁽⁴⁾					
		12	19	mA	+25°C	$VDD = 3.3V^{(1)}$ Regulator Disabled	-				
		12	19	mA	+85°C	guiater Dicabiou	Fosc = 64 MHz				
	All devices	13	20	mA	-40°C	V _{DD} = 5V ⁽⁵⁾	( <b>PRI_RUN</b> mode, EC oscillator)				
		13	20	mA	+25°C	VDD = 5V(*) Regulator Enabled					
		12	20	mA	+85°C						

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

- **3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- **6:** LCD glass is not connected; resistor current is not included.

## 查询PIC18F67K90供应商

#### 31.2 DC Characteristics:

### Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

	PIC18F87K90 Family (Industrial)		Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial								
Param No.	Device	Тур	Max	Units	Conditions						
	Supply Current (IDD) Cont	(2,3)									
	All devices	3.3	5.6	mA	-40°C	$\lambda = -0.0 \lambda (4)$					
		3.3	5.5	mA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	Fosc = 16 MHz, ( <b>PRI_RUN</b> mode, 4 MHz EC oscillator with PLL)				
		3.3	5.5	mA	+85°C						
	All devices	3.5	5.9	mA	-40°C						
		3.5	5.8	mA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled					
		3.5	5.8	mA	+85°C	Rogulator Enabloa					
	All devices	12	18	mA	-40°C	) (= = = 0, 0) ( <b>(4</b> )					
		12	18	mA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled					
		12	18	mA	+85°C		Fosc = 64 MHz,				
	All devices	13	20	mA	-40°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled	<ul> <li>(PRI_RUN mode, 16 MHz EC oscillator with PLL)</li> </ul>				
		12	20	mA	+25°C						
		12	20	mA	+85°C						

**Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or VSS, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

- MCLR = VDD; WDT enabled/disabled as specified.
- **3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).

- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- 6: LCD glass is not connected; resistor current is not included.

#### 查询PIC18F67K90供应商 **31.2 DC Characteristics**:

## Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

	7 <b>K90 Family</b> strial)	Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial									
Param No.	Device	Тур	Max	Units		Conditions					
	Supply Current (IDD) Cont	(2,3)									
	All devices	42	73	μA	-40°C	) ( ) ( <b>(4</b> )					
		42	73	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled					
		43	74	μA	+85°C						
	All devices	110	190	μA	-40°C	) ( ) (A)	Fosc = 1 MHz				
		110	195	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	(PRI_IDLE mode,				
		110	195	μA	+85°C		EC oscillator)				
	All devices	280	450	μA	-40°C						
		290	440	μA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled					
		300	460	μA	+85°C						
	All devices	160	360	μA	-40°C						
		160	360	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled					
		170	370	μA	+85°C						
	All devices	330	650	μA	-40°C		Fosc = 4 MHz				
		340	660	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	(PRI_IDLE mode,				
		340	660	μA	+85°C		EC oscillator)				
	All devices	510	900	μA	-40°C	) (= = = = = ; (5)					
		520	950	μA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled					
		540	990	μA	+85°C						
	All devices	4.7	9	mA	-40°C	) (====================================					
		4.8	9	mA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled					
		4.8	9	mA	+85°C		Fosc = 64 MHz				
	All devices	5.1	11	mA	-40°C		( <b>PRI_IDLE</b> mode, EC oscillator)				
		5.1	11	mA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled					
		5.2	12	mA	+85°C						

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

- **3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- **6:** LCD glass is not connected; resistor current is not included.

## 查询PIC18F67K90供应商

#### 31.2 DC Characteristics:

### Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

PIC18F87K90 Family (Industrial)		Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial								
Param No.	Device	Тур	Мах	Units	Conditions					
	Supply Current (IDD) Cont.	(2,3)								
	All devices	3.7	8.5	μA	-40°C	( + -) (4)				
		5.4	10	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled	Fosc = 32 kHz ⁽³⁾ ( <b>SEC_RUN</b> mode,			
		6.60	13	μA	+85°C	r togalator Bioabioa				
	All devices	8.7	18	μA	-40°C	(0.0)				
		10	20	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled				
		12	23	μA	+85°C	r togalator Disablea	SOSCSEL = 01)			
	All devices	60	150	μA	-40°C	) (				
		90	190	μA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled				
		100	240	μA	+85°C	riogulator Enabled				
	All devices	1.2	4	μA	-40°C	) (= = = ( =) ( <b>(4</b> )				
		1.7	5	μA	+25°C	$V_{DD} = 1.8V^{(4)}$ Regulator Disabled				
		2.6	6	μA	+85°C	r togalator Bioabioa				
	All devices	1.6	7	μA	-40°C	(0.0)	Fosc = 32 kHz ⁽³⁾			
		2.8	9	μA	+25°C	$V_{DD} = 3.3V^{(4)}$ Regulator Disabled	(SEC_IDLE mode,			
		4.1	10	μA	+85°C	- Regulator Biodbiod	SOSCSEL = 01)			
	All devices	60	160	μA	-40°C	) (= = = = = (5)				
		80	180	μA	+25°C	$V_{DD} = 5V^{(5)}$ Regulator Enabled				
		100	240	μA	+85°C					

**Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

- **3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- 6: LCD glass is not connected; resistor current is not included.

#### 查询PIC18F67K90供应商 **31.2 DC Characteristics**:

## Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

PIC18F8 (Indu	<b>7K90 Family</b> strial)	Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial									
Param No.	Device	Тур	Max	Units		Conditions					
	Module Differential Currer	nts (∆lwdt, ⊿	Albor, $\Delta$	IHLVD, A	IOSCB, ∆IAD)						
D022	Watchdog Timer										
(∆IWDT)	PIC18FXXK90	0.3	1	μA	-40°C	VDD = 1.8V ⁽⁴⁾					
		0.3	1	μA	+25°C	Regulator Disabled					
		0.3	1	μA	+85°C	Regulator Disabled					
	PIC18FXXK90	0.6	1.9	μA	-40°C	VDD = 3.3V ⁽⁴⁾					
		0.6	1.8	μA	+25°C	Regulator Disabled					
		0.6	1.8	μA	+85°C	Regulator Disabled					
	PIC18FXXK90	0.6	1.8	μA	-40°C	VDD = 5V ⁽⁵⁾					
		0.6	1.8	μA	+25°C	Regulator Enabled					
		0.6	1.8	μA	+85°C						
D022A	Brown-out Reset			-							
( $\Delta$ IBOR)	PIC18FXXK90	4.6	19	μA	-40°C	VDD = 3.3V ⁽⁴⁾					
		4.5	20	μA	+25°C	Regulator Disabled	High-Power BOR				
		4.7	20	μA	+85°C	r togulator Bioabioa					
	PIC18FXXK90	4.2	20	μA	-40°C	VDD = 5V ⁽⁵⁾					
		4.3	20	μA	+25°C	Regulator Enabled	High-Power BOR				
		4.4	20	μA	+85°C	nogalator Enabled					
D022B	High/Low-Voltage Detect										
$(\Delta HLVD)$	PIC18FXXK90	3.8	9	μA	-40°C	VDD = 1.8V ⁽⁴⁾					
		4.2	9	μA	+25°C	Regulator Disabled					
		4.3	10	μA	+85°C	i logulator Dicabica					
	PIC18FXXK90	4.5	11	μA	-40°C	VDD = 3.3V ⁽⁴⁾					
		4.8	12	μA	+25°C	Regulator Disabled					
		4.8	12	μA	+85°C						
	PIC18FXXK90	4.9	13	μA	-40°C	VDD = 5V ⁽⁵⁾					
		4.9	13	μA	+25°C	Regulator Enabled					
		4.9	13	μA	+85°C						

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

- 3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- 6: LCD glass is not connected; resistor current is not included.

## 查询PIC18F67K90供应商

#### 31.2 DC Characteristics:

### Power-Down and Supply Current PIC18F87K90 Family (Industrial) (Continued)

PIC18F87K (Industr	-	Standard Operating				otherwise stated) +85°C for industrial		
Param No.	Device	Тур	Max	Units		Condition	S	
D025 (∆IRTCC)	Real-Time Clock/ Calendar with SOSC							
	PIC18FXXK90	0.7	2.7	μA	-40°C			
		0.7	2.7	μA	+25°C	VDD = 1.8V ⁽⁴⁾		
		1.1	2.8	μA	+60°C	Regulator Disabled		
		1.1	2.9	μA	+85°C			
	PIC18FXXK90	1.20	2.9	μA	-40°C			
		1.10	2.8	μA	+25°C	VDD = 3.3V ⁽⁴⁾	32.768 kHz, SOSCGO = 1	
		2	4.6	μA	+60°C	Regulator Disabled		
		2	4.8	μA	+85°C			
	PIC18FXXK90	1.5	4.4	μA	-40°C			
		1.5	4.4	μA	+25°C	VDD = 5V ⁽⁵⁾		
		1.7	4.7	μA	+60°C	Regulator Enabled		
		1.7	4.7	μA	+85°C			
D025B	LCD Internal Biasing		1	,		- 1		
$(\Delta ILCD)$	PIC18FXXK90	0.6	2.8	μA	-40°C	VDD = 1.8V ⁽⁴⁾		
		0.6	2.8	μA	+25°C	- Regulator Disabled		
		0.7	3.4	μA	+85°C		(A)	
	PIC18FXXK90	1.1	3.9	μA	-40°C	VDD = 3.3V ⁽⁴⁾	Internal biasing ⁽⁶⁾ 1/4 Multiplex mode	
		1.0	3.9	μA	+25°C	Regulator Disabled	Type-A wave form	
		1.1	4.5	μA	+85°C		LCD clock is internal RC	
	PIC18FXXK90	1.3	5.8	μA	-40°C	VDD = 5V		
		1.2	5.8	μA	+25°C	Regulator Enabled		
		1.6	6.5	μA	+85°C			
D025B	LCD External Biasing							
$(\Delta ILCD)$	PIC18FXXK90	0.3	1.4	μA	-40°C	VDD = 1.8V ⁽⁴⁾		
		0.3	1.4	μA	+25°C	$VDD = 1.8V^{(1)}$ Regulator Disabled		
		0.7	1.7	μA	+85°C		External biasing ⁽⁶⁾ 1/4 Multiplex mode Type-A wave form LCD clock is internal RC	
	PIC18FXXK90	0.7	2.9	μA	-40°C	VDD = 3.3V ⁽⁴⁾		
		0.7	3.5	μA	+25°C	VDD = 3.3V(4) Regulator Disabled		
		1.1	3.9	μA	+85°C			
Γ	PIC18FXXK90	0.8	3.3	μA	-40°C	VDD = 5V		
		1.1	4.1	μA	+25°C	Regulator Enabled		
		1.1	4.2	μA	+85°C			

**Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

**3:** Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).

5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).

**6:** LCD glass is not connected; resistor current is not included.

# 查询PIC18F67K90供应商 31.3 DC Characteristics: PIC18F87K90 Family (Industrial)

DC CHA	ARACTE	RISTICS				unless otherwise stated) ≤ +85°C for industrial
Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
	VIL	Input Low Voltage				
		All I/O Ports:				
D030		with TTL Buffer	Vss	0.15 Vdd	V	VDD < 4.5V
D031		with Schmitt Trigger Buffer	—	0.8	V	$4.5 \leq V\text{DD} \leq 5.5 V$
		RC3, RC4	Vss	0.3 Vdd	V	VDD < 4.5
		RD5, RD6	Vss	1.5	V	$4.5 \le V \text{DD} \le 5.5 \text{V}$
D032		MCLR	Vss	0.2 VDD	V	
D033		OSC1	Vss	0.3 VDD	V	LP, XT, HS, HSPLL modes
D033A		OSC1	Vss	0.2 VDD	V	EC, ECPLL modes
D034		SOSCI	Vss	0.3 Vdd	V	
	Viн	Input High Voltage I/O Ports:				
D040		with TTL Buffer	0.25 VDD	Vdd	V	VDD < 4.5V
			2.0	Vdd		$4.5 \leq V \text{DD} \leq 5.5 \text{V}$
D041		with Schmitt Trigger Buffer	0.8 Vdd	Vdd	V	
		RC3, RC4	0.7 Vdd	Vdd	V	VDD < 4.5
		RD5, RD6	3V	5.5	V	$4.5 \leq V \text{DD} \leq 5.5 \text{V}$
D042		MCLR	0.8 Vdd	Vdd	V	
D043		OSC1	0.7 Vdd	Vdd	V	LP, XT, HS, HSPLL modes
D043A		OSC1	0.8 Vdd	Vdd	V	EC, ECPLL modes
D044		SOSCI	0.7 Vdd	Vdd	V	
	lı∟	Input Leakage Current ⁽¹⁾				
D060		I/O Ports	±50	±200	nA	$Vss \le VPIN \le VDD,$ Pin at High-Impedance
D061		MCLR	_	±5	μA	$Vss \leq V PIN \leq V DD$
D063		OSC1	—	±5	μA	$Vss \leq V PIN \leq V DD$
	IPU	Weak Pull-up Current				
D070	IPURB	PORTB Weak Pull-up Current	50	400	μA	VDD = 3.3V, VPIN = VSS

## 查询PIC18F67K90供应商

31.3 DC Characteristics: PIC18F87K90 Family (Industrial) (Continued)

DC CHA	ARACTE	RISTICS	Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial					
Param No.	Symbol	Characteristic	Min	Мах	Units	Conditions		
	Vol	Output Low Voltage						
D080		I/O Ports:						
		PORTA, PORTF, PORTG, PORTH	_	0.6	V	Io∟ = 2 mA, VDD = 4.5V, -40°C to +85°C		
		PORTB, PORTC, PORTD, PORTE, PORTJ	_	0.6	V	Io∟ = 3.4 mA, VDD = 4.5V, -40°C to +85°C		
D083		OSC2/CLKO (EC, ECPLL modes)	_	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C		
	Vон	Output High Voltage ⁽¹⁾						
D090		I/O Ports:			V			
		PORTA, PORTF, PORTG, PORTH	Vdd - 0.7	—	V	ІОн = -2 mA, VDD = 3.3V, -40°С to +85°С		
		PORTB, PORTC,PORTD, PORTE, PORTJ	Vdd - 0.7	—	V	IOH = -2 mA, VDD = 3.3V, -40°C to +85°C		
D092		OSC2/CLKO (INTOSC, EC, ECPLL modes)	Vdd - 0.7	—	V	IOH = -1 mA, VDD = 3.3V, -40°C to +85°C		
		Capacitive Loading Specs on Output Pins						
D100 ⁽⁴⁾	COSC2	OSC2 Pin	_	20	pF	In HS mode when external clock is used to drive OSC1		
D101	Сю	All I/O Pins and OSC2	_	50	pF	To meet the AC Timing Specifications		
D102	Св	SCLx, SDAx	—	400	pF	I ² C™ Specification		

**Note 1:** Negative current is defined as current sourced by the pin.

### 31.4 DC Characteristics: CTMU Current Source Specifications

DC CH	DC CHARACTERISTICS			$\begin{array}{llllllllllllllllllllllllllllllllllll$					
Param No.	Sym	Characteristic	Min	Typ ⁽¹⁾	Мах	Units	Conditions		
	IOUT1	CTMU Current Source, Base Range	—	550		nA	CTMUICON<1:0> = 01		
	IOUT2	CTMU Current Source, 10x Range	_	5.5	_	μA	CTMUICON<1:0> = 10		
	IOUT3	CTMU Current Source, 100x Range	_	55	_	μA	CTMUICON<1:0> = 11		

**Note 1:** Nominal value at center point of current trim range (CTMUICON<7:2> = 000000).

## 查询PIC18F67K90供应商

### TABLE 31-1: MEMORY PROGRAMMING REQUIREMENTS

DC CH	ARACTI	ERISTICS	Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C $\leq$ TA $\leq$ +85°C for industrial					
Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions	
		Internal Program Memory Programming Specifications ⁽¹⁾						
D110	VPP	Voltage on MCLR/VPP/RE5 pin	VDD + 4.5	—	9	V	(Note 3)	
D113	IDDP	Supply Current during Programming	—	—	10	mA		
		Data EEPROM Memory					(Note 2)	
D120	ED	Byte Endurance	100K	1000K	—	E/W	-40°C to +85°C	
D121	Vdrw	VDD for Read/Write	1.8	_	3.6	V	Using EECON to read/write	
D122	TDEW	Erase/Write Cycle Time	—	4	—	ms		
D123	TRETD	Characteristic Retention	40	—	—	Year	Provided no other specifications are violated	
D124	TREF	Number of Total Erase/Write Cycles before Refresh ⁽²⁾	1M	10M	—	E/W	-40°C to +85°C	
		Program Flash Memory						
D130	Eр	Cell Endurance	10K	_	—	E/W	-40°C to +85°C	
D131	VPR	VDD for Read	1.8	_	5.5	V	ENVREG tied to VDD	
			1.8	—	3.3	V	ENVREG tied to Vss	
D132B	VPEW	Voltage for Self-Timed Erase or Write Operations						
		VDD	1.8	—	5.5	V	ENVREG tied to VDD	
D133A	Tiw	Self-Timed Write Cycle Time	—	2	—	ms		
D134	TRETD	Characteristic Retention	40	—	—	Year	Provided no other specifications are violated	
D135	Iddp	Supply Current during Programming	—	—	10	mA		
D140	TWE	Writes per Erase Cycle	—	—	1		For each physical address	

† Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** These specifications are for programming the on-chip program memory through the use of table write instructions.

2: Refer to Section 8.8 "Using the Data EEPROM" for a more detailed discussion on data EEPROM endurance.

**3:** The MPLAB[®] ICD 2 does not support variable VPP output. Circuitry to limit the ICD 2 VPP voltage must be placed between the ICD 2 and target system when programming or debugging with the ICD 2.

## 查询PIC18F67K90供应商

## TABLE 31-2: COMPARATOR SPECIFICATIONS

Operating	<b>Dperating Conditions:</b> $1.8V \le VDD \le 5V$ , $-40^{\circ}C \le TA \le +85^{\circ}C$ (unless otherwise stated)						
Param No.	Sym	Characteristics	Min	Тур	Мах	Units	Comments
D300	VIOFF	Input Offset Voltage	—	±5.0	40	mV	
D301	VICM	Input Common-Mode Voltage	_	—	AVDD - 1.5	V	
D302	CMRR	Common-Mode Rejection Ratio	55	—	—	dB	
D303	TRESP	Response Time ⁽¹⁾	_	150	400	ns	
D304	Тмс2о∨	Comparator Mode Change to Output Valid*	—	—	10	μS	

**Note 1:** Response time measured with one comparator input at (AVDD – 1.5)/2, while the other input transitions from Vss to VDD.

### TABLE 31-3: VOLTAGE REFERENCE SPECIFICATIONS

Operating	<b>Operating Conditions:</b> $1.8V \le V_{DD} \le 5V$ , $-40^{\circ}C \le T_A \le +85^{\circ}C$ (unless otherwise stated)						
Param No.	Sym	Characteristics	Min	Тур	Max	Units	Comments
D310	VRES	Resolution	VDD/24		VDD/32	LSb	
D311	VRAA	Absolute Accuracy	—	_	1/2	LSb	
D312	VRur	Unit Resistor Value (R)	—	2k	—	Ω	
D313	TSET	Settling Time ⁽¹⁾	—		10	μS	

**Note 1:** Settling time measured while CVRR = 1 and CVR<3:0> transitions from '0000' to '1111'.

### TABLE 31-4: INTERNAL VOLTAGE REGULATOR SPECIFICATIONS

Operatir	<b>Dperating Conditions:</b> $-40^{\circ}C \le TA \le +85^{\circ}C$ (unless otherwise stated)						
Param No.	Sym	Characteristics	Min	Тур	Мах	Units	Comments
	Vrgout	Regulator Output Voltage	_	3.3	—	V	
	CEFC	External Filter Capacitor Value	4.7	10	_	μF	Capacitor must be low-ESR, a low series resistance (< 5Ω)

## 查询PIC18F67K90供应商

## 31.5 AC (Timing) Characteristics

### 31.5.1 TIMING PARAMETER SYMBOLOGY

The timing parameter symbols have been created following one of the following formats:

1. TppS2pp	S	3. Tcc:st	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
Т			
F	Frequency	Т	Time
Lowercase	letters (pp) and their meanings:		
рр			
сс	CCP1	osc	OSC1
ck	CLKO	rd	RD
cs	CS	rw	RD or WR
di	SDI	sc	SCK
do	SDO	SS	SS
dt	Data in	tO	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
Uppercase	letters and their meanings:	·	
S			
F	Fall	Р	Period
н	High	R	Rise
I	Invalid (High-Impedance)	V	Valid
L	Low	Z	High-Impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
TCC:ST (I ² C	specifications only)		
CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	Stop condition
STA	Start condition		

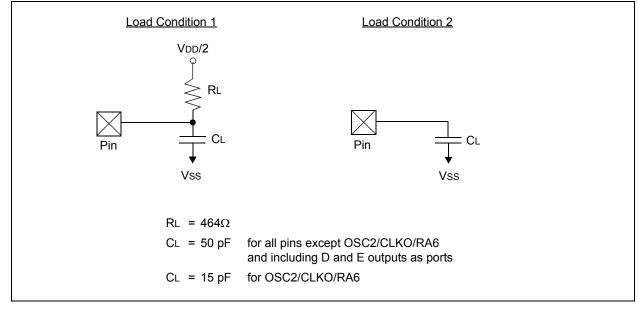
#### 查询PIC18F67K90供应商 31.5.2 IIMING CONDITIONS

The temperature and voltages specified in Table 31-5 apply to all timing specifications unless otherwise noted. Figure 31-3 specifies the load conditions for the timing specifications.

### TABLE 31-5: TEMPERATURE AND VOLTAGE SPECIFICATIONS – AC

	Standard Operating Conditions (unless otherwise stated)
AC CHARACTERISTICS	Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial
	Operating voltage VDD range as described in <b>Section 31.1</b> and <b>Section 31.3</b> .

### FIGURE 31-3: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



#### 

### TABLE 31-6: EXTERNAL CLOCK TIMING REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
1A	Fosc	External CLKIN Frequency ⁽¹⁾	DC	64	MHz	EC, ECIO Oscillator mode
		Oscillator Frequency ⁽¹⁾	DC	4	MHz	RC Oscillator mode
			0.1	4	MHz	XT Oscillator mode
			4	16	MHz	HS Oscillator mode
			4	16	MHz	HS + PLL Oscillator mode
			5	33	kHz	LP Oscillator mode
1	Tosc	External CLKIN Period ⁽¹⁾	15.6	_	ns	EC, ECIO Oscillator mode
		Oscillator Period ⁽¹⁾	250	_	ns	RC Oscillator mode
			250	10,000	ns	XT Oscillator mode
			40 62.5	250 250	ns ns	HS Oscillator mode HS + PLL Oscillator mode
			5	200	μS	LP Oscillator mode
2	Тсү	Instruction Cycle Time ⁽¹⁾	62.5	_	ns	Tcy = 4/Fosc
3	TosL,	External Clock in (OSC1)	30		ns	XT Oscillator mode
	TosH	High or Low Time	2.5	_	μs	LP Oscillator mode
			10		ns	HS Oscillator mode
4	TosR,	External Clock in (OSC1)		20	ns	XT Oscillator mode
	TosF	Rise or Fall Time	—	50	ns	LP Oscillator mode
			—	7.5	ns	HS Oscillator mode

**Note 1:** Instruction cycle period (TCY) equals four times the input oscillator time base period for all configurations except PLL. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "max." cycle time limit is "DC" (no clock) for all devices.

## 查询PIC18F67K90供应商

## TABLE 31-7: PLL CLOCK TIMING SPECIFICATIONS (VDD = 1.8V TO 5.5V)

Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
F10	Fosc	Oscillator Frequency Range	4	_	5	MHz	VDD = 1.8-5.5V
			4		16	MHz	VDD = 3.0-5.5V, -40°C to +85°C
F11	Fsys	On-Chip VCO System Frequency	16	_	20	MHz	VDD = 1.8-5.5V
			16		64	MHz	VDD = 3.0-5.5V, -40°C to +85°C
F12	t _{rc}	PLL Start-up Time (Lock Time)	_	_	2	ms	
F13	$\Delta \text{CLK}$	CLKOUT Stability (Jitter)	-2	_	+2	%	

† Data in "Typ" column is at 3V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

### TABLE 31-8: INTERNAL RC ACCURACY (INTOSC)

PIC18F	87K90 Family	Standard Operating	-	-		nless otherwise s TA ≤ +85°C	tated)	
Param No.	Min   Typ   Max   Units   Conditions				ditions			
OA1	HF-INTOSC Accuracy @ Freq	= 16 MHz, 8 MHz, 4 MHz, 2 MHz, 1 MHz, 500 kHz, 250 kHz ⁽¹⁾						
		-2	_	2	%	+25°C	VDD = 3.0-5.0V	
		-5	_	5	%	-40°C to +85°C	VDD = 3.0-5.0V	
		-5	_	5	%	-40°C to +85°C	VDD = 1.8-5.0V	
OA2	LF-INTOSC Accuracy @ Freq	= 31 kHz						
		-15		15	%	-40°C to +85°C	VDD = 1.8-5.0V	

Note 1: Frequency calibrated at 25°C. OSCTUNE register can be used to compensate for temperature drift.

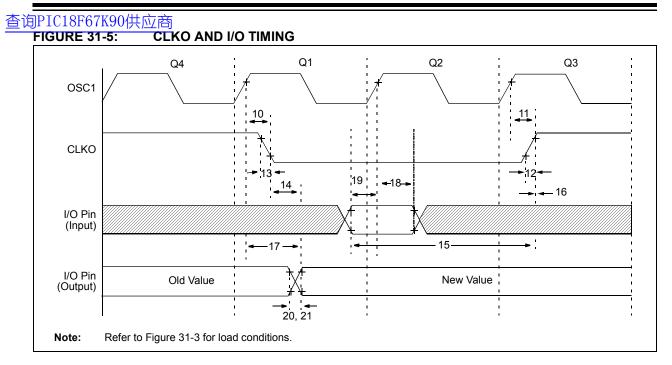


TABLE 31-9:	CLKO AND I/O TIMING REQUIREMENTS
-------------	----------------------------------

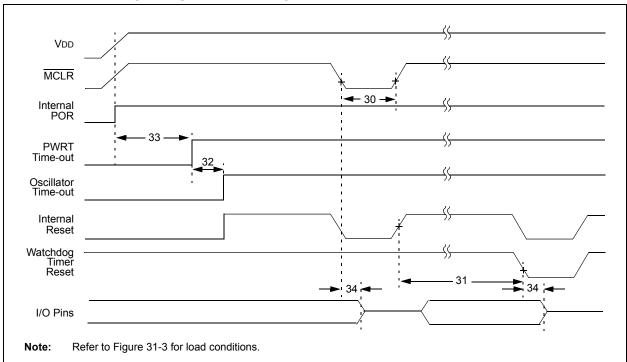
Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
10	TosH2cĸL	OSC1 ↑ to CLKO ↓	—	75	200	ns	(Note 1)
11	TosH2ckH	OSC1 ↑ to CLKO ↑	—	75	200	ns	(Note 1)
12	TCKR	CLKO Rise Time	—	15	30	ns	(Note 1)
13	ТскF	CLKO Fall Time	—	15	30	ns	(Note 1)
14	TckL2IoV	CLKO $\downarrow$ to Port Out Valid	—		0.5 Tcy + 20	ns	
15	TioV2скH	Port In Valid before CLKO ↑	0.25 Tcy + 25		_	ns	
16	TckH2iol	Port In Hold after CLKO ↑	0			ns	
17	TosH2IoV	OSC1 ↑ (Q1 cycle) to Port Out Valid	—	50	150	ns	
18	TosH2ıol	OSC1 ↑ (Q2 cycle) to Port Input Invalid (I/O in hold time)	100	_	—	ns	
19	TioV2osH	Port Input Valid to OSC1 ↑ (I/O in setup time)	0	_	—	ns	
20	TIOR	Port Output Rise Time	—	10	25	ns	
21	TIOF	Port Output Fall Time		10	25	ns	
22†	Tinp	INTx pin High or Low Time	20	_	—	ns	
23†	Trbp	RB<7:4> Change INTx High or Low Time	Тсү		—	ns	

† These parameters are asynchronous events not related to any internal clock edges.

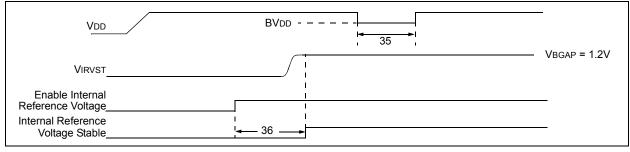
**Note 1:** Measurements are taken in EC mode, where CLKO output is 4 x Tosc.

## 查询PIC18F67K90供应商

FIGURE 31-6: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING



#### FIGURE 31-7: BROWN-OUT RESET TIMING



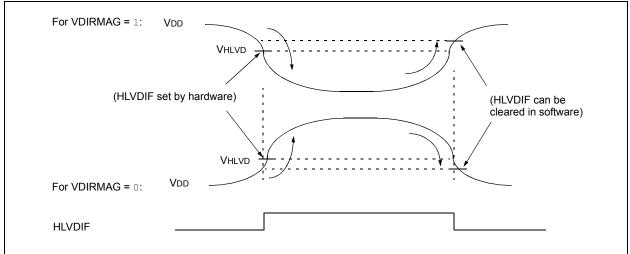
## 查询PIC18F67K90供应商

#### TABLE 31-10: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER AND BROWN-OUT RESET REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Тур	Мах	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2		—	μS	VDD = 3.3-5.0V, -40°C to +85°C
			5	_	_	μS	VDD = 3.3-5.0V
31	Twdt	Watchdog Timer Time-out Period (no postscaler)	—	4.00	—	ms	
32	Tost	Oscillation Start-up Timer Period	1024 Tosc	_	1024 Tosc	_	Tosc = OSC1 period
33	TPWRT	Power-up Timer Period	—	65.5	140	ms	
34	Tioz	I/O High-Impedance from MCLR Low or Watchdog Timer Reset	—	2	—	μS	
35	TBOR	Brown-out Reset Pulse Width	200	_	—	μS	$VDD \le BVDD$ (see D005)
36	TIRVST	Time for Internal Reference Voltage to become Stable	_	25	—	μS	
37	Thlvd	High/Low-Voltage Detect Pulse Width	200	_	—	μS	$V D D \leq V H L V D$
38	TCSD	CPU Start-up Time	5	_	10	μS	
39	TIOBST	Time for INTOSC to Stabilize		1	_	ms	

## 查询PIC18F67K90供应商

FIGURE 31-8: HIGH/LOW-VOLTAGE DETECT CHARACTERISTICS



### TABLE 31-11: HIGH/LOW-VOLTAGE DETECT CHARACTERISTICS

Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial								
Param No.	Sym	Charact	eristic	Min	Тур	Max	Units	Conditions
D420		HLVD Voltage on VDD	HLVDL<3:0> = 0000	1.80	1.86	1.90	V	
		Transition High-to-Low	HLVDL<3:0> = 0001	2.03	2.12	2.13	V	
			HLVDL<3:0> = 0010	2.24	2.33	2.35	V	
			HLVDL<3:0> = 0011	2.40	2.49	2.53	V	
			HLVDL<3:0> = 0100	2.50	2.59	2.62	V	
			HLVDL<3:0> = 0101	2.70	2.75	2.84	V	
			HLVDL<3:0> = 0110	2.82	2.93	2.97	V	
			HLVDL<3:0> = 0111	2.95	3.07	3.10	V	
			HLVDL<3:0> = 1000	3.24	3.30	3.41	V	
			HLVDL<3:0> = 1001	3.42	3.48	3.59	V	
			HLVDL<3:0> = 1010	3.61	3.67	3.79	V	
			HLVDL<3:0> = 1011	3.82	3.87	4.01	V	
			HLVDL<3:0> = 1100	4.06	4.21	4.26	V	
			HLVDL<3:0> = 1101	4.33	4.42	4.55	V	
			HLVDL<3:0> = 1110	4.64	4.77	4.87	V	

查询PIC18F67K90供应商 FIGURE 31-9: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS **T0CKI** 40 11 42 SOSCO/T1CKI 45 47 48 TMR0 or TMR1 I Refer to Figure 31-3 for load conditions. Note:

TABLE	TABLE 31-12: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS								
Param No.	Symbol		Characteristic	;	Min	Max	Units	Conditions	
40	Тт0Н	T0CKI High F	² ulse Width	No prescaler	0.5 Tcy + 20	—	ns		
				With prescaler	10	_	ns		
41	TT0L	T0CKI Low P	ulse Width	No prescaler	0.5 Tcy + 20	_	ns		
				With prescaler	10	—	ns		
42	T⊤0P	T0CKI Period	1	No prescaler	Tcy + 10	—	ns		
				With prescaler	Greater of: 20 ns or (TcY + 40)/N	-	ns	N = prescale value (1, 2, 4,, 256)	
45	T⊤1H	T1CKI High	Synchronous, n	o prescaler	0.5 Tcy + 20	—	ns		
		Time	Synchronous, with prescaler		10	_	ns		
			Asynchronous		30	—	ns		
46	T⊤1L	T1CKI Low	Synchronous, n	o prescaler	0.5 Tcy + 5	—	ns		
		Time	Synchronous, w	vith prescaler	10	_	ns		
			Asynchronous		30	—	ns		
47	T⊤1P	T1CKI Input Period	Synchronous		Greater of: 20 ns or	_	ns	N = prescale value	

TABLE 31-12:	TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS
--------------	-----------------------------------------------

Asynchronous

T1CKI Oscillator Input Frequency Range

Delay from External T1CKI Clock Edge to

Timer Increment

FT1

TCKE2TMRI

48

(TCY + 40)/N

60

DC

2 Tosc

(1, 2, 4, 8)

ns

kHz

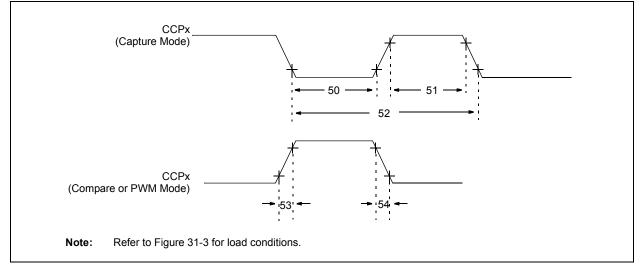
____

50

7 Tosc

### 查询PIC18F67K90供应商

FIGURE 31-10: CAPTURE/COMPARE/PWM TIMINGS (ECCP1, ECCP2 MODULES)



### TABLE 31-13: CAPTURE/COMPARE/PWM REQUIREMENTS (ECCP1, ECCP2 MODULES)

Param No.	Symbol	с	haracteristic	Min	Max	Units	Conditions
50	TccL	CCPx Input Low	No prescaler	0.5 Tcy + 20		ns	
	Tim	Time	With prescaler	10	—	ns	
51	TccH	CCPx Input	No prescaler	0.5 Tcy + 20		ns	
		High Time	With prescaler	10		ns	
52	TCCP	CCPx Input Perio	od	<u>3 Tcy + 40</u> N	_	ns	N = prescale value (1, 4 or 16)
53	TccR	CCPx Output Fal	ll Time	—	25	ns	
54	TCCF	CCPx Output Fal	ll Time	—	25	ns	

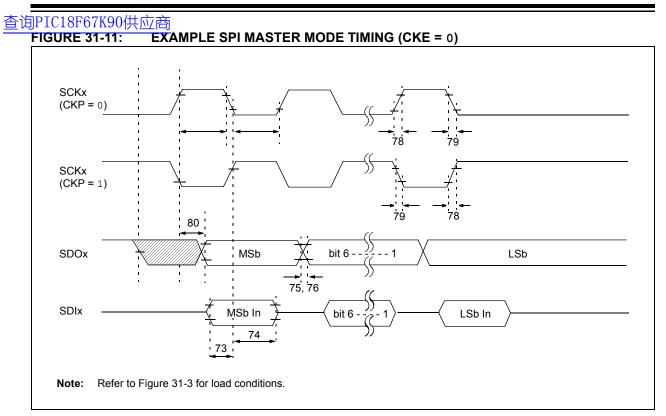


TABLE 31-14:	4: EXAMPLE SPI MODE REQUIREMENTS (MASTER MODE	i, CKE = 0)
--------------	-----------------------------------------------	-------------

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
73	TDIV2scH, TDIV2scL	Setup Time of SDIx Data Input to SCKx Edge	20	—	ns	
73A	Тв2в	Last Clock Edge of Byte 1 to the 1st Clock Edge of Byte 2	1.5 Tcy + 40	_	ns	
74	TscH2dlL, TscL2dlL	Hold Time of SDIx Data Input to SCKx Edge	40		ns	
75	TDOR	SDOx Data Output Rise Time	—	25	ns	
76	TdoF	SDOx Data Output Fall Time	—	25	ns	
78	TscR	SCKx Output Rise Time (Master mode)	—	25	ns	
79	TscF	SCKx Output Fall Time (Master mode)	—	25	ns	
80	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	—	50	ns	

## 

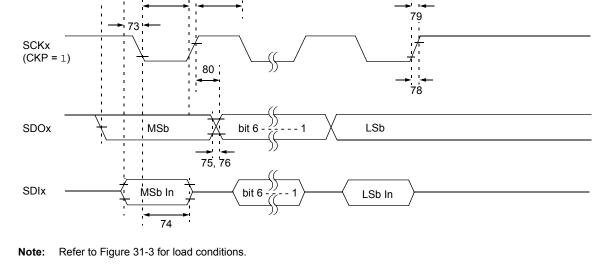


TABLE 31-15:	EXAMPLE SPI MODE REQUIREMENTS (MASTER MODE, CKE = 1)
--------------	------------------------------------------------------

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
73A	Тв2в	Last Clock Edge of Byte 1 to the 1st Clock Edge of Byte 2	1.5 Tcy + 40	—	ns	
74	TscH2DIL, TscL2DIL	Hold Time of SDIx Data Input to SCKx Edge	40	—	ns	
75	TDOR	SDOx Data Output Rise Time	_	25	ns	
76	TdoF	SDOx Data Output Fall Time	—	25	ns	
78	TscR	SCKx Output Rise Time (Master mode)	—	25	ns	
79	TscF	SCKx Output Fall Time (Master mode)	_	25	ns	
80	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	—	50	ns	
81	TDOV2scH, TDOV2scL	SDOx Data Output Setup to SCKx Edge	Тсү	—	ns	

#### 查询PIC18F67K90供应商 FIGURE 31-13: EXAMPLE SPI SLAVE MODE TIMING (CKE = 0) SSx \$ 70 SCKx (CKP = 0) 83-72 79 78 SCKx (CKP = 1) 79 78 80 LSb MSb bit 6 SDOx - 1 → → 75, 76 77 MSb In SDIx bit 6 LSb In 74 73 Refer to Figure 31-3 for load conditions. Note:

### TABLE 31-16: EXAMPLE SPI MODE REQUIREMENTS (SLAVE MODE TIMING, CKE = 0)

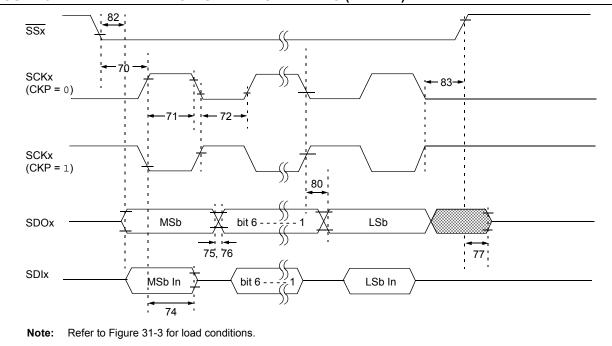
Param No.	Symbol	Characteristic		Min	Мах	Units	Conditions
70	TssL2scH, TssL2scL	$\overline{\text{SSx}} \downarrow$ to SCKx $\downarrow$ or SCKx $\uparrow$ Input		3 Тсү	_	ns	
70A	TssL2WB	SSx to write to SSPxBUF		3 Tcy	—	ns	
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	—	ns	(Note 1)
72	TscL	SCKx Input Low Time	Continuous	1.25 Tcy + 30		ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73	TDIV2scH, TDIV2scL			20	—	ns	
73A	Тв2в	Last Clock Edge of Byte 1 to the First Clo	ck Edge of Byte 2	1.5 Tcy + 40	—	ns	(Note 2)
74	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx	Edge	40	—	ns	
75	TDOR	SDOx Data Output Rise Time		—	25	ns	
76	TdoF	SDOx Data Output Fall Time		—	25	ns	
77	TssH2doZ	SSx ↑ to SDOx Output High-impedance	e	10	50	ns	
78	TscR	SCKx Output Rise Time (Master mode)		—	25	ns	
79	TscF	SCKx Output Fall Time (Master mode)		—	25	ns	
80	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge		—	50	ns	
83	TscH2ssH, TscL2ssH	SSx		1.5 Tcy + 40	_	ns	

Note 1: Requires the use of Parameter #73A.

**2:** Only if Parameter #71A and #72A are used.

## 查询PIC18F67K90供应商

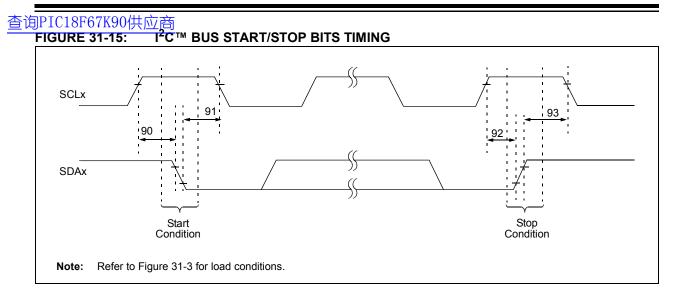
FIGURE 31-14: EXAMPLE SPI SLAVE MODE TIMING (CKE = 1)



Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	$\overline{\text{SSx}} \downarrow$ to SCKx $\downarrow$ or SCKx $\uparrow$ Input		3 Тсү		ns	
70A	TssL2WB	SSx to write to SSPxBUF		3 Tcy	_	ns	
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCKx Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73A	Тв2в	Last Clock Edge of Byte 1 to the First	Clock Edge of Byte 2	1.5 Tcy + 40	—	ns	(Note 2)
74	TscH2DIL, TscL2DIL	Hold Time of SDIx Data Input to SC	Kx Edge	40		ns	
75	TDOR	SDOx Data Output Rise Time		—	25	ns	
76	TDOF	SDOx Data Output Fall Time		—	25	ns	
77	TssH2doZ	SSx ↑ to SDOx Output High-Impeda	ance	10	50	ns	
78	TscR	SCKx Output Rise Time (Master mo	ode)	—	25	ns	
79	TscF	SCKx Output Fall Time (Master mod	de)	—	25	ns	
80	TSCH2DOV, TSCL2DOV	SDOx Data Output Valid after SCKx	—	50	ns		
82	TssL2doV	SDOx Data Output Valid after $\overline{\text{SSx}} \downarrow \text{Edge}$		_	50	ns	
83	TscH2ssH, TscL2ssH	SSx ↑ after SCKx Edge		1.5 Tcy + 40	_	ns	

**Note 1:** Requires the use of Parameter #73A.

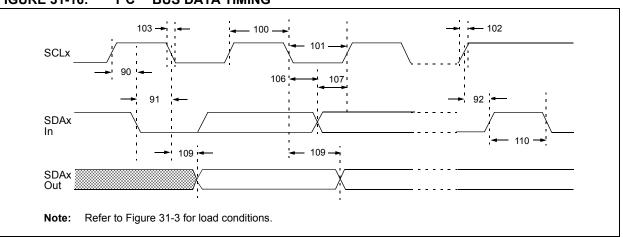
**2:** Only if Parameter #71A and #72A are used.



## TABLE 31-18: I²C[™] BUS START/STOP BITS REQUIREMENTS (SLAVE MODE)

Param. No.	Symbol	Characte	ristic	Min	Max	Units	Conditions
90	TSU:STA	Start Condition	100 kHz mode	4700	_	ns	Only relevant for Repeated
		Setup Time	400 kHz mode	600	—		Start condition
91	THD:STA	Start Condition	100 kHz mode	4000	_	ns	After this period, the first
		Hold Time	400 kHz mode	600	_		clock pulse is generated
92	Tsu:sto	Stop Condition	100 kHz mode	4700	_	ns	
		Setup Time	400 kHz mode	600	_		
93	THD:STO	Stop Condition	100 kHz mode	4000	_	ns	
		Hold Time	400 kHz mode	600	_		

#### 查询PIC18F67K90供应商 FIGURE 31-16: I²C™ BUS DATA TIMING

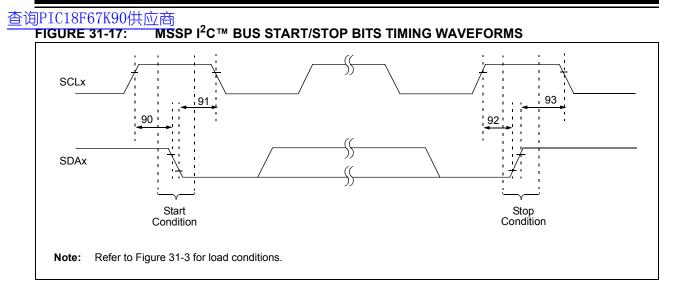


Param. No.	Symbol	Characteris	tic	Min	Мах	Units	Conditions
100	Тнідн	Clock High Time	100 kHz mode	4.0	_	μS	
			400 kHz mode	0.6	_	μS	
			MSSP module	1.5 TCY	—		
101	TLOW	Clock Low Time	100 kHz mode	4.7	_	μS	
			400 kHz mode	1.3	—	μs	
			MSSP module	1.5 TCY	_		
102	TR	SDAx and SCLx Rise Time	100 kHz mode	—	1000	ns	
			400 kHz mode	20 + 0.1 CB	300	ns	CB is specified to be from 10 to 400 pF
103	TF	SDAx and SCLx Fall Time	100 kHz mode	—	300	ns	
			400 kHz mode	20 + 0.1 Св	300	ns	CB is specified to be from 10 to 400 pF
90	TSU:STA	Start Condition Setup Time	100 kHz mode	4.7		μs	Only relevant for Repeated
			400 kHz mode	0.6	_	μS	Start condition
91	THD:STA	Start Condition Hold Time	100 kHz mode	4.0	_	μS	After this period, the first clock
			400 kHz mode	0.6	_	μS	pulse is generated
106	THD:DAT	Data Input Hold Time	100 kHz mode	0	—	ns	
			400 kHz mode	0	0.9	μS	
107	TSU:DAT	Data Input Setup Time	100 kHz mode	250	—	ns	(Note 2)
			400 kHz mode	100	—	ns	
92	Tsu:sto	Stop Condition Setup Time	100 kHz mode	4.7	_	μS	
			400 kHz mode	0.6	_	μS	
109	ΤΑΑ	Output Valid from Clock	100 kHz mode		3500	ns	(Note 1)
			400 kHz mode			ns	
110	TBUF	Bus Free Time	100 kHz mode	4.7	_	μS	Time the bus must be free before
			400 kHz mode	1.3	—	μS	a new transmission can start
D102	Св	Bus Capacitive Loading		—	400	pF	

## TABLE 31-19: I²C[™] BUS DATA REQUIREMENTS (SLAVE MODE)

**Note 1:** As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCLx to avoid unintended generation of Start or Stop conditions.

2: A Fast mode I²C[™] bus device can be used in a Standard mode I²C bus system, but the requirement, TSU:DAT ≥ 250 ns, must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLx signal. If such a device does stretch the LOW period of the SCLx signal, it must output the next data bit to the SDAx line, TR max. + TSU:DAT = 1000 + 250 = 1250 ns (according to the Standard mode I²C bus specification), before the SCLx line is released.



## TABLE 31-20: MSSP I²C[™] BUS START/STOP BITS REQUIREMENTS

Param. No.	Symbol	Characte	ristic	Min	Max	Units	Conditions
90	TSU:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)		ns	Only relevant for
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_		Repeated Start
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_		condition
91	THD:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	After this period, the
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_		first clock pulse is
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_		generated
92	Tsu:sto	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_		
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_		
93	THD:STO	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_	]	
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	]	

**Note 1:** Maximum pin capacitance = 10 pF for all  $I^2C^{TM}$  pins.

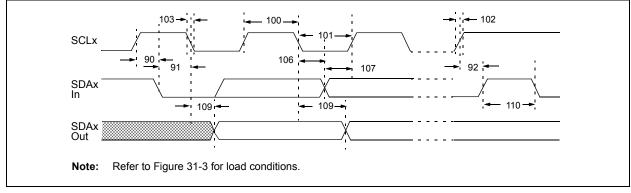


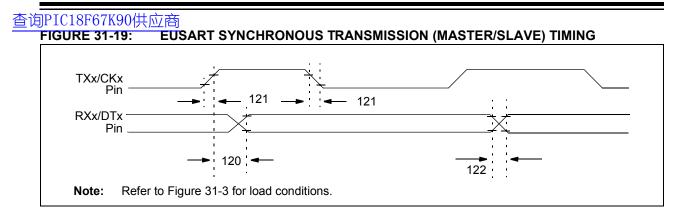
FIGURE 31-18: MSSP I²C[™] BUS DATA TIMING

## 查询PIC18F67K90供应商 TABLE 31-21: MSSPI²C™ BUS DATA REQUIREMENTS

Param. No.	Symbol	Charac	teristic	Min	Max	Units	Conditions	
100	Тнідн	Clock High Time	100 kHz mode	2(Tosc)(BRG + 1)	_	_		
			400 kHz mode	2(Tosc)(BRG + 1)				
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)				
101	TLOW	Clock Low Time	100 kHz mode	2(Tosc)(BRG + 1)	_			
			400 kHz mode	2(Tosc)(BRG + 1)	_	_		
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	—		
102	TR	SDAx and SCLx	100 kHz mode	_	1000	ns	CB is specified to be from	
		Rise Time	400 kHz mode	20 + 0.1 Св	300	ns	10 to 400 pF	
			1 MHz mode ⁽¹⁾	_	300	ns		
103	TF	SDAx and SCLx	100 kHz mode	—	300	ns	CB is specified to be from	
		Fall Time	400 kHz mode	20 + 0.1 Св	300	ns	10 to 400 pF	
			1 MHz mode ⁽¹⁾	_	100	ns		
90	TSU:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	—	Only relevant for Repeated	
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	—	_	Start condition	
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	—	_	-	
91	THD:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	—	After this period, the first	
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_	—	clock pulse is generated	
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	—		
106	THD:DAT	Data Input	100 kHz mode	0	_	ns		
		Hold Time	400 kHz mode	0	0.9	μs		
			1 MHz mode ⁽¹⁾	_	_	ns		
107	TSU:DAT	Data Input	100 kHz mode	250	_	ns	(Note 2)	
		Setup Time	400 kHz mode	100	_	ns		
			1 MHz mode ⁽¹⁾	_	_	ns		
92	Tsu:sto	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	—		
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_	—		
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	—		
109	ΤΑΑ	Output Valid	100 kHz mode	_	3500	ns		
		from Clock	400 kHz mode	_	1000	ns		
			1 MHz mode ⁽¹⁾	_	—	ns		
110	TBUF	Bus Free Time	100 kHz mode	4.7	—	μS	Time the bus must be free	
			400 kHz mode	1.3	—	μS	before a new transmission	
			1 MHz mode ⁽¹⁾	_	—	μS	can start	
D102	Св	Bus Capacitive L	oading	—	400	pF		

**Note 1:** Maximum pin capacitance = 10 pF for all  $I^2C^{TM}$  pins.

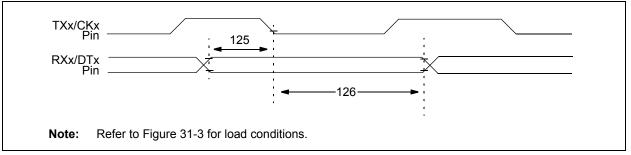
**2:** A Fast mode I²C bus device can be used in a Standard mode I²C bus system, but parameter #107  $\ge$  250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLx signal. If such a device does stretch the LOW period of the SCLx signal, it must output the next data bit to the SDAx line, parameter #102 + parameter #107 = 1000 + 250 = 1250 ns (for 100 kHz mode), before the SCLx line is released.



### TABLE 31-22: EUSART/AUSART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Param No.	Symbol	Characteristic		Мах	Units	Conditions
120	TCKH2DTV	SYNC XMIT (MASTER and SLAVE) Clock High to Data Out Valid	_	40	ns	
121	TCKRF	Clock Out Rise Time and Fall Time (Master mode)	—	20	ns	
122	TDTRF	Data Out Rise Time and Fall Time	—	20	ns	

### FIGURE 31-20: EUSART/AUSART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING



### TABLE 31-23: EUSART/AUSART SYNCHRONOUS RECEIVE REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
125	TDTV2CKL	SYNC RCV (MASTER and SLAVE) Data Hold before $CKx \downarrow (DTx hold time)$	10		ns	
126	TCKL2DTL	Data Hold after CKx $\downarrow$ (DTx hold time)	15		ns	

### TABLE 31-24: ULTRA LOW-POWER WAKE-UP SPECIFICATIONS

	Standard Operating Conditions: $3.0V < VDD < 3.6V$ Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ (unless otherwise stated)							
Param. No.	Symbol	Characteristic	Min	Тур	Max	Units	Comments	
Dxxx	IULP	Ultra Low-Power Wake-up Sink Current	_	60			Net of I/O leakage and current sink at 1.6V on pin, VDD = 3.3V	

© 2010 Microchip Technology Inc.

### 查询PIC18F67K90供应商

## TABLE 31-25: A/D CONVERTER CHARACTERISTICS: PIC18F87K90 FAMILY (INDUSTRIAL)

Param No.	Sym	Characteristic	Min	Тур	Max	Units	Conditions
A01	NR	Resolution	—	_	12	bit	$\Delta VREF \ge 3.0V$
A03	EIL	Integral Linearity Error	—	<±1	±2.0	LSB	VDD = $3.0V (\Delta VREF \ge 3.0V)$
			_	—	±2.0	LSB	VDD = 5.0V
A04	Edl	Differential Linearity Error	—	<±1	+1.5/-1.0	LSB	VDD = $3.0V (\Delta VREF \ge 3.0V)$
			_	_	+1.5/-1.0	LSB	VDD = 5.0V
A06	EOFF	Offset Error	_	<±1	±5	LSB	VDD = $3.0V (\Delta VREF \ge 3.0V)$
			_	—	±3	LSB	VDD = 5.0V
A07	Egn	Gain Error	—	<±1	±1.25	LSB	VDD = $3.0V (\Delta VREF \ge 3.0V)$
			_	—	±2.00	LSB	VDD = 5.0V
A10	—	Monotonicity	(	Guaranteed ⁽	1)	_	$VSS \le VAIN \le VREF$
A20	$\Delta VREF$	Reference Voltage Range (VREFH – VREFL)	3	—	Vdd - Vss	V	For 12-bit resolution
A21	Vrefh	Reference Voltage High	Vss + 3.0V	—	Vss + 3.0V	V	For 12-bit resolution
A22	Vrefl	Reference Voltage Low	Vss – 0.3V	—	Vss - 3.0V	V	For 12-bit resolution
A25	VAIN	Analog Input Voltage	VREFL	_	VREFH	V	
A30	Zain	Recommended Impedance of Analog Voltage Source	—	_	2.5	kΩ	
A50	IREF	VREF Input Current ⁽²⁾	_	—	5	μA	During VAIN acquisition.
			—	—	150	μA	During A/D conversion cycle.

Note 1: The A/D conversion result never decreases with an increase in the input voltage and has no missing codes.

2: VREFH current is from the RA3/AN3/VREF+ pin or VDD, whichever is selected as the VREFH source. VREFL current is from the RA2/AN2/VREF-/CVREF pin or VSs, whichever is selected as the VREFL source.

#### 查询PIC18F67K90供应商 FIGURE 31-21: A/D CONVERSION TIMING BSF ADCON0, GO (Note 2) 131 Q4 130 132 A/D CLK A/D DATA 9 8 . . . 0 NEW_DATA OLD DATA ADRES TCY (Note 1) ADIF GO DONE SAMPLING STOPPED SAMPLE If the A/D clock source is selected as RC, a time of TCY is added before the A/D clock starts. This allows the SLEEP instruction to Note 1: be executed. 2: This is a minimal RC delay (typically 100 ns), which also disconnects the holding capacitor from the analog input.

## TABLE 31-26: A/D CONVERSION REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Мах	Units	Conditions
130	Tad	A/D Clock Period	0.8	12.5 ⁽¹⁾	μS	Tosc based, VREF $\geq$ 3.0V
			1.4	25 ⁽¹⁾	μS	VDD = 3.0V; TOSC based, VREF full range
			_	1	μS	A/D RC mode
			_	3	μS	VDD = 3.0V; A/D RC mode
131	TCNV	Conversion Time (not including acquisition time) ⁽²⁾	14	15	Tad	
132	TACQ	Acquisition Time ⁽³⁾	1.4	_	μS	-40°C to +85°C
135	Tswc	Switching Time from Convert $\rightarrow$ Sample		(Note 4)		
137	TDIS	Discharge Time	0.2	_	μS	

**Note 1:** The time of the A/D clock period is dependent on the device frequency and the TAD clock divider.

2: ADRES registers may be read on the following TCY cycle.

**3:** The time for the holding capacitor to acquire the "New" input voltage when the voltage changes full scale after the conversion (VDD to Vss or Vss to VDD). The source impedance (Rs) on the input channels is 50 $\Omega$ .

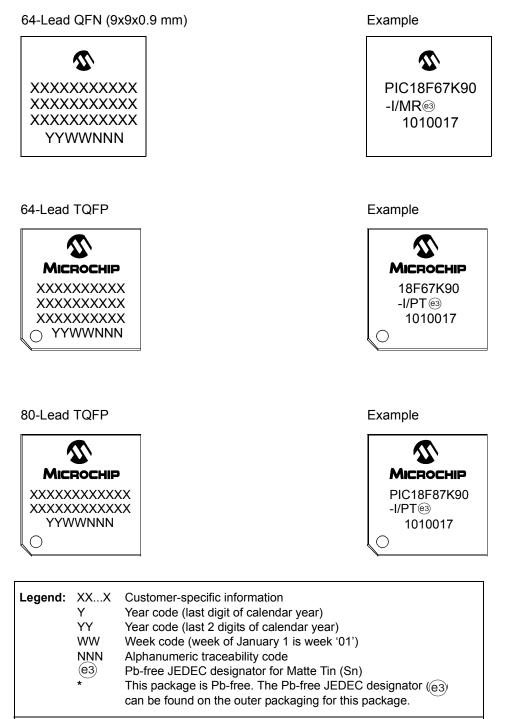
4: On the following cycle of the device clock.

查询PIC18F67K90供应商 NOTES:

#### 查询PIC18F67K90供应商

#### 32.0 PACKAGING INFORMATION

#### 32.1 Package Marking Information



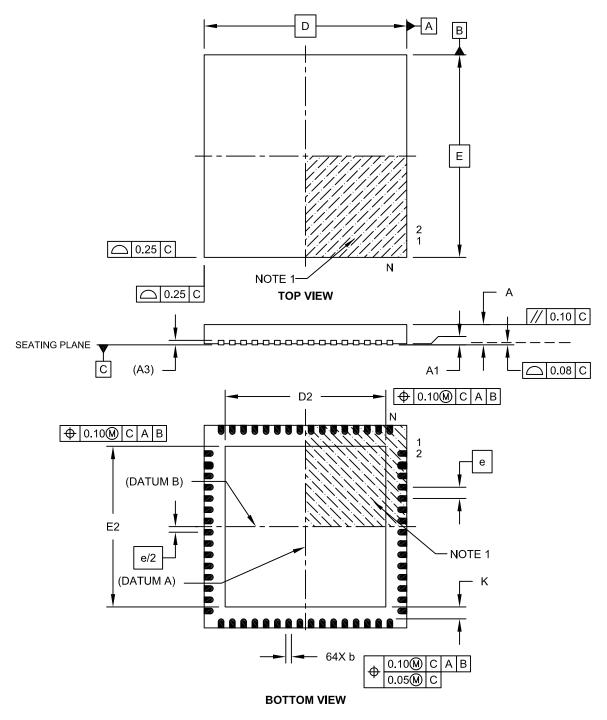
**Note**: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.



The following sections give the technical details of the packages.

#### 64-Lead Plastic Quad Flat, No Lead Package (MR) – 9x9x0.9 mm Body [QFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

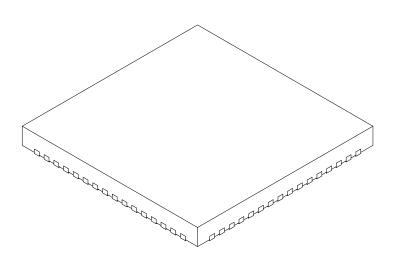


Microchip Technology Drawing C04-149B Sheet 1 of 2

#### 查询PIC18F67K90供应商

#### 64-Lead Plastic Quad Flat, No Lead Package (MR) – 9x9x0.9 mm Body [QFN]

For the most current package drawings, please see the Microchip Packaging Specification located at Note: http://www.microchip.com/packaging



Units		MILLIMETERS		S
Dimensior	n Limits	MIN	NOM	MAX
Number of Pins	N	64		
Pitch	е	0.50 BSC		
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3	0.20 REF		
Overall Width	E	9.00 BSC		
Exposed Pad Width	E2	7.05 7.15 7.5		7.50
Overall Length	D		9.00 BSC	
Exposed Pad Length	D2	7.05	7.15	7.50
Contact Width	b	0.18	0.25	0.30
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	-	-

#### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated.

3. Dimensioning and tolerancing per ASME Y14.5M.

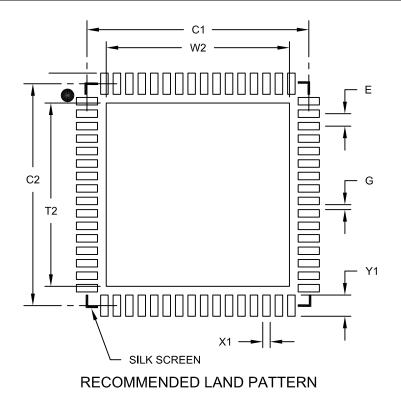
BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-149B Sheet 2 of 2

#### 查询PIC18F67K90供应商

64-Lead Plastic Quad Flat, No Lead Package (MR) – 9x9x0.9 mm Body [QFN] With 0.40 mm Contact Length

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E 0.50 BSC			
Optional Center Pad Width	W2			7.35
Optional Center Pad Length	T2			7.35
Contact Pad Spacing	C1		8.90	
Contact Pad Spacing	C2		8.90	
Contact Pad Width (X64)	X1			0.30
Contact Pad Length (X64)	Y1			0.85
Distance Between Pads	G	0.20		

#### Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

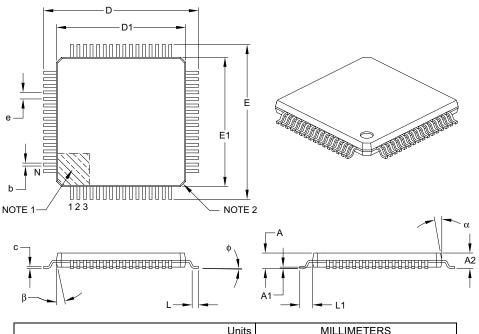
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2149A

#### 查询PIC18F67K90供应商

#### 64-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
	Dimension Limits	MIN	NOM	MAX
Number of Leads	N	64		
Lead Pitch	е		0.50 BSC	
Overall Height	А	-	-	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	-	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	¢	0°	3.5°	7°
Overall Width	E	12.00 BSC		
Overall Length	D		12.00 BSC	
Molded Package Width	E1		10.00 BSC	
Molded Package Length	D1		10.00 BSC	
Lead Thickness	С	0.09	-	0.20
Lead Width	b	0.17	0.22	0.27
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Chamfers at corners are optional; size may vary.

3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.

4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

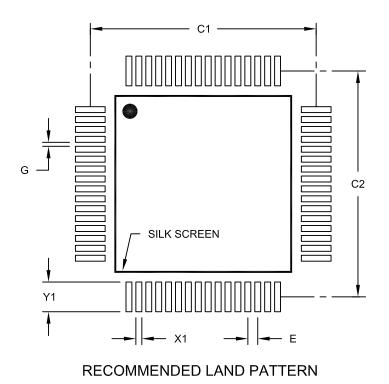
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-085B

#### 查询PIC18F67K90供应商

#### 64-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIM	ETERS	
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.50 BSC	
Contact Pad Spacing	C1		11.40	
Contact Pad Spacing	C2		11.40	
Contact Pad Width (X64)	X1			0.30
Contact Pad Length (X64)	Y1			1.50
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

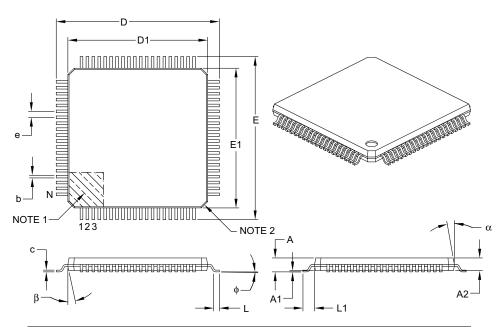
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2085A

#### 查询PIC18F67K90供应商

#### 80-Lead Plastic Thin Quad Flatpack (PT) – 12x12x1 mm Body, 2.00 mm [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS	6
	<b>Dimension Limits</b>	MIN	NOM	MAX
Number of Leads	N	80		
Lead Pitch	е		0.50 BSC	
Overall Height	А	-	-	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	-	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	ф	0°	3.5°	7°
Overall Width	E	14.00 BSC		
Overall Length	D		14.00 BSC	
Molded Package Width	E1		12.00 BSC	
Molded Package Length	D1	12.00 BSC		
Lead Thickness	С	0.09	-	0.20
Lead Width	b	0.17	0.22	0.27
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

#### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Chamfers at corners are optional; size may vary.

3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.

- 4. Dimensioning and tolerancing per ASME Y14.5M.
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.

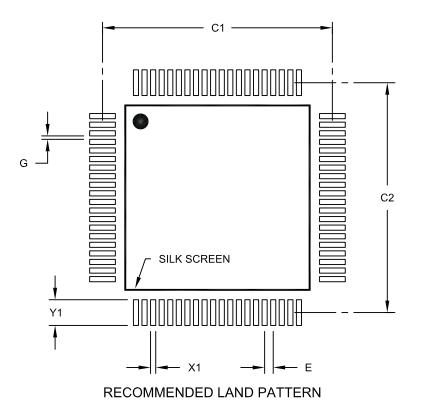
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-092B

#### 查询PIC18F67K90供应商

#### 80-Lead Plastic Thin Quad Flatpack (PT) – 12x12x1 mm Body, 2.00 mm [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIM	ETERS	
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.50 BSC	
Contact Pad Spacing	C1		13.40	
Contact Pad Spacing	C2		13.40	
Contact Pad Width (X80)	X1			0.30
Contact Pad Length (X80)	Y1			1.50
Distance Between Pads	G	0.20		

#### Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2092A

#### 查询PIC18F67K90供应商 APPENDIX A: REVISION HISTORY

#### **Revision A (September 2009)**

Original data sheet for PIC18F87K90 family devices.

#### **Revision B (April 2010)**

Changes to Section 32.0 "Packaging Information", including new packaging diagrams. Changes to some of the values in Section 31.0 "Electrical Characteristics". The new Section 2.0 "Guidelines for Getting Started with PIC18F Microcontrollers" has been added. Minor text edits throughout the document.

#### APPENDIX B: MIGRATION FROM PIC18F85J90 AND PIC18F87J90 TO PIC18F87K90

Devices in the PIC18F87K90, PIC18F85J90 and PIC18F87J90 families are almost similar in their functions and features. Code can be migrated from the 18F85J90 to the PIC18F87K90 without many changes. The differences between the two device families are listed in Table B-1.

#### 查询PIC18F67K90供应商

## TABLE B-1: NOTABLE DIFFERENCES BETWEEN PIC18F87K90, PIC18F87J90 AND PIC18F85J90 FAMILIES FAMILIES

FAMILIES	1	1	
Characteristic	PIC18F87K90 Family	PIC18F87J90 Family	PIC18F85J90 Family
Max Operating Frequency	64 MHz	48 MHz	40 MHz
Max Program Memory	128 Kbytes	128 Kbytes	32 Kbytes
Data Memory	4 Kbytes	4 Kbytes	2 Kbytes
Program Memory Endurance	10,000 Write/Erase (minimum)	10,000 Write/Erase (minimum)	1,000 Write/Erase (minimum)
Single-Word Write for Flash	Yes	Yes	No
Oscillator Options	PLL can be used with INTOSC	Yes	PLL cannot be used with INTOSC
CTMU	Yes	Yes	No
RTCC	Yes	Yes	No
SOSC Oscillator Options	Low-power oscillator option for SOSC	Low-power oscillator option for SOSC	No
TICKI Clock	T1CKI can be used as a clock without enabling the SOSC oscillator	No	No
INTOSC	Up to 16 MHz	8 MHz	8 MHz
SPI/I ² C™	2	1	1
Timers	11	4	4
ECCP	3	No	No
ССР	7	2	2
Data EEPROM	Yes	No	No
Programmable BOR	Multiple level of BOR	No	No
WDT Prescale Options	22	16	16
5V Operation	Yes	No	No
nanoWatt XLP	Yes	No	No
Regulator	Yes	Yes	Yes
Low-Power BOR	Yes	No	No
ADC	24-Channel Differential (12-bit)	12-Channel Not differential (10-bit)	12-Channel Not Differential (10-bit)
Internal Temp Sensor	Yes	No	No
Programmable HLVD	Yes	No	No
EUSART	2 EUSARTs	1 EUSART, 1 AUSART	1 EUSART, 1 AUSART
Comparators	3	2	2
Oscillator Options	14 options by OSC<3:0>	8 options by OSC<3:0>	8 options by OSC<3:0>
Ultra Low-Power Wake-up (ULPW)	Yes	No	No
Power-up Timer	Yes	No	No
MCLR Pin as Input Port	Yes	No	No
LCD Charge Pump	No	Yes	Yes
Internal Resistor Ladder for Biasing	Yes	No	No

#### 查询PIC18F67K90供应商 INDEX

#### Α

A/D	371
A/D Converter Interrupt, Configuring	
Acquisition Requirements	
ADRESH Register	
Analog Port Pins, Configuring	
Associated Registers	
Automatic Acquisition Time	382
Configuring the Module	
Conversion Clock (TAD)	
Conversion Requirements	
Conversion Status (GO/DONE Bit)	
Conversions	
Converter Characteristics	
Differential	
Operation in Power-Managed Modes	
Use of the Special Event Triggers	384
Absolute Maximum Ratings	503
AC (Timing) Characteristics	519
Load Conditions for Device Timing	
Specifications	520
Parameter Symbology	
Temperature and Voltage Capacifications	510
Temperature and Voltage Specifications	520
Timing Conditions	
ACKSTAT	
ACKSTAT Status Flag	337
ADCON0 Register	
GO/DONE Bit	378
ADDFSR	492
ADDLW	455
ADDULNK	
ADDWF	
ADDWFC	
ADRESL Register	
Analog and Digital Ports	104
Analog-to-Digital Converter. See A/D.	450
ANDLW	
ANDWF	457
Assembler	
MPASM Assembler	500
D	
В	
Baud Rate Generator	333
BC	457
BCF	458
BF	337
BF Status Flag	
Block Diagrams	007
	270
A/D	
A/D Differential Channel Measurement	
Analog Input Model	
Baud Rate Generator	
Capture Mode Operation241,	
Comparator Analog Input Model	390
Comparator Configurations	
Comparator Output	
Comparator Voltage Reference	
Comparator Voltage Reference	200
Output Buffer Example	207
	531

CTMU Typical Connections and Internal	
Configuration for Pulse Delay Generation 419	9
CTMU Typical Connections and Internal	_
Configuration for Time Measurement 418	
Device Clock	
EUSART Receive	
EUSART Transmit	
External Clock Input, EC 46	
External Clock Input, HS 46	
External Power-on Reset Circuit	
(Slow VDD Power-up) 69	
Fail-Safe Clock Monitor (FSCM) 443	
Full-Bridge Application	
Generic I/O Port Operation	
Half-Bridge Applications	
High/Low-Voltage Detect with External Input	
Interrupt Logic	
INTIO1 Oscillator Mode	
INTIO2 Oscillator Mode 47	
LCD Bias Internal Resistor Ladder Connection 280	
LCD Clock Generation	
LCD Driver Module 27	1
MSSPx (I ² C Master Mode)	1
MSSPx (I ² C Mode)	
MSSPx (SPI Mode)	
On-Chip Reset Circuit	
PIC18F6XK90	
PIC18F8XK90	
PLL	
PWM Operation (Simplified) 245	5
RC Oscillator Mode 46	6
RCIO Oscillator Mode 46	
Reads from Flash Program Memory 113	
RTCC	
Simplified Steering	
Single Comparator	
SOSC External Components	1 5
Table Read Operation	
Table Write Operation	
Table Writes to Flash Program Memory	
Timer0 in 16-Bit Mode 182	2
Timer0 in 8-Bit Mode 182	
Timer1 188	
Timer2	
Timer3/5/7	
Watchdog Timer	
BN	
BNC	
BNN	
BNOV	
BNZ	)
BOR. See Brown-out Reset.	
BOV	
BRA	1
BRG. See Baud Rate Generator.	h
Brown-out Reset (BOR)	
Detecting	1

#### 查询PIC18F67K90供应商

BSF	404
BTFSC	
BTFSS	462
BTG	
BZ	
C	
C Compilers	
MPLAB C18	
CALL	
CALLW	
Capture (CCP Module)	
Associated Registers	
CCP Pin Configuration	
CCPR4H:CCPR4L Registers	
Prescaler	241
Software Interrupt	
Timer1/3/5/7 Mode Selection	
Capture (ECCP Module)	253
CCPRxH:CCPRxL Registers	
ECCP Pin Configuration	253
Prescaler	
Software Interrupt	
Timer1/Timer3 Mode Selection	
Capture/Compare/PWM (CCP)	
Capture Mode. See Capture.	
CCP Mode and Timer Resources	220
CCP6/7/8/9 Pin Assignment	240
CCPRxH Register	
CCPRxL Register	
-	200
Compare Mode. See Compare.	
Configuration	
Open-Drain Output Option	240
Charge Time Measurement Unit (CTMU)	
Associated Registers	
Calibrating the Module	410
Creating a Delay	
Effects of a Reset	
Measuring Capacitance with the CTMU	
Measuring Capacitance with the CTMO	
	416
Measuring Temperature with Use	416 420
Measuring Temperature with Use	416 420 418
Measuring Temperature with Use	416 420 418
Measuring Temperature with Use	416 420 418 410
Measuring Temperature with Use Measuring Time Module Initialization Operation	416 420 418 410 409
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes	416 420 418 410 409 421
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources	416 420 418 410 409 421 43
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes	416 420 418 410 409 421 43
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset	416 420 418 410 409 421 43 44
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register	416 420 418 410 409 421 43 44 44
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF	416 420 418 410 409 421 43 43 44 44 44
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT	416 420 418 410 409 421 43 43 44 44 44
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF	416 420 418 410 409 421 43 43 44 44 44
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRF Cde Examples	416 420 418 410 409 421 43 43 44 44 445 465
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	416 420 418 410 409 421 43 43 44 44 465 465 465 126
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 16 x 16 Unsigned Multiply Routine	416 420 418 410 409 421 43 43 44 44 465 465 465 126 126
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	416 420 418 410 409 421 43 43 44 44 465 465 465 126 126
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 16 x 16 Unsigned Multiply Routine 8 x 8 Signed Multiply Routine	416 420 418 410 409 421 43 43 44 44 465 465 465 126 126 125
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 16 x 16 Unsigned Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Unsigned Multiply Routine 8 x 8 Unsigned Multiply Routine	416 420 418 410 409 421 43 43 44 44 465 465 465 126 126 125 125
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	416 420 418 410 409 421 43 43 44 44 465 465 126 126 125 125 125 415
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	416 420 418 410 409 421 43 43 44 44 465 465 126 126 125 125 125 415 241, 253
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	416 420 418 410 409 421 43 43 44 44 465 465 126 126 125 125 125 415 241, 253
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	416 420 418 410 409 421 43 44 44 465 465 126 126 125 125 125 415 241, 253 87
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Unsigned Multiply Routine Capacitance Calibration Routine Changing Between Capture Prescalers Computed GOTO Using an Offset Value Current Calibration Routine	416 420 418 410 409 421 43 44 44 465 465 126 126 125 125 125 125 415 241, 253 87 413
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	416 420 418 410 409 421 43 44 44 465 465 126 126 125 125 125 125 415 241, 253 87 413 121
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Unsigned Multiply Routine Capacitance Calibration Routine Changing Between Capture Prescalers Computed GOTO Using an Offset Value Current Calibration Routine	416 420 418 410 409 421 43 44 44 465 465 126 126 125 125 125 125 415 241, 253 87 413 121
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	416 420 418 410 409 421 43 44 44 465 465 126 126 125 125 125 125 125 415 241, 253 87 413 121 122
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	416 420 418 410 409 421 43 44 44 465 465 126 126 125 125 125 125 125 415 241, 253 87 413 121 122 121
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	416 420 418 410 409 421 43 44 44 465 465 126 126 125 125 125 125 415 241, 253 87 413 121 122 121
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 8 x 16 Unsigned Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Signed Multiply Routine Capacitance Calibration Routine	416 420 418 410 409 421 43 44 44 465 465 126 126 125 125 125 125 415 241, 253 87 413 121 122 121
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	416 420 418 410 409 421 43 44 44 465 465 126 126 125 125 125 125 415 241, 253 87 413 121 122 121
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine	416 420 418 409 421 43 44 44 445 465 126 126 125 125 415 241, 253 87 413 121 122 121 122 121 415
Measuring Temperature with Use Measuring Time Module Initialization Operation During Sleep and Idle Modes Clock Sources Default System Clock on Reset Selection Using OSCCON Register CLRF CLRWDT Code Examples 16 x 16 Signed Multiply Routine 8 x 16 Unsigned Multiply Routine 8 x 8 Signed Multiply Routine 8 x 8 Signed Multiply Routine Capacitance Calibration Routine	416 420 418 410 409 421 43 44 44 465 126 126 125 125 125 415 241, 253 413 121 122 121 114 87 102

	158
Initializing PORTC	161
Initializing PORTD	164
Initializing PORTE	167
Initializing PORTF	170
Initializing PORTG	173
Initializing PORTH	
Initializing PORTJ	
Loading the SSP1BUF (SSP1SR) Register	
Reading a Flash Program Memory Word	
Routine for Capacitive Touch Switch	
Routine for Temperature Measurement	
Using Internal Diode	420
Saving STATUS, WREG and BSR	
Registers in RAM	1/0
Setting the RTCWREN Bit	
Setup for CTMU Calibration Routines	
Writing to Flash Program Memory	
Code Protection	
Associated Registers	
Data EEPROM	
Program Memory	
COMF	
Comparator	
Analog Input Connection Considerations	
Associated Registers	394
Control and Configuration	
Effects of a Reset	
Enable and Input Selection	391
Enable and Output Selection	391
Interrupts	393
Operation	390
Operation During Sleep	394
Response Time	
Comparator Specifications	
Comparator Voltage Reference	
Accuracy and Error	
Accuracy and Error Associated Registers	396
Associated Registers	396 397
Associated Registers Configuring	396 397 395
Associated Registers Configuring Connection Considerations	396 397 395 396
Associated Registers Configuring Connection Considerations Effects of a Reset	396 397 395 396 396
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep	396 397 395 396 396 396
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module)	396 397 395 396 396 396 242
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers	396 397 395 396 396 396 242 244
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration	
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register	
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt	
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger	
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection	
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module)	
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module). CCPRx Register	
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module). CCPRx Register Pin Configuration	
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt	
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module). CCPRx Register Pin Configuration Software Interrupt Special Event Trigger	
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection.	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection. Computed GOTO.	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection. Computed GOTO. Configuration Bits	
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection. Computed GOTO. Configuration Bits Configuration Mismatch (CM) Reset.	
Associated Registers Configuring Connection Considerations. Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration. CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection. Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Jimer3 Mode Selection. Computed GOTO. Configuration Bits Configuration Mismatch (CM) Reset. Configuration Register Protection.	
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection Computed GOTO Configuration Bits Configuration Mismatch (CM) Reset Configuration Register Protection Core Features	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection Computed GOTO Configuration Bits Configuration Mismatch (CM) Reset Corfiguration Register Protection Core Features Easy Migration	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection Computed GOTO Configuration Bits Configuration Mismatch (CM) Reset Configuration Register Protection Core Features	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection Computed GOTO Configuration Bits Configuration Mismatch (CM) Reset Corfiguration Register Protection Core Features Easy Migration	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection Computed GOTO Configuration Bits Configuration Mismatch (CM) Reset Configuration Register Protection Core Features Easy Migration Extended Instruction Set	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24
Associated Registers Configuring Connection Considerations Effects of a Reset Operation During Sleep Compare (CCP Module) Associated Registers CCP Pin Configuration CCPR4 Register Software Interrupt Special Event Trigger Timer1/3/5/7 Mode Selection Compare (ECCP Module) CCPRx Register Pin Configuration Software Interrupt Special Event Trigger Timer1/Timer3 Mode Selection Computed GOTO Configuration Bits Configuration Mismatch (CM) Reset Configuration Register Protection Core Features Easy Migration Extended Instruction Set Memory Options	396 397 395 396 396 242 244 242 242 242 242 242 242 242 24

#### 查询PIC18F67K90供应商 CPFSEQ

	12 (1-2)	
CPFSEQ		
CPFSGT		
CPFSLT		
Crystal Oscilla	ator/Ceramic Resonator	
Customer Cha	ange Notification Service	
Customer Not	ification Service	
Customer Sur	oport	

#### D

	100
Data Addressing Modes	102
Comparing Addressing Modes with the	
Extended Instruction Set Enabled	
Direct	
Indexed Literal Offset	105
BSR	107
Instructions Affected	
Mapping Access Bank	
Indirect	
Inherent and Literal	
Data EEPROM Memory	
Associated Registers	100
EEADR and EEADRH Registers	
EECON1 and EECON2 Registers	
Operation During Code-Protect	
Overview	119
Protection, Spurious Writes	122
Reading	121
Usage	
Write Verify	
Writing	
Data Memory	
Access Bank	
Bank Select Register (BSR)	
Extended Instruction Set	
General Purpose Registers	
Memory Maps	
PIC18FX5K90/X7K90 Devices	
Special Function Registers	
Special Function Registers	
DAW	468
DC Characteristics	
CTMU Current Source	516
PIC18F87K90 Family, Industrial	
Power-Down and Supply Current	
Supply Voltage	
DCFSNZ	
DECF	
DECFSZ	
Default System Clock	
Details on Individual Family Members	
Development Support	
Device Overview	
Features (64-Pin Devices)	
Features (80-Pin Devices)	
Direct Addressing	103
E	
Effect on Standard PIC18 Instructions	106
Effects of Power-Managed Modes on Various	

lous	Effects of Power-Manageo
	Clock Sources
	Electrical Characteristics

Enhanced Capture/Compare/PWM (ECCP)	. 249
Capture Mode. See Capture.	
Compare Mode. See Compare.	
ECCP Mode and Timer Resources	252
Enhanced PWM Mode	
Auto-Restart	264
Auto-Shutdown	
Direction Change in Full-Bridge	
Output Mode	261
Full-Bridge Application	259
Full-Bridge Mode	
Half-Bridge Application	
Half-Bridge Application Examples	
Half-Bridge Mode	. 200
Output Relationships (Active-High and	050
Active-Low)	
Output Relationships Diagram	
Programmable Dead-Band Delay	265
Shoot-Through Current	
Start-up Considerations	262
Outputs and Configuration	252
Enhanced Capture/Compare/PWM (ECCP1/2/3)	
Associated Registers	270
Enhanced Universal Synchronous Asynchronous	
Receiver Transmitter (EUSART). See EUSART.	
Equations	
16 x 16 Signed Multiplication Algorithm	126
16 x 16 Unsigned Multiplication Algorithm	
A/D Acquisition Time	
A/D Minimum Charging Time	
	. 301
Calculating the Minimum Required	
Acquisition Time	
Errata	
Errata EUSART	8
Errata EUSART Asynchronous Mode	8
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and	8 . 357
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence	8 . 357 . 364
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive	8 . 357 . 364 . 361
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit	8 . 357 . 364 . 361 . 359
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive	8 . 357 . 364 . 361 . 359
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit	8 . 357 . 364 . 361 . 359 . 362
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break	8 . 357 . 364 . 361 . 359 . 362
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver	. 357 . 364 . 361 . 359 . 362 . 360
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 357
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 357 . 351
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG)	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 357 . 351 . 351
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 357 . 351 . 351 . 352
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect	8 . 357 . 364 . 361 . 359 . 362 . 360 . 360 . 357 . 351 . 351 . 352 . 355
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating	8 357 364 359 362 360 350 357 351 351 351 352 355 352
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rates, Asynchronous Modes	8 357 364 359 362 360 357 351 351 355 352 355 352 353
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rates, Asynchronous Modes High Baud Rate Select (BRGH Bit)	8 357 364 359 362 360 357 351 351 355 352 355 352 353 351
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rates, Asynchronous Modes High Baud Rate Select (BRGH Bit) Sampling	8 357 364 361 359 362 360 357 351 351 355 352 355 352 351 351
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit. Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect. Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers. Auto-Baud Rate Detect. Baud Rate Error, Calculating. Baud Rates, Asynchronous Modes High Baud Rate Select (BRGH Bit) Sampling Synchronous Master Mode	8 357 364 361 359 362 360 350 351 351 352 355 352 353 351 351 351 351
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit. Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers. Auto-Baud Rate Detect. Baud Rate Error, Calculating. Baud Rates, Asynchronous Modes High Baud Rate Select (BRGH Bit) Sampling Synchronous Master Mode	8 357 364 361 359 362 360 350 351 351 355 355 355 355 355 355 355 355
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit. Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect. Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers. Auto-Baud Rate Detect. Baud Rate Error, Calculating. Baud Rates, Asynchronous Modes High Baud Rate Select (BRGH Bit) Sampling Synchronous Master Mode Associated Registers, Receive Associated Registers, Receive Associated Registers, Transmit.	8 357 364 361 359 362 360 357 351 355 355 355 355 355 355 355 355 355
Errata EUSART Asynchronous Mode	8 357 364 361 359 362 360 357 351 351 355 355 355 355 353 351 351 355 353 351 355 353 351 355 368 366 367
Errata EUSART Asynchronous Mode	8 357 364 361 359 362 360 357 351 355 355 355 355 355 355 355 355 355
Errata EUSART Asynchronous Mode	8 357 364 361 359 362 360 357 351 351 352 355 352 353 351 351 355 352 353 351 355 352 353 351 355 353 351 355 353 351 355 353 351 355 353 355 355
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rate Select (BRGH Bit) Sampling Synchronous Master Mode Associated Registers, Receive Associated Registers, Transmit. Reception Transmission Synchronous Slave Mode Associated Registers, Receive	8 357 364 361 359 362 360 357 351 351 352 353 353 351 351 351 355 352 353 353 351 351 355 352 353 353 351 351 355 353 353 351 355 353 353
Errata EUSART Asynchronous Mode	8 357 364 361 359 362 360 357 351 351 352 353 353 351 351 351 355 352 353 353 351 351 355 352 353 353 351 351 355 353 353 351 355 353 353
Errata EUSART Asynchronous Mode 12-Bit Break Transmit and Receive Sequence Associated Registers, Receive Associated Registers, Transmit Auto-Wake-up on Sync Break Receiver Setting Up 9-Bit Mode with Address Detect Transmitter Baud Rate Generator Operation in Power-Managed Modes Baud Rate Generator (BRG) Associated Registers Auto-Baud Rate Detect Baud Rate Error, Calculating Baud Rate Select (BRGH Bit) Sampling Synchronous Master Mode Associated Registers, Receive Associated Registers, Transmit. Reception Transmission Synchronous Slave Mode Associated Registers, Receive	8 357 364 361 359 362 360 357 351 351 352 355 352 353 351 351 355 352 353 351 351 355 352 353 351 355 353 351 355 353 351 355 353 351 355 353 353

查询PIC18F67K90供应商	
Extended Instruction Set	
ADDFSR	
ADDULNK	
CALLW	
MOVSF	
MOVSS	
PUSHL	
SUBFSR	
SUBULNK	
External Oscillator Modes	
Clock Input (EC, ECPLL Modes)	
HS, HSPLL	
F	
Fail-Safe Clock Monitor	423, 443
Exiting Operation	
Interrupts in Power-Managed Modes	
POR or Wake from Sleep	
WDT During Oscillator Failure	
Fast Register Stack	
Firmware Instructions	
Flash Program Memory	109
Associated Registers	117
Control Registers	110
EECON1 and EECON2	
TABLAT (Table Latch) Register	112
TBLPTR (Table Pointer) Register	112
Erase Sequence	
Erasing	
Operation During Code-Protect	
Protection Against Spurious Writes	
Reading	
Table Pointer	
Boundaries Based on Operation	
Table Pointer Boundaries	
Table Reads and Table Writes	109

#### Write Sequence ......115 FSCM. See Fail-Safe Clock Monitor.

#### G

#### н

Hardware Multiplier	
8 x 8 Multiplication Algorithms	125
Operation	125
Performance Comparison (table)	
High/Low-Voltage Detect	
Applications	
Associated Registers	
Current Consumption	401
Effects of a Reset	
Operation	
During Sleep	
Setup	401
Start-up Time	401
Typical Low-Voltage Detect Application	
HLVD. See High/Low-Voltage Detect.	

#### I

- NO Dete
I/O Ports
Open-Drain Outputs
Output Pin Drive
Pin Capabilities
Pull-up Configuration 151 I ² C Mode (MSSP)
Acknowledge Sequence Timing
Associated Registers
Baud Rate Generator
Bus Collision
During a Repeated Start Condition
During a Stop Condition
Clock Arbitration
Clock Stretching
10-Bit Slave Receive Mode (SEN = 1)
10-Bit Slave Transmit Mode 326
7-Bit Slave Receive Mode (SEN = 1) 326
7-Bit Slave Transmit Mode 326
Clock Synchronization and the CKP bit 327
Effects of a Reset 341
General Call Address Support 330
I ² C Clock Rate w/BRG 333
Master Mode 331
Operation
Reception
Repeated Start Condition Timing
Start Condition Timing 335
Transmission
Multi-Master Communication, Bus Collision
and Arbitration
Multi-Master Mode 341
Operation
Read/Write Bit Information (R/W Bit)
Registers
Serial Clock (SCLx)
Slave Mode
Address Masking Modes
5-Bit
7-Bit
Addressing
Reception
Transmission
Sleep Operation
Stop Condition Timing
ID Locations
INCF
INCFSZ
In-Circuit Debugger
In-Circuit Serial Programming (ICSP)
Indexed Literal Offset Addressing
and Standard PIC18 Instructions
Indexed Literal Offset Mode
Indirect Addressing
INFSNZ
Instruction Cycle
Clocking Scheme
Flow/Pipelining
1 10w/1 ipenining

#### 查询PIC18F67K90供应商 Instruction Set

truction Set	440
ADDLW	455
ADDWF	455
ADDWF (Indexed Literal Offset Mode)	
ADDWFC	
ANDLW	456
ANDWF	457
BC	
BCF	458
BN	458
 BNC	
BNN	459
BNOV	460
BNZ	
BOV	
BRA	461
BSF	461
BSF (Indexed Literal Offset Mode)	
BTFSC	462
BTFSS	462
BTG	
BZ	464
CALL	
CLRF	
CLRWDT	
COMF	466
CPFSEQ	
CPFSGT	
CPFSLT	467
DAW	468
DCFSNZ	
DECF	468
DECFSZ	
Extended Instructions	491
Extended Instructions Considerations when Enabling	491 496
Extended Instructions Considerations when Enabling Svntax	491 496 491
Extended Instructions Considerations when Enabling Svntax	491 496 491
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools	491 496 491 498
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format	491 496 491 498 451
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO	491 496 491 498 451 470
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format	491 496 491 498 451 470
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF	491 496 491 498 451 470 470
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW IORWF	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW IORWF LFSR	
Extended Instructions	
Extended Instructions Considerations when Enabling Syntax Use with MPLAB IDE Tools General Format GOTO INCF INCFSZ INFSNZ IORLW IORWF LFSR	
Extended Instructions	491           496           491           498           451           470           471           472           473           474           475           476           477           473           474           475           476           477           476           477           476           477           476           477           476           477           476           477           476           477           476           477           476           477           476           477           476           477           478           478           479
Extended Instructions	
Extended Instructions	
Extended Instructions	491           496           491           498           451           470           471           472           473           474           475           476           477           473           474           475           476           477           476           477           476           477           476           477           476           477           476           477           476           477           476           477           476           477           476           477           476           477           478           479           480
Extended Instructions	491           496           491           498           451           470           471           472           473           473           474           475           476           477           475           476           477           476           477           476           477           476           477           476           477           470           478           479           480           480
Extended Instructions	491           496           491           498           451           470           471           472           473           473           474           475           476           477           476           477           476           477           476           477           476           477           476           477           470           478           479           480           481
Extended Instructions	491           496           491           498           451           470           471           472           473           473           474           475           476           477           475           476           477           478           479           480           481
Extended Instructions	491           496           491           498           451           470           471           472           473           473           474           475           476           477           475           476           477           478           479           480           481
Extended Instructions	491           496           491           498           451           470           471           472           473           473           474           475           476           477           476           477           476           477           476           477           476           477           470           478           479           480           481           482

RRNCF	483
SETF	
SETF (Indexed Literal Offset Mode)	497
SLEEP	
Standard Instructions	449
SUBFWB	484
SUBLW	485
SUBWF	485
SUBWFB	486
SWAPF	486
TBLRD	487
TBLWT	488
TSTFSZ	489
XORLW	489
XORWF	490
INTCON Register	
RBIF Bit	158
Inter-Integrated Circuit. See I ² C.	
Internal Oscillator Block	47
Adjustment	
INTIO Modes	47
INTOSC Frequency Drift	
INTOSC Output Frequency	48
INTPLL Modes	
Internal RC Oscillator	
Use with WDT	438
Internal Voltage Regulator Specifications	518
Internet Address	
Interrupt Sources	423
A/D Conversion Complete	
Capture Complete (CCP)	
Capture Complete (ECCP)	
Compare Complete (CCP)	
Compare Complete (ECCP)	
Interrupt-on-Change (RB7:RB4)	
TMR0 Overflow	183
TMR1 Overflow	
TMR2 to PR2 Match (PWM)	
TMRx Overflow	
TMRx to PRx Match	
TMRx to PRx Match (PWM)	211
Interrupts	127
Associated Registers	150
During, Context Saving	
INTx Pin	149
PORTB, Interrupt-on-Change	149
TMR0	
Interrupts, Flag Bits	
Interrupt-on-Change (RB7:RB4) Flag	
(RBIF Bit)	158
TMR2 to PR2 Match Flag (TMR2IF Bit)	
INTOSC, INTRC. See Internal Oscillator Block.	
IORLW	472
IORWF	472

#### L LCD

)	
Associated Registers	299
Bias Types	279
Clock Source Selection	278
Configuring the Module	298
Frame Frequency	284
Interrupts	296
LCDCON Register	272
LCDDATAx Registers	272
LCDPS Register	272

### 查询PIC18F67K90供应商

LCDSEx Registers	
Multiplex Types	
Operation During Sleep	
Pixel Control	
Prescaler	278
Segment Enables	
Waveform Generation	
LCD Driver	10
LCDCON Register	272
LCDDATAx Registers	272
LCDPS Register	272
LP3:LP0 Bits	278
LCDSEx Registers	272
LFSR	473
Liquid Crystal Display (LCD) Driver	271

#### м

Master Clear (MCLR)	69
Master Synchronous Serial Port (MSSP). See MSSP.	
Memory Organization	83
Data Memory	
Program Memory	83
Memory Programming Requirements	517
Microchip Internet Web Site	562
Migration From PIC18F85J90 and PIC18F87J90	
to PIC18F87K90	549
MOVF	473
MOVFF	474
MOVLB	474
MOVLW	475
MOVSF	493
MOVSS	494
MOVWF	
MPLAB ASM30 Assembler, Linker, Librarian	500
MPLAB Integrated Development Environment	
Software	
MPLAB PM3 Device Programmer	502
MPLAB REAL ICE In-Circuit Emulator System	
MPLINK Object Linker/MPLIB Object Librarian	500
MSSP	
ACK Pulse	6, 319
I ² C Mode. See I ² C Mode.	
Module Overview	
SPI Mode	
Associated Registers	
Bus Mode Compatibility	
Clock Speed, Interactions	
Effects of a Reset	
Enabling SPI I/O	
Master Mode	
Operation	
Operation in Power-Managed Modes	
Serial Clock	
Serial Data Out	
Slave Mode	
Slave Select	
Slave Select Synchronization	
SPI Clock	
SSPxBUF Register	
SSPxSR Register	
Typical Connection	
SPI Mode Serial Data In	
MULLW	
MULWF	476

#### ...

N	
NEGF	477
NOP	477
Notable Differences Between PIC18F87K90,	
PIC18F87J90 and PIC18F85J90 Families	550
0	
On-Chip Regulator	423
On-Chip Voltage Regulator	
Enable/Disable by Hardware	440
Oscillator	
Reference Clock Output	49
Oscillator Configuration	39
EC	39
ECIO	39
HS	39
Internal Oscillator Block	47
INTIO1	39
INTIO2	39
LP	39
RC	39
RCIO	39
XT	39
Oscillator Selection	
Oscillator Start-up Timer (OST)	50
Oscillator Switching	43
Oscillator Transitions	44

#### Ρ

P1A/P1B/P1C/P1D.See Enhanced	
Capture/Compare/PWM (ECCP).	- 44
Packaging	
Details	
Marking	
Pin Functions	00.00
AVDD	,
AVss	,
	,
MCLR/RG5	,
OSC1/CLKI/RA7 OSC2/CLKO/RA6	
RA0/AN0/ULPWU	,
RA1/AN1/SEG18	,
RA2/AN2/VREF	,
RA3/AN3/REF+	
RA3/AN3/VREF+	
RA4/T0CKI/SEG14	
RA5/AN4/SEG15/T1CKI/T3G/HLVDIN	
RB0/INT0/SEG30/FLT0	,
RB0/INT0/SEG30/FLTO	
RB1/INT1/SEG8	
RB2/INT2/SEG9/CTED1	
RB3/INT3/SEG10/CTED2/ECCP2/P2A	- )
RB4/KBI0/SEG11	- )
RB5/KBI1/SEG29/T3CKI/T1G	
RB6/KBI2/PGC	
RB7/KBI3/PGD	,
RC0/SOSCO/SCKLI	- , -
RC0/SOSCO/SCLKI	
RC1/SOSCI/ECCP2/P2A/SEG32	17
RC1/SOSCI/ECCP2/SEG32/P2A	
RC2/ECCP1/P1A/SEG13	
RC3/SCK1/SCL1/SEG17	
	-

#### 查询PIC18F67K90供应商

RC4/SDI1/SDA1/SEG16	
RC5/SDO1/SEG12 17, 26	3
RC6/TX1/CK1/SEG2717, 26	3
RC7/RX1/DT1/SEG28	
RD0/SEG0/CTPLS	
RD1/SEG1/T5CKI/T7G 18, 27	
RD2/SEG2	7
RD3/SEG3	7
RD4/SEG4/SDO2	
RD5/SEG5/SDI2/SDA2	
RD6/SEG6/SCK2/SCL2	_
RD7/SEG7/SS218, 27	
RE0/LCDBIAS/P2D28	3
RE0/LCDBIAS1/P2D19	)
RE1/LCDBIAS/P2C28	3
RE1/LCDBIAS2/P2C	
RE2/LCDBIAS3/P2B/CCP10	
RE2/LCDBIA53/P2B/CCP10	5
RE3/COM0/P3C/CCP9/REFO 19, 28	3
RE4/COM1/P3B/CCP8	3
RE5/COM2/P1C/CCP7 19, 28	3
RE6/COM3/P1B/CCP6	
RE7/ECCP2/P2A/SEG31	
RE7/ECCP2/SEG31/P2A19	,
RF1/AN6/C2OUT/SEG19/CTDIN	
RF2/AN7/C1OUT/SEG2020	
RF2/AN7/C1OUT/SEG20/CTMUI	)
RF3/AN8/SEG21/C2INB	
RF3/AN8/SEG21/C2INB/CTMUI	
RF4/AN9/SEG22/C2INA	
RF5/AN10	
RF5/AN10/CVREF/SEG23/C1INB	
RF6/AN11/SEG24/C1INA	)
RF6/AN11/SEG24/C1INA	
RF7/AN5/SS1/SEG2520, 29	)
RF7/AN5/SS1/SEG2520, 29 RG0/ECCP3/P3A21, 30	)
RF7/AN5/SS1/SEG25	) )
RF7/AN5/SS1/SEG25	) ) )
RF7/AN5/SS1/SEG25	) ) )
RF7/AN5/SS1/SEG25	))))
RF7/AN5/SS1/SEG25	))))
RF7/AN5/SS1/SEG25	
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       21, 30         AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG43/CCP6/P1B/AN15       32         RJ0       33	
RF7/AN5/SS1/SEG25	
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       21, 30         AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG43/CCP6/P1B/AN15       32         RJ0       33	
RF7/AN5/SS1/SEG25	
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31       RH1/SEG46/AN22       31         RH1/SEG46/AN22       31       RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31       RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31       RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33       RJ1/SEG33       33       33         RJ2/SEG34       33       RJ3/SEG35       33	
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ1/SEG34       33         RJ3/SEG35       33         RJ3/SEG35       33         RJ4/SEG39       33	
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31       RH1/SEG46/AN22       31         RH1/SEG46/AN22       31       RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31       RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31       RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33       RJ1/SEG33       33       33         RJ1/SEG34       33       33       RJ3/SEG35       33         RJ3/SEG35       33       RJ4/SEG39       33         RJ5/SEG38       33       33       33	
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       21, 30         AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH4/SEG40/CCP9/P3C/AN12/C2IND       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ1/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ4/SEG37       33	<pre> 3 3 3 3 1 1 1 1 1 1 1 1 1 3 3 3 3 3 3</pre>
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31       RH1/SEG46/AN22       31         RH1/SEG46/AN22       31       RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31       RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31       RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33       RJ1/SEG33       33       33         RJ1/SEG34       33       33       RJ3/SEG35       33         RJ3/SEG35       33       RJ4/SEG39       33       33         RJ6/SEG37       33       RJ6/SEG37       33         RJ7/SEG36       33       RJ7/SEG36       33	<pre> 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3</pre>
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ1/SEG33       33         RJ3/SEG34       33         RJ3/SEG35       33         RJ3/SEG36       33         RJ3/SEG37       33         RJ6/SEG37       33         RJ7/SEG36       33	<pre> 3 3 3 3 1 1 1 1 1 1 1 1 1 1 3 3 3 3 3</pre>
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ1/SEG33       33         RJ3/SEG34       33         RJ3/SEG35       33         RJ3/SEG36       33         RJ3/SEG37       33         RJ6/SEG37       33         RJ7/SEG36       33	<pre> 3 3 3 3 1 1 1 1 1 1 1 1 1 1 3 3 3 3 3</pre>
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31       RH1/SEG46/AN22       31         RH1/SEG46/AN22       31       RH2/SEG45/AN21       31         RH3/SEG44/AN20       31       RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31       RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH6/SEG33       33       RJ1/SEG33       33       RJ1/SEG33       33         RJ2/SEG34       33       RJ3/SEG35       33       33         RJ4/SEG39       33       RJ4/SEG37       33         RJ6/SEG37       33       RJ7/SEG36       33         VDD       33, 22       VDDCORE/VCAP       22, 33	<pre> 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3</pre>
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ1/SEG33       33         RJ2/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ5/SEG38       33         RJ6/SEG37       33         RJ7/SEG36       33         VDD       33, 22         VDDCORE/VCAP       22, 33         Vss       33, 22	<pre> 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3</pre>
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH4/SEG40/CCP9/P3C/AN12/C2IND       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ1/SEG33       33         RJ3/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ5/SEG38       33         RJ6/SEG37       33         RJ7/SEG36       33	<b>a b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b b </b>
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ0       33         RJ1/SEG33       33         RJ3/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ5/SEG38       33         RJ6/SEG37       33         RJ7/SEG36       33         VDD       33, 22         VDDCORE/VCAP       22, 33         Vss       33, 22         Pinout I/O Descriptions       33, 22	<b>a b b b b c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c</b>
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH5/SEG41/CCP6/P1B/AN15       32         RJ0       33         RJ1/SEG33       33         RJ2/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ5/SEG38       33         RJ6/SEG37       33         RJ7/SEG36       33         VDD       33, 22         VDDCORE/VCAP       22, 33         Vss       33, 22         Pinout I/O Descriptions       14         PIC18F6XK90       14	<b>a b b b b c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c c</b>
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH6/SEG42/CCP7/P1C/AN14/C1INC       31         RH7/SEG33       33         RJ1/SEG33       33         RJ1/SEG33       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ5/SEG38       33         RJ6/SEG37       33         RJ7/SEG36       33         VDD       33, 22         VDDCORE/VCAP       22, 33         Vss       33, 22         Pinout I/O Descriptions       33, 22         Pinout I/O Descriptions       14         PIC18F6XK90       14         PIC18F6XK90	<pre> 9 9 9 9 1 1 1 1 1 1 1 1 1 2 3 3 3 3 3 3 3 3 3 2 4 2 4 2 </pre>
RF7/AN5/SS1/SEG25       20, 29         RG0/ECCP3/P3A       21, 30         RG1/TX2/CK2/AN19/C3OUT       21, 30         RG2/RX2/DT2/AN18/C3INA       21, 30         RG3/CCP4/AN17/P3D/C3INB       21, 30         RG4/SEG26/RTCC/T7CKI/T5G/CCP5/       AN16/P1D/C3INC       21, 30         RH0/SEG47/AN23       31         RH1/SEG46/AN22       31         RH2/SEG45/AN21       31         RH3/SEG44/AN20       31         RH4/SEG40/CCP9/P3C/AN12/C2INC       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH5/SEG41/CCP8/P3B/AN13/C2IND       31         RH5/SEG41/CCP6/P1B/AN15       32         RJ0       33         RJ1/SEG33       33         RJ2/SEG34       33         RJ3/SEG35       33         RJ4/SEG39       33         RJ5/SEG38       33         RJ6/SEG37       33         RJ7/SEG36       33         VDD       33, 22         VDDCORE/VCAP       22, 33         Vss       33, 22         Pinout I/O Descriptions       14         PIC18F6XK90       14	<pre> 9 9 9 9 1 1 1 1 1 1 1 1 1 2 3 3 3 3 3 3 3 3 3 2 4 2 4 2 </pre>

PLL	46
HSPLL and ECPLL Oscillator Modes	
Use with HF-INTOSC	
POP	
POR. See Power-on Reset.	
PORTA	
Associated Registers	157
LATA Register	155
PORTA Register	155
TRISA Register	155
PORTB	
Associated Registers	160
LATB Register	158
PORTB Register	
RB7:RB4 Interrupt-on-Change Flag (RBIF Bit)	158
TRISB Register	
PORTC	
Associated Registers	163
LATC Register	161
PORTC Register	161
TRISC Register	
PORTD	
Associated Registers	166
LATD Register	
PORTD Register	
TRISD Register	
PORTE	
Associated Registers	169
LATE Register	
PORTE Register	
TRISE Register	
PORTF	
Associated Registers	172
LATF Register	
PORTF Register	
TRISF Register	
PORTG	
Associated Registers	174
LATG Register	
PORTG Register	
TRISG Register	
PORTH	
Associated Registers	177
LATH Register	
PORTH Register	475
TRISH Register	175
PORTJ	
Associated Registers	179
LATJ Register	
PORTJ Register	
TRISJ Register	
Power-Managed Modes	
and PWM Operation	
and SPI Operation	
Clock Transitions and Status Indicators	
Entering	
Exiting Idle and Sleep Modes	
by Interrupt	
by Reset	
by WDT Time-out	
Without an Oscillator Start-up Delay	

#### 查询PIC18F67K90供应商

Idle Modes PRI IDLE	
PRI IDI E	
	57
RC_IDLE	58
SEC_IDLE	
Multiple Sleep Commands	52
Run Modes	
PRI RUN	
-	
RC_RUN	
SEC_RUN	
Selecting	51
Sleep Mode	
OSC1 and OSC2 Pin States	
Summary (table)	51
Power-on Reset (POR)	
Power-up Delays	
Power-up Timer (PWRT)	50, 70
Time-out Sequence	70
Prescaler, Timer0	
Prescaler, Timer2	
PRI IDLE Mode	57
PRI RUN Mode	52
-	
Program Counter (PC)	
PCL, PCH and PCU Registers	
PCLATH and PCLATU Registers	
Program Memory	
Extended Instruction Set	104
Hard Memory Vectors	
Instructions	
Two-Word	
Interrupt Vector	
Look-up Tables	87
•	
Memory Maps	
Hard Vectors and Configuration Words	
Reset Vector	
Program Verification	
Programming, Device Instructions	
Pulse Steering	
1 uise Steering	
Pulse-Width Modulation. See PWM (CCP Module).	
Pulse-Width Modulation. See PWM (CCP Module). PUSH	266
Pulse-Width Modulation. See PWM (CCP Module).	266
Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions	266 478 86
Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL	266 478 86
Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module)	266 478 86 494
Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL	266 478 86 494
Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL. PWM (CCP Module) Associated Registers	266 478 86 494 247
Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle	266 478 86 494 247 246
Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions	
Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL. PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period.	266 478 494 247 246 246 246 246
Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions	266 478 494 247 246 246 246 246
Pulse-Width Modulation. See PWM (CCP Module). PUSH PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation	
Pulse-Width Modulation. See PWM (CCP Module). PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle. Example Frequencies/Resolutions Period. Setup for PWM Operation TMR2 to PR2 Match	
Pulse-Width Modulation. See PWM (CCP Module). PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle Example Frequencies/Resolutions Period Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit)	266 
Pulse-Width Modulation. See PWM (CCP Module). PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle. Example Frequencies/Resolutions Period. Setup for PWM Operation TMR2 to PR2 Match	266 
Pulse-Width Modulation. See PWM (CCP Module). PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle. Example Frequencies/Resolutions Period. Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match. PWM (ECCP Module)	266 
Pulse-Width Modulation. See PWM (CCP Module). PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle. Example Frequencies/Resolutions Period. Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match. PWM (ECCP Module)	266 
Pulse-Width Modulation. See PWM (CCP Module). PUSH	
Pulse-Width Modulation. See PWM (CCP Module). PUSH and POP Instructions PUSHL PWM (CCP Module) Associated Registers Duty Cycle. Example Frequencies/Resolutions Period. Setup for PWM Operation TMR2 to PR2 Match TMR2 to PR2 Match Flag (TMR2IF Bit) TMRx to PRx Match. PWM (ECCP Module) Effects of a Reset Operation in Power-Managed Modes	266 
Pulse-Width Modulation. See PWM (CCP Module). PUSH	266 
Pulse-Width Modulation. See PWM (CCP Module). PUSH	266 
Pulse-Width Modulation. See PWM (CCP Module). PUSH	266 478 86 494 247 246 246 246 246 246 247 246 136 211 269 269 269 269 269
Pulse-Width Modulation. See PWM (CCP Module). PUSH	266 478 86 494 247 246 246 246 246 247 246 136 211 269 269 269 269 269 269 268
Pulse-Width Modulation. See PWM (CCP Module). PUSH	266 478 86 494 247 246 246 246 246 247 246 136 211 269 269 269 269 269 269 268
Pulse-Width Modulation. See PWM (CCP Module). PUSH	266 478 86 494 247 246 246 246 246 247 246 136 211 269 269 269 269 269 269 268
Pulse-Width Modulation. See PWM (CCP Module). PUSH	266 478 86 494 247 246 246 246 246 247 246 136 211 269 269 269 269 269 269 268
Pulse-Width Modulation. See PWM (CCP Module). PUSH	266 478 86 494 247 246 246 246 246 247 247 246 246 247 246 247 246 249 269 269 269 269 269 268 1255
Pulse-Width Modulation. See PWM (CCP Module). PUSH	266 478 86 494 247 246 246 246 246 247 247 246 246 247 246 247 246 249 269 269 269 269 269 268 1255
Pulse-Width Modulation. See PWM (CCP Module). PUSH	266 478 86 494 247 246 246 246 246 247 247 246 246 247 246 247 246 249 269 269 269 269 269 268 1255
Pulse-Width Modulation. See PWM (CCP Module). PUSH and POP Instructions	266 478 86 494 247 246 246 246 246 247 247 246 246 247 246 247 246 249 269 269 269 269 269 268 1255
Pulse-Width Modulation. See PWM (CCP Module). PUSH and POP Instructions	266 478 86 494 247 246 246 246 246 247 247 246 246 247 246 247 246 249 269 269 269 269 269 268 1255
Pulse-Width Modulation. See PWM (CCP Module). PUSH and POP Instructions	266 478 86 494 247 246 246 246 246 247 246 247 246 247 246 247 246 269 269 269 269 269 269 269 269 269 26
Pulse-Width Modulation. See PWM (CCP Module). PUSH and POP Instructions	266 

RC_RUN Mode ......53

RCON Register	479
Bit Status During Initialization	72
Reader Response	
Real-Time Clock and Calendar (RTCC)	215
Alarm	230
Configuring	
Interrupt	231
Mask Settings	
Alarm Value Registers (ALRMVAL)	
Clock Source	
Control Registers	
Digit Carry Rules	
Operation	
Calibration	
General Functionality	
Leap Year	
Register Mapping	
Register Reads/Writes, Safety Window Write Lock	
Register Interface	
Register Maps	
Registers	
Reset	
Device	
Power-on Reset (POR)	
RTCEN Bit Write	
Sleep Mode	
Value Registers (RTCVAL)	
Register File	
Register File Summary	
Registers	
ADCON0 (A/D Control 0)	372
ADCON1 (A/D Control 1)	
	373
ADCON2 (A/D Control 2)	
	374
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified,	374
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1)	374 375
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified,	374 375
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0)	374 375 376
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified,	374 375 376
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1)	374 375 376 376 376
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration)	374 375 376 376 376 219
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value)	374 375 376 376 376 219 224
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value)	374 375 376 376 376 219 224 225
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value) ALRMMIN (Alarm Minutes Value)	374 375 376 376 376 219 224 225 226
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value) ALRMMIN (Alarm Minutes Value) ALRMMNTH (Alarm Month Value)	374 375 376 376 376 219 224 225 226 224
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value) ALRMHR (Alarm Minutes Value) ALRMMIN (Alarm Minutes Value) ALRMMNTH (Alarm Month Value)	374 375 376 376 376 219 224 225 226 224 220
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value) ALRMMIN (Alarm Minutes Value) ALRMMNTH (Alarm Month Value) ALRMMNTH (Alarm Repeat) ALRMSEC (Alarm Seconds Value)	374 375 376 376 376 219 224 225 226 224 220 226
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value) ALRMHR (Alarm Minutes Value) ALRMMNTH (Alarm Month Value) ALRMMNTH (Alarm Repeat) ALRMSEC (Alarm Seconds Value)	374 375 376 376 376 219 224 225 226 224 220 226 225
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value) ALRMHR (Alarm Minutes Value) ALRMMIN (Alarm Minutes Value) ALRMMNTH (Alarm Repeat) ALRMSEC (Alarm Seconds Value) ALRMWD (Alarm Weekday Value) ALRMWD (Alarm Weekday Value)	374 375 376 376 376 219 224 225 226 224 220 226 225 377
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value) ALRMHR (Alarm Minutes Value) ALRMMIN (Alarm Minutes Value) ALRMMNTH (Alarm Repeat) ALRMSEC (Alarm Seconds Value) ALRMWD (Alarm Weekday Value) ALRMWD (Alarm Weekday Value) ALRMWD (Alarm Weekday Value) ALRMWD (Alarm Veekday Value) ALRMWD (Alarm Veekday Value) ANCON0 (A/D Port Configuration 0)	374 375 376 376 376 219 224 225 226 226 226 225 377 377
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value) ALRMHR (Alarm Minutes Value) ALRMMIN (Alarm Minutes Value) ALRMMNTH (Alarm Repeat) ALRMSEC (Alarm Seconds Value) ALRMWD (Alarm Weekday Value) ALRMWD (Alarm Weekday Value) ALRMWD (Alarm Veekday Value) ALRMWD (Alarm Configuration 0) ANCON1 (A/D Port Configuration 1) ANCON2 (A/D Port Configuration 2)	374 375 376 376 376 219 224 225 226 224 220 226 225 377 377 378
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value) ALRMHR (Alarm Minutes Value) ALRMMIN (Alarm Minutes Value) ALRMMNTH (Alarm Month Value) ALRMMRPT (Alarm Repeat) ALRMSEC (Alarm Seconds Value) ALRMWD (Alarm Weekday Value) ALRMWD (Alarm Weekday Value) ALRMWD (Alarm Veekday Value) ALRMWD (Alarm Configuration 0) ANCON0 (A/D Port Configuration 1) ANCON2 (A/D Port Configuration 2) BAUDCONx (Baud Rate Control)	374 375 376 376 376 376 219 224 225 226 226 226 225 377 377 378 350
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value) ALRMHR (Alarm Minutes Value) ALRMMIN (Alarm Minutes Value) ALRMMNTH (Alarm Month Value) ALRMMRPT (Alarm Repeat) ALRMSEC (Alarm Seconds Value) ALRMWD (Alarm Weekday Value) ALRMWD (Alarm Weekday Value) ALRMWD (Alarm Weekday Value) ALRMCON0 (A/D Port Configuration 0) ANCON1 (A/D Port Configuration 1) ANCON2 (A/D Port Configuration 2) BAUDCONx (Baud Rate Control) CCPRxH (CCPx Period High Byte)	374 375 376 376 376 376 219 224 225 226 226 226 225 377 377 378 350 238
<ul> <li>ADCON2 (A/D Control 2)</li> <li>ADRESH (A/D Result High Byte Left Justified, ADFM = 0)</li> <li>ADRESH (A/D Result High Byte Right Justified, ADFM = 1)</li> <li>ADRESL (A/D Result Low Byte Left Justified, ADFM = 0)</li> <li>ADRESL (A/D Result Low Byte Right Justified, ADFM = 1)</li> <li>ADRESL (A/D Result Low Byte Right Justified, ADFM = 1)</li> <li>ALRMCFG (Alarm Configuration)</li> <li>ALRMDAY (Alarm Day Value)</li> <li>ALRMHR (Alarm Moutes Value)</li> <li>ALRMMIN (Alarm Month Value)</li> <li>ALRMSEC (Alarm Seconds Value)</li> <li>ALRMSEC (Alarm Weekday Value)</li> <li>ALRMWD (Alarm Weekday Value)</li> <li>ANCON0 (A/D Port Configuration 0)</li> <li>ANCON1 (A/D Port Configuration 1)</li> <li>ANCON2 (A/D Port Configuration 2)</li> <li>BAUDCONx (Baud Rate Control)</li> <li>CCPRxH (CCPx Period Low Byte)</li> </ul>	374 375 376 376 376 219 224 225 226 226 226 225 377 377 378 350 238 238
<ul> <li>ADCON2 (A/D Control 2)</li> <li>ADRESH (A/D Result High Byte Left Justified, ADFM = 0)</li> <li>ADRESH (A/D Result High Byte Right Justified, ADFM = 1)</li> <li>ADRESL (A/D Result Low Byte Left Justified, ADFM = 0)</li> <li>ADRESL (A/D Result Low Byte Right Justified, ADFM = 1)</li> <li>ADRESL (A/D Result Low Byte Right Justified, ADFM = 1)</li> <li>ALRMCFG (Alarm Configuration)</li> <li>ALRMDAY (Alarm Day Value)</li> <li>ALRMHR (Alarm Minutes Value)</li> <li>ALRMMIN (Alarm Month Value)</li> <li>ALRMSEC (Alarm Seconds Value)</li> <li>ALRMSEC (Alarm Seconds Value)</li> <li>ALRMWD (Alarm Weekday Value)</li> <li>ALRMWD (Alarm Configuration 0)</li> <li>ANCON0 (A/D Port Configuration 1)</li> <li>ANCON2 (A/D Port Configuration 2)</li> <li>BAUDCONx (Baud Rate Control)</li> <li>CCPRxL (CCPx Period Low Byte)</li> <li>CCPTMRS0 (CCP Timer Select 0)</li> </ul>	374 375 376 376 376 219 224 225 226 226 226 225 377 377 378 350 238 238 231
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value) ALRMHR (Alarm Minutes Value) ALRMMIN (Alarm Month Value) ALRMMTH (Alarm Repeat) ALRMSEC (Alarm Seconds Value) ALRMSEC (Alarm Seconds Value) ALRMWD (Alarm Weekday Value) ALRMWD (Alarm Veekday Value) ALRMWD (Alarm Configuration 0) ALRMVD (Alarm Veekday Value) ALRMCON2 (A/D Port Configuration 1) ANCON2 (A/D Port Configuration 2) BAUDCONX (Baud Rate Control) CCPRXH (CCPx Period Low Byte) CCPTMRS0 (CCP Timer Select 0) CCPTMRS1 (CCPx Timer Select 1)	374 375 376 376 376 219 224 225 226 226 226 226 227 377 378 378 350 238 238 231 236
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value) ALRMHR (Alarm Minutes Value) ALRMMIN (Alarm Month Value) ALRMMTH (Alarm Repeat) ALRMSEC (Alarm Seconds Value) ALRMSEC (Alarm Weekday Value) ALRMWD (Alarm Weekday Value) ALRMVD (Alarm Weekday Value) ALRMVD (Alarm Weekday Value) ALRMSEC (Alarm Seconds Value) ALRMSEC (COP TORIGIN 1) COPTARS (CCP TIMES Select 1) CCPTMRS2 (CCP X Timer Select 2)	374 375 376 376 376 219 224 225 226 226 226 226 377 377 378 350 238 238 236 237
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMDAY (Alarm Minutes Value) ALRMMIN (Alarm Minutes Value) ALRMMTH (Alarm Month Value) ALRMMTH (Alarm Repeat) ALRMSEC (Alarm Seconds Value) ALRMSEC (Alarm Weekday Value) ALRMWD (Alarm Weekday Value) ALRMSEC (Alarm Configuration 0) ANCON0 (A/D Port Configuration 1) ANCON2 (A/D Port Configuration 2) BAUDCONx (Baud Rate Control) CCPRxH (CCPx Period Low Byte) CCPTMRS0 (CCP Timer Select 0) CCPTMRS1 (CCPx Timer Select 1) CCPTMRS2 (CCPx Timer Select 2) CCPXCON (CCPx Control, CCP4-CCP10)	374 375 376 376 376 219 224 225 226 226 226 226 377 377 378 350 238 238 236 237
<ul> <li>ADCON2 (A/D Control 2)</li> <li>ADRESH (A/D Result High Byte Left Justified, ADFM = 0)</li> <li>ADRESH (A/D Result High Byte Right Justified, ADFM = 1)</li> <li>ADRESL (A/D Result Low Byte Left Justified, ADFM = 0)</li> <li>ADRESL (A/D Result Low Byte Right Justified, ADFM = 1)</li> <li>ADRESL (A/D Result Low Byte Right Justified, ADFM = 1)</li> <li>ALRMCFG (Alarm Configuration)</li> <li>ALRMDAY (Alarm Day Value)</li> <li>ALRMHR (Alarm Hours Value)</li> <li>ALRMMIN (Alarm Minutes Value)</li> <li>ALRMMTH (Alarm Month Value)</li> <li>ALRMSEC (Alarm Seconds Value)</li> <li>ALRMSEC (Alarm Weekday Value)</li> <li>ALRMWD (Alarm Weekday Value)</li> <li>ANCON0 (A/D Port Configuration 0)</li> <li>ANCON1 (A/D Port Configuration 2)</li> <li>BAUDCONx (Baud Rate Control)</li> <li>CCPRxH (CCPx Period Low Byte)</li> <li>CCPTMRS0 (CCP Timer Select 0)</li> <li>CCPTMRS1 (CCPx Timer Select 1)</li> <li>CCPXCON (Enhanced Capture/Compare/PWM x</li> </ul>	374 375 376 376 376 219 224 225 226 226 226 226 227 377 378 350 238 238 235
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value) ALRMMIN (Alarm Minutes Value) ALRMMIN (Alarm Month Value) ALRMMRT (Alarm Repeat) ALRMSEC (Alarm Seconds Value) ALRMSEC (Alarm Weekday Value) ALRMWD (Alarm Weekday Value) ALRMWD (Alarm Veekday Value) ALRMSEC (Alarm Configuration 0) ANCON0 (A/D Port Configuration 1) ANCON2 (A/D Port Configuration 2) BAUDCONx (Baud Rate Control). CCPRxH (CCPx Period Low Byte). CCPTMRS0 (CCP Timer Select 0). CCPTMRS1 (CCPx Timer Select 1). CCPTMRS2 (CCPx Timer Select 1). CCPXCON (Enhanced Capture/Compare/PWM x Control)	374 375 376 376 376 219 224 225 226 226 226 226 226 227 377 378 378 378 238 231 235 235 250
ADCON2 (A/D Control 2) ADRESH (A/D Result High Byte Left Justified, ADFM = 0) ADRESH (A/D Result High Byte Right Justified, ADFM = 1) ADRESL (A/D Result Low Byte Left Justified, ADFM = 0) ADRESL (A/D Result Low Byte Right Justified, ADFM = 1) ALRMCFG (Alarm Configuration) ALRMDAY (Alarm Day Value) ALRMHR (Alarm Hours Value) ALRMHR (Alarm Minutes Value) ALRMMIN (Alarm Month Value) ALRMMTH (Alarm Repeat) ALRMSEC (Alarm Seconds Value) ALRMSEC (Alarm Veckday Value) ALRMSEC (Alarm Seconds Value) ALRMSEC (Alarm Veckday Value) ALRMSEC (Alarm Seconds Value) ALRMSEC (CPT Configuration 0) ANCON1 (A/D Port Configuration 1) ANCON2 (A/D Port Configuration 2) BAUDCONX (Baud Rate Control) CCPRXH (CCPx Period Low Byte) CCPTMRS0 (CCP Timer Select 0) CCPTMRS1 (CCPx Timer Select 1) CCPTMRS2 (CCPx Timer Select 2) CCPXCON (CCPx Control, CCP4-CCP10) CCPXCON (Enhanced Capture/Compare/PWM x	374 375 376 376 376 219 224 225 226 226 226 226 227 377 377 378 378 238 238 235 235 235 230 389

#### 查询PIC18F67K90供应商 CONFIG1H (Configuration 1 High) ...... 426 CONFIG1L (Configuration 1 Low)...... 425 CONFIG2H (Configuration 2 High) ...... 428 CONFIG3H (Configuration 3 High) ...... 429 CONFIG4L (Configuration 4 Low)...... 430 CONFIG5H (Configuration 5 High) ...... 432 CONFIG6H (Configuration 6 High) ...... 434 CONFIG7H (Configuration 7 High) ...... 436 CONFIG7L (Configuration 7 Low)......435 CTMUCONH (CTMU Control High) ...... 406 CVRCON (Comparator Voltage EECON1 (Data EEPROM Control 1).....120 EECON1 (EEPROM Control 1)..... 111 HLVDCON (High/Low-Voltage Detect Control)...... 399 INTCON (Interrupt Control)..... 129 INTCON2 (Interrupt Control 2)......130 IPR1 (Peripheral Interrupt Priority 1)......143 IPR2 (Peripheral Interrupt Priority 2).....144 IPR3 (Peripheral Interrupt Priority 3).....145 IPR4 (Peripheral Interrupt Priority 4)......145 IPR5 (Peripheral Interrupt Priority 5)......146 IPR6 (Peripheral Interrupt Priority 6)..... 147 LCDCON (LCD Control)......272 LCDREF (LCD Reference Voltage Control)......274 LCDRL (LCD Reference Ladder Control) ...... 275 LCDSEx (LCD Segmentx Enable) ...... 276 ODCON1 (Peripheral Open-Drain Control 1)......152 ODCON2 (Peripheral Open-Drain Control 2)......153 ODCON3 (Peripheral Open-Drain Control 3).....154 OSCCON (Oscillator Control) ...... 41 OSCTUNE (Oscillator Tuning)......43 PIE1 (Peripheral Interrupt Enable 1)......138 PIE2 (Peripheral Interrupt Enable 2)......139 PIE3 (Peripheral Interrupt Enable 3)......140 PIE4 (Peripheral Interrupt Enable 4)......140 PIE5 (Peripheral Interrupt Enable 5)......141 PIE6 (Peripheral Interrupt Enable 6)......142 PIR2 (Peripheral Interrupt Request (Flag) 2) ...... 133 PIR3 (Peripheral Interrupt Request (Flag) 3) ...... 134 PIR4 (Peripheral Interrupt Request (Flag) 4) ...... 135 PIR5 (Peripheral Interrupt Request (Flag) 5) ...... 136 PIR6 (Peripheral Interrupt Request (Flag) 6) ...... 137 PMD0 (Peripheral Module Disable 0) ......62 PMD1 (Peripheral Module Disable 1) ......61

PMD2 (Peripheral Module Disable 2)	
PMD3 (Peripheral Module Disable 3)	
PSTRxCON (Pulse Steering Control)	
RCON (Reset Control)	
RCSTAx (Receive Status and Control)	
REFOCON (Reference Oscillator Control)	49
Reserved RTCCAL (RTCC Calibration)	
RTCCFG (RTCC Configuration)	
SECOND (Second Value) SSPxCON1 (MSSPx Control 1, I ² C Mode)	223
SSPxCON1 (MSSPx Control 1, 7 C Mode)	202
SSPxCON1 (MSSPx Control 1, SP1 Mode) SSPxCON2 (MSSPx Control 2, I ² C	303
Master Mode)	214
SSPxCON2 (MSSPx Control 2, I ² C Slave Mode)	314
SSPxCON2 (MSSPx Control 2, 1 C Slave Mode) SSPxMSK (I ² C Slave Address Mask, 7-Bit)	315
SSPxSTAT (MSSPx Status, I ² C Mode)	210
SSPxSTAT (MSSPx Status, FC Mode)	
STATUS	
STKPTR (Stack Pointer)	
TOCON (Timer0 Control)	
T1CON (Timer1 Control) T1GCON (Timer1 Gate Control)	100
T2CON (Timer2 Control)	
TxCON (Timer3/5/7 Control)	
TxCON (Timer4/6/8/10/12 Control)	
TxGCON (Timer3/5/7 Gate Control)	
TXSTAx (Transmit Status and Control)	
WDTCON (Watchdog Timer Control)	
WEEKDAY (Weekday Value)	
YEAR (Year Value) RESET	
Reset	
Brown-out Reset (BOR) Configuration Mismatch (CM) Reset	
MCLR Reset, During Power-Managed Modes	
MCLR Reset, Normal Operation	
Power-on Reset (POR)	
RESET Instruction	
Stack Full Reset	
Stack Underflow Reset	
Watchdog Timer (WDT) Reset	
Resets	
Brown-out Reset (BOR)	
Oscillator Start-up Timer (OST)	
Power-on Reset (POR)	
Power-up Timer (PWRT)	
RETFIE	
RETLW	
RETURN	
Return Address Stack	
Return Stack Pointer (STKPTR)	
Revision History	
RLCF	
RLNCF	
RRCF	
RRNCF	
S	

# SCKx 301 SDIx 301 SDOx 301 SEC_IDLE Mode 57 SEC_RUN Mode 52 Secondary Oscillator (SOSC) 43

## 查询PIC18F67K90供应商。

	58
Serial Clock, SCKx	301
Serial Data In (SDIx)	
Serial Data Out (SDOx)	301
Serial Peripheral Interface. See SPI Mode.	
SETF	
Shoot-Through Current	
Slave Select (SSx)	
SLEEP	
Software Simulator (MPLAB SIM)	501
Special Event Trigger. See Compare (CCP Module)	
Special Event Trigger. See Compare (ECCP Mode).	
SSPOV	
SSPOV Status Flag	
SSPxSTAT Register	
R/W Bit	316, 319
<u>SSx</u>	301
Stack Full/Underflow Resets	
SUBFSR	495
SUBFWB	
SUBLW	
SUBULNK	
SUBWF	
SUBWFB	
SWAPF	486

#### Т

Table Reads/Table Writes       87         TBLRD       487         TBLWT       488         Timer0       181         Associated Registers       183         Operation       182         Overflow Interrupt       183         Prescaler       183         Switching Assignment       183         Prescaler Assignment (PSA Bit)       183         Prescaler Select (TOPS2:T0PS0 Bits)       183         Reads and Writes in 16-Bit Mode       182         Source Edge Select (TOSE Bit)       182         Source Select (TOCS Bit)       182         Timer1       185         16-Bit Read/Write Mode       189         Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       189         Resetting, Using the ECCP       Special Event Trigger         Special Event Trigger       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         TI	Table Pointer Operations (table)	112
TBLWT       488         Timer0       181         Associated Registers       183         Operation       182         Overflow Interrupt       183         Prescaler       183         Switching Assignment       183         Prescaler Assignment (PSA Bit)       183         Prescaler Select (TOPS2:T0PS0 Bits)       183         Reads and Writes in 16-Bit Mode       182         Source Edge Select (TOSE Bit)       182         Source Select (TOCS Bit)       182         Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       185         Resetting, Using the ECCP       Special Event Trigger       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         Use as a Clock Source       190         TIMR1L Register       185         TIMEr2       197         Associated Registers       198<		
TBLWT       488         Timer0       181         Associated Registers       183         Operation       182         Overflow Interrupt       183         Prescaler       183         Switching Assignment       183         Prescaler Assignment (PSA Bit)       183         Prescaler Select (TOPS2:T0PS0 Bits)       183         Reads and Writes in 16-Bit Mode       182         Source Edge Select (TOSE Bit)       182         Source Select (TOCS Bit)       182         Timer1       185         16-Bit Read/Write Mode       189         Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       185         Resetting, Using the ECCP       Special Event Trigger         Special Event Trigger       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         Use as a Clock Source       190         TIMR1L Register       185         TIMEr2       198         Op	TBLRD	
Associated Registers       183         Operation       182         Overflow Interrupt       183         Prescaler       183         Switching Assignment       183         Prescaler Assignment (PSA Bit)       183         Prescaler Select (TOPS2:T0PS0 Bits)       183         Reads and Writes in 16-Bit Mode       182         Source Edge Select (TOSE Bit)       182         Source Select (TOCS Bit)       182         Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       185         Resetting, Using the ECCP       Special Event Trigger         Source Coscillator       189         Layout Considerations       190         Use as a Clock Source       190         Use as a Clock Source       190         TIMR1H Register       185         Timer2       197         Associated Register		
Operation182Overflow Interrupt183Prescaler183Switching Assignment183Prescaler Assignment (PSA Bit)183Prescaler Select (TOPS2:T0PS0 Bits)183Reads and Writes in 16-Bit Mode182Source Edge Select (TOSE Bit)182Source Select (TOCS Bit)182Timer118516-Bit Read/Write Mode189Associated Registers195Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCP185Special Event Trigger191SOSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185Timer2197Associated Registers198Interrupt198Operation197		
Overflow Interrupt183Prescaler183Switching Assignment183Prescaler Assignment (PSA Bit)183Prescaler Select (TOPS2:T0PS0 Bits)183Reads and Writes in 16-Bit Mode182Source Edge Select (TOSE Bit)182Source Select (TOCS Bit)182Timer118516-Bit Read/Write Mode189Associated Registers195Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCPSpecial Event TriggerSDSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185Timer2197Associated Registers198Interrupt197Associated Registers198Interrupt198Operation197	Associated Registers	183
Overflow Interrupt183Prescaler183Switching Assignment183Prescaler Assignment (PSA Bit)183Prescaler Select (TOPS2:T0PS0 Bits)183Reads and Writes in 16-Bit Mode182Source Edge Select (TOSE Bit)182Source Select (TOCS Bit)182Timer118516-Bit Read/Write Mode189Associated Registers195Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCPSpecial Event TriggerSDSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185Timer2197Associated Registers198Interrupt197Associated Registers198Interrupt198Operation197	Operation	182
Switching Assignment183Prescaler Assignment (PSA Bit)183Prescaler Select (TOPS2:TOPS0 Bits)183Reads and Writes in 16-Bit Mode182Source Edge Select (TOSE Bit)182Source Select (TOCS Bit)182Timer118516-Bit Read/Write Mode189Associated Registers195Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCP189Layout Considerations190Use as a Clock Source190TMR1H Register185Timer2197Associated Registers197Associated Registers198Interrupt197Associated Registers198Interrupt197Associated Registers198Interrupt197Associated Registers198Interrupt198Operation197		
Switching Assignment183Prescaler Assignment (PSA Bit)183Prescaler Select (TOPS2:TOPS0 Bits)183Reads and Writes in 16-Bit Mode182Source Edge Select (TOSE Bit)182Source Select (TOCS Bit)182Timer118516-Bit Read/Write Mode189Associated Registers195Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCP189Layout Considerations190Use as a Clock Source190TMR1H Register185Timer2197Associated Registers197Associated Registers198Interrupt197Associated Registers198Interrupt197Associated Registers198Interrupt197Associated Registers198Interrupt198Operation197	Prescaler	183
Prescaler Assignment (PSA Bit)       183         Prescaler Select (TOPS2:TOPS0 Bits)       183         Reads and Writes in 16-Bit Mode       182         Source Edge Select (TOSE Bit)       182         Source Select (TOCS Bit)       182         Timer1       185         16-Bit Read/Write Mode       189         Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       185         Resetting, Using the ECCP       189         Layout Considerations       190         Use as a Clock Source       190         Use as a Clock Source       190         TMR1H Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197		
Prescaler Select (T0PS2:T0PS0 Bits)       183         Reads and Writes in 16-Bit Mode       182         Source Edge Select (T0SE Bit)       182         Source Select (T0CS Bit)       182         Timer1       185         16-Bit Read/Write Mode       189         Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       185         Resetting, Using the ECCP       191         Source Considerations       190         Use as a Clock Source       190         Use as a Clock Source       190         TMR1H Register       185         TImer2       197         Associated Registers       198         Interrupt.       198         Operation       197		
Reads and Writes in 16-Bit Mode       182         Source Edge Select (TOSE Bit)       182         Source Select (TOCS Bit)       182         Timer1       185         16-Bit Read/Write Mode       189         Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       185         Resetting, Using the ECCP       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         Use as a Clock Source       190         TMR1H Register       185         Timer2       197         Associated Registers       198         Interrupt.       198         Operation       197		
Source Edge Select (TOSE Bit)182Source Select (TOCS Bit)182Timer118516-Bit Read/Write Mode189Associated Registers195Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCP191SOSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185Timer2197Associated Registers198Interrupt198Operation197		
Source Select (TOCS Bit)182Timer118516-Bit Read/Write Mode189Associated Registers195Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCPSpecial Event TriggerSOSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185Timer2197Associated Registers198Interrupt198Operation197		
Timer1       185         16-Bit Read/Write Mode       189         Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       187         Oscillator       185         Resetting, Using the ECCP       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197		
16-Bit Read/Write Mode       189         Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       187         Special Event Trigger       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197		
Associated Registers       195         Clock Source Selection       187         Gate       191         Interrupt       190         Operation       187         Oscillator       187         Oscillator       185         Resetting, Using the ECCP       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197		
Clock Source Selection187Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCPSpecial Event TriggerSOSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185TImer2197Associated Registers198Interrupt198Operation197		
Gate191Interrupt190Operation187Oscillator185Resetting, Using the ECCP191SOSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185TImer2197Associated Registers198Interrupt198Operation197		
Interrupt		
Operation       187         Oscillator       185         Resetting, Using the ECCP       Special Event Trigger         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         TIMEr2       197         Associated Registers       198         Interrupt       198         Operation       197		
Oscillator       185         Resetting, Using the ECCP       Special Event Trigger       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         TIMEr2       197         Associated Registers       198         Interrupt       198         Operation       197	•	
Resetting, Using the ECCP       Special Event Trigger.       191         SOSC Oscillator       189         Layout Considerations       190         Use as a Clock Source       190         TMR1H Register       185         TMR1L Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197	•	
Special Event Trigger.191SOSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185TMR1L Register185Timer2197Associated Registers198Interrupt198Operation197		
SOSC Oscillator189Layout Considerations190Use as a Clock Source190TMR1H Register185TMR1L Register185Timer2197Associated Registers198Interrupt198Operation197		191
Layout Considerations		
Use as a Clock Source		
TMR1H Register       185         TMR1L Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197	,	
TMR1L Register       185         Timer2       197         Associated Registers       198         Interrupt       198         Operation       197		
Timer2		
Associated Registers		
Interrupt		
Operation		
Output 198		
PR2 Register		
TMR2 to PR2 Match Flag (TMR2IF Bit)		
TMR2 to PR2 Match Interrupt		

Timer3/5/7	199
16-Bit Read/Write Mode	204
Associated Registers	
Gates	204
Operation	
Overflow Interrupt 199	, 208
SOSC Oscillator	
Use as a Clock Source	
Special Event Trigger (ECCP)	208
TMRxH Register	
TMRxL Register	
Timer4/6/8/10/12	
Associated Registers	
Interrupt	
Operation	
Output	212
Outputs, PWM Time Base for ECCP	. 212
Postscaler. See Postscaler, Timer4/6/8/10/12.	
Prescaler. See Prescaler, Timer4/6/8/10/12.	
PRx Register	
TMRx Register	
TMRx to PRx Match Interrupt 211	, 212
Timing Diagrams	
A/D Conversion	539
Automatic Baud Rate Calculation	356
Auto-Wake-up Bit (WUE) During	
Normal Operation	
Auto-Wake-up Bit (WUE) During Sleep	
Baud Rate Generator with Clock Arbitration	
BRG Overflow Sequence	356
BRG Reset Due to SDAx Arbitration During	
Start Condition	343
Brown-out Reset (BOR)	524
Bus Collision During a Repeated Start	
Condition (Case 1)	344
Bus Collision During a Repeated Start	
Condition (Case 2)	344
Bus Collision During a Start Condition	
(SCLx = 0)	
Bus Collision During a Stop Condition (Case 1)	
Bus Collision During a Stop Condition (Case 2)	345
Bus Collision During Start Condition	
(SDAx Only)	
Bus Collision for Transmit and Acknowledge	
Capture/Compare/PWM	
CLKO and I/O	
Clock Synchronization	
Clock/Instruction Cycle	
EUSART Asynchronous Reception	
EUSART Asynchronous Transmission	358
EUSART Asynchronous Transmission	
(Back-to-Back)	
EUSART Synchronous Master Transmission	365
EUSART/AUSART Synchronous Receive	
(Master/Slave)	537
EUSART/AUSART Synchronous Transmission	
(Master/Slave)	
Example SPI Master Mode (CKE = 0)	
Example SPI Master Mode (CKE = 1)	
Example SPI Slave Mode (CKE = 0)	
Example SPI Slave Mode (CKE = 1)	
External Clock	
Fail-Safe Clock Monitor (FSCM)	
First Start Bit Timing	
Full-Bridge PWM Output	260

#### 查询PIC18F67K90供应商

Half-Bridge PWM Output
High-Voltage Detect Operation (VDIRMAG = 1) 402
I ² C Acknowledge Sequence
I ² C Bus Data
I ² C Bus Start/Stop Bits533
I ² C Master Mode (7 or 10-Bit Transmission)
I ² C Master Mode (7-Bit Reception)
I ² C Slave Mode (10-Bit Reception, SEN = 0,
ADMSK = 01001)
I ² C Slave Mode (10-Bit Reception, SEN = 0)
I ² C Slave Mode (10-Bit Reception, SEN = 1)
I ² C Slave Mode (10-Bit Transmission)
I ² C Slave Mode (7-Bit Reception, SEN = 0,
ADMSK = 01011)
I ² C Slave Mode (7-Bit Reception, SEN = 0)
I ² C Slave Mode (7-Bit Reception, SEN = 1)
I ² C Slave Mode (7-Bit Transmission)
I ² C Slave Mode General Call Address Sequence
(7 or 10-Bit Addressing Mode)
I ² C Stop Condition Receive or Transmit Mode 340
LCD Interrupt Timing in Quarter
Duty Cycle Drive
LCD Reference Ladder Power Mode Switching 281
LCD Sleep Entry/Exit When SLPEN = 1 or
CS = 00
Low-Voltage Detect Operation (VDIRMAG = 0) 401
MSSP I ² C Bus Data
MSSP I ² C Bus Start/Stop Bits
PWM Auto-Shutdown with
Auto-Restart Enabled
PWM Auto-Shutdown with Firmware Restart
PWM Direction Change261
PWM Direction Change at Near
100% Duty Cycle
100% Duty Cycle
100% Duty Cycle         262           PWM Output         246           PWM Output (Active-High)         256
100% Duty Cycle         262           PWM Output         246           PWM Output (Active-High)         256           PWM Output (Active-Low)         257
100% Duty Cycle262PWM Output246PWM Output (Active-High)256PWM Output (Active-Low)257Repeated Start Condition336
100% Duty Cycle262PWM Output246PWM Output (Active-High)256PWM Output (Active-Low)257Repeated Start Condition336Reset, Watchdog Timer (WDT), Oscillator Start-up
100% Duty Cycle       262         PWM Output       246         PWM Output (Active-High)       256         PWM Output (Active-Low)       257         Repeated Start Condition       336         Reset, Watchdog Timer (WDT), Oscillator Start-up       Timer (OST) and Power-up Timer (PWRT)
100% Duty Cycle       262         PWM Output       246         PWM Output (Active-High)       256         PWM Output (Active-Low)       257         Repeated Start Condition       336         Reset, Watchdog Timer (WDT), Oscillator Start-up       Timer (OST) and Power-up Timer (PWRT)         Send Break Character Sequence       364
100% Duty Cycle       262         PWM Output       246         PWM Output (Active-High)       256         PWM Output (Active-Low)       257         Repeated Start Condition       336         Reset, Watchdog Timer (WDT), Oscillator Start-up       Timer (OST) and Power-up Timer (PWRT)         Send Break Character Sequence       364         Slave Synchronization       307
100% Duty Cycle       262         PWM Output       246         PWM Output (Active-High)       256         PWM Output (Active-Low)       257         Repeated Start Condition       336         Reset, Watchdog Timer (WDT), Oscillator Start-up       1         Timer (OST) and Power-up Timer (PWRT)       524         Send Break Character Sequence       364         Slave Synchronization       307         Slow Rise Time (MCLR Tied to VDD,
100% Duty Cycle       262         PWM Output       246         PWM Output (Active-High)       256         PWM Output (Active-Low)       257         Repeated Start Condition       336         Reset, Watchdog Timer (WDT), Oscillator Start-up       1         Timer (OST) and Power-up Timer (PWRT)       524         Send Break Character Sequence       364         Slave Synchronization       307         Slow Rise Time (MCLR Tied to VDD,       VDD Rise > TPWRT)
100% Duty Cycle       262         PWM Output       246         PWM Output (Active-High)       256         PWM Output (Active-Low)       257         Repeated Start Condition       336         Reset, Watchdog Timer (WDT), Oscillator Start-up       1         Timer (OST) and Power-up Timer (PWRT)       524         Send Break Character Sequence       364         Slave Synchronization       307         Slow Rise Time (MCLR Tied to VDD, VDD Rise > TPWRT)       71         SPI Mode (Master Mode)       306
100% Duty Cycle         262           PWM Output         246           PWM Output (Active-High)         256           PWM Output (Active-Low)         257           Repeated Start Condition         336           Reset, Watchdog Timer (WDT), Oscillator Start-up         316           Timer (OST) and Power-up Timer (PWRT)         524           Send Break Character Sequence         364           Slave Synchronization         307           Slow Rise Time (MCLR Tied to VDD,         VDD Rise > TPWRT)           VDD Rise > TPWRT)         71           SPI Mode (Master Mode)         306           SPI Mode (Slave Mode, CKE = 0)         308
100% Duty Cycle         262           PWM Output         246           PWM Output (Active-High)         256           PWM Output (Active-Low)         257           Repeated Start Condition         336           Reset, Watchdog Timer (WDT), Oscillator Start-up         336           Timer (OST) and Power-up Timer (PWRT)         524           Send Break Character Sequence         364           Slave Synchronization         307           Slow Rise Time (MCLR Tied to VDD,         VDD Rise > TPWRT)           VDD Rise > TPWRT)         71           SPI Mode (Master Mode)         306           SPI Mode (Slave Mode, CKE = 0)         308           SPI Mode (Slave Mode, CKE = 1)         308
100% Duty Cycle         262           PWM Output         246           PWM Output (Active-High)         256           PWM Output (Active-Low)         257           Repeated Start Condition         336           Reset, Watchdog Timer (WDT), Oscillator Start-up         336           Timer (OST) and Power-up Timer (PWRT)         524           Send Break Character Sequence         364           Slave Synchronization         307           Slow Rise Time (MCLR Tied to VDD,         VDD Rise > TPWRT)           VDD Rise > TPWRT)         71           SPI Mode (Master Mode)         306           SPI Mode (Slave Mode, CKE = 0)         308           SPI Mode (Slave Mode, CKE = 1)         308           Steering Event at Beginning of Instruction         308
100% Duty Cycle         262           PWM Output         246           PWM Output (Active-High)         256           PWM Output (Active-Low)         257           Repeated Start Condition         336           Reset, Watchdog Timer (WDT), Oscillator Start-up         336           Timer (OST) and Power-up Timer (PWRT)         524           Send Break Character Sequence         364           Slave Synchronization         307           Slow Rise Time (MCLR Tied to VDD,         VDD Rise > TPWRT)           VDD Rise > TPWRT)         71           SPI Mode (Master Mode)         308           SPI Mode (Slave Mode, CKE = 0)         308           SPI Mode (Slave Mode, CKE = 1)         308           Steering Event at Beginning of Instruction         (STRSYNC = 1)
100% Duty Cycle         262           PWM Output         246           PWM Output (Active-High)         256           PWM Output (Active-Low)         257           Repeated Start Condition         336           Reset, Watchdog Timer (WDT), Oscillator Start-up         336           Timer (OST) and Power-up Timer (PWRT)         524           Send Break Character Sequence         364           Slave Synchronization         307           Slow Rise Time (MCLR Tied to VDD,         VDD Rise > TPWRT)           VDD Rise > TPWRT)         71           SPI Mode (Master Mode)         308           SPI Mode (Slave Mode, CKE = 0)         308           SPI Mode (Slave Mode, CKE = 1)         308           Steering Event at Beginning of Instruction         (STRSYNC = 1)           Catering Event at End of Instruction         268
100% Duty Cycle         262           PWM Output         246           PWM Output (Active-High)         256           PWM Output (Active-Low)         257           Repeated Start Condition         336           Reset, Watchdog Timer (WDT), Oscillator Start-up         336           Timer (OST) and Power-up Timer (PWRT)         524           Send Break Character Sequence         364           Slave Synchronization         307           Slow Rise Time (MCLR Tied to VDD,         VDD Rise > TPWRT)           VDD Rise > TPWRT)         71           SPI Mode (Master Mode)         308           SPI Mode (Slave Mode, CKE = 0)         308           SPI Mode (Slave Mode, CKE = 1)         308           Steering Event at Beginning of Instruction         (STRSYNC = 1)           (STRSYNC = 0)         268
100% Duty Cycle         262           PWM Output         246           PWM Output (Active-High)         256           PWM Output (Active-Low)         257           Repeated Start Condition         336           Reset, Watchdog Timer (WDT), Oscillator Start-up         336           Timer (OST) and Power-up Timer (PWRT)         524           Send Break Character Sequence         364           Slave Synchronization         307           Slow Rise Time (MCLR Tied to VDD,         VDD Rise > TPWRT)           VDD Rise > TPWRT)         71           SPI Mode (Master Mode)         306           SPI Mode (Slave Mode, CKE = 0)         308           Steering Event at Beginning of Instruction         (STRSYNC = 1)           (STRSYNC = 0)         268           Synchronous Master Transmission         268
100% Duty Cycle         262           PWM Output         246           PWM Output (Active-High)         256           PWM Output (Active-Low)         257           Repeated Start Condition         336           Reset, Watchdog Timer (WDT), Oscillator Start-up         336           Timer (OST) and Power-up Timer (PWRT)         524           Send Break Character Sequence         364           Slave Synchronization         307           Slow Rise Time (MCLR Tied to VDD,         VDD Rise > TPWRT)           VDD Rise > TPWRT)         71           SPI Mode (Master Mode)         306           SPI Mode (Slave Mode, CKE = 0)         308           Steering Event at Beginning of Instruction         (STRSYNC = 1)         268           Steering Event at End of Instruction         (STRSYNC = 0)         268           Synchronous Master Transmission         (Through TXEN)         366
100% Duty Cycle         262           PWM Output         246           PWM Output (Active-High)         256           PWM Output (Active-Low)         257           Repeated Start Condition         336           Reset, Watchdog Timer (WDT), Oscillator Start-up         336           Timer (OST) and Power-up Timer (PWRT)         524           Send Break Character Sequence         364           Slave Synchronization         307           Slow Rise Time (MCLR Tied to VDD,         VDD Rise > TPWRT)           VDD Rise > TPWRT)         71           SPI Mode (Master Mode)         306           SPI Mode (Slave Mode, CKE = 0)         308           Steering Event at Beginning of Instruction         (STRSYNC = 1)           VDR Steering Event at End of Instruction         (STRSYNC = 0)           Synchronous Master Transmission         (Through TXEN)           Grade         Synchronous Reception (Master Mode, SREN)
100% Duty Cycle         262           PWM Output         246           PWM Output (Active-High)         256           PWM Output (Active-Low)         257           Repeated Start Condition         336           Reset, Watchdog Timer (WDT), Oscillator Start-up         336           Timer (OST) and Power-up Timer (PWRT)         524           Send Break Character Sequence         364           Slave Synchronization         307           Slow Rise Time (MCLR Tied to VDD,         VDD Rise > TPWRT)           VDD Rise > TPWRT)         71           SPI Mode (Master Mode)         306           SPI Mode (Slave Mode, CKE = 0)         308           Steering Event at Beginning of Instruction         (STRSYNC = 1)         268           Steering Event at End of Instruction         (STRSYNC = 0)         268           Synchronous Master Transmission         (Through TXEN)         366
100% Duty Cycle       262         PWM Output       246         PWM Output (Active-High)       256         PWM Output (Active-Low)       257         Repeated Start Condition       336         Reset, Watchdog Timer (WDT), Oscillator Start-up       336         Timer (OST) and Power-up Timer (PWRT)       524         Send Break Character Sequence       364         Slave Synchronization       307         Slow Rise Time (MCLR Tied to VDD,       VDD Rise > TPWRT)         VDD Rise > TPWRT)       71         SPI Mode (Slave Mode)       306         SPI Mode (Slave Mode, CKE = 0)       308         Steering Event at Beginning of Instruction       (STRSYNC = 1)         (STRSYNC = 0)       268         Synchronous Master Transmission       (Through TXEN)         (Through TXEN)       366         Synchronous Reception (Master Mode, SREN)       367         Time-out Sequence on Power-up       (MCLR Not Tied to VDD), Case 1       71
100% Duty Cycle       262         PWM Output       246         PWM Output (Active-High)       256         PWM Output (Active-Low)       257         Repeated Start Condition       336         Reset, Watchdog Timer (WDT), Oscillator Start-up       336         Timer (OST) and Power-up Timer (PWRT)       524         Send Break Character Sequence       364         Slave Synchronization       307         Slow Rise Time (MCLR Tied to VDD,       VDD Rise > TPWRT)         VDD Rise > TPWRT)       71         SPI Mode (Slave Mode)       306         SPI Mode (Slave Mode, CKE = 0)       308         Steering Event at Beginning of Instruction       (STRSYNC = 1)         (STRSYNC = 0)       268         Synchronous Master Transmission       (Through TXEN)         (Through TXEN)       366         Synchronous Reception (Master Mode, SREN)       367
100% Duty Cycle       262         PWM Output       246         PWM Output (Active-High)       256         PWM Output (Active-Low)       257         Repeated Start Condition       336         Reset, Watchdog Timer (WDT), Oscillator Start-up       1         Timer (OST) and Power-up Timer (PWRT)       524         Send Break Character Sequence       364         Slave Synchronization       307         Slow Rise Time (MCLR Tied to VDD,       VDD Rise > TPWRT)         VDD Rise > TPWRT)       71         SPI Mode (Master Mode)       306         SPI Mode (Slave Mode, CKE = 0)       308         SPI Mode (Slave Mode, CKE = 1)       308         Steering Event at Beginning of Instruction       (STRSYNC = 1)         (STRSYNC = 0)       268         Synchronous Master Transmission       (Through TXEN)         (Through TXEN)       366         Synchronous Reception (Master Mode, SREN)       367         Time-out Sequence on Power-up       (MCLR Not Tied to VDD), Case 1       71         Time-out Sequence on Power-up       71       71         Time-out Sequence on Power-up       71       71
100% Duty Cycle       262         PWM Output       246         PWM Output (Active-High)       256         PWM Output (Active-Low)       257         Repeated Start Condition       336         Reset, Watchdog Timer (WDT), Oscillator Start-up       336         Timer (OST) and Power-up Timer (PWRT)       524         Send Break Character Sequence       364         Slave Synchronization       307         Slow Rise Time (MCLR Tied to VDD,       VDD Rise > TPWRT)         VDD Rise > TPWRT)       71         SPI Mode (Master Mode)       306         SPI Mode (Slave Mode, CKE = 0)       308         Steering Event at Beginning of Instruction       (STRSYNC = 1)         (STRSYNC = 1)       268         Synchronous Master Transmission       (Through TXEN)         (Through TXEN)       366         Synchronous Reception (Master Mode, SREN)       367         Time-out Sequence on Power-up       (MCLR Not Tied to VDD), Case 1       71         Time-out Sequence on Power-up       71         MCLR Not Tied to VDD), Case 2       71
100% Duty Cycle       262         PWM Output       246         PWM Output (Active-High)       256         PWM Output (Active-Low)       257         Repeated Start Condition       336         Reset, Watchdog Timer (WDT), Oscillator Start-up       Timer (OST) and Power-up Timer (PWRT)         Timer (OST) and Power-up Timer (PWRT)       524         Send Break Character Sequence       364         Slave Synchronization       307         Slow Rise Time (MCLR Tied to VDD,       VDD Rise > TPWRT)         VDD Rise > TPWRT)       71         SPI Mode (Master Mode)       306         SPI Mode (Slave Mode, CKE = 0)       308         SPI Mode (Slave Mode, CKE = 1)       308         Steering Event at Beginning of Instruction       (STRSYNC = 1)         (STRSYNC = 1)       268         Synchronous Master Transmission       (Through TXEN)         (Through TXEN)       366         Synchronous Reception (Master Mode, SREN)       367         Time-out Sequence on Power-up       (MCLR Not Tied to VDD), Case 1       71         Time-out Sequence on Power-up       (MCLR Not Tied to VDD), Case 2       71         Time-out Sequence on Power-up       (MCLR Tied to VDD, VDD Rise TPWRT)       70         Timer Pulse Generation
100% Duty Cycle       262         PWM Output       246         PWM Output (Active-High)       256         PWM Output (Active-Low)       257         Repeated Start Condition       336         Reset, Watchdog Timer (WDT), Oscillator Start-up       Timer (OST) and Power-up Timer (PWRT)         Timer (OST) and Power-up Timer (PWRT)       524         Send Break Character Sequence       364         Slave Synchronization       307         Slow Rise Time (MCLR Tied to VDD,       VDD Rise > TPWRT)         VDD Rise > TPWRT)       71         SPI Mode (Master Mode)       306         SPI Mode (Slave Mode, CKE = 0)       308         Steering Event at Beginning of Instruction       (STRSYNC = 1)         (STRSYNC = 1)       268         Synchronous Master Transmission       (Through TXEN)         (Through TXEN)       366         Synchronous Reception (Master Mode, SREN)       367         Time-out Sequence on Power-up       (MCLR Not Tied to VDD), Case 1       71         Time-out Sequence on Power-up       71       71         Time-out Sequence on Power-up       71       71         MCLR Not Tied to VDD, Case 2       71         Time-out Sequence on Power-up       71         MCLR Tied
100% Duty Cycle       262         PWM Output       246         PWM Output (Active-High)       256         PWM Output (Active-Low)       257         Repeated Start Condition       336         Reset, Watchdog Timer (WDT), Oscillator Start-up       Timer (OST) and Power-up Timer (PWRT)         Timer (OST) and Power-up Timer (PWRT)       524         Send Break Character Sequence       364         Slave Synchronization       307         Slow Rise Time (MCLR Tied to VDD,       VDD Rise > TPWRT)         VDD Rise > TPWRT)       71         SPI Mode (Master Mode)       306         SPI Mode (Slave Mode, CKE = 0)       308         SPI Mode (Slave Mode, CKE = 1)       308         Steering Event at Beginning of Instruction       (STRSYNC = 1)         (STRSYNC = 1)       268         Synchronous Master Transmission       (Through TXEN)         (Through TXEN)       366         Synchronous Reception (Master Mode, SREN)       367         Time-out Sequence on Power-up       (MCLR Not Tied to VDD), Case 1       71         Time-out Sequence on Power-up       (MCLR Not Tied to VDD), Case 2       71         Time-out Sequence on Power-up       (MCLR Tied to VDD, VDD Rise TPWRT)       70         Timer Pulse Generation

Timer1 Gate Single Pulse/Toggle	
Combined Mode	195
Timer1 Gate Toggle Mode	193
Timer3/5/7 Gate Count Enable Mode	204
Timer3/5/7 Gate Single Pulse Mode	206
Timer3/5/7 Gate Single Pulse/Toggle	
Combined Mode	
Timer3/5/7 Gate Toggle Mode	205
Transition for Entry to Idle Mode	
Transition for Entry to SEC_RUN Mode	
Transition for Entry to Sleep Mode	56
Transition for Two-Speed Start-up	
(INTOSC to HSPLL)	
Transition for Wake from Idle to Run Mode	
Transition for Wake from Sleep (HSPLL)	56
Transition from RC_RUN Mode to	
PRI_RUN Mode	55
Transition from SEC_RUN Mode to	-0
PRI_RUN Mode (HSPLL)	
Transition to RC_RUN Mode	55
Type-A in 1/2 MUX, 1/2 Bias Drive	
Type-A in 1/2 MUX, 1/3 Bias Drive	288
Type-A in 1/3 MUX, 1/2 Bias Drive	
Type-A in 1/3 MUX, 1/3 Bias Drive Type-A in 1/4 MUX, 1/3 Bias Drive	
Type-A/Type-B in Static Drive	
Type-B in 1/2 MUX, 1/2 Bias Drive	
Type-B in 1/2 MUX, 1/3 Bias Drive	
Type-B in 1/3 MUX, 1/2 Bias Drive	203
Type-B in 1/3 MUX, 1/3 Bias Drive	
Type-B in 1/4 MUX, 1/3 Bias Drive	
Timing Diagrams and Specifications	200
Capture/Compare/PWM Requirements	528
CLKO and I/O Requirements	
EUSART/AUSART Synchronous Receive	
Requirements	537
EUSART/AUSART Synchronous Transmission	
Requirements	537
Example SPI Mode Requirements	
(Master Mode, CKE = 0)	529
Example SPI Mode Requirements	
(Master Mode, CKE = 1)	530
Example SPI Mode Requirements	
(Slave Mode, CKE = 0)	531
Example SPI Slave Mode Requirements	
(CKE = 1)	
External Clock Requirements	
High/Low-Voltage Detect Characteristics	526
I ² C Bus Data Requirements (Slave Mode)	534
I ² C Bus Start/Stop Bits Requirements	
(Slave Mode)	
Internal RC Accuracy (INTOSC)	522
MSSP I ² C Bus Data Requirements	536
MSSP I ² C Bus Start/Stop Bits Requirements	
PLL Clock	522
Reset, Watchdog Timer, Oscillator Start-up Timer,	
Power-up Timer and Brown-out	EOF
Reset Requirements	525
Timer0 and Timer1 External Clock Requirements	507
Requirements Ultra Low-Power Wake-up	
Top-of-Stack (TOS) Access	
TSTFSZ	
	-03

## 查询PIC18F67K90供应商

Two-Speed Start-up	
IESO (CONFIG1H), Internal/External	
Oscillator Switchover Bit426	
Two-Word Instructions	
Example Cases	
TXSTAx Register	
BRGH Bit	
U	
Ultra Low-Power	
Ultra Low-Power Regulator	
Regulator	
Regulator In Sleep441	
Regulator In Sleep441 Ultra Low-Power Wake-up	
Regulator In Sleep441 Ultra Low-Power Wake-up Exit Delay (table)	

Watchdog Timer (WDT)	
Associated Registers	
Control Register	
During Oscillator Failure	
Programming Considerations	
WCOL	335, 336, 337, 340
WCOL Status Flag	
WWW Address	562
WWW, On-Line Support	
X	
XORLW	
XORWF	

#### 查询PIC18F67K90供应商 THE MICROCHIP WEB SITE

Microchip provides online support via our WWW site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

- Product Support Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- General Technical Support Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
- Business of Microchip Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

## CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at www.microchip.com, click on Customer Change Notification and follow the registration instructions.

#### **CUSTOMER SUPPORT**

Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- Local Sales Office
- Field Application Engineer (FAE)
- Technical Support
- Development Systems Information Line

Customers should contact their distributor, representative or field application engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://support.microchip.com

#### 查询PIC18F67K90供应商 READER RESPONSE

It is our intention to provide you with the best documentation possible to ensure successful use of your Microchip product. If you wish to provide your comments on organization, clarity, subject matter, and ways in which our documentation can better serve you, please FAX your comments to the Technical Publications Manager at (480) 792-4150.

Please list the following information, and use this outline to provide us with your comments about this document.

To:	Technical Publications Manager	Total Pages Sent				
RE:	Reader Response					
From	Name					
	Address					
	City / State / ZIP / Country					
	Telephone: ()	FAX: ()				
Application (optional):						
Would	d you like a reply?YN					
Devic	e: PIC18F87K90 Family	Literature Number: DS39957B				
Ques	tions:					
1. W	1. What are the best features of this document?					
2. H	2. How does this document meet your hardware and software development needs?					
_						
3. D	3. Do you find the organization of this document easy to follow? If not, why?					
_						
_						
4. W	/hat additions to the document do y	ou think would enhance the structure and subject?				
_						
_						
5. V	. What deletions from the document could be made without affecting the overall usefulness?					
_						
6. Is	6. Is there any incorrect or misleading information (what and where)?					
_						
7. H	ow would you improve this docume	ent?				
_						
_						

#### 查询PIC18F67K90供应商 PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO. Device	X /XX XXX       Temperature Package Pattern Range	Examples: a) PIC18F87K90-I/PT 301 = Industrial temperature, TQFP package, QTP pattern #301. b) PIC18F87K90T-I/PT = Tape and reel, Industrial
Device ^(1,2)	PIC18F65K90, PIC18F65K90T PIC18F66K90, PIC18F66K90T PIC18F67K90, PIC18F67K90T PIC18F85K90, PIC18F85K90T PIC18F86K90, PIC18F86K90T PIC18F87K90, PIC18F87K90T	temperature, TQFP package.
Temperature Range	I = -40°C to +85°C (Industrial)	
Package	PT = TQFP (Plastic Thin Quad Flatpack) MR = QFN (Plastic Quad Flat)	Note 1: F = Standard Voltage Range
Pattern	QTP, SQTP, Code or Special Requirements (blank otherwise)	<ul> <li>2: T = In tape and reel</li> <li>3: RSL = Silicon revision A3</li> </ul>



#### WORLDWIDE SALES AND SERVICE

#### AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://support.microchip.com Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

**Cleveland** Independence, OH Tel: 216-447-0464 Fax: 216-447-0643

Dallas Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit Farmington Hills, MI Tel: 248-538-2250 Fax: 248-538-2260

Kokomo Kokomo, IN Tel: 765-864-8360 Fax: 765-864-8387

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

**Santa Clara** Santa Clara, CA Tel: 408-961-6444 Fax: 408-961-6445

Toronto Mississauga, Ontario, Canada Tel: 905-673-0699 Fax: 905-673-6509

#### ASIA/PACIFIC

Asia Pacific Office Suites 3707-14, 37th Floor Tower 6, The Gateway Harbour City, Kowloon Hong Kong Tel: 852-2401-1200 Fax: 852-2401-3431

Australia - Sydney Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

**China - Beijing** Tel: 86-10-8528-2100 Fax: 86-10-8528-2104

**China - Chengdu** Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

**China - Chongqing** Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

**China - Hong Kong SAR** Tel: 852-2401-1200 Fax: 852-2401-3431

China - Nanjing Tel: 86-25-8473-2460

Fax: 86-25-8473-2470 China - Qingdao Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

**China - Shanghai** Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

**China - Shenyang** Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

**China - Shenzhen** Tel: 86-755-8203-2660 Fax: 86-755-8203-1760

**China - Wuhan** Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

**China - Xian** Tel: 86-29-8833-7252 Fax: 86-29-8833-7256

**China - Xiamen** Tel: 86-592-2388138 Fax: 86-592-2388130

**China - Zhuhai** Tel: 86-756-3210040 Fax: 86-756-3210049

#### ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

India - New Delhi Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune Tel: 91-20-2566-1512 Fax: 91-20-2566-1513

**Japan - Yokohama** Tel: 81-45-471- 6166 Fax: 81-45-471-6122

**Korea - Daegu** Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

**Malaysia - Penang** Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore Tel: 65-6334-8870 Fax: 65-6334-8850

**Taiwan - Hsin Chu** Tel: 886-3-6578-300 Fax: 886-3-6578-370

**Taiwan - Kaohsiung** Tel: 886-7-536-4818 Fax: 886-7-536-4803

Taiwan - Taipei Tel: 886-2-2500-6610 Fax: 886-2-2508-0102

Thailand - Bangkok Tel: 66-2-694-1351 Fax: 66-2-694-1350

#### EUROPE

Austria - Wels Tel: 43-7242-2244-39 Fax: 43-7242-2244-393 Denmark - Copenhagen Tel: 45-4450-2828 Fax: 45-4485-2829

France - Paris Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

**Germany - Munich** Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781

Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340

**Spain - Madrid** Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

**UK - Wokingham** Tel: 44-118-921-5869 Fax: 44-118-921-5820

01/05/10